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Hitachi 16-Bit Single-Chip Microcomputer

H8S/2140B Series

H8S/2161B HD64F2161BV, HD6432161BV, HD6432161BVW H8S/2160B HD64F2160BV, HD6432160BV, HD6432160BVW H8S/2141B F-ZTATTM HD64F2141BV H8S/2140B F-ZTATTM HD64F2140BV H8S/2145B F-ZTATTM HD64F2145BV H8S/2148B F-ZTATTM HD64F2148BV, HD64F2148B

Hardware Manual



ADE-602-274A

Rev. 2.0 08/01/02 Hitachi, Ltd.

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General Precautions on Handling of Product

1. Treatment of NC Pins

Note: Do not connect anything to the NC pins.

The NC (not connected) pins are either not connected to any of the internal circuitry or are used as test pins or to reduce noise. If something is connected to the NC pins, the operation of the LSI is not guaranteed.

2. Treatment of Unused Input Pins

Note: Fix all unused input pins to high or low level.

Generally, the input pins of CMOS products are high-impedance input pins. If unused pins are in their open states, intermediate levels are induced by noise in the vicinity, a pass-through current flows internally, and a malfunction may occur.

3. Processing before Initialization

Note: When power is first supplied, the product's state is undefined.

The states of internal circuits are undefined until full power is supplied throughout the chip and a low level is input on the reset pin. During the period where the states are undefined, the register settings and the output state of each pin are also undefined. Design your system so that it does not malfunction because of processing while it is in this undefined state. For those products which have a reset function, reset the LSI immediately after the power supply has been turned on.

4. Prohibition of Access to Undefined or Reserved Addresses

Note: Access to undefined or reserved addresses is prohibited.

The undefined or reserved addresses may be used to expand functions, or test registers may have been be allocated to these addresses. Do not access these registers; the system's operation is not guaranteed if they are accessed.



Configuration of This Manual

This manual comprises the following items:

- 1. General Precautions on Handling of Product
- 2. Configuration of This Manual
- 3. Preface
- 4. Contents
- Overview
- 6. Description of Functional Modules
 - CPU and System-Control Modules
 - On-Chip Peripheral Modules

The configuration of the functional description of each module differs according to the module. However, the generic style includes the following items:

- i) Feature
- ii) Input/Output Pin
- iii) Register Description
- iv) Operation
- v) Usage Note

When designing an application system that includes this LSI, take notes into account. Each section includes notes in relation to the descriptions given, and usage notes are given, as required, as the final part of each section.

- 7. List of Registers
- 8. Electrical Characteristics
- 9. Appendix
- 10. Main Revisions and Additions in this Edition (only for revised versions)

The list of revisions is a summary of points that have been revised or added to earlier versions. This does not include all of the revised contents. For details, see the actual locations in this manual.

11. Index

Preface

The H8S/2140B Series are microcomputers (MCUs) made up of the H8S/2000 CPU employing Hitachi's original architecture as their cores, and the peripheral functions required to configure a system.

The H8S/2000 CPU has an internal 32-bit configuration, sixteen 16-bit general registers, and a simple and optimized instruction set for high-speed operation. The H8S/2000 CPU can handle a 16-Mbyte linear address space.

This LSI is equipped with a data transfer controller (DTC) as a bus master, ROM, RAM, an 8-bit PWM timer (PWM), a 14-bit PWM timer (PWMX), a 16-bit free-running timer (FRT), an 8-bit timer (TMR), timer connection, a watchdog timer (WDT), a serial communication interface (SCI), a keyboard buffer controller, a host interface X-bus interface (XBS), a host interface LPC interface (LPC), an 8-bit D/A converter, a 10-bit A/D converter, and I/O ports as on-chip peripheral modules required for system configuration. An I²C bus interface (IIC) can also be included as an optional interface.

A high-functionality bus controller is also provided, enabling fast and easy connection of DRAM and other kinds of memory.

A flash memory (F-ZTATTM*) version is available for this LSI's ROM. This provides flexibility as it can be reprogrammed in no time to cope with all situations from the early stages of mass production to full-scale mass production. This is particularly applicable to application devices with specifications that will most probably change.

Note: * F-ZTATTM is a trademark of Hitachi, Ltd.

Target Users: This manual was written for users who will be using the H8S/2140B Series in the

design of application systems. Target users are expected to understand the fundamentals of electrical circuits, logical circuits, and microcomputers.

Objective: This manual was written to explain the hardware functions and electrical

characteristics of the H8S/2140B Series to the target users.

Refer to the H8S/2600 Series, H8S/2000 Series Programming Manual for a

detailed description of the instruction set.

Notes on reading this manual:

- In order to understand the overall functions of the chip
 Read the manual according to the contents. This manual can be roughly categorized into parts
 on the CPU, system control functions, peripheral functions and electrical characteristics.
- In order to understand the details of the CPU's functions

Read the H8S/2600 Series, H8S/2000 Series Programming Manual.

• In order to understand the details of a register when its name is known

Read the index that is the final part of the manual to find the page number of the entry on the register. The addresses, bits, and initial values of the registers are summarized in section 27,

List of Registers.

Rules: Register name: The following notation is used for cases when the same or a

similar function, e.g. serial communication interface, is

implemented on more than one channel:

XXX_N (XXX is the register name and N is the channel

number)

Bit order: The MSB is on the left and the LSB is on the right.

Number notation: Binary is B'xxxx, hexadecimal is H'xxxx, decimal is xxxx.

Signal notation: An overbar is added to a low-active signal: \overline{xxxx}

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H8S/2140B Series manuals:

| Manual Title | ADE No. |
|---|-------------|
| H8S/2140B Series Hardware Manual | This manual |
| H8S/2600 Series, H8S/2000 Series Programming Manual | ADE-602-083 |

User's manuals for development tools:

| Manual Title | ADE No. |
|---|-------------|
| H8S, H8/300 Series C/C++ Compiler, Assembler, Optimizing Linkage Editor User's Manual | ADE-702-247 |
| H8S, H8/300 Series Simulator/Debugger User's Manual | ADE-702-282 |
| H8S, H8/300 Series Hitachi Embedded Workshop, Hitachi Debugging Interface Tutorial | ADE-702-231 |
| Hitachi Embedded Workshop User's Manual | ADE-702-201 |

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Section 1 Overview

1.1 Features

 High-speed H8S/2000 central processing unit with an internal 16-bit architecture Upward-compatible with H8/300 and H8/300H CPUs on an object level Sixteen 16-bit general registers

65 basic instructions

• Various peripheral functions

Data transfer controller (DTC)

8-bit PWM timer (PWM)

14-bit PWM timer (PWMX)

16-bit free-running timer (FRT)

8-bit timer (TMR)

Timer connection

Watchdog timer (WDT)

Asynchronous or clocked synchronous serial communication interface (SCI,IrDA)

I²C bus interface (IIC)

Keyboard buffer controller

Host interface X-BUS interface (XBS)

Host interface LPC interface (LPC)

8-bit D/A converter

10-bit A/D converter

Clock pulse generator

• On-chip memory

| ROM | Model | ROM | RAM | Remarks |
|----------------|---------------|------------|----------|----------------------|
| F-ZTAT Version | HD64F2161BV* | 128 kbytes | 4 kbytes | |
| | HD64F2160BV* | 64 kbytes | 4 kbytes | |
| | HD64F2141BV* | 128 kbytes | 4 kbytes | |
| | HD64F2140BV* | 64 kbytes | 4 kbytes | |
| | HD64F2145BV* | 256 kbytes | 8 kbytes | Under development |
| | HD64F2148BV* | 128 kbytes | 4 kbytes | |
| | HD64F2148B | 128 kbytes | 4 kbytes | |
| Masked ROM | HD6432161BV* | 128 kbytes | 4 kbytes | Under |
| Version | HD6432160BV* | 64 kbytes | 4 kbytes | development |
| | HD6432161BVW* | 128 kbytes | 4 kbytes | |
| | HD6432160BVW* | 64 kbytes | 4 kbytes | |

Note:* 3-V version product

• General I/O ports

I/O pins: 74 (H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B)

I/O pins: 114 (H8S/2160B and H8S/2161B)

Input-only pins: 8

• Supports various power-down states

Compact package

| Product | Package | Code | Body Size | Pin Pitch |
|----------------------|-----------|----------|------------------|-----------|
| H8S/2161B, H8S/2160B | TQFP-144 | TFP-144 | 18.0 × 18.0 mm | 0.4 mm |
| H8S/2141B, H8S/2140B | QFP-100B | FP-100B | 16.0 × 16.0 mm | 0.5 mm |
| H8S/2145B, H8S/2148B | TQFP-100B | TFP-100B | | |

1.2 Block Diagram

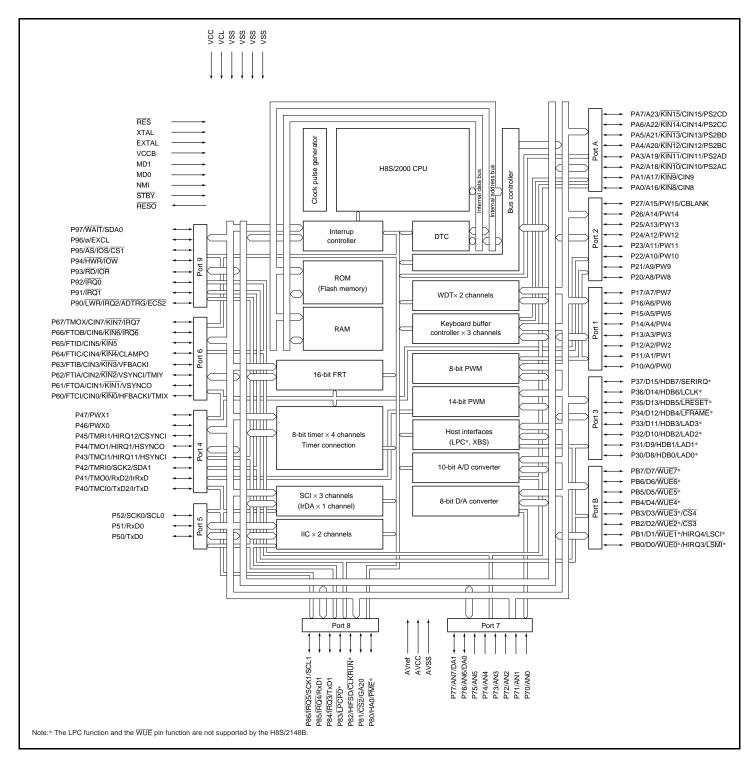


Figure 1.1 Internal Block Diagram of H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B

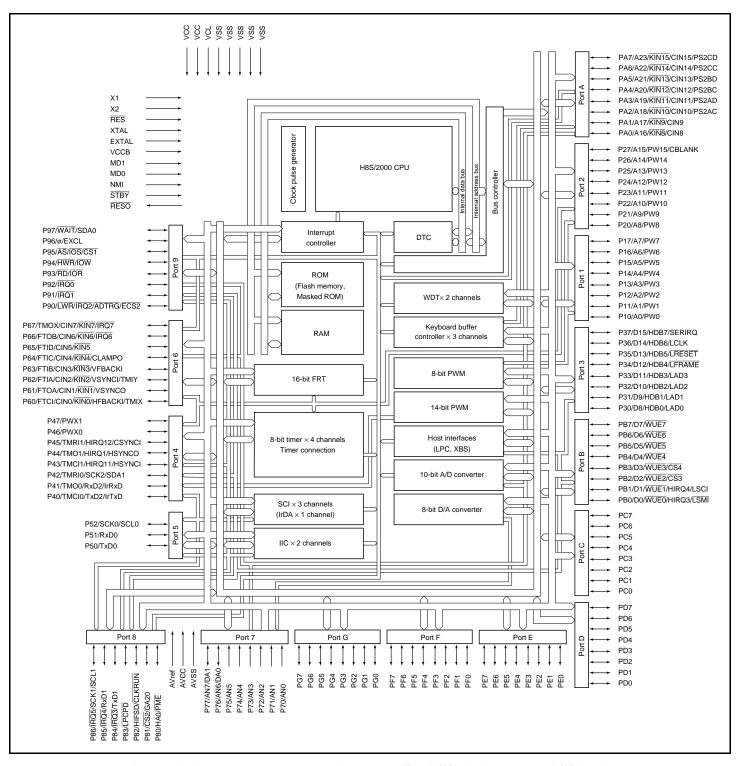


Figure 1.2 Internal Block Diagram of H8S/2160B and H8S/2161B

1.3 Pin Arrangement and Functions

1.3.1 Pin Arrangement

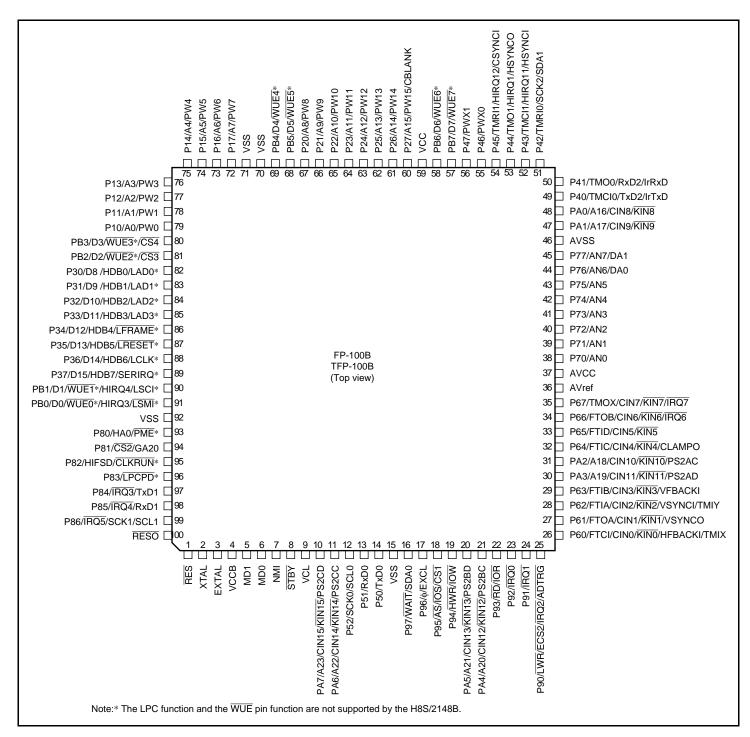


Figure 1.3 Pin Arrangement of H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B

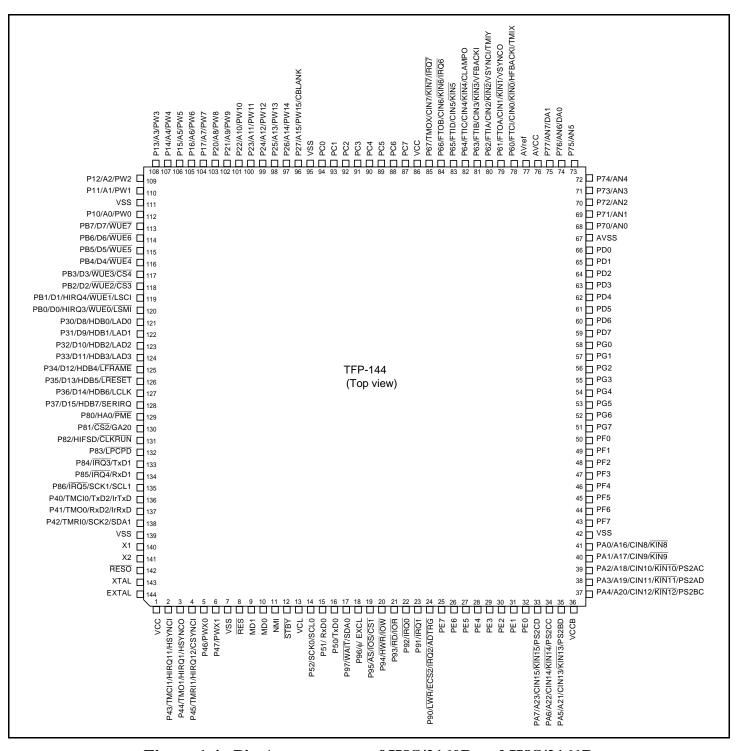


Figure 1.4 Pin Arrangement of H8S/2160B and H8S/2161B

1.3.2 Pin Functions in Each Operating Mode

Table 1.1 Pin Functions of H8S/2141B, H8S/2140B, H8S/2145B, and H8S/2148B in Each Operating Mode

| Pin No. | Extend | ed Modes | Single-Chip Modes | Flash Memory |
|---------------------|---------------------------|-------------------------------|------------------------------|--------------------|
| FP-100B TFP-100B | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 1 | RES | RES | RES | RES |
| 2 | XTAL | XTAL | XTAL | XTAL |
| 3 | EXTAL | EXTAL | EXTAL | EXTAL |
| 4 | VCCB | VCCB | VCCB | VCC |
| 5 | MD1 | MD1 | MD1 | VSS |
| 6 | MD0 | MD0 | MD0 | VSS |
| 7 | NMI | NMI | NMI | FA9 |
| 8 | STBY | STBY | STBY | VCC |
| 9 | VCL | VCL | VCL | VCC |
| 10 (B) | PA7/CIN15/KIN15/ PS2CD | PA7/A23/CIN15/ KIN15/PS2CD | PA7/CIN15/KIN15/ PS2CD | NC |
| 11 (B) | PA6/CIN14/KIN14/ PS2CC | PA6/A22/CIN14/ KIN14/PS2CC | PA6/CIN14/KIN14/ PS2CC | NC |
| 12 (N) | P52/SCK0/SCL0 | P52/SCK0/SCL0 | P52/SCK0/SCL0 | NC |
| 13 | P51/RxD0 | P51/RxD0 | P51/RxD0 | FA17 |
| 14 | P50/TxD0 | P50/TxD0 | P50/TxD0 | NC |
| 15 | VSS | VSS | VSS | VSS |
| 16 (N) | P97/WAIT/SDA0 | P97/WAIT/SDA0 | P97/SDA0 | VCC |
| 17 | P96/ø/EXCL | P96/ø/EXCL | P96/ø/EXCL | NC |
| 18 | AS/IOS | AS/IOS | P95/ CS1 | FA16 |
| 19 | HWR | HWR | P94/ IOW | FA15 |
| 20 (B) | PA5/CIN13/KIN13/ PS2BD | PA5/A21/CIN13/ KIN13/PS2BD | PA5/CIN13/KIN13/ PS2BD | NC |
| 21 (B) | PA4/CIN12/KIN12/ PS2BC | PA4/A20/CIN12/ KIN12/PS2BC | PA4/CIN12/KIN12/ PS2BC | NC |

| Pin No. | Extende | ed Modes | Single-Chip Modes | Flash Memory | |
|---------------------|---|---|---|--------------------|--|
| FP-100B TFP-100B | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode | |
| 22 | RD | RD | P93/IOR | WE | |
| 23 | P92/IRQ0 | P92/IRQ0 | P92/IRQ0 | VSS | |
| 24 | P91/IRQ1 | P91/IRQ1 | P91/IRQ1 | VCC | |
| 25 | P90/LWR/IRQ2/ ADTRG | P90/LWR/IRQ2/ ADTRG | P90/ECS2/IRQ2/ ADTRG | VCC | |
| 26 | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | NC | |
| 27 | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | NC | |
| 28 | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | NC | |
| 29 | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | NC | |
| 30 (B) | PA3/CIN11/KIN11/ PS2AD | PA3/A19/CIN11/ KIN11/PS2AD | PA3/CIN11/KIN11/ PS2AD | NC | |
| 31 (B) | PA2/CIN10/KIN10/ PS2AC | PA2/A18/CIN10/ KIN10/PS2AC | PA2/CIN10/KIN10/ PS2AC | NC | |
| 32 | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | NC | |
| 33 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | P65/FTID/CIN5/ KIN5 | NC | |
| 34 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | NC | |
| 35 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | VSS | |
| 36 | AVref | AVref | AVref | VCC | |
| 37 | AVCC | AVCC | AVCC | VCC | |
| 38 | P70/AN0 | P70/AN0 | P70/AN0 | NC | |
| 39 | P71/AN1 | P71/AN1 | P71/AN1 | NC | |
| 40 | P72/AN2 | P72/AN2 | P72/AN2 | NC | |
| 41 | P73/AN3 | P73/AN3 | P73/AN3 | NC | |

| Pin No. | Extend | ed Modes | Single-Chip Modes | Flash Memory |
|---------------------|--------------------------|------------------------------|------------------------------|--------------------|
| FP-100B TFP-100B | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 42 | P74/AN4 | P74/AN4 | P74/AN4 | NC |
| 43 | P75/AN5 | P75/AN5 | P75/AN5 | NC |
| 44 | P76/AN6/DA0 | P76/AN6/DA0 | P76/AN6/DA0 | NC |
| 45 | P77/AN7/DA1 | P77/AN7/DA1 | P77/AN7/DA1 | NC |
| 46 | AVSS | AVSS | AVSS | VSS |
| 47 (B) | PA1/CIN9/KIN9 | PA1/A17/CIN9/KIN9 | PA1/CIN9/KIN9 | NC |
| 48 (B) | PA0/CIN8/KIN8 | PA0/A16/CIN8/KIN8 | PA0/CIN8/KIN8 | NC |
| 49 | P40/TMCI0/TxD2/ IrTxD | P40/TMCI0/TxD2/ IrTxD | P40/TMCI0/TxD2/ IrTxD | NC |
| 50 | P41/TMO0/RxD2/ IrRxD | P41/TMO0/RxD2/ IrRxD | P41/TMO0/RxD2/ IrRxD | NC |
| 51 (N) | P42/TMRI0/SCK2/ SDA1 | P42/TMRI0/SCK2/ SDA1 | P42/TMRI0/SCK2/ SDA1 | NC |
| 52 | P43/TMCI1/ HSYNCI | P43/TMCI1/ HSYNCI | P43/TMCI1/HIRQ11/ HSYNCI | NC |
| 53 | P44/TMO1/ HSYNCO | P44/TMO1/ HSYNCO | P44/TMO1/HIRQ1/ HSYNCO | NC |
| 54 | P45/TMRI1/ CSYNCI | P45/TMRI1/ CSYNCI | P45/TMRI1/HIRQ12/ CSYNCI | NC |
| 55 | P46/PWX0 | P46/PWX0 | P46/PWX0 | NC |
| 56 | P47/PWX1 | P47/PWX1 | P47/PWX1 | NC |
| 57 | PB7/D7/WUE7* | PB7/D7/WUE7* | PB7/WUE7* | NC |
| 58 | PB6/D6/WUE6* | PB6/D6/WUE6* | PB6/WUE6* | NC |
| 59 | VCC | VCC | VCC | VCC |
| 60 | A15 | P27/A15/PW15/ CBLANK | P27/PW15/ CBLANK | CE |
| 61 | A14 | P26/A14/PW14 | P26/PW14 | FA14 |
| 62 | A13 | P25/A13/PW13 | P25/PW13 | FA13 |
| 63 | A12 | P24/A12/PW12 | P24/PW12 | FA12 |
| 64 | A11 | P23/A11/PW11 | P23/PW11 | FA11 |

| Pin No. | Exten | ded Modes | Single-Chip Modes Flash Me | |
|---------------------|--------------|------------------------------|------------------------------|--------------------|
| FP-100B TFP-100B | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 65 | A10 | P22/A10/PW10 | P22/PW10 | FA10 |
| 66 | A9 | P21/A9/PW9 | P21/PW9 | ŌĒ |
| 67 | A8 | P20/A8/PW8 | P20/PW8 | FA8 |
| 68 | PB5/D5/WUE5* | PB5/D5/WUE5* | PB5/WUE5* | NC |
| 69 | PB4/D4/WUE4* | PB4/D4/WUE4* | PB4/WUE4* | NC |
| 70 | VSS | VSS | VSS | VSS |
| 71 | VSS | VSS | VSS | VSS |
| 72 | A7 | P17/A7/PW7 | P17/PW7 | FA7 |
| 73 | A6 | P16/A6/PW6 | P16/PW6 | FA6 |
| 74 | A5 | P15/A5/PW5 | P15/PW5 | FA5 |
| 75 | A4 | P14/A4/PW4 | P14/PW4 | FA4 |
| 76 | A3 | P13/A3/PW3 | P13/PW3 | FA3 |
| 77 | A2 | P12/A2/PW2 | P12/PW2 | FA2 |
| 78 | A1 | P11/A1/PW1 | P11/PW1 | FA1 |
| 79 | A0 | P10/A0/PW0 | P10/PW0 | FA0 |
| 80 | PB3/D3/WUE3* | PB3/D3/WUE3* | PB3/WUE3*/CS4 | NC |
| 81 | PB2/D2/WUE2* | PB2/D2/WUE2* | PB2/WUE2*/CS3 | NC |
| 82 | D8 | D8 | P30/HDB0/LAD0* | FO0 |
| 83 | D9 | D9 | P31/HDB1/LAD1* | FO1 |
| 84 | D10 | D10 | P32/HDB2/LAD2* | FO2 |
| 85 | D11 | D11 | P33/HDB3/LAD3* | FO3 |
| 86 | D12 | D12 | P34/HDB4/ LFRAME* | FO4 |
| 87 | D13 | D13 | P35/HDB5/ LRESET* | FO5 |
| 88 | D14 | D14 | P36/HDB6/LCLK* | FO6 |
| 89 | D15 | D15 | P37/HDB7/SERIRQ* | FO7 |
| 90 | PB1/D1/WUE1* | PB1/D1/WUE1* | PB1/HIRQ4/WUE1*/ LSCI* | NC |
| 91 | PB0/D0/WUE0* | PB0/D0/WUE0* | PB0/HIRQ3/WUE0*/ LSMI* | NC |

| Pin No. | Extended Modes | | Single-Chip Modes | Flash Memory |
|---------------------|------------------------|------------------------------|------------------------------|--------------------|
| FP-100B TFP-100B | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 92 | VSS | VSS | VSS | VSS |
| 93 | P80 | P80 | P80/HA0/PME* | NC |
| 94 | P81 | P81 | P81/CS2/GA20 | NC |
| 95 | P82 | P82 | P82/HIFSD/ CLKRUN* | NC |
| 96 | P83 | P83 | P83/LPCPD* | NC |
| 97 | P84/IRQ3/TxD1 | P84/IRQ3/TxD1 | P84/IRQ3/TxD1 | NC |
| 98 | P85/IRQ4/RxD1 | P85/IRQ4/RxD1 | P85/IRQ4/RxD1 | NC |
| 99 (N) | P86/ĪRQ5/SCK1/ SCL1 | P86/ĪRQ5/SCK1/ SCL1 | P86/IRQ5/SCK1/ SCL1 | NC |
| 100 | RESO | RESO | RESO | NC |

Note:* The (B) in Pin No. means the VCCB drive and the (N) in Pin No. means the NMOS push-pull/open-drain drive.

^{*:} The LPC function and the $\overline{\text{WUE}}$ pin function are not supported by the H8S/2148B.

Table 1.2 Pin Functions of H8S/2160B and H8S/2161B in Each Operating Mode

| Pin No. TFP-144 | Extended modes | | Single-Chip Modes | Flash Memory |
|-----------------|------------------------|------------------------------|-------------------------------|--------------------|
| | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0)) | Programmer Mode |
| 1 | VCC | VCC | VCC | VCC |
| 2 | P43/TMCI1/ HSYNCI | P43/TMCI1/ HSYNCI | P43/TMCI1/HIRQ11/ HSYNCI | NC |
| 3 | P44/TMO1/ HSYNCO | P44/TMO1/ HSYNCO | P44/TMO1/HIRQ1/ HSYNCO | NC |
| 4 | P45/TMRI1/ CSYNCI | P45/TMRI1/ CSYNCI | P45/TMRI1/HIRQ12/ CSYNCI | NC |
| 5 | P46/PWX0 | P46/PWX0 | P46/PWX0 | NC |
| 6 | P47/PWX1 | P47/PWX1 | P47/PWX1 | NC |
| 7 | VSS | VSS | VSS | VSS |
| 8 | RES | RES | RES | RES |
| 9 | MD1 | MD1 | MD1 | VSS |
| 10 | MD0 | MD0 | MD0 | VSS |
| 11 | NMI | NMI | NMI | FA9 |
| 12 | STBY | STBY | STBY | VCC |
| 13 | VCL | VCL | VCL | VCC |
| 14 (N) | P52/SCK0/SCL0 | P52/SCK0/SCL0 | P52/SCK0/SCL0 | FA18 |
| 15 | P51/RxD0 | P51/RxD0 | P51/RxD0 | FA17 |
| 16 | P50/TxD0 | P50/TxD0 | P50/TxD0 | NC |
| 17 (N) | P97/WAIT/SDA0 | P97/WAIT/SDA0 | P97/SDA0 | VCC |
| 18 | P96/ø/EXCL | P96/ø/EXCL | P96/ø/EXCL | NC |
| 19 | AS/IOS | AS/IOS | P95/ CS1 | FA16 |
| 20 | HWR | HWR | P94/ IOW | FA15 |
| 21 | RD | RD | P93/ IOR | WE |
| 22 | P92/IRQ0 | P92/IRQ0 | P92/IRQ0 | VSS |
| 23 | P91/IRQ1 | P91/IRQ1 | P91/IRQ1 | VCC |
| 24 | P90/LWR/IRQ2/ ADTRG | P90/LWR/IRQ2/ ADTRG | P90/IRQ2/ADTRG/ ECS2 | VCC |
| 25 | PE7 | PE7 | PE7 | NC |

| Pin No. | Extend | ed modes | Single-Chip Modes Flash Me | | |
|---------|---------------------------|-------------------------------|------------------------------|--------------------|--|
| TFP-144 | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode | |
| 26 | PE6 | PE6 | PE6 | NC | |
| 27 | PE5 | PE5 | PE5 | NC | |
| 28 | PE4 | PE4 | PE4 | NC | |
| 29 | PE3 | PE3 | PE3 | NC | |
| 30 | PE2 | PE2 | PE2 | NC | |
| 31 | PE1 | PE1 | PE1 | NC | |
| 32 | PE0 | PE0 | PE0 | NC | |
| 33 (B) | PA7/CIN15/KIN15/ PS2CD | PA7/A23/CIN15/ KIN15/PS2CD | PA7/CIN15/KIN15/ PS2CD | NC | |
| 34 (B) | PA6/CIN14/KIN14/ PS2CC | PA6/A22/CIN14/ KIN14/PS2CC | PA6/CIN14/KIN14/ PS2CC | NC | |
| 35 (B) | PA5/CIN13/KIN13/ PS2BD | PA5/A21/CIN13/ KIN13/PS2BD | PA5/CIN13/KIN13/ PS2BD | NC | |
| 36 | VCCB | VCCB | VCCB | VCC | |
| 37 (B) | PA4/CIN12/KIN12/ PS2BC | PA4/A20/CIN12/ KIN12/PS2BC | PA4/CIN12/KIN12/ PS2BC | NC | |
| 38 (B) | PA3/CIN11/KIN11/ PS2AD | PA3/A19/CIN11/ KIN11/PS2AD | PA3/CIN11/KIN11/ PS2AD | NC | |
| 39 (B) | PA2/CIN10/KIN10/ PS2AC | PA2/A18/CIN10/ KIN10/PS2AC | PA2/CIN10/KIN10/ PS2AC | NC | |
| 40 (B) | PA1/CIN9/KIN9 | PA1/A17/CIN9/KIN9 | PA1/CIN9/KIN9 | NC | |
| 41 (B) | PA0/CIN8/KIN8 | PA0/A16/CIN8/KIN8 | PA0/CIN8/KIN8 | NC | |
| 42 | VSS | VSS | VSS | VSS | |
| 43 | PF7 | PF7 | PF7 | NC | |
| 44 | PF6 | PF6 | PF6 | NC | |
| 45 | PF5 | PF5 | PF5 | NC | |
| 46 | PF4 | PF4 | PF4 | NC | |
| 47 | PF3 | PF3 | PF3 | NC | |
| 48 | PF2 | PF2 | PF2 | NC | |
| 49 | PF1 | PF1 | PF1 | NC | |
| 50 | PF0 | PF0 | PF0 | NC | |

| Pin No. | Exten | ded modes | Single-Chip Modes | Flash Memory |
|---------|---|---|---|--------------------|
| TFP-144 | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 51 (N) | PG7 | PG7 | PG7 | NC |
| 52 (N) | PG6 | PG6 | PG6 | NC |
| 53 (N) | PG5 | PG5 | PG5 | NC |
| 54 (N) | PG4 | PG4 | PG4 | NC |
| 55 (N) | PG3 | PG3 | PG3 | NC |
| 56 (N) | PG2 | PG2 | PG2 | NC |
| 57 (N) | PG1 | PG1 | PG1 | NC |
| 58 (N) | PG0 | PG0 | PG0 | NC |
| 59 | PD7 | PD7 | PD7 | NC |
| 60 | PD6 | PD6 | PD6 | NC |
| 61 | PD5 | PD5 | PD5 | NC |
| 62 | PD4 | PD4 | PD4 | NC |
| 63 | PD3 | PD3 | PD3 | NC |
| 64 | PD2 PD2 | | PD2 | NC |
| 65 | PD1 | PD1 | PD1 | NC |
| 66 | PD0 | PD0 | PD0 | NC |
| 67 | AVSS AVSS AVS | | AVSS | VSS |
| 68 | P70/AN0 | P70/AN0 | P70/AN0 | NC |
| 69 | P71/AN1 | P71/AN1 | P71/AN1 | NC |
| 70 | P72/AN2 | P72/AN2 | P72/AN2 | NC |
| 71 | P73/AN3 | P73/AN3 | P73/AN3 | NC |
| 72 | P74/AN4 | P74/AN4 | P74/AN4 | NC |
| 73 | P75/AN5 | P75/AN5 | P75/AN5 | NC |
| 74 | P76/AN6/DA0 | P76/AN6/DA0 | P76/AN6/DA0 | NC |
| 75 | P77/AN7/DA1 | P77/AN7/DA1 | P77/AN7/DA1 | NC |
| 76 | AVCC | AVCC | AVCC | VCC |
| 77 | AVref | AVref | AVref | VCC |
| 78 | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | P60/FTCI/CIN0/ KIN0/HFBACKI/ TMIX | NC |

| Pin No. | Extende | ed modes | Single-Chip Modes | Flash Memory | |
|---------|------------------------------------|------------------------------------|------------------------------------|--------------------|--|
| TFP-144 | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode | |
| 79 | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | P61/FTOA/CIN1/ KIN1/VSYNCO | NC | |
| 80 | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | P62/FTIA/CIN2/ KIN2/VSYNCI/TMIY | NC | |
| 81 | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | P63/FTIB/CIN3/ KIN3/VFBACKI | NC | |
| 82 | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | P64/FTIC/CIN4/ KIN4/CLAMPO | NC | |
| 83 | P65/FTID/CIN5/KIN5 | P65/FTID/CIN5/KIN5 | P65/FTID/CIN5/KIN5 | NC | |
| 84 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | P66/FTOB/CIN6/ KIN6/IRQ6 | NC | |
| 85 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | P67/TMOX/CIN7/ KIN7/IRQ7 | VSS | |
| 86 | VCC | VCC | VCC | VCC | |
| 87 | PC7 | PC7 | PC7 | NC | |
| 88 | PC6 | PC6 | PC6 | NC | |
| 89 | PC5 | PC5 | PC5 | NC | |
| 90 | PC4 | PC4 | PC4 | NC | |
| 91 | PC3 | PC3 | PC3 | NC | |
| 92 | PC2 | PC2 | PC2 | NC | |
| 93 | PC1 | PC1 | PC1 | NC | |
| 94 | PC0 | PC0 | PC0 | NC | |
| 95 | VSS | VSS | VSS | VSS | |
| 96 | A15 | P27/A15/PW15/ CBLANK | P27/PW15/CBLANK | CE | |
| 97 | A14 | P26/A14/PW14 | P26/PW14 | FA14 | |
| 98 | A13 | P25/A13/PW13 | P25/PW13 | FA13 | |
| 99 | A12 | P24/A12/PW12 | P24/PW12 | FA12 | |
| 100 | A11 | P23/A11/PW11 | P23/PW11 | FA11 | |
| 101 | A10 | P22/A10/PW10 | P22/PW10 | FA10 | |

| Pin No. | Exten | ided modes | Single-Chip Modes | Flash Memory |
|---------|-------------|------------------------------|------------------------------|--------------------|
| TFP-144 | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 102 | A9 | P21/A9/PW9 | P21/PW9 | ŌĒ |
| 103 | A8 | P20/A8/PW8 | P20/PW8 | FA8 |
| 104 | A7 | P17/A7/PW7 | P17/PW7 | FA7 |
| 105 | A6 | P16/A6/PW6 | P16/PW6 | FA6 |
| 106 | A5 | P15/A5/PW5 | P15/PW5 | FA5 |
| 107 | A4 | P14/A4/PW4 | P14/PW4 | FA4 |
| 108 | A3 | P13/A3/PW3 | P13/PW3 | FA3 |
| 109 | A2 | P12/A2/PW2 | P12/PW2 | FA2 |
| 110 | A1 | P11/A1/PW1 | P11/PW1 | FA1 |
| 111 | VSS | VSS | VSS | VSS |
| 112 | A0 | P10/A0/PW0 | P10/PW0 | FA0 |
| 113 | PB7/D7/WUE7 | PB7/D7/WUE7 | PB7/WUE7 | NC |
| 114 | PB6/D6/WUE6 | PB6/D6/WUE6 | PB6/WUE6 | NC |
| 115 | PB5/D5/WUE5 | PB5/D5/WUE5 | PB5/WUE5 | NC |
| 116 | PB4/D4/WUE4 | PB4/D4/WUE4 | PB4/WUE4 | NC |
| 117 | PB3/D3/WUE3 | PB3/D3/WUE3 | PB3/WUE3/CS4 | NC |
| 118 | PB2/D2/WUE2 | PB2/D2/WUE2 | PB2/WUE2/CS3 | NC |
| 119 | PB1/D1/WUE1 | PB1/D1/WUE1 | PB1/HIRQ4/WUE1/ LSCI | NC |
| 120 | PB0/D0/WUE0 | PB0/D0/WUE0 | PB0/HIRQ3/WUE0/ LSMI | NC |
| 121 | D8 | D8 | P30/HDB0/LAD0 | FO0 |
| 122 | D9 | D9 | P31/HDB1/LAD1 | FO1 |
| 123 | D10 | D10 | P32/HDB2/LAD2 | FO2 |
| 124 | D11 | D11 | P33/HDB3/LAD3 | FO3 |
| 125 | D12 | D12 | P34/HDB4/LFRAME | FO4 |
| 126 | D13 | D13 | P35/HDB5/LRESET | FO5 |
| 127 | D14 | D14 | P36/HDB6/LCLK | FO6 |
| 128 | D15 | D15 | P37/HDB7/SERIRQ | FO7 |
| 129 | P80 | P80 | P80/HA0/PME | NC |

| Pin No. | Extend | ed modes | Single-Chip Modes | Flash Memory |
|---------|--------------------------|------------------------------|------------------------------|--------------------|
| TFP-144 | Mode 1 | Mode 2, Mode 3 (EXPE = 1) | Mode 2, Mode 3 (EXPE = 0) | Programmer Mode |
| 130 | P81 | P81 | P81/CS2/GA20 | NC |
| 131 | P82 | P82 | P82/HIFSD/ CLKRUN | NC |
| 132 | P83 | P83 | P83/LPCPD | NC |
| 133 | P84/IRQ3/TxD1 | P84/IRQ3/TxD1 | P84/IRQ3/TxD1 | NC |
| 134 | P85/IRQ4/RxD1 | P85/IRQ4/RxD1 | P85/IRQ4/RxD1 | NC |
| 135 (N) | P86/ĪRQ5/SCK1/ SCL1 | P86/IRQ5/SCK1/ SCL1 | P86/IRQ5/SCK1/ SCL1 | NC |
| 136 | P40/TMCI0/TxD2/ IrTxD | P40/TMCI0/TxD2/ IrTxD | P40/TMCI0/TxD2/ IrTxD | NC |
| 137 | P41/TMO0/RxD2/ IrRxD | P41/TMO0/RxD2/ IrRxD | P41/TMO0/RxD2/ IrRxD | NC |
| 138 (N) | P42/TMRI0/SCK2/ SDA1 | P42/TMRI0/SCK2/ SDA1 | P42/TMRI0/SCK2/ SDA1 | NC |
| 139 | VSS | VSS | VSS | VSS |
| 140 | X1 | X1 | X1 | NC |
| 141 | X2 | X2 | X2 | NC |
| 142 | RESO | RESO | RESO | NC |
| 143 | XTAL | XTAL | XTAL | XTAL |
| 144 | EXTAL | EXTAL | EXTAL | EXTAL |

Note:* The (B) in Pin No. means the VCCB drive and the (N) in Pin No. means the NMOS push-pull/open-drain drive.

1.3.3 Pin Functions

Table 1.3 Pin Functions

Pin No.

| | | | _ | | | |
|------------------------|------------|----------------------|------------------------|--------|---|--|
| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | I/O | Name and Function | |
| Power | VCC | 59 | 1, 86 | Input | Power supply pin. Connect the pin to the system power supply. | |
| | VCL | 9 | 13 | Input | Power supply pin. Connect the pin to VCC. | |
| | VCCB | 4 | 36 | Input | The power supply for the port A input/output buffer. | |
| | VSS | 15, 70, 71, 92 | 7, 42, 95, 111, 139 | Input | Ground pin. Connect to the system power supply (0 V). | |
| Clock | XTAL | 2 | 143 | Input | Pins for connection to crystal resonators. | |
| Ī | EXTAL | 3 | 144 | Input | The EXTAL pin can also input an external clock. | |
| | | | | | See section 25, Clock Pulse Generator, for typical connection diagrams. | |
| | Ø | 17 | 18 | Output | Supplies the system clock to external devices. | |
| | EXCL | 17 | 18 | Input | Input a 32.768 kHz external subclock. | |
| | X1 | _ | 140 | Input | Leave open. | |
| | X2 | _ | 141 | Input | Leave open. | |
| Operating mode control | MD1 MD0 | 5 6 | 9 10 | Input | These pins set the operating mode. These pins should not be changed while the MCU is operating. | |
| System | RES | 1 | 8 | Input | Reset pin. | |
| control | | | | | When this pin becomes low, the chip is reset. | |
| | RESO | 100 | 142 | Output | Outputs reset signal to external device. | |
| | STBY | 8 | 12 | Input | When this pin is driven low, a transition is made to hardware standby mode. | |

| | | Pin | No. | | |
|----------------------|-----------------|--------------------------------------|---|------------------|--|
| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | 1/0 | Name and Function |
| Address bus | A23 to A16 | 10, 11, 20, 21, 30, 31, 47, 48 | 33, 34, 35, 37, 38, 39, 40, 41 | Output | Address output pins when 16-Mbyte space is used. |
| - | A15 to A0 | 60 to 67, 72 to 79 | 96 to 110, 112 | Output | Address output pins |
| Data bus | D15 to D8 | 89 to 82 | 128 to 121 | Input/ output | Bidirectional data bus for upper byte of 16-bit data. |
| | D7 to D0 | 57, 58, 68, 69, 80, 81, 90, 91 | 113 to 120 | Input/ output | Bidirectional data bus for lower byte of 16-bit data. |
| Bus control | WAIT | 16 | 17 | Input | Requests insertion of a wait state in the bus cycle when accessing external 3-state address space. |
| - | RD | 22 | 21 | Output | When this pin is low, it indicates that the external address space is being read. |
| - | HWR | 19 | 20 | Output | When this pin is low, it indicates that the external address space is being written to. The upper half of the data bus is valid. |
| - | LWR | 25 | 24 | Output | When this pin is low, it indicates that the external address space is being written to. The lower half of the data bus is valid. |
| - | AS/IOS | 18 | 19 | Output | When this pin is low, it indicates that address output on the address bus is valid. |
| Interrupt signals | NMI | 7 | 11 | Input | Input pin for a nonmaskable interrupt request. |
| - | IRQ0 to IRQ7 | 23 to 25, 97 to 99, 34, 35 | 22 to 24, 133 to 135, 84, 85 | Input | These pins request a maskable interrupt. |
| | FTCI | 26 | 78 | Input | The counter clock input pin. |
| free- running | FTOA | 27 | 79 | Output | The output compare A output pin. |
| timer | FTOB | 34 | 84 | Output | The output compare B output pin. |
| (FRT) | FTIA | 28 | 80 | Input | The input capture A input pin. |

| P | in | N | 0 |
|---|----|---|---|
| | | | |

| | Pin No. | | _ | | |
|--|----------------------|-----------------------|-------------------|------------------|---|
| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | I/O | Name and Function |
| 16-bit | FTIB | 29 | 81 | Input | The input capture B input pin. |
| free- running | FTIC | 32 | 82 | Input | The input capture C input pin. |
| timer (FRT) | FTID | 33 | 83 | Input | The input capture D input pin. |
| 8-bit timer (TMR_0, TMR_1, | TMO0 TMO1 TMOX | 50 53 35 | 137 3 85 | Output | The waveform output pins for the output compare function. |
| TMR_X) | TMCI0 TMCI1 | 49 52 | 136 2 | Input | Input pins for the external clock input to counters. |
| | TMRI0 TMRI1 | 51 54 | 138 4 | Input | The counter reset input pins. |
| 8-bit timer (TMR_X, TMR_Y) | TMIX TMIY | 26 28 | 78 80 | Input | The counter event input and counter reset input pins. |
| 8-bit PWM timer (PWM) | PW15 to PW0 | 60 to 67, 72 to 79 | 96 to 110, 112 | Output | PWM timer pulse output pins. |
| 14-bit PWM timer (PWMX) | PWX0 PWX1 | 55 56 | 5 6 | Output | PWM D/A pulse output pins. |
| Serial communication | TxD0 TxD1 TxD2 | 14 97 49 | 16 133 136 | Output | Transmit data output pins. |
| interface (SCI_0, SCI_1, SCI_2) | RxD0 RxD1 RxD2 | 13 98 50 | 15 134 137 | Input | Receive data input pins. |
| · <u>-</u> - · | SCK0 SCK1 SCK2 | 12 99 51 | 14 135 138 | Input/ Output | Clock input/output pins. The output type is NMOS push-pull. |
| SCI with IrDA (SCI_2) | IrTxD IrRxD | 49 50 | 136 137 | Output Input | Input and output pins for data encoded for IrDA use. |

Pin No.

| Type Symbol FP-100B, TFP-100B TF Keyboard PS2AC 31 39 |) | I/O | Name and Function |
|---|-------------------------|------------------|---|
| Keyboard PS2AC 31 39 | | | |
| buffer PS2BC 21 37 controller PS2CC 11 34 | | Input/ Output | Keyboard buffer controller synchronization clock input/output pins. |
| PS2AD 30 38 PS2BD 20 35 PS2CD 10 33 | ; | Input/ Output | Keyboard buffer controller data input/output pins. |
| interface HDB0 12 | 28 to 21 | Input/ Output | Bidirectional 8-bit bus for accessing XBS. |
| |), 130, ., 118, 7 | Input | Input pins for selecting XBS channels 1 to 4. The $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ input pin is selected with the system control register. |
| ĪŌR 22 21 | | Input | Input pin that enables reading from XBS. |
| IOW 19 20 |) | Input | Input pin that enables writing to XBS. |
| HA0 93 12 | .9 | Input | Input pin that indicates whether an access is a data access or command access. |
| GA20 94 13 | 80 | Output | A20 gate control signal output pin. |
| HIRQ11 52 2 HIRQ1 53 3 HIRQ12 54 4 HIRQ3 91 12 HIRQ4 90 11 | | Output | Output pins for interrupt requests to the host. |
| HIFSD 95 13 | 31 | Input | Control input pin used to place XBS input/output pins in the high-impedance/ cutoff state. |
| interface LAD0 12 | 24 to 21 | Input/ Output | LPC command, address, and data input/output pins. |
| (LPC) LFRAME 86 12 | 25 | Input | Input pin that indicates the start of an LPC cycle or forced termination of an abnormal LPC cycle. |
| LRESET 87 12 | 26 | Input | Input pin that indicates an LPC reset. |
| LCLK 88 12 | 27 | Input | The LPC clock input pin. |

| P | in | N | 0 |
|---|----|---|---|
| | | | |

| Pin No. | | _ | | | |
|----------------------------------|--------------------|--|------------------------------------|------------------|---|
| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | I/O | Name and Function |
| Host interface (LPC) | SERIRQ | 89 | 128 | Input/ Output | Input/output pin for LPC serialized host interrupts (HIRQ1, SMI, HIRQ6, HIRQ9 to HIRQ12). |
| | LSCI, LSMI, PME | 90, 91, 93 | 119, 120, 129 | Input/ Output | LPC auxiliary output pins. Functionally, they are general I/O ports. |
| | GA20 | 94 | 130 | Input/ Output | A20 gate control signal output pin. Output state monitoring input is possible. |
| | CLKRUN | 95 | 131 | Input/ Output | Input/output pin that requests the start of LCLK operation when LCLK is stopped. |
| | LPCPD | 96 | 132 | Input | Input pin that controls LPC module shutdown. |
| Keyboard buffer controller | KINO to KIN15 | 26 to 29, 32 to 35, 48, 47, 31, 30, 21, 20, 11, 10 | 78 to 85, 41 to 37, 35 to 33 | Input | Matrix keyboard input pins. KINO to KIN15 are used as key-scan inputs, and P10 to P17 and P20 to P27 are used as key-scan outputs. This allows a maximum 16-output × 16-input, 256-key matrix to be configured. |
| | WUE0 to WUE7 | 91, 90, 81, 80, 69, 68, 58, 57 | 120 to 113 | Input | Wakeup event input pins. These pins allow the same kind of wakeup as key-wakeup from various sources. |
| A/D converter | AN7 to AN0 | 45 to 38 | 68 to 75 | Input | Analog input pins. |
| | CIN0 to CIN15 | 26 to 29, 32 to 35, 48, 47, 31, 30, 21, 20, 11, 10 | 78 to 85, 41 to 37, 35 to 33 | Input | A/D conversion input pins, but since they are also used as digital input/output pins, accuracy will fall. |
| | ADTRG | 25 | 24 | Input | Pin for input of an external trigger to start A/D conversion. |
| D/A converter | DA0 DA1 | 44 45 | 74 75 | Output | Analog output pins. |

| P | in | N | 0 | |
|---|----|---|---|--|
| | | | | |

| | | FP-100B, | | - | |
|----------------------|---------|-----------|---------|--------|--|
| Туре | Symbol | TFP-100B, | TFP-144 | I/O | Name and Function |
| A/D converter | AVCC | 37 | 76 | Input | The analog power supply pin for the A/D converter and D/A converter. |
| D/A converter | | | | | When the A/D and D/A converters are not used, this pin should be connected to the system power supply (+3 V). |
| , | AVref | 36 | 77 | Input | The reference power supply pin for the A/D converter and D/A converter. |
| | | | | | When the A/D and D/A converters are not used, this pin should be connected to the system power supply (+3 V). |
| | AVSS | 46 | 67 | Input | The ground pin for the A/D converter and D/A converter. This pin should be connected to the system power supply (0 V). |
| Timer | VSYNCI | 28 | 80 | Input | Timer connection synchronous signal input |
| connec- | HSYNCI | 52 | 2 | · | pins. |
| tion | CSYNCI | 54 | 4 | | |
| , | VFBACKI | 29 | 81 | | |
| | HFBACKI | 26 | 78 | | |
| - , | VSYNCO | 27 | 79 | Output | Timer connection synchronous signal |
| | HSYNCO | 53 | 3 | • | output pins. |
| 1 | CLAMPO | 32 | 82 | | |
| ļ | CBLANK | 60 | 96 | | |
| I ² C bus | SCL0 | 12 | 14 | Input/ | I ² C clock I/O pins. The output type is |
| | SCL1 | 99 | 135 | Output | NMOS open-drain output. |
| (IIC) | SDA0 | 16 | 17 | Input/ | I ² C data I/O pins. The output type is NMOS |
| | SDA1 | 51 | 138 | Output | open-drain output. |

| | | _ |
|------|------|---|
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| | | |

| | | | | _ | | |
|-----------|---------------|--------------------------------------|--------------------|------------------|--|--|
| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | I/O | Name and Function | |
| I/O ports | P17 to P10 | 72 to 79 | 104 to 110, 112 | Input/ Output | Eight input/output pins. | |
| | P27 to P20 | 60 to 67 | 96 to 103 | Input/ Output | Eight input/output pins. | |
| | P37 to P30 | 89 to 82 | 128 to 121 | Input/ Output | Eight input/output pins. | |
| | P47 to P40 | 56 to 49 | 6 to 2, | Input/ | Eight input/output pins. | |
| | | | 138 to 136 | Output | (The output type of P42 is NMOS pushpull.) | |
| | P52 to P50 | 12 to 14 | 14 to 16 | Input/ Output | Three input/output pins. | |
| | | | | | (The output type of P52 is NMOS pushpull.) | |
| | P67 to P60 | 35 to 32 29 to 26 | 85 to 78 | Input/ Output | Eight input/output pins. | |
| | P77 to P70 | 45 to 38 | 75 to 68 | Input | Eight input pins. | |
| | P86 to P80 | 99 to 93 | 135 to | Input/ | Seven input/output pins. | |
| | | | 129 | Output | (The output type of P86 is NMOS pushpull.) | |
| | P97 to P90 | 16 to 19 22 to 25 | 17 to 24 | Input/ Output | Eight input/output pins. | |
| | | | | | (The output type of P97 is NMOS pushpull.) | |
| | PA7 to PA0 | 10, 11, 20, 21, 30, 31, 47, 48 | | Input/ Output | Eight input/output pins. | |
| | PB7 to PB0 | 57, 58, 68, 69, 80, 81, 90, 91 | | Input/ Output | Eight input/output pins. | |
| | PC7 to PC0 | | 87 to 94 | Input/ Output | Eight input/output pins. | |
| | PD7 to PD0 | _ | 59 to 66 | Input/ Output | Eight input/output pins. | |
| | PE7 to PE0 | _ | 25 to 32 | Input/ Output | Eight input/output pins. | |

Pin No.

| Туре | Symbol | FP-100B, TFP-100B | TFP-144 | I/O | Name and Function |
|-----------|------------|----------------------|----------|------------------|---|
| I/O ports | PF7 to PF0 | _ | 43 to 50 | Input/ Output | Eight input/output pins. |
| | PG7 to | _ | 51 to 58 | Input/ | Eight input/output pins. |
| | PG0 | | | Output | (The output type of PG7 to PG0 in the H8S/2160B and the H8S/2161B is NMOS push-pull.) |

Section 2 CPU

The H8S/2000 CPU is a high-speed central processing unit with an internal 32-bit architecture that is upward-compatible with the H8/300 and H8/300H CPUs. The H8S/2000 CPU has sixteen 16-bit general registers, can address a 16-Mbyte linear address space, and is ideal for realtime control.

This section describes the H8S/2000 CPU. The usable modes and address spaces differ depending on the product. For details on each product, refer to section 3, MCU Operating Modes.

2.1 Features

- Upward-compatibility with H8/300 and H8/300H CPUs
 Can execute H8/300 CPU and H8/300H CPU object programs
- General-register architecture

Sixteen 16-bit general registers also usable as sixteen 8-bit registers or eight 32-bit registers

• Sixty-five basic instructions

8/16/32-bit arithmetic and logic instructions

Multiply and divide instructions

Powerful bit-manipulation instructions

• Eight addressing modes

Register direct [Rn]

Register indirect [@ERn]

Register indirect with displacement [@(d:16,ERn) or @(d:32,ERn)]

Register indirect with post-increment or pre-decrement [@ERn+ or @-ERn]

Absolute address [@aa:8, @aa:16, @aa:24, or @aa:32]

Immediate [#xx:8, #xx:16, or #xx:32]

Program-counter relative [@(d:8,PC) or @(d:16,PC)]

Memory indirect [@@aa:8]

• 16-Mbyte address space

Program: 16 Mbytes

Data: 16 Mbytes

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High-speed operation

All frequently-used instructions are executed in one or two states

8/16/32-bit register-register add/subtract: 1 state

 8×8 -bit register-register multiply: 12 states (MULXU.B), 13 states (MULXS.B)

16 ÷ 8-bit register-register divide: 12 states (DIVXU.B)

 16×16 -bit register-register multiply: 20 states (MULXU.W), 21 states (MULXS.W)

32 ÷ 16-bit register-register divide: 20 states (DIVXU.W)

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Two CPU operating modes

Normal mode

Advanced mode

Power-down state

Transition to power-down state by SLEEP instruction Selectable CPU clock speed

2.1.1 Differences between H8S/2600 CPU and H8S/2000 CPU

The differences between the H8S/2600 CPU and the H8S/2000 CPU are as shown below.

- Register configuration
 - The MAC register is supported only by the H8S/2600 CPU.
- Basic instructions

The four instructions MAC, CLRMAC, LDMAC, and STMAC are supported only by the H8S/2600 CPU.

• The number of execution states of the MULXU and MULXS instructions

| | | Execution States | | | | |
|-------------|-----------------|------------------|----------|--|--|--|
| Instruction | Mnemonic | H8S/2600 | H8S/2000 | | | |
| MULXU | MULXU.B Rs, Rd | 3 | 12 | | | |
| | MULXU.W Rs, ERd | 4 | 20 | | | |
| MULXS | MULXS.B Rs, Rd | 4 | 13 | | | |
| | MULXS.W Rs, ERd | 5 | 21 | | | |

Execution States

In addition, there are differences in address space, CCR and EXR register functions, power-down modes, etc., depending on the model.

2.1.2 Differences from H8/300 CPU

In comparison to the H8/300 CPU, the H8S/2000 CPU has the following enhancements.

- More general registers and control registers
 Eight 16-bit extended registers and one 8-bit control register have been added.
- Expanded address space

Normal mode supports the same 64-kbyte address space as the H8/300 CPU.

Advanced mode supports a maximum 16-Mbyte address space.

Enhanced addressing

The addressing modes have been enhanced to make effective use of the 16-Mbyte address space.

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Enhanced instructions

Addressing modes of bit-manipulation instructions have been enhanced.

Signed multiply and divide instructions have been added.

Two-bit shift and two-bit rotate instructions have been added.

Instructions for saving and restoring multiple registers have been added.

A test and set instruction has been added.

• Higher speed

Basic instructions are executed twice as fast.

2.1.3 Differences from H8/300H CPU

In comparison to the H8/300H CPU, the H8S/2000 CPU has the following enhancements.

• Additional control register

One 8-bit control register has been added.

• Enhanced instructions

Addressing modes of bit-manipulation instructions have been enhanced.

Two-bit shift and two-bit rotate instructions have been added.

Instructions for saving and restoring multiple registers have been added.

A test and set instruction has been added.

• Higher speed

Basic instructions are executed twice as fast.

2.2 **CPU Operating Modes**

The H8S/2000 CPU has two operating modes: normal and advanced. Normal mode supports a maximum 64-kbyte address space. Advanced mode supports a maximum 16-Mbyte address space. The mode is selected by the LSI's mode pins.

2.2.1 Normal Mode

The exception vector table and stack have the same structure as in the H8/300 CPU in normal mode.

- Address space
 - Linear access to a maximum address space of 64 kbytes is possible.
- Extended registers (En)
 - The extended registers (E0 to E7) can be used as 16-bit registers, or as the upper 16-bit segments of 32-bit registers.
 - When extended register En is used as a 16-bit register it can contain any value, even when the corresponding general register (Rn) is used as an address register. (If general register Rn is referenced in the register indirect addressing mode with pre-decrement (@-Rn) or post-increment (@Rn+) and a carry or borrow occurs, the value in the corresponding extended register (En) will be affected.)
- Instruction set
 - All instructions and addressing modes can be used. Only the lower 16 bits of effective addresses (EA) are valid.
- Exception vector table and memory indirect branch addresses
 - In normal mode, the top area starting at H'0000 is allocated to the exception vector table. One branch address is stored per 16 bits. The exception vector table in normal mode is shown in figure 2.1. For details on the exception vector table, see section 4, Exception Handling. The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In normal mode, the operand is a 16-bit (word) operand, providing a 16-bit branch address. Branch addresses can be stored in the top area from H'0000 to H'00FF. Note that this area is also used for the exception vector table.
- Stack structure
 - In normal mode, when the program counter (PC) is pushed onto the stack in a subroutine call in normal mode, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.2. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

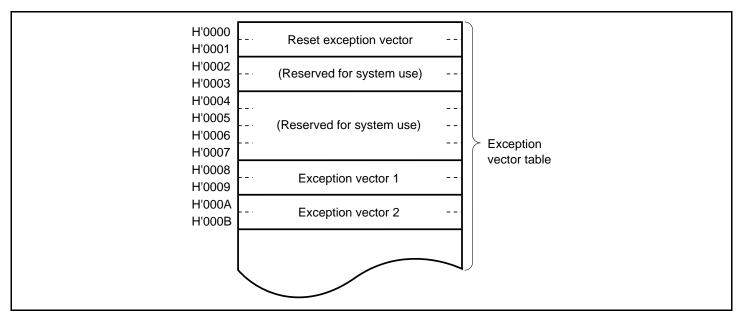


Figure 2.1 Exception Vector Table (Normal Mode)

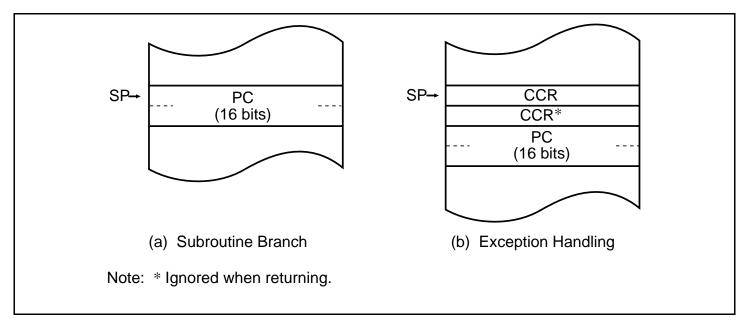


Figure 2.2 Stack Structure in Normal Mode

2.2.2 Advanced Mode

• Address space

Linear access to a maximum address space of 16 Mbytes is possible.

• Extended registers (En)

The extended registers (E0 to E7) can be used as 16-bit registers. They can also be used as the upper 16-bit segments of 32-bit registers or address registers.

• Instruction set

All instructions and addressing modes can be used.

• Exception vector table and memory indirect branch addresses
In advanced mode, the top area starting at H'00000000 is allocated to the exception vector table in 32-bit units. In each 32 bits, the upper 8 bits are ignored and a branch address is stored in the lower 24 bits (see figure 2.3). For details on the exception vector table, see section 4, Exception Handling.

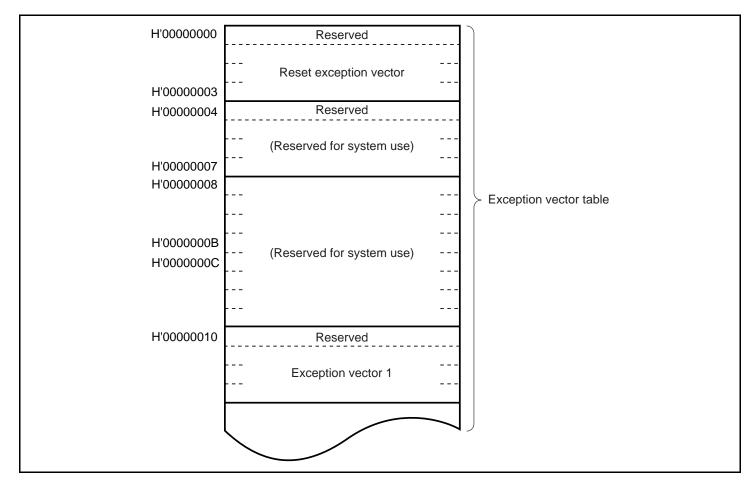


Figure 2.3 Exception Vector Table (Advanced Mode)

The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In advanced mode, the operand is a 32-bit longword operand, providing a 32-bit branch address. The upper 8 bits of these 32 bits are a reserved area that is regarded as H'00. Branch addresses can be stored in the area from H'000000000 to H'000000FF. Note that the top area of this range is also used for the exception vector table.

Stack structure

In advanced mode, when the program counter (PC) is pushed onto the stack in a subroutine call, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.4. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

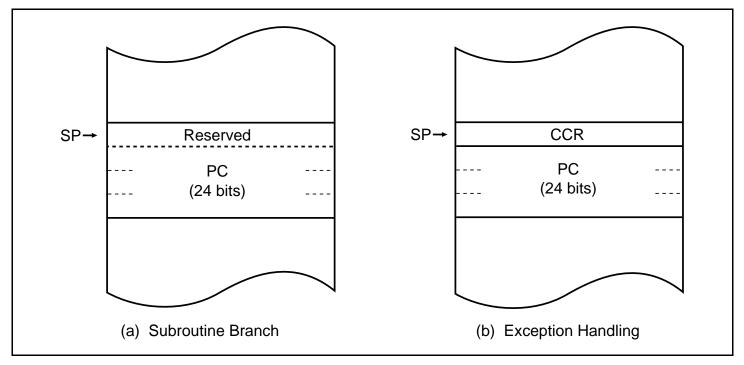


Figure 2.4 Stack Structure in Advanced Mode

2.3 Address Space

Figure 2.5 shows a memory map of the H8S/2000 CPU. The H8S/2000 CPU provides linear access to a maximum 64-kbyte address space in normal mode, and a maximum 16-Mbyte (architecturally 4-Gbyte) address space in advanced mode. The usable modes and address spaces differ depending on the product. For details on each product, refer to section 3, MCU Operating Modes.

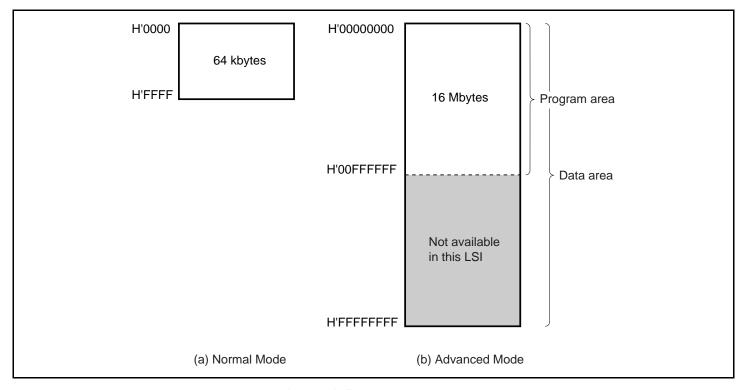


Figure 2.5 Memory Map

2.4 Register Configuration

The H8S/2000 CPU has the internal registers shown in figure 2.6. There are two types of registers: general registers and control registers. Control registers are a 24-bit program counter (PC), an 8-bit extended control register (EXR), and an 8-bit condition code register (CCR).

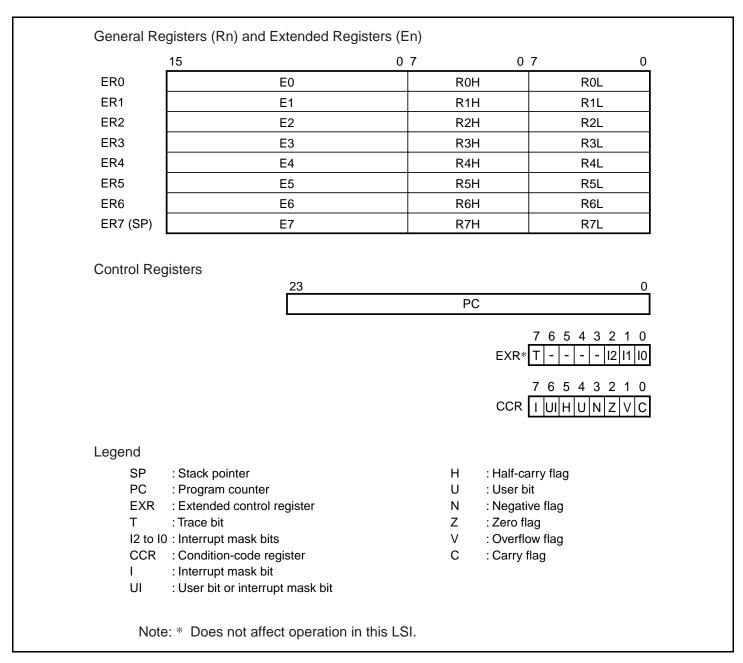


Figure 2.6 CPU Internal Registers

2.4.1 General Registers

The H8S/2000 CPU has eight 32-bit general registers. These general registers are all functionally alike and can be used as both address registers and data registers. When a general register is used as a data register, it can be accessed as a 32-bit, 16-bit, or 8-bit register. Figure 2.7 illustrates the usage of the general registers.

When the general registers are used as 32-bit registers or address registers, they are designated by the letters ER (ER0 to ER7).

When the general registers are used as 16-bit registers, the ER registers are divided into 16-bit general registers designated by the letters E (E0 to E7) and R (R0 to R7). These registers are functionally equivalent, providing a maximum sixteen 16-bit registers. The E registers (E0 to E7) are also referred to as extended registers.

When the general registers are used as 8-bit registers, the R registers are divided into 8-bit general registers designated by the letters RH (R0H to R7H) and RL (R0L to R7L). These registers are functionally equivalent, providing a maximum sixteen 8-bit registers.

The usage of each register can be selected independently.

General register ER7 has the function of the stack pointer (SP) in addition to its general-register function, and is used implicitly in exception handling and subroutine calls. Figure 2.8 shows the stack.

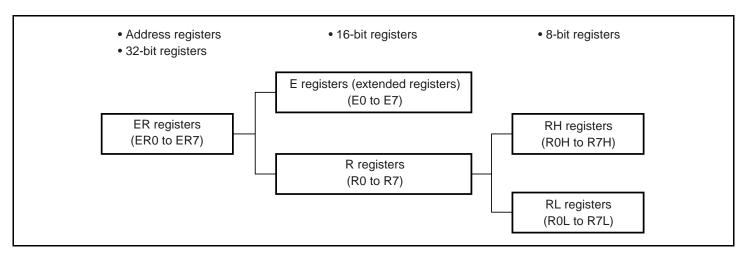


Figure 2.7 Usage of General Registers

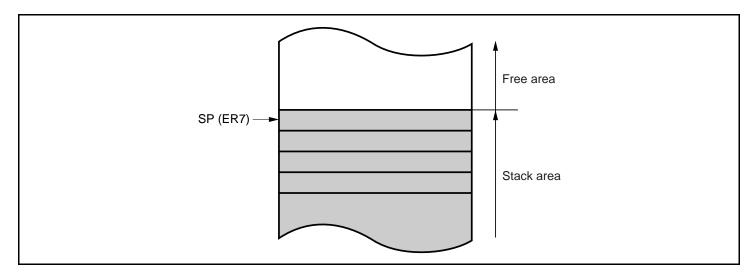


Figure 2.8 Stack

2.4.2 Program Counter (PC)

This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. (When an instruction is fetched for read, the least significant PC bit is regarded as 0.)

2.4.3 Extended Control Register (EXR)

EXR does not affect operation in this LSI.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|------------|---------------|-----|--|
| 7 | Т | 0 | R/W | Trace Bit |
| | | | | Does not affect operation in this LSI. |
| 6 to 3 | _ | All 1 | R | Reserved |
| | | | | These bits are always read as 1. |
| 2 to 0 | 12 | All 1 | R/W | Interrupt Mask Bits 2 to 0 |
| | I 1 | | | Do not affect operation in this LSI. |
| | 10 | | | |

2.4.4 Condition-Code Register (CCR)

This 8-bit register contains internal CPU status information, including an interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags. Operations can be performed on the CCR bits by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used as branching conditions for conditional branch (Bcc) instructions.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | I | 1 | R/W | Interrupt Mask Bit |
| | | | | Masks interrupts other than NMI when set to 1. NMI is accepted regardless of the I bit setting. The I bit is set to 1 at the start of an exception-handling sequence. For details, refer to section 5, Interrupt Controller. |
| 6 | UI | Undefined | R/W | User Bit or Interrupt Mask Bit |
| | | | | Can be written to and read from by software using the LDC, STC, ANDC, ORC, and XORC instructions. |
| 5 | Н | Undefined | R/W | Half-Carry Flag |
| | | | | When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise. |
| 4 | U | Undefined | R/W | User Bit |
| | | | | Can be written to and read from by software using the LDC, STC, ANDC, ORC, and XORC instructions. |
| 3 | N | Undefined | R/W | Negative Flag |
| | | | | Stores the value of the most significant bit of data as a sign bit. |
| 2 | Z | Undefined | R/W | Zero Flag |
| | | | | Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data. |
| 1 | V | Undefined | R/W | Overflow Flag |
| | | | | Set to 1 when an arithmetic overflow occurs, and cleared to 0 otherwise. |
| 0 | С | Undefined | R/W | Carry Flag |
| | | | | Set to 1 when a carry occurs, and cleared to 0 otherwise. Used by |
| | | | | Add instructions, to indicate a carry |
| | | | | Subtract instructions, to indicate a borrow |
| | | | | Shift and rotate instructions, to indicate a carry |
| | | | | The carry flag is also used as a bit accumulator by bit manipulation instructions. |
| | | | | |

2.4.5 Initial Register Values

The program counter (PC) among CPU internal registers is initialized when reset exception handling loads a start address from a vector table. The trace (T) bit in EXR is cleared to 0, and the interrupt mask (I) bits in CCR and EXR are set to 1. The other CCR bits and the general registers are not initialized. Note that the stack pointer (ER7) is undefined. The stack pointer should therefore be initialized by an MOV.L instruction executed immediately after a reset.

2.5 Data Formats

The H8S/2000 CPU can process 1-bit, 4-bit BCD, 8-bit (byte), 16-bit (word), and 32-bit (longword) data. Bit-manipulation instructions operate on 1-bit data by accessing bit n (n = 0, 1, 2, ..., 7) of byte operand data. The DAA and DAS decimal-adjust instructions treat byte data as two digits of 4-bit BCD data.

2.5.1 General Register Data Formats

Figure 2.9 shows the data formats of general registers.

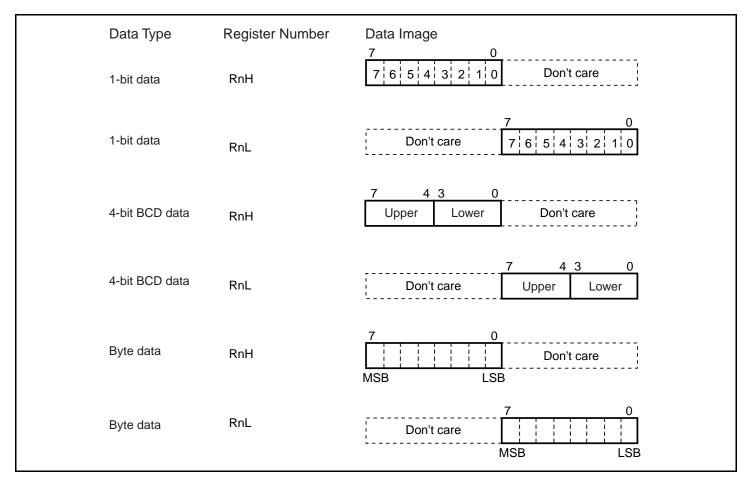


Figure 2.9 General Register Data Formats (1)

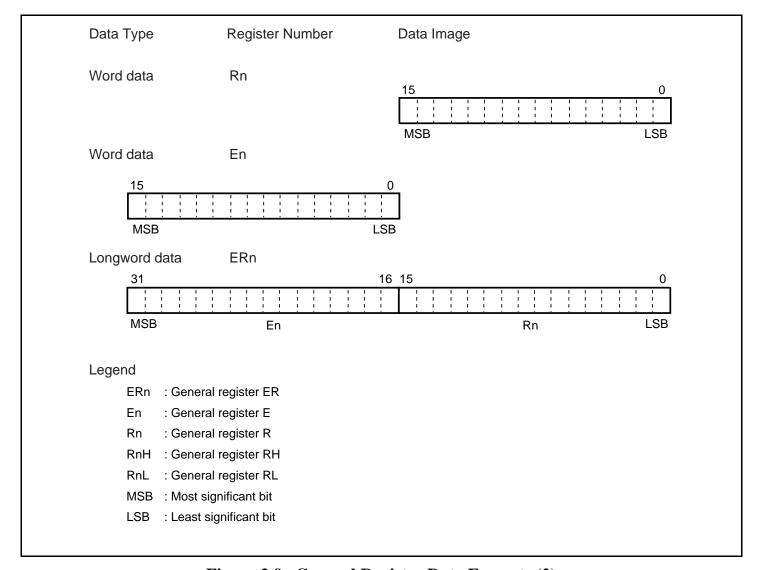


Figure 2.9 General Register Data Formats (2)

2.5.2 Memory Data Formats

Figure 2.10 shows the data formats in memory. The H8S/2000 CPU can access word data and longword data in memory, but word or longword data must begin at an even address. If an attempt is made to access word or longword data at an odd address, no address error occurs but the least significant bit of the address is regarded as 0, so the access starts at the preceding address. This also applies to instruction fetches.

When SP (ER7) is used as an address register to access the stack, the operand size should be word size or longword size.

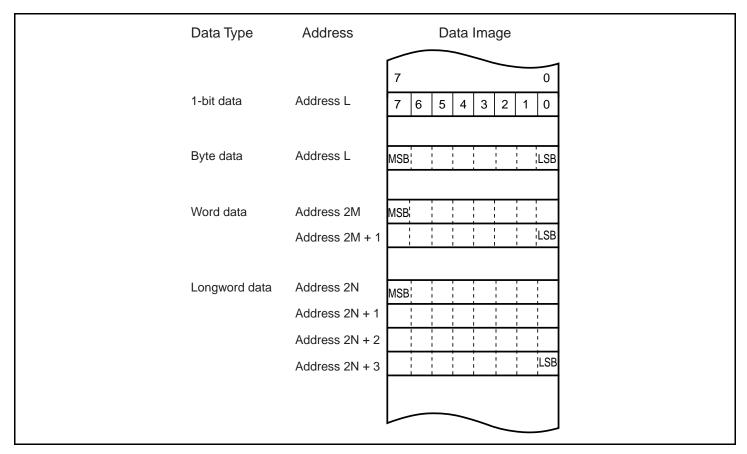


Figure 2.10 Memory Data Formats

2.6 Instruction Set

The H8S/2000 CPU has 65 types of instructions. The instructions are classified by function as shown in table 2.1.

Table 2.1 Instruction Classification

| Function | Instructions | Size | Types |
|---------------------|---|-------|-----------|
| Data transfer | MOV | B/W/L | 5 |
| | POP* ¹ , PUSH* ¹ | W/L | _ |
| | LDM* ⁵ , STM* ⁵ | L | _ |
| | MOVFPE* ³ , MOVTPE* ³ | В | _ |
| Arithmetic | ADD, SUB, CMP, NEG | B/W/L | 19 |
| operations | ADDX, SUBX, DAA, DAS | В | _ |
| | INC, DEC | B/W/L | _ |
| | ADDS, SUBS | L | _ |
| | MULXU, DIVXU, MULXS, DIVXS | B/W | _ |
| | EXTU, EXTS | W/L | _ |
| | TAS* ⁴ | В | _ |
| Logic operations | AND, OR, XOR, NOT | B/W/L | 4 |
| Shift | SHAL, SHAR, SHLL, SHLR, ROTL, ROTR, ROTXL, ROTXR | B/W/L | 8 |
| Bit manipulation | BSET, BCLR, BNOT, BTST, BLD, BILD, BST, BIST, BAND, BIAND, BOR, BIOR, BXOR, BIXOR | В | 14 |
| Branch | B _{cc} *², JMP, BSR, JSR, RTS | _ | 5 |
| System control | TRAPA, RTE, SLEEP, LDC, STC, ANDC, ORC, XORC, NOP | _ | 9 |
| Block data transfer | EEPMOV | _ | 1 |
| | | | Total: 65 |

Notes: B: Byte size; W: Word size; L: Longword size.

- POP.W Rn and PUSH.W Rn are identical to MOV.W @SP+, Rn and MOV.W Rn, @-SP. POP.L ERn and PUSH.L ERn are identical to MOV.L @SP+, ERn and MOV.L ERn, @-SP.
- 2. B_{cc} is the general name for conditional branch instructions.
- 3. Cannot be used in this LSI.
- 4. When using the TAS instruction, use registers ER0, ER1, ER4, and ER5.
- 5. ER7 is not used as the register that can be saved (STM)/restored (LDM) when using STM/LDM instruction, because ER7 is the stack pointer.

2.6.1 Table of Instructions Classified by Function

Tables 2.3 to 2.10 summarize the instructions in each functional category. The notation used in tables 2.3 to 2.10 is defined below.

Table 2.2 Operation Notation

| Symbol | Description |
|----------------|------------------------------------|
| Rd | General register (destination)* |
| Rs | General register (source)* |
| Rn | General register* |
| ERn | General register (32-bit register) |
| (EAd) | Destination operand |
| (EAs) | Source operand |
| EXR | Extended control register |
| CCR | Condition-code register |
| N | N (negative) flag in CCR |
| Z | Z (zero) flag in CCR |
| V | V (overflow) flag in CCR |
| С | C (carry) flag in CCR |
| PC | Program counter |
| SP | Stack pointer |
| #IMM | Immediate data |
| disp | Displacement |
| + | Addition |
| _ | Subtraction |
| × | Multiplication |
| ÷ | Division |
| ^ | Logical AND |
| V | Logical OR |
| \oplus | Logical exclusive OR |
| \rightarrow | Move |
| ~ | NOT (logical complement) |
| :8/:16/:24/:32 | 8-, 16-, 24-, or 32-bit length |

Note:* General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers (ER0 to ER7).

Table 2.3 Data Transfer Instructions

| Instruction | Size*1 | Function | |
|-------------------|--------|---|--|
| MOV | B/W/L | (EAs) 	o Rd, Rs 	o (EAd) | |
| | | Moves data between two general registers or between a general register and memory, or moves immediate data to a general register. | |
| MOVFPE | В | Cannot be used in this LSI. | |
| MOVTPE | В | Cannot be used in this LSI. | |
| POP | W/L | @SP+ → Rn | |
| | | Pops a general register from the stack. POP.W Rn is identical to MOV.W @SP+, Rn. POP.L ERn is identical to MOV.L @SP+, ERn | |
| PUSH | W/L | $Rn 	o @	ext{-SP}$ | |
| | | Pushes a general register onto the stack. PUSH.W Rn is identical to MOV.W Rn, @-SP. PUSH.L ERn is identical to MOV.L ERn, @-SP. | |
| LDM* ² | L | @SP+ → Rn (register list) | |
| | | Pops two or more general registers from the stack. | |
| STM* ² | L | Rn (register list) → @-SP | |
| _ | | Pushes two or more general registers onto the stack. | |

B: Byte

W: Word

L: Longword

2. ER7 is not used as the register that can be saved (STM)/restored (LDM) when using STM/LDM instruction, because ER7 is the stack pointer.

Table 2.4 Arithmetic Operations Instructions (1)

| Instruction | Size* | Function | | |
|-------------|-------|---|--|--|
| ADD | B/W/L | $Rd \pm Rs \rightarrow Rd, Rd \pm \#IMM \rightarrow Rd$ | | |
| SUB | | Performs addition or subtraction on data in two general registers, or on immediate data and data in a general register. (Subtraction on immediate data and data in a general register cannot be performed in bytes. Use the SUBX or ADD instruction.) | | |
| ADDX | В | $Rd \pm Rs \pm C \to Rd, Rd \pm \#IMM \pm C \to Rd$ | | |
| SUBX | | Performs addition or subtraction with carry on data in two general registers, or on immediate data and data in a general register. | | |
| INC | B/W/L | $Rd \pm 1 \rightarrow Rd, Rd \pm 2 \rightarrow Rd$ | | |
| DEC | | Adds or subtracts the value 1 or 2 to or from data in a general register. (Only the value 1 can be added to or subtracted from byte operands.) | | |
| ADDS | L | $Rd \pm 1 \rightarrow Rd, Rd \pm 2 \rightarrow Rd, Rd \pm 4 \rightarrow Rd$ | | |
| SUBS | | Adds or subtracts the value 1, 2, or 4 to or from data in a 32-bit register. | | |
| DAA | В | Rd (decimal adjust) $ ightarrow$ Rd | | |
| DAS | | Decimal-adjusts an addition or subtraction result in a general register by referring to CCR to produce 4-bit BCD data. | | |
| MULXU | B/W | $Rd \times Rs \rightarrow Rd$ | | |
| | | Performs unsigned multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. | | |
| MULXS | B/W | $Rd \times Rs \rightarrow Rd$ | | |
| | | Performs signed multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. | | |
| DIVXU | B/W | $Rd \div Rs \rightarrow Rd$ | | |
| | | Performs unsigned division on data in two general registers: either 16 bits \div 8 bits \rightarrow 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \rightarrow 16-bit quotient and 16-bit remainder. | | |

B: Byte W: Word L: Longword

Table 2.4 Arithmetic Operations Instructions (2)

| Instruction | Size*1 | Function |
|-------------|--------|--|
| DIVXS | B/W | $Rd \div Rs \rightarrow Rd$ |
| | | Performs signed division on data in two general registers: either 16 bits \div 8 bits \to 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \to 16-bit quotient and 16-bit remainder. |
| CMP | B/W/L | Rd – Rs, Rd – #IMM |
| | | Compares data in a general register with data in another general register or with immediate data, and sets the CCR bits according to the result. |
| NEG | B/W/L | $0 - Rd \rightarrow Rd$ |
| | | Takes the two's complement (arithmetic complement) of data in a general register. |
| EXTU | W/L | Rd (zero extension) → Rd |
| | | Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by padding with zeros on the left. |
| EXTS | W/L | Rd (sign extension) → Rd |
| | | Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by extending the sign bit. |
| TAS*2 | В | @ERd − 0, 1 → (<bit 7=""> of @ERd)</bit> |
| | | Tests memory contents, and sets the most significant bit (bit 7) to 1. |

B: Byte W: Word L: Longword

2. When using the TAS instruction, use registers ER0, ER1, ER4 and ER5.

Table 2.5 Logic Operations Instructions

| Instruction | Size* | Function | |
|-------------|-------|---|--|
| AND | B/W/L | $Rd \wedge Rs \rightarrow Rd, Rd \wedge \#IMM \rightarrow Rd$ | |
| | | Performs a logical AND operation on a general register and another general register or immediate data. | |
| OR | B/W/L | $Rd \lor Rs \rightarrow Rd, Rd \lor \#IMM \rightarrow Rd$ | |
| | | Performs a logical OR operation on a general register and another general register or immediate data. | |
| XOR | B/W/L | $Rd \oplus Rs \to Rd, Rd \oplus \#IMM \to Rd$ | |
| | | Performs a logical exclusive OR operation on a general register and another general register or immediate data. | |
| NOT | B/W/L | $\sim Rd \to Rd$ | |
| | | Takes the one's complement (logical complement) of data in a general register. | |
| | | | |

B: Byte W: Word L: Longword

Table 2.6 Shift Instructions

| Instruction | Size* | Function | |
|-------------|-------|---|--|
| SHAL | B/W/L | $Rd (shift) \rightarrow Rd$ | |
| SHAR | | Performs an arithmetic shift on data in a general register. 1-bit or 2 bit shift is possible. | |
| SHLL | B/W/L | Rd (shift) $\rightarrow Rd$ | |
| SHLR | | Performs a logical shift on data in a general register. 1-bit or 2 bit shift is possible. | |
| ROTL | B/W/L | Rd (rotate) → Rd | |
| ROTR | | Rotates data in a general register. 1-bit or 2 bit rotation is possible. | |
| ROTXL | B/W/L | Rd (rotate) → Rd | |
| ROTXR | | Rotates data including the carry flag in a general register. 1-bit or 2 bit rotation is possible. | |

Note:* Size refers to the operand size.

B: Byte W: Word L: Longword

Table 2.7 Bit Manipulation Instructions (1)

| Instruction | Size* | Function | |
|-------------|-------|---|--|
| BSET | В | $1 \rightarrow (\text{sbit-No.> of } \text{EAd>})$ | |
| | | Sets a specified bit in a general register or memory operand to 1. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. | |
| BCLR | В | $0 \rightarrow (\text{sbit-No.> of } \text{EAd>})$ | |
| | | Clears a specified bit in a general register or memory operand to 0. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. | |
| BNOT | В | \sim (<bit-no.> of <ead>) \rightarrow (<bit-no.> of <ead>)</ead></bit-no.></ead></bit-no.> | |
| | | Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. | |
| BTST | В | \sim (<bit-no.> of <ead>) → Z</ead></bit-no.> | |
| | | Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. | |
| BAND | В | $C \land (< bit-No. > of < EAd >) \rightarrow C$ | |
| | | Logically ANDs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| BIAND | В | $C \land (\ of\) \to C$ | |
| | | Logically ANDs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| | | The bit number is specified by 3-bit immediate data. | |
| BOR | В | $C \lor (\ of\) \to C$ | |
| | | Logically ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| BIOR | В | $C \lor (\sim \ of\) \to C$ | |
| | | Logically ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| | | The bit number is specified by 3-bit immediate data. | |

B: Byte

Table 2.7 Bit Manipulation Instructions (2)

| Instruction | Size* | Function | |
|-------------|-------|---|--|
| BXOR | В | $C \oplus (\text{ of }) \rightarrow C$ | |
| | | Logically exclusive-ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| BIXOR | В | $C \oplus \sim (\ of\) \to C$ | |
| | | Logically exclusive-ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. | |
| | | The bit number is specified by 3-bit immediate data. | |
| BLD | В | $($ bit-No. $>$ of <ead<math>><math>) \rightarrow C</math></ead<math> | |
| | | Transfers a specified bit in a general register or memory operand to the carry flag. | |
| BILD | В | \sim (<bit-no.> of <ead>) \rightarrow C</ead></bit-no.> | |
| | | Transfers the inverse of a specified bit in a general register or memory operand to the carry flag. | |
| | | The bit number is specified by 3-bit immediate data. | |
| BST | В | $C \rightarrow (\text{sbit-No.> of } \text{EAd>})$ | |
| | | Transfers the carry flag value to a specified bit in a general register or memory operand. | |
| BIST | В | \sim C \rightarrow (<bit-no.>. of <ead>)</ead></bit-no.> | |
| | | Transfers the inverse of the carry flag value to a specified bit in a general register or memory operand. | |
| | | The bit number is specified by 3-bit immediate data. | |

B: Byte

Table 2.8 Branch Instructions

| Instruction | Size | Function | | | |
|-------------|------|--|-------------------------|---------------------------|--|
| Bcc | _ | Branches to a specified address if a specified condition is true. The branching conditions are listed below. | | | |
| | | Mnemonic | Description | Condition | |
| | | BRA (BT) | Always (true) | Always | |
| | | BRN (BF) | Never (false) | Never | |
| | | BHI | High | C ∨ Z = 0 | |
| | | BLS | Low or same | C ∨ Z = 1 | |
| | | BCC (BHS) | Carry clear | C = 0 | |
| | | | (high or same) | | |
| | | BCS (BLO) | Carry set (low) | C = 1 | |
| | | BNE | Not equal | Z = 0 | |
| | | BEQ | Equal | Z = 1 | |
| | | BVC | Overflow clear | V = 0 | |
| | | BVS | Overflow set | V = 1 | |
| | | BPL | Plus | N = 0 | |
| | | ВМІ | Minus | N = 1 | |
| | | BGE | Greater or equal | N ⊕ V = 0 | |
| | | BLT | Less than | N ⊕ V = 1 | |
| | | BGT | Greater than | $Z \vee (N \oplus V) = 0$ | |
| | | BLE | Less or equal | Z ∨ (N ⊕ V) = 1 | |
| | | | | | |
| JMP | _ | Branches unco | onditionally to a speci | fied address. | |
| BSR | | Branches to a subroutine at a specified address | | | |

Branches to a subroutine at a specified address

Returns from a subroutine

JSR RTS

Table 2.9 System Control Instructions

| Instruction | Size* | Function | | | |
|-------------|-------|---|--|--|--|
| TRAPA | _ | Starts trap-instruction exception handling. | | | |
| RTE | _ | Returns from an exception-handling routine. | | | |
| SLEEP | _ | Causes a transition to a power-down state. | | | |
| LDC | B/W | (EAs) 	o CCR, (EAs) 	o EXR | | | |
| | | Moves the memory operand contents or immediate data to CCR or EXR. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid. | | | |
| STC | B/W | CCR 	o (EAd), EXR 	o (EAd) | | | |
| | | Transfers CCR or EXR contents to a general register or memory operand. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid. | | | |
| ANDC | В | $CCR \land \#IMM \to CCR, EXR \land \#IMM \to EXR$ | | | |
| | | Logically ANDs the CCR or EXR contents with immediate data. | | | |
| ORC | В | $CCR \lor \#IMM \to CCR, EXR \lor \#IMM \to EXR$ | | | |
| | | Logically ORs the CCR or EXR contents with immediate data. | | | |
| XORC | В | $CCR \oplus \#IMM \to CCR, EXR \oplus \#IMM \to EXR$ | | | |
| | | Logically exclusive-ORs the CCR or EXR contents with immediate data. | | | |
| NOP | _ | $PC + 2 \rightarrow PC$ | | | |
| Natari Car | | Only increments the program counter. | | | |

B: Byte W: Word

Table 2.10 Block Data Transfer Instructions

| Instruction | Size | Function |
|-------------|------|---|
| EEPMOV.B | _ | if R4L \neq 0 then Repeat @ER5 + \rightarrow @ER6+ R4L-1 \rightarrow R4L Until R4L = 0 else next; |
| EEPMOV.W | _ | if R4 \neq 0 then Repeat @ER5 + \rightarrow @ER6+ R4-1 \rightarrow R4 Until R4 = 0 else next; |
| | | Transfers a data block. Starting from the address set in ER5, transfers data for the number of bytes set in R4L or R4 to the address location set in ER6. |
| | | Execution of the next instruction begins as soon as the transfer is completed. |

2.6.2 Basic Instruction Formats

The H8S/2000 CPU instructions consist of 2-byte (1-word) units. An instruction consists of an operation field (op), a register field (r), an effective address extension (EA), and a condition field (cc).

Figure 2.11 shows examples of instruction formats.

Operation field

Indicates the function of the instruction, the addressing mode, and the operation to be carried out on the operand. The operation field always includes the first four bits of the instruction. Some instructions have two operation fields.

Register field

Specifies a general register. Address registers are specified by 3 bits, and data registers by 3 bits or 4 bits. Some instructions have two register fields, and some have no register field.

• Effective address extension

8, 16, or 32 bits specifying immediate data, an absolute address, or a displacement.

• Condition field

Specifies the branching condition of Bcc instructions.

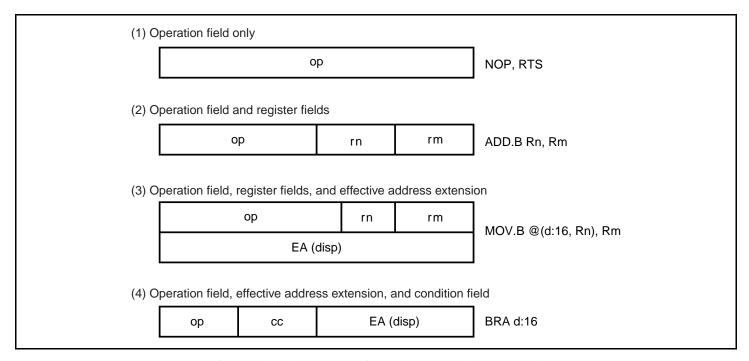


Figure 2.11 Instruction Formats (Examples)

2.7 **Addressing Modes and Effective Address Calculation**

The H8S/2000 CPU supports the eight addressing modes listed in table 2.11. Each instruction uses a subset of these addressing modes.

Arithmetic and logic operations instructions can use the register direct and immediate addressing modes. Data transfer instructions can use all addressing modes except program-counter relative and memory indirect. Bit manipulation instructions can use register direct, register indirect, or absolute addressing mode to specify an operand, and register direct (BSET, BCLR, BNOT, and BTST instructions) or immediate (3-bit) addressing mode to specify a bit number in the operand.

Table 2.11 Addressing Modes

| No. | Addressing Mode | Symbol |
|-----|---------------------------------------|----------------------------|
| 1 | Register direct | Rn |
| 2 | Register indirect | @ERn |
| 3 | Register indirect with displacement | @(d:16,ERn)/@(d:32,ERn) |
| 4 | Register indirect with post-increment | @ERn+ |
| | Register indirect with pre-decrement | @-ERn |
| 5 | Absolute address | @aa:8/@aa:16/@aa:24/@aa:32 |
| 6 | Immediate | #xx:8/#xx:16/#xx:32 |
| 7 | Program-counter relative | @(d:8,PC)/@(d:16,PC) |
| 8 | Memory indirect | @@aa:8 |

2.7.1 Register Direct—Rn

The register field of the instruction code specifies an 8-, 16-, or 32-bit general register which contains the operand. R0H to R7H and R0L to R7L can be specified as 8-bit registers. R0 to R7 and E0 to E7 can be specified as 16-bit registers. ER0 to ER7 can be specified as 32-bit registers.

2.7.2 Register Indirect—@ERn

The register field of the instruction code specifies an address register (ERn) which contains the address of a memory operand. If the address is a program instruction address, the lower 24 bits are valid and the upper 8 bits are all assumed to be 0 (H'00).

2.7.3 Register Indirect with Displacement—@(d:16, ERn) or @(d:32, ERn)

A 16-bit or 32-bit displacement contained in the instruction code is added to an address register (ERn) specified by the register field of the instruction, and the sum gives the address of a memory operand. A 16-bit displacement is sign-extended when added.

2.7.4 Register Indirect with Post-Increment or Pre-Decrement—@ERn+ or @-ERn

Register Indirect with Post-Increment—@**ERn+:** The register field of the instruction code specifies an address register (ERn) which contains the address of a memory operand. After the operand is accessed, 1, 2, or 4 is added to the address register contents and the sum is stored in the address register. The value added is 1 for byte access, 2 for word access, and 4 for longword access. For word or longword transfer instructions, the register value should be even.

Register Indirect with Pre-Decrement—@**-ERn:** The value 1, 2, or 4 is subtracted from an address register (ERn) specified by the register field in the instruction code, and the result becomes the address of a memory operand. The result is also stored in the address register. The value subtracted is 1 for byte access, 2 for word access, and 4 for longword access. For word or longword transfer instructions, the register value should be even.

2.7.5 Absolute Address—@aa:8, @aa:16, @aa:24, or @aa:32

The instruction code contains the absolute address of a memory operand. The absolute address may be 8 bits long (@aa:8), 16 bits long (@aa:16), 24 bits long (@aa:24), or 32 bits long (@aa:32). Table 2.12 indicates the accessible absolute address ranges.

To access data, the absolute address should be 8 bits (@aa:8), 16 bits (@aa:16), or 32 bits (@aa:32) long. For an 8-bit absolute address, the upper 16 bits are all assumed to be 1 (H'FFFF). For a 16-bit absolute address, the upper 16 bits are a sign extension. For a 32-bit absolute address, the entire address space is accessed.

A 24-bit absolute address (@aa:24) indicates the address of a program instruction. The upper 8 bits are all assumed to be 0 (H'00).

Table 2.12 Absolute Address Access Ranges

| Absolute Address | | Normal Mode | Advanced Mode |
|-----------------------------|------------------|------------------|---|
| Data address | 8 bits (@aa:8) | H'FF00 to H'FFFF | H'FFFF00 to H'FFFFFF |
| | 16 bits (@aa:16) | H'0000 to H'FFFF | H'000000 to H'007FFF, H'FF8000 to H'FFFFFF |
| | 32 bits (@aa:32) | | H'000000 to H'FFFFFF |
| Program instruction address | 24 bits (@aa:24) | _ | |

2.7.6 Immediate—#xx:8, #xx:16, or #xx:32

The 8-bit (#xx:8), 16-bit (#xx:16), or 32-bit (#xx:32) immediate data contained in an instruction code can be used directly as an operand.

The ADDS, SUBS, INC, and DEC instructions implicitly contain immediate data in their instruction codes. Some bit manipulation instructions contain 3-bit immediate data in the instruction code, specifying a bit number. The TRAPA instruction contains 2-bit immediate data in its instruction code, specifying a vector address.

2.7.7 Program-Counter Relative—@(d:8, PC) or @(d:16, PC)

This mode can be used by the Bcc and BSR instructions. An 8-bit or 16-bit displacement contained in the instruction code is sign-extended to 24 bits and added to the 24-bit address indicated by the PC value to generate a 24-bit branch address. Only the lower 24 bits of this branch address are valid; the upper 8 bits are all assumed to be 0 (H'00). The PC value to which the displacement is added is the address of the first byte of the next instruction, so the possible branching range is –126 to +128 bytes (–63 to +64 words) or –32766 to +32768 bytes (–16383 to +16384 words) from the branch instruction. The resulting value should be an even number.

2.7.8 Memory Indirect—@@aa:8

This mode can be used by the JMP and JSR instructions. The instruction code contains an 8-bit absolute address specifying a memory operand which contains a branch address. The upper bits of the 8-bit absolute address are all assumed to be 0, so the address range is 0 to 255 (H'0000 to H'00FF in normal mode, H'000000 to H'000FF in advanced mode).

In normal mode, the memory operand is a word operand and the branch address is 16 bits long. In advanced mode, the memory operand is a longword operand, the first byte of which is assumed to be 0 (H'00). Note that the top area of the address range in which the branch address is stored is also used for the exception vector area. For further details, refer to section 4, Exception Handling.

If an odd address is specified in word or longword memory access, or as a branch address, the least significant bit is regarded as 0, causing data to be accessed or the instruction code to be fetched at the address preceding the specified address. (For further information, see section 2.5.2, Memory Data Formats.)

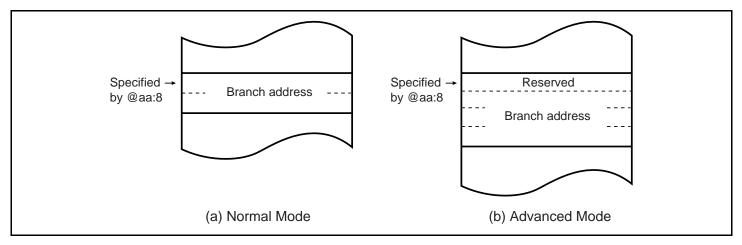


Figure 2.12 Branch Address Specification in Memory Indirect Addressing Mode

2.7.9 Effective Address Calculation

Table 2.13 indicates how effective addresses are calculated in each addressing mode. In normal mode, the upper 8 bits of the effective address are ignored in order to generate a 16-bit address.

Table 2.13 Effective Address Calculation (1)

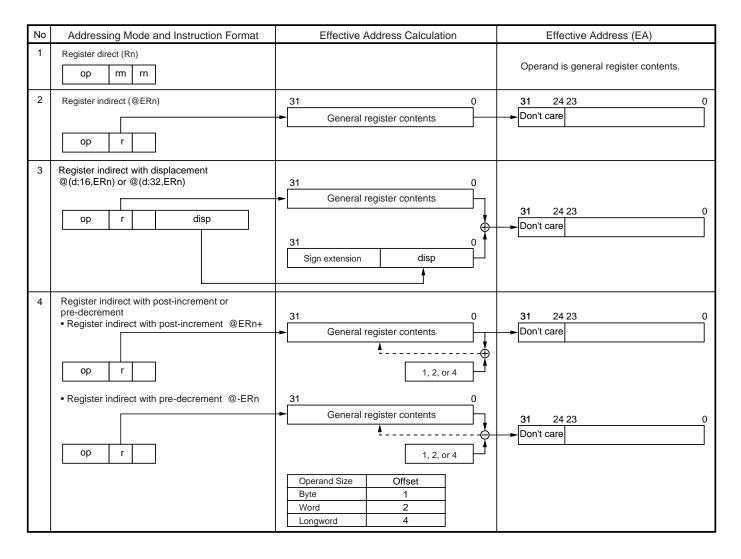
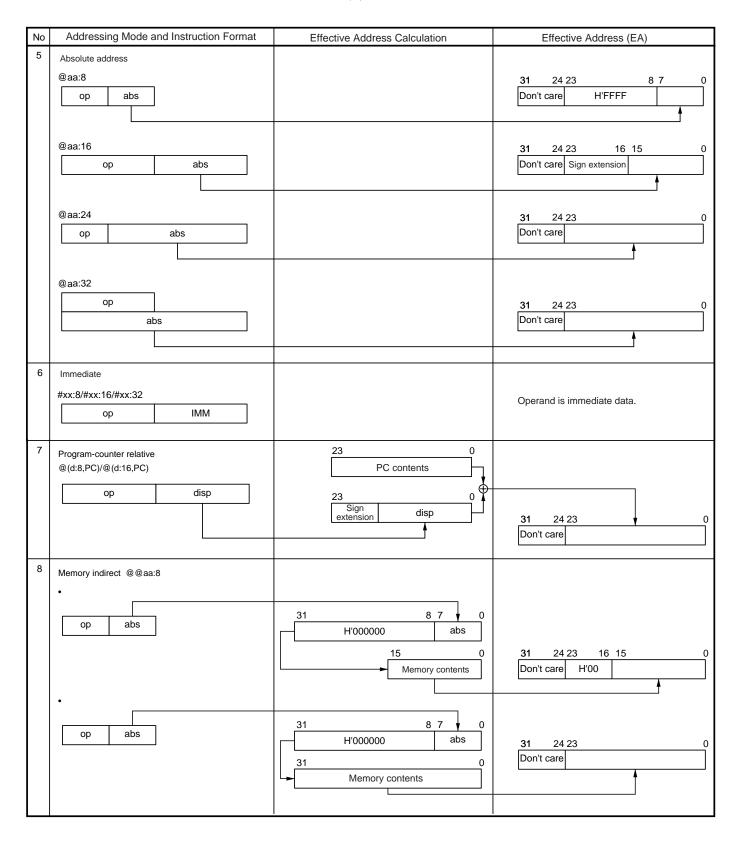


Table 2.13 Effective Address Calculation (2)



2.8 Processing States

The H8S/2000 CPU has five main processing states: the reset state, exception handling state, program execution state, bus-released state, and program stop state. Figure 2.13 indicates the state transitions.

Reset state

In this state the CPU and on-chip peripheral modules are all initialized and stopped. When the \overline{RES} input goes low, all current processing stops and the CPU enters the reset state. All interrupts are masked in the reset state. Reset exception handling starts when the \overline{RES} signal changes from low to high. For details, refer to section 4, Exception Handling.

The reset state can also be entered by a watchdog timer overflow.

• Exception-handling state

The exception-handling state is a transient state that occurs when the CPU alters the normal processing flow due to an exception source, such as, a reset, trace, interrupt, or trap instruction. The CPU fetches a start address (vector) from the exception vector table and branches to that address. For further details, refer to section 4, Exception Handling.

Program execution state

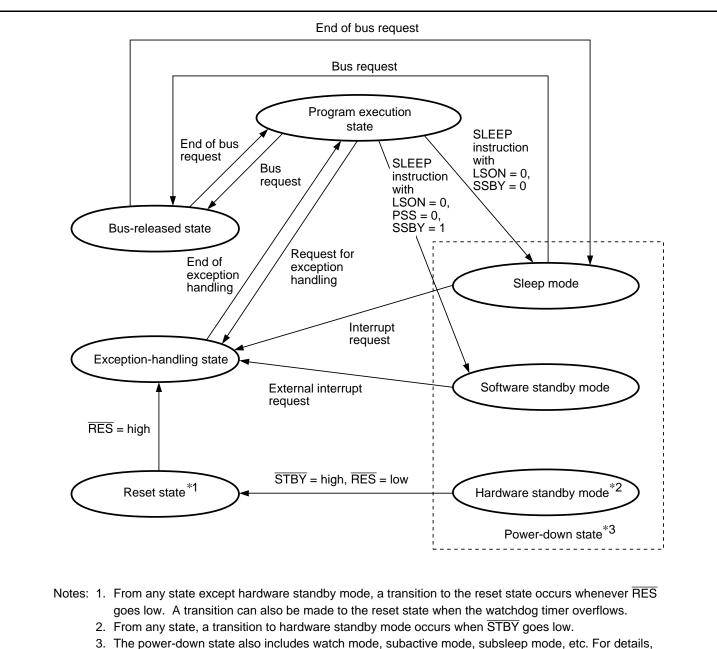
In this state the CPU executes program instructions in sequence.

• Bus-released state

In a product which has a bus master other than the CPU, such as a data transfer controller (DTC), the bus-released state occurs when the bus has been released in response to a bus request from a bus master other than the CPU. While the bus is released, the CPU halts operations. For details, see section 6, Bus Controller (BSC).

• Program stop state

This is a power-down state in which the CPU stops operating. The program stop state occurs when a SLEEP instruction is executed or the CPU enters hardware standby mode. For details, refer to section 26, Power-Down Modes.



The power-down state also includes watch mode, subactive mode, subsleep mode, etc. For details, refer to section 26, Power-Down Modes.

Figure 2.13 State Transitions

2.9 Usage Notes

2.9.1 Note on TAS Instruction Usage

When using the TAS instruction, use registers ER0, ER1, ER4 and ER5.

The TAS instruction is not generated by the Hitachi H8S and H8/300 series C/C++ compilers. When the TAS instruction is used as a user-defined intrinsic function, use registers ER0, ER1, ER4 and ER5.

2.9.2 Note on STM/LDM Instruction Usage

ER7 is not used as the register that can be saved (STM)/restored (LDM) when using STM/LDM instruction, because ER7 is the stack pointer. Two, three, or four registers can be saved/restored by one STM/LDM instruction. The following ranges can be specified in the register list.

Two registers: ER0—ER1, ER2—ER3, or ER4—ER5

Three registers: ER0—ER2 or ER4—ER6

Four registers: ER0—ER3

The STM/LDM instruction including ER7 is not generated by the Hitachi H8S and H8/300 series C/C++ compilers.

2.9.3 Note on Bit Manipulation Instructions

The BSET, BCLR, BNOT, BST, and BIST instructions read data from the specified address in byte units, manipulate the data of the target bit, and write data to the same address again in byte units. Special care is required when using these instructions in cases where a register containing a write-only bit is used or a bit is directly manipulated for a port, because this may rewrite data of a bit other than the bit to be manipulated.

Example: The BCLR instruction is executed for DDR in port 4.

P47 and P46 are input pins, with a low-level signal input at P47 and a high-level signal input at P46. P45 to P40 are output pins and output low-level signals. The following shows an example in which P40 is set to be an input pin with the BCLR instruction.

Prior to executing BCLR:

| | P47 | P46 | P45 | P44 | P43 | P42 | P41 | P40 |
|--------------|--------------|---------------|--------------|--------------|--------------|--------------|--------------|--------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| DDR | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| DR | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

BCLR instruction executed:

| BCLR #0, @P4DDR | The BCLR instruction is executed for DDR in port 4. |
|-----------------|---|
|-----------------|---|

After executing BCLR:

| | P47 | P46 | P45 | P44 | P43 | P42 | P41 | P40 |
|--------------|--------------|---------------|--------------|--------------|--------------|--------------|--------------|---------------|
| Input/output | Output | Output | Output | Output | Output | Output | Output | Input |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| DDR | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| DR | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Operation:

- 1. When the BCLR instruction is executed, first the CPU reads P4DDR.

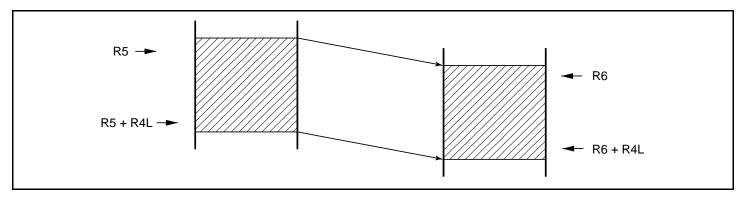
 Since P4DDR is a write-only register, so the CPU reads H'FF. In this example P4DDR has a value of H'3F, but the value read by the CPU is H'FF.
- 2. The CPU clears bit 0 of the read data to 0, changing data to H'FE.
- 3. The CPU writes H'FE to DDR, completing execution of BCLR.

As a result of the BCLR instruction, bit 0 in DDR is set to 0, and P40 becomes an input pin. However, bits 7 and 6 of DDR are modified to 1, therefore P47 and P46 become output pins.

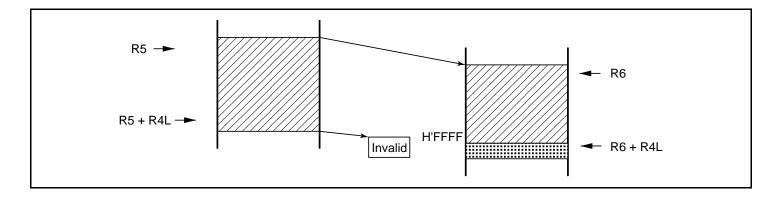
RENESAS

2.9.4 EEPMOV Instruction

1. EEPMOV is a block-transfer instruction and transfers the byte size of data indicated by R4L, which starts from the address indicated by R5, to the address indicated by R6.



2. Set R4L and R6 so that the end address of the destination address (value of R6 + R4L) does not exceed H'FFFF (the value of R6 must not change from H'FFFF to H'0000 during execution).



Section 3 MCU Operating Modes

3.1 MCU Operating Mode Selection

This LSI has three operating modes (modes 1 to 3). The operating mode is determined by the setting of the mode pins (MD1 and MD0). Table 3.1 shows the MCU operating mode selection.

Table 3.1 lists the MCU operating modes.

Table 3.1 MCU Operating Mode Selection

| MCU Operating Mode | MD1 | MD0 | CPU Operating Mode | Description | On-Chip ROM |
|--------------------------|-----|-----|--------------------------|---|----------------|
| 0 | 0 | 0 | _ | _ | _ |
| 1 | | 1 | Normal | Expanded mode with on-chip ROM disabled | Disabled |
| 2 | 1 | 0 | Advanced | Expanded mode with on-chip ROM enabled | Enabled |
| | | | | Single-chip mode | |
| 3 | | 1 | Normal | Expanded mode with on-chip ROM enabled | |
| | | | | Single-chip mode | |

Mode 1 is an expanded mode that allows access to external memory and peripheral devices. With modes 2 and 3, operation begins in single-chip mode after reset release, but a transition can be made to external expansion mode by setting the EXPE bit in MDCR to 1.

Mode 0 cannot be used in this LSI. Thus, mode pins should be set to enable mode 1, 2 or 3 in normal program execution state. Mode pins should not be changed during operation.

3.2 Register Descriptions

The following registers are related to the operating mode. For details on the bus control register (BCR), refer to section 6.3.1, Bus Control Register (BCR).

- Mode control register (MDCR)
- System control register (SYSCR)
- Serial timer control register (STCR)

3.2.1 Mode Control Register (MDCR)

MDCR is used to set an operating mode and to monitor the current operating mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|--------------|---------------|------|--|
| 7 | EXPE | * | R/W* | Extended Mode Enable |
| | | | | Specifies extended mode. Fixed to 1 and cannot be modified in mode 1. Readable/writable and the initial value is 0 in mode 2 or 3. |
| | | | | 0: Single-chip mode |
| | | | | 1: Extended mode |
| 6 | _ | All 0 | R | Reserved |
| to 2 | | | | These bits are always read as 0. These bits cannot be modified. |
| 1 | MDS1 | * | R | Mode Select 1 and 0 |
| 0 | MDS0 | * | R | These bits indicate the input levels at mode pins (MD1 and MD0) (the current operating mode). Bits MDS1 and MDS0 correspond to MD1 and MD0, respectively. These bits are read-only bits and they cannot be written to. The mode pin (MD1 and MD0) input levels are latched into these bits when MDCR is read. These latches are canceled by a reset. |

Note:* The initial values are determined by the settings of the MD1 and MD0 pins.

3.2.2 System Control Register (SYSCR)

SYSCR selects a system pin function, monitors a reset source, selects the interrupt control mode and the detection edge for NMI, pin location selection, enables or disables register access to the on-chip peripheral modules, and enables or disables on-chip RAM address space.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | CS2E | 0 | R/W | Chip Select 2 Enable |
| | | | | Specifies the location of the control pin (CS2) of the host interface together with the FGA20E bit in HICR. See section 18, Host Interface X-Bus Interface (XBS), for details. |
| 6 | IOSE | 0 | R/W | IOS Enable |
| | | | | Enables or disables $\overline{\text{AS}}/\overline{\text{IOS}}$ pin function in extended mode. |
| | | | | 0: AS pin Outputs low when an external area is accessed. |
| | | | | 1: IOS pin Outputs low when a specified address of addresses H'(FF)F000 to H'(FF)F7FF is accessed. |
| 5 | INTM1 | 0 | R | These bits select the control mode of the interrupt |
| 4 | INTM0 | 0 | R/W | controller. For details on the interrupt control modes and interrupt control select modes 1 and 0, see section 5.6, Interrupt Control Modes and Interrupt Operation. |
| | | | | 00: Interrupt control mode 0 |
| | | | | 01: Interrupt control mode 1 |
| | | | | 10: Setting prohibited |
| | | | | 11: Setting prohibited |
| 3 | XRST | 1 | R | External Reset |
| | | | | This bit indicates the reset source. A reset is caused by an external reset input, or when the watchdog timer overflows. |
| | | | | 0: A reset is caused when the watchdog timer overflows. |
| | | | | 1: A reset is caused by an external reset. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | NMIEG | 0 | R/W | NMI Edge Select |
| | | | | Selects the valid edge of the NMI interrupt input. |
| | | | | 0: An interrupt is requested at the falling edge of NMI input |
| | | | | 1: An interrupt is requested at the rising edge of NMI input |
| 1 | HIE | 0 | R/W | Host Interface Enable |
| | | | | Controls CPU access to the host interface registers (HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2), the keyboard matrix interrupt and MOS input pull-up control registers (KMIMR, KMPCR, and KMIMRA), the 8-bit timer (TMR_X and TMR_Y) registers (TCR_X/TCR_Y, TCSR_X/TCSR_Y, TICRR/TCORA_Y, TICRF/TCORB_Y, TCNT_X/TCNT_Y, TCORC/TISR, TCORA_X, and TCORB_X), and the timer connection registers (TCONRI, TCONRO, TCONRS, and SEDGR). |
| | | | | 0: In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, CPU access to 8-bit timer (TMR_X and TMR_Y) registers and timer connection registers is permitted |
| | | | | 1: In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, CPU access to host interface registers and keyboard matrix interrupt and MOS input pull-up control registers is permitted |
| 0 | RAME | 1 | R/W | RAM Enable |
| | | | | Enables or disables on-chip RAM. The RAME bit is initialized when the reset state is released. |
| | | | | 0: On-chip RAM is disabled |
| | | | | 1: On-chip RAM is enabled |

3.2.3 Serial Timer Control Register (STCR)

STCR enables or disables register access, IIC operating mode, and on-chip flash memory, and selects the input clock of the timer counter.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | IICS | 0 | R/W | I ² C Extra Buffer Select |
| | | | | Specifies bits 7 to 4 of port A as output buffers similar to SLC and SDA. These pins are used to implement an I ² C interface only by software. |
| | | | | 0: PA7 to PA4 are normal input/output pins. |
| | | | | 1: PA7 to PA4 are input/output pins enabling bus driving. |
| 6 | IICX1 | 0 | R/W | I ² C Transfer Rate Select 1 and 0 |
| 5 | IICX0 | 0 | R/W | These bits control the IIC operation. These bits select a transfer rate in master mode together with bits CKS2 to CKS0 in the I ² C bus mode register (ICMR). For details on the transfer rate, refer to table 16.3. |
| 4 | IICE | 0 | R/W | I ² C Master Enable |
| | | | | Enables or disables CPU access for IIC registers (ICCR, ICSR, ICDR/SARX, ICMR/SAR), PWMX registers (DADRAH/DACR, DADRAL, DADRBH/DACNTH, DADRBL/DACNTL), and SCI registers (SMR, BRR, SCMR). |
| | | | | 0: SCI_1 registers are accessed in an area from H'(FF)FF88 to H'(FF)FF89 and from H'(FF)FF8E to H'(FF)FF8F. |
| | | | | SCI_2 registers are accessed in an area from H'(FF)FFA0 to H'(FF)FFA1 and from H'(FF)FFA6 to H'(FF)FFA7. |
| | | | | SCI_0 registers are accessed in an area from H'(FF)FFD8 to H'(FF)FFD9 and from H'(FF)FFDE to H'(FF)FFDF. |
| | | | | 1: IIC_1 registers are accessed in an area from H'(FF)FF88 to H'(FF)FF89 and from H'(FF)FF8E to H'(FF)FF8F. |
| | | | | PWMX registers are accessed in an area from H'(FF)FFA0 to H'(FF)FFA1 and from H'(FF)FFA6 to H'(FF)FFA7. |
| | | | | IIC_0 registers are accessed in an area from H'(FF)FFD8 to H'(FF)FFD9 and from H'(FF)FFDE to H'(FF)FFDF. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-------|---|
| 3 | FLSHE | 0 | R/W | Flash Memory Control Register Enable |
| | | | | Enables or disables CPU access for flash memory registers (FLMCR1, FLMCR2, EBR1, EBR2), control registers in power-down state (SBYCR, LPWRCR, MSTPCRH, MSTPCRL), and control registers of onchip peripheral modules (PCSR, SYSCR2). |
| | | | | 0: Registers in power-down state and control registers of on-chip peripheral modules are accessed in an area from H'(FF)FF80 to H'(FF)FF87. |
| | | | | 1: Control registers of flash memory are accessed in an area from H'(FF)FF80 to H'(FF)FF87. |
| 2 | _ | 0 | R/(W) | Reserved |
| | | | | The initial value should not be changed. |
| 1 | ICKS1 | 0 | R/W | Internal Clock Source Select 1, 0 |
| 0 | ICKS0 | 0 | R/W | These bits select a clock to be input to the timer counter (TCNT) and a count condition together with bits CKS2 to CKS0 in the timer control register (TCR). For details, refer to section 12.3.4, Timer Control Register (TCR). |

3.3 Operating Mode Descriptions

3.3.1 Mode 1

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is disabled.

Ports 1 and 2 function as an address bus, port 3 functions as a data bus, and part of port 9 carries bus control signals. Clearing the ABW bit to 0 in the WSCR register makes port B a data bus.

3.3.2 Mode 2

The CPU can access a 16-Mbyte address space in advanced mode. The on-chip ROM is enabled.

After a reset, the LSI is set to single-chip mode. To access an external address space, bit EXPE in MDCR should be set to 1.

When the EXPE bit in MDCR is set to 1, ports 1, 2 and A function as input ports after a reset. Ports 1, 2 and A output an address by setting 1 to the corresponding port data direction register (DDR). Port 3 functions as a data bus, and parts of port 9 carry bus control signals. Port B functions as a data bus when the ABW bit in WSCR is cleared to 0.

3.3.3 Mode 3

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is enabled. The CPU can access a 56-kbyte address space in mode 3.

After a reset, the LSI is set to single-chip mode. To access an external address space, bit EXPE in MDCR should be set to 1.

When the EXPE bit in MDCR is set to 1, ports 1 and 2 function as input ports after a reset. Ports 1 and 2 function as an address bus by setting 1 to the corresponding port data direction register (DDR). Port 3 functions as a data bus, and parts of port 9 carry bus control signals. Port B functions as a data bus when the ABW bit in WSCR is cleared to 0.

3.3.4 Pin Functions in Each Operating Mode

Pin functions of ports 1 to 3, 9, A, and B depend on the operating mode. Table 3.2 shows pin functions in each operating mode.

Table 3.2 Pin Functions in Each Mode

| Port | | Mode 1 | Mode 2 | Mode 3 | |
|-----------|------------|--------|--------|--------|--|
| Port 1 | | Α | P*/A | P*/A | |
| Port 2 | | А | P*/A | P*/A | |
| Port A | | Р | P*/A | Р | |
| Port 3 | | D | P*/D | P*/D | |
| Port B | | P*/D | P*/D | P*/D | |
| Port 9 | P97 | P*/C | P*/C | P*/C | |
| | P96 | C*/P | P*/C | P*/C | |
| | P95 to P93 | С | P*/C | P*/C | |
| | P92 to P91 | Р | Р | Р | |
| | P90 | P*/C | P*/C | P*/C | |
| Port C to | Port G | Р | Р | Р | |

Legend

P: I/O port

A: Address bus output

D: Data bus I/O

C: Control signals, clock I/O*: Immediately after reset

3.4 **Address Map in Each Operating Mode**

Figures 3.1 to 3.10 show the address map in each operating mode.

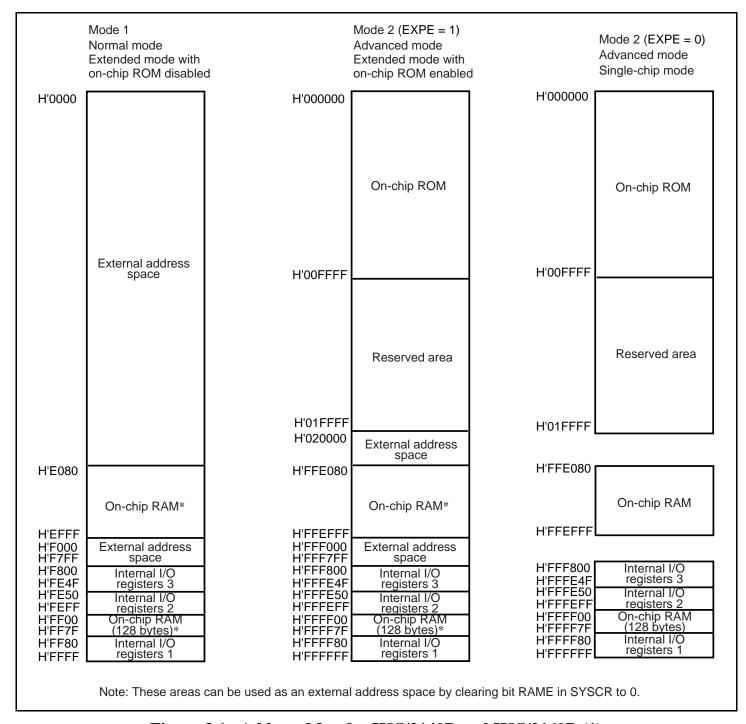


Figure 3.1 Address Map for H8S/2140B and H8S/2160B (1)

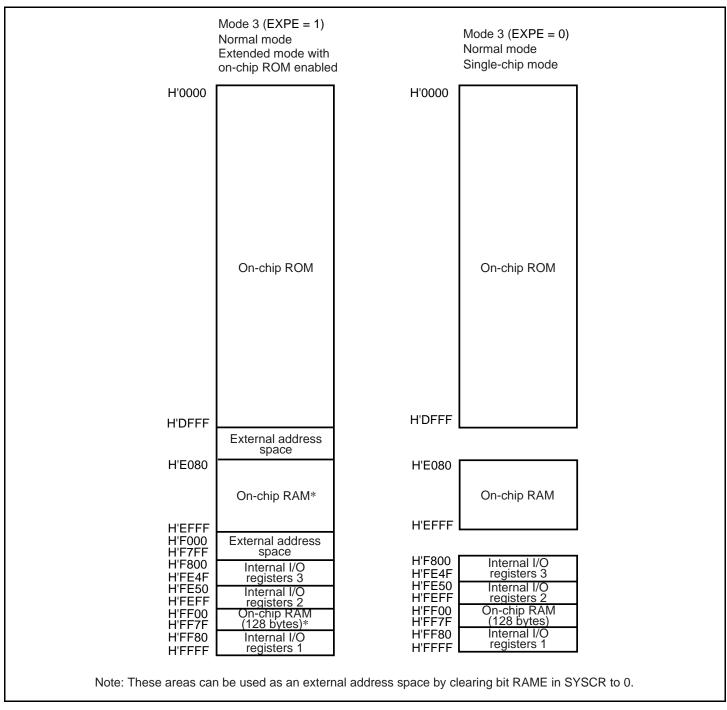


Figure 3.2 Address Map for H8S/2140B and H8S/2160B (2)

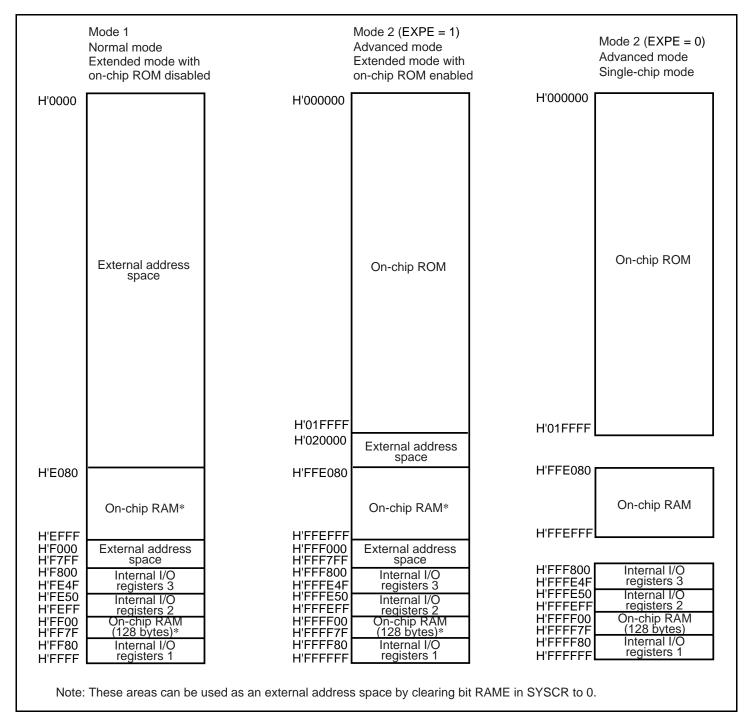


Figure 3.3 Address Map for H8S/2141B and H8S/2161B (1)

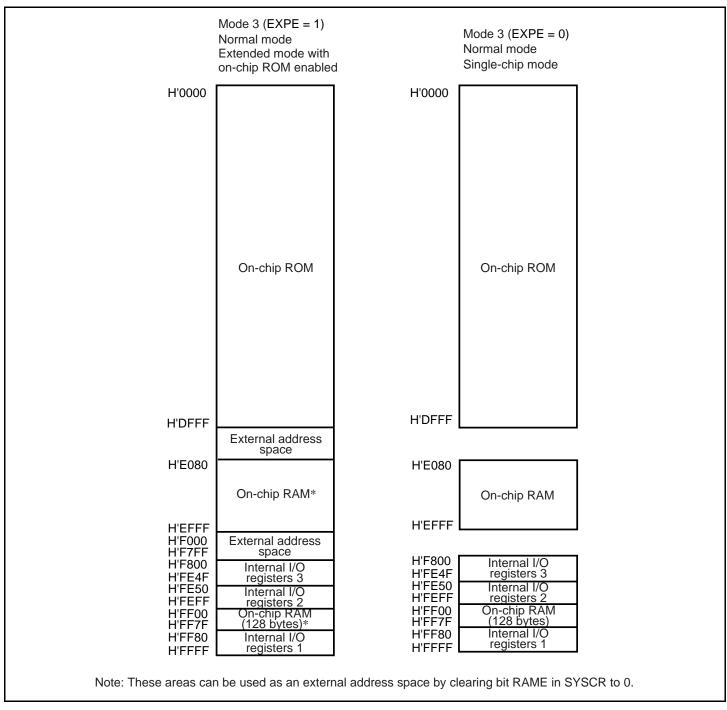


Figure 3.4 Address Map for H8S/2141B and H8S/2161B (2)

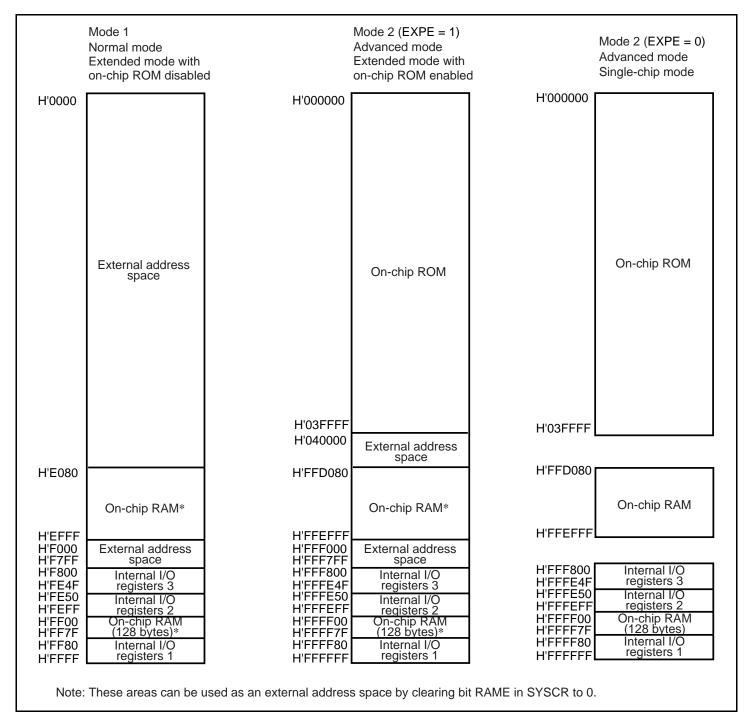


Figure 3.5 Address Map for H8S/2145BV (1)

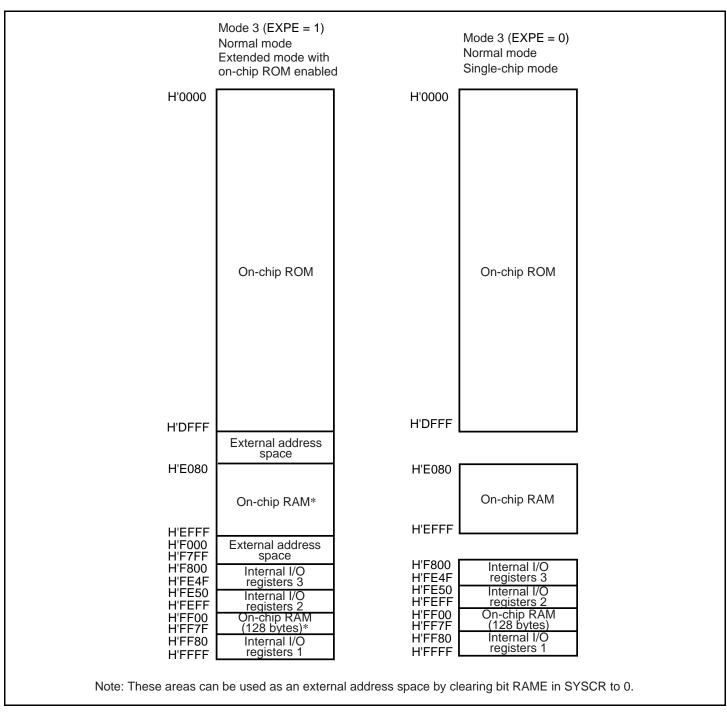


Figure 3.6 Address Map for H8S/2145BV (2)

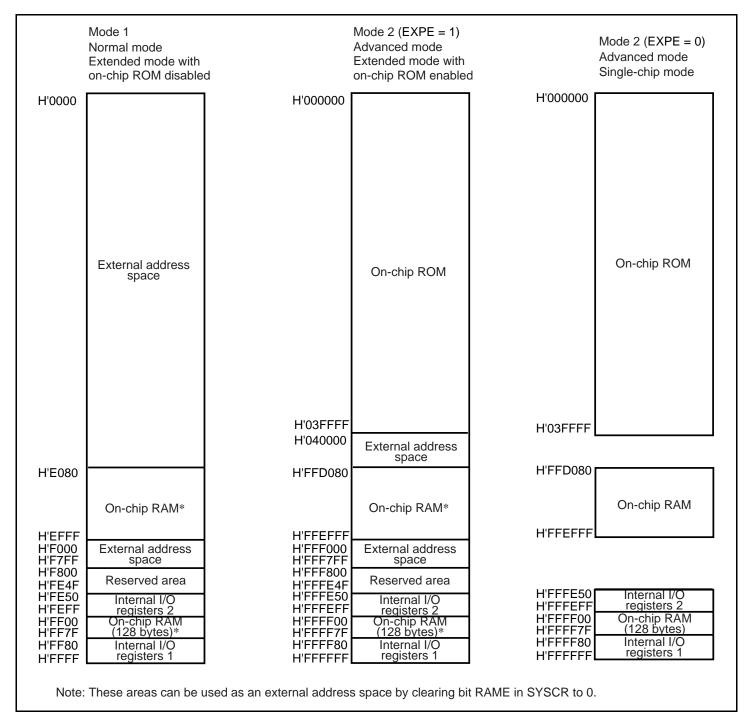


Figure 3.7 Address Map for H8S/2148B (1)

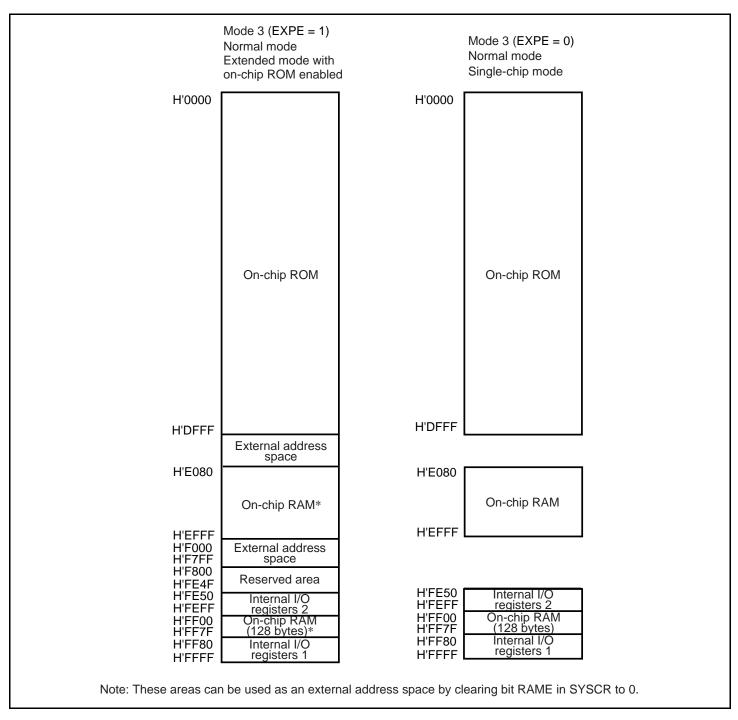


Figure 3.8 Address Map for H8S/2148B (2)

Section 4 Exception Handling

4.1 Exception Handling Types and Priority

As table 4.1 indicates, exception handling may be caused by a reset, interrupt, direct transition, or trap instruction. Exception handling is prioritized as shown in table 4.1. If two or more exceptions occur simultaneously, they are accepted and processed in order of priority.

Table 4.1 Exception Types and Priority

| Priority | Exception Type | Start of Exception Handling |
|----------|-----------------------|--|
| High | Reset | Starts immediately after a low-to-high transition of the RES pin, or when the watchdog timer overflows. |
| | Interrupt | Starts when execution of the current instruction or exception handling ends, if an interrupt request has been issued. Interrupt detection is not performed on completion of ANDC, ORC, XORC, or LDC instruction execution, or on completion of reset exception handling. |
| | Direct transition | Starts when a direction transition occurs as the result of SLEEP instruction execution. |
| Low | Trap instruction | Started by execution of a trap (TRAPA) instruction. Trap instruction exception handling requests are accepted at all times in program execution state. |

4.2 Exception Sources and Exception Vector Table

Different vector addresses are assigned to different exception sources. Table 4.2 lists the exception sources and their vector addresses.

Table 4.2 Exception Handling Vector Table

Vector Address

| Exception Source | | Vector Number | Normal Mode | Advanced Mode | |
|-------------------------|--------|----------------------|----------------------|--------------------------|--|
| Reset | | 0 | H'0000 to H'0001 | H'000000 to H'000003 | |
| Reserved for syste | em use | 1 | H'0002 to H'0003 | H'000004 to H'000007 | |
| | | 5 | H'000A to H'000B | H'000014 to H'000017 | |
| Direct transition | | 6 | H'000C to H'000D | H'000018 to H'00001B | |
| External interrupt | (NMI) | 7 | H'000E to H'000F | H'00001C to H'00001F | |
| Trap instruction (for | our | 8 | H'0010 to H'0011 | H'000020 to H'000023 | |
| sources) | | 9 | H'0012 to H'0013 | H'000024 to H'000027 | |
| | | 10 | H'0014 to H'0015 | H'000028 to H'00002B | |
| | | 11 | H'0016 to H'0017 | H'00002C to H'00002F | |
| Reserved for system use | | 12 | H'0018 to H'0019 | H'000030 to H'000033 | |
| | | 15 | H'001E to H'001F | H'00003C to H'00003F | |
| External interrupt | IRQ0 | 16 | H'0020 to H'0021 | H'000040 to H'000043 | |
| | IRQ1 | 17 | H'0022 to H'0023 | H'000044 to H'000047 | |
| | IRQ2 | 18 | H'0024 to H'0025 | H'000048 to H'00004B | |
| | IRQ3 | 19 | H'0026 to H'0027 | H'00004C to H'00004F | |
| | IRQ4 | 20 | H'0028 to H'0029 | H'000050 to H'000053 | |
| | IRQ5 | 21 | H'002A to H'002B | H'000054 to H'000057 | |
| | IRQ6 | 22 | H'002C to H'002D | H'000058 to H'00005B | |
| | IRQ7 | 23 | H'002E to H'002F | H'00005C to H'00005F | |
| Internal interrupt* | | 24 | H'0030 to H'0031 | H'000060 to H'000063 | |
| | | 107 | H'00DE to H'00DF | H'0001BC to H'0001BF | |

Note:* For details on the internal interrupt vector table, see section 5.5, Interrupt Exception Handling Vector Table.

4.3 Reset

A reset has the highest exception priority. When the \overline{RES} pin goes low, all processing halts and this LSI enters the reset. To ensure that this LSI is reset, hold the \overline{RES} pin low for at least 20 ms at power-on. To reset the chip during operation, hold the \overline{RES} pin low for at least 20 states. A reset initializes the internal state of the CPU and the registers of on-chip peripheral modules. The chip can also be reset by overflow of the watchdog timer. For details, see section 14, Watchdog Timer (WDT).

4.3.1 Reset Exception Handling

When the \overline{RES} pin goes high after being held low for the necessary time, this LSI starts reset exception handling as follows:

- 1. The internal state of the CPU and the registers of the on-chip peripheral modules are initialized and the I bit is set to 1 in CCR.
- 2. The reset exception handling vector address is read and transferred to the PC, and program execution starts from the address indicated by the PC.

Figure 4.1 shows an example of the reset sequence.

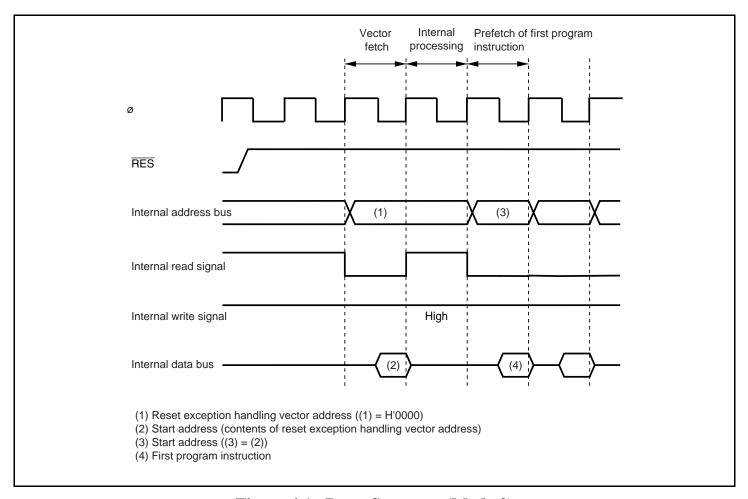


Figure 4.1 Reset Sequence (Mode 3)

4.3.2 Interrupts after Reset

If an interrupt is accepted after a reset and before the stack pointer (SP) is initialized, the PC and CCR will not be saved correctly, leading to a program crash. To prevent this, all interrupt requests, including NMI, are disabled immediately after a reset. Since the first instruction of a program is always executed immediately after the reset state ends, make sure that this instruction initializes the stack pointer (example: MOV.L #xx: 32, SP).

4.3.3 On-Chip Peripheral Modules after Reset is Cancelled

After a reset is cancelled, the module stop control registers (MSTPCR) are initialized, and all modules except the DTC operate in module stop mode. Therefore, the registers of on-chip peripheral modules cannot be read from or written to. To read from and write to these registers, clear module stop mode.

4.4 Interrupt Exception Handling

Interrupts are controlled by the interrupt controller. The sources to start interrupt exception handling are external interrupt sources (NMI, IRQ7 to IRQ0, KIN15 to KIN0, and WUE7 to WUE0) and internal interrupt sources from the on-chip peripheral modules. NMI is an interrupt with the highest priority. For details, refer to section 5, Interrupt Controller.

Interrupt exception handling is conducted as follows:

- 1. The values in the program counter (PC) and condition code register (CCR) are saved to the stack.
- 2. A vector address corresponding to the interrupt source is generated, the start address is loaded from the vector table to the PC, and program execution begins from that address.

4.5 Trap Instruction Exception Handling

Trap instruction exception handling starts when a TRAPA instruction is executed. Trap instruction exception handling can be executed at all times in the program execution state.

Trap instruction exception handling is conducted as follows:

- 1. The values in the program counter (PC) and condition code register (CCR) are saved to the stack.
- 2. A vector address corresponding to the interrupt source is generated, the start address is loaded from the vector table to the PC, and program execution starts from that address.

The TRAPA instruction fetches a start address from a vector table entry corresponding to a vector number from 0 to 3, as specified in the instruction code.

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Table 4.3 shows the status of CCR after execution of trap instruction exception handling.

Table 4.3 Status of CCR after Trap Instruction Exception Handling

| | | CCR | |
|------------------------|---|--------------|--|
| Interrupt Control Mode | Ī | UI | |
| 0 | 1 | _ | |
| 1 | 1 | 1 | |

Legend

1: Set to 1

—: Retains value prior to execution

4.6 Stack Status after Exception Handling

Figure 4.2 shows the stack after completion of trap instruction exception handling and interrupt exception handling.

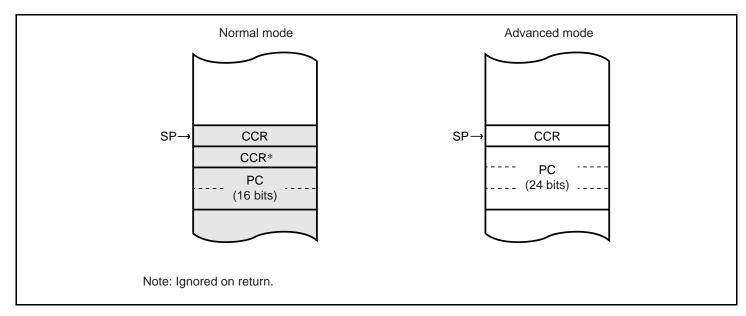


Figure 4.2 Stack Status after Exception Handling

4.7 Usage Note

When accessing word data or longword data, this LSI assumes that the lowest address bit is 0. The stack should always be accessed in words or longwords, and the value of the stack pointer (SP: ER7) should always be kept even.

Use the following instructions to save registers:

```
PUSH.W Rn (or MOV.W Rn, @-SP)
PUSH.L ERn (or MOV.L ERn, @-SP)
```

Use the following instructions to restore registers:

```
POP.W Rn (or MOV.W @SP+, Rn)
POP.L ERn (or MOV.L @SP+, ERn)
```

Setting SP to an odd value may lead to a malfunction. Figure 4.3 shows an example of what happens when the SP value is odd.

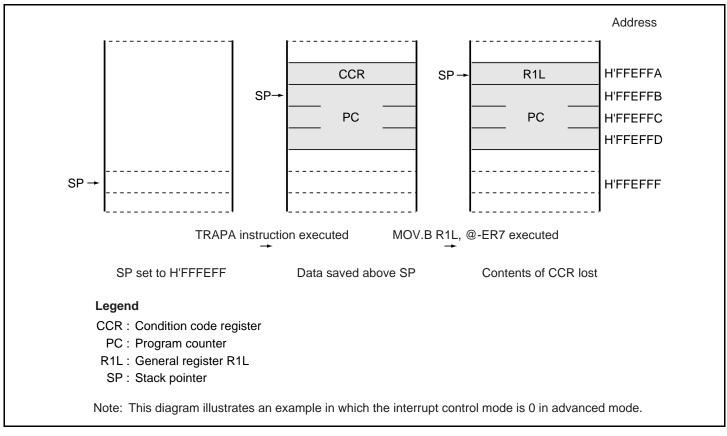


Figure 4.3 Operation when SP Value is Odd

Section 5 Interrupt Controller

5.1 Features

• Two interrupt control modes

Any of two interrupt control modes can be set by means of the INTM1 and INTM0 bits in the system control register (SYSCR).

• Priorities settable with ICR

An interrupt control register (ICR) is provided for setting interrupt priorities. Three priority levels can be set for each module for all interrupts except NMI and address break.

Independent vector addresses

All interrupt sources are assigned independent vector addresses, making it unnecessary for the source to be identified in the interrupt handling routine.

• Thirty-one external interrupts

NMI is the highest-priority interrupt, and is accepted at all times. Rising edge or falling edge detection can be selected for NMI. Falling-edge, rising-edge, or both-edge detection, or level sensing, can be selected for $\overline{IRQ7}$ to $\overline{IRQ0}$. The IRQ6 interrupt is shared by the interrupt from the $\overline{IRQ6}$ pin and eight external interrupt inputs ($\overline{KIN7}$ to $\overline{KIN0}$), and the IRQ7 interrupt is shared by the interrupt from the $\overline{IRQ7}$ pin and sixteen external interrupt inputs ($\overline{KIN15}$ to $\overline{KIN8}$ and $\overline{WUE7}$ to $\overline{WUE0}$). $\overline{KIN15}$ to $\overline{KIN0}$ and $\overline{WUE7}$ to $\overline{WUE0}$ can be masked individually by the user program.

• DTC control

The DTC can be activated by an interrupt request.

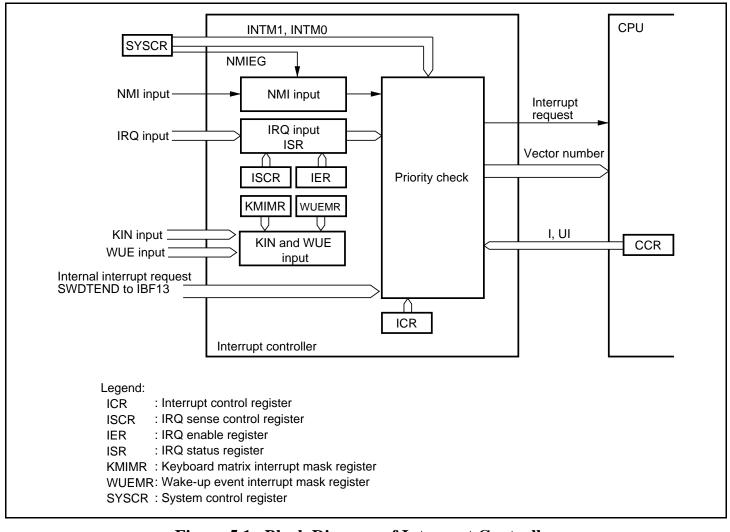


Figure 5.1 Block Diagram of Interrupt Controller

5.2 Input/Output Pins

Table 5.1 summarizes the pins of the interrupt controller.

Table 5.1 Pin Configuration

| Symbol | I/O | Function |
|---------------|-------|--|
| NMI | Input | Nonmaskable external interrupt |
| | | Rising edge or falling edge can be selected |
| IRQ7 to IRQ0 | Input | Maskable external interrupts |
| | | Rising edge, falling edge, or both edges, or level sensing, can be selected individually for each pin. |
| KIN15 to KIN0 | Input | Maskable external interrupts |
| | | Falling edge or level sensing can be selected. |
| WUE7 to WUE0* | Input | Maskable external interrupts |
| | | Falling edge or level sensing can be selected. |

Note:* Not supported by the H8S/2148B.

5.3 Register Descriptions

The interrupt controller has the following registers. For details on the system control register (SYSCR), refer to section 3.2.2, System Control Register (SYSCR).

- Interrupt control registers A to C (ICRA to ICRC)
- Address break control register (ABRKCR)
- Break address registers A to C (BARA to BARC)
- IRQ sense control registers (ISCRH, ISCRL)
- IRQ enable register (IER)
- IRQ status register (ISR)
- Keyboard matrix interrupt mask registers (KMIMRA, KMIMR)
- Wake-up event interrupt mask register (WUEMRB)

5.3.1 Interrupt Control Registers A to C (ICRA to ICRC)

The ICR registers set interrupt control levels for interrupts other than NMI and address breaks.

The correspondence between interrupt sources and ICRA to ICRC settings is shown in table 5.2.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|-------------|---------------|-----|--|
| 7 | ICRn7 | All 0 | R/W | Interrupt Control Level |
| to 0 | to IRCn0 | | | 0: Corresponding interrupt source is interrupt control level 0 (no priority) |
| | | | | 1: Corresponding interrupt source is interrupt control level 1 (priority) |
| | A O | | | |

n: A to C

Table 5.2 Correspondence between Interrupt Source and ICR

Register

| Bit | Bit Name | ICRA | ICRB | ICRC |
|-----|----------|------------|------------------------------------|-------|
| DIL | DIL Name | ICRA | ICRB | ICRC |
| 7 | ICRn7 | IRQ0 | A/D converter | SCI_0 |
| 6 | ICRn6 | IRQ1 | FRT | SCI_1 |
| 5 | ICRn5 | IRQ2, IRQ3 | _ | SCI_2 |
| 4 | ICRn4 | IRQ4, IRQ5 | _ | IIC_0 |
| 3 | ICRn3 | IRQ6, IRQ7 | TMR_0 | IIC_1 |
| 2 | ICRn2 | DTC | TMR_1 | _ |
| 1 | ICRn1 | WDT_0 | TMR_X , TMR_Y | LPC* |
| 0 | ICRn0 | WDT_1 | XBS, Keyboard buffer controller | _ |

n: A to C

Note:* On products not including LPC, this bit is reserved. The write value should always be 0.

^{—:} Reserved. The write value should always be 0.

5.3.2 Address Break Control Register (ABRKCR)

ABRKCR controls the address breaks. When both the CMF flag and BIE flag are set to 1, an address break is requested.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|---|
| 7 | CMF | 0 | R | Condition Match Flag |
| | | | | Address break source flag. Indicates that an address specified by BARA to BARC is prefetched. |
| | | | | [Setting condition] |
| | | | | When an address specified by BARA to BARC is prefetched while the BIE flag is set to 1. |
| | | | | [Clearing condition] |
| | | | | When an exception handling is executed for an address break interrupt. |
| 6 | <u> </u> | All 0 | R | Reserved |
| to 1 | | | | These bits are always read as 0 and cannot be modified. |
| 0 | BIE | 0 | R/W | Break Interrupt Enable |
| | | | | Enables or disables address break. |
| | | | | 0: Disabled |
| | | | | 1: Enabled |

5.3.3 Break Address Registers A to C (BARA to BARC)

The BAR registers specify an address that is to be a break address. An address in which the first byte of an instruction exists should be set as a break address. In normal mode, addresses A23 to A16 are not compared.

BARA

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|-----------|---------------|-----|---|
| 7 | A23 | All 0 | R/W | Addresses 23 to 16 |
| to 0 | to A16 | | | The A23 to A16 bits are compared with A23 to A16 in the internal address bus. |

• BARB

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|---|
| 7 | A15 | All 0 | R/W | Addresses 15 to 8 |
| to 0 | to A8 | | | The A15 to A8 bits are compared with A15 to A8 in the internal address bus. |

• BARC

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|---|
| 7 | A7 | All 0 | R/W | Addresses 7 to 1 |
| to 1 | to A1 | | | The A7 to A1 bits are compared with A7 to A1 in the internal address bus. |
| 0 | _ | 0 | R | Reserved |
| | | | | This bit is always read as 0 and cannot be modified. |

5.3.4 IRQ Sense Control Registers (ISCRH, ISCRL)

The ISCR registers select the source that generates an interrupt request at pins $\overline{IRQ7}$ to $\overline{IRQ0}$.

• ISCRH

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | IRQ7SCB | 0 | R/W | IRQn Sense Control B |
| 6 | IRQ7SCA | 0 | R/W | IRQn Sense Control A |
| 5 | IRQ6SCB | 0 | R/W | 00: Interrupt request generated at low level of |
| 4 | IRQ6SCA | 0 | R/W | IRQn input |
| 3 | IRQ5SCB | 0 | R/W | 01: Interrupt request generated at falling edge of IRQn input |
| 2 | IRQ5SCA | 0 | R/W | 10: Interrupt request generated at rising edge of |
| 1 | IRQ4SCB | 0 | R/W | IRQn input |
| 0 | IRQ4SCA | 0 | R/W | 11: Interrupt request generated at both falling and rising edges of IRQn input |
| | | | | (n = 7 to 4) |

• ISCRL

| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|-----|---|--|
| 7 | IRQ3SCB | 0 | R/W | IRQn Sense Control B | |
| 6 | IRQ3SCA | 0 | R/W | IRQn Sense Control A | |
| 5 | IRQ2SCB | 0 | R/W | 00: Interrupt request generated at low level of | |
| 4 | IRQ2SCA | 0 | R/W | IRQn input | |
| 3 | IRQ1SCB | 0 | R/W | 01: Interrupt request generated at falling edge of IRQn input | |
| 2 | IRQ1SCA | 0 | R/W | 10: Interrupt request generated at rising edge of | |
| 1 | IRQ0SCB | 0 | R/W | IRQn input | |
| 0 | IRQ0SCA | 0 | R/W | 11: Interrupt request generated at both falling and rising edges of IRQn input | |
| | | | | (n = 3 to 0) | |

5.3.5 IRQ Enable Register (IER)

IER controls the enabling and disabling of interrupt requests IRQ7 to IRQ0.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | IRQ7E | 0 | R/W | IRQn Enable (n = 7 to 0) |
| 6 | IRQ6E | 0 | R/W | The IRQn interrupt request is enabled when this |
| 5 | IRQ5E | 0 | R/W | bit is 1. |
| 4 | IRQ4E | 0 | R/W | |
| 3 | IRQ3E | 0 | R/W | |
| 2 | IRQ2E | 0 | R/W | |
| 1 | IRQ1E | 0 | R/W | |
| 0 | IRQ0E | 0 | R/W | |

5.3.6 IRQ Status Register (ISR)

The ISR register is a flag register that indicates the status of IRQ7 to IRQ0 interrupt requests.

| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|---------------------|--|--|
| 7 | IRQ7F | 0 | R/(W)*2 | [Setting condition] | |
| 6 | IRQ6F | 0 | R/(W)*2 | When the interrupt source selected by the ISCR | |
| 5 | IRQ5F | 0 | R/(W)* ² | registers occurs | |
| 4 | IRQ4F | 0 | R/(W)*2 | [Clearing conditions] | |
| 3 | IRQ3F | 0 | R/(W)*2 | When reading IRQnF flag when IRQnF = 1, | |
| 2 | IRQ2F | 0 | R/(W)*2 | then writing 0 to IRQnF flag | |
| 1 | IRQ1F | 0 | R/(W)*2 | When interrupt exception handling is | |
| 0 | IRQ0F | 0 | R/(W)* ² | executed when low-level detection is set and \overline{IRQn} input is high $(n = 7 \text{ to } 0)^{*1}$ | |
| | | | | When IRQn interrupt exception handling is executed when falling-edge, rising-edge, or both-edge detection is set*1 | |

Notes: 1. When a product, in which a DTC is incorporated, is used, the corresponding flag bit is not automatically cleared even when exception handing is executed. For details, refer to section 5.8.4, Setting on a Product Incorporating DTC.

2. Only 0 can be written, for flag clearing.

5.3.7 Keyboard Matrix Interrupt Mask Registers (KMIMRA, KMIMR) Wake-Up Event Interrupt Mask Register (WUEMRB)

The KMIMRA, KMIMR, and WUEMRB registers enable or disable key-sensing interrupt inputs $(\overline{KIN15} \text{ to } \overline{KIN0})$, and wake-up event interrupt inputs $(\overline{WUE7} \text{ to } \overline{WUE0})$.

KMIMRA

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KMIMR15 | 1 | R/W | Keyboard Matrix Interrupt Mask 15 to 8 |
| 6 | KMIMR14 | 1 | R/W | These bits enable or disable a key-sensing |
| 5 | KMIMR13 | 1 | R/W | input interrupt request (KIN15 to KIN8). |
| 4 | KMIMR12 | 1 | R/W | 0: Enables a key-sensing input interrupt request |
| 3 | KMIMR11 | 1 | R/W | 1: Disables a key-sensing input interrupt |
| 2 | KMIMR10 | 1 | R/W | request |
| 1 | KMIMR9 | 1 | R/W | |
| 0 | KMIMR8 | 1 | R/W | |

KMIMR

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KMIMR7 | 1 | R/W | Keyboard Matrix Interrupt Mask 7 to 0 |
| 6 | KMIMR6 | 0 | R/W | These bits enable or disable a key-sensing |
| 5 | KMIMR5 | 1 | R/W | input interrupt request (KIN7 to KIN0). |
| 4 | KMIMR4 | 1 | R/W | KMIMR6 also performs interrupt request mask control for pin IRQ6. |
| 3 | KMIMR3 | 1 | R/W | · |
| 2 | KMIMR2 | 1 | R/W | 0: Enables a key-sensing input interrupt request |
| 1 | KMIMR1 | 1 | R/W | Disables a key-sensing input interrupt request |
| 0 | KMIMR0 | 1 | R/W | • |

WUEMRB*

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | WUEMR7 | 1 | R/W | Wake-Up Event Interrupt Mask 7 to 0 |
| 6 | WUEMR6 | 1 | R/W | These bits enable or disable a wake-up event |
| 5 | WUEMR5 | 1 | R/W | input interrupt request (WUE7 to WUE0). |
| 4 | WUEMR4 | 1 | R/W | Enables a wake-up event input interrupt |
| 3 | WUEMR3 | 1 | R/W | request |
| 2 | WUEMR2 | 1 | R/W | 1: Disables a wake-up event input interrupt request |
| 1 | WUEMR1 | 1 | R/W | · |
| 0 | WUEMR0 | 1 | R/W | |

Note:* Not supported by the H8S/2148B.

Figure 5.2 shows the relationship between interrupts IRQ7 and IRQ6, interrupts KIN15 to KIN0, interrupts WUE7 to WUE0, and registers KMIMRA, KMIMR, and WUEMRB.

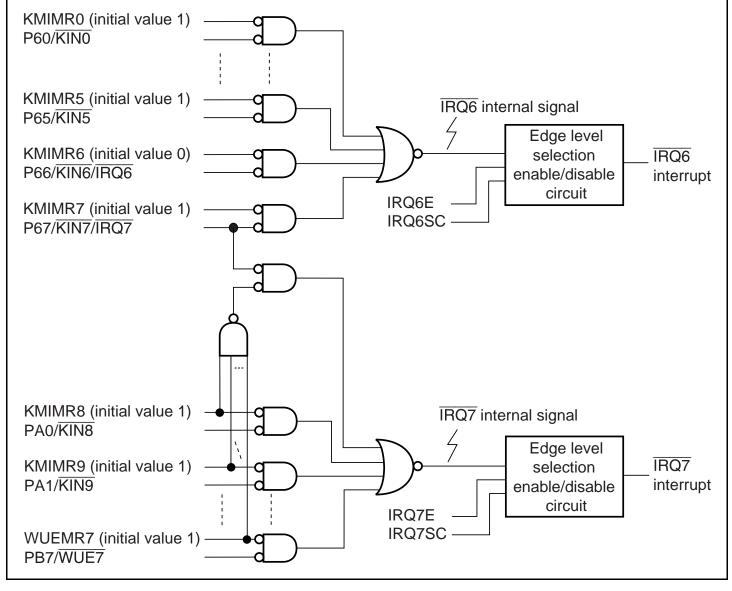


Figure 5.2 Relationship between Interrupts IRQ7 and IRQ6, Interrupts KIN15 to KIN0, Interrupts WUE7 to WUE0, and Registers KMIMR, KMIMRA, and WUEMRB

If any of bits KMIMR15 to KMIMR8 or WUEMRB7 to WUEMRB0 is cleared to 0, interrupt input from the $\overline{IRQ7}$ pin will be ignored. When pins $\overline{KIN7}$ to $\overline{KIN0}$, $\overline{KIN15}$ to $\overline{KIN8}$, or $\overline{WUE7}$ to $\overline{WUE0}$ are used as key-sense interrupt input pins or wakeup event interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6 or IRQ7).

5.4 Interrupt Sources

5.4.1 External Interrupts

There are four types of external interrupts: NMI, IRQ7 to IRQ0, KIN15 to KIN0 and WUE7 to WUE0. WUE7 to WUE0 and KIN15 to KIN8 share the IRQ7 interrupt source, and KIN7 to KIN0 share the IRQ6 interrupt source. Of these, NMI, IRQ7, IRQ6, and IRQ2 to IRQ0 can be used to restore this LSI from software standby mode.

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NMI Interrupt: NMI is the highest-priority interrupt, and is always accepted by the CPU regardless of the interrupt control mode or the status of the CPU interrupt mask bits. The NMIEG bit in SYSCR can be used to select whether an interrupt is requested at a rising edge or a falling edge on the NMI pin.

IRQ7 to IRQ0 Interrupts: Interrupts IRQ7 to IRQ0 are requested by an input signal at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$. Interrupts IRQ7 to IRQ0 have the following features:

- The interrupt exception handling for interrupt requests IRQ7 to IRQ0 can be started at an independent vector address.
- Using ISCR, it is possible to select whether an interrupt is generated by a low level, falling edge, rising edge, or both edges, at pins $\overline{IRQ7}$ to $\overline{IRQ0}$.
- Enabling or disabling of interrupt requests IRQ7 to IRQ0 can be selected with IER.
- Interrupt control levels can be specified by the ICR settings.
- The status of interrupt requests IRQ7 to IRQ0 is indicated in ISR. ISR flags can be cleared to 0 by software.

The detection of IRQ7 to IRQ0 interrupts does not depend on whether the relevant pin has been set for input or output. However, when a pin is used as an external interrupt input pin, do not clear the corresponding DDR to 0 to use the pin as an I/O pin for another function.

A block diagram of interrupts IRQ7 to IRQ0 is shown in figure 5.3.

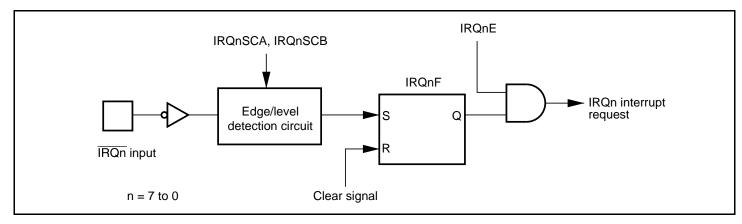


Figure 5.3 Block Diagram of Interrupts IRQ7 to IRQ0

When pin $\overline{IRQ6}$ is used as an IRQ6 interrupt input pin, clear the KMIMR6 bit to 0.

When pin $\overline{IRQ7}$ is used as an IRQ7 interrupt pin, set all of bits KMIMR15 to KMIMR8 and WUEMR7 to WUEMR0 to 1. If any of these bits is cleared to 0, IRQ7 interrupt input from the $\overline{IRQ7}$ pin will be ignored.

Since interrupt request flags IRQ7F to IRQ0F are set each time the setting condition is satisfied, regardless of the IER setting, refer to a needed flag only.

KIN15 to KIN0 Interrupts, WUE7 to WUE0 Interrupts: Interrupts KIN15 to KIN0 and WUE7 to WUE0 are requested by an input signal at pins KIN15 to KIN0 and WUE7 to WUE0. When pins KIN15 to KIN0 and WUE7 to WUE0 are used for key-sense input or wakeup event, clear the corresponding KMIMR and WUEMR bits to 0 in order to enable their key-sense input and wakeup event interrupts. Remaining unused KMIMR and WUEMR bits for key-sense input should be set to 1 in order to disable interrupts. Interrupts WUE7 to WUE0 and KIN15 to KIN8 generate IRQ7 interrupts, and interrupts KIN7 to KIN0 generate IRQ6 interrupts. The pin conditions for interrupt request generation, enable of interrupt requests, settings of interrupt control levels, and status display of interrupt requests depend on each setting and display of the IRQ7 or IRQ6 interrupt.

When pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$, $\overline{\text{KIN15}}$ to $\overline{\text{KIN8}}$, or $\overline{\text{WUE7}}$ to $\overline{\text{WUE0}}$ are used as key-sense interrupt input pins or wakeup event interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6 or IRQ7).

5.4.2 Internal Interrupts

Internal interrupts issued from the on-chip peripheral modules have the following features:

- 1. For each on-chip peripheral module there are flags that indicate the interrupt request status, and enable bits that individually select enabling or disabling of these interrupts. When the enable bit for a particular interrupt source is set to 1, an interrupt request is sent to the interrupt controller.
- 2. The control level for each interrupt can be set by ICR.
- 3. The DTC can be activated by an interrupt request from an on-chip peripheral module.
- 4. An interrupt request that activates the DTC is not affected by the interrupt control mode or the status of the CPU interrupt mask bits.

5.5 Interrupt Exception Handling Vector Table

Table 5.3 lists interrupt exception handling sources, vector addresses, and interrupt priorities. For default priorities, the lower the vector number, the higher the priority. Modules set at the same priority will conform to their default priorities. Priorities within a module are fixed.

An interrupt control level can be specified for a module to which an ICR bit is assigned. Interrupt requests from modules that are set to control level 1 (priority) by the ICR bit setting and the I and UI bits in CCR are given priority and processed before interrupt requests from modules that are set to control level 0 (no priority).

Table 5.3 Interrupt Sources, Vector Addresses, and Interrupt Priorities

| Origin of | | | Vect | or Address | | | |
|---------------------|---|--|--|--|----------|----------|--|
| Interrupt Source | Name | Vector Number | Normal Advance Mode Mode | | — ICR | Priority | |
| External pin | NMI | 7 | H'000E | H'00001C | _ | High | |
| | IRQ0 | 16 | H'0020 | H'000040 | ICRA7 | _ 🛉 | |
| | IRQ1 | 17 | H'0022 | H'000044 | ICRA6 | _ | |
| | IRQ2 IRQ3 | 18 19 | H'0024 H'0026 | H'000048 H'00004C | ICRA5 | _ | |
| | IRQ4 IRQ5 | 20 21 | H'0028 H'002A | H'000050 H'000054 | ICRA4 | _ | |
| | IRQ6, KIN7 to KIN0 IRQ7, KIN15 to KIN8, WUE7 to WUE0 | 22 23 | H'002C H'002E | H'000058 H'00005C | ICRA3 | | |
| DTC | SWDTEND (Software activation data transfer end) | 24 | H'0030 | H'000060 | ICRA2 | _ | |
| WDT_0 | WOVI0 (Interval timer) | 25 | H'0032 | H'000064 | ICRA1 | | |
| WDT_1 | WOVI1 (Interval timer) | 26 | H'0034 | H'000068 | ICRA0 | _ | |
| _ | Address break | 27 | H'0036 | H'00006C | _ | _ | |
| A/D converter | ADI (A/D conversion end) | 28 | H'0038 | H'000070 | ICRB7 | _ | |
| _ | Reserved for system use | 29 to 47 | H'003A to H'005E | H'000074 to H'0000BC | _ | | |
| FRT | ICIA (Input capture A) ICIB (Input capture B) ICIC (Input capture C) ICID (Input capture D) OCIA (Output compare A) OCIB (Output compare B) FOVI (Overflow) Reserved for system use | 48 49 50 51 52 53 54 55 | H'0060 H'0062 H'0064 H'0066 H'0068 H'006A H'006C H'006E | H'0000C0 H'0000C4 H'0000C8 H'0000CC H'0000D0 H'0000D4 H'0000D8 H'0000DC | ICRB6 | | |
| _ | Reserved for system use | 56 to 63 | H'0070 to H'007E | H'0000E0 to H'0000FC | _ | | |
| TMR_0 | CMIA0 (Compare match A) CMIB0 (Compare match A) OVI0 (Overflow) Reserved for system use | 64 65 66 67 | H'0080 H'0082 H'0084 H'0086 | H'000100 H'000104 H'000108 H'00010C | ICRB3 | Low | |

Vector Address Origin of Interrupt Vector Normal **Advanced ICR** Source Name **Number Mode** Mode **Priority** TMR 1 68 H'0088 H'000110 ICRB2 High CMIA1 (Compare match A) CMIB1 (Compare match B) 69 H'008A H'000114 OVI1 (Overflow) 70 H'008C H'000118 Reserved for system use 71 H'008E H'00011C TMR X, CMIAY (Compare match A) 72 H'0090 ICRB1 H'000120 73 H'0092 TMR Y CMIBY (Compare match B) H'000124 OVIY (Overflow) 74 H'0094 H'000128 ICIX (Input capture X) 75 H'0096 H'00012C IBF1 (IDR1 reception completion) 76 **XBS** H'0098 H'000130 ICRB0 IBF2 (IDR2 reception completion) 77 H'009A H'000134 IBF3 (IDR3 reception completion) 78 H'009C H'000138 IBF4 (IDR4 reception completion) 79 H'009E H'00013C SCI_0 ERIO (Reception error 0) 80 H'00A0 H'000140 ICRC7 RXI0 (Reception completion 0) 81 H'00A2 H'000144 TXI0 (Transmission data empty 0) 82 H'00A4 H'000148 TEI0 (Transmission end 0) 83 H'00A6 H'00014C SCI_1 ERI1 (Reception error 1) 84 H'00A8 ICRC6 H'000150 RXI1 (Reception completion 1) 85 H'00AA H'000154 TXI1 (Transmission data empty 1) 86 H'00AC H'000158 TEI1 (Transmission end 1) 87 H'00AE H'00015C SCI 2 ERI2 (Reception error 2) 88 H'00B0 H'000160 ICRC5 RXI2 (Reception completion 2) 89 H'00B2 H'000164 TXI2 (Transmission data empty 2) 90 H'00B4 H'000168 TEI2 (Transmission end 2) H'00B6 91 H'00016C IIC_0 IICI0 (1-byte transmission/ 92 H'00B8 ICRC4 H'000170 reception completion) DDCSWI (Format switch) 93 H'00BA H'000174 IIC_1 IICI1 (1-byte transmission/ 94 H'00BC H'000178 ICRC3 reception completion) Reserved for system use 95 H'00BE H'00017C Keyboard KBIA (Reception completion A) 96 H'00C0 H'000180 ICRB0 buffer KBIB (Reception completion B) 97 H'00C2 H'000184 controller KBIC (Reception completion C) 98 H'00C4 H'000188 Reserved for system use 99 H'00C6 H'00018C 100 Reserved for system use H'00C8 H'000190 to to to

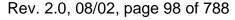
Note:* Reserved for system use on products not including LPC.

IBF1 (IDR1 reception completion)

IBF2 (IDR2 reception completion)

IBF3 (IDR3 reception completion)

ERRI (Transfer error)





107

108

109

110

111

H'00D6

H'00D8

H'00DA

H'00DC

H'00DE

H'0001AC

H'0001B0

H'0001B4

H'0001B8

H'0001BC

ICRC1

Low

LPC*

5.6 Interrupt Control Modes and Interrupt Operation

The interrupt controller has two modes: Interrupt control mode 0 and interrupt control mode 1. Interrupt operations differ depending on the interrupt control mode. NMI interrupts and address break interrupts are always accepted except for in reset state or in hardware standby mode. The interrupt control mode is selected by SYSCR. Table 5.4 shows the interrupt control modes.

Table 5.4 Interrupt Control Modes

| Interrupt Control | SYSCR INTM1 INTM0 | | Priority - Setting | Interrupt | Description | |
|----------------------|-------------------|---|--------------------|-----------|--|--|
| Mode | | | Registers | Mask Bits | | |
| 0 | 0 | 0 | ICR | I | Interrupt mask control is performed by the I bit. Priority levels can be set with ICR. | |
| 1 | _ | 1 | ICR | I, UI | 3-level interrupt mask control is performed by the I bit. Priority levels can be set with ICR. | |

5.6.1 Interrupt Control Mode 0

In interrupt control mode 0, interrupt requests other than NMI and address breaks are masked by ICR and the I bit of the CCR in the CPU. Figure 5.4 shows a flowchart of the interrupt acceptance operation.

- 1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- 2. According to the interrupt control level specified in ICR, the interrupt controller only accepts an interrupt request with interrupt control level 1 (priority), and holds pending an interrupt request with interrupt control level 0 (no priority). If several interrupt requests are issued, an interrupt request with the highest priority is accepted according to the priority order, an interrupt handling is requested to the CPU, and other interrupt requests are held pending.
- 3. If the I bit in CCR is set to 1, only NMI and address break interrupts are accepted by the interrupt controller, and other interrupt requests are held pending. If the I bit is cleared to 0, any interrupt request is accepted.
- 4. When the CPU accepts an interrupt request, it starts interrupt exception handling after execution of the current instruction has been completed.
- 5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
- 6. Next, the I bit in CCR is set to 1. This masks all interrupts except for NMI and address break interrupts.

7. The CPU generates a vector address for the accepted interrupt and starts execution of the interrupt handling routine at the address indicated by the contents of the vector address in the vector table.

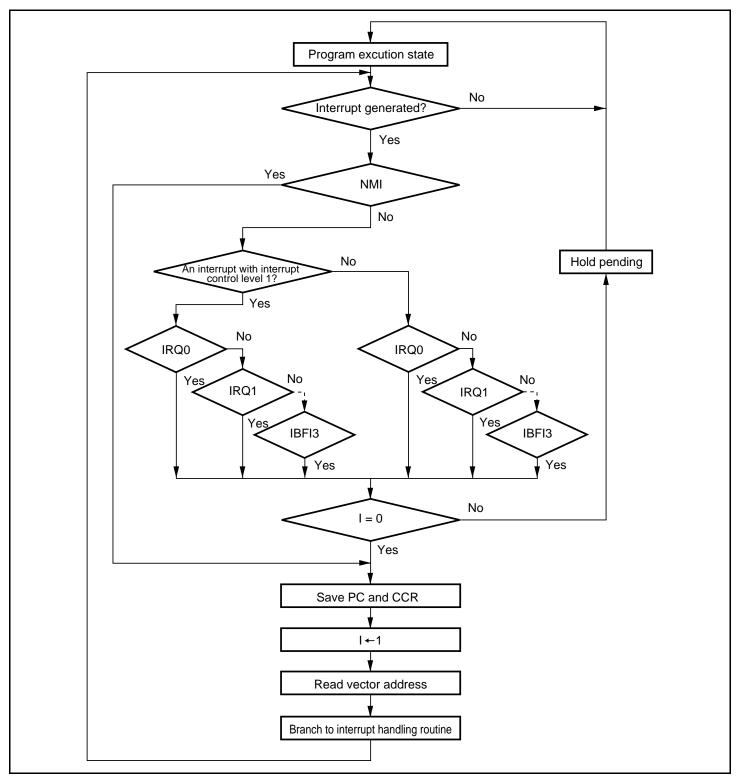


Figure 5.4 Flowchart of Procedure up to Interrupt Acceptance in Interrupt Control Mode 0

5.6.2 Interrupt Control Mode 1

In interrupt control mode 1, mask control is applied to three levels for IRQ and on-chip peripheral module interrupt requests by comparing the I and UI bits in CCR in the CPU, and the ICR setting.

- An interrupt request with interrupt control level 0 is accepted when the I bit in CCR is cleared to 0. When the I bit is set to 1, the interrupt request is held pending
- An interrupt request with interrupt control level 1 is accepted when the I bit or UI bit in CCR is cleared to 0. When both I and UI bits are set to 1, the interrupt request is held pending.

For instance, the state transition when the interrupt enable bit corresponding to each interrupt is set to 1, and ICRA to ICRC are set to H'20, H'00, and H'00, respectively (IRQ2 and IRQ3 interrupts are set to control level 1, and other interrupts are set to control level 0) is shown below. Figure 5.5 shows a state transition diagram.

- All interrupt requests are accepted when I = 0. (Priority order: NMI > IRQ2 > IRQ3 > address break > IRQ0 > IRQ1 ...)
- Only NMI, IRQ2, IRQ3 and address break interrupt requests are accepted when I = 1 and UI = 0.
- Only an NMI and address break interrupt request is accepted when I = 1 and UI = 1.

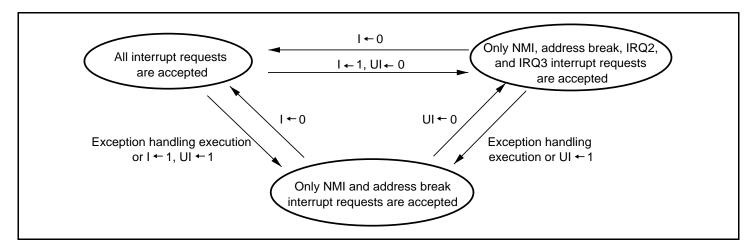


Figure 5.5 State Transition in Interrupt Control Mode 1

Figure 5.6 shows a flowchart of the interrupt acceptance operation.

- 1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- 2. According to the interrupt control level specified in ICR, the interrupt controller only accepts an interrupt request with interrupt control level 1 (priority), and holds pending an interrupt request with interrupt control level 0 (no priority). If several interrupt requests are issued, an interrupt request with the highest priority is accepted according to the priority order, an interrupt handling is requested to the CPU, and other interrupt requests are held pending.

- 3. An interrupt request with interrupt control level 1 is accepted when the I bit is cleared to 0, or when the I bit is set to 1 while the UI bit is cleared to 0.
 - An interrupt request with interrupt control level 0 is accepted when the I bit is cleared to 0. When the I bit is set to 1, only an NMI or address break interrupt request is accepted, and other interrupts are held pending.
 - When both the I and UI bits are set to 1, only an NMI or address break interrupt request is accepted, and other interrupts are held pending.
 - When the I bit is cleared to 0, the UI bit is not affected.
- 4. When the CPU accepts an interrupt request, it starts interrupt exception handling after execution of the current instruction has been completed.
- 5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
- 6. The I and UI bits in CCR are set to 1. This masks all interrupts except for an NMI or address break interrupt.
- 7. The CPU generates a vector address for the accepted interrupt and starts execution of the interrupt handling routine at the address indicated by the contents of the vector address in the vector table.

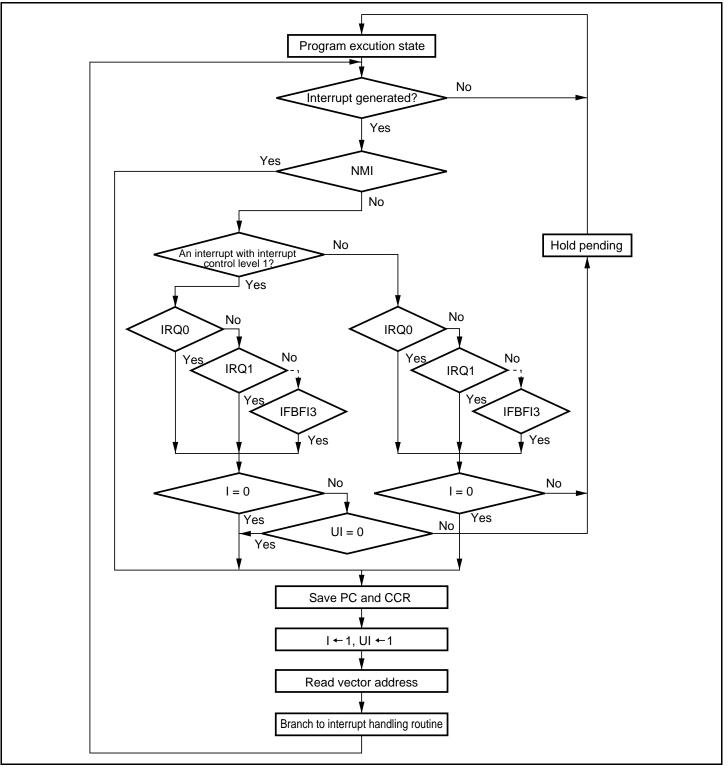


Figure 5.6 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 1

5.6.3 Interrupt Exception Handling Sequence

Figure 5.7 shows the interrupt exception handling sequence. The example shown is for the case where interrupt control mode 0 is set in advanced mode, and the program area and stack area are in on-chip memory.

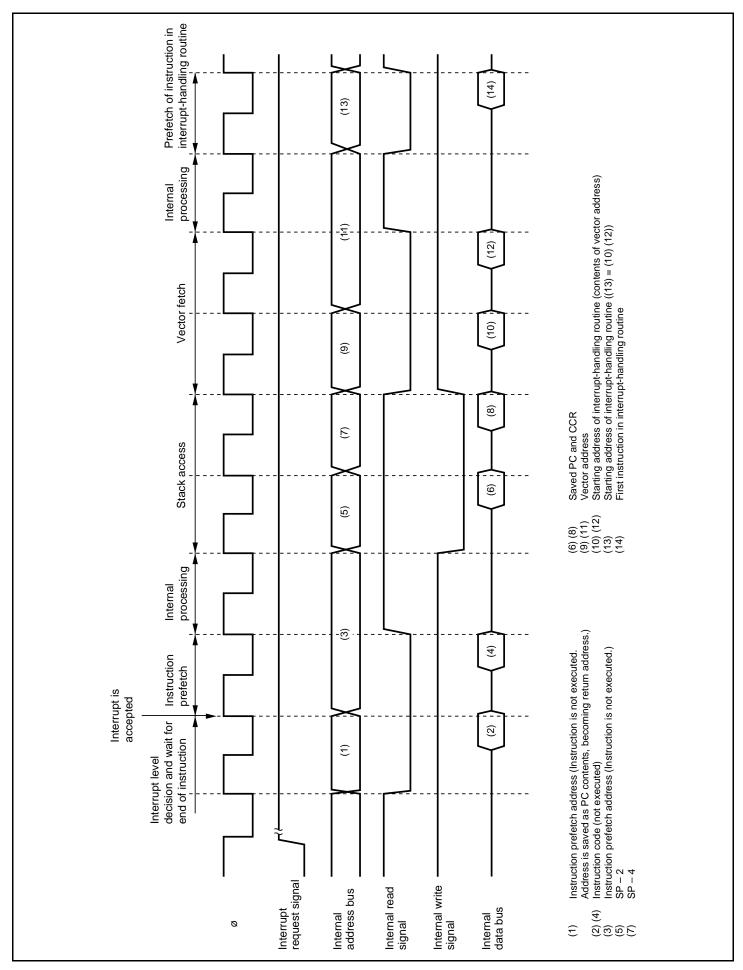


Figure 5.7 Interrupt Exception Handling

5.6.4 Interrupt Response Times

Table 5.5 shows interrupt response times – the intervals between generation of an interrupt request and execution of the first instruction in the interrupt handling routine. The execution status symbols used in table 5.5 are explained in table 5.6.

Table 5.5 Interrupt Response Times

| No. | Execution Status | Normal Mode | Advanced Mode | |
|-----|--|-------------------------------|----------------------|--|
| 1 | Interrupt priority determination*1 | | 3 | |
| 2 | Number of wait states until executing instruction ends* ² | 1 to (19 + 2·S _I) | | |
| 3 | PC, CCR stack save | 2·Sĸ | 2 . Sκ | |
| 4 | Vector fetch | Sı | 2·Sı | |
| 5 | Instruction fetch*3 | | 2·Sı | |
| 6 | Internal processing*4 | | 2 | |
| | Total (using on-chip memory) | 11 to 31 | 12 to 32 | |

Notes: 1. Two states in case of internal interrupt.

- 2. Refers to MULXS and DIVXS instructions.
- 3. Prefetch after interrupt acceptance and prefetch of interrupt handling routine.
- 4. Internal processing after interrupt acceptance and internal processing after vector fetch.

Table 5.6 Number of States in Interrupt Handling Routine Execution Status

| | Object of Access | | | | | | |
|------------------------|--------------------|-------------------|-------------------|-------------------|-------------------|--|--|
| | | | Exter | nal Device | | | |
| | | 8-B | it Bus | 16- | Bit Bus | | |
| Symbol | Internal Memory | 2-State Access | 3-State Access | 2-State Access | 3-State Access | | |
| Instruction fetch Si | 1 | 4 | 6 + 2m | 2 | 3 + m | | |
| Branch address read SJ | | | | | | | |
| Stack manipulation Sk | | | | | | | |
| Legend | | | | | | | |

Legend

m: Number of wait states in external device access

5.6.5 DTC Activation by Interrupt

The DTC can be activated by an interrupt. In this case, the following options are available:

- Interrupt request to CPU
- Activation request to DTC
- Selection of a number of the above

For details on interrupt requests that can be used to activate the DTC, see section 7, Data Transfer Controller (DTC).

Figure 5.8 shows a block diagram of the DTC and interrupt controller.

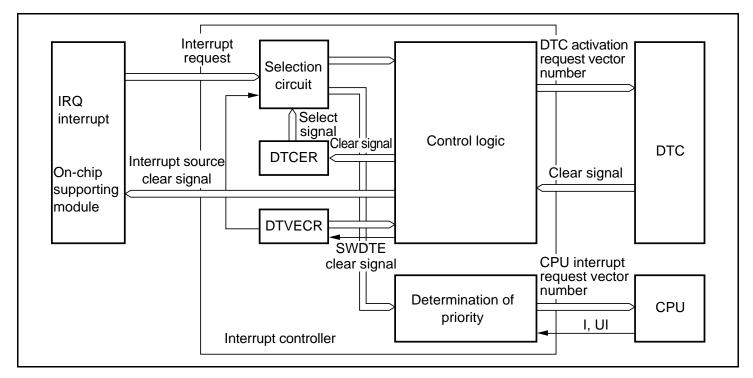


Figure 5.8 DTC and Interrupt Controller

Selection of Interrupt Source: Interrupt factors are selected as DTC activation source or CPU interrupt source by the DTCE bit of DTCERA to DTCERE of DTC.

By specifying the DISEL bit of the DTC's MRB, it is possible to clear the DTCE bit to 0 after DTC data transfer, and request a CPU interrupt.

If DTC carries out the designate number of data transfers and the transfer counter reads 0, after DTC data transfer, the DTCE bit is also cleared to 0, and an interrupt is requested to the CPU.

Determination of Priority: The DTC activation source is selected in accordance with the default priority order, and is not affected by mask or priority levels. See table 7.1 for the respective priority.

Operation Order: If the same interrupt is selected as a DTC activation source and a CPU interrupt source, the DTC data transfer is performed first, followed by CPU interrupt exception handling.

Table 5.7 shows the interrupt factor clear control and selection of interrupt factors by specification of the DTCE bit of DTC's DTCERA to DTCERH, and the DISEL bit of DTC's MRB.

Table 5.7 Interrupt Source Selection and Clearing Control

Settings

| | DTC | Interrupt Sou | rces Selection/Clearing Control |
|------|-------|---------------|---------------------------------|
| DTCE | DISEL | DTC | CPU |
| 0 | * | × | 0 |
| 1 | 0 | 0 | X |
| | 1 | 0 | 0 |

Legend

O: The relevant interrupt is used. Interrupt source clearing is performed.

(The CPU should clear the source flag in the interrupt handling routine.)

o: The relevant interrupt is used. The interrupt source is not cleared.

X: The relevant interrupt cannot be used.

*: Don't care

Note: The SCI, IIC, LPC, or A/D converter interrupt source is cleared when the DTC reads or writes to the prescribed register, and is not dependent upon the DISEL bit.

5.7 Address Break

5.7.1 Features

This LSI can determine the specific address prefetch by the CPU to generate an address break interrupt by setting ABRKCR and BAR. If an address break interrupt is generated, the address break interrupt exception handling is performed.

With this function, the execution start point of a program containing a bug is detected and execution is branched to the correcting program.

RENESAS

5.7.2 Block Diagram

Figure 5.9 shows a block diagram of the address break.

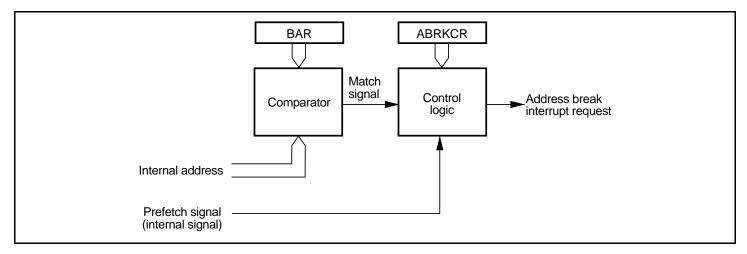


Figure 5.9 Address Break Block Diagram

5.7.3 Operation

If the CPU prefetches an address specified in BAR by setting ABRKCR and BAR, an address break interrupt can be generated. This address break function generates an interrupt request to the interrupt controller at prefetch, and determines the priority by the interrupt controller. When an interrupt is accepted, an interrupt exception handling is activated after the current instruction has been completed. Note that the interrupt mask control according to the I and UI bits in CCR of the CPU is invalid to an address break interrupt.

To use the address break function, set each register as follows:

- 1. Set a break address in the A23 to A1 bits in BAR.
- 2. Set the BIE bit in ABRKCR to 1 to enable the address break.

 When the BIE bit is cleared to 0, an address break is not requested.

When the setting conditions are satisfied, the CMF flag in ABRKCR is set to 1 to request an interrupt. The interrupt source should be determined by the interrupt handling routine if necessary.

5.7.4 Usage Notes

- 1. In an address break, the break address should be an address where the first byte of the instruction exists. Otherwise, a break condition will not be satisfied.
- 2. In normal mode, addresses A23 to A16 are not compared.
- 3. When the branch instructions (Bcc, BSR), jump instructions (JMP, JSR), RST instruction, and RTE instruction are placed immediately prior to the address specified by BAR, a prefetch signal to the address may be output to request an address break by executing these instruction. It is necessary to take countermeasures: do not set a break address to an address immediately after these instructions, or determine whether interrupt handling is performed by satisfaction of a normal condition.
- 4. An address break interrupt is generated by combining the internal prefetch signal and an address. Therefore, the timing to enter the interrupt exception handling differs according to the instructions at the specified and at prior addresses and execution cycles.

Figure 5.10 shows an example of address timing.

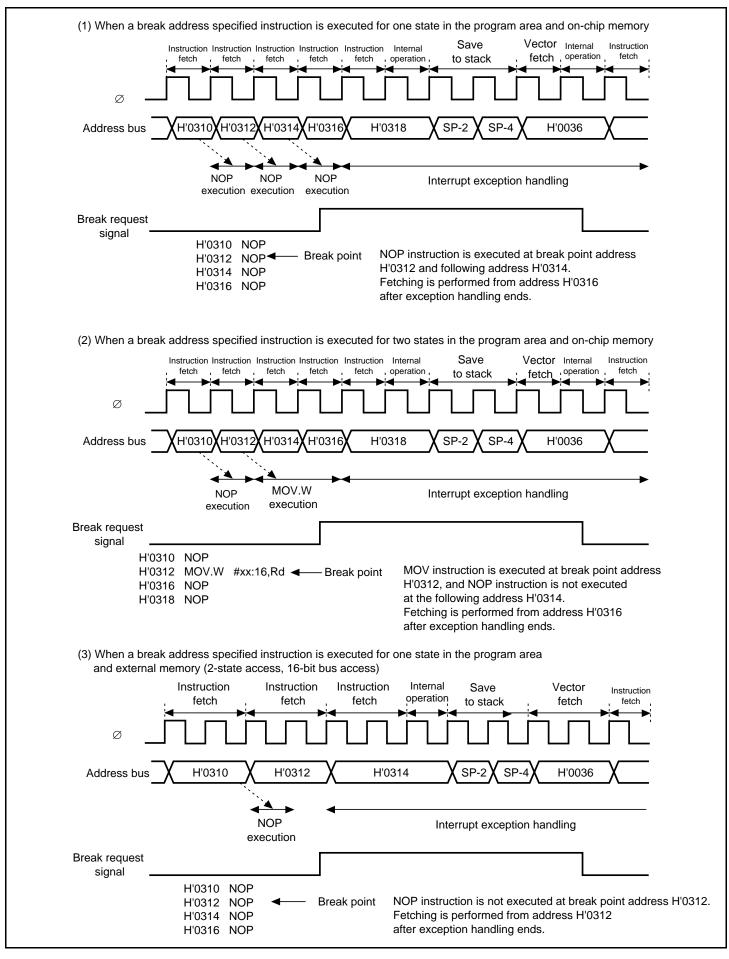


Figure 5.10 Address Break Timing Example

5.8 Usage Notes

5.8.1 Conflict between Interrupt Generation and Disabling

When an interrupt enable bit is cleared to 0 to disable interrupt requests, the disabling becomes effective after execution of the instruction. When an interrupt enable bit is cleared to 0 by an instruction such as BCLR or MOV, and if an interrupt is generated during execution of the instruction, the interrupt concerned will still be enabled on completion of the instruction, so interrupt exception handling for that interrupt will be executed on completion of the instruction. However, if there is an interrupt request of higher priority than that interrupt, interrupt exception handling will be executed for the higher-priority interrupt, and the lower-priority interrupt will be ignored. The same rule is also applied when an interrupt source flag is cleared to 0. Figure 5.11 shows an example in which the CMIEA bit in the TMR's TCR register is cleared to 0.

The above conflict will not occur if an enable bit or interrupt source flag is cleared to 0 while the interrupt is masked.

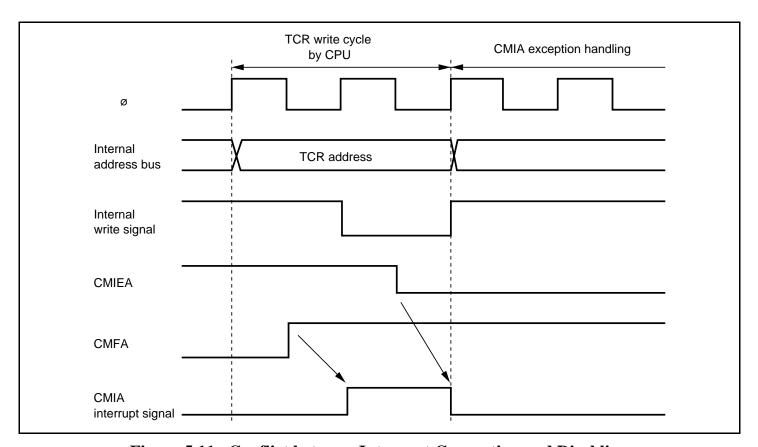


Figure 5.11 Conflict between Interrupt Generation and Disabling

5.8.2 Instructions that Disable Interrupts

The instructions that disable interrupts are LDC, ANDC, ORC, and XORC. After any of these instructions are executed, all interrupts including NMI are disabled and the next instruction is

always executed. When the I bit or UI bit is set by one of these instructions, the new value becomes valid two states after execution of the instruction ends.

5.8.3 Interrupts during Execution of EEPMOV Instruction

Interrupt operation differs between the EEPMOV.B instruction and the EEPMOV.W instruction.

With the EEPMOV.B instruction, an interrupt request (including NMI) issued during the transfer is not accepted until the move is completed.

With the EEPMOV.W instruction, if an interrupt request is issued during the transfer, interrupt exception handling starts at a break in the transfer cycle. The PC value saved on the stack in this case is the address of the next instruction. Therefore, if an interrupt is generated during execution of an EEPMOV.W instruction, the following coding should be used.

L1: EEPMOV.W

MOV.W R4,R4

BNE L1

5.8.4 Setting on Product Incorporating DTC

When a product, in which a DTC is incorporated, is used in the following settings, the corresponding flag bit is not automatically cleared even when exception handing, which is a clear condition, is executed and the bit is held at 1.

- 1. When DTCEA3 is set to 1(ADI is set to an interrupt source), IRQ4F flag is not automatically cleared.
- 2. When DTCEA2 is set to 1(ICIA is set to an interrupt source), IRQ5F flag is not automatically cleared.
- 3. When DTCEA1 is set to 1(ICIB is set to an interrupt source), IRQ6F flag is not automatically cleared.
- 4. When DTCEA0 is set to 1(OCIA is set to an interrupt source), IRQ7F flag is not automatically cleared.

When activation interrupt sources of DTC and IRQ interrupts are used with the above combinations, clear the interrupt flag by software in the interrupt handling routine of the corresponding IRQ.

5.8.5 IRQ Status Register (ISR)

According to the pin status after a reset, IRQnF may be set to 1, so ISR should be read after a reset to write 0. (n = 7 to 0)

Section 6 Bus Controller (BSC)

This LSI has an on-chip bus controller (BSC) that manages the bus width and the number of access states of the external address space. The BSC also has a bus arbitration function, and controls the operation of the internal bus masters – CPU, and data transfer controller (DTC).

6.1 Features

- Basic bus interface
 - 2-state access or 3-state access can be selected for each area
 - Program wait states can be inserted for each area
- Burst ROM interface
 - A burst ROM interface can be set for basic expansion areas
 - 1-state access or 2-state access can be selected for burst access
- Idle cycle insertion
 - An idle cycle can be inserted for external write cycles immediately after external read cycles
- Bus arbitration function
 - Includes a bus arbiter that arbitrates bus mastership between the CPU and DTC

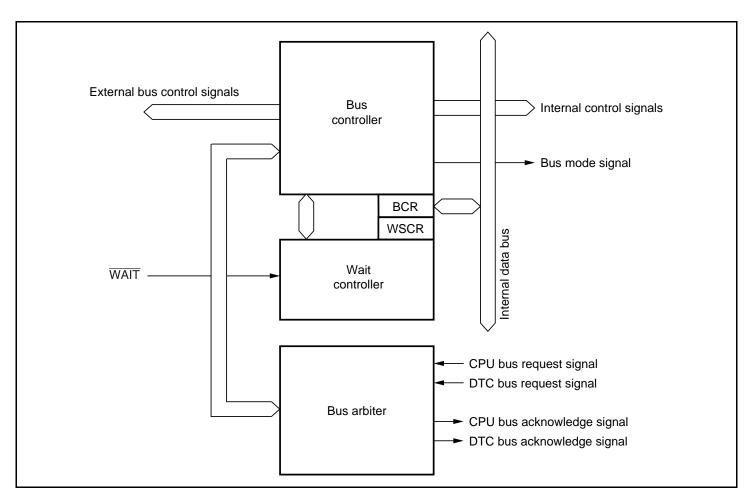


Figure 6.1 Block Diagram of Bus Controller

6.2 Input/Output Pins

Table 6.1 summarizes the pins of the bus controller.

Table 6.1 Pin Configuration

| Symbol | I/O | Function |
|--------|--------|--|
| ĀS | Output | Strobe signal indicating that address output on the address bus is enabled (when the IOSE bit in SYSCR is cleared to 0). |
| ĪOS | Output | I/O select signal (when the IOSE bit in SYSCR is set to 1). |
| RD | Output | Strobe signal indicating that the external address space is being read. |
| HWR | Output | Strobe signal indicating that the external address space is being written to, and the upper half (D15 to D8) of the data bus is enabled. |
| LWR | Output | Strobe signal indicating that the external address space is being written to, and the lower half (D7 to D0) of the data bus is enabled. |
| WAIT | Input | Wait request signal when accessing the external 3-state access space. |

6.3 Register Descriptions

The bus controller has the following registers. For details on the system control register, refer to section 3.2.2, System Control Register (SYSCR).

- Bus control register (BCR)
- Wait state control register (WSCR)

6.3.1 Bus Control Register (BCR)

BCR is used to specify the access mode for the external address space or the I/O area range when the $\overline{AS/IOS}$ pin is specified as an I/O strobe pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | _ | 1 | R/W | Reserved |
| | | | | This bit should not be written by 0. |
| 6 | ICIS0 | 1 | R/W | Idle Cycle Insertion |
| | | | | Selects whether or not to insert 1-state of the idle cycle between bus cycles when the external write cycle follows the external read cycle. |
| | | | | 0: Idle cycle not inserted when the external write cycle follows the external read cycle |
| | | | | 1: 1-state idle cycle inserted when the external write cycle follows the external read cycle |
| 5 | BRSTRM | 0 | R/W | Burst ROM Enable |
| | | | | Selects the bus interface for the external address space. |
| | | | | 0: Basic bus interface |
| | | | | 1: Burst ROM interface |
| 4 | BRSTS1 | 1 | R/W | Burst Cycle Select 1 |
| | | | | Selects the number of states in the burst cycle of the burst ROM interface. |
| | | | | 0: 1 state |
| | | | | 1: 2 states |
| 3 | BRSTS0 | 0 | R/W | Burst Cycle Select 0 |
| | | | | Selects the number of words that can be accessed by burst access via the burst ROM interface. |
| | | | | 0: Max, 4 words |
| | | | | 1: Max, 8 words |
| 2 | _ | 0 | R/W | Reserved |
| | | | | This bit should not be written by 0. |
| 1 | IOS1 | 1 | R/W | IOS Select 1, 0 |
| 0 | IOS0 | 1 | R/W | Select the address range where the $\overline{\text{IOS}}$ signal is output. For details, refer to table 6.3. |

6.3.2 Wait State Control Register (WSCR)

WSCR is used to specify the data bus width for external address space access, the number of access states, the wait mode, and the number of wait states for access to external address spaces. The bus width and the number of access states for internal memory and internal I/O registers are fixed regardless of the WSCR settings.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | _ | 0 | R/W | Reserved |
| 6 | _ | 0 | R/W | These bits should not be written by 1. |
| 5 | ABW | 1 | R/W | Bus Width Control |
| | | | | Selects 8 or 16bits for access to the external address space. |
| | | | | 0: 16-bit access space |
| | | | | 1: 8-bit access space |
| 4 | AST | 1 | R/W | Access State Control |
| | | | | Selects 2 or 3 access states for access to the external address space. This bit also enables or disables waitstate insertion. |
| | | | | 0: 2-state access space. Wait state insertion disabled in external address space access |
| | | | | 1: 3-state access space. Wait state insertion enabled in external address space access |
| 3 | WMS1 | 0 | R/W | Wait Mode Select 1, 0 |
| 2 | WMS0 | 0 | R/W | Select the wait mode for access to the external address space when the AST bit is set to 1. |
| | | | | 00: Program wait mode |
| | | | | 01: Wait disabled mode |
| | | | | 10: Pin wait mode |
| | | | | 11: Pin auto-wait mode |
| 1 | WC1 | 1 | R/W | Wait Count 1, 0 |
| 0 | WC0 | 1 | R/W | Select the number of program wait states to be inserted when the external address space is accessed while the AST bit is set to 1. |
| | | | | 00: Program wait state is not inserted |
| | | | | 01: 1 program wait state is inserted |
| | | | | 10: 2 program wait states are inserted |
| | | | | 11: 3 program wait states are inserted |

6.4 Bus Control

6.4.1 Bus Specifications

The external address space bus specifications consist of three elements: Bus width, the number of access states, and the wait mode and the number of program wait states. The bus width and the number of access states for on-chip memory and internal I/O registers are fixed, and are not affected by the bus controller settings.

Bus Width: A bus width of 8 or 16 bits can be selected via the ABW bit in WSCR.

Number of Access States: Two or three access states can be selected via the AST bit in WSCR. When the 2-state access space is designated, wait-state insertion is disabled.

In the burst ROM interface, the number of access states is determined regardless of the AST bit setting.

Wait Mode and Number of Program Wait States: When a 3-state access space is designated by the AST bit in WSCR, the wait mode and the number of program wait states to be inserted automatically is selected by the WMS1, WMS0, WC1, and WC0 bits in WSCR. From 0 to 3 program wait states can be selected.

Table 6.2 shows the bus specifications for the basic bus interface of each area.

Table 6.2 Bus Specifications for Basic Bus Interface

| | | | | | | В | us Specification | ons |
|-----|-----|------|------|-----|-----|-----------|-------------------------------|--|
| ABW | AST | WMS1 | WMS0 | WC1 | WC0 | Bus Width | Number of Access States | Number of Program Wait States |
| 0 | 0 | _ | _ | _ | _ | 16 | 2 | 0 |
| | 1 | 0 | 1 | _ | _ | 16 | 3 | 0 |
| | | * | * | 0 | 0 | | 3 | 0 |
| | | | | | 1 | | | 1 |
| | | | | 1 | 0 | _ | | 2 |
| | | | | | 1 | | | 3 |
| 1 | 0 | _ | | _ | | 8 | 2 | 0 |
| | 1 | 0 | 1 | _ | | 8 | 3 | 0 |
| | | * | * | 0 | 0 | | 3 | 0 |
| | | | | | 1 | | | 1 |
| | | | | 1 | 0 | | | 2 |
| | | | | | 1 | | | 3 |

Note:* Other than WMS1 = 0 and WMS0 = 1

6.4.2 Advanced Mode

The external address space is initialized as the basic bus interface and a 3-state access space. In on-chip ROM enable extended mode, the address space other than on-chip ROM, on-chip RAM, internal I/O registers, and their reserved areas is specified as the external address space. The on-chip RAM and its reserved area are enabled when the RAME bit in SYSCR is set to 1. The on-chip RAM and its reserved area are disabled and corresponding addresses are the external address space when the RAME bit is cleared to 0.

6.4.3 Normal Mode

The external address space is initialized as the basic bus interface and a 3-state access space. In on-chip ROM disable extended mode, the address space other than on-chip RAM and internal I/O registers is specified as the external address space. In on-chip ROM enable extended mode, the address space other than on-chip ROM, on-chip RAM, internal I/O registers, and their reserved areas is specified as the external address space. The on-chip RAM area is enabled when the

RAME bit in SYSCR is set to 1, and disabled and specified as the external address space when the RAME bit is cleared to 0.

6.4.4 I/O Select Signals

The LSI can output I/O select signals ($\overline{\text{IOS}}$); the signal is driven low when the corresponding external address space is accessed. Figure 6.2 shows an example of $\overline{\text{IOS}}$ signal output timing.

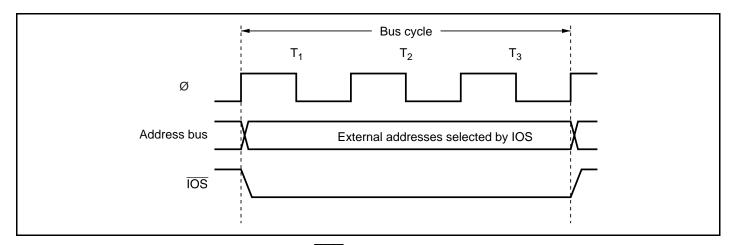


Figure 6.2 **IOS** Signal Output Timing

Enabling or disabling \overline{IOS} signal output is performed by the IOSE bit in SYSCR. In extended mode, the \overline{IOS} pin functions as an \overline{AS} pin by a reset. To use this pin as an \overline{IOS} pin, set the IOSE bit to 1. For details, refer to section 8, I/O Ports.

The address ranges of the $\overline{\text{IOS}}$ signal output can be specified by the IOS1 and IOS0 bits in BCR, as shown in table 6.3.

Table 6.3 Address Range for IOS Signal Output

| IOS1 | IOS0 | IOS Signal Output Range | |
|------|------|--------------------------|-----------------|
| 0 | 0 | H'(FF)F000 to H'(FF)F03F | |
| | 1 | H'(FF)F000 to H'(FF)F0FF | |
| 1 | 0 | H'(FF)F000 to H'(FF)F3FF | |
| | 1 | H'(FF)F000 to H'(FF)F7FF | (Initial value) |

6.5 Basic Bus Interface

The basic bus interface enables direct connection to ROM and SRAM. For details on selection of the bus specifications when using the basic bus interface, see table 6.2

6.5.1 Data Size and Data Alignment

Data sizes for the CPU and other internal bus masters are byte, word, and longword. The BSC has a data alignment function, and controls whether the upper data bus (D15 to D8) or lower data bus (D7 to D0) is used when the external address space is accessed, according to the bus specifications for the area being accessed (8-bit access space or 16-bit access space) and the data size.

8-Bit Access Space: Figure 6.3 illustrates data alignment control for the 8-bit access space. With the 8-bit access space, the upper data bus (D15 to D8) is always used for accesses. The amount of data that can be accessed at one time is one byte: a word access is performed as two byte accesses, and a longword access, as four byte accesses.

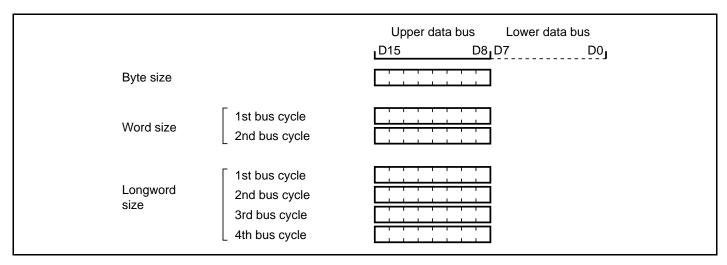


Figure 6.3 Access Sizes and Data Alignment Control (8-Bit Access Space)

16-Bit Access Space: Figure 6.4 illustrates data alignment control for the 16-bit access space. With the 16-bit access space, the upper data bus (D15 to D8) and lower data bus (D7 to D0) are used for accesses. The amount of data that can be accessed at one time is one byte or one word, and a longword access is executed as two word accesses.

In byte access, whether the upper or lower data bus is used is determined by whether the address is even or odd. The upper data bus is used for an even address, and the lower data bus for an odd address.

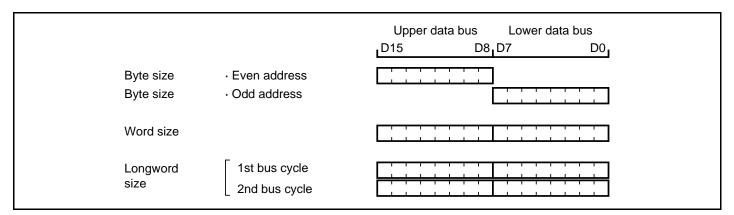


Figure 6.4 Access Sizes and Data Alignment Control (16-bit Access Space)

6.5.2 Valid Strobes

Table 6.4 shows the data buses used and valid strobes for each access space.

In a read, the \overline{RD} signal is valid for both the upper and lower halves of the data bus. In a write, the \overline{HWR} signal is valid for the upper half of the data bus, and the \overline{LWR} signal for the lower half.

Table 6.4 Data Buses Used and Valid Strobes

| Area | Access Size | Read/ Write | Address | Valid Strobe | Upper Data Bus (D15 to D8) | Lower Data Bus (D7 to D0) |
|--------------|----------------|----------------|---------|-----------------|-------------------------------|------------------------------|
| 8-bit | Byte | Read | _ | RD | Valid | Ports or others |
| access space | | Write | _ | HWR | _ | Ports or others |
| 16-bit | Byte | Read | Even | RD | Valid | Invalid |
| access space | | | Odd | _ | Invalid | Valid |
| | | Write | Even | HWR | Valid | Undefined |
| | | | Odd | LWR | Undefined | Valid |
| | Word | Read | _ | RD | Valid | Valid |
| | | Write | _ | HWR, LWR | Valid | Valid |

Note:* Undefined: Undefined data is output.

Invalid: Input state with the input value ignored.

Ports or others: Used as ports or I/O pins for on-chip peripheral modules, and are not used as the data bus.

6.5.3 Basic Operation Timing

8-Bit, 2-State Access Space: Figure 6.5 shows the bus timing for an 8-bit, 2-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used. Wait states cannot be inserted.

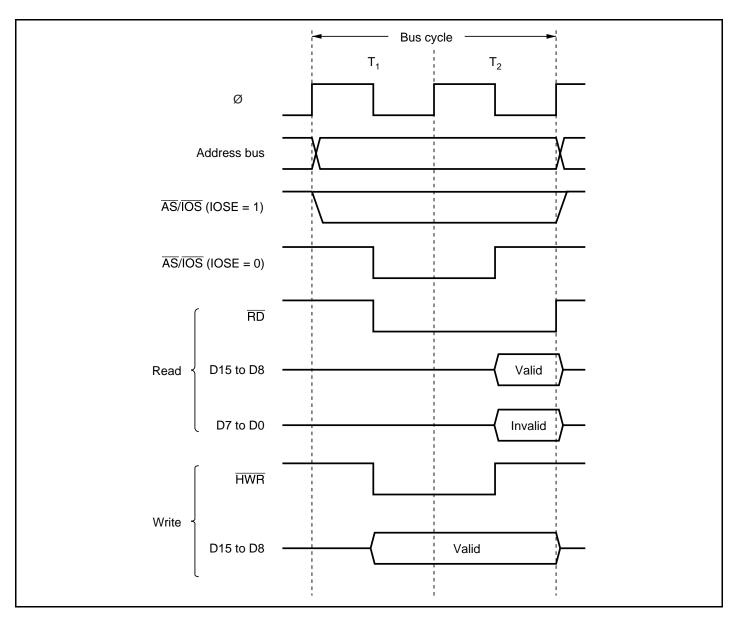


Figure 6.5 Bus Timing for 8-Bit, 2-State Access Space

8-Bit, 3-State Access Space: Figure 6.6 shows the bus timing for an 8-bit, 3-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used. Wait states can be inserted.

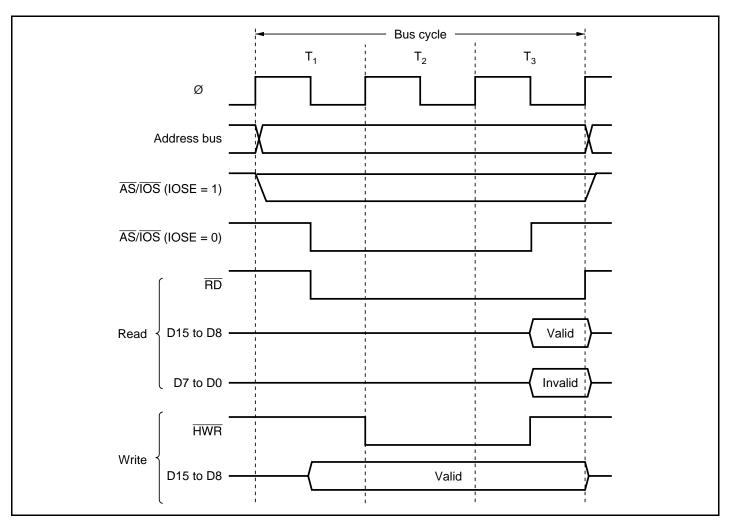


Figure 6.6 Bus Timing for 8-Bit, 3-State Access Space

16-Bit, 2-State Access Space: Figures 6.7 to 6.9 show bus timings for a 16-bit, 2-state access space. When a 16-bit access space is accessed, the upper half (D15 to D8) of the data bus is used for even addresses, and the lower half (D7 to D0) for odd addresses. Wait states cannot be inserted.

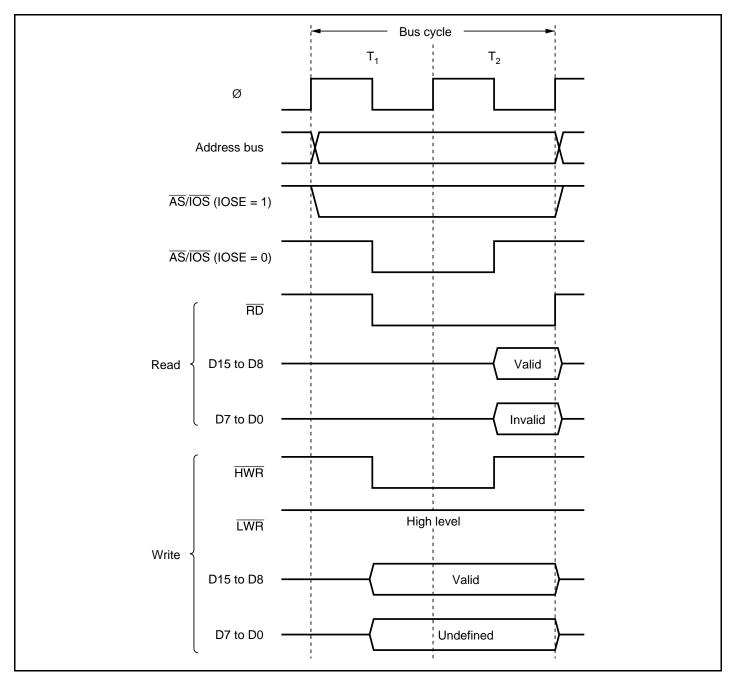


Figure 6.7 Bus Timing for 16-Bit, 2-State Access Space (Even Byte Access)

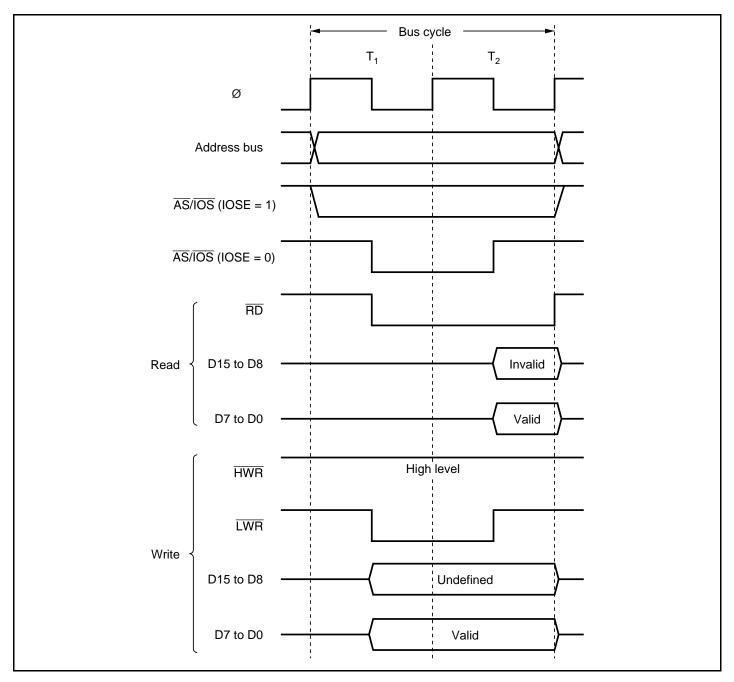


Figure 6.8 Bus Timing for 16-Bit, 2-State Access Space (Odd Byte Access)

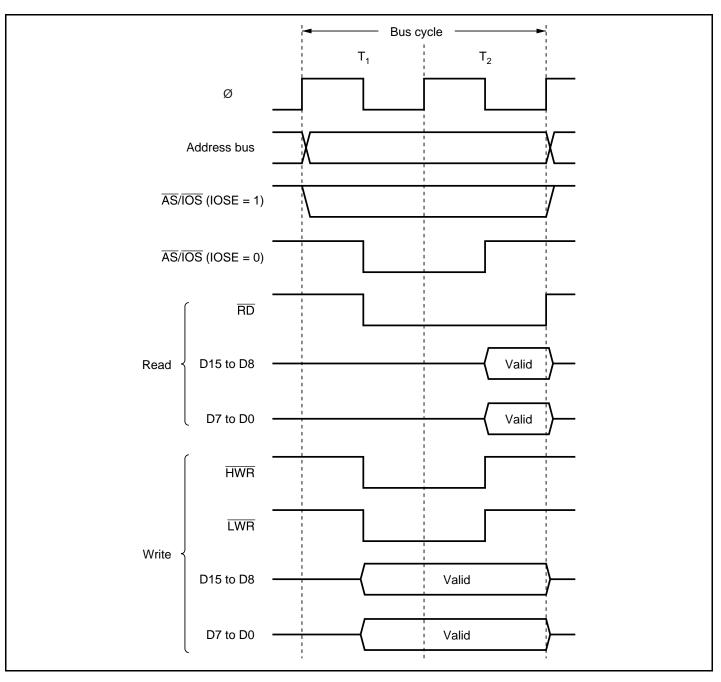


Figure 6.9 Bus Timing for 16-Bit, 2-State Access Space (Word Access)

16-Bit, 3-State Access Space: Figures 6.10 to 6.12 show bus timings for a 16-bit, 3-state access space. When a 16-bit access space is accessed, the upper half (D15 to D8) of the data bus is used for even addresses, and the lower half (D7 to D0) for odd addresses. Wait states can be inserted.

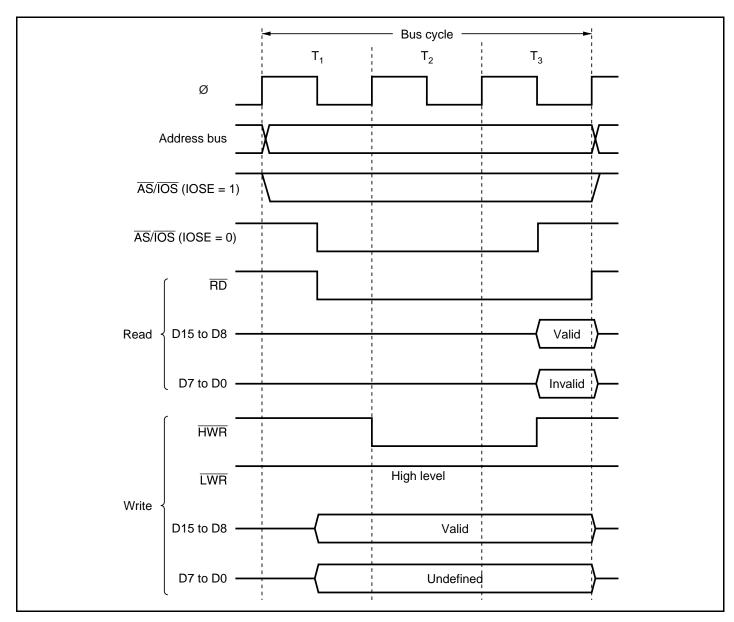


Figure 6.10 Bus Timing for 16-Bit, 3-State Access Space (Even Byte Access)

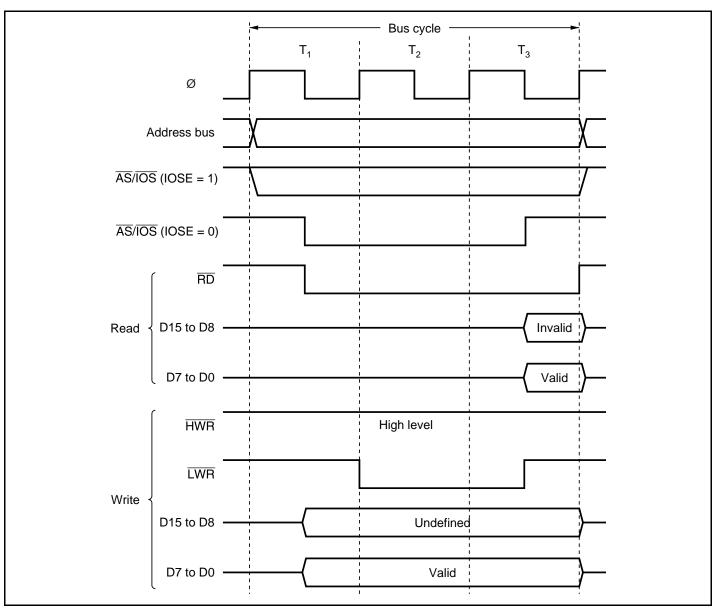


Figure 6.11 Bus Timing for 16-Bit, 3-State Access Space (Odd Byte Access)

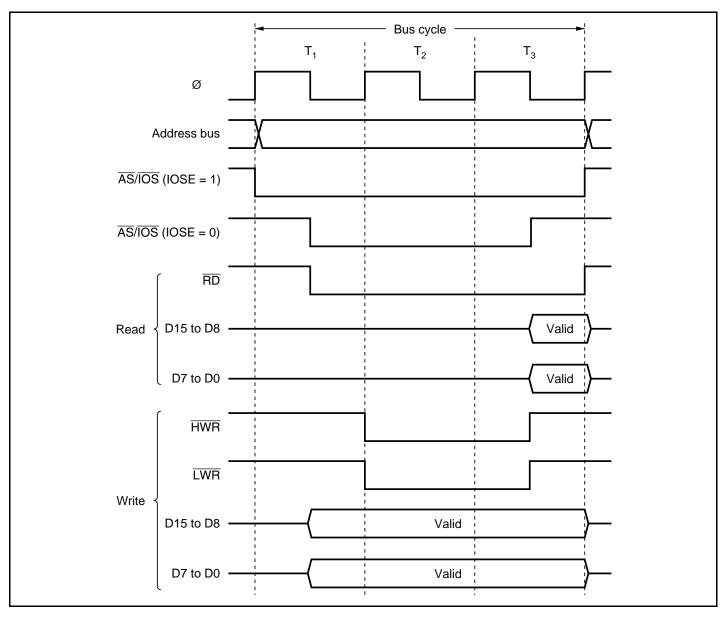


Figure 6.12 Bus Timing for 16-Bit, 3-State Access Space (Word Access)

6.5.4 Wait Control

When accessing the external address space, this LSI can extend the bus cycle by inserting one or more wait states (T_w). There are three ways of inserting wait states: Program wait insertion, pin wait insertion using the \overline{WAIT} pin, and the combination of program wait and the \overline{WAIT} pin.

Program Wait Mode: A specified number of wait states T_w can be inserted automatically between the T_2 state and T_3 state when accessing the external address space always according to the settings of the WC1 and WC0 bits in WSCR.

Pin Wait Mode: A specified number of wait states T_w can be inserted automatically between the T_2 state and T_3 state when accessing the external address space always according to the settings of the WC1 and WC0 bits. If the \overline{WAIT} pin is low at the falling edge of \emptyset in the last T_2 or T_w state, another T_w state is inserted. If the \overline{WAIT} pin is held low, T_w states are inserted until it goes high.

This is useful when inserting four or more T_w states, or when changing the number of T_w states to be inserted for each external device.

Pin Auto-Wait Mode: A specified number of wait states T_w can be inserted automatically between the T_2 state and T_3 state when accessing the external address space according to the settings of the WC1 and WC0 bits if the \overline{WAIT} pin is low at the falling edge of \emptyset in the last T_2 state. Even if the \overline{WAIT} pin is held low, T_w states can be inserted only up to the specified number of states.

This function enables the low-speed memory interface only by inputting the chip select signal to the $\overline{\text{WAIT}}$ pin.

Figure 6.13 shows an example of wait state insertion timing in pin wait mode.

The settings after a reset are: 3-state access, 3 program wait insertion, and WAIT pin input disabled.

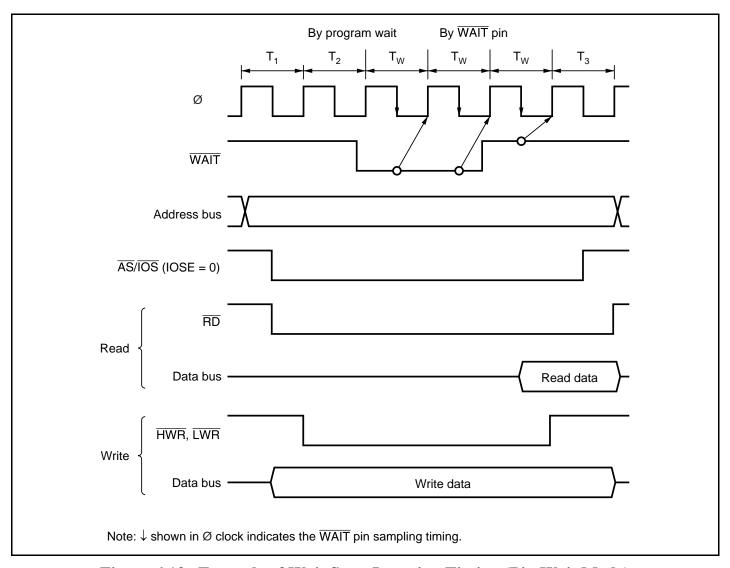


Figure 6.13 Example of Wait State Insertion Timing (Pin Wait Mode)

6.6 Burst ROM Interface

In this LSI, the external address space can be designated as the burst ROM space by setting the BRSTRM bit in BCR to 1, and the burst ROM interface enabled. Consecutive burst accesses of a maximum four or eight words can be performed only during CPU instruction fetch. 1 or 2 states can be selected for burst ROM access.

6.6.1 Basic Operation Timing

The number of access states in the initial cycle (full access) of the burst ROM interface is determined by the AST bit in WSCR. When the AST bit is set to 1, wait states can be inserted. 1 or 2 states can be selected for burst access according to the setting of the BRSTS1 bit in BCR. Wait states cannot be inserted in a burst cycle. Burst accesses of a maximum four words is performed when the BRSTS0 bit in BCR is cleared to 0, and burst accesses of a maximum eight words is performed when the BRSTS0 bit in BCR is set to 1.

The basic access timing for the burst ROM space is shown in figures 6.14 and 6.15.

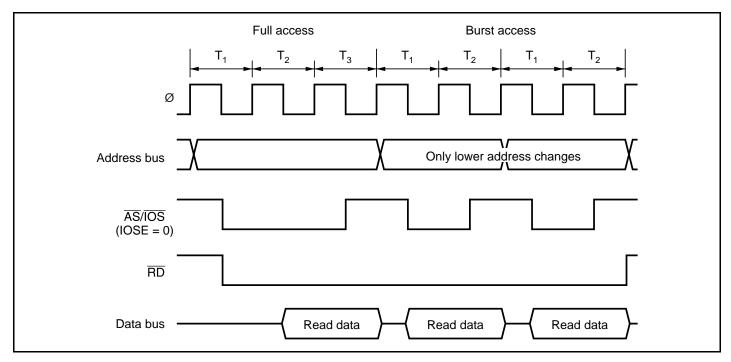


Figure 6.14 Access Timing Example in Burst ROM Space (AST = BRSTS1 = 1)

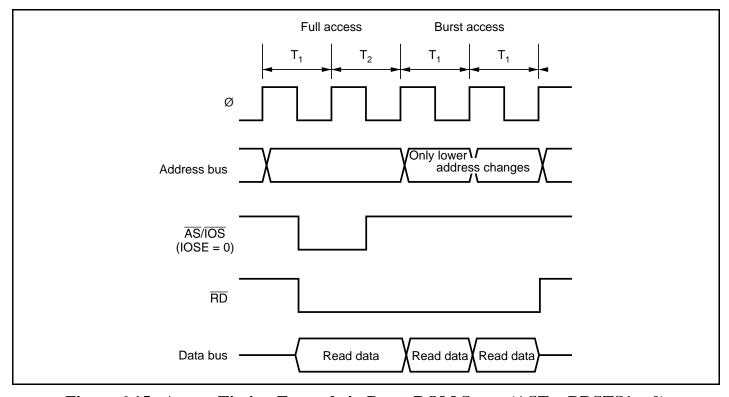


Figure 6.15 Access Timing Example in Burst ROM Space (AST = BRSTS1 = 0)

6.6.2 Wait Control

As with the basic bus interface, program wait insertion or pin wait insertion using the $\overline{\text{WAIT}}$ pin can be used in the initial cycle (full access) of the burst ROM interface. For details, see section 6.5.4, Wait Control. Wait states cannot be inserted in a burst cycle.

6.7 Idle Cycle

When this LSI accesses the external address space, it can insert a 1-state idle cycle (T₁) between bus cycles when a write cycle occurs immediately after a read cycle. By inserting an idle cycle it is possible, for example, to avoid data collisions between ROM with a long output floating time, and high-speed memory and I/O interfaces.

If an external write occurs after an external read while the ICISO bit is set to 1 in BCR, an idle cycle is inserted at the start of the write cycle.

Figure 6.16 shows examples of idle cycle operation. In these examples, bus cycle A is a read cycle for ROM with a long output floating time, and bus cycle B is a CPU write cycle. In figure 6.16 (a), with no idle cycle inserted, a collision occurs in bus cycle B between the read data from ROM and the CPU write data. In figure 6.16 (b), an idle cycle is inserted, thus preventing data collision.

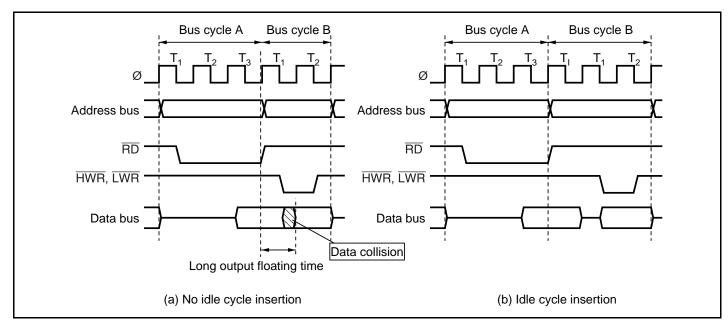


Figure 6.16 Examples of Idle Cycle Operation

Table 6.5 shows the pin states in an idle cycle.

Table 6.5 Pin States in Idle Cycle

| A23 to A0, $\overline{\text{IOS}}$ Contents of immediately following bus cycle High impedance High High HWR, LWR High | Pins | Pin State |
|--|---------------------------|---|
| AS High RD High | A23 to A0, IOS | Contents of immediately following bus cycle |
| RD High | D15 to D0 | High impedance |
| | | High |
| HWR, LWR High | RD | High |
| | HWR, LWR | High |

6.8 Bus Arbitration

The bus controller has a bus arbiter that arbitrates bus master operations. There are two bus masters – the CPU and DTC – that perform read/write operations when they have possession of the bus.

6.8.1 Priority of Bus Masters

Each bus master requests the bus by means of a bus request signal. The bus arbiter detects the bus masters' bus request signals, and if a bus request occurs, it sends a bus request acknowledge signal to the bus master making the request at the designated timing. If there are bus requests from more than one bus master, the bus request acknowledge signal is sent to the one with the highest priority. When a bus master receives the bus request acknowledge signal, it takes possession of the bus until that signal is canceled. The order of priority of the bus masters is as follows:

6.8.2 Bus Transfer Timing

When a bus request is received from a bus master with a higher priority than that of the bus master that has acquired the bus and is currently operating, the bus is not necessarily transferred immediately. Each bus master can relinquish the bus at the timings given below.

CPU: The CPU is the lowest-priority bus master, and if a bus request is received from the DTC, the bus arbiter transfers the bus to the DTC.

- DTC bus transfer timing
 - The bus is transferred at a break between bus cycles. However, if a bus cycle is executed in discrete operations, as in the case of a longword-size access, the bus is not transferred between the component operations. For details, refer to the H8S/2600 Series, H8S/2000 Series Programming Manual.
 - If the CPU is in sleep mode, the bus is transferred immediately.

DTC: The DTC has the highest bus master priority. The DTC sends the bus arbiter a request for the bus when an activation request is generated. The DTC does not release the bus until it completes its operation.

Section 7 Data Transfer Controller (DTC)

This LSI includes a data transfer controller (DTC). The DTC can be activated by an interrupt or software, to transfer data.

Figure 7.1 shows a block diagram of the DTC. The DTC's register information is stored in the on-chip RAM. When the DTC is used, the RAME bit in SYSCR must be set to 1. A 32-bit bus connects the DTC to addresses H'(FF)EC00 to H'(FF)EFFF in on-chip RAM (1 kbyte), enabling 32-bit/1-state reading and writing of the DTC register information.

7.1 Features

- Transfer is possible over any number of channels
- Three transfer modes
 Normal, repeat, and block transfer modes are available.
- One activation source can trigger a number of data transfers (chain transfer)
- Direct specification of 16-Mbyte address space is possible
- Activation by software is possible
- Transfer can be set in byte or word units
- A CPU interrupt can be requested for the interrupt that activated the DTC
- Module stop mode can be set

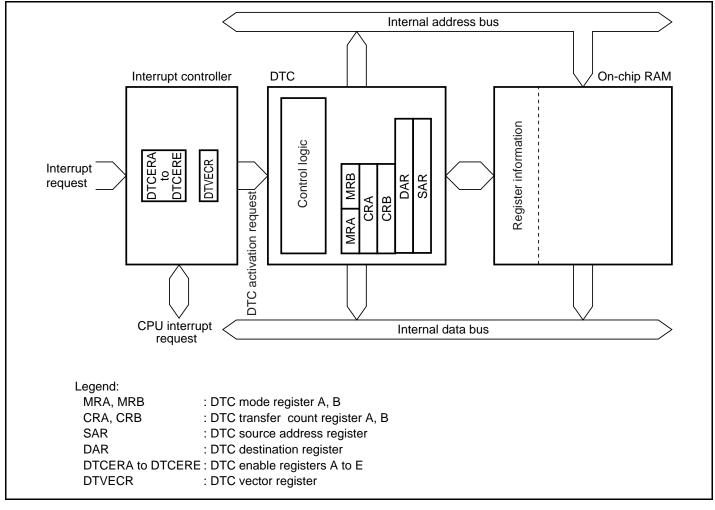


Figure 7.1 Block Diagram of DTC

7.2 Register Descriptions

The DTC has the following registers.

- DTC mode register A (MRA)
- DTC mode register B (MRB)
- DTC source address register (SAR)
- DTC destination address register (DAR)
- DTC transfer count register A (CRA)
- DTC transfer count register B (CRB)

These six registers cannot be directly accessed from the CPU. When a DTC activation interrupt source occurs, the DTC reads a set of register information that is stored in on-chip RAM to the corresponding DTC registers and transfers data. After the data transfer, it writes a set of updated register information back to on-chip RAM.

- DTC enable registers A to E (DTCERA to DTCERE)
- DTC vector register (DTVECR)

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7.2.1 DTC Mode Register A (MRA)

MRA selects the DTC operating mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | SM1 | Undefined | _ | Source Address Mode 1, 0 |
| 6 | SM0 | Undefined | _ | These bits specify an SAR operation after a data transfer. |
| | | | | 0X: SAR is fixed |
| | | | | 10: SAR is incremented after a transfer (by +1 when Sz = 0, by +2 when Sz = 1) |
| | | | | 11: SAR is decremented after a transfer(by −1 when Sz = 0, by −2 when Sz = 1) |
| 5 | DM1 | Undefined | _ | Destination Address Mode 1, 0 |
| 4 | DM0 | Undefined | _ | These bits specify a DAR operation after a data transfer. |
| | | | | 0X: DAR is fixed |
| | | | | 10: DAR is incremented after a transfer (by +1 when Sz = 0, by +2 when Sz = 1) |
| | | | | 11: DAR is decremented after a transfer (by –1 when Sz = 0, by –2 when Sz = 1) |
| 3 | MD1 | Undefined | _ | DTC Mode |
| 2 | MD0 | Undefined | _ | These bits specify the DTC transfer mode. |
| | | | | 00: Normal mode |
| | | | | 01: Repeat mode |
| | | | | 10: Block transfer mode |
| | | | | 11: Setting prohibited |
| 1 | DTS | Undefined | _ | DTC Transfer Mode Select |
| | | | | Specifies whether the source side or the destination side is set to be a repeat area or block area in repeat mode or block transfer mode. |
| | | | | 0: Destination side is repeat area or block area |
| | | | | 1: Source side is repeat area or block area |
| 0 | Sz | Undefined | _ | DTC Data Transfer Size |
| | | | | Specifies the size of data to be transferred. |
| | | | | 0: Byte-size transfer |
| | | | | 1: Word-size transfer |

Legend:

X: Don't care

7.2.2 DTC Mode Register B (MRB)

MRB selects the DTC operating mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|--|
| 7 | CHNE | Undefined | | DTC Chain Transfer Enable |
| | | | | When this bit is set to 1, a chain transfer will be performed. For details, refer to section 7.5.4, Chain Transfer. |
| | | | | In data transfer with CHNE set to 1, determination of the end of the specified number of data transfers, clearing of the interrupt source flag, and clearing of DTCER are not performed. |
| 6 | DISEL | Undefined | | DTC Interrupt Select |
| | | | | When this bit is set to 1, a CPU interrupt request is generated every time data transfer ends (the DTC clears the interrupt source flag for the activation source). When this bit is cleared to 0, a CPU interrupt request is generated only when the specified number of data transfer ends (the DTC does not clear the interrupt source flag for the activation source). |
| 5 | _ | Undefined | _ | Reserved |
| to 0 | | | | These bits have no effect on DTC operation. Only 0 should be written to these bits. |

7.2.3 DTC Source Address Register (SAR)

SAR is a 24-bit register that designates the source address of data to be transferred by the DTC. For word-size transfer, specify an even source address.

7.2.4 DTC Destination Address Register (DAR)

DAR is a 24-bit register that designates the destination address of data to be transferred by the DTC. For word-size transfer, specify an even destination address.

7.2.5 DTC Transfer Count Register A (CRA)

CRA is a 16-bit register that designates the number of times data is to be transferred by the DTC.

In normal mode, the entire CRA functions as a 16-bit transfer counter (1 to 65536). It is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

In repeat mode or block transfer mode, the CRA is divided into two parts; the upper 8 bits (CRAH) and the lower 8 bits (CRAL). CRAH holds the number of transfers while CRAL functions as an 8-bit transfer counter (1 to 256). CRAL is decremented by 1 every time data is transferred, and the contents of CRAH are sent when the count reaches H'00.

7.2.6 DTC Transfer Count Register B (CRB)

CRB is a 16-bit register that designates the number of times data is to be transferred by the DTC in block transfer mode. It functions as a 16-bit transfer counter (1 to 65536) that is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

7.2.7 DTC Enable Registers (DTCER)

DTCER specifies DTC activation interrupt sources. DTCER is comprised of five registers: DTCERA to DTCERE. The correspondence between interrupt sources and DTCE bits is shown in table 7.1. For DTCE bit setting, use bit manipulation instructions such as BSET and BCLR. Multiple DTC activation sources can be set at one time (only at the initial setting) by masking all interrupts and writing data after executing a dummy read on the relevant register.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | DTCE7 | 0 | R/W | DTC Activation Enable |
| 6 | DTCE6 | 0 | R/W | Setting this bit to 1 specifies a relevant interrupt source as a DTC activation source. |
| 5 | DTCE5 | 0 | R/W | |
| 4 | DTCE4 | 0 | R/W | [Clearing conditions] |
| 3 | DTCE3 | 0 | R/W | When data transfer has ended with the DISEL bit in |
| 2 | DTCE2 | 0 | R/W | MRB set to 1. |
| 1 | DTCE1 | 0 | R/W | When the specified number of transfers have ended. |
| 0 | DTCE0 | 0 | R/W | [Holding condition] |
| | | | | When the DISEL bit is 0 and the specified number of transfers have not been completed. |

7.2.8 DTC Vector Register (DTVECR)

DTVECR enables or disables DTC activation by software, and sets a vector number for the software activation interrupt.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | SWDTE | 0 | R/W | DTC Software Activation Enable |
| | | | | Setting this bit to 1 activates DTC. Only 1 can always be written to this bit. 0 can be written to after reading 1 from this bit. |
| | | | | [Clearing conditions] |
| | | | | When the DISEL bit is 0 and the specified number of transfers have not ended. |
| | | | | When 0 is written to the DISEL bit after a software- activated data transfer end interrupt (SWDTEND) request has been sent to the CPU. |
| | | | | [Holding conditions] |
| | | | | When the DISEL bit is 1 and data transfer has ended |
| | | | | When the specified number of transfers have ended. |
| | | | | During data transfer activated by software |
| 6 | DTVEC6 | 0 | R/W | DTC Software Activation Vectors 6 to 0 |
| 5 | DTVEC5 | 0 | R/W | These bits specify a vector number for DTC software activation. |
| 4 | DTVEC4 | 0 | R/W | |
| 3 | DTVEC3 | 0 | R/W | The vector address is expressed as $H'0400 + (vector number \times 2)$. For example, when DTVEC6 to DTVEC0 = $H'10$, the vector address is $H'0420$. When the SWDTE bit is 0, these bits can be written to. |
| 2 | DTVEC2 | 0 | R/W | |
| 1 | DTVEC1 | 0 | R/W | |
| 0 | DTVEC0 | 0 | R/W | |

7.3 Activation Sources

The DTC is activated by an interrupt request or by a write to DTVECR by software. The interrupt request source to activate the DTC is selected by DTCER. At the end of a data transfer (or the last consecutive transfer in the case of chain transfer), the interrupt flag that became the activation source or the corresponding DTCER bit is cleared. The activation source flag, in the case of RXIO, for example, is the RDRF flag in SCI_0.

When an interrupt has been designated as a DTC activation source, the existing CPU mask level and interrupt controller priorities have no effect. If there is more than one activation source at the same time, the DTC operates in accordance with the default priorities. Figure 7.2 shows a block

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diagram of DTC activation source control. For details on the interrupt controller, see section 5, Interrupt Controller.

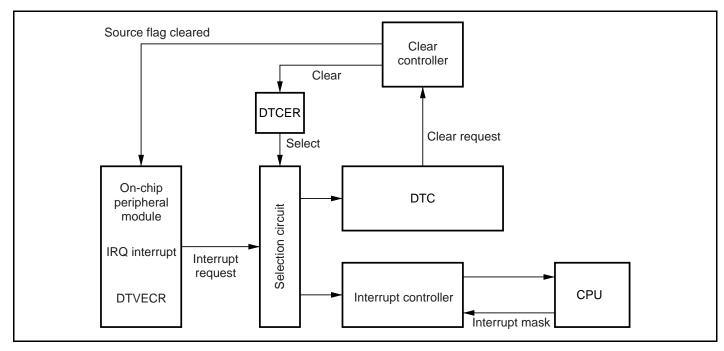


Figure 7.2 Block Diagram of DTC Activation Source Control

7.4 Location of Register Information and DTC Vector Table

Locate the register information in the on-chip RAM (addresses: H'(FF)EC00 to H'(FF)EFFF). Register information should be located at an address that is a multiple of four within the range. The method for locating the register information in address space is shown in figure 7.3. Locate MRA, SAR, MRB, DAR, CRA, and CRB, in that order, from the start address of the register information. In the case of chain transfer, register information should be located in consecutive areas as shown in figure 7.3, and the register information start address should be located at the vector address corresponding to the interrupt source in the DTC vector table. The DTC reads the start address of the register information from the vector table set for each activation source, and then reads the register information from that start address.

When the DTC is activated by software, the vector address is obtained from: $H'0400 + (DTVECR[6:0] \times 2)$. For example, if DTVECR is H'10, the vector address is H'0420.

The configuration of the vector address is the same in both normal and advanced modes; a 2-byte unit is used in both cases. Specify the lower two bits of the register information start address.

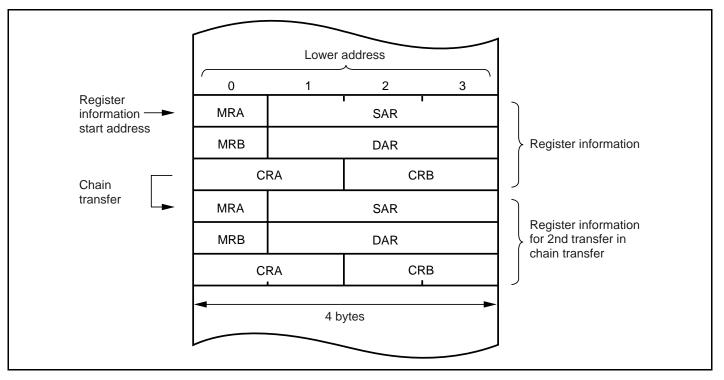


Figure 7.3 DTC Register Information Location in Address Space

Table 7.1 Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs

| Activation Source | | Vector | DTC Vector | | |
|-------------------|--------------------------|--------|--------------------|--------|------------|
| Origin | Activation Source | Number | Address | DTCE*1 | Priority |
| Software | Write to DTVECR | DTVECR | H'0400 + (vector | | High |
| | | | number \times 2) | | ♠ |
| External pins | IRQ0 | 16 | H'0420 | DTCEA7 | |
| | IRQ1 | 17 | H'0422 | DTCEA6 | |
| | IRQ2 | 18 | H'0424 | DTCEA5 | |
| | IRQ3 | 19 | H'0426 | DTCEA4 | |
| A/D converter | ADI | 28 | H'0438 | DTCEA3 | |
| FRT | ICIA | 48 | H'0460 | DTCEA2 | |
| | ICIB | 49 | H'0462 | DTCEA1 | |
| | OCIA | 52 | H'0468 | DTCEA0 | _ |
| | OCIB | 53 | H'046A | DTCEB7 | |
| TMR_0 | CMIA0 | 64 | H'0480 | DTCEB2 | |
| | CMIB0 | 65 | H'0482 | DTCEB1 | |
| TMR_1 | CMIA1 | 68 | H'0488 | DTCEB0 | |
| | CMIB1 | 69 | H'048A | DTCEC7 | |
| TMR_Y | CMIAY | 72 | H'0490 | DTCEC6 | |
| | CMIBY | 73 | H'0492 | DTCEC5 | |
| XBS | IBF1 | 76 | H'0498 | DTCEC4 | |
| | IBF2 | 77 | H'049A | DTCEC3 | |
| SCI_0 | RXI0 | 81 | H'04A2 | DTCEC2 | |
| | TXI0 | 82 | H'04A4 | DTCEC1 | |
| SCI_1 | RXI1 | 85 | H'04AA | DTCEC0 | |
| | TXI1 | 86 | H'04AC | DTCED7 | |
| SCI_2 | RXI2 | 89 | H'04B2 | DTCED6 | _ |
| | TXI2 | 90 | H'04B4 | DTCED5 | _ |
| IIC_0 | IICI0 | 92 | H'04B8 | DTCED4 | |
| IIC_1 | IICI1 | 94 | H'04BC | DTCED3 | |
| LPC*2 | ERRI | 108 | H'04D8 | DTCEE3 | |
| | IBFI1 | 109 | H'04DA | DTCEE2 | |
| | IBFI2 | 110 | H'04DC | DTCEE1 | — ▼ |
| | IBFI3 | 111 | H'04DE | DTCEE0 | Low |

Notes: 1. DTCE bits with no corresponding interrupt are reserved, and only 0 should be written to this bit.

2. Not supported by the H8S/2148B.

7.5 Operation

The DTC stores register information in on-chip RAM. When activated, the DTC reads register information in on-chip RAM and transfers data. After the data transfer, the DTC writes updated register information back to on-chip RAM. The pre-storage of register information in memory makes it possible to transfer data over any required number of channels. The transfer mode can be specified as normal, repeat, or block transfer mode. Setting the CHNE bit in MRB to 1 makes it possible to perform a number of transfers with a single activation source (chain transfer).

The 24-bit SAR designates the DTC transfer source address, and the 24-bit DAR designates the transfer destination address. After each transfer, SAR and DAR are independently incremented, decremented, or left fixed depending on its register information.

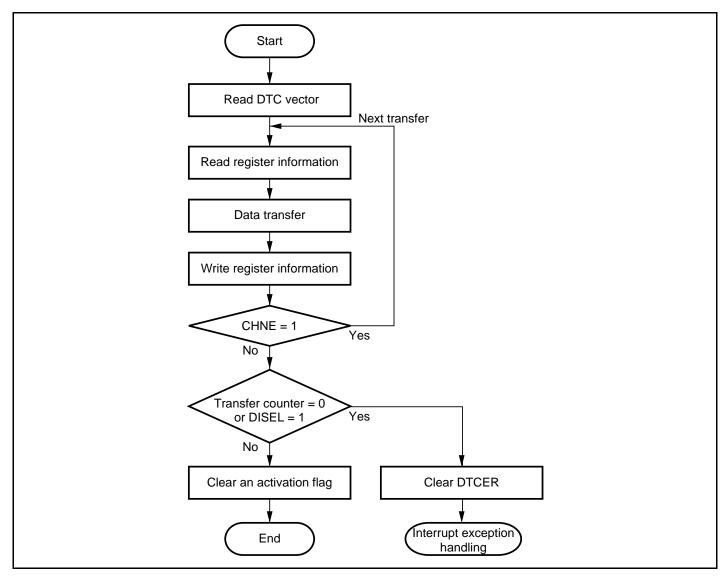


Figure 7.4 DTC Operation Flowchart

7.5.1 Normal Mode

In normal mode, one activation source transfers one byte or one word of data. Table 7.2 lists the register functions in normal mode. From 1 to 65,536 transfers can be specified. Once the specified number of transfers have been completed, a CPU interrupt can be requested.

Table 7.2 Register Functions in Normal Mode

| Name | Abbreviation | Function |
|----------------------------------|--------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register A | CRA | Transfer counter |
| DTC transfer count register B | CRB | Not used |

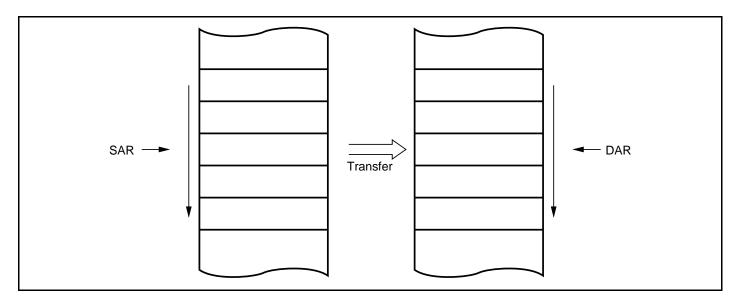


Figure 7.5 Memory Mapping in Normal Mode

7.5.2 Repeat Mode

In repeat mode, one activation source transfers one byte or one word of data. Table 7.3 lists the register functions in repeat mode. From 1 to 256 transfers can be specified. Once the specified number of transfers have completed, the initial states of the transfer counter and the address register that is specified as the repeat area is restored, and transfer is repeated. In repeat mode, the transfer counter value does not reach H'00, and therefore CPU interrupts cannot be requested when the DISEL bit in MRB is cleared to 0.

Table 7.3 Register Functions in Repeat Mode

| Name | Abbreviation | Function |
|----------------------------------|--------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register AH | CRAH | Holds number of transfers |
| DTC transfer count register AL | CRAL | Transfer Count |
| DTC transfer count register B | CRB | Not used |

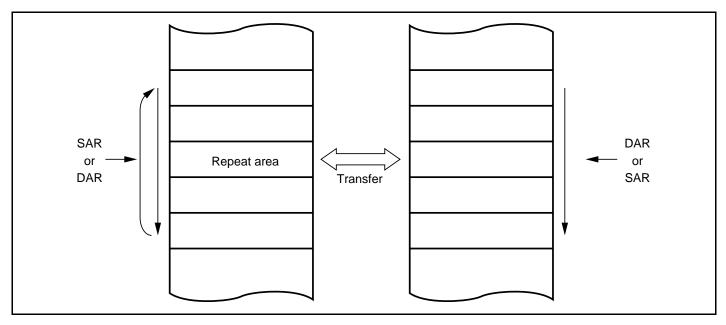


Figure 7.6 Memory Mapping in Repeat Mode

7.5.3 Block Transfer Mode

In block transfer mode, one activation source transfers one block of data. Either the transfer source or the transfer destination is designated as a block area. Table 7.4 lists the register functions in block transfer mode. The block size can be between 1 and 256. When the transfer of one block ends, the initial state of the block size counter and the address register that is specified as the block area is restored. The other address register is then incremented, decremented, or left fixed according to the register information. From 1 to 65,536 transfers can be specified. Once the specified number of transfers have been completed, a CPU interrupt is requested.

Table 7.4 Register Functions in Block Transfer Mode

| Name | Abbreviation | Function |
|----------------------------------|--------------|------------------------------|
| DTC source address register | SAR | Transfer source address |
| DTC destination address register | DAR | Transfer destination address |
| DTC transfer count register AH | CRAH | Holds block size |
| DTC transfer count register AL | CRAL | Block size counter |
| DTC transfer count register B | CRB | Transfer counter |

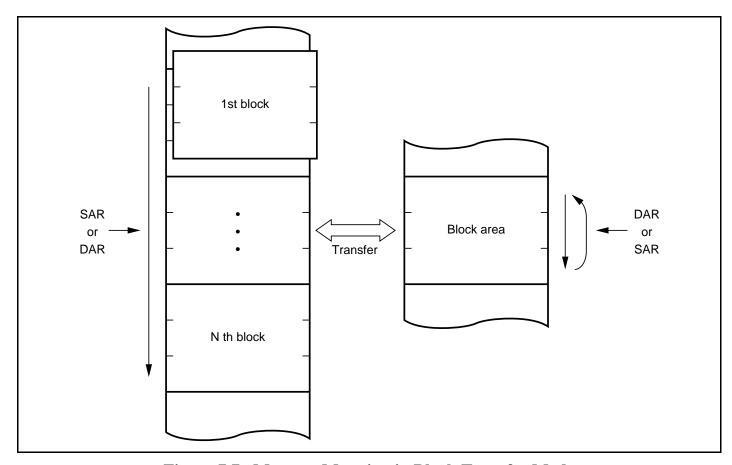


Figure 7.7 Memory Mapping in Block Transfer Mode

7.5.4 Chain Transfer

Setting the CHNE bit in MRB to 1 enables a number of data transfers to be performed consecutively in response to a single transfer request. SAR, DAR, CRA, CRB, MRA, and MRB, which define data transfers, can be set independently.

Figure 7.8 shows the overview of chain transfer operation. When activated, the DTC reads the register information start address stored at the DTC vector address, and then reads the first register information at that start address. After the data transfer, the CHNE bit will be tested. When it has been set to 1, DTC reads the next register information located in a consecutive area and performs the data transfer. These sequences are repeated until the CHNE bit is cleared to 0.

In the case of transfer with the CHNE bit set to 1, an interrupt request to the CPU is not generated at the end of the specified number of transfers or by setting of the DISEL bit to 1, and the interrupt source flag for the activation source is not affected.

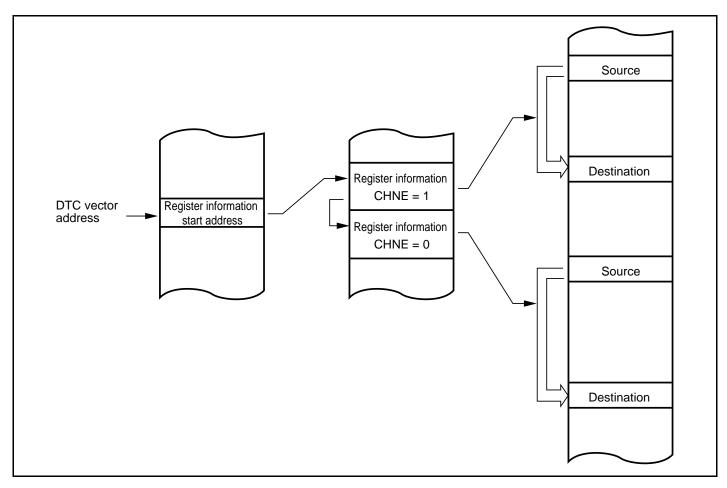


Figure 7.8 Chain Transfer Operation

7.5.5 Interrupts

An interrupt request is issued to the CPU when the DTC has completed the specified number of data transfers, or a data transfer for which the DISEL bit was set to 1. In the case of interrupt activation, the interrupt set as the activation source is generated. These interrupts to the CPU are subject to CPU mask level and priority level control by the interrupt controller.

In the case of software activation, a software-activated data transfer end interrupt (SWDTEND) is generated.

When the DISEL bit is 1 and one data transfer has been completed, or the specified number of transfers have been completed, after data transfer ends, the SWDTE bit is held at 1 and an SWDTEND interrupt is generated. The interrupt handling routine will then clear the SWDTE bit to 0.

When the DTC is activated by software, an SWDTEND interrupt is not generated during a data transfer wait or during data transfer even if the SWDTE bit is set to 1.

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7.5.6 Operation Timing

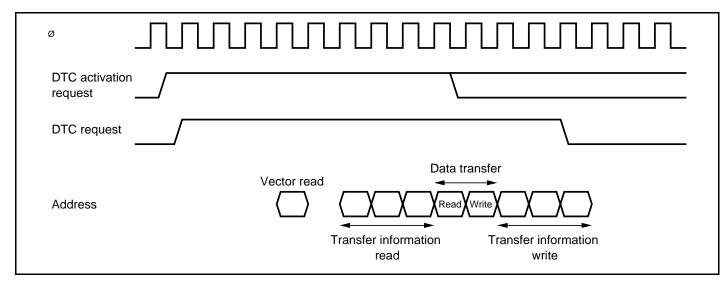


Figure 7.9 DTC Operation Timing (Example in Normal Mode or Repeat Mode)

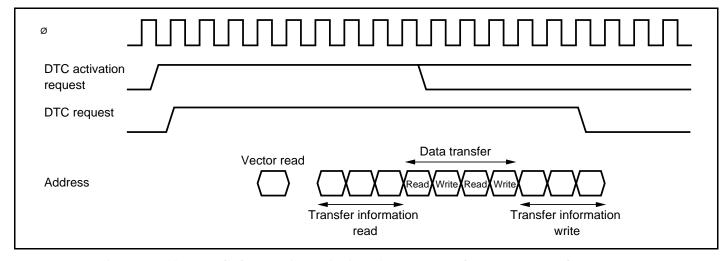


Figure 7.10 DTC Operation Timing (Example of Block Transfer Mode, with Block Size of 2)

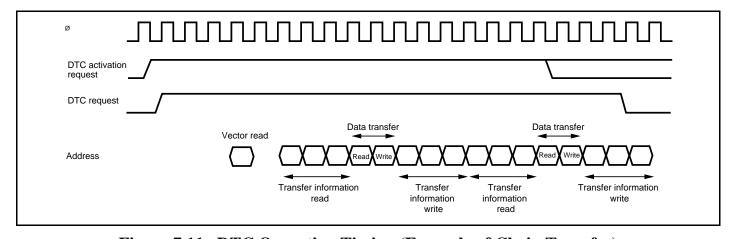


Figure 7.11 DTC Operation Timing (Example of Chain Transfer)

7.5.7 Number of DTC Execution States

Table 7.5 lists the execution status for a single DTC data transfer, and table 7.6 shows the number of states required for each execution status.

Table 7.5 DTC Execution Status

| Mode | Vector Read I | Register Information Read/Write J | Data Read K | Data Write L | Internal Operations M |
|----------------|------------------|---|----------------|-----------------|-----------------------------|
| Normal | 1 | 6 | 1 | 1 | 3 |
| Repeat | 1 | 6 | 1 | 1 | 3 |
| Block transfer | 1 | 6 | N | N | 3 |

N: Block size (initial setting of CRAH and CRAL)

Table 7.6 Number of States Required for Each Execution Status

| Object to be Accessed | | On-Chip On-Chip I/O RAM ROM Registers | | | • | | External Devices | | |
|-----------------------|--|--|----|---|----|---|------------------|---|-------|
| Bus width | 1 | 32 | 16 | 8 | 16 | | 8 | | 16 |
| Access st | ates | 1 | 1 | 2 | 2 | 2 | 3 | 2 | 3 |
| | Vector read S | _ | 1 | _ | _ | 4 | 6 + 2m | 2 | 3 + m |
| status | Register information read/write S _J | 1 | _ | _ | | _ | _ | | _ |
| | Byte data read S_{κ} | 1 | 1 | 2 | 2 | 2 | 3 + m | 2 | 3 + m |
| | Word data read S_{κ} | l1 | 1 | 4 | 2 | 4 | 6 + 2m | 2 | 3 + m |
| | Byte data write S _L | 1 | 1 | 2 | 2 | 2 | 3 + m | 2 | 3 + m |
| | Word data write S _L | 1 | 1 | 4 | 2 | 4 | 6 + 2m | 2 | 3 + m |
| | Internal operation S _M | | | | | 1 | | | |

The number of execution states is calculated from using the formula below. Note that Σ is the sum of all transfers activated by one activation source (the number in which the CHNE bit is set to 1, plus 1).

Number of execution states = $I \cdot S_{_{I}} + \Sigma (J \cdot S_{_{J}} + K \cdot S_{_{K}} + L \cdot S_{_{L}}) + M \cdot S_{_{M}}$

For example, when the DTC vector address table is located in on-chip ROM, normal mode is set, and data is transferred from on-chip ROM to an internal I/O register, then the time required for the DTC operation is 13 states. The time from activation to the end of data write is 10 states.

7.6 Procedures for Using DTC

7.6.1 Activation by Interrupt

The procedure for using the DTC with interrupt activation is as follows:

- 1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in on-chip RAM.
- 2. Set the start address of the register information in the DTC vector address.
- 3. Set the corresponding bit in DTCER to 1.
- 4. Set the enable bits for the interrupt sources to be used as the activation sources to 1. The DTC is activated when an interrupt used as an activation source is generated.
- 5. After one data transfer has been completed, or after the specified number of data transfers have been completed, the DTCE bit is cleared to 0 and a CPU interrupt is requested. If the DTC is to continue transferring data, set the DTCE bit to 1.

7.6.2 Activation by Software

The procedure for using the DTC with software activation is as follows:

- 1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in on-chip RAM.
- 2. Set the start address of the register information in the DTC vector address.
- 3. Check that the SWDTE bit is 0.
- 4. Write 1 to the SWDTE bit and the vector number to DTVECR.
- 5. Check the vector number written to DTVECR.
- 6. After one data transfer has been completed, if the DISEL bit is 0 and a CPU interrupt is not requested, the SWDTE bit is cleared to 0. If the DTC is to continue transferring data, set the SWDTE bit to 1. When the DISEL bit is 1 or after the specified number of data transfers have been completed, the SWDTE bit is held at 1 and a CPU interrupt is requested.

7.7 Examples of Use of DTC

7.7.1 Normal Mode

An example is shown in which the DTC is used to receive 128 bytes of data via the SCI.

- 1. Set MRA to a fixed source address (SM1 = SM0 = 0), incrementing destination address (DM1 = 1, DM0 = 0), normal mode (MD1 = MD0 = 0), and byte size (Sz = 0). The DTS bit can have any value. Set MRB for one data transfer by one interrupt (CHNE = 0, DISEL = 0). Set the SCI, RDR address in SAR, the start address of the RAM area where the data will be received in DAR, and 128 (H'0080) in CRA. CRB can be set to any value.
- 2. Set the start address of the register information at the DTC vector address.
- 3. Set the corresponding bit in DTCER to 1.
- 4. Set the SCI to the appropriate receive mode. Set the RIE bit in SCR to 1 to enable the reception complete (RXI) interrupt. Since the generation of a receive error during the SCI reception operation will disable subsequent reception, the CPU should be enabled to accept receive error interrupts.
- 5. Each time the reception of one byte of data has been completed on the SCI, the RDRF flag in SSR is set to 1, an RXI interrupt is generated, and the DTC is activated. The receive data is transferred from RDR to RAM by the DTC. DAR is incremented and CRA is decremented. The RDRF flag is automatically cleared to 0.
- 6. When CRA becomes 0 after 128 data transfers have been completed, the RDRF flag is held at 1, the DTCE bit is cleared to 0, and an RXI interrupt request is sent to the CPU. The interrupt handling routine will perform wrap-up processing.

7.7.2 Software Activation

An example is shown in which the DTC is used to transfer a block of 128 bytes of data by means of software activation. The transfer source address is H'1000 and the transfer destination address is H'2000. The vector number is H'60, so the vector address is H'04C0.

- 1. Set MRA to incrementing source address (SM1 = 1, SM0 = 0), incrementing destination address (DM1 = 1, DM0 = 0), block transfer mode (MD1 = 1, MD0 = 0), and byte size (Sz = 0). The DTS bit can have any value. Set MRB for one block transfer by one interrupt (CHNE = 0). Set the transfer source address (H'1000) in SAR, the transfer destination address (H'2000) in DAR, and 128 (H'8080) in CRA. Set 1 (H'0001) in CRB.
- 2. Set the start address of the register information at the DTC vector address (H'04C0).
- 3. Check that the SWDTE bit in DTVECR is 0. Check that there is currently no transfer activated by software.
- 4. Write 1 to the SWDTE bit and the vector number (H'60) to DTVECR. The write data is H'E0.
- 5. Read DTVECR again and check that it is set to the vector number (H'60). If it is not, this indicates that the write failed. This is presumably because an interrupt occurred between steps 3 and 4 and led to a different software activation. To activate this transfer, go back to step 3.
- 6. If the write was successful, the DTC is activated and a block of 128 bytes of data is transferred.
- 7. After the transfer, an SWDTEND interrupt occurs. The interrupt handling routine should clear the SWDTE bit to 0 and perform wrap-up processing.

7.8 Usage Notes

7.8.1 Module Stop Mode Setting

DTC operation can be enabled or disabled by the module stop control register (MSTPCR). In the initial state, DTC operation is enabled. Access to DTC registers are disabled when module stop mode is set. Note that when the DTC is being activated, module stop mode cannot be specified. For details, refer to section 26, Power-Down Modes.

7.8.2 On-Chip RAM

MRA, MRB, SAR, DAR, CRA, and CRB are all located in on-chip RAM. When the DTC is used, the RAME bit in SYSCR should not be cleared to 0.

7.8.3 DTCE Bit Setting

For DTCE bit setting, use bit manipulation instructions such as BSET and BCLR, for reading and writing. Multiple DTC activation sources can be set at one time (only at the initial setting) by masking all interrupts and writing data after executing a dummy read on the relevant register.

7.8.4 Setting Required on Entering Subactive Mode or Watch Mode

Set the MSTP14 bit in MSTPCRH to 1 to make the DTC enter module stop mode, then confirm that is set to 1 before making a transition to subactive mode or watch mode.

7.8.5 DTC Activation by Interrupt Sources of SCI, IIC, LPC, or A/D Converter

Interrupt sources of the SCI, IIC, LPC, or A/D converter which activate the DTC are cleared when DTC reads from or writes to the respective registers, and they cannot be cleared by the DISEL bit in MRB.

Section 8 I/O Ports

8.1 Overview

This LSI has ten I/O ports (ports 1 to 6, 8, 9, A, and B), and one input-only port (port 7).

For additional ports C, D, E, F, and G in H8S/2160B and H8S/2161B, see section 8.13 Additional Overview for H8S/2160B and H8S/2161B.

Table 8.1 is a summary of the port functions. The pins of each port also have other functions.

Each port includes a data direction register (DDR) that controls input/output (not provided for the input-only port) and data registers (DR, ODR) that store output data.

Ports 1 to 3, 6, A, and B have an on-chip input pull-up MOS function. For ports A and B, the on/off status of the input pull-up MOS is controlled by DDR and ODR. Ports 1 to 3 and 6 have an input pull-up MOS control register (PCR), in addition to DDR and DR, to control the on/off status of the input pull-up MOS.

Ports 1 to 6, 8, 9, A, and B can drive a single TTL load and 30 pF capacitive load. All the I/O ports can drive a Darlington transistor when in output mode. Ports 1, 2, and 3 can drive an LED (10 mA sink current).

Port A input and output use by the VccB power supply, which is independent of the V_{cc} power supply. When the VccB voltage is 5V, the pins on port A will be 5-V tolerant.

PA4 to PA7 of port A have bus-buffer drive capability.

P52 in port 5, P97 in port 9, P86 in port 8 and P42 in port 4 are NMOS push-pull outputs. P52, P97, P86 and P42 are thus 5-V tolerant, with DC characteristics that are dependent on the $V_{\rm cc}$ voltage.

For the P42/SCK2, P52/SCK0, P86/SCK1, and P97 outputs, connect pull-up resistors to pins to raise output-high-level voltage.

Table 8.1 Port Functions of H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B

| | | | Mode 2 | Mode 3 | I/O |
|-----------|--|------------|-------------------------|----------------------|------------------|
| Port | Description | Mode 1 | (EXPE = 1) | (EXPE = 0) | Status |
| Port | General I/O port | A7 | A7/P17/PW7 | P17/PW7 | On-chip |
| 1 | also functioning as address output and | A6 | A6/P16/PW6 | P16/PW6 | input pull-up |
| | PWM output pins | A5 | A5/P15/PW5 | P15/PW5 | MOSs |
| | | A4 | A4/P14/PW4 | P14/PW4 | |
| | | A3 | A3/P13/PW3 | P13/PW3 | |
| | | A2 | A2/P12/PW2 | P12/PW2 | |
| | | A1 | A1/P11/PW1 | P11/PW1 | |
| | | A0 | A0/P10/PW0 | P10/PW0 | |
| Port 2 | General I/O port also functioning as | A15 | A15/P27/PW15/ CBLANK | P27/PW15 /CBLANK | On-chip input |
| | address output pin, | A14 A13 | A14/P26/PW14 | P26/PW14 | pull-up |
| | PWM output pin, and timer | A13 A12 | A13/P25/PW13 | P25/PW13 | MOSs |
| | connection output | A12 A11 | A12/P24/PW12 | P24/PW12 | |
| | pin | A10 | A11/P23/PW11 | P23/PW11 | |
| | | A10 | A10/P22/PW10 | P22/PW10 | |
| | | A9 A8 | A9/P21/PW9 | P21/PW9 | |
| | | 710 | A8/P20/PW8 | P20/PW8 | |
| Port | General I/O port | D15 | | P37/ | On-chip |
| 3 | also functioning as | D14 | | HDB7/SERIRQ* | input |
| | data bus input/output, XBS | D13 | | P36/HDB6/LCLK* | pull-up MOSs |
| | data bus | D12 | | P35/HDB5/ | |
| | input/output, and | D11 | | TRESET* | |
| | LPC input/output pins | D10 | | P34/HDB4/ LFRAME* | |
| | | D9 | | P33/HDB3/LAD3* | |
| | | D8 | | P32/HDB2/LAD2* | |
| | | | | P31/HDB1/LAD1* | |
| | | | | P30/HDB0/LAD0* | |
| | | | | | |

| | | | Mode 2 | Mode 3 | I/O |
|-----------|--|---|---|--|--------------------------|
| Port | Description | Mode 1 | (EXPE = 1) | (EXPE = 0) | Status |
| Port 4 | General I/O port also functioning as PWMX output, TMR_0 and TMR_1 input/output, timer connection input/output, XBS host interrupt request output, SCI_2 input/output, IrDA interface input/output, and IIC_1 input/output pins | P47/PWX1 P46/ PWX0 P45/TMRI1/0 P44/TMO1/H P43/TMCI1/0 P42/TMRI0/0 P41/TMO0/F P40/TMCI0/ | HSYNCO HSYNCI SCK2/SDA1 RxD2/IrRxD | P47/PWX1 P46/PWX0 P45/TMRI1/HIRQ12 /CSYNCI P44/TMO1/HIRQ1/ HSYNCO P43/TMCI1/HIRQ11 /HSYNCI P42/TMRI0/SCK2/ SDA1 P41/TMO0/RxD2/ IrRxD P40/TMCI0/TxD2/ IrTxD | |
| Port 5 | General I/O port also functioning as SCI_0 input/output and IIC_0 input/output pins General I/O port | P52/SCK0/S P51/RxD0 P50/TxD0 | MOX/KIN7/CIN7 | | On-chip |
| 6 | also functioning as interrupt input, FRT input/output, TMR_X and TMR_Y input/output, timer connection input/output, keysense interrupt input, and expansion A/D input pins | P65/FTID/KI P64/FTIC/KI P63/FTIB/KI P62/FTIA/TM P61/FTOA/K | TOB/KIN6/CIN6 N5/CIN5 N4/CIN4/CLAMPO N3/CIN3/VFBACKI MIY/KIN2/CIN2/VSY KIN1/CIN1/VSYNCC MIX/KIN0/CIN0/HFE |) | input pull-up MOSs |

| | | | Mode 2 | Mode 3 | I/O |
|-----------|---|---------------|------------|-------------------------|--------|
| Port | Description | Mode 1 | (EXPE = 1) | (EXPE = 0) | Status |
| Port | General input port | P77/AN7/D | A1 | | |
| 7 | also functioning as A/D converter | P76/AN6/D | A0 | | |
| | analog input and | P75/AN5 | | | |
| | D/A converter | P74/AN4 | | | |
| | analog output pins | P73/AN3 | | | |
| | | P72/AN2 | | | |
| | | P71/AN1 | | | |
| | | P70/AN0 | | | |
| Port 8 | General I/O port also functioning as | P86/IRQ5/S | SCK1/SCL1 | P86/IRQ5/SCK1/ SCL1 | |
| | interrupt input, | P84/IRQ3/TxD1 | | P85/IRQ4/RxD1 | |
| | SCI_1 input/output, XBS control | P83 | IXDI | P84/IRQ3/TxD1 | |
| | input/output, LPC | P82 | | P83/LPCPD* | |
| | input/output, and | P81 | | P82/HIFSD/ | |
| | <pre>IIC_1 input/output pins</pre> | P80 | | CLKRUN* | |
| | F | F00 | | P81/CS2/GA20 | |
| | | | | P80/HA0/PME* | |
| Port | General I/O port | P97/WAIT/ | SDA0 | P97/SDA0 | |
| 9 | also functioning as extended data bus | P96/ø/EXC | L | P96/ø/EXCL | |
| | control input/output, | AS/IOS | | P95/CS1 | |
| | IIC_0 input/output, subclock input, ø output, interrupt input, XBS control | HWR | | P94/ IOW | |
| | | RD | | P93/IOR | |
| | | P92/IRQ0 | | P92/IRQ0 | |
| | input, and A/D | P91/IRQ1 | | P91/IRQ1 | |
| | converter external trigger input pins | P90/LWR/I | RQ2/ADTRG | P90/IRQ2/ADTRG/ ECS2 | |

| | | | Mode 2 | Mode 3 | I/O |
|-----------|---|-------------------------------|-------------------------------|---------------------------|-----------------|
| Port | Description | Mode 1 | (EXPE = 1) | (EXPE = 0) | Status |
| Port A | General I/O port also functioning as | ioning as /CIN15/ | PA7/A23/KIN15/ CIN15/PS2CD | PA7/KIN15/CIN15/ PS2CD | On-chip input |
| | address output, key-sense interrupt | PS2CD PA6/KIN14 | PA6/A22/KIN14/ CIN14/PS2CC | PA6/KIN14/CIN14/ PS2CC | pull-up MOSs |
| | input, extended A/D input, and keyboard buffer controller | /CIN14/ PS2CC | PA5/A21/KIN13/ CIN13/PS2BD | PA5/KIN13/CIN13/ PS2BD | |
| | input/output pins | PA5/KIN13 /CIN13/ | PA4/A20/KIN12/ CIN12/PS2BC | PA4/KIN12/CIN12/ PS2BC | |
| | | PS2BD PA4/KIN12 | PA3/A19/KIN11/ CIN11/PS2AD | PA3/KIN11/CIN11/ PS2AD | |
| | | /CIN12/ PS2BC | PA2/A18/KIN10/ CIN10/PS2AC | PA2/KIN10/CIN10/ PS2AC | |
| | | PA3/KIN11 /CIN11/ | PA1/A17/KIN9/ | PA1/KIN9/CIN9 | |
| | | PS2AD | CIN9 | PA0/KIN8/CIN8 | |
| | | PA2/KIN10 /CIN10/ PS2AC | PA0/A16/KIN8/ CIN8 | | |
| | | PA1/KIN9/ CIN9 | | | |
| | | PA0/KIN8/ CIN8 | | | |
| Port | General I/O port | PB7/D7/WU | E7* | PB7/WUE7* | On-chip |
| В | also functioning as | PB6/D6/WU | E 6* | PB6/WUE6* | input |
| | wakeup event interrupt input, data | PB5/D5/WU | E5 * | PB5/WUE5* | pull-up MOSs |
| | bus input/output, | PB4/D4/WU | E 4* | PB4/WUE4* | |
| | XBS control input/output, and | PB3/D3/WU | E 3* | PB3/WUE3*/CS4 | |
| | LPC input/output | PB2/D2/WU | E2 * | PB2/WUE2*/CS3 | |
| | pins | PB1/D1/WU | <u>E1</u> * | PB1/WUE1*/HIRQ4 | |
| | | PB0/D0/WU | E0 * | /LSCI* | |
| | | | | PB0/WUE0*/HIRQ3 /LSMI* | |

Note:* Not supported by the H8S/2148B.

8.2 Port 1

Port 1 is an 8-bit I/O port. Port 1 pins also function as an address bus and PWM output pins. Port 1 functions change according to the operating mode. Port 1 has an on-chip input pull-up MOS function that can be controlled by software. Port 1 has the following registers.

- Port 1 data direction register (P1DDR)
- Port 1 data register (P1DR)
- Port 1 pull-up MOS control register (P1PCR)

8.2.1 Port 1 Data Direction Register (P1DDR)

P1DDR specifies input or output for the pins of port 1 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P17DDR | 0 | W | In mode 1: |
| 6 | P16DDR | 0 | W | Each pin of port 1 is address output regardless of |
| 5 | P15DDR | 0 | W | the set value of P1DDR. |
| 4 | P14DDR | 0 | W | In modes 2 and 3 (EXPE=1): |
| 3 | P13DDR | 0 | W | The corresponding port 1 pins are address output or PWM output ports when P1DDR bits are set to 1, |
| 2 | P12DDR | 0 | W | and input ports when cleared to 0. |
| 1 | P11DDR | 0 | W | In modes 2 and 3 (EXPE=0): |
| 0 | P10DDR | 0 | W | The corresponding port 1 pins are output ports or PWM outputs when the P1DDR bits are set to 1, and input ports when cleared to 0. |

8.2.2 Port 1 Data Register (P1DR)

P1DR stores output data for the port 1 pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P17DR | 0 | R/W | If a port 1 read is performed while the P1DDR bits |
| 6 | P16DR | 0 | R/W | are set to 1, the P1DR values are read. If a port 1 read is performed while the P1DDR bits are cleared |
| 5 | P15DR | 0 | R/W | to 0, the pin states are read. |
| 4 | P14DR | 0 | R/W | _ |
| 3 | P13DR | 0 | R/W | |
| 2 | P12DR | 0 | R/W | _ |
| 1 | P11DR | 0 | R/W | _ |
| 0 | P10DR | 0 | R/W | - |

8.2.3 Port 1 Pull-Up MOS Control Register (P1PCR)

P1PCR controls the on/off status of the port 1 on-chip input pull-up MOSs.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P17PCR | 0 | R/W | When the pins are in input state, the corresponding |
| 6 | P16PCR | 0 | R/W | input pull-up MOS is turned on when a P1PCR bitis set to 1. |
| 5 | P15PCR | 0 | R/W | _ 13 361 16 1. |
| 4 | P14PCR | 0 | R/W | _ |
| 3 | P13PCR | 0 | R/W | |
| 2 | P12PCR | 0 | R/W | _ |
| 1 | P11PCR | 0 | R/W | _ |
| 0 | P10PCR | 0 | R/W | |

8.2.4 Pin Functions

P17/A7/PW7 to P10/A0/PW0

The pin function is switched as shown below according to the combination of the OEn bit in PWOERA of PWM, the P1nDDR bit, and operating mode.

| Operating Mode | Mode 1 | Mode | e 2, 3 (EXPE | = 1) | Mode | e 2, 3 (EXPE | = 0) |
|-------------------|----------------------------|-----------------------------|----------------------------|---------------------------------|-----------------------------|---------------------------------|---------------------------------|
| P1nDDR | _ | 0 | | 1 | 0 | 1 | |
| OEn | _ | _ | 0 1 | | _ | 0 | 1 |
| Pin Function | A7 to A0 output pins | P17 to P10 input pins | A7 to A0 output pins | PW7 to PW0 output pins | P17 to P10 input pins | P17 to P10 output pins | PW7 to PW0 output pins |

Legend

n = 7 to 0

8.2.5 Port 1 Input Pull-Up MOS

Port 1 has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

Table 8.2 summarizes the input pull-up MOS states.

Table 8.2 Input Pull-Up MOS States (Port 1)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|------|-------|--------------------------|--------------------------|------------------------|
| 1 | Off | Off | Off | Off |
| 2, 3 | | | On/Off | On/Off |

Legend:

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, P1DDR = 0, and P1PCR = 1; otherwise off.

8.3 Port 2

Port 2 is an 8-bit I/O port. Port 2 pins also function as address bus output function, 8-bit PWM output pins, and the timer connection output pin. Port 2 functions change according to the operating mode. Port 2 has an on-chip input pull-up MOS function that can be controlled by software. Port 2 has the following registers.

- Port 2 data direction register (P2DDR)
- Port 2 data register (P2DR)
- Port 2 pull-up MOS control register (P2PCR)

8.3.1 Port 2 Data Direction Register (P2DDR)

P2DDR specifies input or output for the pins of port 2 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P27DDR | 0 | W | In Mode 1: |
| 6 | P26DDR | 0 | W | The corresponding port 2 pins are address outputs, |
| 5 | P25DDR | 0 | W | regardless of the P2DDR setting. |
| 4 | P24DDR | 0 | W | Modes 2 and 3 (EXPE = 1): |
| 3 | P23DDR | 0 | W | The corresponding port 2 pins are address outputs or PWM outputs when P2DDR bits are set to 1, |
| 2 | P22DDR | 0 | W | and input ports when cleared to 0. P27 to P24 are |
| 1 | P21DDR | 0 | W | switched from address outputs to output ports by setting the IOSE bit to 1. |
| 0 | P20DDR | 0 | W | P27 can be used as an on-chip peripheral module output pin regardless of the P27DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip peripheral module output pin when port 2 pins are used as address output pins. |
| | | | | Modes 2 and 3 (EXPE = 0): |
| | | | | The corresponding port 2 pins are output ports or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0. |
| | | | | P27 can be used as an on-chip peripheral module output pin regardless of the P27DDR setting. |

8.3.2 Port 2 Data Register (P2DR)

P2DR stores output data for port 2.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P27DR | 0 | R/W | If a port 2 read is performed while P2DDR bits are |
| 6 | P26DR | 0 | R/W | set to 1, the P2DR values are read directly, regardless of the actual pin states. If a port 2 read |
| 5 | P25DR | 0 | R/W | is performed while P2DDR bits are cleared to 0, the |
| 4 | P24DR | 0 | R/W | pin states are read. |
| 3 | P23DR | 0 | R/W | _ |
| 2 | P22DR | 0 | R/W | - |
| 1 | P21DR | 0 | R/W | _ |
| 0 | P20DR | 0 | R/W | - |

8.3.3 Port 2 Pull-Up MOS Control Register (P2PCR)

P2PCR controls the port 2 on-chip input pull-up MOSs.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P27PCR | 0 | R/W | In modes 2 and 3, the input pull-up MOS is turned |
| 6 | P26PCR | 0 | R/W | on when a P2PCR bit is set to 1 in the input port state. |
| 5 | P25PCR | 0 | R/W | _ state. |
| 4 | P24PCR | 0 | R/W | _ |
| 3 | P23PCR | 0 | R/W | _ |
| 2 | P22PCR | 0 | R/W | _ |
| 1 | P21PCR | 0 | R/W | _ |
| 0 | P20PCR | 0 | R/W | |

8.3.4 Pin Functions

To ensure normal access to external space, P27 should not be set as an on-chip peripheral module output pin when port 2 pins are used as address output pins.

P27/A15/PW15/CBLANK

The pin function is switched as shown below according to the combination of the IOSE bit in SYSCR, the CBOE bit in TCONRO of timer connection, the OE15 bit in PWOERB of PWM, the P27DDR bit, and operating mode.

| Operating Mode | Mode 1 | | Mode 2, 3 (EXPE = 1) | | | | | Mode 2, 3 | (EXPE = 0 | 0) |
|-------------------|----------------------|---------------------|----------------------|----------------------|-----------------------|-------------------------|---------------------|----------------------|-----------------------|-------------------------|
| CBOE | _ | | | 0 | | 1 | | 0 | | 1 |
| P27DDR | _ | 0 | 1 | | | _ | 0 | , | 1 | _ |
| OE15 | _ | _ | (|) | 1 | _ | _ | 0 | 1 | _ |
| IOSE | _ | _ | 0 | 1 | _ | _ | _ | _ | _ | _ |
| Pin Function | A15 output pin | P27 input pin | A15 output pin | P27 output pin | PW15 output pin | CBLANK output pin | P27 input pin | P27 output pin | PW15 output pin | CBLANK output pin |

• P26/A14/PW14, P25/A13/PW13, P24/A12/PW12

The pin function is switched as shown below according to the combination of the IOSE bit in SYSCR, the OEm bit in PWOERB of PWM, the P2nDDR bit, and operating mode.

| Operating Mode | Mode 1 | Mode 2, 3 (EXPE = 1) Mode 2, 3 (EXPE = 0) | | | | | E = 0) | |
|-------------------|------------------------------------|---|---------------------------------|---------------------------------|--------------------------------------|--------------------------------|---------------------------------|--------------------------------------|
| P2nDDR | | 0 | | 1 | | 0 | , | I |
| OEm | _ | _ | 0 | | 1 | _ | 0 | 1 |
| IOSE | _ | _ | 0 | 1 | _ | _ | 1 | _ |
| Pin Function | A14 to A12 output pins | P26 to P24 input pins | A14 to A12 output pins | P26 to P24 output pins | PW14 to PW12 output pins | P26 to P24 input pins | P26 to P24 output pins | PW14 to PW12 output pins |

RENESAS

Legend

n = 6 to 4

m = 14 to 12

P23/A11/PW11, P22/A10/PW10, P21/A9/PW9, P20/A8/PW8

The pin function is switched as shown below according to the combination of the OEm bit in PWOERB of PWM, the P2nDDR bit, and operating mode.

| Operating Mode | Mode 1 | Mode | e 2, 3 (EXPE | = 1) | Mode | e 2, 3 (EXPE | = 0) |
|-------------------|-----------------------------|-----------------------------|-----------------------------|----------------------------------|-----------------------------|---------------------------------|----------------------------------|
| P2nDDR | _ | 0 | 1 | | 0 | 1 | |
| OEm | _ | _ | 0 | 1 | _ | 0 | 1 |
| Pin Function | A11 to A8 output pins | P23 to P20 input pins | A11 to A8 output pins | PW11 to PW8 output pins | P23 to P20 input pins | P23 to P20 output pins | PW11 to PW8 output pins |

Legend

n = 3 to 0

m = 11 to 8

8.3.5 Port 2 Input Pull-Up MOS

Port 2 has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

Table 8.3 summarizes the input pull-up MOS states.

Table 8.3 Input Pull-Up MOS States (Port 2)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations | |
|------|-------|--------------------------|--------------------------|------------------------|--|
| 1 | Off | Off | Off | Off | |
| 2, 3 | | | On/Off | On/Off | |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, P2DDR = 0, and P2PCR = 1; otherwise off.

8.4 Port 3

Port 3 is an 8-bit I/O port. Port 3 pins also function as a bidirectional data bus, XBS bidirectional data bus, and LPC input/output pins. Port 3 functions change according to the operating mode. Port 3 has the following registers.

- Port 3 data direction register (P3DDR)
- Port 3 data register (P3DR)
- Port 3 pull-up MOS control register (P3PCR)

8.4.1 Port 3 Data Direction Register (P3DDR)

P3DDR specifies input or output for the pins of port 3 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P37DDR | 0 | W | Modes 1, 2, and 3 (EXPE = 1) |
| 6 | P36DDR | 0 | W | The input/output direction specified by P3DDR is |
| 5 | P35DDR | 0 | W | ignored, and pins automatically function as data I/Opins. |
| 4 | P34DDR | 0 | W | Modes 2 and 3 (EXPE = 0) |
| 3 | P33DDR | 0 | W | The corresponding port 3 pins are output ports |
| 2 | P32DDR | 0 | W | when P3DDR bits are set to 1, and input ports when |
| 1 | P31DDR | 0 | W | cleared to 0. |
| 0 | P30DDR | 0 | W | _ |

8.4.2 Port 3 Data Register (P3DR)

P3DR stores output data of port 3.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P37DR | 0 | R/W | If a port 3 read is performed while P3DDR bits are |
| 6 | P36DR | 0 | R/W | set to 1, the P3DR values are read directly, regardless of the actual pin states. If a port 3 read is |
| 5 | P35DR | 0 | R/W | performed while P3DDR bits are cleared to 0, the |
| 4 | P34DR | 0 | R/W | pin states are read. |
| 3 | P33DR | 0 | R/W | _ |
| 2 | P32DR | 0 | R/W | _ |
| 1 | P31DR | 0 | R/W | _ |
| 0 | P30DR | 0 | R/W | |

8.4.3 Port 3 Pull-Up MOS Control Register (P3PCR)

P3PCR controls the port 3 on-chip input pull-up MOSs on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P37PCR | 0 | R/W | In modes 2 and 3 (when EXPE = 0), the input pull- |
| 6 | P36PCR | 0 | R/W | up MOS is turned on when a P3PCR bit is set to 1 in the input port state. |
| 5 | P35PCR | 0 | R/W | The input pull-up MOS function cannot be used |
| 4 | P34PCR | 0 | R/W | when the host interface is enabled. |
| 3 | P33PCR | 0 | R/W | _ |
| 2 | P32PCR | 0 | R/W | _ |
| 1 | P31PCR | 0 | R/W | _ |
| 0 | P30PCR | 0 | R/W | - |

8.4.4 Pin Functions

P37/D15/HDB7/SERIRQ*, P36/D14/HDB6/LCLK*, P35/D13/HDB5/\(\overline{LRESET}\)*, P34/D12/HDB4/\(\overline{LFRAME}\)*, P33/D11/HDB3/LAD3*, P32/D10/HDB2/LAD2*, P31/D9/HDB1/LAD1*, P30/D8/HDB0/LAD0*

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2, the LPC3E to LPC1E bits in HICR0 of host interface (LPC), the P3nDDR bit, and operating mode.

| Operating Mode | Mode 1, 2, 3 (EXPE = 1) | Mode 2, 3 (EXPE = 0) | | | | |
|-------------------|-----------------------------------|-----------------------|---------------------------|---|-----------------------------|--|
| LPCmE | All 0 | All 0 Not all 0 | | | | |
| HI12E | 0 | 0 1 | | | 0 | |
| P3nDDR | _ | 0 | 1 | _ | 0 | |
| Pin Function | D15 to D8 input/output pins | P37 to P30 input pins | P37 to P30 output pins | HDB7 to HDB0 input/output pins | LPC input/output pins | |

Note:* The combination of bits not described in the above table must not be used.

m = 3 to 1: LPC input/output pins (SERIRQ, LCLK, \overline{LRESET} , \overline{LFRAME} , LAD3 to LAD0) when at least one of LPC3E to LPC1E is set to 1.

n = 7 to 0

*: Not supported by the H8S/2148B.

8.4.5 Port 3 Input Pull-Up MOS

Port 3 has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

Table 8.4 summarizes the input pull-up MOS states.

Table 8.4 Input Pull-Up MOS States (Port 3)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|-------------------|-------------|--------------------------|--------------------------|------------------------|
| 1, 2, 3 (EXPE = 1 |) Off | Off | Off | Off |
| 2, 3 (EXPE = 0) | | | On/Off | On/Off |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, P3DDR = 0, and P3PCR = 1; otherwise off.

8.5 Port 4

Port 4 is an 8-bit I/O port. Port 4 pins also function as PWMX output pins, TMR_0 and TMR_1 I/O pins, timer connection I/O pins, SCI_2 I/O pins, IrDA interface I/O pins, XBS output pins, and the IIC_1 I/O pin. The output type of P42 and SCK2 is NMOS push-pull output. The output type of SDA1 is NMOS open drain output. Port 4 pin functions are the same in all operating modes. Port 4 has the following registers.

- Port 4 data direction register (P4DDR)
- Port 4 data register (P4DR)

8.5.1 Port 4 Data Direction Register (P4DDR)

P4DDR specifies input or output for the pins of port 4 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P47DDR | 0 | W | When a bit in P4DDR is set to 1, the corresponding |
| 6 | P46DDR | 0 | W | pin functions as an output port, and when cleared to 0, as an input port. |
| 5 | P45DDR | 0 | W | As 14-bit PWM and SCI_2 are initialized in software |
| 4 | P44DDR | 0 | W | standby mode, the pin states are determined by the |
| 3 | P43DDR | 0 | W | TMR_0, TMR_1, XBS, IIC_1, P4DDR, and P4DR specifications. |
| 2 | P42DDR | 0 | W | |
| 1 | P41DDR | 0 | W | _ |
| 0 | P40DDR | 0 | W | |

8.5.2 Port 4 Data Register (P4DR)

P4DR stores output data for port 4.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P47DR | 0 | R/W | If a port 4 read is performed while P4DDR bits are |
| 6 | P46DR | 0 | R/W | set to 1, the P4DR values are read directly, regardless of the actual pin states. If a port 4 read is |
| 5 | P45DR | 0 | R/W | performed while P4DDR bits are cleared to 0, the |
| 4 | P44DR | 0 | R/W | pin states are read. |
| 3 | P43DR | 0 | R/W | _ |
| 2 | P42DR | 0 | R/W | _ |
| 1 | P41DR | 0 | R/W | _ |
| 0 | P40DR | 0 | R/W | |

8.5.3 Pin Functions

• P47/PWX1

The pin function is switched as shown below according to the combination of the OEB bit in DACR of the 14-bit PWM and the P47DDR bit.

| OEB | | 0 | 1 |
|--------------|---------------|----------------|-----------------|
| P47DDR | 0 1 | | _ |
| Pin Function | P47 input pin | P47 output pin | PWX1 output pin |

P46/PWX0

The pin function is switched as shown below according to the combination of the OEA bit in DACR of the 14-bit PWM and the P46DDR bit.

| OEA | | 0 | 1 |
|--------------|---------------|----------------|-----------------|
| P46DDR | 0 1 | | _ |
| Pin Function | P46 input pin | P46 output pin | PWX0 output pin |

• P45/TMRI1/HIRQ12/CSYNCI

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2 and the P45DDR bit.

| P45DDR | 0 | 1 | | | |
|--------------|------------------------------------|----------------------------------|---|--|--|
| HI12E | 0 | 0 | 1 | | |
| Pin Function | P45 input pin | P45 output pin HIRQ12 output pin | | | |
| | TMRI1 input pin, CSYNCI input pin* | | | | |

Note:* When bits CCLR1 and CCLR0 in TCR1 of TMR_1 are set to 1, this pin is used as the TMRI1 input pin. It can also be used as the CSYNCI input pin.

• P44/TMO1/HIRQ1/HSYNCO

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2, the OS3 to OS0 bits in TCSR of TMR_1, the HOE bit in TCONRO of the timer connection function, and the P44DDR bit.

| HOE | 0 | | | | 1 |
|--------------|------------------|-------------------|---------------------|--------------------|-------------------|
| OS3 to OS0 | All 0 Not all 0 | | | Not all 0 | _ |
| P44DDR | 0 | 1 | | _ | _ |
| HI12E | _ | 0 | 1 | _ | _ |
| Pin Function | P44 input pin | P44 output pin | HIRQ1 output pin | TMO1 output pin | HSYNCO output pin |

P43/TMCI1/HIRQ11/HSYNCI

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2 and the P43DDR bit.

| P43DDR | 0 | 1 | | | |
|--------------|------------------------------------|----------------|-------------------|--|--|
| HI12E | _ | 0 | 1 | | |
| Pin Function | P43 input pin | P43 output pin | HIRQ11 output pin | | |
| | TMCI1 input pin, HSYNCI input pin* | | | | |

Note:* When the external clock is selected by bits CKS2 to CKS0 in TCR1 of TMR_1, this pin is used as the TMCI1 input pin. It can also be used as the HSYNCI input pin.

P42/TMRI0/SCK2/SDA1

The pin function is switched as shown below according to the combination of the ICE bit in ICCR of IIC1, the CKE1 and CKE0 bits in SCR of SCI_2, the C/A bit in SMR of SCI_2, and the P42DDR bit.

| ICE | | | 1 | | | |
|--------------|------------------|-------------------|-----------------|-----------------|-------------------|-----------------|
| CKE1 | | | 0 | | 1 | 0 |
| C/Ā | 0 | | | 1 | _ | 0 |
| CKE0 | (|) | 1 | _ | _ | 0 |
| P42DDR | 0 | 1 | _ | _ | _ | _ |
| Pin Function | P42 input pin | P42 output pin | SCK2 output pin | SCK2 output pin | SCK2 input pin | SDA1 I/O pin |
| | | | TMRI0 ir | nput pin* | | |

Note:* When this pin is used as the SDA1 I/O pin, bits CKE1 and CKE0 in SCR of SCI_2 and bit C/A in SMR of SCI_2 must all be cleared to 0. SDA1 is an NMOS-only output, and has direct bus drive capability.

When bits CCLR1 and CCLR0 in TCR0 of TMR_0 are set to 1, this pin is used as the TMRI0 input pin.

When the P42 output pin and SCK2 output pin are set, the output type is NMOS push-pull output.

• P41/TMO0/RxD2/IrRxD

The pin function is switched as shown below according to the combination of the OS3 to OS0 bits in TCSR of TMR0, the RE bit in SCR of SCI_2 and the P41DDR bit.

| OS3 to OS0 | | Not all 0 | | |
|--------------|------------------|-------------------|-------------------------|--------------------|
| RE | 0 | | 1 | 0 |
| P41DDR | 0 | 1 | _ | _ |
| Pin Function | P41 input pin | P41 output pin | RxD2/IrRxD input pin | TMO0 output pin |

Note:* When this pin is used as the TMO0 output pin, bit RE in SCR of SCI_2 must be cleared to 0.

• P40/TMCI0/TxD2/IrTxD

The pin function is switched as shown below according to the combination of the TE bit in SCR of SCI_2 and the P40DDR bit.

| TE | 0 1 | | | |
|--------------|------------------|-------------------|--------------------------|--|
| P40DDR | 0 | 1 | _ | |
| Pin Function | P40 input pin | P40 output pin | TxD2/IrTxD output pin | |
| | TMCI0 input pin* | | | |

Note:* When an external clock is selected with bits CKS2 to CKS0 in TCR0 of TMR_0, this pin is used as the TMCl0 input pin.

8.6 Port 5

Port 5 is a 3-bit I/O port. Port 5 pins also function as SCI_0 I/O pins, and the IIC_0 I/O pin. P52 and SCK0 are NMOS push-pull outputs, and SCL0 is an NMOS open-drain output. Port 5 has the following registers.

- Port 5 data direction register (P5DDR)
- Port 5 data register (P5DR)

8.6.1 Port 5 Data Direction Register (P5DDR)

P5DDR specifies input or output for the pins of port 5 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|--|
| 7 | _ | All 1 | _ | Reserved |
| to 3 | | | | The initial value must not be changed. |
| 2 | P52DDR | 0 | W | The corresponding port 5 pins are output ports |
| 1 | P51DDR | 0 | W | when P5DDR bits are set to 1, and input ports when cleared to 0. As SCI_0 is initialized in |
| 0 | P50DDR | 0 | W | software standby mode, the pin states are determined by the IIC_0 ICCR, P5DDR, and P5DR specifications. |

8.6.2 Port 5 Data Register (P5DR)

P5DR stores output data for port 5 pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|--|---|
| 7 | _ | All 1 | _ | Reserved |
| to 3 | | | | The initial value must not be changed. |
| 2 | P52DR | 0 | R/W set to 1, the P5DR values are read directly, | If a port 5 read is performed while P5DDR bits are |
| 1 | P51DR | 0 | | set to 1, the P5DR values are read directly, regardless of the actual pin states. If a port 5 read |
| 0 | P50DR | 0 | R/W | is performed while P5DDR bits are cleared to 0, the pin states are read. |

8.6.3 **Pin Functions**

P52/SCK0/SCL0

The pin function is switched as shown below according to the combination of the CKE1 and CKE0 bits in SCR of SCI_0, the C/A bit in SMR of SCI_0, the ICE bit in ICCR of IIC_0, and the P52DDR bit.

| ICE | 0 | | | | | 1 |
|--------------|------------------------------|---|-----------------|-----------------|-------------------|-----------------|
| CKE1 | | (|) | | 1 | 0 |
| C/A | | 0 | | 1 | _ | 0 |
| CKE0 | 0 | | 1 | _ | - | 0 |
| P52DDR | 0 | 1 | _ | _ | _ | _ |
| Pin Function | P52 P52 input pin output pin | | SCK0 output pin | SCK0 output pin | SCK0 input pin | SCL0 I/O pin |

Note:* When this pin is used as the SCL0 I/O pin, bits CKE1 and CKE0 in SCR of SCI0 and bit C/A in SMR of SCI0 must all be cleared to 0.

SCL0 is an NMOS open-drain output, and has direct bus drive capability.

When set as the P52 output pin or SCK0 output pin, this pin is an NMOS push-pull output.

P51/RxD0

The pin function is switched as shown below according to the combination of the RE bit in SCR of SCI_0 and the P51DDR bit.

| RE | (| 1 | |
|--------------|---------------|----------------|----------------|
| P51DDR | 0 | 1 | _ |
| Pin Function | P51 input pin | P51 output pin | RxD0 input pin |

RENESAS

P50/TxD0

The pin function is switched as shown below according to the combination of the TE bit in SCR of SCI_0 and the P50DDR bit.

| TE | (| 1 | |
|--------------|---------------|----------------|-----------------|
| P50DDR | 0 | 1 | _ |
| Pin Function | P50 input pin | P50 output pin | TxD0 output pin |

8.7 Port 6

Port 6 is an 8-bit I/O port. Port 6 pins also function as the FRT I/O pins, TMR_X I/O pins, the TMR_Y input pin, timer connection I/O pins, key-sense interrupt input pins, expansion A/D converter input pins, and external interrupt input pins. The port 6 input level can be switched in four stages. Port 6 pin functions are the same in all operating modes. For details on the system control register 2 (SYSCR2), refer to section 18, Host Interface X-Bus Interface (XBS). Port 6 has the following registers.

- Port 6 data direction register (P6DDR)
- Port 6 data register (P6DR)
- Port 6 pull-up MOS control register (KMPCR6)
- System control register 2 (SYSCR2)

8.7.1 Port 6 Data Direction Register (P6DDR)

P6DDR specifies input or output for the pins of port 6 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | P67DDR | 0 | W | The corresponding port 6 pins are output ports |
| 6 | P66DDR | 0 | W | when P6DDR bits are set to 1, and input portswhen cleared to 0. |
| 5 | P65DDR | 0 | W | — When dicared to 0. |
| 4 | P64DDR | 0 | W | |
| 3 | P63DDR | 0 | W | |
| 2 | P62DDR | 0 | W | |
| 1 | P61DDR | 0 | W | _ |
| 0 | P60DDR | 0 | W | |

8.7.2 Port 6 Data Register (P6DR)

P6DR stores output data for port 6.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P67DR | 0 | R/W | If a port 6 read is performed while P6DDR bits are |
| 6 | P66DR | 0 | R/W | set to 1, the P6DR values are read directly, regardless of the actual pin states. If a port 6 read |
| 5 | P65DR | 0 | R/W | is performed while P6DDR bits are cleared to 0, the |
| 4 | P64DR | 0 | R/W | pin states are read. |
| 3 | P63DR | 0 | R/W | _ |
| 2 | P62DR | 0 | R/W | - |
| 1 | P61DR | 0 | R/W | _ |
| 0 | P60DR | 0 | R/W | - |

8.7.3 Port 6 Pull-Up MOS Control Register (KMPCR)

KMPCR controls the port 6 on-chip input pull-up MOSs on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KM7PCR | 0 | R/W | The input pull-up MOS is turned on when a |
| 6 | KM6PCR | 0 | R/W | KMPCR bit is set to 1 while the corresponding P6DDR bit is cleared to 0 (input port setting). |
| 5 | KM5PCR | 0 | R/W | = 1 0001 bit is cleared to 6 (input port setting). |
| 4 | KM4PCR | 0 | R/W | _ |
| 3 | KM3PCR | 0 | R/W | _ |
| 2 | KM2PCR | 0 | R/W | _ |
| 1 | KM1PCR | 0 | R/W | _ |
| 0 | KM0PCR | 0 | R/W | _ |

8.7.4 Pin Functions

• P67/TMOX/CIN7/KIN7/IRQ7

The pin function is switched as shown below according to the combination of the OS3 to OS0 bits in TCSR of TMR_X and the P67DDR bit.

| OS3 to OS0 | Al | Not all 0 | |
|--------------|---|-----------|-----------------|
| P67DDR | 0 | 1 | _ |
| Pin Function | P67 input pin P67 output pin TM | | TMOX output pin |
| | IRQ7 input pin, KIN7 input pin, CIN7 input pin* | | |

Note:* This pin is used as the IRQ7 input pin when bit IRQ7E is set to 1 in IER. It can always be used as the KIN7 or CIN7 input pin.

• P66/FTOB/CIN6/KIN6/IRQ6

The pin function is switched as shown below according to the combination of the OEB bit in TOCR of the FRT and the P66DDR bit.

| OEB | 0 | 1 | |
|----------------------------|---|----------------|-----------------|
| P66DDR | 0 | 1 | _ |
| Pin Function P66 input pin | | P66 output pin | FTOB output pin |
| | IRQ6 input pin, KIN6 input pin, CIN6 input pin* | | |

Note:* This pin is used as the IRQ6 input pin when bit IRQ6E is set to 1 in IER while the KMIMR6 bit in KMIMR is 0. It can always be used as the KIN6 or CIN6 input pin.

• P65/FTID/CIN5/KIN5

| P65DDR | 0 | 1 | | |
|--------------|---|----------------|--|--|
| Pin Function | P65 input pin | P65 output pin | | |
| | FTID input pin, KIN5 input pin, CIN5 input pin* | | | |

Note:* This pin can always be used as the FTID, KIN5, or CIN5 input pin.

• P64/FTIC/CIN4/KIN4/CLAMPO

The pin function is switched as shown below according to the combination of the CLOE bit in TCONRO of the timer connection function and the P64DDR bit.

| CLOE | (| 1 | | |
|--------------|---|----------------|-------------------|--|
| P64DDR | 0 | 1 | _ | |
| Pin Function | P64 input pin | P64 output pin | CLAMPO output pin | |
| | FTIC input pin, KIN4 input pin, CIN4 input pin* | | | |

Note:* This pin can always be used as the FTIC, KIN4, or CIN4 input pin.

• P63/FTIB/CIN3/KIN3/VFBACKI

| P63DDR | 0 | 1 | |
|--------------|--|----------------|--|
| Pin Function | P63 input pin | P63 output pin | |
| | FTIB input pin, VFBACKI input pin, KIN3 input pin, CIN3 input pin* | | |

Note:* This pin can always be used as the FTIB, KIN3, CIN3, or VFBACKI input pin.

• P62/FTIA/CIN2/KIN2/VSYNCI/TMIY

| P62DDR | 0 | 1 | |
|--------------|--|----------------|--|
| Pin Function | P62 input pin | P62 output pin | |
| | FTIA input pin, VSYNCI input pin CIN2 inp | | |

Note:* This pin can always be used as the FTIA, TMIY, KIN2, CIN2, or VSYNCI input pin.

• P61/FTOA/CIN1/KIN1/VSYNCO

The pin function is switched as shown below according to the combination of the OEA bit in TOCR of the FRT, the VOE bit in TCONRO of the timer connection function, and the P61DDR bit.

| VOE | | 1 | | | |
|--------------|---------------------------------|-----|-----------------|-------------------|--|
| OEA | | 0 | 1 | _ | |
| P61DDR | 0 | 0 1 | | _ | |
| Pin Function | P61 input pin P61 output pin | | FTOA output pin | VSYNCO output pin | |
| | KIN1 input pin, CIN1 input pin* | | | | |

Note:* When this pin is used as the VSYNCO pin, bit OEA in TOCR of the FRT must be cleared to 0. This pin can always be used as the KIN1 or CIN1 input pin.

• P60/FTCI/CIN0/KIN0/HFBACKI/TMIX

| P60DDR | 0 | 1 | |
|--------------|--|----------------|--|
| Pin Function | P60 input pin | P60 output pin | |
| | FTCI input pin, HFBACKI input pi CIN0 inp | | |

Note:* This pin is used as the FTCI input pin when an external clock is selected with bits CKS1 and CKS0 in TCR of the FRT. It can always be used as the TMIX, KINO, CINO, or HFBACKI input pin.

8.7.5 Port 6 Input Pull-Up MOS

Port 6 has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

The input pull-up MOS current specification can be changed by means of the P6PUE bit. When a pin is designated as an on-chip peripheral module output pin, the input pull-up MOS is always off.

Table 8.5 summarizes the input pull-up MOS states.

Table 8.5 Input Pull-Up MOS States (Port 6)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|---------|-------|--------------------------|--------------------------|------------------------|
| 1, 2, 3 | Off | Off | On/Off | On/Off |

Legend:

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, P6DDR = 0, and KMPCR = 1; otherwise off.

8.8 Port 7

Port 7 is an 8-bit input only port. Port 7 pins also function as the A/D converter analog input pins and D/A converter analog output pins. Port 7 functions are the same in all operating modes. Port 7 has the following register.

• Port 7 input data register (P7PIN)

8.8.1 Port 7 Input Data Register (P7PIN)

P7PIN reflects the pin states of port 7.

| Bi | it Bit Name | Initial Value | R/W | Description |
|----|-------------|---------------|-----|--|
| 7 | P77PIN | Undefined* | R | When a P7PIN read is performed, the pin states |
| 6 | P76PIN | Undefined* | R | are always read. P7PIN has the same address as PBDDR; if a write is performed, data will be written |
| 5 | P75PIN | Undefined* | R | into PBDDR and the port B setting will be changed. |
| 4 | P74PIN | Undefined* | R | _ |
| 3 | P73PIN | Undefined* | R | _ |
| 2 | P72PIN | Undefined* | R | _ |
| 1 | P71PIN | Undefined* | R | _ |
| 0 | P70PIN | Undefined* | R | _ |

Note:* Determined by the pin states of P77 to P70.

8.8.2 Pin Functions

• P77/AN7/DA1

The pin function is switched as shown below according to the combination of the DAE bit in DACR of the D/A converter and the DAOE1 bit.

| DAOE1 | (| 1 | | | |
|--------------|-----------------------------|---|----------------|--|--|
| DAE | 0 1 | | _ | | |
| Pin Function | P77 input pin DA1 input pin | | DA1 output pin | | |
| | AN7 input pin* | | | | |

Note:* This pin can always be used as the AN7 input pin.

• P76/AN6/DA0

The pin function is switched as shown below according to the combination of the DAE bit in DACR of the D/A converter and the DAOE0 bit.

| DAOE0 | | 1 | | | |
|--------------|------------------------------|---|----------------|--|--|
| DAE | 0 1 | | _ | | |
| Pin Function | P76 input pin DA0 output pin | | DA0 output pin | | |
| | AN6 input pin* | | | | |

Note:* This pin can always be used as the AN6 input pin.

P75/AN5, P74/AN4, P73/AN3, P72/AN2, P71/AN1, P70/AN0

| Pin Function | P75 to P70 input pins |
|--------------|-----------------------|
| | AN5 to AN0 input pin* |

Note:* This pin can always be used as the AN5 to AN0 input pins.

8.9 Port 8

Port 8 is an 8-bit I/O port. Port 8 pins also function as SCI_1 I/O pins, the IIC_1 I/O pin, XBS I/O pins, LPC I/O pins, and interrupt input pins. The output type of P86 and SCK1 is NMOS push-pull output. The output type of SCL1 is NMOS open drain output and direct bus driving is enabled. Port 8 pin functions are the same in all operating modes except host interface function. Port 8 has the following registers.

- Port 8 data direction register (P8DDR)
- Port 8 data register (P8DR)

8.9.1 Port 8 Data Direction Register (P8DDR)

P8DDR specifies input or output for the pins of port 8 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | _ | 1 | _ | Reserved |
| | | | | The initial value must not be changed. |
| 6 | P86DDR | 0 | W | P8DDR has the same address as PBPIN, and if |
| 5 | P85DDR | 0 | W | read, the port B state will be returned. |
| 4 | P84DDR | 0 | W | The corresponding port 8 pins are output ports when P8DDR bits are set to 1, and input ports |
| 3 | P83DDR | 0 | W | when cleared to 0. |
| 2 | P82DDR | 0 | W | _ |
| 1 | P81DDR | 0 | W | _ |
| 0 | P80DDR | 0 | W | _ |

8.9.2 Port 8 Data Register (P8DR)

P8DR stores output data for the port 8 pins (P86 to P80).

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | _ | 1 | _ | Reserved |
| | | | | The initial value must not be changed. |
| 6 | P86DR | 0 | R/W | If a port 8 read is performed while P8DDR bits are |
| 5 | P85DR | 0 | R/W | set to 1, the P8DR values are read directly, regardless of the actual pin states. If a port 8 read |
| 4 | P84DR | 0 | R/W | is performed while P8DDR bits are cleared to 0, the |
| 3 | P83DR | 0 | R/W | pin states are read. |
| 2 | P82DR | 0 | R/W | _ |
| 1 | P81DR | 0 | R/W | _ |
| 0 | P80DR | 0 | R/W | _ |

8.9.3 Pin Functions

• P86/<u>IRQ5</u>/ SCK1/SCL1

The pin function is switched as shown below according to the combination of the CKE1 and CKE0 bits in SCR of SCI_1, the C/\overline{A} bit in SMR of SCI_1, the ICE bit in ICCR of IIC_1, and the P86DDR bit.

| ICE | | 1 | | | | |
|--------------|------------------|-------------------|--------------------|--------------------|-------------------|-----------------|
| CKE1 | | (|) | | 1 | 0 |
| C/A | | 0 | _ | 0 | | |
| CKE0 | 0 1 | | | _ | _ | 0 |
| P86DDR | 0 1 | | _ | _ | _ | _ |
| Pin Function | P86 input pin | P86 output pin | SCK1 output pin | SCK1 output pin | SCK1 input pin | SCL1 I/O pin |
| | IRQ5 input pin* | | | | | |

Note:* When the IRQ5E bit in IER is set to 1, this pin is used as the IRQ5 input pin. When this pin is used as the SCL1 I/O pin, bits CKE1 and CKE0 in SCR of SCI_1 and bit C/A in SMR of SCI_1 must all be cleared to 0. When the P86 output pin and SCK1 output pin are set, the output type is NMOS push-pull output. SCL1 is an NMOS-only output, and has direct bus drive capability.

• P85/IRQ4/RxD1

The pin function is switched as shown below according to the combination of the RE bit in SCR of SCI_1 and the P85DDR bit.

| RE | (| 1 | | | | |
|--------------|------------------------------|---|----------------|--|--|--|
| P85DDR | 0 1 | | _ | | | |
| Pin Function | P85 input pin P85 output pin | | RxD1 input pin | | | |
| | IRQ4 input pin* | | | | | |

Note:* When the IRQ4E bit in IER is set to 1, this pin is used as the IRQ4 input pin.

• P84/<u>IRQ3</u>/TxD1

The pin function is switched as shown below according to the combination of the TE bit in SCR of SCI_1 and the P84DDR bit.

| TE | | 1 | | | | |
|--------------|------------------------------|---|-----------------|--|--|--|
| P84DDR | 0 | 1 | _ | | | |
| Pin Function | P84 input pin P84 output pin | | TxD1 output pin | | | |
| | IRQ3 input pin* | | | | | |

Note:* When the IRQ3E bit in IER is set to 1, this pin is used as the IRQ3 input pin.

• P83/<u>LPCPD</u>*²

The pin function is switched as shown below according to the P83DDR bit.

| P83DDR | 0 | 1 | | | |
|--------------|---------------------|----------------|--|--|--|
| Pin Function | P83 input pin | P83 output pin | | | |
| | LPCPD input pin*1*2 | | | | |

Notes: 1. When at least one of bits LPC3E to LPC1E is set to 1 in HICR0, this pin is used as the $\overline{\text{LPCPD}}$ input pin. The $\overline{\text{LPCPD}}$ input pin can only be used in mode 2 or 3 (EXPE = 0).

2. Not supported by the H8S/2148B.

• P82/HIFSD/CLKRUN*²

The pin function is switched as shown below according to the combination of the HI12E and SDE bits in SYSCR2, the LPC3E to LPC1E bits in HICR0, and the P82DDR bit.

| LPC3E to LPC1E | | Not all 0 | | | | |
|-------------------|------------------|-------------------|------------------|---------------------------------|---|-----|
| HI12E | (| 0 1 | | | | |
| SDE | _ | _ | (|) | 1 | _ |
| P82DDR | 0 | 1 | 0 | 1 | _ | 0*1 |
| Pin Function | P82 input pin | P82 output pin | P82 input pin | CLKRUN I/O pin* ² | | |

Notes: The HIFSD input pin and $\overline{\text{CLKRUN}}$ I/O pin can only be used in mode 2 or 3 (EXPE = 0).

- 1. When at least one of bits LPC3E to LPC1E is set to 1, bits HI12E and P82DDR should be cleared to 0.
- 2. Not supported by the H8S/2148B.

• P81/CS2/GA20

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2, the CS2E bit in SYSCR, the FGA20E bit in HICR, the FGA20E bit in HICR0, and the P81DDR bit.

| FGA20E (LPC) | 0 | | | | | 1 | | |
|-----------------|------------------|-------------------|---|---------|-----------|--------------------|---|-----|
| HI12E | (| 0 | | | 1 | | | 0*1 |
| FGA20E (XBS) | _ | _ | | 0 | | | 1 | |
| CS2E | - | _ | (| 0 | 1 | _ | _ | _ |
| P81DDR | 0 | 1 | 0 | 1 | _ | 0 | 1 | 0*1 |
| Pin Function | P81 input pin | P81 output pin | · | | | GA20 output pin | | |
| | | | | GA20 in | put pin*2 | | | |

Notes: 1. When bit FGA20E is set to 1 in HICR0, bits HI12E and P81DDR should be cleared to 0.

2. The GA20 output pin and $\overline{\text{CS2}}$ input pin can only be used in mode 2 or 3 (EXPE = 0).

• P80/HA0/<u>PME</u>*³

The pin function is switched as shown below according to the combination of the HI12E bit in SYSCR2, the PMEE bit in HICR0, and the P80DDR bit.

| PMEE | | 1 | | | | |
|--------------|-------------------|----------------|-----------------|----------------|--|--|
| HI12E | 0 | | 1 | 0*1 | | |
| P80DDR | 0 1 | | _ | 0*1 | | |
| Pin Function | P80 input pin | P80 output pin | HA0 input pin*2 | PME output pin | | |
| | PME input pin*2*3 | | | | | |

Notes: 1. When bit PMEE is set to 1 in HICR0, bits HI12E and P80DDR should be cleared to 0.

- 2. The HA0 input pin can only be used in mode 2 or 3 (EXPE = 0).
- 3. Not supported by the H8S/2148B.

8.10 Port 9

Port 9 is an 8-bit I/O port. Port 9 pins also function as external interrupt input pins, the A/D converter input pin, host interface (XBS) input pins, the IIC_0 I/O pin, the subclock input pin, bus control signal I/O pins, and the system clock (ø) output pin. P97 is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability. Port 9 has the following registers.

- Port 9 data direction register (P9DDR)
- Port 9 data register (P9DR)

8.10.1 Port 9 Data Direction Register (P9DDR)

P9DDR specifies input or output for the pins of port 9 on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|------------------|-----|---|
| 7 | P97DDR | 0 | W | P9DDR is initialized to H'40 (mode 1) or H'00 (modes 2 |
| 6 | P96DDR | 1/0* | W | and 3). |
| 5 | P95DDR | 0 | W | Modes 1, 2, and 3 (EXPE = 1): |
| 4 | P94DDR | 0 | W | Pin P97 functions as a bus control input (WAIT), the IIC_0 I/O pin (SDA0), or an I/O port, according to the wait mode |
| 3 | P93DDR | 0 | W | setting. When P97 functions as an I/O port, it becomes an |
| 2 | P92DDR | 0 | W | output port when P97DDR is set to 1, and an input port when P97DDR is cleared to 0. |
| 1 | P91DDR | 0 | W | Pin P96 functions as the ø output pin when P96DDR is set |
| 0 | P90DDR | 0 | W | to 1, and as the subclock input (EXCL) or an input port when P96DDR is cleared to 0. |
| | | | | Pins P95 to P93 automatically become bus control outputs (AS/IOS, HWR, RD), regardless of the input/output direction indicated by P95DDR to P93DDR. |
| | | | | Pins P92 and P91 become output ports when P92DDR and P91DDR are set to 1, and input ports when P92DDR and P91DDR are cleared to 0. |
| | | | | When the ABW bit in WSCR is cleared to 0, pin P90 becomes a bus control output (LWR), regardless of the input/output direction indicated by P90DDR. When the ABW bit is 1, pin P90 becomes an output port if P90DDR is set to 1, and an input port if P90DDR is cleared to 0. |
| | | | | Modes 2 and 3 (EXPE = 0): |
| | | | | When the corresponding P9DDR bits are set to 1, pin P96 functions as the Ø output pin and pins P97 and P95 to P90 become output ports. When P9DDR bits are cleared to 0, the corresponding pins become input ports. |

Note:* The initial value of P96DDR is 1 (mode 1) or 0 (modes 2 and 3).

8.10.2 Port 9 Data Register (P9DR)

P9DR stores output data for the port 9 pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P97DR | 0 | R/W | With the exception of P96, if a port 9 read is |
| 6 | P96DR | Undefined* | R | performed while P9DDR bits are set to 1, the P9DR values are read directly, regardless of the actual |
| 5 | P95DR | 0 | R/W | pin states. If a port 9 read is performed while |
| 4 | P94DR | 0 | R/W | P9DDR bits are cleared to 0, the pin states are |
| 3 | P93DR | 0 | R/W | - read. |
| 2 | P92DR | 0 | R/W | For P96, the pin state is always read. |
| 1 | P91DR | 0 | R/W | |
| 0 | P90DR | 0 | R/W | |

Note:* The initial value of bit 6 is determined according to the P96 pin state.

8.10.3 Pin Functions

• P97/WAIT/SDA0

The pin function is switched as shown below according to the combination of operating mode, the WMS1 bit in WSCR, the ICE bit in ICCR of IIC_0, and the P97DDR bit.

| Operating Mode | N | Modes 1, 2, 3 | (EXPE = 1 | Mode | s 2, 3 (EXPE | E = 0) | |
|-------------------|------------------|-------------------|-----------------|----------------|------------------|-------------------|-----------------|
| WMS1 | | 0 | | 1 | _ | | |
| ICE | 0 | | 1 | _ | 0 1 | | 1 |
| P97DDR | 0 | 1 | _ | _ | 0 | 1 | _ |
| Pin Function | P97 input pin | P97 output pin | SDA0 I/O pin | WAIT input pin | P97 input pin | P97 output pin | SDA0 I/O pin |

Note:* When this pin is set as the P97 output pin, it is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability.

P96/ø/EXCL

The pin function is switched as shown below according to the combination of the EXCLE bit in LPWRCR and the P96DDR bit.

| P96DDR | (| 1 | |
|--------------|---------------|----------------|--------------|
| EXCLE | 0 | 1 | 0 |
| Pin Function | P96 input pin | EXCL input pin | ø output pin |

Note:* When this pin is used as the EXCL input pin, P96DDR should be cleared to 0.

• P95/AS/IOS/CS1

The pin function is switched as shown below according to the combination of operating mode, the IOSE bit in SYSCR, the HI12E bit in SYSCR2, and the P95DDR bit.

| Operating Mode | Modes 1, 2, 3 | 3 (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | |
|-------------------|------------------|-------------------|-----------------------|-------------------|------------------|
| HI12E | | _ | 0 | | 1 |
| P95DDR | _ | | 0 | 1 | _ |
| IOSE | 0 | 0 1 | | _ | _ |
| Pin Function | AS output pin | IOS output pin | P95 input pin | P95 output pin | CS1 input pin |

• P94/HWR/IOW

The pin function is switched as shown below according to the combination of operating mode, the HI12E bit in SYSCR2, and the P94DDR bit.

| Operating Mode | Modes 1, 2, 3 (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | | |
|-------------------|--------------------------|-----------------------|-------------------|------------------|--|
| HI12E | _ | (| 1 | | |
| P94DDR | _ | 0 | 1 | _ | |
| Pin Function | HWR output pin | P94 input pin | P94 output pin | IOW input pin | |

P93/RD/IOR

The pin function is switched as shown below according to the combination of operating mode, the HI12E bit in SYSCR2, and the P93DDR bit.

| Operating Mode | Modes 1, 2, 3 (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | 0) |
|----------------|-----------------------------|-----------------------|----------------|---------------|
| HI12E | _ | 0 | | 1 |
| P93DDR | _ | 0 | 1 | _ |
| Pin Function | RD output pin | P93 input pin | P93 output pin | IOR input pin |

• P92/<u>IRQ0</u>

| P92DDR | 0 | 1 | | |
|--------------|-----------------|----------------|--|--|
| Pin Function | P92 input pin | P92 output pin | | |
| | IRQ0 input pin* | | | |

Note:* When bit IRQ0E in IER is set to 1, this pin is used as the IRQ0 input pin.

• P91/IRQ1

| P91DDR | 0 | 1 | | |
|--------------|-----------------|----------------|--|--|
| Pin Function | P91 input pin | P91 output pin | | |
| | IRQ1 input pin* | | | |

Note:* When bit IRQ1E in IER is set to 1, this pin is used as the IRQ1 input pin.

• P90/LWR/IRQ2/ADTRG/ECS2

The pin function is switched as shown below according to the combination of operating mode, the ABW bit in WSCR, the HI12E and CS2E bits in SYSCR2, the FGA20E bit in HICR, and the P90DDR bit.

| Operating Mode | Mode | s 1, 2, 3 (EXP | E = 1) | Modes 2, 3 (EXPE = 0) | | |
|-------------------|-------------------|------------------|-------------------|-----------------------|-------------------|----------------|
| ABW | 0 | , | 1 | | _ | |
| HI12E | - | | | Any o | one 0 | 1 |
| FGA20E | | _ | | | | 1 |
| CS2E | _ | | | | | 1 |
| P90DDR | _ | 0 | 1 | 0 | 1 | _ |
| Pin Function | LWR output pin | P90 input pin | P90 output pin | P90 input pin | P90 output pin | ECS2 input pin |
| | | | IRQ2 inpu | ıt pin, ADTRG | input pin* | |

Note:* When the IRQ2E bit in IER is set to 1 in mode 1, 2, or 3 (EXPE = 1) with the ABW bit in WSCR set to 1, or in mode 2 and 3 (EXPE = 0), this pin is used as the IRQ2 input pin.

When TRGS1 and TRGS0 in ADCR of the A/D converter are both set to 1, this pin is used as the ADTRG input pin.

8.11 Port A

Port A is an 8-bit I/O port. Port A pins also function as keyboard buffer controller I/O pins, keysense interrupt input pins, expansion A/D converter input pins, and address output pins. Port A pin functions change according to the operating mode. Port A input/output operates by VccB power independent from the Vcc power. Up to 5 V can be applied to port A pins if VccB power is 5 V. Port A has the following registers. PADDR and PAPIN have the same address.

- Port A data direction register (PADDR)
- Port A output data register (PAODR)
- Port A input data register (PAPIN)

8.11.1 Port A Data Direction Register (PADDR)

PADDR specifies input or output for the pins of port A on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PA7DDR | 0 | W | In mode 1, 2 (EXPE = 0), or 3: |
| 6 | PA6DDR | 0 | W | The corresponding port A pins are output ports |
| 5 | PA5DDR | 0 | W | when PADDR bits are set to 1, and input ports when cleared to 0. |
| 4 | PA4DDR | 0 | W | In mode 2 (EXPE = 1): |
| 3 | PA3DDR | 0 | W | The corresponding port A pins are address output |
| 2 | PA2DDR | 0 | W | when PADDR bits are set to 1, and input ports |
| 1 | PA1DDR | 0 | W | when cleared to 0. The port A pins changes from the address I/O ports to output ports by setting the |
| 0 | PA0DDR | 0 | W | IOSE bit to 1. |
| | | | | PA7 to PA2 pins are used as the keyboard buffer controller I/O pins by setting the KBIOE bit to 1 regardless of the operating mode, while the I/O direction according to PA7DDR to PA2DDR is ignored. |
| | | | | PADDR has the same address as PAPIN, if read, port A status is returned. |

8.11.2 Port A Output Data Register (PAODR)

PAODR stores output data for port A.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PA7ODR | 0 | R/W | PAODR can always be read or written to, |
| 6 | PA6ODR | 0 | R/W | regardless of the contents of PADDR. |
| 5 | PA5ODR | 0 | R/W | _ |
| 4 | PA4ODR | 0 | R/W | _ |
| 3 | PA3ODR | 0 | R/W | _ |
| 2 | PA2ODR | 0 | R/W | _ |
| 1 | PA10DR | 0 | R/W | _ |
| 0 | PA0ODR | 0 | R/W | |

8.11.3 Port A Input Data Register (PAPIN)

PAPIN indicates the port A state.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PA7PIN | Undefined* | R | Reading PAPIN always returns the pin states. |
| 6 | PA6PIN | Undefined* | R | PAPIN has the same address as PADDR. If a write is performed, the port A settings will change. |
| 5 | PA5PIN | Undefined* | R | is performed, the pert / tectings will enalige. |
| 4 | PA4PIN | Undefined* | R | _ |
| 3 | PA3PIN | Undefined* | R | |
| 2 | PA2PIN | Undefined* | R | _ |
| 1 | PA1PIN | Undefined* | R | _ |
| 0 | PA0PIN | Undefined* | R | - |

Note:* The initial value is determined according to the PA7 to PA0 pin states.

8.11.4 Pin Functions

• PA7/A23/KIN15/CIN15/PS2CD

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_2 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA7DDR bit.

| Operating Mode | Modes | 1, 2 (EXPE | = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|------------------------------|------------|------------------|------------------------------|-------------|-------------------|------------------|
| KBIOE | 0 | | 1 | | 0 | 1 | |
| PA7DDR | 0 1 | | _ | 0 | 1 | | _ |
| IOSE | _ | _ | | _ | 0 | 1 | _ |
| Pin Function | PA7 PA7 input pin output pin | | PS2CD output pin | PA7 A23 output input pin pin | | PA7 output pin | PS2CD output pin |
| | | KIN15 | input pin, Cl | N15 input pi | n, PS2CD in | out pin* | |

Note:* When the KBIOE bit is set to 1 or the IICS bit in STCR is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2CD, KIN15, or CIN15 input pin.

• PA6/A22/KIN14/CIN14/PS2CC

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_2 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA6DDR bit.

| Operating Mode | Modes | 3 1, 2 (EXPE | = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|--|-------------------|---------------------|-------------------|-------------------|-------------------|---------------------|
| KBIOE | 0 1 | | | 0 | | | 1 |
| PA6DDR | 0 | 1 | _ | 0 | 1 | | _ |
| IOSE | _ | _ | _ | _ | 0 | 1 | _ |
| Pin Function | PA6 input pin | PA6 output pin | PS2CC output pin | PA6 input pin | A22 output pin | PA6 output pin | PS2CC output pin |
| | KIN14 input pin, CIN14 input pin, PS2CC input pin* | | | | | | |

Note:* When the KBIOE bit is set to 1 or the IICS bit in STCR is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2CC, KIN14, or CIN14 input pin.

• PA5/A21/KIN13/CIN13/PS2BD

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_1 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA5DDR bit.

| Operating Mode | Modes | 1, 2 (EXPE | = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|------------------|-------------------|--------------------------------------|-----------------------------------|-----------------------------------|-------------------------------|---------------------|
| KBIOE | 0 1 | | | 0 | | | 1 |
| PA5DDR | 0 | 0 1 | | 0 | 1 | | _ |
| IOSE | _ | _ | _ | _ | 0 | 1 | _ |
| Pin Function | PA5 input pin | PA5 output pin | PS2BD output pin input pin, CI | PA5 input pin N13 input pir | A21 output pin n, PS2BD inp | PA5 output pin out pin* | PS2BD output pin |

Note:* When the KBIOE bit is set to 1 or the IICS bit in STCR is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2BD, KIN13, or CIN13 input pin.

• PA4/A20/KIN12/CIN12/PS2BC

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_1 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA4DDR bit.

| Operating Mode | Modes 1, 2 (EXPE = 0), 3 | | | Mode 2 (EXPE = 1) | | | |
|-------------------|--|-----|---|-----------------------------------|-----------------------------------|-------------------------------|---------------------|
| KBIOE | (|) | 1 | 0 | | | 1 |
| PA4DDR | 0 | 0 1 | | 0 | 1 | | _ |
| IOSE | _ | _ | _ | _ | 0 | 1 | _ |
| Pin Function | PA4 PA4 PS2BC output pin output pin KIN12 input pin, CIN | | | PA4 input pin N12 input pir | A20 output pin n, PS2BC inp | PA4 output pin out pin* | PS2BC output pin |

Note:* When the KBIOE bit is set to 1 or the IICS bit in STCR is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2BC, KIN12, or CIN12 input pin.

• PA3/A19/KIN11/CIN11/PS2AD

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_0 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA3DDR bit.

| Operating Mode | Modes | 3 1, 2 (EXPE | = 0), 3 | Mode 2 (EXPE = 1) | | | | |
|-------------------|-------|--------------|---------------------|-------------------|-------------------|-------------------|---------------------|--|
| KBIOE | (|) | 1 | | 0 | 0 | | |
| PA3DDR | 0 1 | | _ | 0 | 1 | | _ | |
| IOSE | _ | _ | _ | _ | 0 | 1 | _ | |
| Pin Function | | | PS2AD output pin | PA3 input pin | A19 output pin | PA3 output pin | PS2AD output pin | |
| | | KIN11 | input pin, Cl | N11 input pir | n, PS2AD inp | out pin* | | |

Note:* When the KBIOE bit is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2AD, KIN11, or CIN11 input pin.

• PA2/A18/KIN10/CIN10/PS2AC

The pin function is switched as shown below according to the combination of operating mode, the KBIOE bit in KBCRH_0 of the keyboard buffer controller, the IOSE bit in SYSCR, and the PA2DDR bit.

| Operating Mode | Modes | 3 1, 2 (EXPE | = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|--|--------------|------------------|-------------------|-------------------|------------------|---|
| KBIOE | (|) | 1 | | 0 | | |
| PA2DDR | 0 1 | | _ | 0 | 1 | | _ |
| IOSE | _ | _ | _ | _ | 0 | 1 | _ |
| Pin Function | PA2 PA2 PS2AC input pin output pin | | PA2 input pin | A18 output pin | PA2 output pin | PS2AC output pin | |
| | KIN10 input pin, CIN10 input pin, PS2AC input pin* | | | | | | |

Note:* When the KBIOE bit is set to 1, this pin is an NMOS open-drain output, and has direct bus drive capability. This pin can always be used as the PS2AC, KIN10, or CIN10 input pin.

• PA1/A17/KIN9/CIN9

The pin function is switched as shown below according to the combination of operating mode, the IOSE bit in SYSCR and the PA1DDR bit.

| Operating Mode | Modes 1, 2 (I | EXPE = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|------------------|-------------------|---------------------------|-------------------|-------------------|--|
| PA1DDR | 0 1 | | 0 | 1 | | |
| IOSE | | | _ | 0 1 | | |
| Pin Function | PA1 input pin | PA1 output pin | PA1 input pin | A17 output pin | PA1 output pin | |
| | | KIN9 in | nput pin, CIN9 input pin* | | | |

Note:* This pin can always be used as the KIN9 or CIN9 input pin.

• PA0/A16/ KIN8/CIN8

The pin function is switched as shown below according to the combination of operating mode, the IOSE bit in SYSCR and the PA0DDR bit.

| Operating Mode | Modes 1, 2 (| EXPE = 0), 3 | Mode 2 (EXPE = 1) | | | |
|-------------------|------------------|-------------------|--------------------------|-------------------|-------------------|--|
| PA0DDR | 0 1 | | 0 | 1 | | |
| IOSE | | | | 0 1 | | |
| Pin Function | PA0 input pin | PA0 output pin | PA0 input pin | A16 output pin | PA0 output pin | |
| KIN8 inpu | | | put pin, CIN8 input pin* | | | |

Note:* This pin can always be used as the KIN8 or CIN8 input pin.

8.11.5 Port A Input Pull-Up MOS

Port A has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

The input pull-up MOS for pins PA7 to PA4 is always off when IICS is set to 1. When the keyboard buffer control pin function is selected for pins PA7 to PA2, the input pull-up MOS is always off.

Table 8.6 summarizes the input pull-up MOS states.

Table 8.6 Input Pull-Up MOS States (Port A)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|---------|-------|--------------------------|--------------------------|------------------------|
| 1, 2, 3 | Off | Off | On/Off | On/Off |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, PADDR = 0, and PAODR = 1; otherwise off.

8.12 Port B

Port B is an 8-bit I/O port. Port B pins also have XBS input/output pins, LPC input/output pins, wakeup event interrupt input pins, and a data bus input/output function. The pin functions depend on the operating mode. Port B has the following registers.

- Port B data direction register (PBDDR)
- Port B output data register (PBODR)
- Port B input data register (PBPIN)

8.12.1 Port B Data Direction Register (PBDDR)

PBDDR specifies input or output for the pins of port B on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PB7DDR | 0 | W | PBDDR has the same address as P7PIN, and if |
| 6 | PB6DDR | 0 | W | read, the port 7 pin states will be returned. |
| 5 | PB5DDR | 0 | W | |
| 4 | PB4DDR | 0 | W | When the ABW bit in WSCR is cleared to 0, |
| 3 | PB3DDR | 0 | W | port B pins automatically become data I/O pins |
| 2 | PB2DDR | 0 | W | (D7 to D0), regardless of the input/output |
| 1 | PB1DDR | 0 | W | direction indicated by PBDDR. When the ABW |
| 0 | PB0DDR | 0 | W | bit is 1, a port B pin becomes an output port if the corresponding PBDDR bit is set to 1, and an input port if the bit is cleared to 0. Modes 2 and 3 (EXPE = 0) |
| | | | | A port B pin becomes an output port if the corresponding PBDDR bit is set to 1, and an input port if the bit is cleared to 0. |

8.12.2 Port B Output Data Register (PBODR)

PBODR stores output data for port B.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PB7ODR | 0 | R/W | PBODR can always be read or written to, |
| 6 | PB6ODR | 0 | R/W | regardless of the contents of PBDDR. |
| 5 | PB5ODR | 0 | R/W | - |
| 4 | PB4ODR | 0 | R/W | - |
| 3 | PB3ODR | 0 | R/W | - |
| 2 | PB2ODR | 0 | R/W | - |
| 1 | PB1ODR | 0 | R/W | - |
| 0 | PB0ODR | 0 | R/W | _ |

8.12.3 Port B Input Data Register (PBPIN)

PBPIN indicates the port B state.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------------------------------|--|
| 7 | PB7PIN | Undefined* | R | Reading PBPIN always returns the pin states. |
| 6 | PB6PIN | Undefined* | R | PBPIN has the same address as P8DDR. If a write is performed, data will be written to P8DDR and the |
| 5 | PB5PIN | Undefined* | R port 8 settings will change. | • |
| 4 | PB4PIN | Undefined* | R | _ |
| 3 | PB3PIN | Undefined* | R | - |
| 2 | PB2PIN | Undefined* | R | _ |
| 1 | PB1PIN | Undefined* | R | _ |
| 0 | PB0PIN | Undefined* | R | |

Note:* The initial value is determined according to the PB7 to PB0 pin states.

8.12.4 Pin Functions

• PB7/D7/WUE7*², PB6/D6/WUE6*², PB5/D5/WUE5*², PB4/D4/WUE4*²

The pin function is switched as shown below according to the combination of the operating mode, the PBnDDR bit, and the ABW bit in WSCR.

| Operating Mode | Mode 1 | and Modes 2, 3 | Modes 2, 3 | (EXPE = 0) | |
|-------------------|---------------|------------------|-------------------|------------------|-------------------|
| ABW | 0 | | 1 | _ | _ |
| PBnDDR | _ | 0 1 | | 0 | 1 |
| Pin Function | Dn I/O pin | PBn input pin | PBn output pin | PBn input pin | PBn output pin |
| | | | WUEn ir | nput pin*1 | |

Notes: 1. Except when used as a data bus pin, this pin can always be used as the $\overline{\text{WUEn}}$ input pin. (n = 7 to 4)

2. Not supported by the H8S/2148B.

PB3/D3/WUE3*²/CS4

The pin function is switched as shown below according to the combination of the operating mode, the HI12E and CS4E bits in SYSCR2, the ABW bit in WSCR, and the PB3DDR bit.

| Operating Mode | Mode 1 ar | nd Modes 2, 3 | (EXPE = 1) | Mode | es 2, 3 (EXPE = | 0) |
|-------------------|------------|------------------|-------------------|------------------|-------------------|------------------|
| HI12E | | _ | | Either cle | 1 | |
| CS4E | | _ | | | 1 | |
| ABW | 0 | | 1 | - | _ | |
| PB3DDR | _ | 0 | 1 | 0 | 1 | _ |
| Pin Function | D3 I/O pin | PB3 input pin | PB3 output pin | PB3 input pin | PB3 output pin | CS4 input pin |
| | | | V | WUE3 input pin*1 | | |

Notes: 1. Except when used as a data bus pin, this pin can always be used as the $\overline{\text{WUE3}}$ input pin. The $\overline{\text{CS4}}$ input pin can only be used in mode 2 or 3 (EXPE = 0).

2. Not supported by the H8S/2148B.

PB2/D2/WUE2*²/CS3

The pin function is switched as shown below according to the combination of the operating mode, the HI12E and CS3E bits in SYSCR2, the ABW bit in WSCR, and the PB2DDR bit.

| Operating Mode | Mode 1 ar | nd Modes 2, 3 | (EXPE = 1) | Modes 2, 3 (EXPE = 0) | | |
|-------------------|------------|------------------|-------------------|-----------------------|-------------------|------------------|
| HI12E | | _ | | Either cleared to 0 | | 1 |
| CS3E | | _ | | | 1 | |
| ABW | 0 | , | 1 | _ | _ | |
| PB2DDR | _ | 0 | 1 | 0 | 1 | _ |
| Pin Function | D2 I/O pin | PB2 input pin | PB2 output pin | PB2 input pin | PB2 output pin | CS3 input pin |
| | | | V | WUE2 input pin*1 | | |

Notes: 1. Except when used as a data bus pin, this pin can always be used as the $\overline{WUE2}$ input pin. The $\overline{CS3}$ input pin can only be used in mode 2 or 3 (EXPE = 0).

2. Not supported by the H8S/2148B.

• PB1/D1/WUE1/HIRQ4/LSCI*4

The pin function is switched as shown below according to the combination of the operating mode, the HI12E and CS4E bits in SYSCR2, the LSCIE bits in HICR0 of host interface (LPC), the ABW bit in WSCR, and the PB1DDR bit.

| Operating Mode | Modes | 1, 2, 3 (EXF | PE = 1) | Mode 2, 3 (EXPE = 0) | | | |
|-------------------|------------|------------------|-------------------|------------------------------|----------------|---------------------|----------------------|
| LSCIE | | 0*3 | | | 0 | | 1 |
| HI12E | | | | Either cle | eared to 0 | 1 | 0*1 |
| CS4E | | _ | | | | 1 | _ |
| ABW | 0 | | 1 | _ | | _ | _ |
| PB1DDR | _ | 0 | 1 | 0 | 1 | _ | 0*1 |
| Pin Function | D1 I/O pin | PB1 input pin | PB1 output pin | PB1 input pin | PB1 output pin | HIRQ4 output pin | LSCI*4 output pin |
| | | | | LSCI input pin* ² | | | |
| | | | | WUE1 input pin*2*4 | | | |

Notes: 1. When bit LSCIE is set to 1 in HICR0, bits HI12E and PB1DDR should be cleared to 0.

- 2. Except when used as a data bus pin, this pin can always be used as the WUE1 input pin. The HIRQ4 output pin and LSCI I/O pin can only be used in mode 2 or 3 (EXPE = 0).
- 3. In mode 1, 2, 3 (EXPE = 1), clear the LSCIE bit to 0.
- 4. Not supported by the H8S/2148B.

• PB0/D0/WUE0/HIRQ3/LSMI*4

The pin function is switched as shown below according to the combination of the operating mode, the HI12E and CS3E bits in SYSCR2, the LSMIE bits in HICR0 of host interface (LPC), the ABW bit in WSCR, and the PB0DDR bit.

| Operating Mode | Modes | 1, 2, 3 (EXF | PE = 1) | Mode 2, 3 (EXPE = 0) | | | |
|-------------------|------------|------------------|-------------------|----------------------|----------------|---------------------|----------------------|
| LSMIE | | 0*3 | | | 0 | | 1 |
| HI12E | | _ | | Either cle | eared to 0 | 1 | 0*1 |
| CS3E | | _ | | | | 1 | _ |
| ABW | 0 | | 1 | - | | _ | _ |
| PB0DDR | _ | 0 | 1 | 0 | 1 | _ | 0*1 |
| Pin Function | D0 I/O pin | PB0 input pin | PB0 output pin | PB0 input pin | PB0 output pin | HIRQ3 output pin | LSMI*4 output pin |
| | | | | WUE0 input pin*2 | | | |

Notes: 1. When bit LSMIE is set to 1 in HICR0, bits HI12E and PB0DDR should be cleared to 0.

- Except when used as a data bus pin, this pin can always be used as the WUE0 input pin. The HIRQ3 output pin and LSMI I/O pin can only be used in mode 2 or 3 (EXPE = 0).
- 3. In mode 1, 2, 3 (EXPE = 1), clear the LSMIE bit to 0.
- 4. Not supported by the H8S/2148B.

8.12.5 Port B Input Pull-Up MOS

Port B has an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be specified as on or off on a bit-by-bit basis.

When a pin is designated as an on-chip peripheral module output pin, the input pull-up MOS is always off.

Table 8.7 summarizes the input pull-up MOS states.

Table 8.7 Input Pull-Up MOS States (Port B)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | In Other Operations |
|---|-------|--------------------------|--------------------------|------------------------|
| 1, 2, 3 (EXPE = 1) with ABW in WSCR = 0 | Off | Off | Off | Off |
| 1, 2, 3 (EXPE = 1) with ABW in WSCR = 1, or 2, 3 (EXPE = 0) | _ | | On/Off | On/Off |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when the pin is in the input state, PBDDR = 0, and PBODR = 1; otherwise off.

8.13 Additional Overview for H8S/2160B and H8S/2161B

The H8S/2160B and H8S/2161B has fifteen I/O ports (ports 1 to 6, 8, 9, A, B, C, D, E, F, G), and one input-only port (port 7).

Table 8.8 is a summary of the additional port functions. As the functions of ports 1 to 9, A, and B are the same on the H8S/2140B, H8S/2141B, H8S/2148B, and H8S/2145B, table 8.1 provides a summary.

Each extra port includes a data direction register (DDR) that controls input/output, and data registers (ODR) for storing output data.

Ports C, D, E, and F have an on-chip input pull-up MOS function. On ports C, D, E, and F, whether the input pull-up MOS is on or off is controlled by the corresponding DDR and ODR.

Ports C, D, E, F, and G can drive a single-TTL load and 30-pF-capacitive load. All I/O port pins are capable of driving a Darlington transistor when they are in output.

The output type on port G is NMOS push-pull output. Port G can be 5-V tolerant.

When port G is used as an output pin, connect a pull-up resistor to the pin for raise an output high-level voltage.

Table 8.8 H8S/2160B, H8S/2161B Additional Port Functions

Mode 2, 3 **Port Description** Mode 1 (EXPE = 1)(EXPE = 0)I/O Status Port C 8-bit I/O port PC7 to PC0 On-chip input pull-up MOSs Port D 8-bit I/O port PD7 to PD0 On-chip input pull-up MOSs Port E 8-bit I/O port PE7 to PE0 On-chip input pull-up MOSs Port F On-chip input 8-bit I/O port PF7 to PF0 pull-up MOSs Port G 8-bit I/O port PG7 to PG0

8.14 Ports C, D

Port C and port D are two sets of 8-bit I/O ports. The pin functions are the same in all operating modes.

- Port C data direction register (PCDDR)
- Port C output data register (PCODR)
- Port C input data register (PCPIN)
- Port C Nch-OD control register (PCNOCR)
- Port D data direction register (PDDDR)
- Port D output data register (PDODR)
- Port D input data register (PDPIN)
- Port D Nch-OD control register (PDNOCR)

8.14.1 Port C and Port D Data Direction Registers (PCDDR, PDDDR)

PCDDR and PDDDR select input or output for the pins of port C and port D on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PC7DDR | 0 | W | 0: Port C pin is an input pin |
| 6 | PC6DDR | 0 | W | 1: Port C pin is an output pin |
| 5 | PC5DDR | 0 | W | PCDDR has the same address as PCPIN, and if |
| 4 | PC4DDR | 0 | W | read, the port C pin states will be returned. |
| 3 | PC3DDR | 0 | W | |
| 2 | PC2DDR | 0 | W | |
| 1 | PC1DDR | 0 | W | |
| 0 | PC0DDR | 0 | W | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PD7DDR | 0 | W | 0: Port D pin is an input pin |
| 6 | PD6DDR | 0 | W | 1: Port D pin is an output pin |
| 5 | PD5DDR | 0 | W | PDDDR has the same address as PDPIN, and if |
| 4 | PD4DDR | 0 | W | read, the port D pin states will be returned. |
| 3 | PD3DDR | 0 | W | |
| 2 | PD2DDR | 0 | W | |
| 1 | PD1DDR | 0 | W | |
| 0 | PD0DDR | 0 | W | |

8.14.2 Port C and Port D Output Data Registers (PCODR, PDODR)

PCODR and PDODR store output data for the pins on ports C and D.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PC7ODR | 0 | R/W | PCODR can always be read or written to, |
| 6 | PC6ODR | 0 | R/W | regardless of the contents of PCDDR. |
| 5 | PC5ODR | 0 | R/W | _ |
| 4 | PC4ODR | 0 | R/W | _ |
| 3 | PC3ODR | 0 | R/W | _ |
| 2 | PC2ODR | 0 | R/W | _ |
| 1 | PC10DR | 0 | R/W | _ |
| 0 | PC0ODR | 0 | R/W | _ |
| | • | | | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PD70DR | 0 | R/W | PDODR can always be read or written to, |
| 6 | PD6ODR | 0 | R/W | regardless of the contents of PDDDR. |
| 5 | PD5ODR | 0 | R/W | - |
| 4 | PD4ODR | 0 | R/W | _ |
| 3 | PD3ODR | 0 | R/W | _ |
| 2 | PD2ODR | 0 | R/W | _ |
| 1 | PD10DR | 0 | R/W | _ |
| 0 | PD00DR | 0 | R/W | - |

8.14.3 Port C and Port D Input Data Registers (PCPIN, PDPIN)

Reading PCPIN and PDPIN always returns the pin states.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PC7PIN | Undefined* | R | PCPIN indicates the port C state. PCPIN has the |
| 6 | PC6PIN | Undefined* | R | same address as PCDDR. If a write is performed, the port C settings will change. |
| 5 | PC5PIN | Undefined* | R | - the port of countries will charige. |
| 4 | PC4PIN | Undefined* | R | |
| 3 | PC3PIN | Undefined* | R | |
| 2 | PC2PIN | Undefined* | R | |
| 1 | PC1PIN | Undefined* | R | _ |
| 0 | PC0PIN | Undefined* | R | _ |

Note:* The initial value is determined according to the PC7 to PC0 pin states.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PD7PIN | Undefined* | R | PDPIN indicates the port D state. PDPIN has the |
| 6 | PD6PIN | Undefined* | R | same address as PDDDR. If a write is performed, the port D settings will change. |
| 5 | PD5PIN | Undefined* | R | — the port D settings will change. |
| 4 | PD4PIN | Undefined* | R | _ |
| 3 | PD3PIN | Undefined* | R | |
| 2 | PD2PIN | Undefined* | R | _ |
| 1 | PD1PIN | Undefined* | R | |
| 0 | PD0PIN | Undefined* | R | |

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Note:* The initial value is determined according to the PD7 to PD0 pin states.

8.14.4 Port C and Port D Nch-OD Control Register (PCNOCR, PDNOCR)

PCNOCR and PDNOCR specify the output driver type for pins on ports C and D which are configured as outputs on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PC7NOCR | 0 | R/W | 0: CMOS (p-channel driver enabled) |
| 6 | PC6NOCR | 0 | R/W | 1: N-channel open drain (p-channel driver disabled) |
| 5 | PC5NOCR | 0 | R/W | _ |
| 4 | PC4NOCR | 0 | R/W | _ |
| 3 | PC3NOCR | 0 | R/W | |
| 2 | PC2NOCR | 0 | R/W | _ |
| 1 | PC1NOCR | 0 | R/W | _ |
| 0 | PC0NOCR | 0 | R/W | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PD7NOCR | 0 | R/W | 0: CMOS (p-channel driver enabled) |
| 6 | PD6NOCR | 0 | R/W | 1: N-channel open drain (p-channel driver disabled) |
| 5 | PD5NOCR | 0 | R/W | |
| 4 | PD4NOCR | 0 | R/W | _ |
| 3 | PD3NOCR | 0 | R/W | |
| 2 | PD2NOCR | 0 | R/W | _ |
| 1 | PD1NOCR | 0 | R/W | |
| 0 | PD0NOCR | 0 | R/W | |

8.14.5 Pin Functions

| DDR | (|) | 1 | | | |
|-------------------|------|-------|------------|-----|----|-----|
| NOCR | _ | _ | (|) | 1 | |
| ODR | 0 1 | | 0 | 1 | 0 | 1 |
| N-ch. driver | OI | FF | ON | OFF | ON | OFF |
| P-ch. driver | OI | FF | OFF | ON | OI | FF |
| Input pull-up MOS | OFF | ON | OFF | | | |
| Pin function | Inpu | t pin | Output pin | | | |

8.14.6 Input Pull-Up MOS in Ports C and D

Port C and port D have an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be switched on or off on a bit-by-bit basis.

Table 8.9 is a summary of the input pull-up MOS states.

Table 8.9 Input Pull-Up MOS States (Port C and port D)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | Other Operations |
|---------|-------|--------------------------|--------------------------|---------------------|
| 1, 2, 3 | Off | Off | On/Off | On/Off |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when PCDDR = 0 and PCODR = 1 (PDDDR = 0 and PDODR = 1); otherwise off.

8.15 **Ports E, F**

Port E and port F are two sets of 8-bit I/O ports. The pins of ports E and F have the same functions in all operating modes.

- Port E data direction register (PEDDR)
- Port E output data register (PEODR)
- Port E input data register (PEPIN)
- Port E Nch-OD control register (PENOCR)
- Port F data direction register (PFDDR)
- Port F output data register (PFODR)
- Port F input data register (PFPIN)
- Port F Nch-OD control register (PFNOCR)

8.15.1 Port E and Port F Data Direction Registers (PEDDR, PFDDR)

PEDDR and PFDDR select input or output for the pins of port E and port F on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PE7DDR | 0 | W | 0: Port E pin is an input pin |
| 6 | PE6DDR | 0 | W | 1: Port E pin is an output pin |
| 5 | PE5DDR | 0 | W | PEDDR has the same address as PEPIN, and if |
| 4 | PE4DDR | 0 | W | read, the port E pin states will be returned. |
| 3 | PE3DDR | 0 | W | |
| 2 | PE2DDR | 0 | W | |
| 1 | PE1DDR | 0 | W | |
| 0 | PE0DDR | 0 | W | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PF7DDR | 0 | W | 0: Port F pin is an input pin |
| 6 | PF6DDR | 0 | W | 1: Port F pin is an output pin |
| 5 | PF5DDR | 0 | W | PFDDR has the same address as PFPIN, and if |
| 4 | PF4DDR | 0 | W | read, the port F pin states will be returned. |
| 3 | PF3DDR | 0 | W | |
| 2 | PF2DDR | 0 | W | |
| 1 | PF1DDR | 0 | W | |
| 0 | PF0DDR | 0 | W | |

8.15.2 Port E and Port F Output Data Registers (PEODR, PFODR)

PEODR and PFODR store output data for the pins on ports E and F.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PE7ODR | 0 | R/W | PEODR can always be read or written to, |
| 6 | PE6ODR | 0 | R/W | regardless of the contents of PEDDR. |
| 5 | PE5ODR | 0 | R/W | |
| 4 | PE4ODR | 0 | R/W | |
| 3 | PE3ODR | 0 | R/W | |
| 2 | PE2ODR | 0 | R/W | |
| 1 | PE10DR | 0 | R/W | |
| 0 | PE0ODR | 0 | R/W | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PF7ODR | 0 | R/W | PFODR can always be read or written to, |
| 6 | PF6ODR | 0 | R/W | regardless of the contents of PFDDR. |
| 5 | PF5ODR | 0 | R/W | - |
| 4 | PF4ODR | 0 | R/W | _ |
| 3 | PF3ODR | 0 | R/W | _ |
| 2 | PF2ODR | 0 | R/W | _ |
| 1 | PF10DR | 0 | R/W | _ |
| 0 | PF0ODR | 0 | R/W | _ |

8.15.3 Port E and Port F Input Data Registers (PEPIN, PFPIN)

Reading PEPIN and PFPIN always returns the pin states.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PE7PIN | Undefined* | R | PEPIN indicates the port E state. PEPIN has the |
| 6 | PE6PIN | Undefined* | R | same address as PEDDR. If a write is performed, the port E settings will change. |
| 5 | PE5PIN | Undefined* | R | - the port 2 detailige will change. |
| 4 | PE4PIN | Undefined* | R | |
| 3 | PE3PIN | Undefined* | R | _ |
| 2 | PE2PIN | Undefined* | R | - |
| 1 | PE1PIN | Undefined* | R | - |
| 0 | PE0PIN | Undefined* | R | - |

Note:* The initial value is determined according to the PE7 to PE0 pin states.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PF7PIN | Undefined* | R | PFPIN indicates the port F state. PFPIN has the |
| 6 | PF6PIN | Undefined* | R | same address as PFDDR. If a write is performed, the port F settings will change. |
| 5 | PF5PIN | Undefined* | R | — the point counge will endinge. |
| 4 | PF4PIN | Undefined* | R | _ |
| 3 | PF3PIN | Undefined* | R | _ |
| 2 | PF2PIN | Undefined* | R | _ |
| 1 | PF1PIN | Undefined* | R | |
| 0 | PF0PIN | Undefined* | R | |

Note:* The initial value is determined according to the PF7 to PF0 pin states.

8.15.4 Port E and Port F Nch-OD Control Register (PENOCR, PFNOCR)

PENOCR and PFNOCR specify the output driver type for pins on ports E and F which are configured as outputs on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PE7NOCR | 0 | R/W | 0: CMOS (p-channel driver enabled) |
| 6 | PE6NOCR | 0 | R/W | 1: N-channel open drain (p-channel driver disabled) |
| 5 | PE5NOCR | 0 | R/W | _ |
| 4 | PE4NOCR | 0 | R/W | _ |
| 3 | PE3NOCR | 0 | R/W | _ |
| 2 | PE2NOCR | 0 | R/W | _ |
| 1 | PE1NOCR | 0 | R/W | _ |
| 0 | PE0NOCR | 0 | R/W | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PF7NOCR | 0 | R/W | 0: CMOS (p-channel driver enabled) |
| 6 | PF6NOCR | 0 | R/W | 1: N-channel open drain (p-channel driver disabled) |
| 5 | PF5NOCR | 0 | R/W | |
| 4 | PF4NOCR | 0 | R/W | |
| 3 | PF3NOCR | 0 | R/W | _ |
| 2 | PF2NOCR | 0 | R/W | _ |
| 1 | PF1NOCR | 0 | R/W | _ |
| 0 | PF0NOCR | 0 | R/W | _ |

8.15.5 Pin Functions

| DDR | (|) | 1 | | | |
|-------------------|--------|-------|-----|------|--------|-----|
| NOCR | _ | _ | 0 | | 1 | |
| ODR | 0 | 1 | 0 | 1 | 0 | 1 |
| N-ch. driver | Ol | FF | ON | OFF | ON | OFF |
| P-ch. driver | Ol | FF | OFF | ON | Ol | FF |
| Input pull-up MOS | OFF ON | | OFF | | | |
| Pin function | Inpu | t pin | | Outp | ut pin | |

8.15.6 Input Pull-Up MOS in Ports E and F

Port E and port F have an on-chip input pull-up MOS function that can be controlled by software. This input pull-up MOS function can be switched on or off on a bit-by-bit basis.

Table 8.10 is a summary of the input pull-up MOS states.

Table 8.10 Input Pull-Up MOS States (Port E and port F)

| Mode | Reset | Hardware Standby Mode | Software Standby Mode | Other Operations |
|---------|-------|--------------------------|--------------------------|---------------------|
| 1, 2, 3 | Off | Off | On/Off | On/Off |

Legend

Off: Input pull-up MOS is always off.

On/Off: On when PEDDR = 0 and PEODR = 1 (PFDDR = 0 and PFODR = 1); otherwise off.

8.16 Port G

Port G is an 8-bit I/O port. Port G pin functions are the same in all operating modes. The output type of port G is NMOS open-drain.

- Port G data direction register (PGDDR)
- Port G output data register (PGODR)
- Port G input data register (PGPIN)
- Port G Nch-OD control register (PGNOCR)

8.16.1 Port G Data Direction Register (PGDDR)

PGDDR selects input or output for the pins of port G on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PG7DDR | 0 | W | 0: Port G pin is an input pin |
| 6 | PG6DDR | 0 | W | 1: Port G pin is an output pin |
| 5 | PG5DDR | 0 | W | PGDDR has the same address as PGPIN, and if |
| 4 | PG4DDR | 0 | W | read, the port G pin states will be returned. |
| 3 | PG3DDR | 0 | W | |
| 2 | PG2DDR | 0 | W | |
| 1 | PG1DDR | 0 | W | |
| 0 | PG0DDR | 0 | W | |
| | | | | |

8.16.2 Port G Output Data Register (PGODR)

PGODR stores output data for the pins on port G.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PG70DR | 0 | R/W | PGODR can always be read or written to, |
| 6 | PG60DR | 0 | R/W | regardless of the contents of PGDDR. |
| 5 | PG50DR | 0 | R/W | _ |
| 4 | PG40DR | 0 | R/W | _ |
| 3 | PG3ODR | 0 | R/W | _ |
| 2 | PG2ODR | 0 | R/W | _ |
| 1 | PG10DR | 0 | R/W | _ |
| 0 | PG00DR | 0 | R/W | _ |

8.16.3 Port G Input Data Register (PGPIN)

Reading PGPIN always returns the pin states.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PG7PIN | Undefined* | R | PGPIN indicates the port G state. PGPIN has the |
| 6 | PG6PIN | Undefined* | R | same address as PGDDR. If a write is performed, the port G settings will change. |
| 5 | PG5PIN | Undefined* | R | - the port of settings will charige. |
| 4 | PG4PIN | Undefined* | R | _ |
| 3 | PG3PIN | Undefined* | R | _ |
| 2 | PG2PIN | Undefined* | R | _ |
| 1 | PG1PIN | Undefined* | R | _ |
| 0 | PG0PIN | Undefined* | R | _ |

Note:* The initial value is determined according to the PG7 to PG0 pin states.

8.16.4 Port G Nch-OD Control Register (PGNOCR)

PGNOCR specifies the output driver type for pins on port G which are configured as outputs on a bit-by-bit basis.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PG7NOCR | 0 | R/W | 0: NMOS push-pull (Vcc-side n-channel driver |
| 6 | PG6NOCR | 0 | R/W | enabled) |
| 5 | PG5NOCR | 0 | R/W | 1: Vss-side N-channel open drain (Vcc-side N- channel driver disabled) |
| 4 | PG4NOCR | 0 | R/W | |
| 3 | PG3NOCR | 0 | R/W | |
| 2 | PG2NOCR | 0 | R/W | _ |
| 1 | PG1NOCR | 0 | R/W | _ |
| 0 | PG0NOCR | 0 | R/W | _ |

8.16.5 Pin Functions

| DDR | (|) | 1 | | | |
|------------------------------------|-----------|----|------------|-----|-----|-----|
| NOCR | _ | _ | 0 | | 1 | |
| ODR | 0 1 | | 0 | 1 | 0 | 1 |
| V _{ss} -side N-ch. driver | OI | FF | ON | OFF | ON | OFF |
| V _∞ -side N-ch. driver | OFF | | OFF | ON | OFF | |
| Pin function | Input pin | | Output pin | | | |

Section 9 8-Bit PWM Timer (PWM)

This LSI has an on-chip pulse width modulation (PWM) timer with sixteen outputs. Sixteen output waveforms are generated from a common time base, enabling PWM output with a high carrier frequency to be produced using pulse division.

9.1 Features

- Operable at a maximum carrier frequency of 625 kHz using pulse division (at 10 MHz operation)
- Duty cycles from 0 to 100% with 1/256 resolution (100% duty realized by port output)
- Direct or inverted PWM output, and PWM output enable/disable control

Figure 9.1 shows a block diagram of the PWM timer.

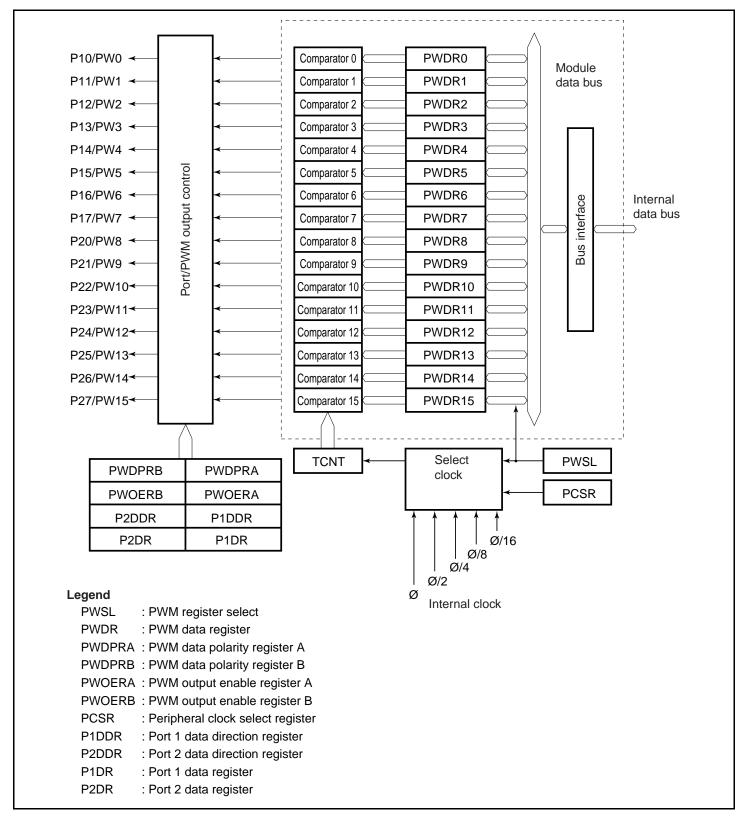


Figure 9.1 Block Diagram of PWM Timer

9.2 Input/Output Pin

Table 9.1 shows the PWM output pins.

Table 9.1 Pin Configuration

| Name | Abbreviation | I/O | Function |
|--------------------|--------------|--------|--------------------------------|
| PWM output 15 to 0 | PW15 to PW0 | Output | PWM timer pulse output 15 to 0 |

9.3 Register Descriptions

The PWM has the following registers. To access PCSR, the FLSHE bit in the serial timer control register (STCR) must be cleared to 0. For details on the serial timer control register (STCR), see section 3.2.3, Serial Timer Control Register (STCR).

- PWM register select (PWSL)
- PWM data registers 0 to 15 (PWDR0 to PWDR15)
- PWM data polarity register A (PWDPRA)
- PWM data polarity register B (PWDPRB)
- PWM output enable register A (PWOERA)
- PWM output enable register B (PWOERB)
- Peripheral clock select register (PCSR)

9.3.1 PWM Register Select (PWSL)

PWSL is used to select the input clock and the PWM data register.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|-------------|---------------|-----|---|
| 7 | PWCKE | 0 | R/W | PWM Clock Enable |
| 6 | PWCKS | 0 | R/W | PWM Clock Select |
| | | | | These bits, together with bits PWCKB and PWCKA in PCSR, select the internal clock input to TCNT in the PWM. For details, see table 9.2. |
| | | | | The resolution, PWM conversion period, and carrier frequency depend on the selected internal clock, and can be obtained from the following equations. |
| | | | | Resolution (minimum pulse width) = 1/internal clock frequency |
| | | | | PWM conversion period = resolution \times 256 |
| | | | | Carrier frequency = 16/PWM conversion period |
| | | | | With a 10 MHz system clock (ø), the resolution, PWM conversion period, and carrier frequency are as shown in table 9.3. |
| 5 | | 1 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |
| 4 | _ | 0 | R | Reserved |
| | | | | This bit is always read as 0 and cannot be modified. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 3 | RS3 | 0 | R/W | Register Select |
| 2 | RS2 | 0 | R/W | These bits select the PWM data register. |
| 1 | RS1 | 0 | R/W | 0000: PWDR0 selected |
| 0 | RS0 | 0 | R/W | 0001: PWDR1 selected |
| | | | | 0010: PWDR2 selected |
| | | | | 0011: PWDR3 selected |
| | | | | 0100: PWDR4 selected |
| | | | | 0101: PWDR5 selected |
| | | | | 0110: PWDR6 selected |
| | | | | 0111: PWDR7 selected |
| | | | | 1000: PWDR8 selected |
| | | | | 1001: PWDR9 selected |
| | | | | 1010: PWDR10 selected |
| | | | | 1011: PWDR11 selected |
| | | | | 1100: PWDR12 selected |
| | | | | 1101: PWDR13 selected |
| | | | | 1110: PWDR14 selected |
| | | | | 1111: PWDR15 selected |

Table 9.2 Internal Clock Selection

| PWSL | | F | PCSR | | |
|-------|-------|-------|-------|------------------------------|-----------------|
| PWCKE | PWCKS | PWCKB | PWCKA | Description | |
| 0 | _ | _ | _ | Clock input is disabled | (Initial value) |
| 1 | 0 | | _ | ø (system clock) is selected | |
| | 1 | 0 | 0 | ø/2 is selected | |
| | | | 1 | ø/4 is selected | |
| | | 1 | 0 | ø/8 is selected | |
| | | | 1 | ø/16 is selected | |

Table 9.3 Resolution, PWM Conversion Period and Carrier Frequency when $\emptyset = 10 \text{ MHz}$

| Internal Clock | | PWM Conversion | |
|----------------|------------|----------------|-------------------|
| Frequency | Resolution | Period | Carrier Frequency |
| Ø | 100 ns | 25.6 μs | 625 kHz |
| ø/2 | 200 ns | 51.2 μs | 312.5 kHz |
| ø/4 | 400 ns | 102.4 μs | 156.3 kHz |
| ø/8 | 800 ns | 204.8 μs | 78.1 kHz |
| ø/16 | 1600 ns | 409.6 μs | 39.1 kHz |

9.3.2 PWM Data Registers (PWDR0 to PWDR15)

PWDR are 8-bit readable/writable registers. The PWM has sixteen PWM data registers. Each PWDR specifies the duty cycle of the basic pulse to be output, and the number of additional pulses. The value set in PWDR corresponds to a 0 or 1 ratio in the conversion period. The upper four bits specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16. The lower four bits specify how many extra pulses are to be added within the conversion period comprising 16 basic pulses. Thus, a specification of 0/256 to 255/256 is possible for 0/1 ratios within the conversion period. For 256/256 (100%) output, port output should be used. PWDR0 to PWDR15 are initialized to H'00.

9.3.3 PWM Data Polarity Registers A and B (PWDPRA, PWDPRB)

Each PWDPR selects the PWM output phase.

PWDPRA

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | OS7 | 0 | R/W | Output Select 7 to 0 |
| 6 | OS6 | 0 | R/W | These bits select the PWM output phase. Bits OS7 to |
| 5 | OS5 | 0 | R/W | OS0 correspond to outputs PW7 to PW0. |
| 4 | OS4 | 0 | R/W | 0: PWM direct output (PWDR value corresponds to high width of output) |
| 3 | OS3 | 0 | R/W | , |
| 2 | OS2 | 0 | R/W | 1: PWM inverted output (PWDR value corresponds to low width of output) |
| 1 | OS1 | 0 | R/W | |
| 0 | OS0 | 0 | R/W | |

PWDPRB

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | OS15 | 0 | R/W | Output Select 15 to 8 |
| 6 | OS14 | 0 | R/W | These bits select the PWM output phase. Bits OS15 to |
| 5 | OS13 | 0 | R/W | OS8 correspond to outputs PW15 to PW8. |
| 4 | OS12 | 0 | R/W | 0: PWM direct output (PWDR value corresponds to high width of output) |
| 3 | OS11 | 0 | R/W | 1 / |
| 2 | OS10 | 0 | R/W | 1: PWM inverted output (PWDR value corresponds to low width of output) |
| 1 | OS9 | 0 | R/W | |
| 0 | OS8 | 0 | R/W | |

9.3.4 PWM Output Enable Registers A and B (PWOERA, PWOERB)

Each PWOER switches between PWM output and port output.

PWOERA

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | OE7 | 0 | R/W | Output Enable 7 to 0 |
| 6 | OE6 | 0 | R/W | These bits, together with P1DDR, specify the P1n/PWn |
| 5 | OE5 | 0 | R/W | pin state. Bits OE7 to OE0 correspond to outputs PW7 to PW0. |
| 4 | OE4 | 0 | R/W | P1nDDR OEn: Pin state |
| 3 | OE3 | 0 | R/W | 0X: Port input |
| 2 | OE2 | 0 | R/W | · |
| 1 | OE1 | 0 | R/W | 10: Port output or PWM 256/256 output |
| 0 | OE0 | 0 | R/W | 11: PWM output (0 to 255/256 output) |

Legend

X: Don't care

RENESAS

PWOERB

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | OE15 | 0 | R/W | Output Enable 15 to 8 |
| 6 | OE14 | 0 | R/W | These bits, together with P2DDR, specify the P2n/PWn |
| 5 | OE13 | 0 | R/W | pin state. Bits OE15 to OE8 correspond to outputs PW15 to PW8. |
| 4 | OE12 | 0 | R/W | P2nDDR OEn: Pin state |
| 3 | OE11 | 0 | R/W | 0X: Port input |
| 2 | OE10 | 0 | R/W | • |
| 1 | OE9 | 0 | R/W | 10: Port output or PWM 256/256 output |
| 0 | OE8 | 0 | R/W | 11: PWM output (0 to 255/256 output) |

Legend

X: Don't care

To perform PWM 256/256 output when DDR = 1 and OE = 0, the corresponding pin should be set to port output. The corresponding pin can be set as port output in single-chip mode or when IOSE = 1 and CS256E = 0 in SYSCR in extended mode with on-chip ROM. Otherwise, it should be noted that an address bus is output to the corresponding pin.

DR data is output when the corresponding pin is used as port output. A value corresponding to PWM 256/256 output is determined by the OS bit, so the value should have been set to DR beforehand.

9.3.5 Peripheral Clock Select Register (PCSR)

PCSR selects the PWM input clock.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 3 | _ | 0 | R | Reserved |
| | | | | This bit is always read as 0. The initial value should not be changed. |
| 2 | PWCKB | 0 | R/W | PWM Clock Select B, A |
| 1 | PWCKA | 0 | R/W | Together with bits PWCKE and PWCKS in PWSL, these bits select the internal clock input to TCNT in the PWM. For details, see table 9.2. |
| 0 | _ | 0 | R | Reserved |
| | | | | This bit is always read as 0. The initial value should not be changed. |

9.4 Operation

The upper four bits of PWDR specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16. Table 9.4 shows the duty cycles of the basic pulse.

Table 9.4 Duty Cycle of Basic Pulse

| Upper 4 Bits | Basic Pulse Waveform (Internal) |
|--------------|-----------------------------------|
| 0000 | 0 1 2 3 4 5 6 7 8 9 A B C D E F 0 |
| 0001 | |
| 0010 | |
| 0011 | |
| 0100 | |
| 0101 | |
| 0110 | |
| 0111 | |
| 1000 | |
| 1001 | |
| 1010 | |
| 1011 | |
| 1100 | |
| 1101 | |
| 1110 | |
| 1111 | |

The lower four bits of PWDR specify the position of pulses added to the 16 basic pulses. An additional pulse adds a high period (when OS = 0) with a width equal to the resolution before the rising edge of a basic pulse. When the upper four bits of PWDR are 0000, there is no rising edge of the basic pulse, but the timing for adding pulses is the same. Table 9.5 shows the positions of the additional pulses added to the basic pulses, and figure 9.2 shows an example of additional pulse timing.

Table 9.5 Position of Pulses Added to Basic Pulses

| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----|-----------------------------|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | | | | | | | _ | | | - • | | |
| | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | Yes |
| | | | | | | Yes | | | | | | | | Yes |
| | | | | | | Yes | | | | Yes | | | | Yes |
| | | Yes | | | | Yes | | | | Yes | | | | Yes |
| | | Yes | | | | Yes | | | | Yes | | Yes | | Yes |
| | | Yes | | Yes | | Yes | | | | Yes | | Yes | | Yes |
| | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes |
| Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes |
| Yes | | Yes | | Yes | | Yes | | Yes | | Yes | | Yes | Yes | Yes |
| Yes | | Yes | | Yes | Yes | Yes | | Yes | | Yes | | Yes | Yes | Yes |
| Yes | | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes |
| Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes |
| Yes | Yes | Yes | | Yes | Yes | Yes | | Yes | Yes | Yes | Yes | Yes | Yes | Yes |
| Yes | Yes | Yes | Yes | Yes | Yes | Yes | | Yes | Yes | Yes | Yes | Yes | Yes | Yes |
| Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes | Yes |
| | Yes Yes Yes Yes Yes Yes Yes | Yes | Yes | Yes | Yes Yes Yes Yes | Yes Yes Yes Yes | Yes Yes Yes Yes | Yes Yes Yes Yes | Yes Yes Yes | Yes Yes Yes | Yes Yes Yes Yes Yes Yes | Yes Yes Yes Yes Yes Yes | Yes Yes Yes Yes Yes Yes | Yes Yes Yes |

Basic Pulse No.

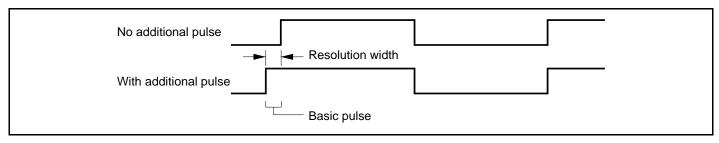


Figure 9.2 Example of Additional Pulse Timing (when Upper 4 Bits of PWDR = 1000)

9.5 Usage Note

9.5.1 Module Stop Mode Setting

PWM operation can be enabled or disabled using the module stop control register. The initial setting is for PWM operation to be halted. Register access is enabled by canceling the module stop mode. For details, refer to section 26, Power-Down Modes.

Section 10 14-Bit PWM Timer (PWMX)

This LSI has an on-chip 14-bit pulse-width modulator (PWM) timer with two output channels. It can be connected to an external low-pass filter to operate as a 14-bit D/A converter.

10.1 Features

- Division of pulse into multiple base cycles to reduce ripple
- Two resolution settings
 The resolution can be set equal to one or two system clock cycles.
- Two base cycle settings

 The base cycle can be set equal to $T \times 64$ or $T \times 256$, where T is the resolution.
- Four operating speeds
- Four operation clocks (by combination of two resolution settings and two base cycle settings)

Figure 10.1 shows a block diagram of the PWM (D/A) module.

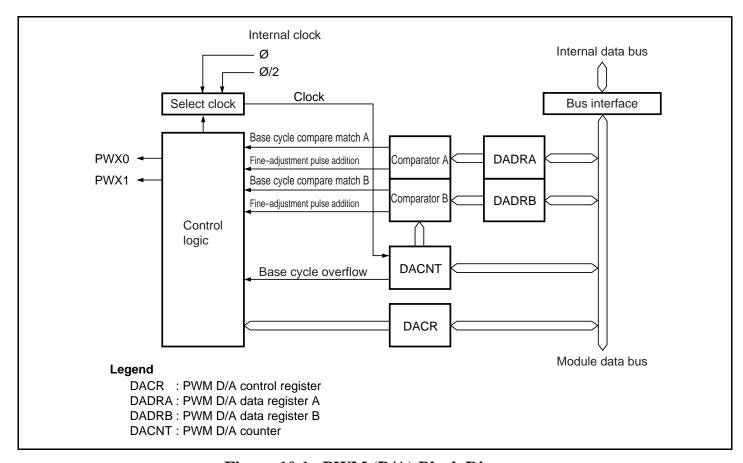


Figure 10.1 PWM (D/A) Block Diagram

10.2 Input/Output Pins

Table 10.1 lists the PWM (D/A) module input and output pins.

Table 10.1 Pin Configuration

| Name | Abbreviation | I/O | Function |
|-------------------|--------------|--------|------------------------------|
| PWM output pin X0 | PWX0 | Output | PWM output of PWMX channel A |
| PWM output pin X1 | PWX1 | Output | PWM output of PWMX channel B |

10.3 Register Descriptions

The PWM (D/A) module has the following registers. The PWM (D/A) registers are assigned to the same addresses with other registers. The registers are selected by the IICE bit in the serial timer control register (STCR). For details on STCR, see section 3.2.3, Serial Timer Control Register (STCR).

- PWM (D/A) counter H (DACNTH)
- PWM (D/A) counter L (DACNTL)
- PWM (D/A) data register AH (DADRAH)
- PWM (D/A) data register AL (DADRAL)
- PWM (D/A) data register BH (DADRBH)
- PWM (D/A) data register BL (DADRBL)
- PWM (D/A) control register (DACR)

Note: The same addresses are shared by DADRA and DACR, and by DADRB and DACNT. Switching is performed by the REGS bit in DACNT or DADRB.

10.3.1 PWM (D/A) Counters H and L (DACNTH, DACNTL)

DACNT is a 14-bit readable/writable up-counter. The input clock is selected by the clock select bit (CKS) in DACR. DACNT functions as the time base for both PWM (D/A) channels. When a channel operates with 14-bit precision, it uses all DACNT bits. When a channel operates with 12-bit precision, it uses the lower 12 bits and ignores the upper two bits. Since DACNT consists of 16-bit data, DACNT transfers data to the CPU via the temporary register (TEMP). For details, refer to section 10.4, Bus Master Interface.

| | | | | [| DACN | ГΗ | | | | - | | | DAC | NTL | | | |
|----------------------------|---|----------|---------|---------|---------|----|----|---|---|----------|--------|---------|---------|-----|---------|---|------|
| Bit (CPU) Bit (Counter) | : | 15 | 14 6 | 13 5 | 12 4 | 11 | 10 | 9 | 8 | 7 8 | 6 9 | 5 10 | 4 11 | 3 | 2 13 | 1 | 0 |
| Dit (Oddriter) | • | | 6 | 5 | 4 | 3 | | I | U | 0 | Э | 10 | 11 | 12 | 13 | - | REGS |

• DACNTH

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|------------------|
| 7 | UC7 | All 0 | R/W | Upper Up-Counter |
| to | to | | | |
| 0 | UC0 | | | |

• DACNTL

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|------------|---------------|-----|---|
| 7 to | UC8 | All 0 | R/W | Lower Up-Counter |
| to 2 | to UC13 | | | |
| 1 | _ | 1 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |
| 0 | REGS | 1 | R/W | Register Select |
| | | | | DADRA and DACR, and DADRB and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. |
| | | | | 0: DADRA and DADRB can be accessed |
| | | | | 1: DACR and DACNT can be accessed |

10.3.2 PWM (D/A) Data Registers A and B (DADRA, DADRB)

DADRA corresponds to PWM (D/A) channel A, and DADRB to PWM (D/A) channel B. Since DADR consists of 16-bit data, DADR transfers data to the CPU via the temporary register (TEMP). For details, refer to section 10.4, Bus Master Interface.

DADRA

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 15 | DA13 | 1 | R/W | D/A Data 13 to 0 |
| 14 | DA12 | 1 | R/W | These bits set a digital value to be converted to an |
| 13 | DA11 | 1 | R/W | analog value. |
| 12 | DA10 | 1 | R/W | In each base cycle, the DACNT value is continually |
| 11 | DA9 | 1 | R/W | compared with the DADR value to determine the duty cycle of the output waveform, and to decide whether to |
| 10 | DA8 | 1 | R/W | output a fine-adjustment pulse equal in width to the |
| 9 | DA7 | 1 | R/W | resolution. To enable this operation, this register must |
| 8 | DA6 | 1 | R/W | be set within a range that depends on the CFS bit. If the |
| 7 | DA5 | 1 | R/W | DADR value is outside this range, the PWM output is held constant. |
| 6 | DA4 | 1 | R/W | A channel can be operated with 12-bit precision by |
| 5 | DA3 | 1 | R/W | keeping the two lowest data bits (DA1 and DA0) cleared |
| 4 | DA2 | 1 | R/W | to 0. The two lowest data bits correspond to the two |
| 3 | DA1 | 1 | R/W | highest bits in DACNT. |
| 2 | DA0 | 1 | R/W | |
| 1 | CFS | 1 | R/W | Carrier Frequency Select |
| | | | | 0: Base cycle = resolution (T) × 64 DADR range = H'0401 to H'FFFD |
| | | | | 1: Base cycle = resolution (T) × 256 DADR range = H'0103 to H'FFFF |
| 0 | _ | 1 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |
| _ | | | • | |

• DADRB

| Bit | Bit Name | Initial Value | R/W | Description | | | | | | |
|-----|----------|---------------|-----|---|--|--|--|--|--|--|
| 15 | DA13 | 1 | R/W | D/A Data 13 to 0 | | | | | | |
| 14 | DA12 | 1 | R/W | These bits set a digital value to be converted to an | | | | | | |
| 13 | DA11 | 1 | R/W | analog value. | | | | | | |
| 12 | DA10 | 1 | R/W | In each base cycle, the DACNT value is continually | | | | | | |
| 11 | DA9 | 1 | R/W | compared with the DADR value to determine the duty cycle of the output waveform, and to decide whether to | | | | | | |
| 10 | DA8 | 1 | R/W | output a fine-adjustment pulse equal in width to the | | | | | | |
| 9 | DA7 | 1 | R/W | resolution. To enable this operation, this register must | | | | | | |
| 8 | DA6 | 1 | R/W | be set within a range that depends on the CFS bit. If the DADR value is outside this range, the PWM output is | | | | | | |
| 7 | DA5 | 1 | R/W | held constant. | | | | | | |
| 6 | DA4 | 1 | R/W | A channel can be operated with 12-bit precision by | | | | | | |
| 5 | DA3 | 1 | R/W | keeping the two lowest data bits (DA1 and DA0) cleared | | | | | | |
| 4 | DA2 | 1 | R/W | to 0. The two lowest data bits correspond to the two | | | | | | |
| 3 | DA1 | 1 | R/W | highest bits in DACNT. | | | | | | |
| 2 | DA0 | 1 | R/W | | | | | | | |
| 1 | CFS | 1 | R/W | Carrier Frequency Select | | | | | | |
| | | | | 0: Base cycle = resolution (T) × 64 DADR range = H'0401 to H'FFFD | | | | | | |
| | | | | 1: Base cycle = resolution (T) × 256 DADR range = H'0103 to H'FFFF | | | | | | |
| 0 | REGS | 1 | R/W | Register Select | | | | | | |
| | | | | DADRA and DACR, and DADRB and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. | | | | | | |
| | | | | 0: DADRA and DADRB can be accessed | | | | | | |
| | | | | 1: DACR and DACNT can be accessed | | | | | | |

10.3.3 PWM (D/A) Control Register (DACR)

DACR selects test mode, enables the PWM outputs, and selects the output phase and operating speed.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | TEST | 0 | R/W | Test Mode |
| | | | | Selects test mode, which is used in testing this LSI. Normally this bit should be cleared to 0. |
| | | | | 0: PWM (D/A) in user state: Normal operation |
| | | | | 1: PWM (D/A) in test state: Correct conversion results unobtainable |
| 6 | PWME | 0 | R/W | PWM Enable |
| | | | | Starts or stops the PWM D/A counter (DACNT). |
| | | | | 0: DACNT operates as a 14-bit up-counter |
| | | | | 1: DACNT halts at H'0003 |
| 5 | _ | 1 | R | Reserved |
| 4 | _ | 1 | R | These bits are always read as 1 and cannot be modified. |
| 3 | OEB | 0 | R/W | Output Enable B |
| | | | | Enables or disables output on PWM (D/A) channel B. |
| | | | | 0: PWM (D/A) channel B output (at the PWX1 pin) is disabled |
| | | | | 1: PWM (D/A) channel B output (at the PWX1 pin) is enabled |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 2 | OEA | 0 | R/W | Output Enable A |
| | | | | Enables or disables output on PWM (D/A) channel A. |
| | | | | 0: PWM (D/A) channel A output (at the PWX0 pin) is disabled |
| | | | | 1: PWM (D/A) channel A output (at the PWX0 pin) is enabled |
| 1 | OS | 0 | R/W | Output Select |
| | | | | Selects the phase of the PWM (D/A) output. |
| | | | | 0: Direct PWM (D/A) output |
| | | | | 1: Inverted PWM (D/A) output |
| 0 | CKS | 0 | R/W | Clock Select |
| | | | | Selects the PWM (D/A) resolution. If the system clock (Ø) frequency is 10 MHz, resolutions of 100 ns and 200 ns, can be selected. |
| | | | | 0: Operates at resolution (T) = system clock cycle time (t_{cyc}) |
| | | | | 1: Operates at resolution (T) = system clock cycle time $(t_{\text{cyc}}) \times 2$ |

10.4 Bus Master Interface

DACNT, DADRA, and DADRB are 16-bit registers. The data bus linking the bus master and the on-chip peripheral modules, however, is only 8 bits wide. When the bus master accesses these registers, it therefore uses an 8-bit temporary register (TEMP).

These registers are written to and read from as follows.

Write: When the upper byte is written to, the upper-byte write data is stored in TEMP. Next, when the lower byte is written to, the lower-byte write data and TEMP value are combined, and the combined 16-bit value is written in the register.

Read: When the upper byte is read from, the upper-byte value is transferred to the CPU and the lower-byte value is transferred to TEMP. Next, when the lower byte is read from, the lower-byte value in TEMP is transferred to the CPU.

These registers should always be accessed 16 bits at a time with a MOV instruction, and the upper byte should always be accessed before the lower byte. Correct data will not be transferred if only the upper byte or only the lower byte is accessed. Also note that a bit manipulation instruction cannot be used to access these registers.

Example 1: Write to DACNT

Example 2: Read DADRA

MOV.W @DADRA, RO; Copy contents of DADRA to RO

Table 10.2 Read and Write Access Methods for 16-Bit Registers

| | | Read | | Write | |
|-----------------|------|------|------|-------|--|
| Register Name | Word | Byte | Word | Byte | |
| DADRA and DADRB | Yes | Yes | Yes | × | |
| DACNT | Yes | × | Yes | × | |

Legend

Yes: Permitted type of access. Word access includes successive byte accesses to the upper byte (first) and lower byte (second).

×: This type of access may give incorrect results.

10.5 Operation

A PWM waveform like the one shown in figure 10.2 is output from the PWMX pin. The value in DADR corresponds to the total width (T_L) of the low (0) pulses output in one conversion cycle (256 pulses when CFS = 0, 64 pulses when CFS = 1). When OS = 0, this waveform is directly output. When OS = 1, the output waveform is inverted, and the DADR value corresponds to the total width (T_H) of the high (1) output pulses. Figures 10.3 and 10.4 show the types of waveform output available.

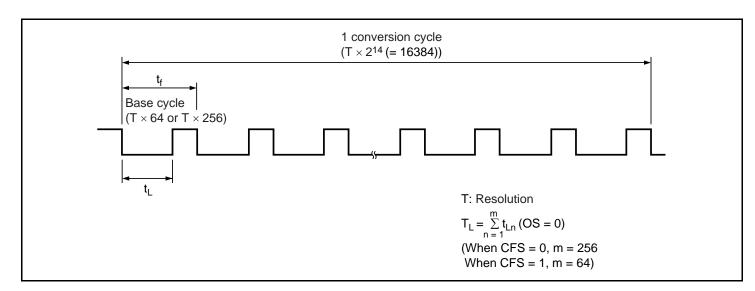


Figure 10.2 PWM D/A Operation

Table 10.3 summarizes the relationships between the CKS, CFS, and OS bit settings and the resolution, base cycle, and conversion cycle. The PWM output remains fixed unless DADR contains at least a certain minimum value.

Table 10.3 Settings and Operation (Examples when $\emptyset = 10 \text{ MHz}$)

| | | | | | | | Fixed | DA | NDR | B | ts | |
|-----|----------------------|-----|--------------------|--------------------------|----|--|--------------|----|-----|----|----|------------------------|
| | | | | | | | Precisi- | | Bit | Da | ta | = |
| CKS | Resolution T (µs) | CFS | Base Cycle (µs) | Conversion Cycle (µs) | _ | (if OS = 0) (if OS = 1) | on (Bits) | 3 | 2 | 1 | 0 | Conversion Cycle* (µs) |
| 0 | 0.1 | 0 | 6.4 | 1638.4 | 1. | Always low (or high) | 14 | | | | | 1638.4 |
| | | | | | | (DADR = H'0001 to H'03FD) | 12 | | | 0 | 0 | 409.6 |
| | | | | | 2. | (Data value) × T (DADR = H'0401 to H'FFFD) | 10 | 0 | 0 | 0 | 0 | 102.4 |
| | | 1 | 25.6 | - | 1. | Always low (or high) | 14 | | | | | 1638.4 |
| | | | | | | (DADR = H'0003 to H'00FF) | 12 | | | 0 | 0 | 409.6 |
| | | | | 2 | 2. | (Data value) \times T | | | | | | |
| | | | | | | (DADR = H'0103 to H'FFFF) | 10 | 0 | 0 | 0 | 0 | 102.4 |
| 1 | 0.2 | 0 | 12.8 | 3276.8 | 1. | Always low (or high) | 14 | | | | | 3276.8 |
| | | | | | | (DADR = H'0001 to H'03FD) | 12 | | | 0 | 0 | 819.2 |
| | | | | | 2. | (Data value) \times T | | | | | | |
| | | | | | | (DADR = H'0401 to H'FFFD) | 10 | 0 | 0 | 0 | 0 | 204.8 |
| | | 1 | 51.2 | _ | 1. | Always low (or high) | 14 | | | | | 3276.8 |
| | | | | | | (DADR = H'0003 to H'00FF) | 12 | | | 0 | 0 | 819.2 |
| | | | | | 2. | (Data value) × T (DADR = H'0103 to H'FFFF) | 10 | 0 | 0 | 0 | 0 | 204.8 |

Note:* This column indicates the conversion cycle when specific DADR bits are fixed.

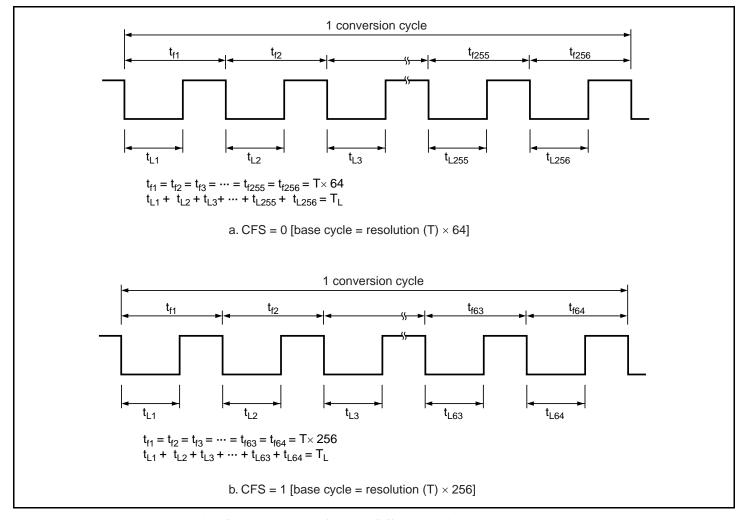


Figure 10.3 Output Waveform (OS = 0, DADR corresponds to T_L)

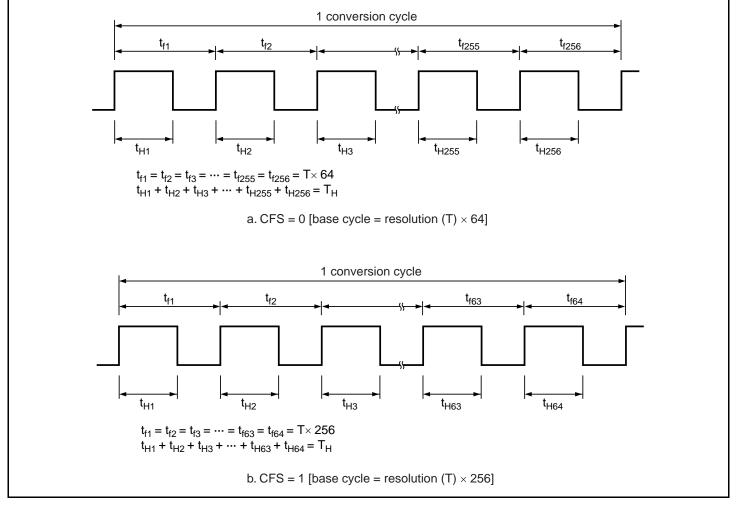


Figure 10.4 Output Waveform (OS = 1, DADR corresponds to T_H)

An example of setting CFS to 1 (basic cycle = resolution (T) \times 256) and OS to 1 (PWMX inverted output) is shown as an additional pulse. When CFS is set to 1, the duty ratio of the basic pulse is determined by the upper eight bits (DA13 to DA6) in DADR, and the position of the additional pulse is determined by the following six bits (DA5 to DA0) as shown in figure 10.5.

Table 10.4 shows the position of the additional pulse.

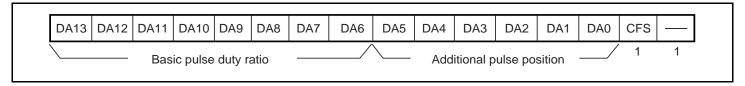


Figure 10.5 D/A Data Register Configuration when CFS = 1

Here, the case of DADR = H'0207 (B'0000 0010 0000 0111) is considered. Figure 10.6 shows an output waveform. Because CFS = 1 and the value of upper eight bits is B'0000 0010, the duty ratio of the basic pulse is $2/256 \times (T)$ of high width.

Since the value of the following six bits is B'0000 01, the additional pulse is output at the position of basic pulse No. 63 as shown in table 10.4. Only $1/256 \times (T)$ of the additional pulse is added to the basic pulse.

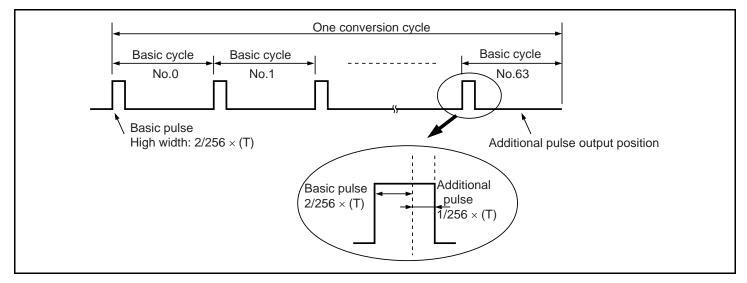


Figure 10.6 Output Waveform when DADR = H'0207 (OS = 1)

Note that the case of CFS = 0 (basic cycle = resolution (T) \times 64) is similar other than the duty ratio of the basic pulse is determined by the upper six bits, and the position of the additional pulse is determined by the following eight bits.

Table 10.4 Position of Pulse to be Added to Basic Pulse (CFS = 1)

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10.6 Usage Note

10.6.1 Module Stop Mode Setting

PWMX operation can be enabled or disabled using the module stop control register. The initial setting is for PWMX operation to be halted. Register access is enabled by canceling the module stop mode. For details, refer to section 26, Power-Down Modes.

Section 11 16-Bit Free-Running Timer (FRT)

This LSI has an on-chip 16-bit free-running timer (FRT). The FRT operates on the basis of the 16-bit free-running counter (FRC), and outputs two independent waveforms, and measures the input pulse width and external clock periods.

11.1 Features

• Selection of four clock sources

One of the three internal clocks ($\emptyset/2$, $\emptyset/8$, or $\emptyset/32$), or an external clock input can be selected (enabling use as an external event counter).

- Two independent comparators
 - Two independent waveforms can be output.
- Four independent input capture channels
 - The rising or falling edge can be selected.
 - Buffer modes can be specified.
- Counter clearing
 - The free-running counters can be cleared on compare-match A.
- Seven independent interrupts
 - Two compare-match interrupts, four input capture interrupts, and one overflow interrupt can be requested independently.
- Special functions provided by automatic addition function
 - The contents of OCRAR and OCRAF can be added to the contents of OCRA automatically, enabling a periodic waveform to be generated without software intervention. The contents of ICRD can be added automatically to the contents of OCRDM \times 2, enabling input capture operations in this interval to be restricted.



Figure 11.1 shows a block diagram of the FRT.

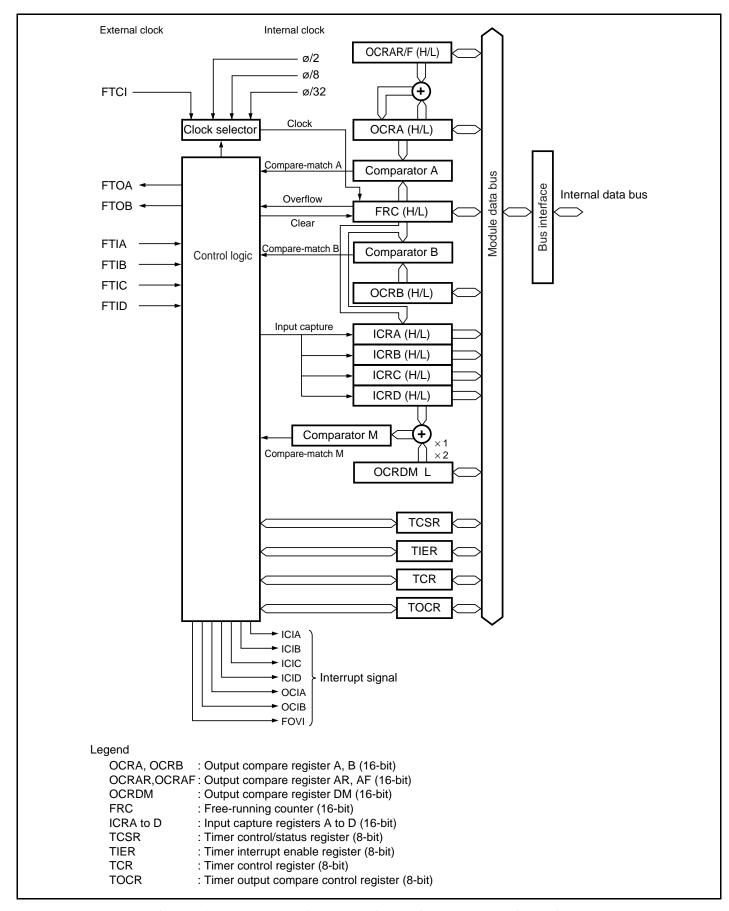


Figure 11.1 Block Diagram of 16-Bit Free-Running Timer

11.2 Input/Output Pins

Table 11.1 lists the FRT input and output pins.

Table 11.1 Pin Configuration

| Name | Abbreviation | I/O | Function |
|-----------------------------|--------------|--------|-------------------------|
| Counter clock input pin | FTCI | Input | FRC counter clock input |
| Output compare A output pin | FTOA | Output | Output compare A output |
| Output compare B output pin | FTOB | Output | Output compare B output |
| Input capture A input pin | FTIA | Input | Input capture A input |
| Input capture B input pin | FTIB | Input | Input capture B input |
| Input capture C input pin | FTIC | Input | Input capture C input |
| Input capture D input pin | FTID | Input | Input capture D input |

11.3 Register Descriptions

The FRT has the following registers.

- Free-running counter (FRC)
- Output compare register A (OCRA)
- Output compare register B (OCRB)
- Input capture register A (ICRA)
- Input capture register B (ICRB)
- Input capture register C (ICRC)
- Input capture register D (ICRD)
- Output compare register AR (OCRAR)
- Output compare register AF (OCRAF)
- Output compare register DM (OCRDM)
- Timer interrupt enable register (TIER)
- Timer control/status register (TCSR)
- Timer control register (TCR)
- Timer output compare control register (TOCR)

Note: OCRA and OCRB share the same address. Register selection is controlled by the OCRS bit in TOCR. ICRA, ICRB, and ICRC share the same addresses with OCRAR, OCRAF, and OCRDM. Register selection is controlled by the ICRS bit in TOCR.

11.3.1 Free-Running Counter (FRC)

FRC is a 16-bit readable/writable up-counter. The clock source is selected by bits CKS1 and CKS0 in TCR. FRC can be cleared by compare-match A. When FRC overflows from H'FFFF to H'0000, the overflow flag bit (OVF) in TCSR is set to 1. FRC should always be accessed in 16-bit units; cannot be accessed in 8-bit units. FRC is initialized to H'0000.

11.3.2 Output Compare Registers A and B (OCRA, OCRB)

The FRT has two output compare registers, OCRA and OCRB, each of which is a 16-bit readable/writable register whose contents are continually compared with the value in FRC. When a match is detected (compare-match), the corresponding output compare flag (OCFA or OCFB) is set to 1 in TCSR. If the OEA or OEB bit in TOCR is set to 1, when the OCR and FRC values match, the output level selected by the OLVLA or OLVLB bit in TOCR is output at the output compare output pin (FTOA or FTOB). Following a reset, the FTOA and FTOB output levels are 0 until the first compare-match. OCR should always be accessed in 16-bit units; cannot be accessed in 8-bit units. OCR is initialized to H'FFFF.

11.3.3 Input Capture Registers A to D (ICRA to ICRD)

The FRT has four input capture registers, ICRA to ICRD, each of which is a 16-bit read-only register. When the rising or falling edge of the signal at an input capture input pin (FTIA to FTID) is detected, the current FRC value is transferred to the corresponding input capture register (ICRA to ICRD). At the same time, the corresponding input capture flag (ICFA to ICFD) in TCSR is set to 1. The FRC contents are transferred to ICR regardless of the value of ICF. The input capture edge is selected by the input edge select bits (IEDGA to IEDGD) in TCR.

ICRC and ICRD can be used as ICRA and ICRB buffer registers, respectively, by means of buffer enable bits A and B (BUFEA and BUFEB) in TCR. For example, if an input capture occurs when ICRC is specified as the ICRA buffer register, the FRC contents are transferred to ICRA, and then transferred to the buffer register ICRC.

To ensure input capture, the input capture pulse width should be at least 1.5 system clocks (\emptyset) for a single edge. When triggering is enabled on both edges, the input capture pulse width should be at least 2.5 system clocks (\emptyset).

ICRA to ICRD should always be accessed in 16-bit units; cannot be accessed in 8-bit units. ICR is initialized to H'0000.

11.3.4 Output Compare Registers AR and AF (OCRAR, OCRAF)

OCRAR and OCRAF are 16-bit readable/writable registers. When the OCRAMS bit in TOCR is set to 1, the operation of OCRA is changed to include the use of OCRAR and OCRAF. The contents of OCRAR and OCRAF are automatically added alternately to OCRA, and the result is written to OCRA. The write operation is performed on the occurrence of compare-match A. In the 1st compare-match A after setting the OCRAMS bit to 1, OCRAF is added. The operation due to compare-match A varies according to whether the compare-match follows addition of OCRAR or OCRAF. The value of the OLVLA bit in TOCR is ignored, and 1 is output on a compare-match A following addition of OCRAF, while 0 is output on a compare-match A following addition of OCRAR.

When using the OCRA automatic addition function, do not select internal clock ø/2 as the FRC input clock together with a set value of H'0001 or less for OCRAR (or OCRAF).

OCRAR and OCRAF should always be accessed in 16-bit units; cannot be accessed in 8-bit units. OCRAR and OCRAF are initialized to H'FFFF.

11.3.5 Output Compare Register DM (OCRDM)

OCRDM is a 16-bit readable/writable register in which the upper 8 bits are fixed at H'00. When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, the operation of ICRD is changed to include the use of OCRDM. The point at which input capture D occurs is taken as the start of a mask interval. Next, twice the contents of OCRDM is added to the contents of ICRD, and the result is compared with the FRC value. The point at which the values match is taken as the end of the mask interval. New input capture D events are disabled during the mask interval. A mask interval is not generated when the contents of OCRDM are H'0000 while the ICRDMS bit is set to 1.

OCRDM should always be accessed in 16-bit units; cannot be accessed in 8-bit units. OCRDM is initialized to H'0000.

11.3.6 Timer Interrupt Enable Register (TIER)

TIER enables and disables interrupt requests.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ICIAE | 0 | R/W | Input Capture Interrupt A Enable |
| | | | | Selects whether to enable input capture interrupt A request (ICIA) when input capture flag A (ICFA) in TCSR is set to 1. |
| | | | | 0: ICIA requested by ICFA is disabled |
| | | | | 1: ICIA requested by ICFA is enabled |
| 6 | ICIBE | 0 | R/W | Input Capture Interrupt B Enable |
| | | | | Selects whether to enable input capture interrupt B request (ICIB) when input capture flag B (ICFB) in TCSR is set to 1. |
| | | | | 0: ICIB requested by ICFB is disabled |
| | | | | 1: ICIB requested by ICFB is enabled |
| 5 | ICICE | 0 | R/W | Input Capture Interrupt C Enable |
| | | | | Selects whether to enable input capture interrupt C request (ICIC) when input capture flag C (ICFC) in TCSR is set to 1. |
| | | | | 0: ICIC requested by ICFC is disabled |
| | | | | 1: ICIC requested by ICFC is enabled |
| 4 | ICIDE | 0 | R/W | Input Capture Interrupt D Enable |
| | | | | Selects whether to enable input capture interrupt D request (ICID) when input capture flag D (ICFD) in TCSR is set to 1. |
| | | | | 0: ICID requested by ICFD is disabled |
| | | | | 1: ICID requested by ICFD is enabled |
| 3 | OCIAE | 0 | R/W | Output Compare Interrupt A Enable |
| | | | | Selects whether to enable output compare interrupt A request (OCIA) when output compare flag A (OCFA) in TCSR is set to 1. |
| | | | | 0: OCIA requested by OCFA is disabled |
| | | | | 1: OCIA requested by OCFA is enabled |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | OCIBE | 0 | R/W | Output Compare Interrupt B Enable |
| | | | | Selects whether to enable output compare interrupt B request (OCIB) when output compare flag B (OCFB) in TCSR is set to 1. |
| | | | | 0: OCIB requested by OCFB is disabled |
| | | | | 1: OCIB requested by OCFB is enabled |
| 1 | OVIE | 0 | R/W | Timer Overflow Interrupt Enable |
| | | | | Selects whether to enable a free-running timer overflow request interrupt (FOVI) when the timer overflow flag (OVF) in TCSR is set to 1. |
| | | | | 0: FOVI requested by OVF is disabled |
| | | | | 1: FOVI requested by OVF is enabled |
| 0 | | 0 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |

11.3.7 Timer Control/Status Register (TCSR)

TCSR is used for counter clear selection and control of interrupt request signals.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 7 | ICFA | 0 | R/(W)* | Input Capture Flag A |
| | | | | This status flag indicates that the FRC value has been transferred to ICRA by means of an input capture signal. When BUFEA = 1, ICFA indicates that the old ICRA value has been moved into ICRC and the new FRC value has been transferred to ICRA. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When an input capture signal causes the FRC value to be transferred to ICRA |
| | | | | [Clearing condition] |
| | | | | Read ICFA when ICFA = 1, then write 0 to ICFA |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 6 | ICFB | 0 | R/(W)* | Input Capture Flag B |
| | | | | This status flag indicates that the FRC value has been transferred to ICRB by means of an input capture signal. When BUFEB = 1, ICFB indicates that the old ICRB value has been moved into ICRD and the new FRC value has been transferred to ICRB. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When an input capture signal causes the FRC value to be transferred to ICRB |
| | | | | [Clearing condition] |
| | | | | Read ICFB when ICFB = 1, then write 0 to ICFB |
| 5 | ICFC | 0 | R/(W)* | Input Capture Flag C |
| | | | | This status flag indicates that the FRC value has been transferred to ICRC by means of an input capture signal. When BUFEA = 1, on occurrence of an input capture signal specified by the IEDGC bit at the FTIC input pin, ICFC is set but data is not transferred to ICRC. In buffer operation, ICFC can be used as an external interrupt signal by setting the ICICE bit to 1. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When an input capture signal is received |
| | | | | [Clearing condition] |
| | | | | Read ICFC when ICFC = 1, then write 0 to ICFC |
| 4 | ICFD | 0 | R/(W)* | Input Capture Flag D |
| | | | | This status flag indicates that the FRC value has been transferred to ICRD by means of an input capture signal. When BUFEB = 1, on occurrence of an input capture signal specified by the IEDGD bit at the FTID input pin, ICFD is set but data is not transferred to ICRD. In buffer operation, ICFD can be used as an external interrupt signal by setting the ICIDE bit to 1. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When an input capture signal is received |
| | | | | [Clearing condition] |
| | | | | Read ICFD when ICFD = 1, then write 0 to ICFD |
| | | | | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 3 | OCFA | 0 | R/(W)* | Output Compare Flag A |
| | | | | This status flag indicates that the FRC value matches the OCRA value. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When FRC = OCRA |
| | | | | [Clearing condition] |
| | | | | Read OCFA when OCFA = 1, then write 0 to OCFA |
| 2 | OCFB | 0 | R/(W)* | Output Compare Flag B |
| | | | | This status flag indicates that the FRC value matches the OCRB value. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When FRC = OCRB |
| | | | | [Clearing condition] |
| | | | | Read OCFB when OCFB = 1, then write 0 to OCFB |
| 1 | OVF | 0 | R/(W)* | Timer Overflow |
| | | | | This status flag indicates that the FRC has overflowed. Only 0 can be written to this bit to clear the flag. |
| | | | | [Setting condition] |
| | | | | When FRC overflows (changes from H'FFFF to H'0000) |
| | | | | [Clearing condition] |
| | | | | Read OVF when OVF = 1, then write 0 to OVF |
| 0 | CCLRA | 0 | R/W | Counter Clear A |
| | | | | This bit selects whether the FRC is to be cleared at compare-match A (when the FRC and OCRA values match). |
| | | | | 0: FRC clearing is disabled |
| | | | | 1: FRC is cleared at compare-match A |

Note:* Only 0 can be written to clear the flag.

11.3.8 Timer Control Register (TCR)

TCR selects the rising or falling edge of the input capture signals, enables the input capture buffer mode, and selects the FRC clock source.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | IEDGA | 0 | R/W | Input Edge Select A |
| | | | | Selects the rising or falling edge of the input capture A signal (FTIA). |
| | | | | 0: Capture on the falling edge of FTIA |
| | | | | 1: Capture on the rising edge of FTIA |
| 6 | IEDGB | 0 | R/W | Input Edge Select B |
| | | | | Selects the rising or falling edge of the input capture B signal (FTIB). |
| | | | | 0: Capture on the falling edge of FTIB |
| | | | | 1: Capture on the rising edge of FTIB |
| 5 | IEDGC | 0 | R/W | Input Edge Select C |
| | | | | Selects the rising or falling edge of the input capture C signal (FTIC). |
| | | | | 0: Capture on the falling edge of FTIC |
| | | | | 1: Capture on the rising edge of FTIC |
| 4 | IEDGD | 0 | R/W | Input Edge Select D |
| | | | | Selects the rising or falling edge of the input capture D signal (FTID). |
| | | | | 0: Capture on the falling edge of FTID |
| | | | | 1: Capture on the rising edge of FTID |
| 3 | BUFEA | 0 | R/W | Buffer Enable A |
| | | | | Selects whether ICRC is to be used as a buffer register for ICRA. |
| | | | | 0: ICRC is not used as a buffer register for ICRA |
| | | | | 1: ICRC is used as a buffer register for ICRA |
| 2 | BUFEB | 0 | R/W | Buffer Enable B |
| | | | | Selects whether ICRD is to be used as a buffer register for ICRB. |
| | | | | 0: ICRD is not used as a buffer register for ICRB |
| | | | | 1: ICRD is used as a buffer register for ICRB |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 1 | CKS1 | 0 | R/W | Clock Select 1, 0 |
| 0 | CKS0 | 0 | | Select clock source for FRC. |
| | | | | 00: ø/2 internal clock source |
| | | | | 01: ø/8 internal clock source |
| | | | | 10: ø/32 internal clock source |
| | | | | 11: External clock source (counting at FTCI rising edge) |

11.3.9 Timer Output Compare Control Register (TOCR)

TOCR enables output from the output compare pins, selects the output levels, switches access between output compare registers A and B, controls the ICRD and OCRA operating modes, and switches access to input capture registers A, B, and C.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | ICRDMS | 0 | R/W | Input Capture D Mode Select |
| | | | | Specifies whether ICRD is used in the normal operating mode or in the operating mode using OCRDM. |
| | | | | 0: The normal operating mode is specified for ICRD |
| | | | | 1: The operating mode using OCRDM is specified for ICRD |
| 6 | OCRAMS | 0 | R/W | Output Compare A Mode Select |
| | | | | Specifies whether OCRA is used in the normal operating mode or in the operating mode using OCRAR and OCRAF. |
| | | | | 0: The normal operating mode is specified for OCRA |
| | | | | 1: The operating mode using OCRAR and OCRAF is specified for OCRA |
| 5 | ICRS | 0 | R/W | Input Capture Register Select |
| | | | | The same addresses are shared by ICRA and OCRAR, by ICRB and OCRAF, and by ICRC and OCRDM. The ICRS bit determines which registers are selected when the shared addresses are read from or written to. The operation of ICRA, ICRB, and ICRC is not affected. |
| | | | | 0: ICRA, ICRB, and ICRC are selected |
| | | | | 1: OCRAR, OCRAF, and OCRDM are selected |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 4 | OCRS | 0 | R/W | Output Compare Register Select |
| | | | | OCRA and OCRB share the same address. When this address is accessed, the OCRS bit selects which register is accessed. The operation of OCRA or OCRB is not affected. |
| | | | | 0: OCRA is selected |
| | | | | 1: OCRB is selected |
| 3 | OEA | 0 | R/W | Output Enable A |
| | | | | Enables or disables output of the output compare A output pin (FTOA). |
| | | | | 0: Output compare A output is disabled |
| | | | | 1: Output compare A output is enabled |
| 2 | OEB | 0 | R/W | Output Enable B |
| | | | | Enables or disables output of the output compare B output pin (FTOB). |
| | | | | 0: Output compare B output is disabled |
| | | | | 1: Output compare B output is enabled |
| 1 | OLVLA | 0 | R/W | Output Level A |
| | | | | Selects the level to be output at the output compare A output pin (FTOA) in response to compare-match A (signal indicating a match between the FRC and OCRA values). When the OCRAMS bit is 1, this bit is ignored. |
| | | | | 0: 0 is output at compare-match A |
| | | | | 1: 1 is output at compare-match A |
| 0 | OLVLB | 0 | R/W | Output Level B |
| | | | | Selects the level to be output at the output compare B output pin (FTOB) in response to compare-match B (signal indicating a match between the FRC and OCRB values). |
| | | | | 0: 0 is output at compare-match B |
| | | | | 1: 1 is output at compare-match B |

11.4 Operation

11.4.1 Pulse Output

Figure 11.2 shows an example of 50%-duty pulses output with an arbitrary phase difference. When a compare match occurs while the CCLRA bit in TCSR is set to 1, the OLVLA and OLVLB bits are inverted by software.

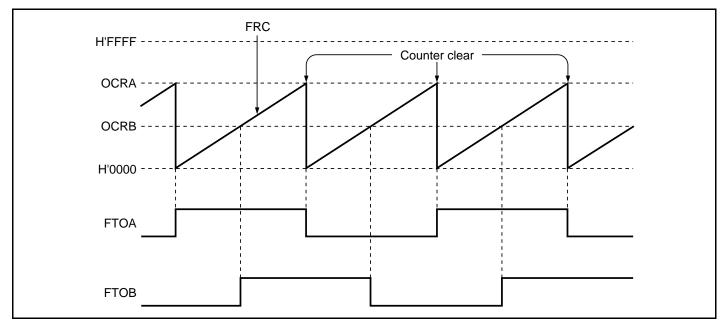


Figure 11.2 Example of Pulse Output

11.5 Operation Timing

11.5.1 FRC Increment Timing

Figure 11.3 shows the FRC increment timing with an internal clock source. Figure 11.4 shows the increment timing with an external clock source. The pulse width of the external clock signal must be at least 1.5 system clocks (\emptyset). The counter will not increment correctly if the pulse width is shorter than 1.5 system clocks (\emptyset).

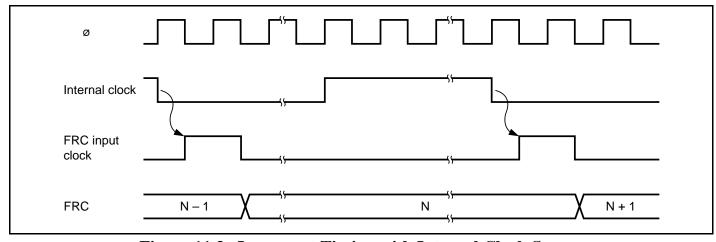


Figure 11.3 Increment Timing with Internal Clock Source

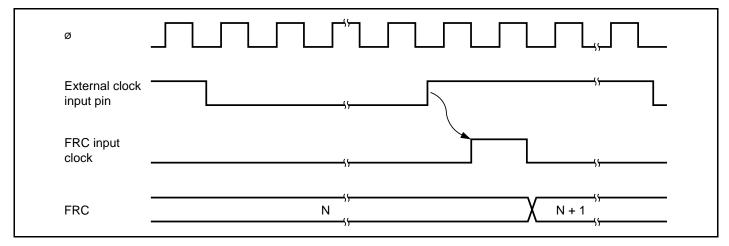


Figure 11.4 Increment Timing with External Clock Source

11.5.2 Output Compare Output Timing

A compare-match signal occurs at the last state when the FRC and OCR values match (at the timing when the FRC updates the counter value). When a compare-match signal occurs, the level selected by the OLVL bit in TOCR is output at the output compare pin (FTOA or FTOB). Figure 11.5 shows the timing of this operation for compare-match A.

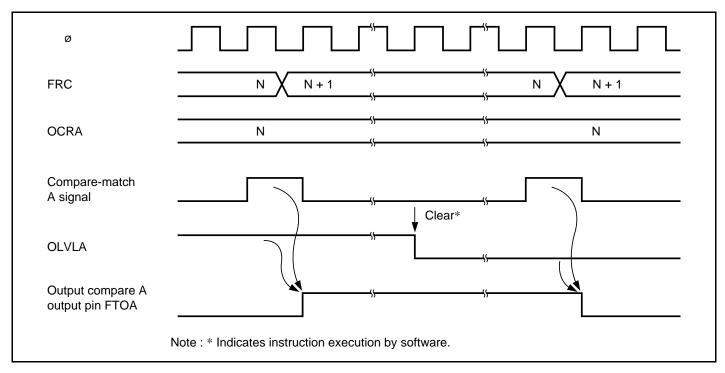


Figure 11.5 Timing of Output Compare A Output

11.5.3 FRC Clear Timing

FRC can be cleared when compare-match A occurs. Figure 11.6 shows the timing of this operation.

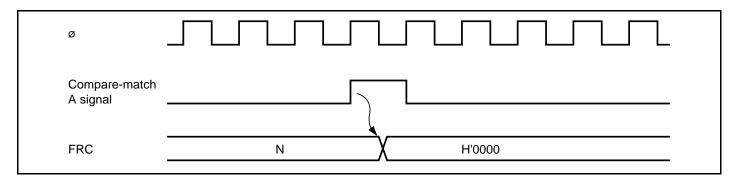


Figure 11.6 Clearing of FRC by Compare-Match A Signal

11.5.4 Input Capture Input Timing

The rising or falling edge can be selected for the input capture input timing by the IEDGA to IEDGD bits in TCR. Figure 11.7 shows the usual input capture timing when the rising edge is selected.

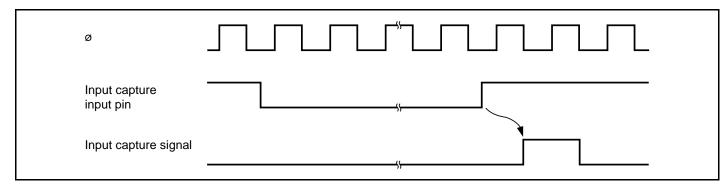


Figure 11.7 Input Capture Input Signal Timing (Usual Case)

If ICRA to ICRAD are read when the corresponding input capture signal arrives, the internal input capture signal is delayed by one system clock (\emptyset) . Figure 11.8 shows the timing for this case.

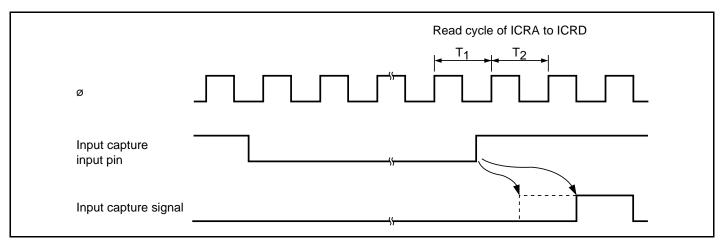


Figure 11.8 Input Capture Input Signal Timing (When ICRA to ICRD are Read)

11.5.5 Buffered Input Capture Input Timing

ICRC and ICRD can operate as buffers for ICRA and ICRB, respectively. Figure 11.9 shows how input capture operates when ICRC is used as ICRA's buffer register (BUFEA = 1) and IEDGA and IEDGC are set to different values (IEDGA = 0 and IEDGC = 1, or IEDGA = 1 and IEDGC = 0), so that input capture is performed on both the rising and falling edges of FTIA.

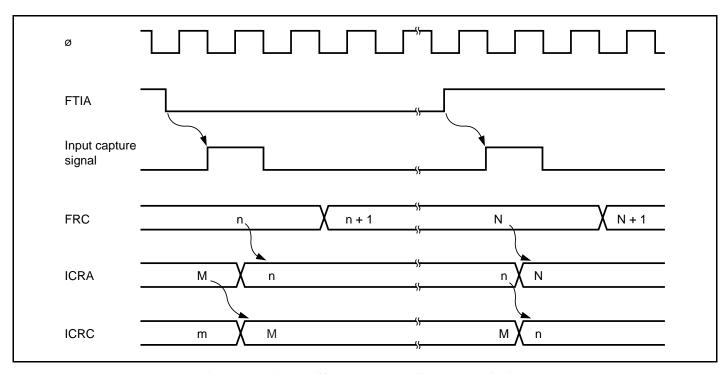


Figure 11.9 Buffered Input Capture Timing

Even when ICRC or ICRD is used as a buffer register, its input capture flag is set by the selected transition of its input capture signal. For example, if ICRC is used to buffer ICRA, when the edge transition selected by the IEDGC bit occurs on the FTIC input capture line, ICFC will be set, and if the ICICE bit is set at this time, an interrupt will be requested. The FRC value will not be transferred to ICRC, however. In buffered input capture, if either set of two registers to which data

will be transferred (ICRA and ICRC, or ICRB and ICRD) is being read when the input capture input signal arrives, input capture is delayed by one system clock (\emptyset). Figure 11.10 shows the timing when BUFEA = 1.

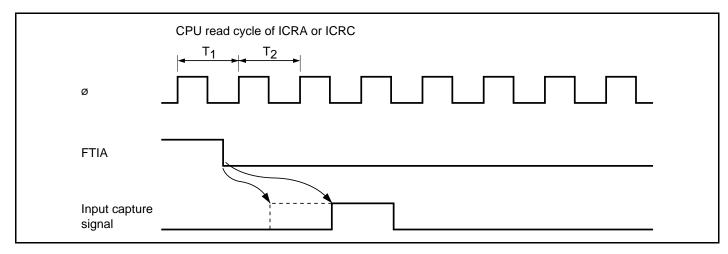


Figure 11.10 Buffered Input Capture Timing (BUFEA = 1)

11.5.6 Timing of Input Capture Flag (ICF) Setting

The input capture flag, ICFA, ICFB, ICFC, or ICFD, is set to 1 by the input capture signal. The FRC value is simultaneously transferred to the corresponding input capture register (ICRA, ICRB, ICRC, or ICRD). Figure 11.11 shows the timing of setting the ICFA to ICFD flag.

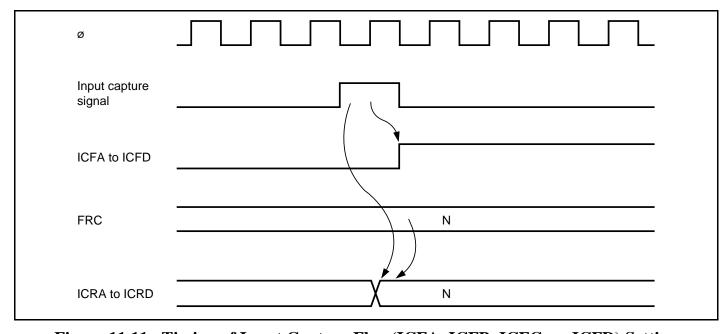


Figure 11.11 Timing of Input Capture Flag (ICFA, ICFB, ICFC, or ICFD) Setting

11.5.7 Timing of Output Compare Flag (OCF) setting

The output compare flag, OCFA or OCFB, is set to 1 by a compare-match signal generated when the FRC value matches the OCRA or OCRB value. This compare-match signal is generated at the last state in which the two values match, just before FRC increments to a new value. When the FRC and OCRA or OCRB value match, the compare-match signal is not generated until the next cycle of the clock source. Figure 11.12 shows the timing of setting the OCFA or OCFB flag.

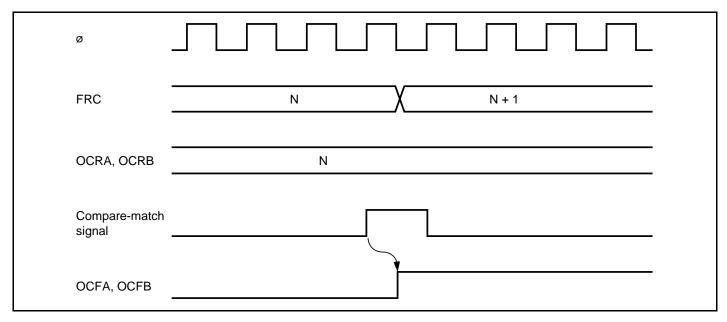


Figure 11.12 Timing of Output Compare Flag (OCFA or OCFB) Setting

11.5.8 Timing of FRC Overflow Flag Setting

The FRC overflow flag (OVF) is set to 1 when FRC overflows (changes from H'FFFF to H'0000). Figure 11.13 shows the timing of setting the OVF flag.

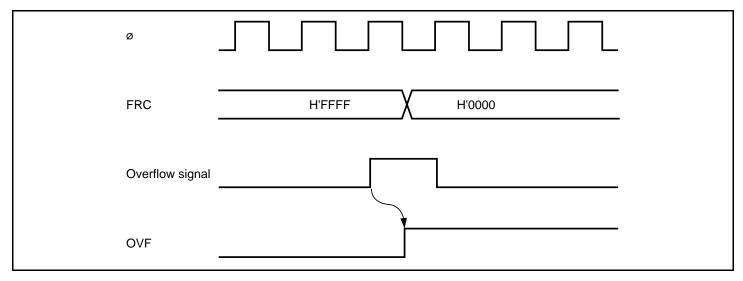


Figure 11.13 Timing of Overflow Flag (OVF) Setting

11.5.9 Automatic Addition Timing

When the OCRAMS bit in TOCR is set to 1, the contents of OCRAR and OCRAF are automatically added to OCRA alternately, and when an OCRA compare-match occurs a write to OCRA is performed. Figure 11.14 shows the OCRA write timing.

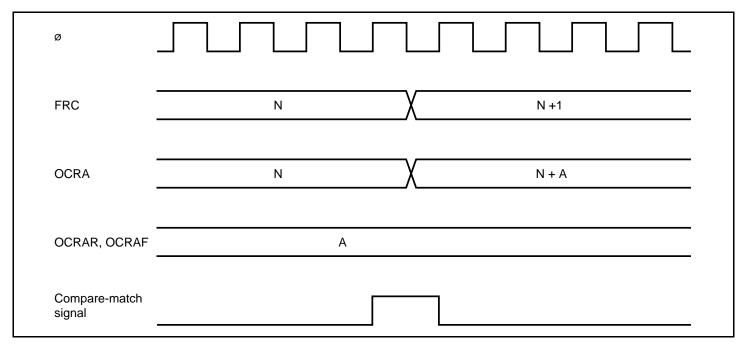


Figure 11.14 OCRA Automatic Addition Timing

11.5.10 Mask Signal Generation Timing

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, a signal that masks the ICRD input capture signal is generated. The mask signal is set by the input capture signal. The mask signal is cleared by the sum of the ICRD contents and twice the OCRDM contents, and an FRC compare-match. Figure 11.15 shows the timing of setting the mask signal. Figure 11.16 shows the timing of clearing the mask signal.

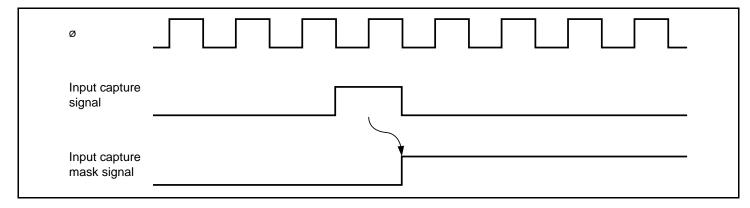


Figure 11.15 Timing of Input Capture Mask Signal Setting

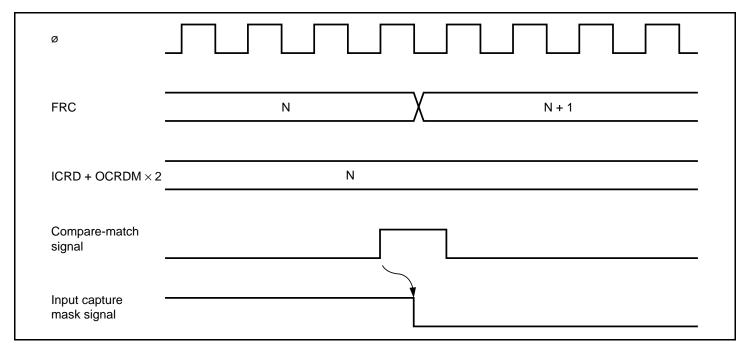


Figure 11.16 Timing of Input Capture Mask Signal Clearing

11.6 Interrupt Sources

The free-running timer can request seven interrupts: ICIA to ICID, OCIA, OCIB, and FOVI. Each interrupt can be enabled or disabled by an enable bit in TIER. Independent signals are sent to the interrupt controller for each interrupt. Table 11.2 lists the sources and priorities of these interrupts.

The ICIA, ICIB, OCIA, and OCIB interrupts can be used as the on-chip DTC activation sources.

Table 11.2 FRT Interrupt Sources

| Interrupt | Interrupt Source | Interrupt Flag | DTC Activation | Priority |
|-----------|-----------------------|----------------|-------------------|----------|
| ICIA | Input capture of ICRA | ICFA | Enabled | High |
| ICIB | Input capture of ICRB | ICFB | Enabled | A |
| ICIC | Input capture of ICRC | ICFC | Disabled | |
| ICID | Input capture of ICRD | ICFD | Disabled | |
| OCIA | Compare match of OCRA | OCFA | Enabled | |
| OCIB | Compare match of OCRB | OCFB | Enabled | |
| FOVI | Overflow of FRC | OVF | Disabled | Low |

11.7 Usage Notes

11.7.1 Conflict between FRC Write and Clear

If an internal counter clear signal is generated during the state after an FRC write cycle, the clear signal takes priority and the write is not performed. Figure 11.17 shows the timing for this type of conflict.

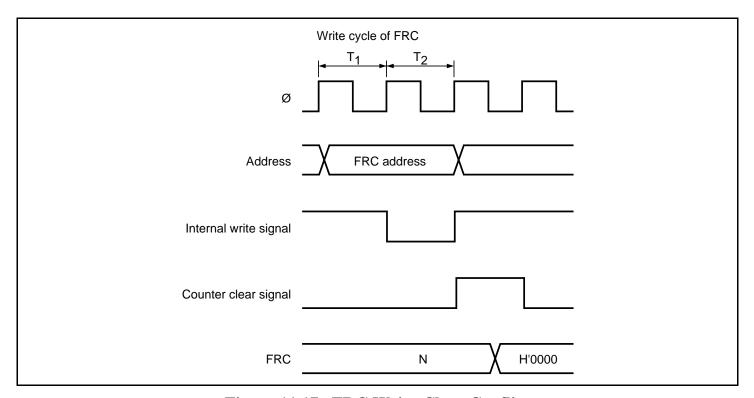


Figure 11.17 FRC Write-Clear Conflict

RENESAS

11.7.2 Conflict between FRC Write and Increment

If an FRC increment pulse is generated during the state after an FRC write cycle, the write takes priority and FRC is not incremented. Figure 11.18 shows the timing for this type of conflict.

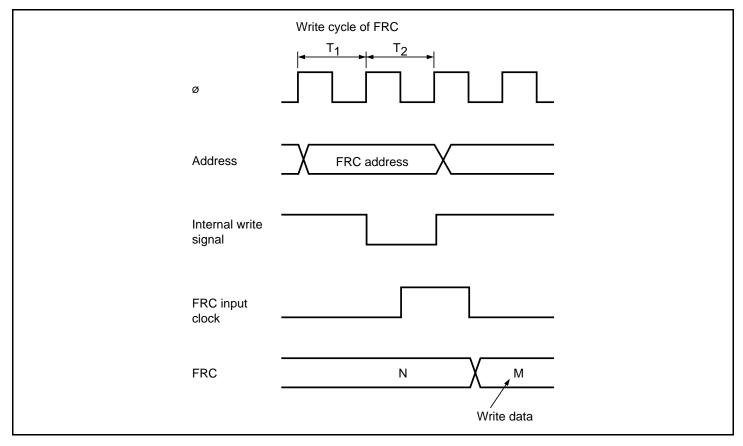


Figure 11.18 FRC Write-Increment Conflict

11.7.3 Conflict between OCR Write and Compare-Match

If a compare-match occurs during the state after an OCRA or OCRB write cycle, the write takes priority and the compare-match signal is disabled. Figure 11.19 shows the timing for this type of conflict.

If automatic addition of OCRAR and OCRAF to OCRA is selected, and a compare-match occurs in the cycle following the OCRA, OCRAR, and OCRAF write cycle, the OCRA, OCRAR and OCRAF write takes priority and the compare-match signal is disabled. Consequently, the result of the automatic addition is not written to OCRA. Figure 11.20 shows the timing for this type of conflict.

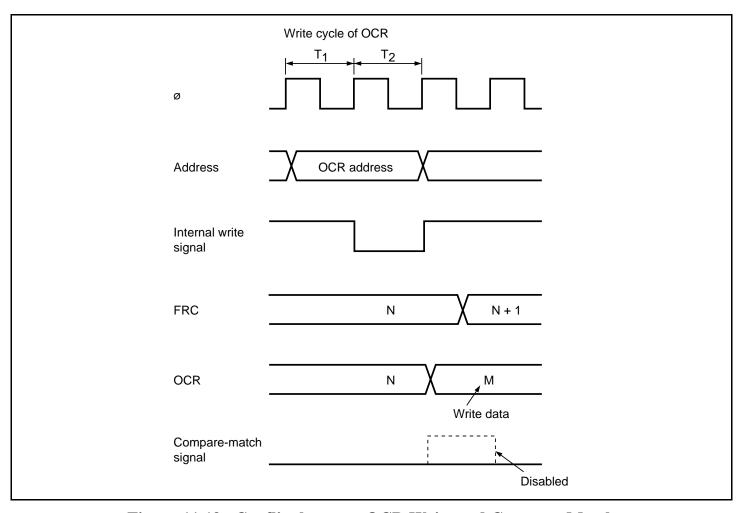


Figure 11.19 Conflict between OCR Write and Compare-Match (When Automatic Addition Function is Not Used)

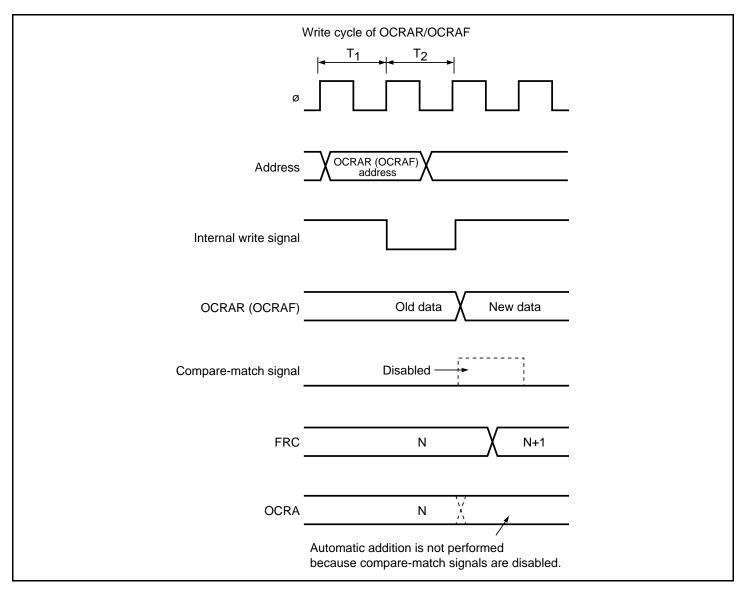


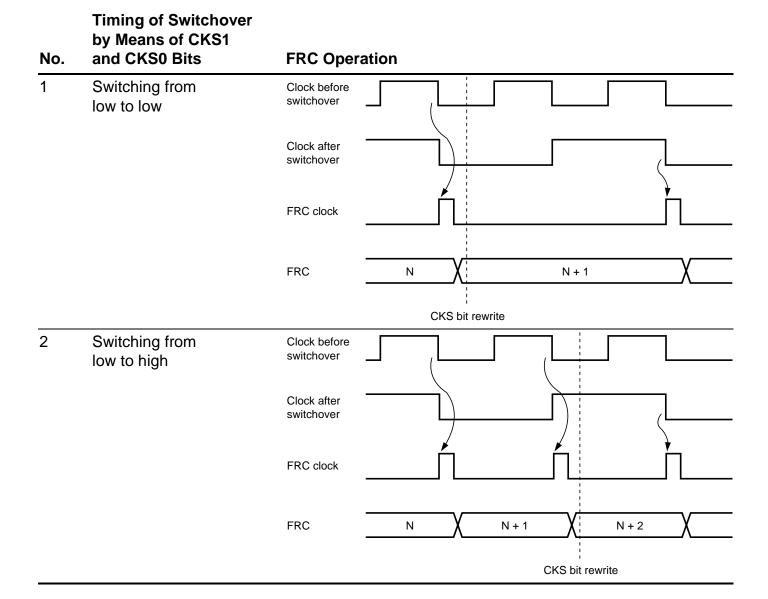
Figure 11.20 Conflict between OCRAR/OCRAF Write and Compare-Match (When Automatic Addition Function is Used)

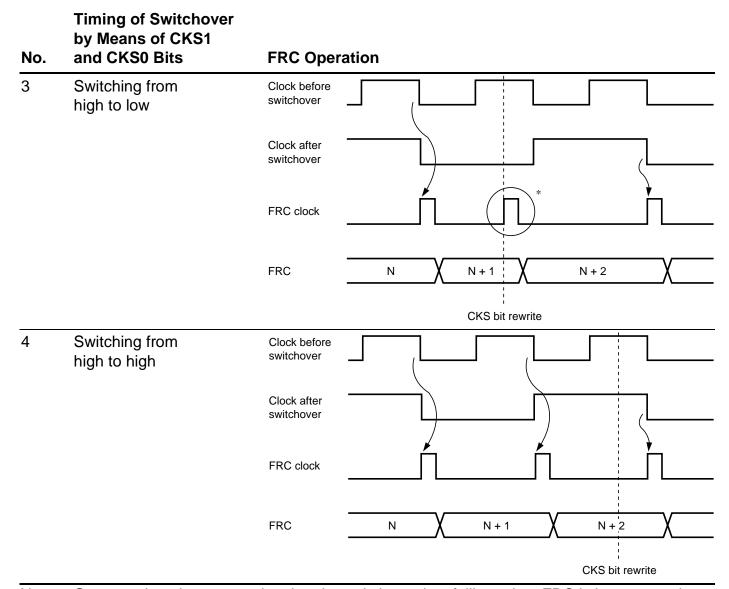
11.7.4 Switching of Internal Clock and FRC Operation

When the internal clock is changed, the changeover may cause FRC to increment. This depends on the time at which the clock is switched (bits CKS1 and CKS0 are rewritten), as shown in table 11.3.

When an internal clock is used, the FRC clock is generated on detection of the falling edge of the internal clock scaled from the system clock (ø). If the clock is changed when the old source is high and the new source is low, as in case no. 3 in table 11.3, the changeover is regarded as a falling edge that triggers the FRC clock, and FRC is incremented. Switching between an internal clock and external clock can also cause FRC to increment.

Table 11.3 Switching of Internal Clock and FRC Operation





Note:* Generated on the assumption that the switchover is a falling edge; FRC is incremented.

11.7.5 Module Stop Mode Setting

FRT operation can be enabled or disabled using the module stop control register. The initial setting is for FRT operation to be halted. Register access is enabled by canceling the module stop mode. For details, refer to section 26, Power-Down Modes.

Section 12 8-Bit Timer (TMR)

This LSI has an on-chip 8-bit timer module (TMR_0 and TMR_1) with two channels operating on the basis of an 8-bit counter. The 8-bit timer module can count external events, and can also be used as a multifunction timer in a variety of applications, such as generation of counter reset, interrupt requests, and pulse output with an arbitrary duty cycle using a compare-match signal with two registers.

This LSI also has a similar on-chip 8-bit timer module (TMR_Y and TMR_X) with two channels, which can be used through connection to the timer connection.

12.1 Features

- Selection of clock sources
 - TMR_0, TMR_1: The counter input clock can be selected from six internal clocks and an external clock
 - TMR_Y, TMR_X: The counter input clock can be selected from three internal clocks and an external clock
- Selection of three ways to clear the counters
 - The counters can be cleared on compare-match A or compare-match B, or by an external reset signal.
- Timer output controlled by two compare-match signals
 - The timer output signal in each channel is controlled by two independent compare-match signals, enabling the timer to be used for various applications, such as the generation of pulse output or PWM output with an arbitrary duty cycle. (The TMR_Y does not have a timer output pin.)
- Cascading of TMR_0 and TMR_1
 - (TMR_Y and TMR_X cannot be cascaded.)
 - Operation as a 16-bit timer can be performed using TMR_0 as the upper half and TMR_1 as the lower half (16-bit count mode).
 - TMR_1 can be used to count TMR_0 compare-match occurrences (compare-match count mode).
- Multiple interrupt sources for each channel
 - TMR_0, TMR_1, and TMR_Y: Three types of interrupts: Compare-match A, compare-match B, and overflow
 - TMR_X: Input capture

Figures 12.1 and 12.2 show block diagrams of the 8-bit timer module.

TMR_X and TMR_Y have a similar configuration, but cannot be cascaded. TMR_X also has an input capture function. For details, see section 13, Timer Connection.

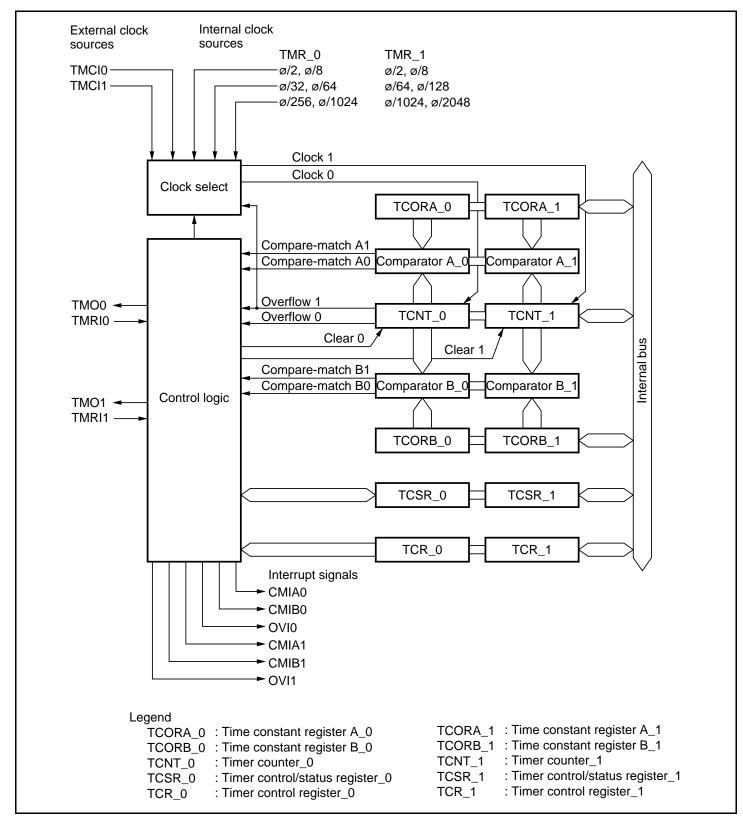


Figure 12.1 Block Diagram of 8-Bit Timers (TMR_0 and TMR_1)

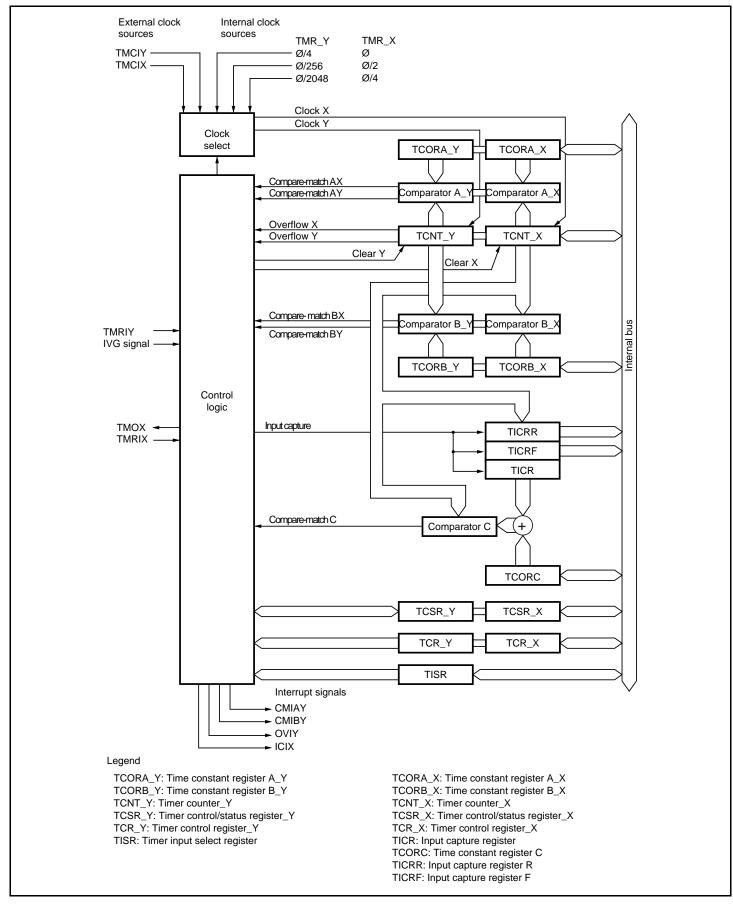


Figure 12.2 Block Diagram of 8-Bit Timers (TMR_Y and TMR_X)

12.2 Input/Output Pins

Table 12.1 summarizes the input and output pins of the TMR.

Table 12.1 Pin Configuration

| Channel | Name | Symbol | I/O | Function |
|---------|-------------------------|-------------------------------|--------|---|
| TMR_0 | Timer output | TMO0 | Output | Output controlled by compare-match |
| | Timer clock input | TMCI0 | Input | External clock input for the counter |
| | Timer reset input | TMRI0 | Input | External reset input for the counter |
| TMR_1 | Timer output | TMO1 | Output | Output controlled by compare-match |
| | Timer clock input | TMCI1 | Input | External clock input for the counter |
| | Timer reset input | TMRI1 | Input | External reset input for the counter |
| TMR_Y | Timer clock/reset input | VSYNCI/TMIY (TMCIY/TMRIY) | Input | External clock input/external reset input for the counter |
| TMR_X | Timer output | TMOX | Output | Output controlled by compare-match |
| | Timer clock/reset input | HFBACKI/TMIX (TMCIX/TMRIX) | • | External clock input/external reset input for the counter |

12.3 Register Descriptions

The TMR has the following registers. For details on the serial timer control register, refer to section 3.2.3, Serial Timer Control Register (STCR). For details on timer connection register S, refer to section 13.3.3, Timer Connection Register S (TCONRS).

- Timer counter (TCNT)
- Time constant register A (TCORA)
- Time constant register B (TCORB)
- Timer control register (TCR)
- Timer control/status register (TCSR)
- Timer input select register (TISR)*1
- Time constant register C (TCORC)*²
- Input capture register R (TICRR)*²
- Input capture register F (TICRF)*²

Notes: 1. TISR is only for the TMR_Y.

2. TCORC, TICRR, and TICRF are only for the TMR_X.

12.3.1 Timer Counter (TCNT)

Each TCNT is an 8-bit readable/writable up-counter. TCNT_0 and TCNT_1 comprise a single 16-bit register, so they can be accessed together by word access. The clock source is selected by the CKS2 to CKS0 bits in TCR. TCNT can be cleared by an external reset input signal, comparematch A signal or compare-match B signal. The method of clearing can be selected by the CCLR1 and CCLR0 bits in TCR. When TCNT overflows (changes from H'FF to H'00), the OVF bit in TCSR is set to 1. TCNT is initialized to H'00.

12.3.2 Time Constant Register A (TCORA)

TCORA is an 8-bit readable/writable register. TCORA_0 and TCORA_1 comprise a single 16-bit register, so they can be accessed together by word access. TCORA is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag A (CMFA) in TCSR is set to 1. Note however that comparison is disabled during the T2 state of a TCORA write cycle. The timer output from the TMO pin can be freely controlled by these compare-match A signals and the settings of output select bits OS1 and OS0 in TCSR. TCORA is initialized to H'FF.

12.3.3 Time Constant Register B (TCORB)

TCORB is an 8-bit readable/writable register. TCORB_0 and TCORB_1 comprise a single 16-bit register, so they can be accessed together by word access. TCORB is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag B (CMFB) in TCSR is set to 1. Note however that comparison is disabled during the T2 state of a TCORB write cycle. The timer output from the TMO pin can be freely controlled by these compare-match B signals and the settings of output select bits OS3 and OS2 in TCSR. TCORB is initialized to H'FF.

12.3.4 Timer Control Register (TCR)

TCR selects the TCNT clock source and the condition by which TCNT is cleared, and enables/disables interrupt requests.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | CMIEB | 0 | R/W | Compare-Match Interrupt Enable B |
| | | | | Selects whether the CMFB interrupt request (CMIB) is enabled or disabled when the CMFB flag in TCSR is set to 1. Note that a CMIB interrupt is not generated by TMR_X, regardless of the CMIEB value. |
| | | | | 0: CMFB interrupt request (CMIB) is disabled |
| | | | | 1: CMFB interrupt request (CMIB) is enabled |
| 6 | CMIEA | 0 | R/W | Compare-Match Interrupt Enable A |
| | | | | Selects whether the CMFA interrupt request (CMIA) is enabled or disabled when the CMFA flag in TCSR is set to 1. Note that a CMIA interrupt is not generated by TMR_X, regardless of the CMIEA value. |
| | | | | 0: CMFA interrupt request (CMIA) is disabled |
| | | | | 1: CMFA interrupt request (CMIA) is enabled |
| 5 | OVIE | 0 | R/W | Timer Overflow Interrupt Enable |
| | | | | Selects whether the OVF interrupt request (OVI) is enabled or disabled when the OVF flag in TCSR is set to 1. Note that an OVI interrupt is not generated by TMR_X, regardless of the OVIE value. |
| | | | | 0: OVF interrupt request (OVI) is disabled |
| | | | | 1: OVF interrupt request (OVI) is enabled |

| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|---|---|--|
| 4 | CCLR1 | 0 | R/W | Counter Clear 1, 0 | |
| 3 | CCLR0 | 0 | R/W These bits select the method by which the timer counter is cleared. | | |
| | | | | 00: Clearing is disabled | |
| | | | | 01: Cleared on compare-match A | |
| | | | | 10: Cleared on compare-match B | |
| | | | | 11: Cleared on rising edge of external reset input | |
| 2 | CKS2 | 0 | R/W | Clock Select 2 to 0 | |
| 1 | CKS1 | 0 | R/W | These bits select the clock input to TCNT and count | |
| 0 | CKS0 | 0 | R/W | condition, together with the ICKS1 and ICKS0 bits in STC For details, see table 12.2. | |

Table 12.2 Clock Input to TCNT and Count Condition

| | TCR | | | S | TCR | |
|---------|------|------|------|-------|-------|---|
| Channel | CKS2 | CKS1 | CKS0 | ICKS1 | ICKS0 | |
| TMR_0 | 0 | 0 | 0 | | | Disables clock input |
| | 0 | 0 | 1 | _ | 0 | Increments at falling edge of internal clock ø/8 |
| | 0 | 0 | 1 | _ | 1 | Increments at falling edge of internal clock ø/2 |
| | 0 | 1 | 0 | _ | 0 | Increments at falling edge of internal clock ø/64 |
| | 0 | 1 | 0 | _ | 1 | Increments at falling edge of internal clock ø/32 |
| | 0 | 1 | 1 | _ | 0 | Increments at falling edge of internal clock ø/1024 |
| | 0 | 1 | 1 | _ | 1 | Increments at falling edge of internal clock ø/256 |
| | 1 | 0 | 0 | _ | _ | Increments at overflow signal from TCNT_1* |

| | TCR | | | S | TCR | | |
|---------|------|------|------|-------|-------------|--|--|
| Channel | CKS2 | CKS1 | CKS0 | ICKS1 | ICKS0 | Description | |
| TMR_1 | 0 | 0 | 0 | _ | _ | Disables clock input | |
| | 0 | 0 | 1 | 0 | _ | Increments at falling edge of internal clock ø/8 | |
| | 0 | 0 | 1 | 1 | _ | Increments at falling edge of internal clock ø/2 | |
| | 0 | 1 | 0 | 0 | — | Increments at falling edge of internal clock ø/64 | |
| | 0 | 1 | 0 | 1 | _ | Increments at falling edge of internal clock ø/128 | |
| | 0 | 1 | 1 | 0 | _ | Increments at falling edge of internal clock ø/1024 | |
| | 0 | 1 | 1 | 1 | _ | Increments at falling edge of internal clock ø/2048 | |
| | 1 | 0 | 0 | _ | _ | Increments at compare-match A from TCNT_0* | |
| TMR_Y | 0 | 0 | 0 | _ | _ | Disables clock input | |
| | 0 | 0 | 1 | _ | _ | Increments at falling edge of internal clock ø/4 | |
| | 0 | 1 | 0 | _ | _ | Increments at falling edge of internal clock ø/256 | |
| | 0 | 1 | 1 | _ | _ | Increments at falling edge of internal clock ø/2048 | |
| | 1 | 0 | 0 | _ | _ | Disables clock input | |
| TMR_X | 0 | 0 | 0 | _ | _ | Disables clock input | |
| | 0 | 0 | 1 | _ | — | Increments at falling edge of internal clock ø | |
| | 0 | 1 | 0 | _ | — | Increments at falling edge of internal clock ø/2 | |
| | 0 | 1 | 1 | _ | — | Increments at falling edge of internal clock ø/4 | |
| | 1 | 0 | 0 | _ | _ | Disables clock input | |
| Common | 1 | 0 | 1 | _ | _ | Increments at rising edge of external clock | |
| | 1 | 1 | 0 | _ | _ | Increments at falling edge of external clock | |
| | 1 | 1 | 1 | _ | | Increments at both rising and falling edges of external clock. | |

Note:* If the TMR_0 clock input is set as the TCNT_1 overflow signal and the TMR_1 clock input is set as the TCNT_0 compare-match signal simultaneously, a count-up clock cannot be generated.

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12.3.5 Timer Control/Status Register (TCSR)

TCSR indicates the status flags and controls compare-match output.

• TCSR_0

| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|--------|--|--|
| 7 | CMFB | 0 | R/(W)* | Compare-Match Flag B | |
| | | | | [Setting condition] | |
| | | | | When the values of TCNT_0 and TCORB_0 match | |
| | | | | [Clearing conditions] | |
| | | | | • Read CMFB when CMFB = 1, then write 0 in CMFB | |
| | | | | When the DTC is activated by a CMIB interrupt | |
| 6 | CMFA | 0 | R/(W)* | Compare-Match Flag A | |
| | | | | [Setting condition] | |
| | | | | When the values of TCNT_0 and TCORA_0 match | |
| | | | | [Clearing conditions] | |
| | | | | • Read CMFA when CMFA = 1, then write 0 in CMFA | |
| | | | | When the DTC is activated by a CMIA interrupt | |
| 5 | OVF | 0 | R/(W)* | Timer Overflow Flag | |
| | | | | [Setting condition] | |
| | | | | When TCNT_0 overflows from H'FF to H'00 | |
| | | | | [Clearing condition] | |
| | | | | Read OVF when OVF = 1, then write 0 in OVF | |
| 4 | ADTE | 0 | R/W | A/D Trigger Enable | |
| | | | | Enables or disables A/D converter start requests by compare-match A. | |
| | | | | 0: A/D converter start requests by compare-match A are disabled | |
| | | | | 1: A/D converter start requests by compare-match A are enabled | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 3 | OS3 | 0 | R/W | Output Select 3, 2 |
| 2 | OS2 | 0 | R/W | These bits specify how the TMO0 pin output level is to be changed by compare-match B of TCORB_0 and TCNT_0. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |
| 1 | OS1 | 0 | R/W | Output Select 1, 0 |
| 0 | OS0 | 0 | R/W | These bits specify how the TMO0 pin output level is to be changed by compare-match A of TCORA_0 and TCNT_0. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

Note:* Only 0 can be written, for flag clearing.

• TCSR_1

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 7 | CMFB | 0 | R/(W)* | Compare-Match Flag B |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_1 and TCORB_1 match |
| | | | | [Clearing conditions] |
| | | | | • Read CMFB when CMFB = 1, then write 0 in CMFB |
| | | | | When the DTC is activated by a CMIB interrupt |
| 6 | CMFA | 0 | R/(W)* | Compare-Match Flag A |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_1 and TCORA_1 match |
| | | | | [Clearing conditions |
| | | | | • Read CMFA when CMFA = 1, then write 0 in CMFA |
| | | | | When the DTC is activated by a CMIA interrupt |
| 5 | OVF | 0 | R/(W)* | Timer Overflow Flag |
| | | | | [Setting condition] |
| | | | | When TCNT_1 overflows from H'FF to H'00 |
| | | | | [Clearing condition] |
| | | | | Read OVF when OVF = 1, then write 0 in OVF |
| 4 | _ | 1 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |
| 3 | OS3 | 0 | R/W | Output Select 3, 2 |
| 2 | OS2 | 0 | R/W | These bits specify how the TMO1 pin output level is to be changed by compare-match B of TCORB_1 and TCNT_1. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 1 | OS1 | 0 | R/W | Output Select 1, 0 |
| 0 | OS0 | 0 | R/W | These bits specify how the TMO1 pin output level is to be changed by compare-match A of TCORA_1 and TCNT_1. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

Note:* Only 0 can be written, for flag clearing.

• TCSR_Y

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 7 | CMFB | 0 | R/(W)* | ¹ Compare-Match Flag B |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_Y and TCORB_Y match |
| | | | | [Clearing conditions] |
| | | | | • Read CMFB when CMFB = 1, then write 0 in CMFB |
| | | | | When the DTC is activated by a CMIB interrupt |
| 6 | CMFA | 0 | R/(W)* | ¹ Compare-Match Flag A |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_Y and TCORA_Y match |
| | | | | [Clearing conditions] |
| | | | | • Read CMFA when CMFA = 1, then write 0 in CMFA |
| | | | | When the DTC is activated by a CMIA interrupt |
| 5 | OVF | 0 | R/(W)* | ¹ Timer Overflow Flag |
| | | | | [Setting condition] |
| | | | | When TCNT_Y overflows from H'FF to H'00 |
| | | | | [Clearing condition] |
| | | | | Read OVF when OVF = 1, then write 0 in OVF |
| 4 | ICIE | 0 | R/W | Input Capture Interrupt Enable |
| | | | | Enables or disables the ICF interrupt request (ICIX) when the ICF bit in TCSR_X is set to 1. |
| | | | | 0: ICF interrupt request (ICIX) is disabled |
| | | | | 1: ICF interrupt request (ICIX) is enabled |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 3 | OS3 | 0 | R/W | Output Select 3, 2 |
| 2 | OS2 | 0 | R/W | These bits specify how the TMOY pin*2 output level is to be changed by compare-match B of TCORB_Y and TCNT_Y. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |
| 1 | OS1 | 0 | R/W | Output Select 1, 0 |
| 0 | OS0 | 0 | R/W | These bits specify how the TMOY pin*2 output level is to be changed by compare-match A of TCORA_Y and TCNT_Y. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

Notes: 1. Only 0 can be written, for flag clearing.

2. This product does not have a TMOY external output pin.

• TCSR_X

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 7 | CMFB | 0 | R/(W)* | Compare-Match Flag B |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_X and TCORB_X match |
| | | | | [Clearing conditions] |
| | | | | • Read CMFB when CMFB = 1, then write 0 in CMFB |
| | | | | When the DTC is activated by a CMIB interrupt |
| 6 | CMFA | 0 | R/(W)* | Compare-Match Flag A |
| | | | | [Setting condition] |
| | | | | When the values of TCNT_X and TCORA_X match |
| | | | | [Clearing conditions] |
| | | | | • Read CMFA when CMFA = 1, then write 0 in CMFA |
| | | | | When the DTC is activated by a CMIA interrupt |
| 5 | OVF | 0 | R/(W)* | Timer Overflow Flag |
| | | | | [Setting condition] |
| | | | | When TCNT_X overflows from H'FF to H'00 |
| | | | | [Clearing condition] |
| | | | | Read OVF when OVF = 1, then write 0 in OVF |
| 4 | ICF | 0 | R/(W)* | Input Capture Flag |
| | | | | [Setting condition] |
| | | | | When a rising edge and falling edge is detected in the external reset signal in that order, after the ICST bit in TCONRI of the timer connection is set to 1 |
| | | | | [Clearing condition] |
| | | | | Read ICF when ICF = 1, then write 0 in ICF |
| 3 | OS3 | 0 | R/W | Output Select 3, 2 |
| 2 | OS2 | 0 | R/W | These bits specify how the TMOX pin output level is to be changed by compare-match B of TCORB_X and TCNT_X. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 1 | OS1 | 0 | R/W | Output Select 1, 0 |
| 0 | OS0 | 0 | R/W | These bits specify how the TMOX pin output level is to be changed by compare-match A of TCORA_X and TCNT_X. |
| | | | | 00: No change |
| | | | | 01: 0 is output |
| | | | | 10: 1 is output |
| | | | | 11: Output is inverted (toggle output) |

Note:* Only 0 can be written, for flag clearing.

12.3.6 Input Capture Register (TICR)

TICR is an 8-bit register. The contents of TCNT are transferred to TICR at the rising edge of the external reset input. TICR cannot be directly accessed by the CPU. The TICR function is used for the timer connection. For details, refer to section 13, Timer Connection.

12.3.7 Time Constant Register (TCORC)

TCORC is an 8-bit readable/writable register. The sum of contents of TCORC and TICR is always compared with TCNT. When a match is detected, a compare-match C signal is generated. However, comparison at the T2 state in the write cycle to TCORC and at the input capture cycle of TICR is disabled. TCORC is initialized to H'FF. The TCORC function is used for the timer connection. For details, refer to section 13, Timer Connection.

12.3.8 Input Capture Registers R and F (TICRR, TICRF)

TICRR and TICRF are 8-bit read-only registers. The contents of TCNT are transferred at the rising edge and falling edge of the external reset input in that order, when the ICST bit in TCONRI of the timer connection is set to 1. The ICST bit is cleared to 0 when one capture operation ends. TICRR and TICRF are initialized to H'00. The TICRR and TICRF functions are used for timer connection. For details, refer to section 13, Timer Connection.

12.3.9 Timer Input Select Register (TISR)

TISR selects a signal source of external clock/reset input for the counter.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-------|--|
| 7 | _ | All 1 | R/(W) | Reserved |
| to 1 | | | | The initial values should not be modified. |
| 0 | IS | 0 | R/W | Input Select |
| | | | | Selects an internal synchronization signal (IVG signal) or timer clock/reset input pin VSYNCI/TMIY (TMCIY/TMRIY) as the signal source of external clock/reset input for the TMR_Y counter. |
| | | | | 0: IVG signal is selected |
| | | | | 1: VSYNCI/TMIY (TMCIY/TMRIY) is selected |

12.4 Operation

12.4.1 Pulse Output

Figure 12.3 shows an example for outputting an arbitrary duty pulse.

- 1. Clear the CCLR1 bit in TCR to 0 so that TCNT is cleared according to the compare match of TCORA, and then set the CCLR0 bit to 1.
- 2. Set the OS3 to OS0 bits in TCSR to B'0110 so that 1 is output according to the compare match of TCORA and 0 is output according to the compare match of TCORB.

According to the above settings, the waveforms with the TCORA cycle and TCORB pulse width can be output without the intervention of software.

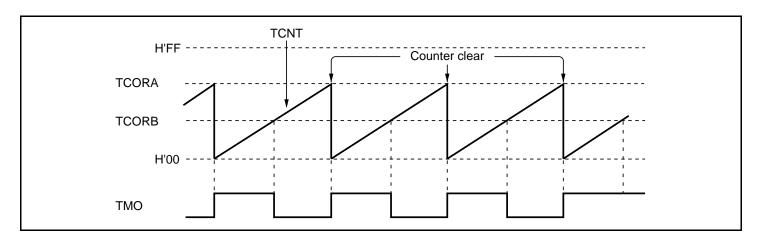


Figure 12.3 Pulse Output Example

12.5 Operation Timing

12.5.1 TCNT Count Timing

Figure 12.4 shows the TCNT count timing with an internal clock source. Figure 12.5 shows the TCNT count timing with an external clock source. The pulse width of the external clock signal must be at least 1.5 system clocks (ø) for a single edge and at least 2.5 system clocks (ø) for both edges. The counter will not increment correctly if the pulse width is less than these values.

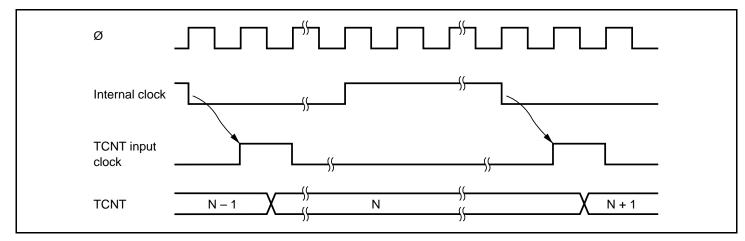


Figure 12.4 Count Timing for Internal Clock Input

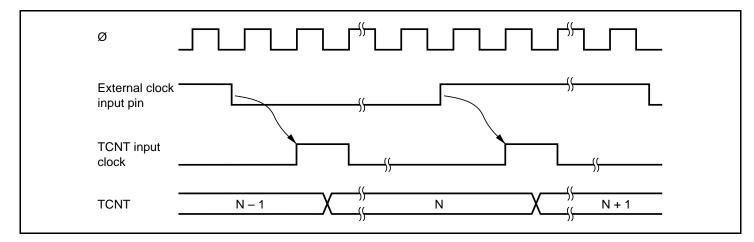


Figure 12.5 Count Timing for External Clock Input (Both Edges)

12.5.2 Timing of CMFA and CMFB Setting at Compare-Match

The CMFA and CMFB flags in TCSR are set to 1 by a compare-match signal generated when the TCNT and TCOR values match. The compare-match signal is generated at the last state in which the match is true, just when the timer counter is updated. Therefore, when TCNT and TCOR match, the compare-match signal is not generated until the next TCNT input clock. Figure 12.6 shows the timing of CMF flag setting.

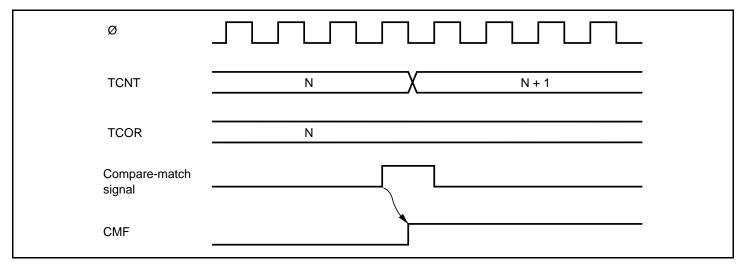


Figure 12.6 Timing of CMF Setting at Compare-Match

12.5.3 Timing of Timer Output at Compare-Match

When a compare-match signal occurs, the timer output changes as specified by the OS3 to OS0 bits in TCSR. Figure 12.7 shows the timing of timer output when the output is set to toggle by a compare-match A signal.

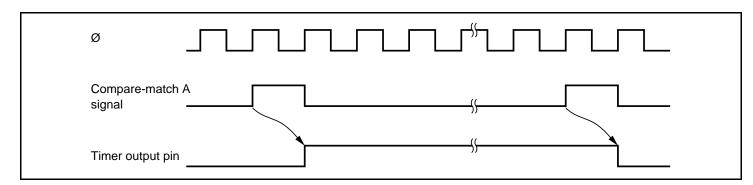


Figure 12.7 Timing of Toggled Timer Output by Compare-Match A Signal

12.5.4 Timing of Counter Clear at Compare-Match

TCNT is cleared when compare-match A or compare-match B occurs, depending on the setting of the CCLR1 and CCLR0 bits in TCR. Figure 12.8 shows the timing of clearing the counter by a compare-match.

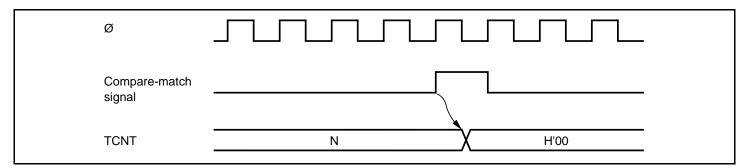


Figure 12.8 Timing of Counter Clear by Compare-Match

12.5.5 TCNT External Reset Timing

TCNT is cleared at the rising edge of an external reset input, depending on the settings of the CCLR1 and CCLR0 bits in TCR. The width of the clearing pulse must be at least 1.5 states. Figure 12.9 shows the timing of clearing the counter by an external reset input.

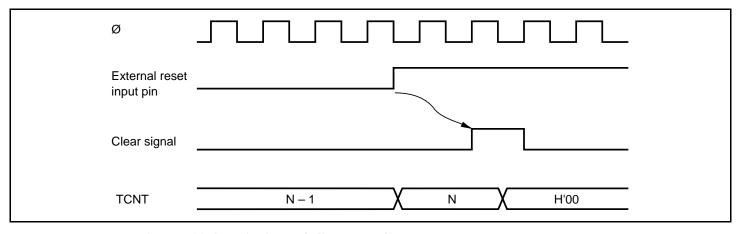


Figure 12.9 Timing of Counter Clear by External Reset Input

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12.5.6 Timing of Overflow Flag (OVF) Setting

The OVF bit in TCSR is set to 1 when the TCNT overflows (changes from H'FF to H'00). Figure 12.10 shows the timing of OVF flag setting.

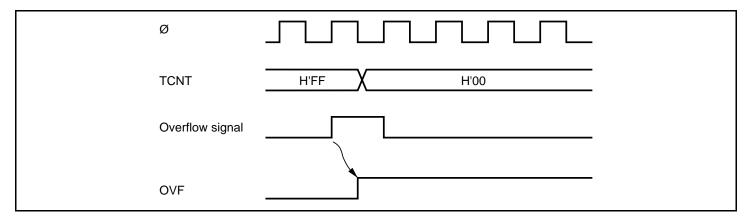


Figure 12.10 Timing of OVF Flag Setting

12.6 Operation with Cascaded Connection

If bits CKS2 to CKS0 in either TCR_0 or TCR_1 are set to B'100, the 8-bit timers of the two channels are cascaded. With this configuration, a single 16-bit timer can be used (16-bit count mode) or the compare-matches of the 8-bit timer of channel 0 can be counted by the 8-bit timer of channel 1 (compare-match count mode).

12.6.1 16-Bit Count Mode

When bits CKS2 to CKS0 in TCR_0 are set to B'100, the timer functions as a single 16-bit timer with channel 0 occupying the upper 8 bits and channel 1 occupying the lower 8 bits.

Setting of Compare-Match Flags:

- The CMF flag in TCSR_0 is set to 1 when a 16-bit compare-match occurs.
- The CMF flag in TCSR_1 is set to 1 when a lower 8-bit compare-match occurs.

Counter Clear Specification:

- If the CCLR1 and CCLR0 bits in TCR_0 have been set for counter clear at compare-match, the 16-bit counter (TCNT_0 and TCNT_1 together) is cleared when a 16-bit compare-match occurs. The 16-bit counter (TCNT_0 and TCNT_1 together) is also cleared when counter clear by the TMI0 pin has been set.
- The settings of the CCLR1 and CCLR0 bits in TCR_1 are ignored. The lower 8 bits cannot be cleared independently.

Pin Output:

- Control of output from the TMO0 pin by bits OS3 to OS0 in TCSR_0 is in accordance with the 16-bit compare-match conditions.
- Control of output from the TMO1 pin by bits OS3 to OS0 in TCSR_1 is in accordance with the lower 8-bit compare-match conditions.

12.6.2 Compare-Match Count Mode

When bits CKS2 to CKS0 in TCR_1 are B'100, TCNT_1 counts the occurrence of compare-match A for channel 0. Channels 0 and 1 are controlled independently. Conditions such as setting of the CMF flag, generation of interrupts, output from the TMO pin, and counter clearing are in accordance with the settings for each channel.

12.7 Input Capture Operation

TMR_X has input capture registers (TICR, TICRR and TICRF). A narrow pulse width can be measured with TICRR and TICRF, using a single capture operation controlled by the ICST bit in TCONRI of the timer connection. If the falling edge of TMRIX is detected after its rising edge has been detected while the ICST bit is set to 1, the value of TCNT at that time is transferred to both TICRR and TICRF, and the ICST bit is cleared to 0.

The input signal to TMRIX can be switched by the setting of the other bits in TCONRI.

Input Capture Signal Input Timing: Figure 12.11 shows the timing of the input capture operation.

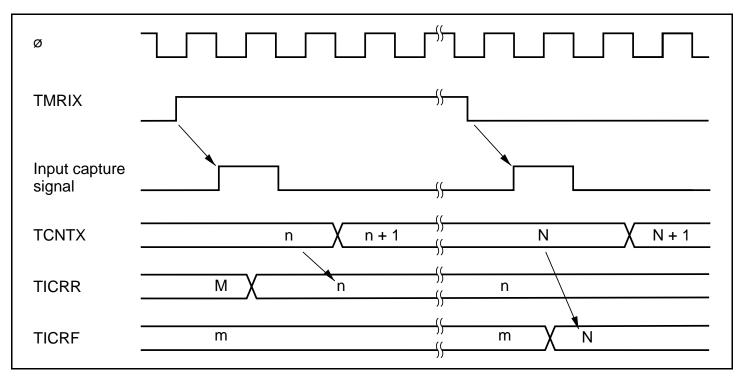


Figure 12.11 Timing of Input Capture Operation

If the input capture signal is input while TICRR and TICRF are being read, the input capture signal is delayed by one system clock (Ø) cycle. Figure 12.12 shows the timing of this operation.

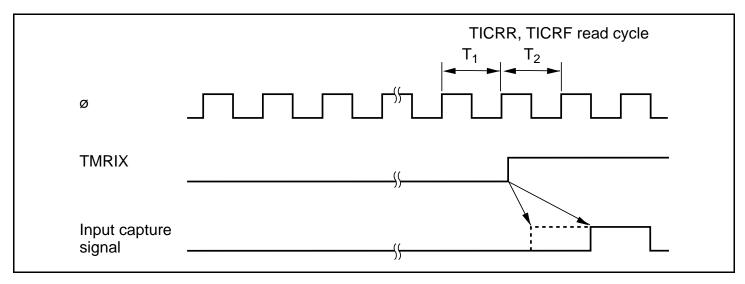


Figure 12.12 Timing of Input Capture Signal (Input capture signal is input during TICRR and TICRF read)

Selection of Input Capture Signal Input: Input capture input signal of TMR_X (TMRIX) is switched according to the setting of the bits in TCONRI of the timer connection. Input capture signal selections are shown in figure 12.13 and table 12.3. For details, see section 13.3.1, Timer Connection Register I (TCONRI).

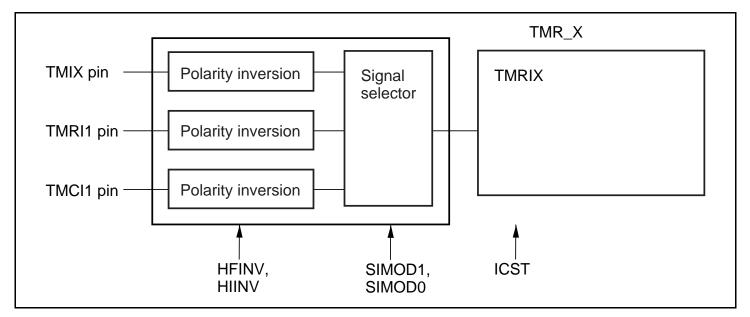


Figure 12.13 Input Capture Signal Selection

Table 12.3 Input Capture Signal Selection

TCONRI

| Bit 4 | Bit 7 | Bit 6 | Bit 3 | Bit 1 | |
|-------|--------|--------|-------|-------|------------------------------------|
| ICST | SIMOD1 | SIMOD0 | HFINV | HIINV | Description |
| 0 | _ | _ | _ | _ | Input capture function not used |
| 1 | 0 | 0 | 0 | _ | TMIX pin input selection |
| | | | 1 | | Inverted TMIX pin input selection |
| | | 1 | | 0 | TMRI1 pin input selection |
| | | | _ | 1 | Inverted TMRI1 pin input selection |
| | 1 | 1 | _ | 0 | TMCI1 pin input selection |
| | | | _ | 1 | Inverted TMCI1 pin input selection |

12.8 Interrupt Sources

TMR_0, TMR_1, and TMR_Y can generate three types of interrupts: CMIA, CMIB, and OVI. TMR_X can generate an ICIX interrupt. Table 12.4 shows the interrupt sources and priorities. Each interrupt source can be enabled or disabled independently by interrupt enable bits in TCR or TCSR. Independent signals are sent to the interrupt controller for each interrupt.

The CMIA and CMIB interrupts can be used as DTC activation interrupt sources.

Table 12.4 Interrupt Sources of 8-Bit Timers TMR_0, TMR_1, TMR_Y, and TMR_X

| TCORA_0 compare-match TCORB_0 compare-match TCNT_0 overflow | CMFA CMFB OVF | Enabled Enabled Disabled | High — 🛉 |
|---|---------------------|--------------------------|------------------------------|
| TCNT_0 overflow | | | <u> </u> |
| | OVF | Disabled | |
| TCOBA 1 compare motoh | | | |
| TCORA_1 compare-match | CMFA | Enabled | _ |
| TCORB_1 compare-match | CMFB | Enabled | _ |
| TCNT_1 overflow | OVF | Disabled | _ |
| TCORA_Y compare-match | CMFA | Enabled | _ |
| TCORB_Y compare-match | CMFB | Enabled | _ |
| TCNT_Y overflow | OVF | Disabled | _ |
| 1 | ICF | Disabled | Low |
| | <u>_</u> | TCNT_Y overflow OVF | TCNT_Y overflow OVF Disabled |

12.9 Usage Notes

12.9.1 Conflict between TCNT Write and Clear

If a counter clear signal is generated during the T2 state of a TCNT write cycle as shown in figure 12.14, clearing takes priority, so that the counter is cleared and the write is not performed.

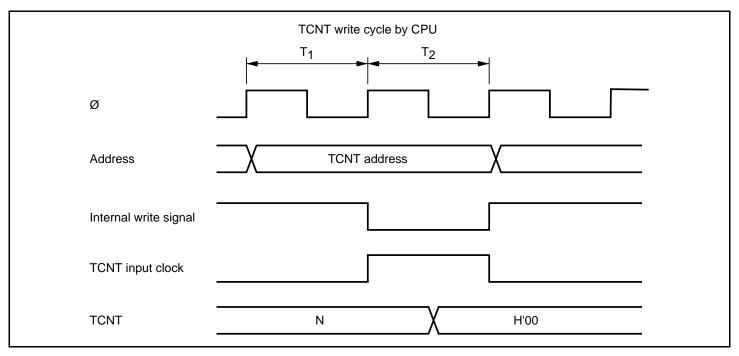


Figure 12.14 Conflict between TCNT Write and Clear

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12.9.2 Conflict between TCNT Write and Increment

If a TCNT input clock is generated during the T2 state of a TCNT write cycle as shown in figure 12.15, the write takes priority and the counter is not incremented.

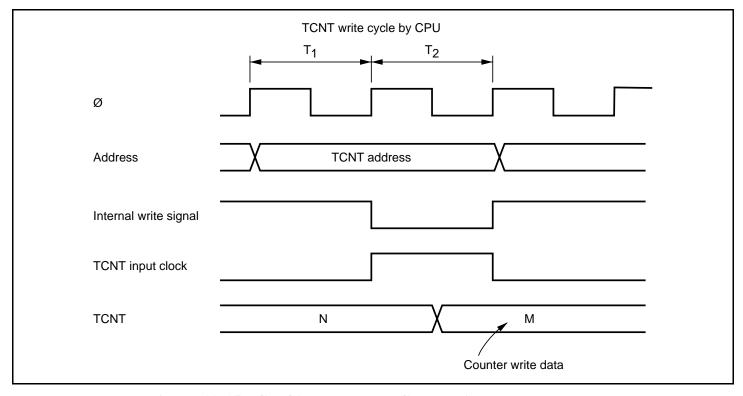


Figure 12.15 Conflict between TCNT Write and Increment

12.9.3 Conflict between TCOR Write and Compare-Match

If a compare-match occurs during the T2 state of a TCOR write cycle as shown in figure 12.16, the TCOR write takes priority and the compare-match signal is disabled. With TMR_X, a TICR input capture conflicts with a compare-match in the same way as with a write to TCORC. In this case also, the input capture takes priority and the compare-match signal is disabled.

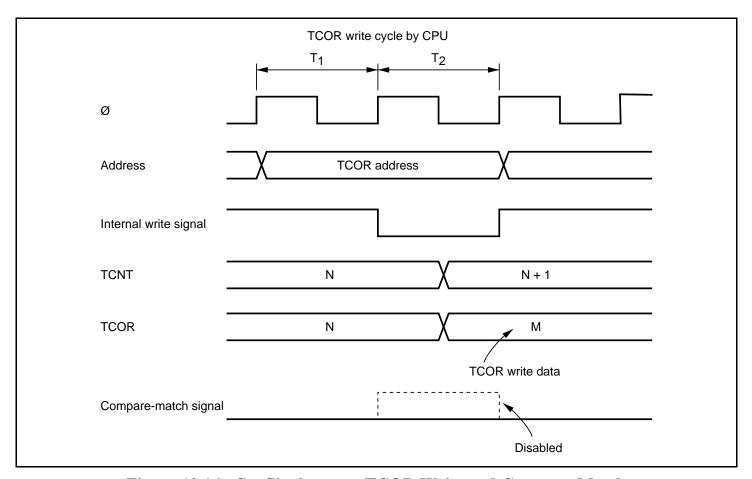


Figure 12.16 Conflict between TCOR Write and Compare-Match

12.9.4 Conflict between Compare-Matches A and B

If compare-matches A and B occur at the same time, the 8-bit timer operates in accordance with the priorities for the output states set for compare-match A and compare-match B, as shown in table 12.5.

Table 12.5 Timer Output Priorities

| Output Setting | Priority | |
|----------------|----------|--|
| Toggle output | High | |
| 1 output | | |
| 0 output | | |
| No change | Low | |

12.9.5 Switching of Internal Clocks and TCNT Operation

TCNT may increment erroneously when the internal clock is switched over. Table 12.6 shows the relationship between the timing at which the internal clock is switched (by writing to the CKS1 and CKS0 bits) and the TCNT operation.

When the TCNT clock is generated from an internal clock, the falling edge of the internal clock pulse is detected. If clock switching causes a change from high to low level, as shown in no. 3 in table 12.6, a TCNT clock pulse is generated on the assumption that the switchover is a falling edge, and TCNT is incremented.

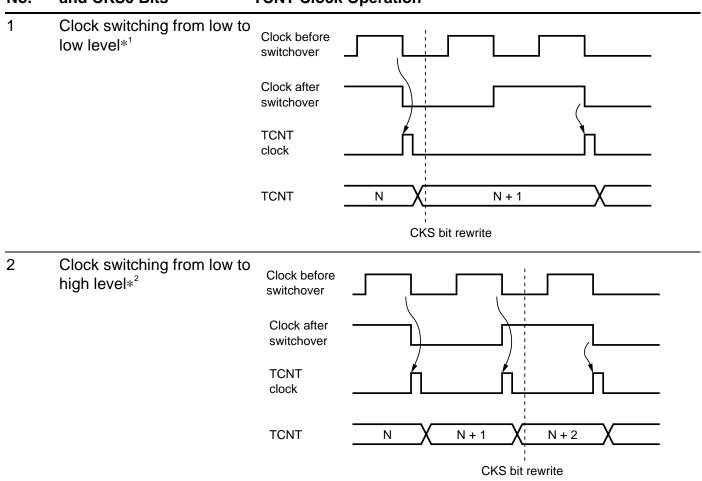
Erroneous incrementation can also happen when switching between internal and external clocks.

Table 12.6 Switching of Internal Clocks and TCNT Operation

Timing of Switchover by Means of CKS1

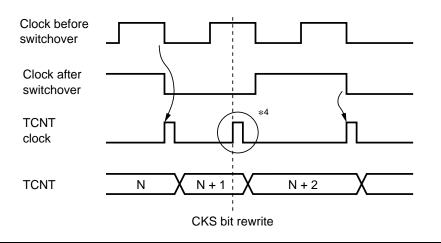


TCNT Clock Operation

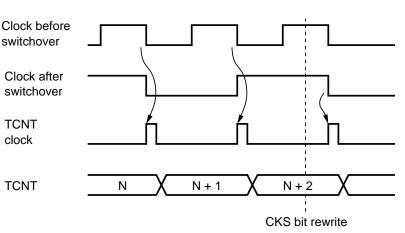


3 Clock switching from high to low level*3

No.



4 Clock switching from high to high level



Notes: 1. Includes switching from low to stop, and from stop to low.

- 2. Includes switching from stop to high.
- 3. Includes switching from high to stop.
- 4. Generated on the assumption that the switchover is a falling edge; TCNT is incremented.

12.9.6 Mode Setting with Cascaded Connection

If the 16-bit count mode and compare-match count mode are set simultaneously, the input clock pulses for TCNT_0 and TCNT_1 are not generated, and thus the counters will stop operating. Simultaneous setting of these two modes should therefore be avoided.

12.9.7 Module Stop Mode Setting

TMR operation can be enabled or disabled using the module stop control register. The initial setting is for TMR operation to be halted. Register access is enabled by canceling the module stop mode. For details, refer to section 26, Power-Down Modes.

Section 13 Timer Connection

This LSI allows interconnection between a 16-bit free-running timer (FRT) and three 8-bit timer channels (TMR_1, TMR_X, and TMR_Y). This capability can be used to implement complex functions such as PWM decoding and clamp waveform output.

13.1 Features

- Five input pins and four output pins, all of which can be designated for phase inversion. Positive logic is assumed for all signals used within the timer connection facility.
- An edge-detection circuit is connected to the input pins, simplifying signal input detection.
- TMR_X can be used for PWM input signal decoding.
- TMR_X can be used for clamp waveform generation.
- An external clock signal divided by TMR_1 can be used as the FRT capture input signal.
- An internal synchronization signal can be generated using the FRT and TMR_Y.
- A signal generated/modified using an input signal and timer connection can be selected and output.

Figure 13.1 shows a block diagram of the timer connection facility.

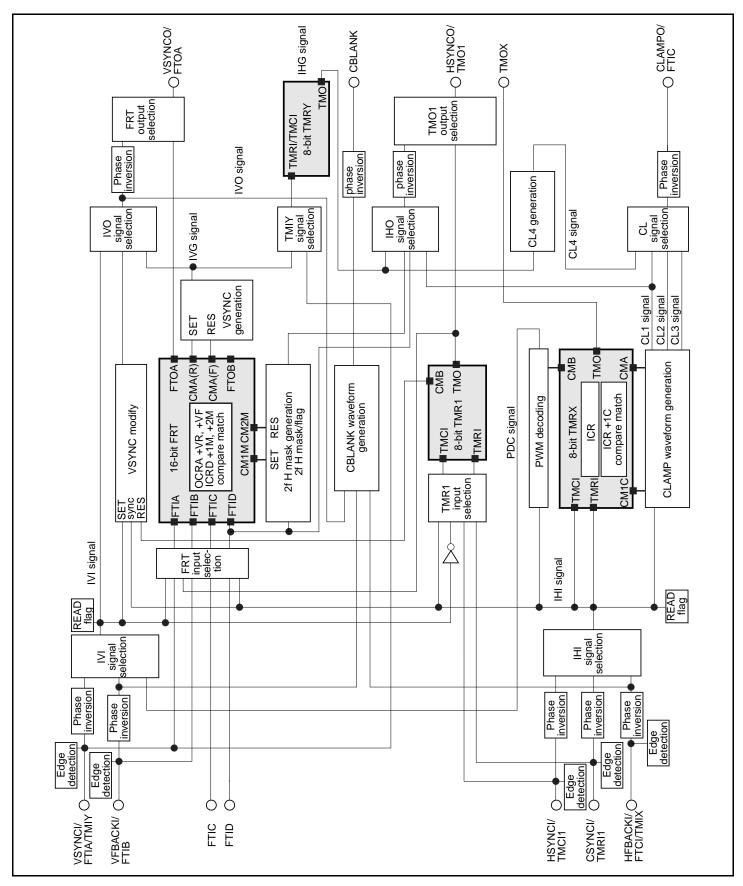


Figure 13.1 Block Diagram of Timer Connection

13.2 Input/Output Pins

Table 13.1 lists the timer connection input and output pins.

Table 13.1 Pin Configuration

| Name | Abbreviation | Input/ Output | Function |
|---|--------------|------------------|--|
| Vertical synchronization signal input pin | VSYNCI | Input | Vertical synchronization signal input pin or FTIA input pin/TMIY input pin |
| Horizontal synchronization signal input pin | HSYNCI | Input | Horizontal synchronization signal input pin or TMCI1 input pin |
| Composite synchronization signal input pin | CSYNCI | Input | Composite synchronization signal input pin or TMRI1 input pin |
| Spare vertical synchronization signal input pin | VFBACKI | Input | Spare vertical synchronization signal input pin or FTIB input pin |
| Spare horizontal synchronization signal input pin | HFBACKI | Input | Spare horizontal synchronization signal input pin or FTCI input pin/TMIX input pin |
| Vertical synchronization signal output pin | VSYNCO | Output | Vertical synchronization signal output pin or FTOA output pin |
| Horizontal synchronization signal output pin | HSYNCO | Output | Horizontal synchronization signal output pin or TMO1 output pin |
| Clamp waveform output pin | CLAMPO | Output | Clamp waveform output pin or FTIC input pin |
| Blanking waveform output pin | CBLANK | Output | Blanking waveform output pin |

13.3 Register Descriptions

The timer connection has the following registers.

- Timer connection register I (TCONRI)
- Timer connection register O (TCONRO)
- Timer connection register S (TCONRS)
- Edge sense register (SEDGR)

13.3.1 Timer Connection Register I (TCONRI)

TCONRI controls connection between timers, the signal source for synchronization signal input, phase inversion, etc.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | SIMOD1 | 0 | R/W | Input Synchronization Mode Select 1, 0 |
| 6 | SIMOD0 | 0 | R/W | These bits select the signal source of the IHI and IVI signals. |
| | | | | Mode |
| | | | | 00: No signal |
| | | | | 01: S-on-G mode |
| | | | | 10: Composite mode |
| | | | | 11: Separate mode |
| | | | | IHI Signal |
| | | | | 00: HFBACKI input |
| | | | | 01: CSYNCI input |
| | | | | 1X: HSYNCI input |
| | | | | IVI Signal |
| | | | | 00: VFBACKI input |
| | | | | 01: PDC input |
| | | | | 10: PDC input |
| | | | | 11: VSYNCI input |
| 5 | SCONE | 0 | R/W | Synchronization Signal Connection Enable |
| | | | | Selects the signal source of the FRT FTI input and the TMR_1 TMI1 input and TMCI1/TMRI1 input. For details, see table 13.2. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 4 | ICST | 0 | R/W | Input Capture Start Bit |
| | | | | The TMR_X external reset input (TMRIX) is connected to the IHI signal. TMR_X has input capture registers (TICR, TICRR, and TICRF). TICRR and TICRF can measure the width of a pulse by means of a single capture operation under the control of the ICST bit. When a rising edge followed by a falling edge is detected on TMRIX after the ICST bit is set to 1, the contents of TCNT at those points are captured into TICRR and TICRF, respectively, and the ICST bit is cleared to 0. |
| | | | | [Clearing condition] |
| | | | | When a rising edge followed by a falling edge is detected on TMRIX |
| | | | | [Setting condition] |
| | | | | When 1 is written in ICST after reading ICST = 0 |

| Bit | Bit Name | Initial Value | R/W | Description | | | | | | |
|-------|----------|---------------|--|--|--|--|--|--|--|--|
| 3 | HFINV | 0 | R/W | Input Synchronization Signal Inversion | | | | | | |
| 2 | VFINV | 0 | R/W | These bits select inversion of the input phase of the | | | | | | |
| 1 | HIINV | 0 | R/W R/W | spare horizontal synchronization signal (HFBACKI), the spare vertical synchronization signal (VFBACKI), | | | | | | |
| 0 | VIINV | 0 | | the horizontal synchronization signal (HSYNCI), composite synchronization signal (CSYNCI), and the vertical synchronization signal (VSYNCI). | | | | | | |
| | | • | • HFINV | | | | | | | |
| | | | | 0: The HFBACKI pin state is used directly as the HFBACKI input | | | | | | |
| | | | | 1: The HFBACKI pin state is inverted before use as the HFBACKI input | | | | | | |
| | | | | • VFINV | | | | | | |
| | | | 0: The VFBACKI pin state is used directly as the VFBACKI input | | | | | | | |
| | | | | | | | | | | 1: The VFBACKI pin state is inverted before use as the VFBACKI input |
| | | | | • HIINV | | | | | | |
| | | | | 0: The HSYNCI and CSYNCI pin states are used directly as the HSYNCI and CSYNCI inputs | | | | | | |
| | | | | 1: The HSYNCI and CSYNCI pin states are inverted before use as the HSYNCI and CSYNCI inputs | | | | | | |
| | | | | • VIINV | | | | | | |
| | | | 0: The VSYNCI pin state is used directly as the VSYNCI input | | | | | | | |
| | | | 1: The VSYNCI pin state is inverted before use as the VSYNCI input | | | | | | | |
| Lagan | 4 | | | | | | | | | |

Legend

X: Don't care

Table 13.2 Synchronization Signal Connection Enable

Bit 5 Description

| SCONE | Mode | FTIA | FTIB | FTIC | FTID | TMCI1 | TMRI1 |
|-------|--|---------------|----------------|------------------|---------------|---------------|--------------------------|
| 0 | Normal connection (Initial value) | FTIA input | FTIB input | FTIC input | FTID input | TMCI1 input | TMRI1 input |
| 1 | Synchronization signal connection mode | IVI signal | TMO1 signal | VFBACKI input | IHI signal | IHI signal | IVI inverse signal |

13.3.2 Timer Connection Register O (TCONRO)

TCONRO controls output signal output, phase inversion, etc.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | HOE | 0 | R/W | Output Enable |
| 6 | VOE | 0 | R/W | These bits control enabling/disabling of output of |
| 5 | CLOE | 0 | R/W | horizontal synchronization signal (HSYNCO), vertical |
| 4 | CBOE | CBOE 0 R/ | R/W | synchronization signal (VSYNCO), clamp waveform (CLAMPO), and blanking waveform (CBLANK). When output is disabled, the state of the relevant pin is determined by port DR and DDR, FRT, TMR, and PWM settings. |
| | | | | Output enabling/disabling control does not affect the port, FRT, or TMR input functions, but some FRT and TMR input signal sources are determined by the SCONE bit in TCONRI. |
| | | | | HOE: |
| | | | | 0: The P44/TMO1/HIRQ1/HSYNCO pin functions as the P44/TMO1/HIRQ1 pin |
| | | | | 1: The P44/TMO1/HIRQ1/HSYNCO pin functions as the HSYNCO pin |
| | | | | VOE: |
| | | | | 0: The P61/FTOA/CIN1/KIN1/VSYNCO pin functions as the P61/FTOA/CIN1/KIN1 pin |
| | | | | 1: The P61/FTOA/CIN1/KIN1/VSYNCO pin functions as the VSYNCO pin |
| | | | | CLOE: |
| | | | | 0: The P64/FTIC/CIN4/KIN4/CLAMPO pin functions as the P64/FTIC/CIN4/KIN4 pin |
| | | | | 1: The P64/FTIC/CIN4/KIN4/CLAMPO pin functions as the CLAMPO pin |
| | | | | CBOE: |
| | | | | 0: The P27/A15/PW15/CBLANK pin functions as the P27/A15/PW15 pin |
| | | | | In mode 1: |
| | | | | 1: The P27/A15/PW15/CBLANK pin functions as the A15 pin |
| | | | | In modes 2 and 3: |
| | | | | 1: The P27/A15/PW15/CBLANK pin functions as the CBLANK pin |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|--|---------------|--|---|
| 3 | HOINV | 0 | R/W | Output Synchronization Signal Inversion |
| 2 | VOINV | 0 | R/W | These bits select inversion of the output phase of the |
| 1 | CLOINV | 0 | R/W | horizontal synchronization signal (HSYNCO), the vertical synchronization signal (VSYNCO), the clamp |
| 0 | CBOINV | 0 | R/W | waveform (CLAMPO), and the blanking waveform (CBLANK). |
| | | | | HOINV: |
| | The IHO signal is used directly as the HSYNCO output | | | |
| | | | | The IHO signal is inverted before use as the HSYNCO output |
| | | | | • VOINV: |
| | | | 0: The IVO signal is used directly as the VSY output | The IVO signal is used directly as the VSYNCO output |
| | | | | The IVO signal is inverted before use as the VSYNCO output |
| | | | | CLOINV: |
| | | | | 0: The CLO signal (CL1, CL2, CL3, or CL4 signal) is used directly as the CLAMPO output |
| | | | | 1: The CLO signal (CL1, CL2, CL3, or CL4 signal) is inverted before use as the CLAMPO output |
| | | | | CBOINV: |
| | | | | 0: The CBLANK signal is used directly as the CBLANK output |
| | | | | The CBLANK signal is inverted before use as the CBLANK output |

13.3.3 Timer Connection Register S (TCONRS)

TCONRS selects whether to access TMR_X or TMR_Y registers, and the synchronization signal output signal source and generation method.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | TMRX/Y | 0 | R/W | TMR_X/TMR_Y Access Select |
| | | | | For details, see table 13.3. |
| | | | | 0: The TMR_X registers are accessed at addresses H'(FF)FFF0 to H'(FF)FFF5 |
| | | | | 1: The TMR_Y registers are accessed at addresses H'(FF)FFF0 to H'(FF)FFF5 |
| 6 | ISGENE | 0 | R/W | Internal Synchronization Signal |
| | | | | Selects internal synchronization signals (IHG, IVG, and CL4 signals) as the signal sources for the IHO, IVO, and CLO signals together with the HOMOD1, HOMOD0, VOMOD1, VOMOD0, CLMOD1, and CLMOD0 bits. |
| 5 | HOMOD1 | 0 | R/W | Horizontal Synchronization Output Mode Select 1, 0 |
| 4 | HOMOD0 | 0 | R/W | These bits select the signal source and generation method for the IHO signal. |
| | | | | • ISGENE = 0 |
| | | | | 00: The IHI signal (without 2fH modification) is selected |
| | | | | 01: The IHI signal (with 2fH modification) is selected |
| | | | | 1X: The CL1 signal is selected |
| | | | | • ISGENE = 1 |
| | | | | XX: The IHG signal is selected |

| Bit | Bit Name | Initial Value | R/W | Description |
|-------|----------|---------------|-----|--|
| 3 | VOMOD1 | 0 | R/W | Vertical Synchronization Output Mode Select 1, 0 |
| 2 | VOMOD0 | 0 | R/W | These bits select the signal source and generation method for the IVO signal. |
| | | | | • ISGENE = 0 |
| | | | | 00: The IVI signal (without fall modification or IHI synchronization) is selected |
| | | | | 01: The IVI signal (without fall modification, with IHI synchronization) is selected |
| | | | | 10: The IVI signal (with fall modification, without IHI synchronization) is selected |
| | | | | 11: The IVI signal (with fall modification and IHI synchronization) is selected |
| | | | | • ISGENE = 1 |
| | | | | XX: The IVG signal is selected |
| 1 | CLMOD1 | 0 | R/W | Clamp Waveform Mode Select 1, 0 |
| 0 | CLMOD0 | 0 | R/W | These bits select the signal source for the CLO signal (clamp waveform). |
| | | | | • ISGENE = 0 |
| | | | | 00: The CL1 signal is selected |
| | | | | 01: The CL2 signal is selected |
| | | | | 1X: The CL3 signal is selected |
| | | | | • ISGENE = 1 |
| | | | | XX: The CL4 signal is selected |
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Legend

X: Don't care

Table 13.3 Registers Accessible by TMR_X/TMR_Y

| TMRX/Y | H'FFF0 | H'FFF1 | H'FFF2 | H'FFF3 | H'FFF4 | H'FFF5 | H'FFF6 | H'FFF7 |
|--------|--------|--------|---------|---------|--------|--------|--------|-----------|
| 0 | TMR_X | TMR_X | TMR_X | TMR_X | TMR_X | TMR_X | TMR_X | TMR_X |
| | TCR_X | TCSR_X | TICRR | TICRF | TCNT_X | TCORC | TCORA_ | X TCORB_X |
| 1 | TMR_Y | TMR_Y | TMR_Y | TMR_Y | TMR_Y | TMR_Y | | |
| | TCR_Y | TCSR_Y | TCORA_Y | TCORB_Y | TCNT_Y | TISR | | |

13.3.4 Edge Sense Register (SEDGR)

SEDGR detects a rising edge on the timer connection input pins and the occurrence of 2fH modification, and determines the phase of the IVI and IHI signals.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|---------|--|
| 7 | VEDG | 0 | R/(W)*1 | VSYNCI Edge |
| | | | | Detects a rising edge on the VSYNCI pin. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in VEDG after reading VEDG = 1 |
| | | | | [Setting condition] |
| | | | | When a rising edge is detected on the VSYNCI pin |
| 6 | HEDG | 0 | R/(W)*1 | HSYNCI Edge |
| | | | | Detects a rising edge on the HSYNCI pin. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in HEDG after reading HEDG = 1 |
| | | | | [Setting condition] |
| | | | | When a rising edge is detected on the HSYNCI pin |
| 5 | CEDG | 0 | R/(W)*1 | CSYNCI Edge |
| | | | | Detects a rising edge on the CSYNCI pin. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in CEDG after reading CEDG = 1 |
| | | | | [Setting condition] |
| | | | | When a rising edge is detected on the CSYNCI pin |
| 4 | HFEDG | 0 | R/(W)*1 | HFBACKI Edge |
| | | | | Detects a rising edge on the HFBACKI pin. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in HFEDG after reading HFEDG = 1 |
| | | | | [Setting condition] |
| | | | | When a rising edge is detected on the HFBACKI pin |
| 3 | VFEDG | 0 | R/(W)*1 | VFBACKI Edge |
| | | | | Detects a rising edge on the VFBACKI pin. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in VFEDG after reading VFEDG = 1 |
| | | | | [Setting condition] |
| | | | | When a rising edge is detected on the VFBACKI pin |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|---------|---|
| 2 | PREQF | 0 | R/(W)*1 | Pre-Equalization Flag |
| | | | | Detects the occurrence of an IHI signal 2fH modification condition. The generation of a falling/rising edge in the IHI signal during a mask interval is expressed as the occurrence of a 2fH modification condition. For details, see section 13.4.4, 2fH Modification of IHI Signal. |
| | | | | [Clearing condition] |
| | | | | When 0 is written in PREQF after reading PREQF = 1 |
| | | | | [Setting condition] |
| | | | | When an IHI signal 2fH modification condition is detected |
| 1 | IHI | Undefined*2 | R | IHI Signal Level |
| | | | | Indicates the current level of the IHI signal. Signal source and phase inversion selection for the IHI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IHI signal at positive phase by modifying TCONRI. |
| | | | | 0: The IHI signal is low |
| | | | | 1: The IHI signal is high |
| 0 | IVI | Undefined*2 | R | IVI Signal Level |
| | | | | Indicates the current level of the IVI signal. Signal source and phase inversion selection for the IVI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IVI signal at positive phase by modifying TCONRI. |
| | | | | 0: The IVI signal is low |
| | | | | 1: The IVI signal is high |

Notes: 1. Only 0 can be written, to clear the flag.

2. The initial value is undefined since it depends on the pin state.

13.4 Operation

13.4.1 PWM Decoding (PDC Signal Generation)

The timer connection facility and TMR_X can be used to decode a PWM signal in which 0 and 1 are represented by the pulse width. To do this, a signal in which a rising edge is generated at regular intervals must be selected as the IHI signal.

The timer counter (TCNT) in TMR_X is set to count the internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal). The value to be used as the threshold for deciding the pulse width is written in TCORB. The PWM decoder contains a delay latch which uses the IHI signal as data and compare-match signal B (CMB) as a clock, and the state of the IHI signal (the result of the pulse width decision) at the first compare-match signal B timing after TCNT is reset by the rise of the IHI signal is output as the PDC signal.

The pulse width setting using TICRR and TICRF of TMR_X can be used to determine the pulse width decision threshold. Examples of TCR and TCORB settings of TMR_X are shown in tables 13.4 and 13.5, and the PWM decoding timing chart is shown in figure 13.2.

Table 13.4 Examples of TCR Settings

| Bit | Abbreviation | Contents | Description |
|-----------|-----------------|----------|--|
| 7 | 7 CMIEB | | Interrupts due to compare-match and overflow are |
| 6 CMIEA 0 | | 0 | disabled |
| 5 | OVIE | 0 | |
| 4 and 3 | CCLR1 and CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (IHI signal) |
| 2 to 0 | CKS2 to CKS0 | 001 | Incremented on internal clock (ø) |

Table 13.5 Examples of TCORB (Pulse Width Threshold) Settings

| | ø: 10 MHz | ø: 12 MHz | ø: 16 MHz | ø: 20 MHz |
|------|-----------|-----------|-----------|-----------|
| H'07 | 0.8 µs | 0.67 µs | 0.5 µs | 0.4 µs |
| H'0F | 1.6 µs | 1.33 µs | 1 µs | 0.8 µs |
| H'1F | 3.2 µs | 2.67 µs | 2 µs | 1.6 µs |
| H'3F | 6.4 µs | 5.33 µs | 4 µs | 3.2 µs |
| H'7F | 12.8 µs | 10.67 µs | 8 µs | 6.4 µs |
| | | · | | |

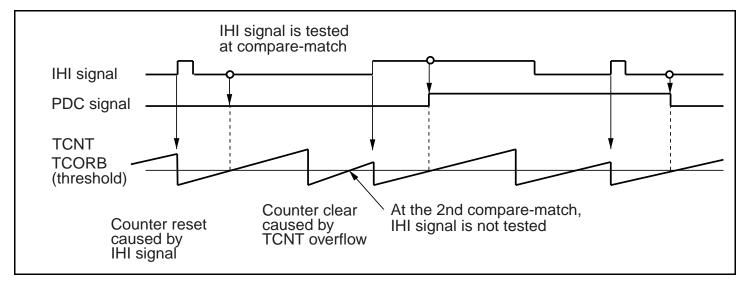


Figure 13.2 Timing Chart for PWM Decoding

13.4.2 Clamp Waveform Generation (CL1/CL2/CL3 Signal Generation)

The timer connection facility and TMR_X can be used to generate signals with different duty cycles and rising/falling edges (clamp waveforms) in synchronization with the input signal (IHI signal). Three clamp waveforms can be generated: the CL1, CL2, and CL3 signals. In addition, the CL4 signal can be generated using TMR_Y.

The CL1 signal rises simultaneously with the rise of the IHI signal, and when the CL1 signal is high, the CL2 signal rises simultaneously with the fall of the IHI signal. The fall of both the CL1 and CL2 signals can be specified by TCORA. The rise of the CL3 signal can be specified as simultaneous with the sampling of the fall of the IHI signal using the system clock, and the fall of the CL3 signal can be specified by TCORC. The CL3 signal can also fall when the IHI signal rises.

TCNT in TMR_X is set to count internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal).

The value to be used as the CL1 signal pulse width is written in TCORA. Write a value of H'02 or more in TCORA when internal clock \emptyset is selected as the TMR_X counter clock, and a value or H'01 or more when \emptyset /2 is selected. When internal clock \emptyset is selected, the CL1 signal pulse width is (TCORA set value + 3 ± 0.5). When the CL2 signal is used, the setting must be made so that this pulse width is greater than the IHI signal pulse width.

The value to be used as the CL3 signal pulse width is written in TCORC. TICR in TMR_X captures the value of TCNT at the inverse of the external reset signal edge (in this case, the falling edge of the IHI signal). The timing of the fall of the CL3 signal is determined by the sum of the contents of TICR and TCORC. Caution is required if the rising edge of the IHI signal precedes the fall timing set by the contents of TCORC, since the IHI signal will cause the CL3 signal to fall.

Examples of TCR settings of TMR_X are the same as those in table 13.4. The clamp waveform timing charts are shown in figures 13.3 and 13.4.

Since the rise of the CL1 and CL2 signals is synchronized with the edge of the IHI signal, and their fall is synchronized with the system clock, the pulse width variation is equivalent to the resolution of the system clock.

Both the rise and the fall of the CL3 signal are synchronized with the system clock and the pulse width is fixed, but there is a variation in the phase relationship with the IHI signal equivalent to the resolution of the system clock.

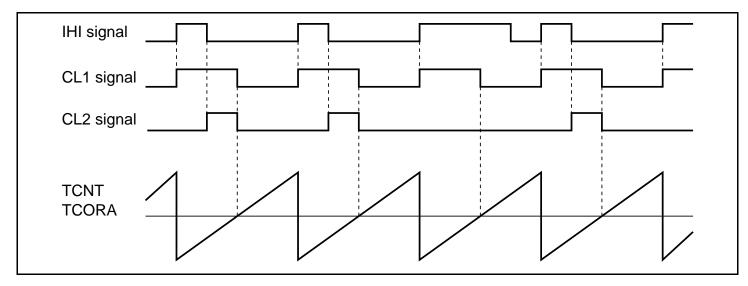


Figure 13.3 Timing Chart for Clamp Waveform Generation (CL1 and CL2 Signals)

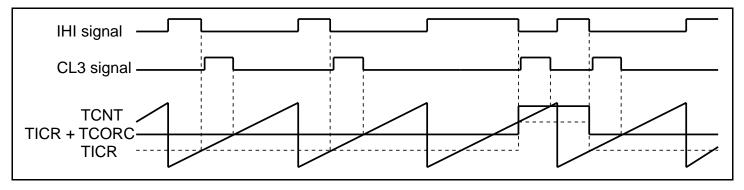


Figure 13.4 Timing Chart for Clamp Waveform Generation (CL3 Signal)

13.4.3 Measurement of 8-Bit Timer Divided Waveform Period

The timer connection facility, TMR_1, and the free-running timer (FRT) can be used to measure the period of an IHI signal divided waveform. Since TMR_1 can be cleared by a rising edge of the inverted IVI signal, the rise and fall of the IHI signal divided waveform can be synchronized with the IVI signal. This enables period measurement to be carried out efficiently.

To measure the period of an IHI signal divided waveform, TCNT in TMR_1 is set to count the external clock (IHI signal) pulses and to be cleared on the rising edge of the external reset signal (inverse of the IVI signal). The value to be used as the division factor is written in TCORA, and the TMO output method is specified by the OS bits in TCSR.

Examples of TCR and TCSR settings in TMR_1, and TCR and TCSR settings in the FRT are shown in table 13.6, and the timing chart for measurement of the IVI signal and IHI signal divided waveform periods is shown in figure 13.5. The period of the IHI signal divided waveform is given by $(ICRD(3) - ICRD(2)) \times resolution$.

Table 13.6 Examples of TCR and TCSR Settings

| Register | Bit | Abbreviation | Contents | Description |
|---------------|---------|-----------------|----------|--|
| TCR in TMR_1 | 7 | CMIEB | 0 | Interrupts due to compare-match and |
| | 6 | CMIEA | 0 | overflow are disabled |
| | 5 | OVIE | 0 | _ |
| | 4 and 3 | CCLR1 and CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (inverse of the IVI signal) |
| | 2 to 0 | CKS2 to CKS0 | 101 | TCNT is incremented on the rising edge of the external clock (IHI signal) |
| TCSR in TMR_1 | 3 to 0 | OS3 to OS0 | 0011 | Not changed by compare-match B; output inverted by compare-match A (toggle output): Division by 512 |
| | | | 1001 | When TCORB < TCORA, 1 output on compare-match B, and 0 output on compare-match A: Division by 256 |
| TCR in FRT | 6 | IEDGB | 0/1 | O: FRC value is transferred to ICRB on falling edge of input capture input B (IHI divided signal waveform) |
| | | | | 1: FRC value is transferred to ICRB on rising edge of input capture input B (IHI divided signal waveform) |
| | 1 and 0 | CKS1 and CKS0 | 01 | FRC is incremented on internal clock: ø/8 |
| TCSR in FRT | 0 | CCLRA | 0 | FRC clearing is disabled |

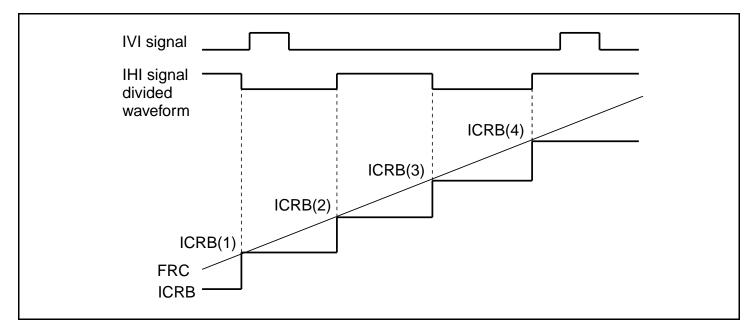


Figure 13.5 Timing Chart for Measurement of IVI Signal and IHI Signal Divided Waveform Periods

13.4.4 2fH Modification of IHI Signal

By using the timer connection facility and FRT, even if there is a part of the IHI signal with twice the frequency, this can be eliminated. In order for this function to operate properly, the duty cycle of the IHI signal must be approximately 30% or less, or approximately 70% or above.

The 8-bit OCRDM contents or twice the OCRDM contents can be added automatically to the data captured in ICRD in the FRT, and compare-matches generated at these points. The interval between the two compare-matches is called a mask interval. A value equivalent to approximately 1/3 the IHI signal period is written in OCRDM. ICRD is set so that capture is performed on the rise of the IHI signal.

Since the IHI signal supplied to the IHO signal selection circuit is normally set on the rise of the IHI signal and reset on the fall, its waveform is the same as that of the original IHI signal. When 2fH modification is selected, IHI signal edge detection is disabled during mask intervals. Capture is also disabled during these intervals.

Examples of TCR, TCSR, TOCR, and OCRDM settings in the FRT are shown in table 13.7, and the 2fH modification timing chart is shown in figure 13.6.

Table 13.7 Examples of TCR, TCSR, TOCR, and OCRDM Settings

| Register | Bit | Abbreviation | Contents | Description |
|--------------|---------|---------------------|--------------|---|
| TCR in FRT | 4 | IEDGD | 1 | FRC value is transferred to ICRD on the rising edge of input capture input D (IHI signal) |
| | 1 and 0 | CKS1 and CKS0 | 01 | FRC is incremented on internal clock: ø/8 |
| TCSR in FRT | 0 | CCLRA | 0 | FRC clearing is disabled |
| TOCR in FRT | 7 | ICRDMS | 1 | ICRD is set to the operating mode in which OCRDM is used |
| OCRDM in FRT | 7 to 0 | OCRDM7 to OCRDM0 | H'01 to H'FF | Specifies the period during which ICRD operation is masked |

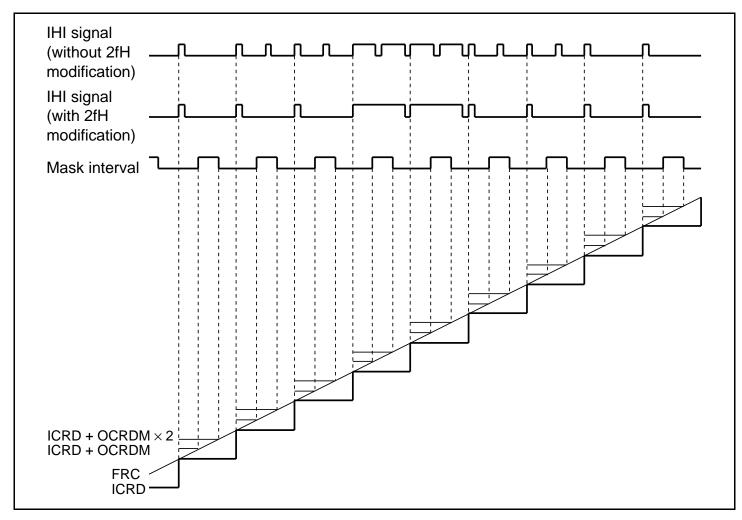


Figure 13.6 2fH Modification Timing Chart

13.4.5 IVI Signal Fall Modification and IHI Synchronization

By using the timer connection facility and TMR_1, the fall of the IVI signal can be shifted backward by the specified number of IHI signal waveforms. Also, the fall of the IVI signal can be synchronized with the rise of the IHI signal.

To perform 8-bit timer divided waveform period measurement, TCNT in TMR_1 is set to count external clock (IHI signal) pulses, and to be cleared on the rising edge of the external reset signal (inverse of the IVI signal). The number of IHI signal pulses until the fall of the IVI signal is written in TCORB.

Since the IVI signal supplied to the IVO signal selection circuit is normally set on the rise of the IVI signal and reset on the fall, its waveform is the same as that of the original IVI signal. When fall modification is selected, a reset is performed on a TMR_1 TCORB compare-match in TMR_1.

The fall of the waveform generated in this way can be synchronized with the rise of the IHI signal, regardless of whether or not fall modification is selected.

Examples of TCR, TCSR, and TCORB settings in TMR_1 are shown in table 13.8, and the fall modification/IHI synchronization timing chart is shown in figure 13.7.

Table 13.8 Examples of TCR, TCSR, and TCORB Settings

| Register | Bit | Abbreviation | Contents | Description |
|------------------|---------|--------------------|-------------------|---|
| TCR in | 7 | CMIEB | 0 | Interrupts due to compare-match and |
| TMR_1 | 6 | CMIEA | 0 | overflow are disabled |
| | 5 | OVIE | 0 | |
| | 4 and 3 | CCLR1 and CCLR0 | 11 | TCNT is cleared by the rising edge of the external reset signal (inverse of the IVI signal) |
| | 2 to 0 | CKS2 to CKS0 | 101 | TCNT is incremented on the rising edge of the external clock (IHI signal) |
| TCSR in TMR_1 | 3 to 0 | OS3 to OS0 | 0011 | Not changed by compare-match B; output inverted by compare-match A (toggle output) |
| | | | 1001 | When TCORB < TCORA, 1 output on compare-match B, 0 output on compare-match A |
| TCORB in TMR_1 | | | H'03 (example) | Compare-match on the 4th (example) rise of the IHI signal after the rise of the inverse of the IVI signal |

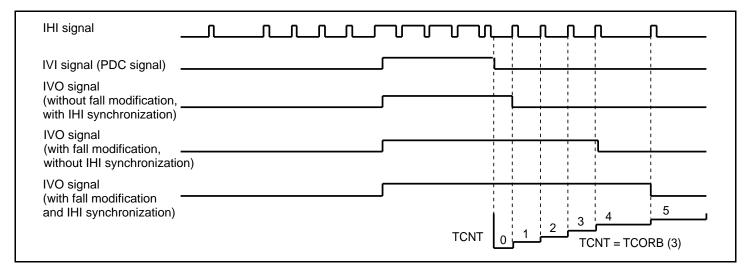


Figure 13.7 Fall Modification and IHI Synchronization Timing Chart

13.4.6 Internal Synchronization Signal Generation (IHG/IVG/CL4 Signal Generation)

By using the timer connection facility, FRT, and TMR_Y, it is possible to automatically generate internal signals (IHG and IVG signals) corresponding to the IHI and IVI signals. As the IHG signal is synchronized with the rise of the IVG signal, the IHG signal period must be made a divisor of the IVG signal period in order to keep it constant. In addition, the CL4 signal can be generated in synchronization with the IHG signal.

The contents of OCRA in the FRT are updated by the automatic addition of the contents of OCRAR or OCRAF, alternately, each time a compare-match occurs. A value corresponding to the 0 interval of the IVG signal is written in OCRAR, and a value corresponding to the 1 interval of the IVG signal is written in OCRAF. The IVG signal is set by a compare-match after an OCRAR addition, and reset by a compare-match after an OCRAF addition.

The IHG signal is the TMR_Y timer output. TMR_Y is set to count internal clock pulses, and to be cleared on a TCORA compare-match, to fix the period and set the timer output. TCORB is set so as to reset the timer output. The IVG signal is connected as the TMR_Y reset input (TMRI), and the rise of the IVG signal can be treated in the same way as a TCORA compare-match.

The CL4 signal is a waveform that rises within one system clock period after the fall of the IHG signal, and has an interval of 1 for 6 system clock periods.

Examples of TCR, TCSR, TCORA, and TCORB settings in TMR_Y, and TCR, OCRAR, OCRAF, and TOCR settings in the FRT are shown in table 13.9, and the IHG signal/IVG signal timing chart is shown in figure 13.8.

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Table 13.9 Examples of OCRAR, OCRAF, TCORA, TCORB, TCR, and TCSR Settings

| Register | Bit | Abbreviation | Contents | Description | | |
|----------------|---------|--------------------|---------------------|---|---|--|
| TCR in | 7 | CMIEB | 0 | Interrupts due to co | • | |
| TMR_Y | 6 | CMIEA | 0 | overflow are disabled | | |
| | 5 | OVIE | 0 | _ | | |
| | 4 and 3 | CCLR1 and CCLR0 | 01 | TCNT is cleared by | compare-match A | |
| | 2 to 0 | CKS2 to CKS0 | 001 | TCNT is incremented on internal clock: ø/4 | | |
| TCSR in TMR_Y | 3 to 0 | OS3 to OS0 | 0110 | 0 output on compare-match B 1 output on compare-match A | | |
| TCORA in TMR_Y | | | H'3F (example) | IHG signal period = $\emptyset \times 256$ | | |
| TCORB in TMR | R_Y | | H'03 (example) | IHG signal 1 interva | $al = \emptyset \times 16$ | |
| TCR in FRT | 1 and 0 | CKS1 and CKS0 | 01 | FRC is incremented | d on internal clock: ø/8 | |
| OCRAR in FRT | | | H'7FEF (example) | IVG signal 0 interval = ø × 262016 | IVG signal period = $\emptyset \times 262144$ (1024 times IHG signal) | |
| OCRAF in FRT | | | H'000F (example) | IVG signal 1 interval = $\emptyset \times 128$ | | |
| TOCR in FRT | 6 | OCRAMS | 1 | OCRA is set to the which OCRAR and | | |

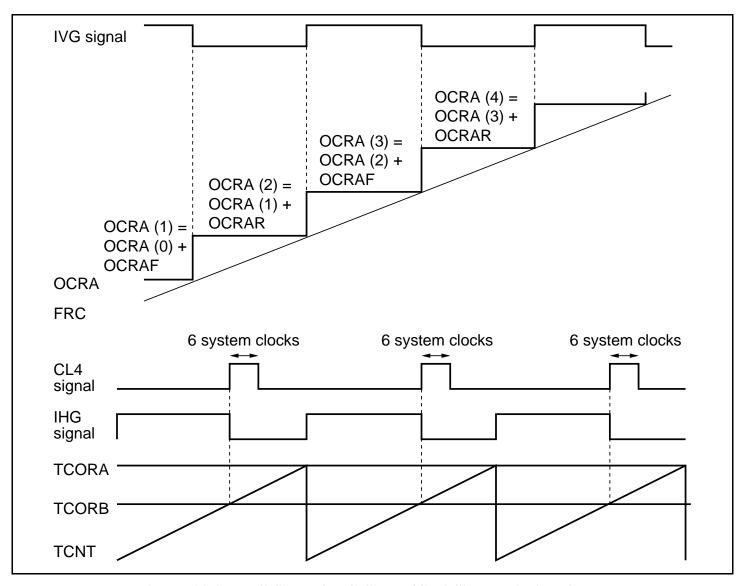


Figure 13.8 IVG Signal/IHG Signal/CL4 Signal Timing Chart

13.4.7 HSYNCO Output

With the HSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IHI signal source and the waveform required by external circuitry. The HSYNCO output modes are shown in table 13.10.

Table 13.10 HSYNCO Output Modes

| Mode | IHI Signal | IHO Signal | Meaning of IHO Signal |
|----------------|------------------|---------------------------------------|---|
| No signal | HFBACKI input | IHI signal (without 2fH modification) | HFBACKI input is output directly |
| | | IHI signal (with 2fH modification) | Meaningless unless there is a double-frequency part in the HFBACKI input |
| | | CL1 signal | HFBACKI input 1 interval is changed before output |
| | | IHG signal | Internal synchronization signal is output |
| S-on-G mode | CSYNCI input | IHI signal (without 2fH modification) | CSYNCI input (composite synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Double-frequency part of CSYNCI input (composite synchronization signal) is eliminated before output |
| | | CL1 signal | CSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output |
| | | IHG signal | Internal synchronization signal is output |
| Composite mode | HSYNCI input | IHI signal (without 2fH modification) | HSYNCI input (composite synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Double-frequency part of HSYNCI input (composite synchronization signal) is eliminated before output |
| | | CL1 signal | HSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output |
| | | IHG signal | Internal synchronization signal is output |
| Separate mode | HSYNCI input | IHI signal (without 2fH modification) | HSYNCI input (horizontal synchronization signal) is output directly |
| | | IHI signal (with 2fH modification) | Meaningless unless there is a double-frequency part in the HSYNCI input (horizontal synchronization signal) |
| | | CL1 signal | HSYNCI input (horizontal synchronization signal) 1 interval is changed before output |
| | | IHG signal | Internal synchronization signal is output |

13.4.8 VSYNCO Output

With the VSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IVI signal source and the waveform required by external circuitry. The VSYNCO output modes are shown in table 13.11.

Table 13.11 VSYNCO Output Modes

| Mode | IVI Signal | IVO Signal | Meaning of IVO Signal |
|--|------------------|--|---|
| No signal | VFBACKI input | IVI signal (without fall modification or IHI synchronization) | VFBACKI input is output directly |
| | | IVI signal (without fall modification, with IHI synchronization) | Meaningless unless VFBACKI input is synchronized with HFBACKI input |
| | | IVI signal (with fall modification, without IHI synchronization) | VFBACKI input fall is modified before output |
| n n | | IVI signal (with fall modification and IHI synchronization) | VFBACKI input fall is modified and signal is synchronized with HFBACKI input before output |
| | | IVG signal | Internal synchronization signal is output |
| S-on-G mode or composite mode | PDC signal | IVI signal (without fall modification or IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated before output |
| | | IVI signal (without fall modification, with IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and signal is synchronized with CSYNCI/HSYNCI input before output |
| | | IVI signal (with fall modification, without IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and fall is modified before output |
| | | IVI signal (with fall modification and IHI synchronization) | CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, fall is modified, and signal is synchronized with CSYNCI/HSYNCI input before output |
| | | IVG signal | Internal synchronization signal is output |

| Mode | IVI Signal | IVO Signal | Meaning of IVO Signal |
|------------------|---|--|--|
| Separate mode | • | | VSYNCI input (vertical synchronization signal) is output directly |
| | | IVI signal (without fall modification, with IHI synchronization) | Meaningless unless VSYNCI input (vertical synchronization signal) is synchronized with HSYNCI input (horizontal synchronization signal) |
| | | IVI signal (with fall modification, without IHI synchronization) | VSYNCI input (vertical synchronization signal) fall is modified before output |
| | | IVI signal (with fall modification and IHI synchronization) | VSYNCI input (vertical synchronization signal) fall is modified and signal is synchronized with HSYNCI input (horizontal synchronization signal) before output |
| | | IVG signal | Internal synchronization signal is output |

13.4.9 CBLANK Output

Using the signals generated/selected with timer connection, it is possible to generate a waveform based on the composite synchronization signal (blanking waveform).

One kind of blanking waveform is generated by combining HFBACKI and VFBACKI inputs, with the phase polarity made positive by means of bits HFINV and VFINV in TCONRI, with the IVO signal.

The logic of CBLANK output waveform generation is shown in figure 13.9.

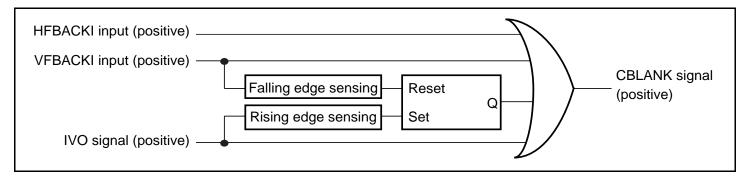


Figure 13.9 CBLANK Output Waveform Generation

13.5 Usage Note

13.5.1 Module Stop Mode Setting

Timer connection operation can be enabled or disabled using the module stop control register. The initial setting is for timer connection operation to be halted. Register access is enabled by canceling the module stop mode. For details, refer to section 26, Power-Down Modes.

Section 14 Watchdog Timer (WDT)

This LSI incorporates two watchdog timer channels (WDT_0 and WDT_1). The watchdog timer can generate an internal reset signal or an internal NMI interrupt signal if a system crash prevents the CPU from writing to the timer counter, thus allowing it to overflow. Simultaneously, it can output an overflow signal (RESO) externally.

When this watchdog function is not needed, the WDT can be used as an interval timer. In interval timer operation, an interval timer interrupt is generated each time the counter overflows. A block diagram of the WDT_0 and WDT_1 is shown in figure 14.1.

14.1 Features

- Selectable from eight (WDT_0) or 16 (WDT_1) counter input clocks.
- Switchable between watchdog timer mode and interval timer mode

Watchdog Timer Mode:

- If the counter overflows, an internal reset or an internal NMI interrupt is generated.
- When the LSI is selected to be internally reset at counter overflow, a low level signal is output from the $\overline{\text{RESO}}$ pin if the counter overflows.

Internal Timer Mode:

• If the counter overflows, an internal timer interrupt (WOVI) is generated.



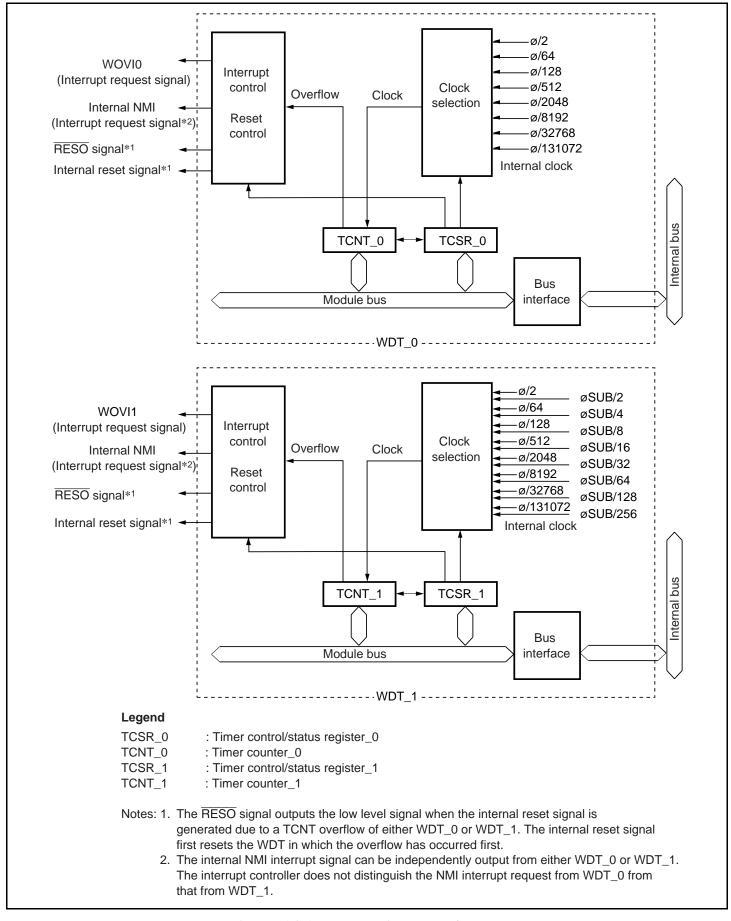


Figure 14.1 Block Diagram of WDT

14.2 Input/Output Pins

The WDT has the pins listed in table 14.1.

Table 14.1 Pin Configuration

| Name | Symbol | I/O | Function |
|------------------------------|--------|--------|--|
| Reset output pin | RESO | Output | Outputs the counter overflow signal in watchdog timer mode |
| External sub-clock input pin | EXCL | Input | Inputs the clock pulses to the WDT_1 prescaler counter |

14.3 Register Descriptions

The WDT has the following registers. To prevent accidental overwriting, TCSR and TCNT have to be written to in a method different from normal registers. For details, refer to section 14.6.1, Notes on Register Access. For details on the system control register, refer to section 3.2.2, System Control Register (SYSCR).

- Timer counter (TCNT)
- Timer control/status register (TCSR)

14.3.1 Timer Counter (TCNT)

TCNT is an 8-bit readable/writable up-counter.

TCNT is initialized to H'00 when the TME bit in the timer control/status register (TCSR) is cleared to 0.

14.3.2 Timer Control/Status Register (TCSR)

TCSR selects the clock source to be input to TCNT, and the timer mode.

• TCSR_0

| D: ₄ | D'AM. | Initial | D 444 | December 1985 |
|-----------------|-------------------|---------|---------|---|
| Bit | Bit Name | Value | R/W | Description |
| 7 | OVF | 0 | R/(W)*1 | Overflow Flag |
| | | | | Indicates that TCNT has overflowed (changes from H'FF to H'00). |
| | | | | [Setting condition] |
| | | | | When TCNT overflows (changes from H'FF to H'00) |
| | | | | However, when internal reset request generation is selected in watchdog timer mode, OVF is cleared automatically by the internal reset. |
| | | | | [Clearing conditions] |
| | | | | When TCSR is read when OVF = 1*2, then 0 is written to OVF |
| | | | | When 0 is written to TME |
| 6 | WT/ IT | 0 | R/W | Timer Mode Select |
| | | | | Selects whether the WDT is used as a watchdog timer or interval timer. |
| | | | | 0: Interval timer mode |
| | | | | 1: Watchdog timer mode |
| 5 | TME | 0 | R/W | Timer Enable |
| | | | | When this bit is set to 1, TCNT starts counting. |
| | | | | When this bit is cleared, TCNT stops counting and is initialized to H'00. |
| 4 | _ | 0 | R/(W) | Reserved |
| | | | | The initial value should not be modified. |
| 3 | RST/NMI | 0 | R/W | Reset or NMI |
| | | | | Selects to request an internal reset or an NMI interrupt when TCNT has overflowed. |
| | | | | 0: An NMI interrupt is requested |
| | | | | 1: An internal reset is requested |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | CKS2 | 0 | R/W | Clock Select 2 to 0 |
| 1 | CKS1 | 0 | R/W | Selects the clock source to be input to. The overflow |
| 0 | CKS0 | 0 | R/W | frequency for $\emptyset = 10$ MHz is enclosed in parentheses. |
| | | | | 000: ø/2 (frequency: 51.2 μs) |
| | | | | 001: ø/64 (frequency: 1.64 ms) |
| | | | | 010: ø/128 (frequency: 3.28 ms) |
| | | | | 011: ø/512 (frequency: 13.1 ms) |
| | | | | 100: ø/2048 (frequency: 52.4 ms) |
| | | | | 101: ø/8192 (frequency: 209.7 ms) |
| | | | | 110: ø/32768 (frequency: 0.84 s) |
| | | | | 111: ø/131072 (frequency: 3.36 s) |

Notes: 1. Only 0 can be written, to clear the flag.

2. When OVF is polled with the interval timer interrupt disabled, OVF = 1 must be read at least twice.

• TCSR_1

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|-------------------|---------------|---------|---|
| 7 | OVF | 0 | R/(W)*1 | Overflow Flag |
| | | | | Indicates that TCNT has overflowed (changes from H'FF to H'00). |
| | | | | [Setting condition] |
| | | | | When TCNT overflows (changes from H'FF to H'00) |
| | | | | However, when internal reset request generation is selected in watchdog timer mode, OVF is cleared automatically by the internal reset. |
| | | | | [Clearing conditions] |
| | | | | When TCSR is read when OVF = 1^{*2} , then 0 is written to OVF |
| | | | | When 0 is written to TME |
| 6 | WT/ IT | 0 | R/W | Timer Mode Select |
| | | | | Selects whether the WDT is used as a watchdog timer or interval timer. |
| | | | | 0: Interval timer mode |
| | | | | 1: Watchdog timer mode |
| 5 | TME | 0 | R/W | Timer Enable |
| | | | | When this bit is set to 1, TCNT starts counting. |
| | | | | When this bit is cleared, TCNT stops counting and is initialized to H'00. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 4 | PSS | 0 | R/W | Prescaler Select |
| | | | | Selects the clock source to be input to TCNT. |
| | | | | 0: Counts the divided cycle of ø-based prescaler (PSM) |
| | | | | Counts the divided cycle of øSUB-based prescaler (PSS) |
| 3 | RST/NMI | 0 | R/W | Reset or NMI |
| | | | | Selects to request an internal reset or an NMI interrupt when TCNT has overflowed. |
| | | | | 0: An NMI interrupt is requested |
| | | | | 1: An internal reset is requested |
| 2 | CKS2 | 0 | R/W | Clock Select 2 to 0 |
| 1 | CKS1 | 0 | R/W | Selects the clock source to be input to TCNT. The |
| 0 | CKS0 | 0 | R/W | overflow cycle for \emptyset = 10 MHz and \emptyset SUB = 32.768 kHz is enclosed in parentheses. |
| | | | | When PSS = 0: |
| | | | | 000: ø/2 (frequency: 51.2 μs) |
| | | | | 001: ø/64 (frequency: 1.64 ms) |
| | | | | 010: ø/128 (frequency: 3.28 ms) |
| | | | | 011: ø/512 (frequency: 13.1 ms) |
| | | | | 100: ø/2048 (frequency: 52.4 ms) |
| | | | | 101: ø/8192 (frequency: 209.7 ms) |
| | | | | 110: ø/32768 (frequency: 0.84 s) |
| | | | | 111: ø/131072 (frequency: 3.36 s) |
| | | | | When PSS = 1: |
| | | | | 000: øSUB/2 (cycle: 15.6 ms) |
| | | | | 001: øSUB/4 (cycle: 31.3 ms) |
| | | | | 010: øSUB/8 (cycle: 62.5 ms) |
| | | | | 011: øSUB/16 (cycle: 125 ms) |
| | | | | 100: øSUB/32 (cycle: 250 ms) |
| | | | | 101: øSUB/64 (cycle: 500 ms) |
| | | | | 110: øSUB/128 (cycle: 1 s) |
| | | | | 111: ø/256 (cycle: 2 s) |

Notes: 1. Only 0 can be written, to clear the flag.

2. When OVF is polled with the interval timer interrupt disabled, OVF = 1 must be read at least twice.

14.4 Operation

14.4.1 Watchdog Timer Mode

To use the WDT as a watchdog timer, set the WT/IT bit and the TME bit in TCSR to 1. While the WDT is used as a watchdog timer, if TCNT overflows without being rewritten because of a system malfunction or another error, an internal reset or NMI interrupt request is generated. TCNT does not overflow while the system is operating normally. Software must prevent TCNT overflows by rewriting the TCNT value (normally be writing H'00) before overflows occurs.

If the RST/NMI bit of TCSR is set to 1, when the TCNT overflows, an internal reset signal for this LSI is issued for 518 system clocks, and the low level signal is simultaneously output from the $\overline{\text{RESO}}$ pin for 132 states, as shown in figure 14.2. If the RST/ $\overline{\text{NMI}}$ bit is cleared to 0, when the TCNT overflows, an NMI interrupt request is generated. Here, the output from the $\overline{\text{RESO}}$ pin remains high.

An internal reset request from the watchdog timer and a reset input from the RES pin are processed in the same vector. Reset source can be identified by the XRST bit status in SYSCR. If a reset caused by a signal input to the \overline{RES} pin occurs at the same time as a reset caused by a WDT overflow, the \overline{RES} pin reset has priority and the XRST bit in SYSCR is set to 1.

An NMI interrupt request from the watchdog timer and an interrupt request from the NMI pin are processed in the same vector. Do not handle an NMI interrupt request from the watchdog timer and an interrupt request from the NMI pin at the same time.

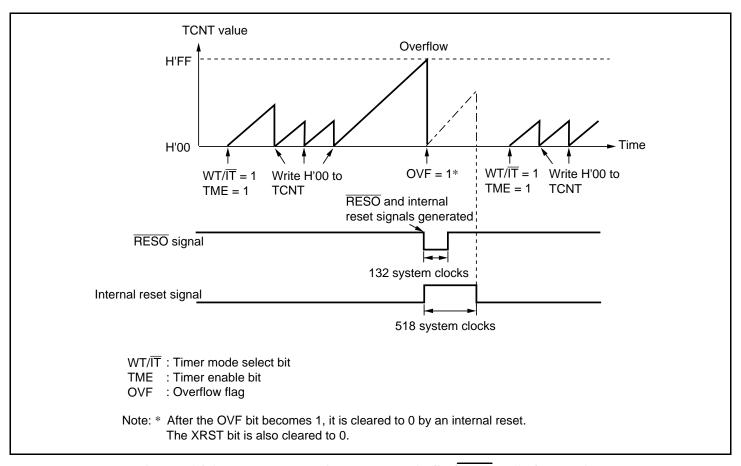


Figure 14.2 Watchdog Timer Mode (RST/ \overline{NMI} = 1) Operation

14.4.2 Interval Timer Mode

When the WDT is used as an interval timer, an interval timer interrupt (WOVI) is generated each time the TCNT overflows, as shown in figure 14.3. Therefore, an interrupt can be generated at intervals.

When the TCNT overflows in interval timer mode, an interval timer interrupt (WOVI) is requested at the same time the OVF bit of TCSR is set to 1. The timing is shown figure 14.4.

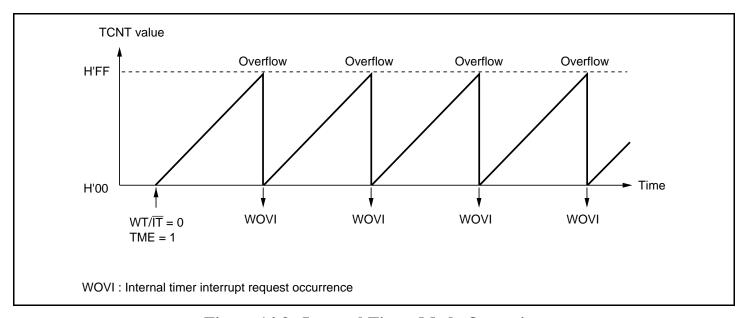


Figure 14.3 Interval Timer Mode Operation

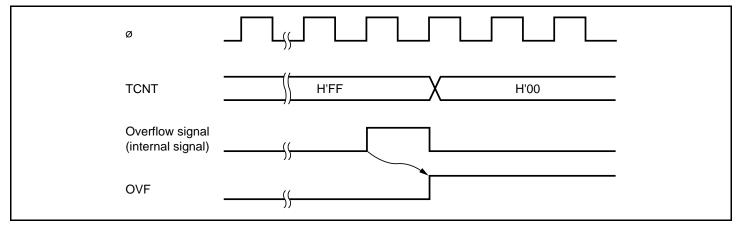


Figure 14.4 OVF Flag Set Timing

14.4.3 RESO Signal Output Timing

When TCNT overflows in watchdog timer mode, the OVF bit in TCSR is set to 1. When the RST/ $\overline{\text{NMI}}$ bit is 1 here, the internal reset signal is generated for the entire LSI. At the same time, the low level signal is output from the $\overline{\text{RESO}}$ pin. The timing is shown in figure 14.5.

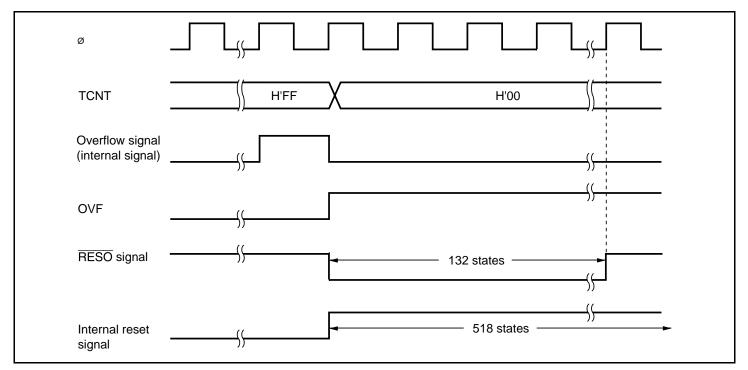


Figure 14.5 Output Timing of RESO signal

14.5 Interrupt Sources

During interval timer mode operation, an overflow generates an interval timer interrupt (WOVI). The interval timer interrupt is requested whenever the OVF flag is set to 1 in TCSR. OVF must be cleared to 0 in the interrupt handling routine.

When the NMI interrupt request is selected in watchdog timer mode, an NMI interrupt request is generated by an overflow.

Table 14.2 WDT Interrupt Source

| Name | Interrupt Source | Interrupt Flag | DTC Activation |
|------|------------------|----------------|----------------|
| WOVI | TCNT overflow | OVF | Not possible |

14.6 Usage Notes

14.6.1 Notes on Register Access

The watchdog timer's registers, TCNT and TCSR differ from other registers in being more difficult to write to. The procedures for writing to and reading from these registers are given below.

Writing to TCNT and TCSR (Example of WDT_0): These registers must be written to by a word transfer instruction. They cannot be written to by a byte transfer instruction.

TCNT and TCSR both have the same write address. Therefore, satisfy the relative condition shown in figure 14.6 to write to TCNT or TCSR. To write to TCNT, the upper bytes must contain the value H'5A and the lower bytes must contain the write data before the transfer instruction execution. To write to TCSR, the upper bytes must contain the value H'A5 and the lower bytes must contain the write data.

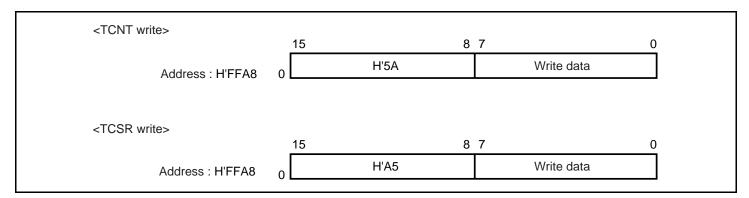


Figure 14.6 Writing to TCNT and TCSR (WDT_0)

Reading from TCNT and TCSR (Example of WDT_0): These registers are read in the same way as other registers. The read address is H'FFA8 for TCSR and H'FFA9 for TCNT.

14.6.2 Conflict between Timer Counter (TCNT) Write and Increment

If a timer counter clock pulse is generated during the T2 state of a TCNT write cycle, the write takes priority and the timer counter is not incremented. Figure 14.7 shows this operation.

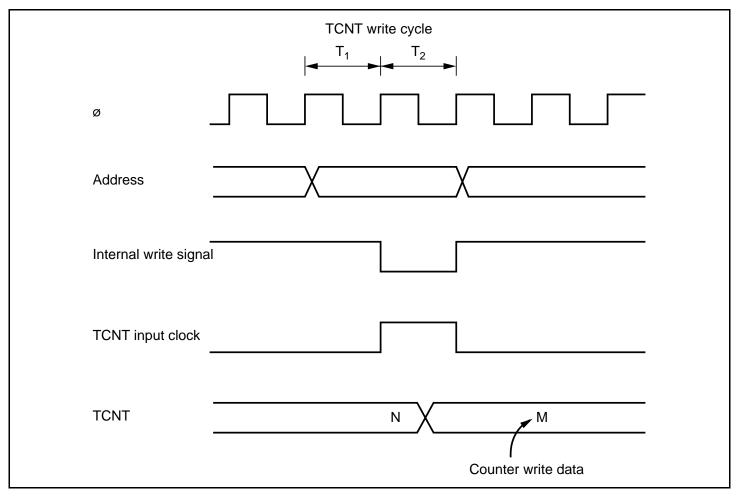


Figure 14.7 Conflict between TCNT Write and Increment

14.6.3 Changing Values of CKS2 to CKS0 Bits

If bits CKS2 to CKS0 in TCSR are written to while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before changing the values of bits CKS2 to CKS0.

14.6.4 Switching between Watchdog Timer Mode and Interval Timer Mode

If the mode is switched from watchdog timer to interval timer, while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before switching the mode.

14.6.5 System Reset by $\overline{\text{RESO}}$ Signal

Inputting the \overline{RESO} output signal to the \overline{RESO} pin of this LSI prevents the LSI from being initialized correctly; the \overline{RESO} signal must not be logically connected to the \overline{RES} pin of the LSI. To reset the entire system by the \overline{RESO} signal, use the circuit as shown in figure 14.8.

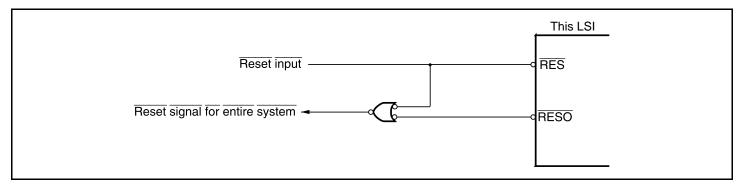


Figure 14.8 Sample Circuit for Resetting System by RESO Signal

14.6.6 Counter Values during Transitions between High-Speed, Sub-Active, and Watch Modes

When WDT_1 is used as a clock counter and is allowed to transit between high-speed mode and sub-active or watch mode, the counter does not display the correct value due to internal clock switching.

Specifically, when transiting from high-speed mode to sub-active or watch mode, that is, when the control clock for WDT_1 switches from the main clock to the sub-clock, the counter incrementing timing is delayed for approximately two to three clock cycles.

Similarly, when transiting from sub-active or watch mode to high-speed mode, the clock is not supplied until stabilized internal oscillation is available because the main clock oscillator is halted in sub-clock mode. The counter is therefore prevented from incrementing for the time specified by the STS2 to STS0 bits in SBYCR after internal oscillation starts, thus producing counter value differences for this time.

Special care must be taken when using WDT_1 as a clock counter. Note that no counter value difference is produced while operated in the same mode.

Section 15 Serial Communication Interface (SCI and IrDA)

This LSI has three independent serial communication interface (SCI) channels. The SCI can handle both asynchronous and clocked synchronous serial communication. Asynchronous serial data communication can be carried out with standard asynchronous communication chips such as a Universal Asynchronous Receiver/Transmitter (UART) or Asynchronous Communication Interface Adapter (ACIA). A function is also provided for serial communication between processors (multiprocessor communication function) in asynchronous mode.

SCI_2 can handle communication using the waveform based on the Infrared Data Association (IrDA) standard version 1.0.

15.1 **Features**

- Choice of asynchronous or clocked synchronous serial communication mode
- Full-duplex communication capability

The transmitter and receiver are mutually independent, enabling transmission and reception to be executed simultaneously. Double-buffering is used in both the transmitter and the receiver, enabling continuous transmission and continuous reception of serial data.

- The on-chip baud rate generator allows any bit rate to be selected An external clock can be selected as a transfer clock source.
- Choice of LSB-first or MSB-first transfer (except in the case of asynchronous mode 7-bit data)
- Four interrupt sources

Four interrupt sources — transmit-end, transmit-data-empty, receive-data-full, and receive error — that can issue requests.

The transmit-data-empty and receive-data-full interrupt sources can activate the DTC.

Asynchronous Mode:

- Data length: 7 or 8 bits
- Stop bit length: 1 or 2 bits
- Parity: Even, odd, or none
- Receive error detection: Parity, overrun, and framing errors
- Break detection: Break can be detected by reading the RxD pin level directly in case of a framing error

Clocked Synchronous Mode:

- Data length: 8 bits
- Receive error detection: Overrun errors
- Serial data communication with other LSIs that have the clock synchronized communication function

A block diagram of the SCI is shown in figure 15.1.

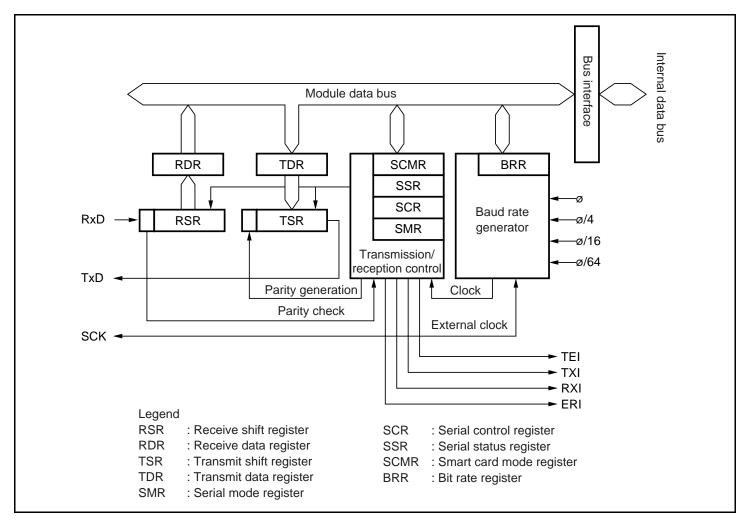


Figure 15.1 Block Diagram of SCI

15.2 Input/Output Pins

Table 15.1 shows the input/output pins for each SCI channel.

Table 15.1 Pin Configuration

| Channel | Symbol* | Input/Output | Function |
|---------|------------|--------------|--|
| 0 | SCK0 | Input/Output | Channel 0 clock input/output |
| | RxD0 | Input | Channel 0 receive data input |
| | TxD0 | Output | Channel 0 transmit data output |
| 1 | SCK1 | Input/Output | Channel 1 clock input/output |
| | RxD1 | Input | Channel 1 receive data input |
| | TxD1 | Output | Channel 1 transmit data output |
| 2 | SCK2 | Input/Output | Channel 2 clock input/output |
| | RxD2/IrRxD | Input | Channel 2 receive data input (normal/IrDA) |
| | TxD2/IrTxD | Output | Channel 2 transmit data output (normal/IrDA) |

Note:* Pin names SCK, RxD, and TxD are used in the text for all channels, omitting the channel designation.

15.3 Register Descriptions

The SCI has the following registers for each channel.

- Receive shift register (RSR)
- Receive data register (RDR)
- Transmit data register (TDR)
- Transmit shift register (TSR)
- Serial mode register (SMR)
- Serial control register (SCR)
- Serial status register (SSR)
- Serial interface mode register (SCMR)
- Bit rate register (BRR)
- Keyboard comparator control register (KBCOMP)

15.3.1 Receive Shift Register (RSR)

RSR is a shift register used to receive serial data that converts it into parallel data. When one frame of data has been received, it is transferred to RDR automatically. RSR cannot be directly accessed by the CPU.

15.3.2 Receive Data Register (RDR)

RDR is an 8-bit register that stores receive data. When the SCI has received one frame of serial data, it transfers the received serial data from RSR to RDR where it is stored. After this, RSR can receive the next data. Since RSR and RDR function as a double buffer in this way, continuous receive operations can be performed. After confirming that the RDRF bit in SSR is set to 1, read RDR for only once. RDR cannot be written to by the CPU. RDR is initialized to H'00.

15.3.3 Transmit Data Register (TDR)

TDR is an 8-bit register that stores transmit data. When the SCI detects that TSR is empty, it transfers the transmit data written in TDR to TSR and starts transmission. The double-buffered structures of TDR and TSR enables continuous serial transmission. If the next transmit data has already been written to TDR when one frame of data is transmitted, the SCI transfers the written data to TSR to continue transmission. Although TDR can be read from or written to by the CPU at all times, to achieve reliable serial transmission, write transmit data to TDR for only once after confirming that the TDRE bit in SSR is set to 1. TDR is initialized to H'FF.

15.3.4 Transmit Shift Register (TSR)

TSR is a shift register that transmits serial data. To perform serial data transmission, the SCI first transfers transmit data from TDR to TSR, then sends the data to the TxD pin. TSR cannot be directly accessed by the CPU.

15.3.5 Serial Mode Register (SMR)

SMR is used to set the SCI's serial transfer format and select the on-chip baud rate generator clock source.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | C/A | 0 | R/W | Communication Mode |
| | | | | 0: Asynchronous mode |
| | | | | 1: Clocked synchronous mode |
| 6 | CHR | 0 | R/W | Character Length (enabled only in asynchronous mode) |
| | | | | 0: Selects 8 bits as the data length. |
| | | | | 1: Selects 7 bits as the data length. LSB-first is fixed and the MSB of TDR is not transmitted in transmission. |
| | | | | In clocked synchronous mode, a fixed data length of 8 bits is used. |
| 5 | PE | 0 | R/W | Parity Enable (enabled only in asynchronous mode) |
| | | | | When this bit is set to 1, the parity bit is added to transmit data before transmission, and the parity bit is checked in reception. For a multiprocessor format, parity bit addition and checking are not performed regardless of the PE bit setting. |
| 4 | O/Ē | 0 | R/W | Parity Mode (enabled only when the PE bit is 1 in asynchronous mode) |
| | | | | 0: Selects even parity. |
| | | | | 1: Selects odd parity. |

RENESAS

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 3 | STOP | 0 | R/W | Stop Bit Length (enabled only in asynchronous mode) |
| | | | | Selects the stop bit length in transmission. |
| | | | | 0: 1 stop bit |
| | | | | 1: 2 stop bits |
| | | | | In reception, only the first stop bit is checked. If the second stop bit is 0, it is treated as the start bit of the next transmit frame. |
| 2 | MP | 0 | R/W | Multiprocessor Mode (enabled only in asynchronous mode) |
| | | | | When this bit is set to 1, the multiprocessor communication function is enabled. The PE bit and O/\overline{E} bit settings are invalid in multiprocessor mode. |
| 1 | CKS1 | 0 | R/W | Clock Select 1,0 |
| 0 | CKS0 | 0 | R/W | These bits select the clock source for the on-chip baud rate generator. |
| | | | | 00: ø clock (n = 0) |
| | | | | 01: ø/4 clock (n = 1) |
| | | | | 10: ø/16 clock (n = 2) |
| | | | | 11: ø/64 clock (n = 3) |
| | | | | For the relation between the bit rate register setting and the baud rate, see section 15.3.9, Bit Rate Register (BRR). n is the decimal display of the value of n in BRR. |

15.3.6 Serial Control Register (SCR)

SCR is a register that performs enabling or disabling of SCI transfer operations and interrupt requests, and selection of the transfer clock source. For details on interrupt requests, refer to section 15.8, Interrupt Sources.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | TIE | 0 | R/W | Transmit Interrupt Enable |
| | | | | When this bit is set to 1, a TXI interrupt request is enabled. |
| 6 | RIE | 0 | R/W | Receive Interrupt Enable |
| | | | | When this bit is set to 1, RXI and ERI interrupt requests are enabled. |
| 5 | TE | 0 | R/W | Transmit Enable |
| | | | | When this bit is set to 1, transmission is enabled. |
| 4 | RE | 0 | R/W | Receive Enable |
| | | | | When this bit is set to 1, reception is enabled. |
| 3 | MPIE | 0 | R/W | Multiprocessor Interrupt Enable (enabled only when the MP bit in SMR is 1 in asynchronous mode) |
| | | | | When this bit is set to 1, receive data in which the multiprocessor bit is 0 is skipped, and setting of the RDRF, FER, and ORER status flags in SSR is disabled. On receiving data in which the multiprocessor bit is 1, this bit is automatically cleared and normal reception is resumed. For details, refer to section 15.5, Multiprocessor Communication Function. |
| 2 | TEIE | 0 | R/W | Transmit End Interrupt Enable |
| | | | | When this bit is set to 1, a TEI interrupt request is enabled. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 1 | CKE1 | 0 | R/W | Clock Enable 1, 0 |
| 0 | CKE0 | 0 | R/W | These bits select the clock source and SCK pin function. |
| | | | | Asynchronous mode |
| | | | | 00: Internal clock |
| | | | | (SCK pin functions as I/O port.) |
| | | | | 01: Internal clock |
| | | | | (Outputs a clock of the same frequency as the bit rate from the SCK pin.) |
| | | | | 1X: External clock |
| | | | | (Inputs a clock with a frequency 16 times the bit rate from the SCK pin.) |
| | | | | Clocked synchronous mode |
| | | | | 0X: Internal clock (SCK pin functions as clock output.) |
| | | | | 1X: External clock (SCK pin functions as clock input.) |

Legend

X: Don't care

15.3.7 Serial Status Register (SSR)

SSR is a register containing status flags of the SCI and multiprocessor bits for transfer. TDRE, RDRF, ORER, PER, and FER can only be cleared.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 7 | TDRE | 1 | R/(W)* | Transmit Data Register Empty Indicates whether TDR contains transmit data. [Setting conditions] • When the TE bit in SCR is 0 • When data is transferred from TDR to TSR and TDR is ready for data write [Clearing conditions] • When 0 is written to TDRE after reading TDRE = 1 • When a TXI interrupt request is issued |
| 6 | RDRF | 0 | R/(W)* | allowing the DTC to write data to TDR Receive Data Register Full Indicates that receive data is stored in RDR. [Setting condition] • When serial reception ends normally and receive data is transferred from RSR to RDR [Clearing conditions] • When 0 is written to RDRF after reading RDRF = 1 • When an RXI interrupt request is issued allowing the DTC to read data from RDR The RDRF flag is not affected and retains its previous value when the RE bit in SCR is cleared to 0. |
| 5 | ORER | 0 | R/(W)* | Overrun Error [Setting condition] • When the next data is received while RDRF = 1 [Clearing condition] • When 0 is written to ORER after reading ORER = 1 |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 4 | FER | 0 | R/(W)* | Framing Error |
| | | | | [Setting condition] |
| | | | | When the stop bit is 0 |
| | | | | [Clearing condition] |
| | | | | When 0 is written to FER after reading FER = 1 |
| | | | | In 2-stop-bit mode, only the first stop bit is checked. |
| 3 | PER | 0 | R/(W)* | Parity Error |
| | | | | [Setting condition] |
| | | | | When a parity error is detected during reception |
| | | | | [Clearing condition] |
| | | | | When 0 is written to PER after reading PER = 1 |
| 2 | TEND | 1 | R | Transmit End |
| | | | | [Setting conditions] |
| | | | | When the TE bit in SCR is 0 |
| | | | | When TDRE = 1 at transmission of the last bit of a 1-byte serial transmit character |
| | | | | [Clearing conditions] |
| | | | | When 0 is written to TDRE after reading TDRE = 1 |
| | | | | When a TXI interrupt request is issued allowing the DTC to write data to TDR |
| 1 | MPB | 0 | R | Multiprocessor Bit |
| | | | | MPB stores the multiprocessor bit in the receive frame. When the RE bit in SCR is cleared to 0 its previous state is retained. |
| 0 | MPBT | 0 | R/W | Multiprocessor Bit Transfer |
| | | | | MPBT stores the multiprocessor bit to be added to the transmit frame. |

Note:* Only 0 can be written, to clear the flag.

15.3.8 Serial Interface Mode Register (SCMR)

SCMR selects SCI functions and its format.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|---|
| 7 to | _ | All 1 | R | Reserved |
| 4 | | | | These bits are always read as 1 and cannot be modified. |
| 3 | SDIR | 0 | R/W | Data Transfer Direction |
| | | | | Selects the serial/parallel conversion format. |
| | | | | 0: TDR contents are transmitted with LSB-first. |
| | | | | Receive data is stored as LSB first in RDR. |
| | | | | 1: TDR contents are transmitted with MSB-first. |
| | | | | Receive data is stored as MSB first in RDR. |
| | | | | The SDIR bit is valid only when the 8-bit data format is used for transmission/reception; when the 7-bit data format is used, data is always transmitted/received with LSB-first. |
| 2 | SINV | 0 | R/W | Data Invert |
| | | | | Specifies inversion of the data logic level. The SINV bit does not affect the logic level of the parity bit. When the parity bit is inverted, invert the O/E bit in SMR. |
| | | | | 0: TDR contents are transmitted as they are. Receive data is stored as it is in RDR. |
| | | | | 1: TDR contents are inverted before being transmitted. Receive data is stored in inverted form in RDR. |
| 1 | _ | 1 | R | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |
| 0 | SMIF | 0 | R/W | Serial Communication Interface Mode Select: |
| | | | | 0: Normal asynchronous or clocked synchronous mode |
| | | | | 1: Reserved mode |

15.3.9 Bit Rate Register (BRR)

BRR is an 8-bit register that adjusts the bit rate. As the SCI performs baud rate generator control independently for each channel, different bit rates can be set for each channel. Table 15.2 shows the relationships between the N setting in BRR and bit rate B for normal asynchronous mode and clocked synchronous mode. The initial value of BRR is H'FF, and it can be read from or written to by the CPU at all times.

Table 15.2 Relationships between N Setting in BRR and Bit Rate B

| Mode | Bit Rate | Error |
|--------------------------|---|---|
| Asynchronous mode | B = $\frac{\emptyset \times 10^{6}}{64 \times 2^{2n-1} \times (N+1)}$ | Error (%) = { $\frac{\varnothing \times 10^6}{B \times 64 \times 2^{2n-1} \times (N+1)}$ -1} \tag{-1} |
| Clocked synchronous mode | $B = \frac{\emptyset \times 10^{6}}{64 \times 2^{2n-1} \times (N+1)}$ | _ |

Legend

B: Bit rate (bit/s)

N: BRR setting for baud rate generator $(0 \le N \le 255)$

ø: Operating frequency (MHz)

n: Determined by the SMR settings shown in the following table.

SMR Setting

| CKS1 | CKS0 | n | |
|------|------|---|--|
| 0 | 0 | 0 | |
| 0 | 1 | 1 | |
| 1 | 0 | 2 | |
| 1 | 1 | 3 | |

Table 15.3 shows sample N settings in BRR in normal asynchronous mode. Table 15.4 shows the maximum bit rate settable for each frequency. Table 15.6 shows sample N settings in BRR in clocked synchronous mode. Tables 15.5 and 15.7 show the maximum bit rates with external clock input.

Table 15.3 BRR Settings for Various Bit Rates (Asynchronous Mode)

Operating Frequency ø (MHz)

| | | 2 | | | 2.097 | 152 | | 2.45 | 76 | | 3 | |
|------------------|---|-----|--------------|---|-------|--------------|---|------|--------------|---|-----|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 1 | 141 | 0.03 | 1 | 148 | -0.04 | 1 | 174 | -0.26 | 1 | 212 | 0.03 |
| 150 | 1 | 103 | 0.16 | 1 | 108 | 0.21 | 1 | 127 | 0.00 | 1 | 155 | 0.16 |
| 300 | 0 | 207 | 0.16 | 0 | 217 | 0.21 | 0 | 255 | 0.00 | 1 | 77 | 0.16 |
| 600 | 0 | 103 | 0.16 | 0 | 108 | 0.21 | 0 | 127 | 0.00 | 0 | 155 | 0.16 |
| 1200 | 0 | 51 | 0.16 | 0 | 54 | -0.70 | 0 | 63 | 0.00 | 0 | 77 | 0.16 |
| 2400 | 0 | 25 | 0.16 | 0 | 26 | 1.14 | 0 | 31 | 0.00 | 0 | 38 | 0.16 |
| 4800 | 0 | 12 | 0.16 | 0 | 13 | -2.48 | 0 | 15 | 0.00 | 0 | 19 | -2.34 |
| 9600 | | _ | | 0 | 6 | -2.48 | 0 | 7 | 0.00 | 0 | 9 | -2.34 |
| 19200 | _ | _ | _ | _ | _ | _ | 0 | 3 | 0.00 | 0 | 4 | -2.34 |
| 31250 | 0 | 1 | 0.00 | _ | _ | _ | _ | _ | _ | 0 | 2 | 0.00 |
| 38400 | _ | _ | _ | _ | _ | _ | 0 | 1 | 0.00 | _ | _ | |

Operating Frequency ø (MHz)

| | | 3.68 | 64 | | 4 | | | 4.91 | 52 | | 5 | |
|------------------|---|------|--------------|---|-----|--------------|---|------|--------------|---|-----|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 64 | 0.70 | 2 | 70 | 0.03 | 2 | 86 | 0.31 | 2 | 88 | -0.25 |
| 150 | 1 | 191 | 0.00 | 1 | 207 | 0.16 | 1 | 255 | 0.00 | 2 | 64 | 0.16 |
| 300 | 1 | 95 | 0.00 | 1 | 103 | 0.16 | 1 | 127 | 0.00 | 1 | 129 | 0.16 |
| 600 | 0 | 191 | 0.00 | 0 | 207 | 0.16 | 0 | 255 | 0.00 | 1 | 64 | 0.16 |
| 1200 | 0 | 95 | 0.00 | 0 | 103 | 0.16 | 0 | 127 | 0.00 | 0 | 129 | 0.16 |
| 2400 | 0 | 47 | 0.00 | 0 | 51 | 0.16 | 0 | 63 | 0.00 | 0 | 64 | 0.16 |
| 4800 | 0 | 23 | 0.00 | 0 | 25 | 0.16 | 0 | 31 | 0.00 | 0 | 32 | -1.36 |
| 9600 | 0 | 11 | 0.00 | 0 | 12 | 0.16 | 0 | 15 | 0.00 | 0 | 15 | 1.73 |
| 19200 | 0 | 5 | 0.00 | | | | 0 | 7 | 0.00 | 0 | 7 | 1.73 |
| 31250 | _ | _ | | 0 | 3 | 0.00 | 0 | 4 | -1.70 | 0 | 4 | 0.00 |
| 38400 | 0 | 2 | 0.00 | _ | _ | _ | 0 | 3 | 0.00 | 0 | 3 | 1.73 |

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Legend

Note:* Make the settings so that the error does not exceed 1%.

^{—:} Can be set, but there will be a degree of error.

Operating Frequency ø (MHz)

| | 6 | | | | 6.14 | 14 | | 7.37 | '28 | | 8 | |
|------------------|---|-----|--------------|---|------|--------------|---|------|--------------|---|-----|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 106 | -0.44 | 2 | 108 | 0.08 | 2 | 130 | -0.07 | 2 | 141 | 0.03 |
| 150 | 2 | 77 | 0.16 | 2 | 79 | 0.00 | 2 | 95 | 0.00 | 2 | 103 | 0.16 |
| 300 | 1 | 155 | 0.16 | 1 | 159 | 0.00 | 1 | 191 | 0.00 | 1 | 207 | 0.16 |
| 600 | 1 | 77 | 0.16 | 1 | 79 | 0.00 | 1 | 95 | 0.00 | 1 | 103 | 0.16 |
| 1200 | 0 | 155 | 0.16 | 0 | 159 | 0.00 | 0 | 191 | 0.00 | 0 | 207 | 0.16 |
| 2400 | 0 | 77 | 0.16 | 0 | 79 | 0.00 | 0 | 95 | 0.00 | 0 | 103 | 0.16 |
| 4800 | 0 | 38 | 0.16 | 0 | 39 | 0.00 | 0 | 47 | 0.00 | 0 | 51 | 0.16 |
| 9600 | 0 | 19 | -2.34 | 0 | 19 | 0.00 | 0 | 23 | 0.00 | 0 | 25 | 0.16 |
| 19200 | 0 | 9 | -2.34 | 0 | 9 | 0.00 | 0 | 11 | 0.00 | 0 | 12 | 0.16 |
| 31250 | 0 | 5 | 0.00 | 0 | 5 | 2.40 | | | _ | 0 | 7 | 0.00 |
| 38400 | 0 | 4 | -2.34 | 0 | 4 | 0.00 | 0 | 5 | 0.00 | _ | _ | |

Operating Frequency ø (MHz)

| | | 9.83 | 04 | | 10 | | | 12 | 2 | | 12.2 | 88 |
|---------------------|---|------|--------------|---|-----|--------------|---|-----|--------------|---|------|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 174 | -0.26 | 2 | 177 | -0.25 | 2 | 212 | 0.03 | 2 | 217 | 0.08 |
| 150 | 2 | 127 | 0.00 | 2 | 129 | 0.16 | 2 | 155 | 0.16 | 2 | 159 | 0.00 |
| 300 | 1 | 255 | 0.00 | 2 | 64 | 0.16 | 2 | 77 | 0.16 | 2 | 79 | 0.00 |
| 600 | 1 | 127 | 0.00 | 1 | 129 | 0.16 | 1 | 155 | 0.16 | 1 | 159 | 0.00 |
| 1200 | 0 | 255 | 0.00 | 1 | 64 | 0.16 | 1 | 77 | 0.16 | 1 | 79 | 0.00 |
| 2400 | 0 | 127 | 0.00 | 0 | 129 | 0.16 | 0 | 155 | 0.16 | 0 | 159 | 0.00 |
| 4800 | 0 | 63 | 0.00 | 0 | 64 | 0.16 | 0 | 77 | 0.16 | 0 | 79 | 0.00 |
| 9600 | 0 | 31 | 0.00 | 0 | 32 | -1.36 | 0 | 38 | 0.16 | 0 | 39 | 0.00 |
| 19200 | 0 | 15 | 0.00 | 0 | 15 | 1.73 | 0 | 19 | -2.34 | 0 | 19 | 0.00 |
| 31250 | 0 | 9 | -1.70 | 0 | 9 | 0.00 | 0 | 11 | 0.00 | 0 | 11 | 2.40 |
| 38400 | 0 | 7 | 0.00 | 0 | 7 | 1.73 | 0 | 9 | -2.34 | 0 | 9 | 0.00 |

Legend

—: Can be set, but there will be a degree of error.

Note:* Make the settings so that the error does not exceed 1%.

Operating Frequency ø (MHz)

| | | 14 | | | 14.74 | 456 | | 16 | 6 | | 17.20 | 32 |
|------------------|---|-----|--------------|---|-------|--------------|---|-----|--------------|---|-------|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 2 | 248 | -0.17 | 3 | 64 | 0.70 | 3 | 70 | 0.03 | 3 | 75 | 0.48 |
| 150 | 2 | 181 | 0.16 | 2 | 191 | 0.00 | 2 | 207 | 0.16 | 2 | 223 | 0.00 |
| 300 | 2 | 90 | 0.16 | 2 | 95 | 0.00 | 2 | 103 | 0.16 | 2 | 111 | 0.00 |
| 600 | 1 | 181 | 0.16 | 1 | 191 | 0.00 | 1 | 207 | 0.16 | 1 | 223 | 0.00 |
| 1200 | 1 | 90 | 0.16 | 1 | 95 | 0.00 | 1 | 103 | 0.16 | 1 | 111 | 0.00 |
| 2400 | 0 | 181 | 0.16 | 0 | 191 | 0.00 | 0 | 207 | 0.16 | 0 | 223 | 0.00 |
| 4800 | 0 | 90 | 0.16 | 0 | 95 | 0.00 | 0 | 103 | 0.16 | 0 | 111 | 0.00 |
| 9600 | 0 | 45 | -0.93 | 0 | 47 | 0.00 | 0 | 51 | 0.16 | 0 | 55 | 0.00 |
| 19200 | 0 | 22 | -0.93 | 0 | 23 | 0.00 | 0 | 25 | 0.16 | 0 | 27 | 0.00 |
| 31250 | 0 | 13 | 0.00 | 0 | 14 | -1.70 | 0 | 15 | 0.00 | 0 | 16 | 1.20 |
| 38400 | _ | _ | _ | 0 | 11 | 0.00 | 0 | 12 | 0.16 | 0 | 16 | 0.00 |

Operating Frequency ø (MHz)

| | | 18 | | | 19.66 | 808 | | 20 |) |
|---------------------|---|-----|--------------|---|-------|--------------|---|-----|--------------|
| Bit Rate (bit/s) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 3 | 79 | -0.12 | 3 | 86 | 0.31 | 3 | 88 | -0.25 |
| 150 | 2 | 233 | 0.16 | 2 | 255 | 0.00 | 3 | 64 | 0.16 |
| 300 | 2 | 116 | 0.16 | 2 | 127 | 0.00 | 2 | 129 | 0.16 |
| 600 | 1 | 233 | 0.16 | 1 | 255 | 0.00 | 2 | 64 | 0.16 |
| 1200 | 1 | 166 | 0.16 | 1 | 127 | 0.00 | 1 | 129 | 0.16 |
| 2400 | 0 | 233 | 0.16 | 0 | 255 | 0.00 | 1 | 64 | 0.16 |
| 4800 | 0 | 166 | 0.16 | 0 | 127 | 0.00 | 0 | 129 | 0.16 |
| 9600 | 0 | 58 | -0.69 | 0 | 63 | 0.00 | 0 | 64 | 0.16 |
| 19200 | 0 | 28 | 1.02 | 0 | 31 | 0.00 | 0 | 32 | -1.36 |
| 31250 | 0 | 17 | 0.00 | 0 | 19 | -1.70 | 0 | 19 | 0.00 |
| 38400 | 0 | 14 | -2.34 | 0 | 15 | 0.00 | 0 | 15 | 1.73 |

Legend

—: Can be set, but there will be a degree of error.

Note:* Make the settings so that the error does not exceed 1%.



Table 15.4 Maximum Bit Rate for Each Frequency (Asynchronous Mode)

| ø (MHz) | Maximum Bit Rate (bit/s) | n | N | ø (MHz) | Maximum Bit Rate (bit/s) | n | N |
|----------|--------------------------------|---|---|---------|--------------------------------|---|---|
| 2 | 62500 | 0 | 0 | 9.8304 | 307200 | 0 | 0 |
| 2.097152 | 65536 | 0 | 0 | 10 | 312500 | 0 | 0 |
| 2.4576 | 76800 | 0 | 0 | 12 | 375000 | 0 | 0 |
| 3 | | 0 | | | | 0 | 0 |
| | 93750 | | 0 | 12.288 | 384000 | | |
| 3.6864 | 115200 | 0 | 0 | 14 | 437500 | 0 | 0 |
| 4 | 125000 | 0 | 0 | 14.7456 | 460800 | 0 | 0 |
| 4.9152 | 153600 | 0 | 0 | 16 | 500000 | 0 | 0 |
| 5 | 156250 | 0 | 0 | 17.2032 | 537600 | 0 | 0 |
| 6 | 187500 | 0 | 0 | 18 | 562500 | 0 | 0 |
| 6.144 | 192000 | 0 | 0 | 19.6608 | 614400 | 0 | 0 |
| 7.3728 | 230400 | 0 | 0 | 20 | 625000 | 0 | 0 |
| 8 | 250000 | 0 | 0 | | | | |

Table 15.5 Maximum Bit Rate with External Clock Input (Asynchronous Mode)

| ø (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bit/s) | ø (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bit/s) |
|----------|-------------------------------|-----------------------------|---------|-------------------------------|-----------------------------|
| 2 | 0.5000 | 31250 | 9.8304 | 2.4576 | 153600 |
| 2.097152 | 0.5243 | 32768 | 10 | 2.5000 | 156250 |
| 2.4576 | 0.6144 | 38400 | 12 | 3.0000 | 187500 |
| 3 | 0.7500 | 46875 | 12.288 | 3.0720 | 192000 |
| 3.6864 | 0.9216 | 57600 | 14 | 3.5000 | 218750 |
| 4 | 1.0000 | 62500 | 14.7456 | 3.6864 | 230400 |
| 4.9152 | 1.2288 | 76800 | 16 | 4.0000 | 250000 |
| 5 | 1.2500 | 78125 | 17.2032 | 4.3008 | 268800 |
| 6 | 15.000 | 93750 | 18 | 4.5000 | 281250 |
| 6.144 | 1.5360 | 96000 | 19.6608 | 4.9152 | 307200 |
| 7.3728 | 1.8432 | 115200 | 20 | 5.0000 | 312500 |
| 8 | 2.0000 | 125000 | | | |

Table 15.6 BRR Settings for Various Bit Rates (Clocked Synchronous Mode)

| D:4 | | | | | | | | | | | | |
|------------------------|---|-----|---|-----|---|-----|---|-----|---|-----|---|-----|
| Bit Rate (bit/s) | | 2 | | 4 | | 8 | , | 10 | | 16 | | 20 |
| | n | N | n | N | n | N | n | N | n | N | n | N |
| 110 | 3 | 70 | | | | | | | | | | |
| 250 | 2 | 124 | 2 | 249 | 3 | 124 | _ | _ | 3 | 249 | | |
| 500 | 1 | 249 | 2 | 124 | 2 | 249 | _ | _ | 3 | 124 | _ | _ |
| 1k | 1 | 124 | 1 | 249 | 2 | 124 | _ | _ | 2 | 249 | _ | _ |
| 2.5k | 0 | 199 | 1 | 99 | 1 | 199 | 1 | 249 | 2 | 99 | 2 | 124 |
| 5k | 0 | 99 | 0 | 199 | 1 | 99 | 1 | 124 | 1 | 199 | 1 | 249 |
| 10k | 0 | 49 | 0 | 99 | 0 | 199 | 0 | 249 | 1 | 99 | 1 | 124 |
| 25k | 0 | 19 | 0 | 39 | 0 | 79 | 0 | 99 | 0 | 159 | 0 | 199 |
| 50k | 0 | 9 | 0 | 19 | 0 | 39 | 0 | 49 | 0 | 79 | 0 | 99 |
| 100k | 0 | 4 | 0 | 9 | 0 | 19 | 0 | 24 | 0 | 39 | 0 | 49 |
| 250k | 0 | 1 | 0 | 3 | 0 | 7 | 0 | 9 | 0 | 15 | 0 | 19 |
| 500k | 0 | 0* | 0 | 1* | 0 | 3 | 0 | 4 | 0 | 7 | 0 | 9 |
| 1M | | | 0 | 0 | 0 | 1 | | | 0 | 3 | 0 | 4 |
| 2.5M | | | | | | | 0 | 0* | | | 0 | 1 |
| 5M | | | | | | | | | | | 0 | 0* |
| | | | | | | | | | | | | |

Legend

Blank: Cannot be set.

—: Can be set, but there will be a degree of error.

*: Continuous transfer or reception is not possible.

Table 15.7 Maximum Bit Rate with External Clock Input (Clocked Synchronous Mode)

| ø (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bit/s) | ø (MHz) | External Input Clock (MHz) | Maximum Bit Rate (bit/s) |
|---------|-------------------------------|-----------------------------|---------|-------------------------------|-----------------------------|
| 2 | 0.3333 | 333333.3 | 12 | 2.0000 | 2000000.0 |
| 4 | 0.6667 | 666666.7 | 14 | 2.3333 | 2333333.3 |
| 6 | 1.0000 | 1000000.0 | 16 | 2.6667 | 2666666.7 |
| 8 | 1.3333 | 1333333.3 | 18 | 3.0000 | 3000000.0 |
| 10 | 1.6667 | 1666666.7 | 20 | 3.3333 | 3333333.3 |

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15.3.10 Keyboard Comparator Control Register (KBCOMP)

KBCOMP selects the functions of the SCI and A/D converter.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------------|---------------|------------|--|
| 7 | IrE | 0 | R/W | IrDA Enable |
| | | | | Specifies SCI_2 I/O pins for either normal SCI or IrDA. |
| | | | | 0: TxD2/IrTxD and RxD2/IrRxD pins function as TxD2 and RxD2 pins, respectively |
| | | | | 1: TxD2/IrTxD and RxD2/IrRxD pins function as IrTxD and IrRxD pins, respectively |
| 6 | IrCKS2 | 0 | R/W | IrDA Clock Select 2 to 0 |
| 5 4 | | | R/W R/W | These bits specify the high-level width of the clock pulse during IrTxD output pulse encoding when the IrDA function is enabled. |
| | | | | 000: B × 3/16 (B: Bit rate) |
| | | | | 001: ø/2 |
| | | | | 010: ø /4 |
| | | | | 011: ø /8 |
| | | | | 100: ø /16 |
| | | | | 101: ø /32 |
| | | | | 110: ø /64 |
| | | | | 111: ø /128 |
| 3 | KBADE | 0 | R/W | Bits related to the A/D converter |
| 2 | KBCH2 | 0 | R/W | For details, refer to section 21.3.4, Keyboard |
| 1 0 | KBCH1 KBCH0 | 0 | R/W R/W | Comparator Control Register (KBCOMP). |

15.4 Operation in Asynchronous Mode

Figure 15.2 shows the general format for asynchronous serial communication. One frame consists of a start bit (low level), followed by transmit/receive data, a parity bit, and finally stop bits (high level). In asynchronous serial communication, the transmission line is usually held in the mark state (high level). The SCI monitors the transmission line, and when it goes to the space state (low level), recognizes a start bit and starts serial communication. Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication. Both the transmitter and the receiver also have a double-buffered structure, so that data can be read or written during transmission or reception, enabling continuous data transfer and reception.

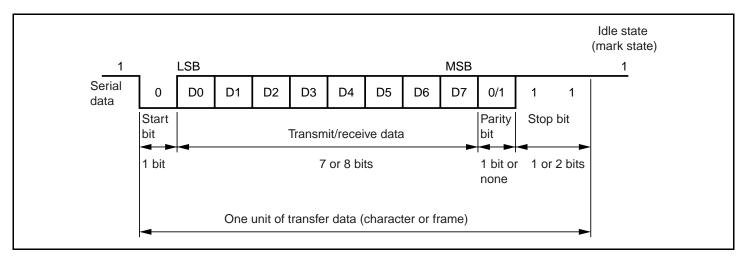


Figure 15.2 Data Format in Asynchronous Communication (Example with 8-Bit Data, Parity, Two Stop Bits)

15.4.1 Data Transfer Format

Table 15.8 shows the data transfer formats that can be used in asynchronous mode. Any of 12 transfer formats can be selected according to the SMR setting. For details on the multiprocessor bit, refer to section 15.5, Multiprocessor Communication Function.

Table 15.8 Serial Transfer Formats (Asynchronous Mode)

| SMR Settings | | | | Serial Transmit/Receive Format and Frame Length | | | |
|--------------|----|----|------|---|--|--|--|
| CHR | PE | MP | STOP | 1 2 3 4 5 6 7 8 9 10 11 12 | | | |
| 0 | 0 | 0 | 0 | S 8-bit data STOP | | | |
| 0 | 0 | 0 | 1 | S 8-bit data STOP STOP | | | |
| 0 | 1 | 0 | 0 | S 8-bit data P STOP | | | |
| 0 | 1 | 0 | 1 | S 8-bit data P STOP STOP | | | |
| 1 | 0 | 0 | 0 | S 7-bit data STOP | | | |
| 1 | 0 | 0 | 1 | S 7-bit data STOP STOP | | | |
| 1 | 1 | 0 | 0 | S 7-bit data P STOP | | | |
| 1 | 1 | 0 | 1 | S 7-bit data P STOP STOP | | | |
| 0 | _ | 1 | 0 | S 8-bit data MPB STOP | | | |
| 0 | _ | 1 | 1 | S 8-bit data MPB STOP STOP | | | |
| 1 | _ | 1 | 0 | S 7-bit data MPB STOP | | | |
| 1 | _ | 1 | 1 | S 7-bit data MPB STOP STOP | | | |

15.4.2 Receive Data Sampling Timing and Reception Margin in Asynchronous Mode

In asynchronous mode, the SCI operates on a basic clock with a frequency of 16 times the bit rate. In reception, the SCI samples the falling edge of the start bit using the basic clock, and performs internal synchronization. Since receive data is latched internally at the rising edge of the 8th pulse of the basic clock, data is latched at the middle of each bit, as shown in figure 15.3. Thus the reception margin in asynchronous mode is determined by formula (1) below.

$$M = \{ (0.5 - \frac{1}{2N}) - \frac{D - 0.5}{N} (1 + F) - (L - 0.5) F \} \times 100 \quad [\%] \quad \cdots \quad \text{Formula (1)}$$

M: Reception margin (%)

N: Ratio of bit rate to clock (N = 16)

D: Clock duty (D = 0.5 to 1.0)

L : Frame length (L = 9 to 12)

F: Absolute value of clock rate deviation

Assuming values of F = 0 and D = 0.5 in formula (1), the reception margin is determined by the formula below.

$$M = \{0.5 - 1/(2 \times 16)\} \times 100$$
 [%] = 46.875 %

However, this is only the computed value, and a margin of 20% to 30% should be allowed in system design.

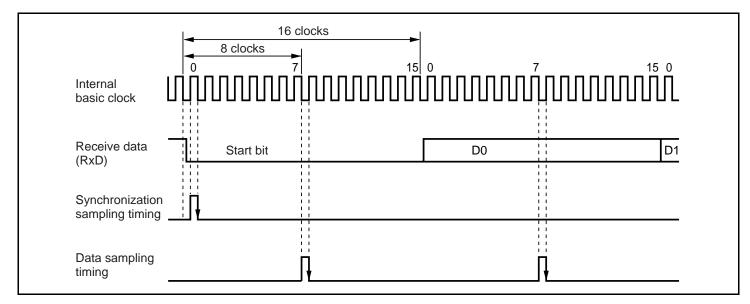


Figure 15.3 Receive Data Sampling Timing in Asynchronous Mode

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15.4.3 Clock

Either an internal clock generated by the on-chip baud rate generator or an external clock input at the SCK pin can be selected as the SCI's transfer clock, according to the setting of the C/\overline{A} bit in SMR and the CKE1 and CKE0 bits in SCR. When an external clock is input at the SCK pin, the clock frequency should be 16 times the bit rate used.

When the SCI is operated on an internal clock, the clock can be output from the SCK pin. The frequency of the clock output in this case is equal to the bit rate, and the phase is such that the rising edge of the clock is in the middle of the transmit data, as shown in figure 15.4.

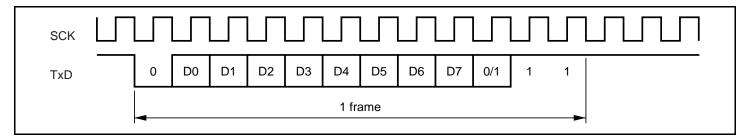


Figure 15.4 Relation between Output Clock and Transmit Data Phase (Asynchronous Mode)

15.4.4 SCI Initialization (Asynchronous Mode)

Before transmitting and receiving data, you should first clear the TE and RE bits in SCR to 0, then initialize the SCI as shown in figure 15.5. When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag in SSR is set to 1. Note that clearing the RE bit to 0 does not initialize the contents of the RDRF, PER, FER, and ORER flags in SSR, or the contents of RDR. When an external clock is used in asynchronous mode, the clock must be supplied even during initialization.

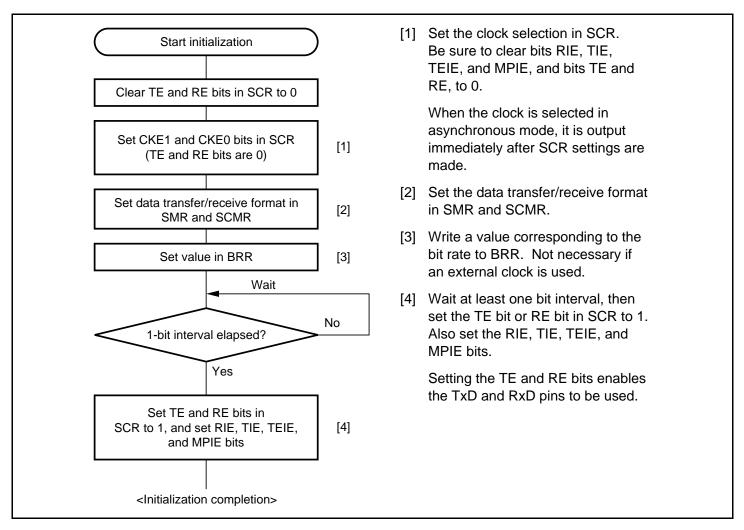


Figure 15.5 Sample SCI Initialization Flowchart

15.4.5 Data Transmission (Asynchronous Mode)

Figure 15.6 shows an example of the operation for transmission in asynchronous mode. In transmission, the SCI operates as described below.

- 1. The SCI monitors the TDRE flag in SSR, and if it is cleared to 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
- 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission. If the TIE bit in SCR is set to 1 at this time, a transmit data empty interrupt request (TXI) is generated. Because the TXI interrupt routine writes the next transmit data to TDR before transmission of the current transmit data has finished, continuous transmission can be enabled.
- 3. Data is sent from the TxD pin in the following order: start bit, transmit data, parity bit or multiprocessor bit (may be omitted depending on the format), and stop bit.
- 4. The SCI checks the TDRE flag at the timing for sending the stop bit.
- 5. If the TDRE flag is 0, the data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.
- 6. If the TDRE flag is 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the "mark state" is entered in which 1 is output. If the TEIE bit in SCR is set to 1 at this time, a TEI interrupt request is generated.

Figure 15.7 shows a sample flowchart for transmission in asynchronous mode.

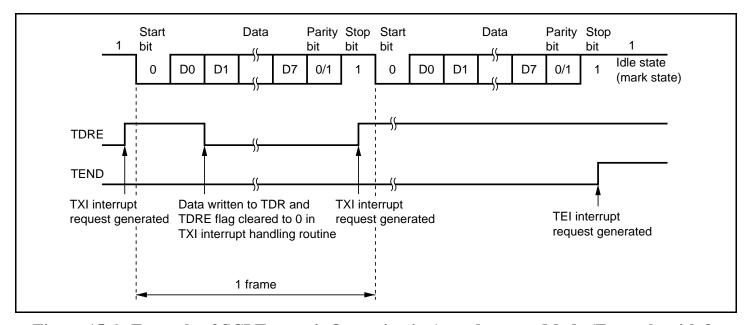


Figure 15.6 Example of SCI Transmit Operation in Asynchronous Mode (Example with 8-Bit Data, Parity, One Stop Bit)

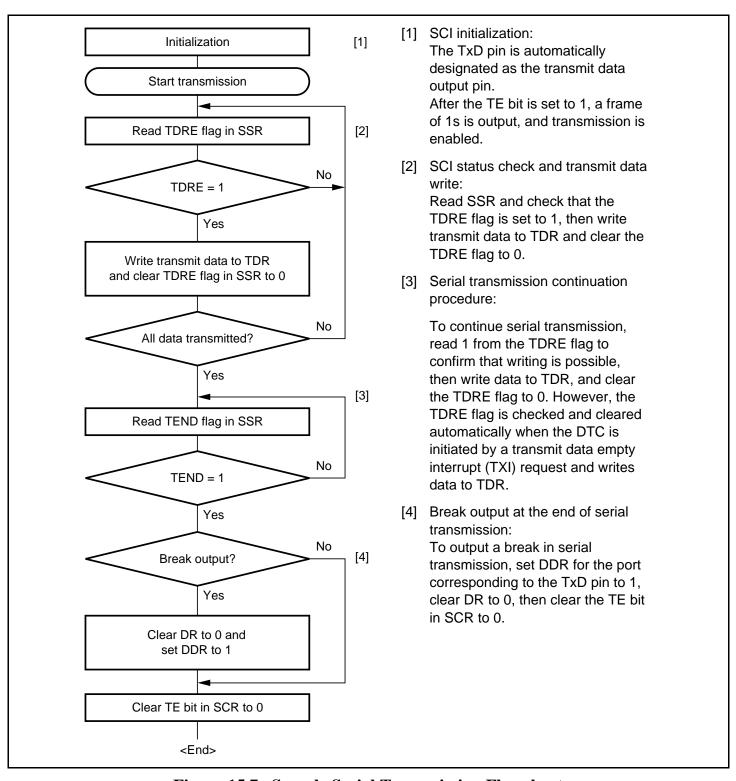


Figure 15.7 Sample Serial Transmission Flowchart

15.4.6 Serial Data Reception (Asynchronous Mode)

Figure 15.8 shows an example of the operation for reception in asynchronous mode. In serial reception, the SCI operates as described below.

- 1. The SCI monitors the communication line, and if a start bit is detected, performs internal synchronization, receives receive data in RSR, and checks the parity bit and stop bit.
- 2. If an overrun error (when reception of the next data is completed while the RDRF flag in SSR is still set to 1) occurs, the ORER bit in SSR is set to 1. If the RIE bit in SCR is set to 1 at this time, an ERI interrupt request is generated. Receive data is not transferred to RDR. The RDRF flag remains to be set to 1.
- 3. If a parity error is detected, the PER bit in SSR is set to 1 and receive data is transferred to RDR. If the RIE bit in SCR is set to 1 at this time, an ERI interrupt request is generated.
- 4. If a framing error (when the stop bit is 0) is detected, the FER bit in SSR is set to 1 and receive data is transferred to RDR. If the RIE bit in SCR is set to 1 at this time, an ERI interrupt request is generated.
- 5. If reception finishes successfully, the RDRF bit in SSR is set to 1, and receive data is transferred to RDR. If the RIE bit in SCR is set to 1 at this time, an RXI interrupt request is generated. Because the RXI interrupt routine reads the receive data transferred to RDR before reception of the next receive data has finished, continuous reception can be enabled.

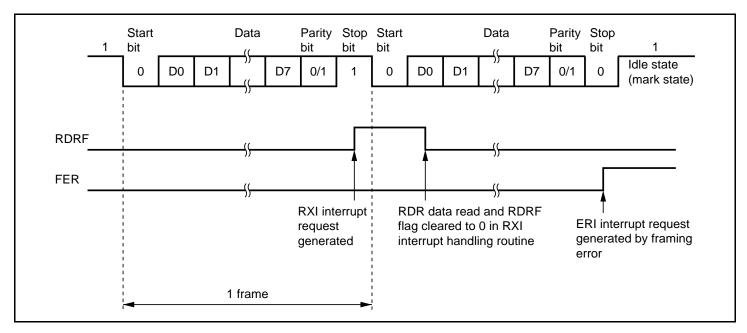


Figure 15.8 Example of SCI Receive Operation in Asynchronous Mode (Example with 8-Bit Data, Parity, One Stop Bit)

Table 15.9 shows the states of the SSR status flags and receive data handling when a receive error is detected. If a receive error is detected, the RDRF flag retains its state before receiving data. Reception cannot be resumed while a receive error flag is set to 1. Accordingly, clear the ORER, FER, PER, and RDRF bits to 0 before resuming reception. Figure 15.9 shows a sample flow chart for serial data reception.

Table 15.9 SSR Status Flags and Receive Data Handling

SSR Status Flag

| RDRF* | ORER | FER | PER | Receive Data | Receive Error Type | |
|-------|------|-----|-----|--------------------|--|--|
| 1 | 1 | 0 | 0 | Lost | Overrun error | |
| 0 | 0 | 1 | 0 | Transferred to RDR | Framing error | |
| 0 | 0 | 0 | 1 | Transferred to RDR | Parity error | |
| 1 | 1 | 1 | 0 | Lost | Overrun error + framing error | |
| 1 | 1 | 0 | 1 | Lost | Overrun error + parity error | |
| 0 | 0 | 1 | 1 | Transferred to RDR | Framing error + parity error | |
| 1 | 1 | 1 | 1 | Lost | Overrun error + framing error + parity error | |

Note:* The RDRF flag retains the state it had before data reception.

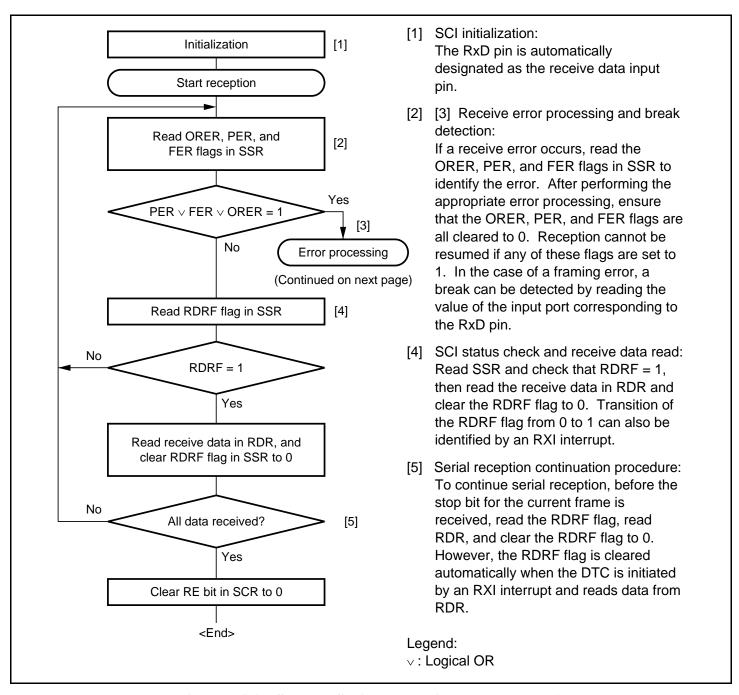


Figure 15.9 Sample Serial Reception Flowchart (1)

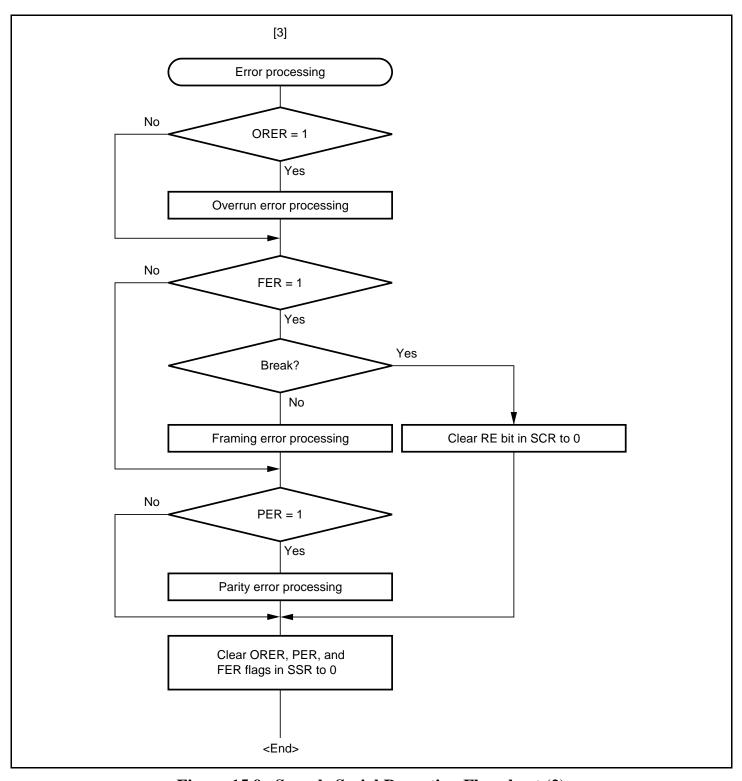


Figure 15.9 Sample Serial Reception Flowchart (2)

15.5 Multiprocessor Communication Function

Use of the multiprocessor communication function enables data transfer to be performed among a number of processors sharing communication lines by means of asynchronous serial communication using the multiprocessor format, in which a multiprocessor bit is added to the transfer data. When multiprocessor communication is carried out, each receiving station is addressed by a unique ID code. The serial communication cycle consists of two component cycles: an ID transmission cycle which specifies the receiving station, and a data transmission cycle for the specified receiving station. The multiprocessor bit is used to differentiate between the ID transmission cycle and the data transmission cycle. If the multiprocessor bit is 1, the cycle is an ID transmission cycle, and if the multiprocessor bit is 0, the cycle is a data transmission cycle. Figure 15.10 shows an example of inter-processor communication using the multiprocessor format. The transmitting station first sends the ID code of the receiving station with which it wants to perform serial communication as data with a 1 multiprocessor bit added. It then sends transmit data as data with a 0 multiprocessor bit added. The receiving station skips data until data with a 1 multiprocessor bit is sent. When data with a 1 multiprocessor bit is received, the receiving station compares that data with its own ID. The station whose ID matches then receives the data sent next. Stations whose ID does not match continue to skip data until data with a 1 multiprocessor bit is again received.

The SCI uses the MPIE bit in SCR to implement this function. When the MPIE bit is set to 1, transfer of receive data from RSR to RDR, error flag detection, and setting the SSR status flags, RDRF, FER, and ORER in SSR to 1 are prohibited until data with a 1 multiprocessor bit is received. On reception of a receive character with a 1 multiprocessor bit, the MPB bit in SSR is set to 1 and the MPIE bit is automatically cleared, thus normal reception is resumed. If the RIE bit in SCR is set to 1 at this time, an RXI interrupt is generated.

When the multiprocessor format is selected, the parity bit setting is invalid. All other bit settings are the same as those in normal asynchronous mode. The clock used for multiprocessor communication is the same as that in normal asynchronous mode.

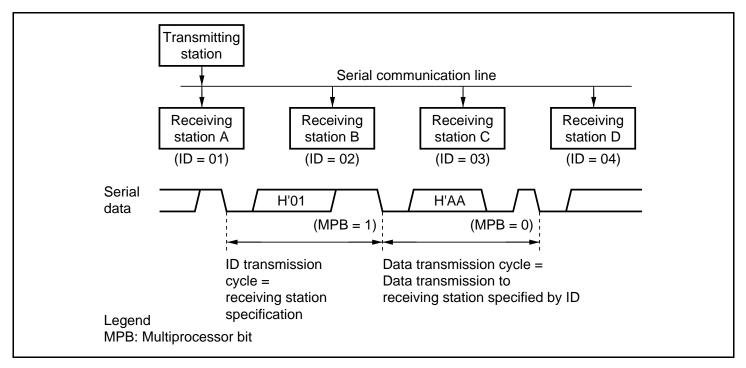


Figure 15.10 Example of Communication Using Multiprocessor Format (Transmission of Data H'AA to Receiving Station A)

15.5.1 Multiprocessor Serial Data Transmission

Figure 15.11 shows a sample flowchart for multiprocessor serial data transmission. For an ID transmission cycle, set the MPBT bit in SSR to 1 before transmission. For a data transmission cycle, clear the MPBT bit in SSR to 0 before transmission. All other SCI operations are the same as those in asynchronous mode.

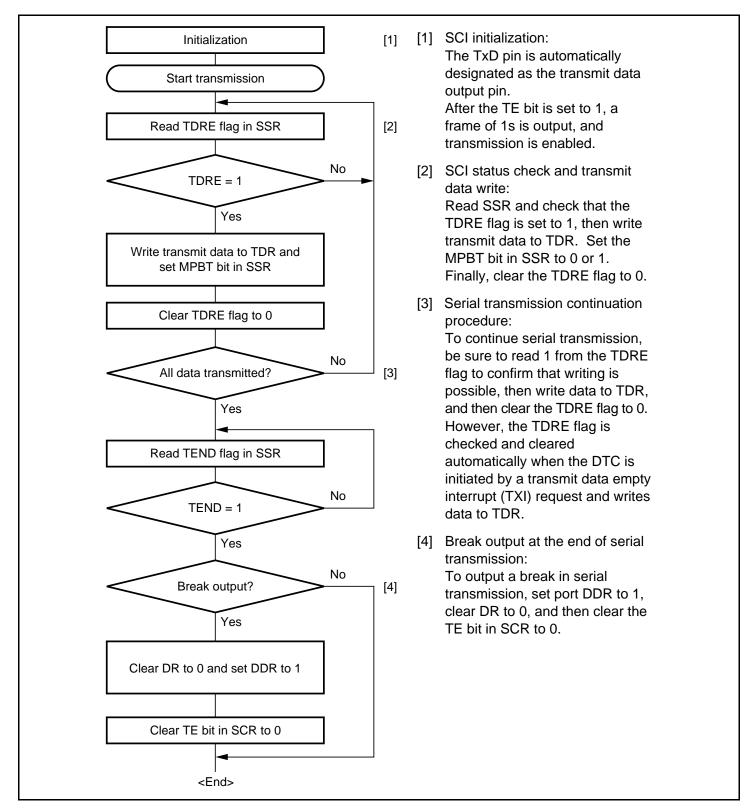


Figure 15.11 Sample Multiprocessor Serial Transmission Flowchart

15.5.2 Multiprocessor Serial Data Reception

Figure 15.13 shows a sample flowchart for multiprocessor serial data reception. If the MPIE bit in SCR is set to 1, data is skipped until data with a 1 multiprocessor bit is sent. On receiving data with a 1 multiprocessor bit, the receive data is transferred to RDR. An RXI interrupt request is generated at this time. All other SCI operations are the same as in asynchronous mode. Figure 15.12 shows an example of SCI operation for multiprocessor format reception.

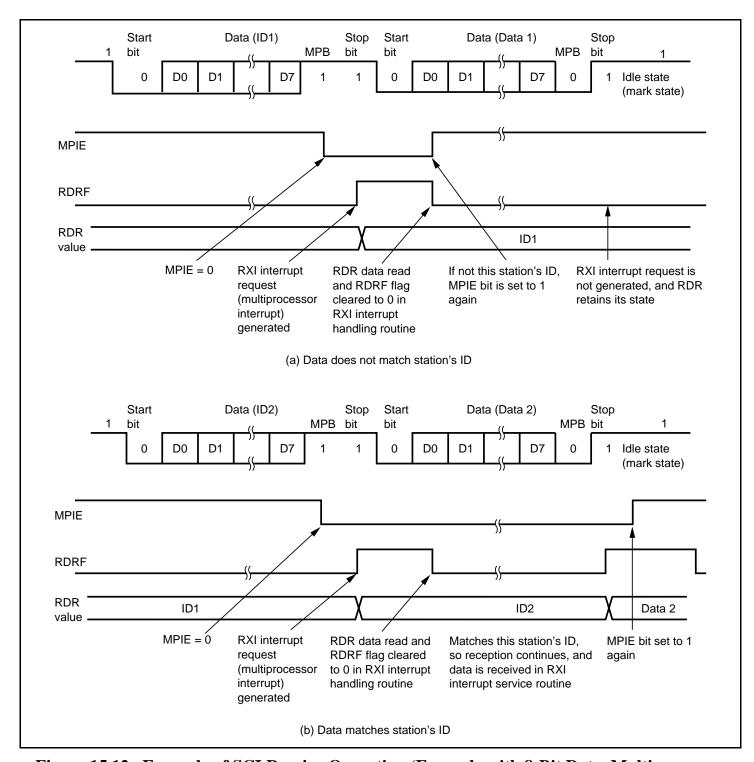


Figure 15.12 Example of SCI Receive Operation (Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit)

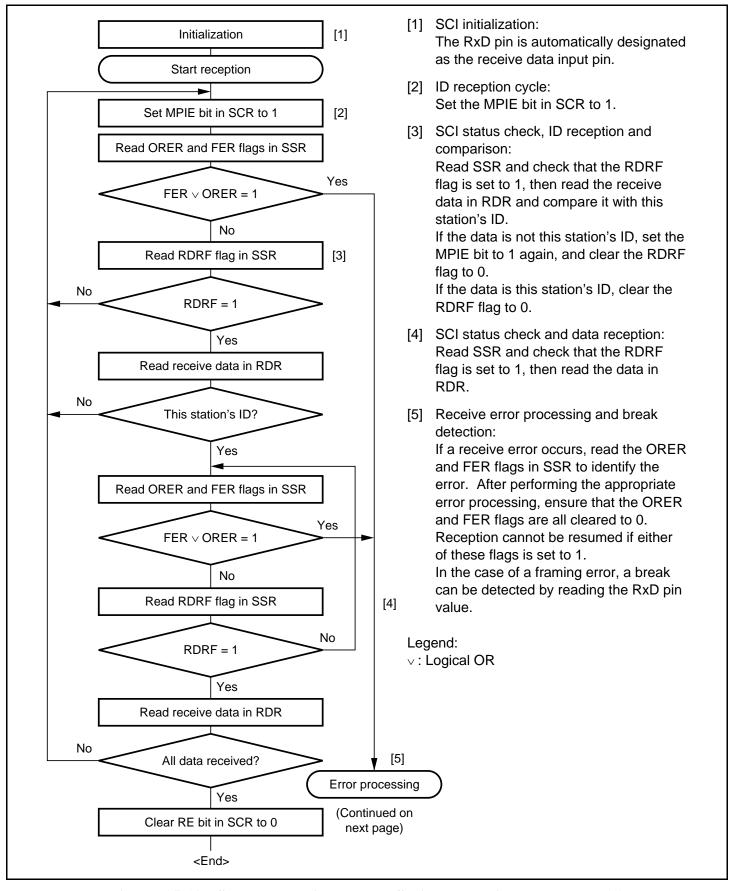


Figure 15.13 Sample Multiprocessor Serial Reception Flowchart (1)

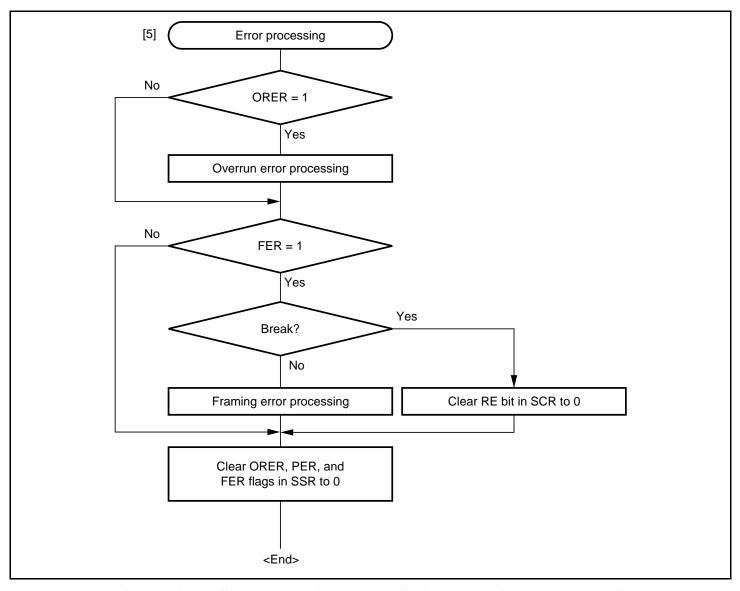


Figure 15.13 Sample Multiprocessor Serial Reception Flowchart (2)

RENESAS

15.6 Operation in Clocked Synchronous Mode

Figure 15.14 shows the general format for clocked synchronous communication. In clocked synchronous mode, data is transmitted or received in synchronization with clock pulses. One character in transfer data consists of 8-bit data. In data transmission, the SCI outputs data from one falling edge of the synchronization clock to the next. In data reception, the SCI receives data in synchronization with the rising edge of the synchronization clock. After 8-bit data is output, the transmission line holds the MSB state. In clocked synchronous mode, no parity or multiprocessor bit is added. Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication by use of a common clock. Both the transmitter and the receiver also have a double-buffered structure, so that the next transmit data can be written during transmission or the previous receive data can be read during reception, enabling continuous data transfer.

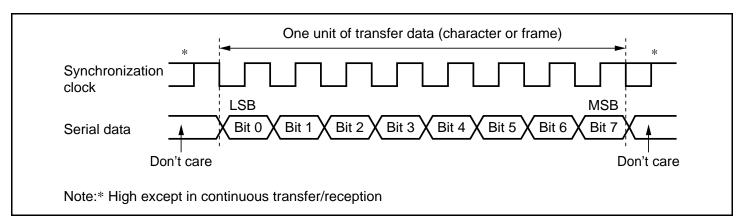


Figure 15.14 Data Format in Clocked Synchronous Communication (LSB-First)

15.6.1 Clock

Either an internal clock generated by the on-chip baud rate generator or an external synchronization clock input at the SCK pin can be selected, according to the setting of the CKE1 and CKE0 bits in SCR. When the SCI is operated on an internal clock, the synchronization clock is output from the SCK pin. Eight synchronization clock pulses are output in the transfer of one character, and when no transfer is performed the clock is fixed high.

15.6.2 SCI Initialization (Clocked Synchronous Mode)

Before transmitting and receiving data, you should first clear the TE and RE bits in SCR to 0, then initialize the SCI as described in a sample flowchart in figure 15.15. When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag in SSR is set to 1. However, clearing the RE bit to 0 does not initialize the RDRF, PER, FER, and ORER flags in SSR, or RDR.

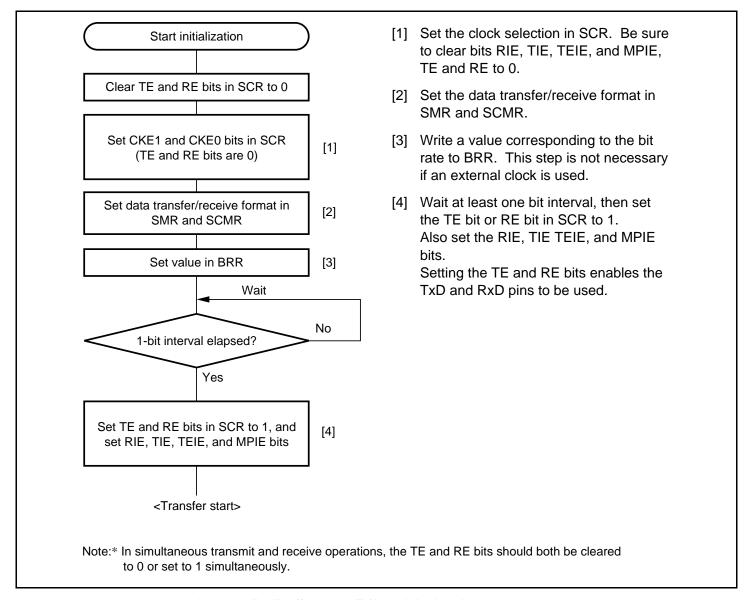


Figure 15.15 Sample SCI Initialization Flowchart

15.6.3 Serial Data Transmission (Clocked Synchronous Mode)

Figure 15.16 shows an example of SCI operation for transmission in clocked synchronous mode. In serial transmission, the SCI operates as described below.

- 1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
- 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission. If the TIE bit in SCR is set to 1 at this time, a TXI interrupt request is generated. Because the TXI interrupt routine writes the next transmit data to TDR before transmission of the current transmit data has finished, continuous transmission can be enabled.
- 3. 8-bit data is sent from the TxD pin synchronized with the output clock when output clock mode has been specified and synchronized with the input clock when use of an external clock has been specified.
- 4. The SCI checks the TDRE flag at the timing for sending the last bit.
- 5. If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, and serial transmission of the next frame is started.
- 6. If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, and the TxD pin maintains the output state of the last bit. If the TEIE bit in SCR is set to 1 at this time, a TEI interrupt request is generated. The SCK pin is fixed high.

Figure 15.17 shows a sample flow chart for serial data transmission. Even if the TDRE flag is cleared to 0, transmission will not start while a receive error flag (ORER, FER, or PER) is set to 1. Make sure to clear the receive error flags to 0 before starting transmission. Note that clearing the RE bit to 0 does not clear the receive error flags.

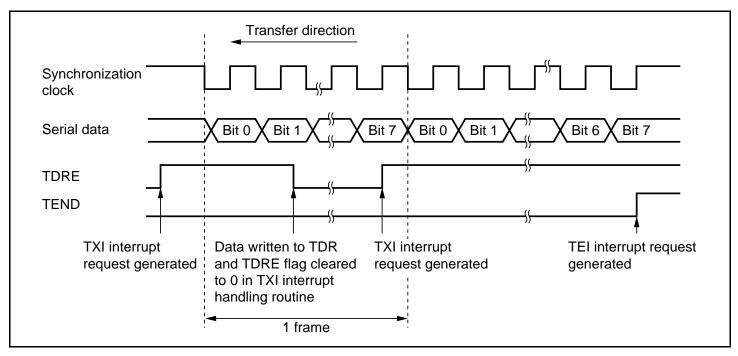


Figure 15.16 Example of SCI Transmit Operation in Clocked Synchronous Mode

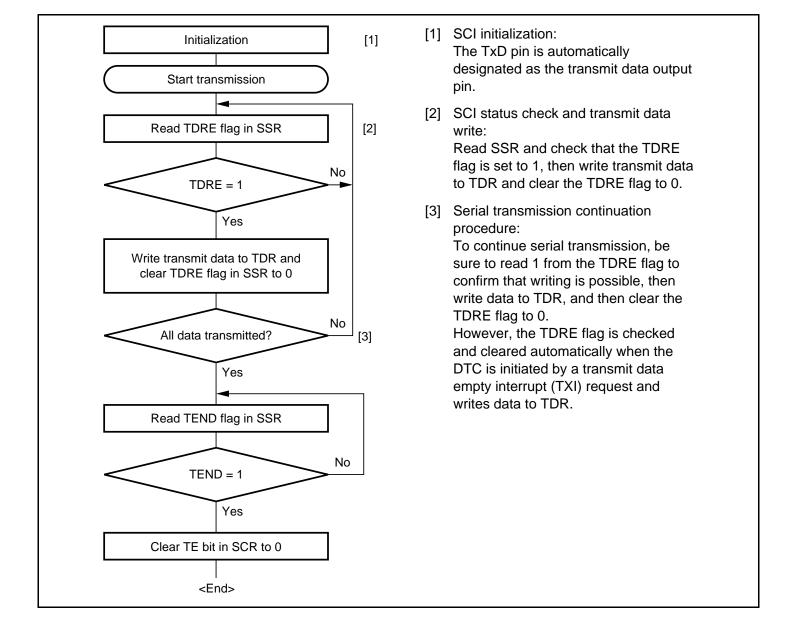


Figure 15.17 Sample Serial Transmission Flowchart

RENESAS

15.6.4 Serial Data Reception (Clocked Synchronous Mode)

Figure 15.18 shows an example of SCI operation for reception in clocked synchronous mode. In serial reception, the SCI operates as described below.

- 1. The SCI performs internal initialization in synchronization with a synchronization clock input or output, starts receiving data, and stores the receive data in RSR.
- 2. If an overrun error (when reception of the next data is completed while the RDRF flag is still set to 1) occurs, the ORER bit in SSR is set to 1. If the RIE bit in SCR is set to 1 at this time, an ERI interrupt request is generated. Receive data is not transferred to RDR. The RDRF flag remains to be set to 1.
- 3. If reception finishes successfully, the RDRF bit in SSR is set to 1, and receive data is transferred to RDR. If the RIE bit in SCR is set to 1 at this time, an RXI interrupt request is generated. Because the RXI interrupt routine reads the receive data transferred to RDR before reception of the next receive data has finished, continuous reception can be enabled.

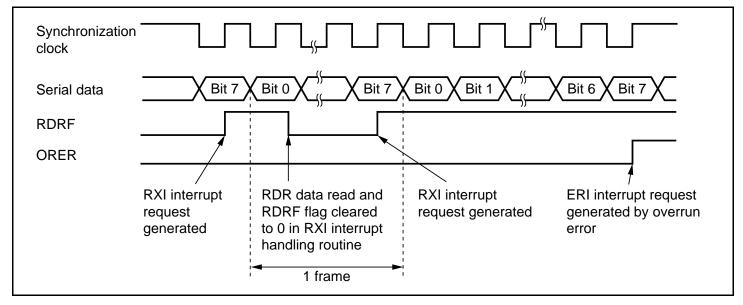


Figure 15.18 Example of SCI Receive Operation in Clocked Synchronous Mode

Reception cannot be resumed while a receive error flag is set to 1. Accordingly, clear the ORER, FER, PER, and RDRF bits to 0 before resuming reception. Figure 15.19 shows a sample flowchart for serial data reception.

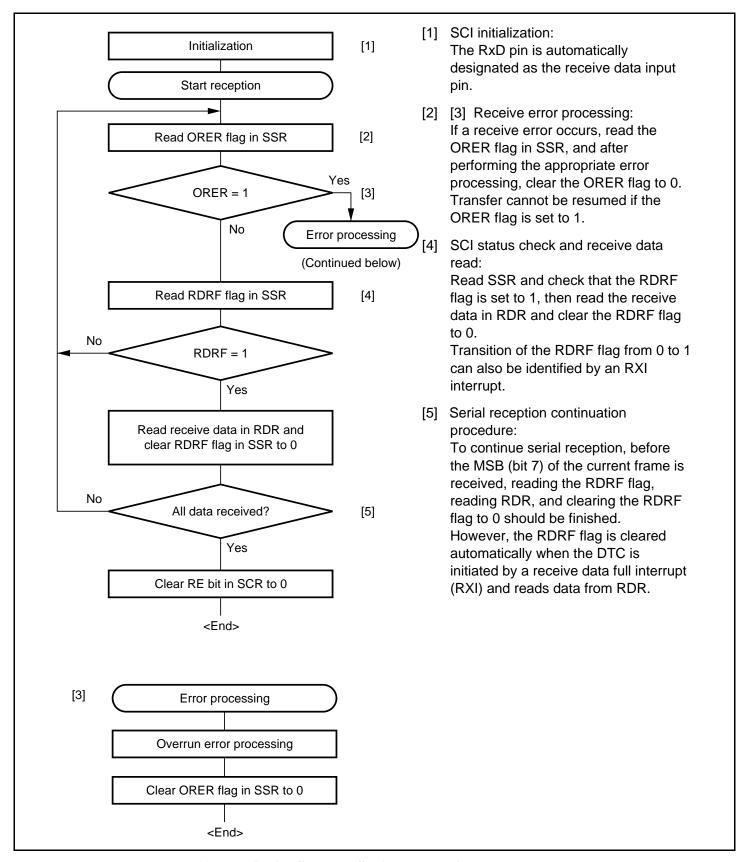


Figure 15.19 Sample Serial Reception Flowchart

15.6.5 Simultaneous Serial Data Transmission and Reception (Clocked Synchronous Mode)

Figure 15.20 shows a sample flowchart for simultaneous serial transmit and receive operations. After initializing the SCI, the following procedure should be used for simultaneous serial data transmit and receive operations. To switch from transmit mode to simultaneous transmit and receive mode, check that the SCI has finished transmission and the TDRE and TEND flags in SSR are set to 1, clear the TE bit in SCR to 0, and then set the TE and RE bits to 1 simultaneously with a single instruction. To switch from receive mode to simultaneous transmit and receive mode, check that the SCI has finished reception, and clear the RE bit to 0. Then after checking that the RDRF bit in SSR and receive error flags (ORER, FER, and PER) are cleared to 0, set the TE and RE bits to 1 simultaneously with a single instruction.

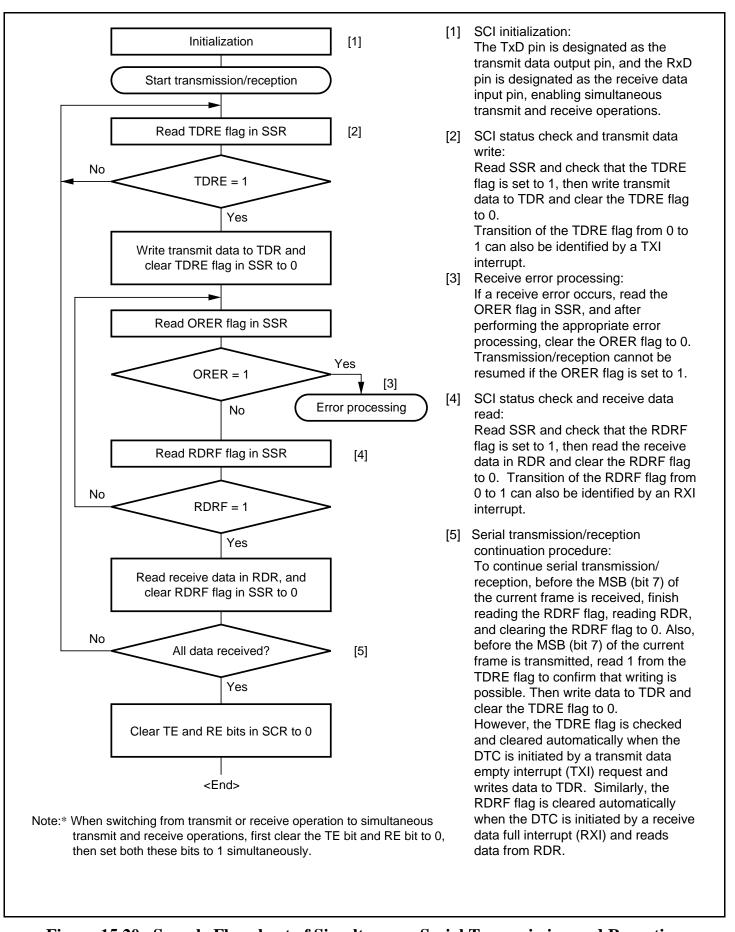


Figure 15.20 Sample Flowchart of Simultaneous Serial Transmission and Reception

15.7 IrDA Operation

IrDA operation can be used with SCI_2. Figure 15.22 shows an IrDA block diagram.

If the IrDA function is enabled using the IrE bit in KBCOMP, the TxD2 and RxD2 pins in SCI_2 are allowed to encode and decode the waveform based on the IrDA standard version 1.0 (function as the IrTxD and IrRxD pins). Connecting these pins to the infrared data transceiver achieves infrared data communication based on the system defined by the IrDA standard version 1.0.

In the system defined by the IrDA standard version 1.0, communication is started at a transfer rate of 9600 bps, which can be modified as required. The IrDA interface provided by this LSI does not incorporate the capability of automatic modification of the transfer rate; the transfer rate must be modified through programming.

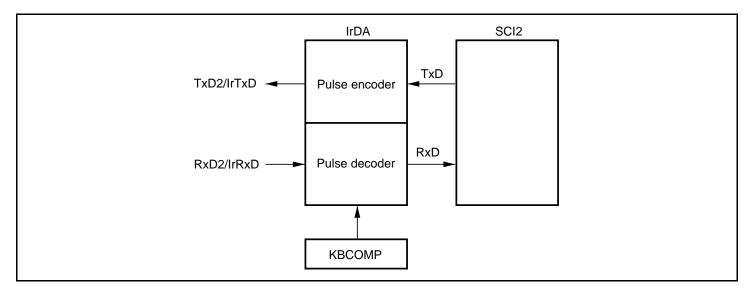


Figure 15.21 IrDA Block Diagram

Transmission: During transmission, the output signals from the SCI (UART frames) are converted to IR frames using the IrDA interface (see figure 15.22).

For serial data of level 0, a high-level pulse having a width of 3/16 of the bit rate (1-bit interval) is output (initial setting). The high-level pulse can be selected using the IrCKS2 to IrCKS0 bits in KBCOMP.

The high-level pulse width is defined to be 1.41 μ s at minimum and (3/16 + 2.5%) × bit rate or (3/16 × bit rate) + 1.08 μ s at maximum. For example, when the frequency of system clock ϕ is 20 MHz, a high-level pulse width of at least 1.4 μ s to 1.6 μ s can be specified.

For serial data of level 1, no pulses are output.

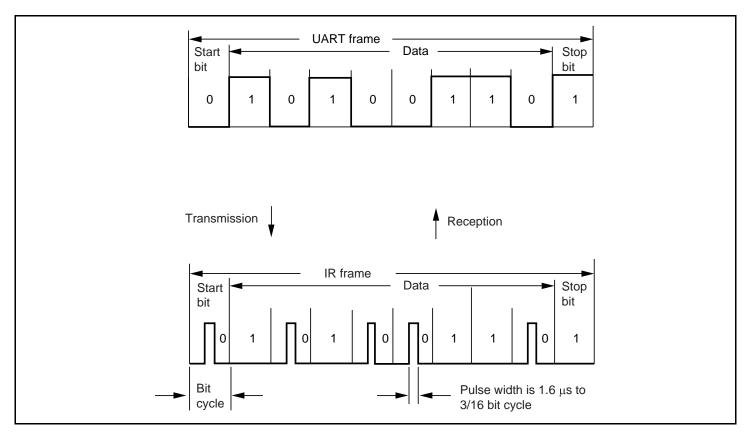


Figure 15.22 IrDA Transmission and Reception

Reception: During reception, IR frames are converted to UART frames using the IrDA interface before inputting to SCI_2.

Data of level 0 is output each time a high-level pulse is detected and data of level 1 is output when no pulse is detected in a bit cycle. If a pulse has a high-level width of less than 1.41 µs, the minimum width allowed, the pulse is recognized as level 0.

High-Level Pulse Width Selection: Table 15.10 shows possible settings for bits IrCKS2 to IrCKS0 (minimum pulse width), and this LSI's operating frequencies and bit rates, for making the pulse width shorter than 3/16 times the bit rate in transmission.

Table 15.10 IrCKS2 to IrCKS0 Bit Settings

Bit Rate (bps) (Upper Row) / Bit Interval × 3/16 (μs) (Lower Row) Operating Frequency 19.53 78.13 9.77 4.88 3.26 1.63 ø (MHz) 2.097152 2.4576 3.6864 4.9152 6.144 7.3728 9.8304 12.288 14.7456 16.9344 17.2032 19.6608

Legend

—: An SCI bit rate setting cannot be made.

15.8 Interrupt Sources

Table 15.11 shows the interrupt sources in serial communication interface. A different interrupt vector is assigned to each interrupt source, and individual interrupt sources can be enabled or disabled using the enable bits in SCR.

When the TDRE flag in SSR is set to 1, a TXI interrupt request is generated. When the TEND flag in SSR is set to 1, a TEI interrupt request is generated. A TXI interrupt can activate the DTC to allow data transfer. The TDRE flag is automatically cleared to 0 at data transfer by the DTC.

When the RDRF flag in SSR is set to 1, an RXI interrupt request is generated. When the ORER, PER, or FER flag in SSR is set to 1, an ERI interrupt request is generated. An RXI interrupt can activate the DTC to allow data transfer. The RDRF flag is automatically cleared to 0 at data transfer by the DTC.

A TEI interrupt is requested when the TEND flag is set to 1 while the TEIE bit is set to 1. If a TEI interrupt and a TXI interrupt are requested simultaneously, the TXI interrupt has priority for acceptance. However, note that if the TDRE and TEND flags are cleared simultaneously by the TXI interrupt routine, the SCI cannot branch to the TEI interrupt routine later.

Table 15.11 SCI Interrupt Sources

| Channel | Name | Interrupt Source | Interrupt Flag | DTC Activation | Priority |
|---------|------|---------------------|----------------|----------------|----------|
| 0 | ERI0 | Receive error | ORER, FER, PER | Not possible | High |
| | RXI0 | Receive data full | RDRF | Possible | |
| | TXI0 | Transmit data empty | TDRE | Possible | - |
| | TEI0 | Transmit end | TEND | Not possible | - |
| 1 | ERI1 | Receive error | ORER, FER, PER | Not possible | |
| | RXI1 | Receive data full | RDRF | Possible | - |
| | TXI1 | Transmit data empty | TDRE | Possible | - |
| | TEI1 | Transmit end | TEND | Not possible | - |
| 2 | ERI2 | Receive error | ORER, FER, PER | Not possible | |
| | RXI2 | Receive data full | RDRF | Possible | - |
| | TXI2 | Transmit data empty | TDRE | Possible | - |
| | TEI2 | Transmit end | TEND | Not possible | Low |

15.9 Usage Notes

15.9.1 Module Stop Mode Setting

SCI operation can be disabled or enabled using the module stop control register. The initial setting is for SCI operation to be halted. Register access is enabled by clearing module stop mode. For details, refer to section 26, Power-Down Modes.

15.9.2 Break Detection and Processing

When framing error detection is performed, a break can be detected by reading the RxD pin value directly. In a break, the input from the RxD pin becomes all 0s, and so the FER flag in SSR is set, and the PER flag may also be set. Note that, since the SCI continues the receive operation even after receiving a break, even if the FER flag is cleared to 0, it will be set to 1 again.

15.9.3 Mark State and Break Detection

When the TE bit in SCR is 0, the TxD pin is used as an I/O port whose direction (input or output) and level are determined by DR and DDR of the port. This can be used to set the TxD pin to the mark state (high level) or send a break during serial data transmission. To maintain the communication line at mark state until TE is set to 1, set both DDR and DR to 1. Since the TE bit is cleared to 0 at this point, the TxD pin becomes an I/O port, and 1 is output from the TxD pin. To send a break during serial transmission, first set DDR to 1 and DR to 0, and then clear the TE bit to 0. When the TE bit is cleared to 0, the transmitter is initialized regardless of the current transmission state, the TxD pin becomes an I/O port, and 0 is output from the TxD pin.

15.9.4 Receive Error Flags and Transmit Operations (Clocked Synchronous Mode Only)

Transmission cannot be started when a receive error flag (ORER, FER, or RER) is SSR is set to 1, even if the TDRE flag in SSR is cleared to 0. Be sure to clear the receive error flags to 0 before starting transmission. Note also that the receive error flags cannot be cleared to 0 even if the RE bit in SCR is cleared to 0.

15.9.5 Relation between Writing to TDR and TDRE Flag

Data can be written to TDR irrespective of the TDRE flag status in SSR. However, if the new data is written to TDR when the TDRE flag is 0, that is, when the previous data has not been transferred to TSR yet, the previous data in TDR is lost. Be sure to write transmit data to TDR after verifying that the TDRE flag is set to 1.

15.9.6 Restrictions on Using DTC

When an external clock source is used as a synchronization clock, update TDR by the DTC or RFU and wait for at least five ø clock cycles before allowing the transmit clock to be input. If the transmit clock is input within four clock cycles after TDR modification, the SCI may malfunction (figure 15.23).

When using the DTC to read RDR, be sure to set the receive end interrupt source (RXI) as a DTC activation source.

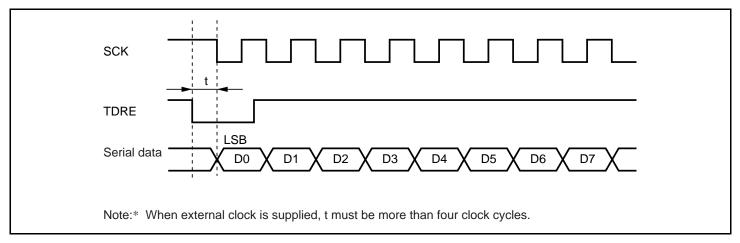


Figure 15.23 Example of Transmission using DTC in Clocked Synchronous Mode

15.9.7 SCI Operations during Mode Transitions

Transmission: Before making a transition to module stop, software standby, or sub-sleep mode, stop all transmit operations (TE = TEIE = TEIE = 0). TSR, TDR, and SSR are reset. The states of the output pins during each mode depend on the port settings, and the pins output a high-level signal after mode cancellation. If a transition is made during data transmission, the data being transmitted will be undefined.

To transmit data in the same transmission mode after mode cancellation, set TE to 1, read SSR, write to TDR, clear TDRE in this order, and then start transmission. To transmit data in a different transmission mode, initialize the SCI first.

Figure 15.24 shows a sample flowchart for mode transition during transmission. Figures 15.25 and 15.26 show the pin states during transmission.

Before making a transition from the transmission mode using DTC transfer to module stop, software standby, or sub-sleep mode, stop all transmit operations (TE = TIE = TEIE = 0). Setting TE and TIE to 1 after mode cancellation generates a TXI interrupt request to start transmission using the DTC.

Reception: Before making a transition to module stop, software standby, watch, sub-active, or sub-sleep mode, stop reception (RE = 0). RSR, RDR, and SSR are reset. If a transition is made during data reception, the data being received will be invalid.

To receive data in the same reception mode after mode cancellation, set RE to 1, and then start reception. To receive data in a different reception mode, initialize the SCI first.

Figure 15.27 shows a sample flowchart for mode transition during reception.

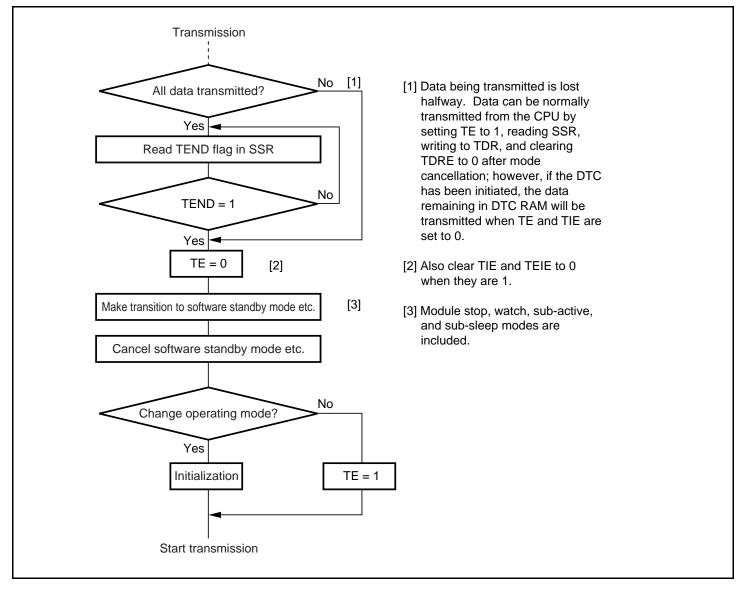


Figure 15.24 Sample Flowchart for Mode Transition during Transmission

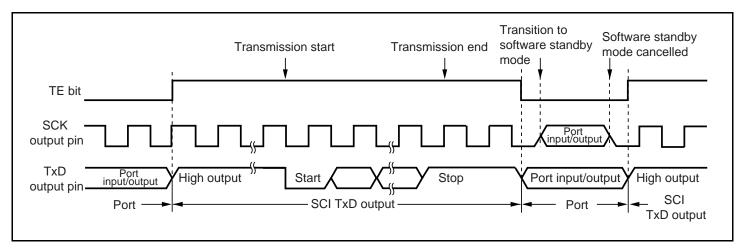


Figure 15.25 Pin States during Transmission in Asynchronous Mode (Internal Clock)

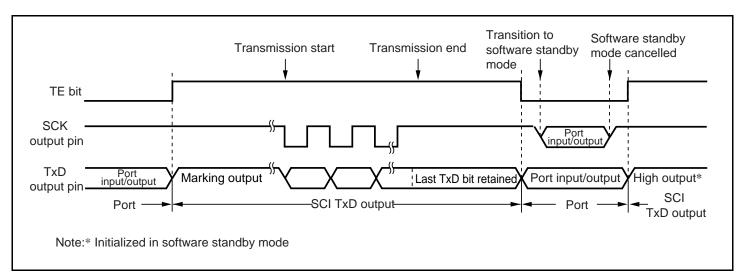


Figure 15.26 Pin States during Transmission in Clocked Synchronous Mode (Internal Clock)

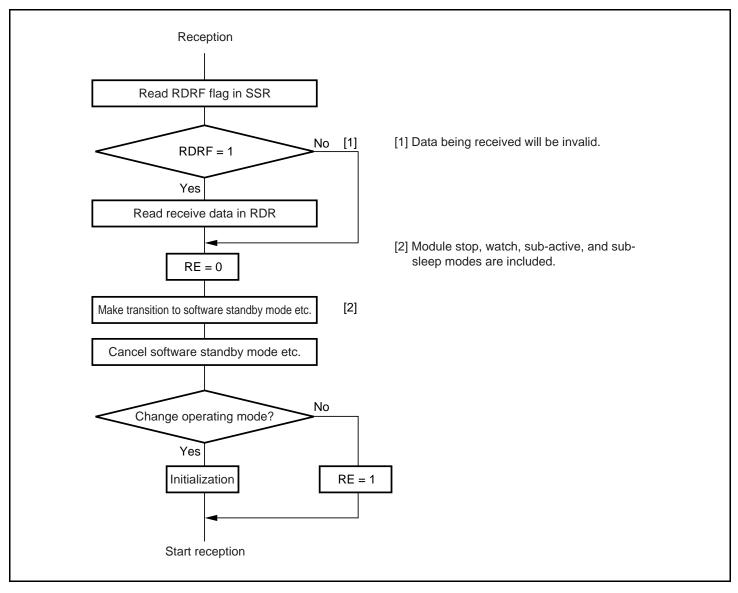


Figure 15.27 Sample Flowchart for Mode Transition during Reception

15.9.8 Notes on Switching from SCK Pins to Port Pins

When SCK pins are switched to port pins after transmission has completed, pins are enabled for port output after outputting a low pulse of half a cycle as shown in figure 15.28.

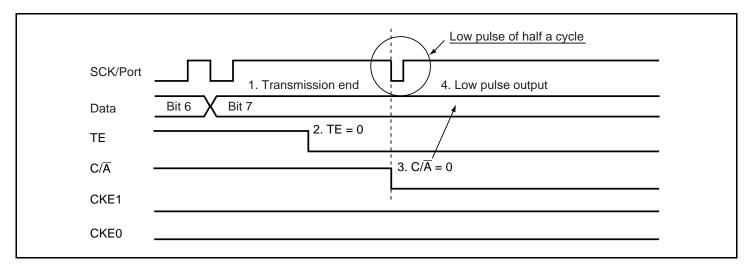


Figure 15.28 Switching from SCK Pins to Port Pins

To prevent the low pulse output that is generated when switching the SCK pins to the port pins, specify the SCK pins for input (pull up the SCK/port pins externally), and follow the procedure below with DDR = 1, DR = 1, C/\overline{A} = 1, CKE1 = 0, CKE1 = 0, and TE = 1.

- 1. End serial data transmission
- 2. TE bit = 0
- 3. CKE1 bit = 1
- 4. C/\overline{A} bit = 0 (switch to port output)
- 5. CKE1 bit = 0

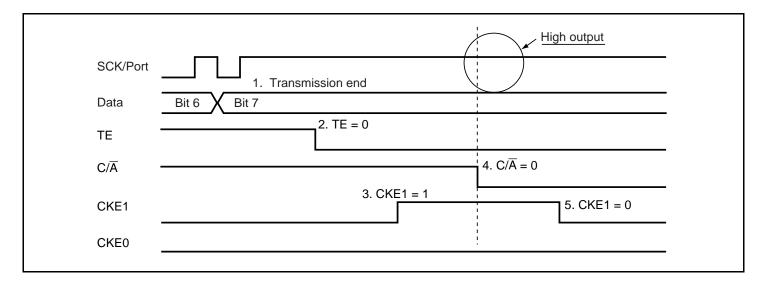


Figure 15.29 Prevention of Low Pulse Output at Switching from SCK Pins to Port Pins

Section 16 I²C Bus Interface (IIC) (Optional)

The I²C bus interface is provided as an optional function. Note the following point when using this optional function.

• Although the product type name is identical, please contact Hitachi before using this optional function on an F-ZTAT version product.

This LSI has a two-channel I²C bus interface. The I²C bus interface conforms to and provides a subset of the Philips I²C bus (inter-IC bus) interface functions. The register configuration that controls the I²C bus differs partly from the Philips configuration, however.

16.1 Features

- Selection of addressing format or non-addressing format
 - I²C bus format: addressing format with an acknowledge bit, for master/slave operation
 - Clocked synchronous serial format: non-addressing format without an acknowledge bit, for master operation only
 - Formatless (for IIC_0 only): non-addressing format with a clock pin dedicated for formatless; for slave operation only
- Conforms to Philips I²C bus interface (I²C bus format)
- Two ways of setting slave address (I²C bus format)
- Start and stop conditions generated automatically in master mode (I²C bus format)
- Selection of the acknowledge output level in reception (I²C bus format)
- Automatic loading of an acknowledge bit in transmission (I²C bus format)
- Wait function in master mode (I²C bus format)
 - A wait can be inserted by driving the SCL pin low after data transfer, excluding acknowledgement.
 - The wait can be cleared by clearing the interrupt flag.
- Wait function (I²C bus format)
 - A wait request can be generated by driving the SCL pin low after data transfer.
 - The wait request is cleared when the next transfer becomes possible.
- Interrupt sources
 - Data transfer end (including when a transition to transmit mode with I²C bus format occurs, when ICDR data is transferred, or during a wait state)
 - Address match: When any slave address matches or the general call address is received in slave receive mode with I²C bus format (including address reception after loss of master arbitration)
 - Start condition detection (in master mode)
 - Stop condition detection (in slave mode)



- Selection of 16 internal clocks (in master mode)
- Direct bus drive (SCL/SDA pin)
 - Four pins—P52/SCL0, P97/SDA0, P86/SCL1, and P42/SDA1 —(normally NMOS pushpull outputs) function as NMOS open-drain outputs when the bus drive function is selected.
- Automatic switching from formatless mode to I²C bus format (IIC_0 only)
 - Formatless operation (no start/stop conditions, non-addressing mode) in slave mode
 - Operation using a common data pin (SDA) and independent clock pins (VSYNCI, SCL)
 - Automatic switching from formatless mode to I²C bus format on the fall of the SCL pin

Figure 16.1 shows a block diagram of the I²C bus interface. Figure 16.2 shows an example of I/O pin connections to external circuits. Since I²C bus interface I/O pins are different in structure from normal port pins, they have different specifications for permissible applied voltages. For details, see section 28, Electrical Characteristics.

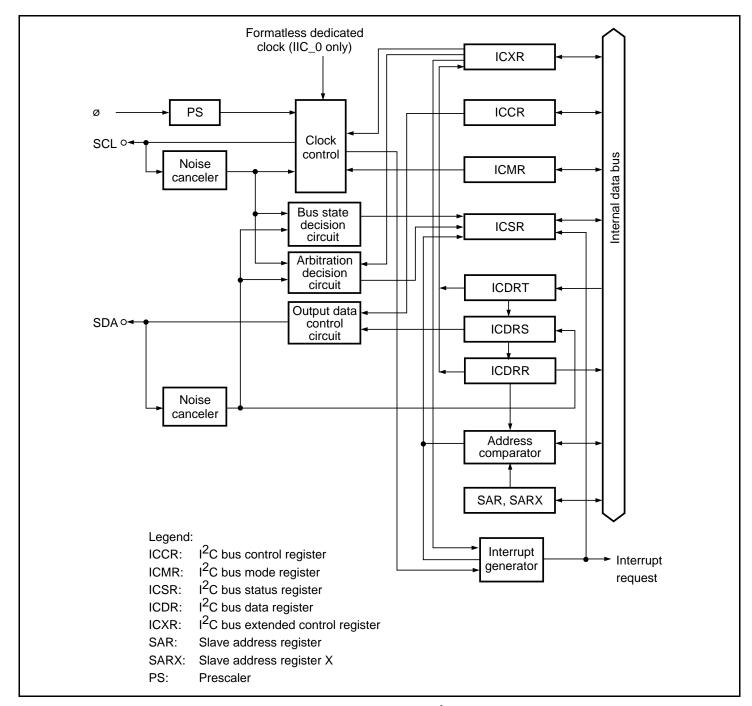


Figure 16.1 Block Diagram of I²C Bus Interface

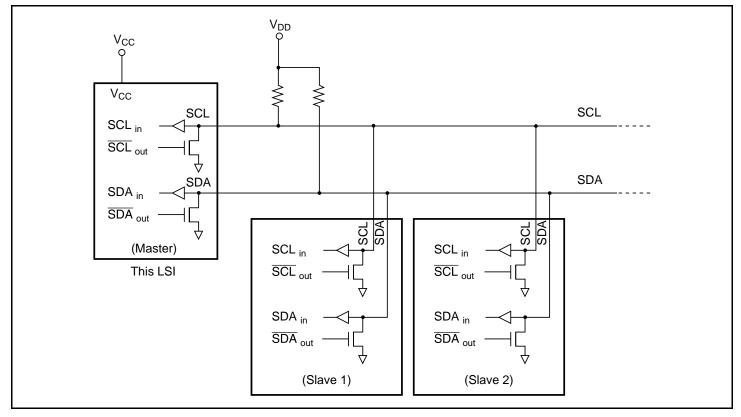


Figure 16.2 I²C Bus Interface Connections (Example: This LSI as Master)

16.2 Input/Output Pins

Table 16.1 summarizes the input/output pins used by the I^2C bus interface.

Table 16.1 Pin Configuration

| Channel | Symbol* | Input/Output | Function |
|---------|---------|--------------|--|
| 0 | SCL0 | Input/Output | Serial clock input/output pin of IIC_0 |
| | SDA0 | Input/Output | Serial data input/output pin of IIC_0 |
| | VSYNCI | Input | Formatless serial clock input pin of IIC_0 |
| 1 | SCL1 | Input/Output | Serial clock input/output pin of IIC_1 |
| | SDA1 | Input/Output | Serial data input/output pin of IIC_1 |

Note:* In the text, the channel subscript is omitted, and only SCL and SDA are used.

16.3 Register Descriptions

The I²C bus interface has the following registers. Registers ICDR and SARX and registers ICMR and SAR are allocated to the same addresses. Accessible registers differ depending on the ICE bit in ICCR. When the ICE bit is cleared to 0, SAR and SARX can be accessed, and when the ICE bit is set to 1, ICMR and ICDR can be accessed. For details on the serial timer control register, refer to section 3.2.3, Serial Timer Control Register (STCR).

- I²C bus control register (ICCR)
- I²C bus status register (ICSR)
- I²C bus data register (ICDR)
- I²C bus mode register (ICMR)
- Slave address register (SAR)
- Second slave address register (SARX)
- I²C bus extended control register (ICXR)
- DDC switch register (DDCSWR) (for IIC_0 only)

16.3.1 I²C Bus Data Register (ICDR)

ICDR is an 8-bit readable/writable register that is used as a transmit data register when transmitting and a receive data register when receiving. ICDR is internally divided into a shift register (ICDRS), receive buffer (ICDRR), and transmit buffer (ICDRT). Data transfers among these three registers are performed automatically in accordance with changes in the bus state, and they affect the status of internal flags such as ICDRE and ICDRF.

In master transmit mode with the I²C bus format, writing transmit data to ICDR should be performed after start condition detection. When the start condition is detected, previous write data is ignored. In slave transmit mode, writing should be performed after the slave addresses match and the TRS bit is automatically changed to 1.

If the IIC is in transmit mode (TRS = 1) and ICDRT has the next transmit data (the ICDRE flag is 0) after successful transmission/reception of one frame of data using ICDRS, data is transferred automatically from ICDRT to ICDRS.

If the IIC is in transmit mode (TRS = 1) and ICDRT has the next data (the ICDRE flag is 0), data is transferred automatically from ICDRT to ICDRS, following transmission of one frame of data using ICDRS. When the ICDRE flag is 1 and the next transmit data writing is waited, data is transferred automatically from ICDRT to ICDRS by writing to ICDR. If I^2C is in receive mode (TRS = 0), no data is transferred from ICDRT to ICDRS. Note that data should not be written to ICDR in receive mode.

Reading receive data from ICDR is performed after data is transferred from ICDRS to ICDRR.

If I²C is in receive mode and no previous data remains in ICDRR (the ICDRF flag is 0), data is transferred automatically from ICDRS to ICDRR, following reception of one frame of data using ICDRS. If additional data is received while the ICDRF flag is 1, data is transferred automatically from ICDRS to ICDRR by reading from ICDR. In transmit mode, no data is transferred from ICDRS to ICDRR. Always set I²C to receive mode before reading from ICDR.

If the number of bits in a frame, excluding the acknowledge bit, is less than eight, transmit data and receive data are stored differently. Transmit data should be written justified toward the MSB side when MLS = 0 in ICMR, and toward the LSB side when MLS = 1. Receive data bits should be read from the LSB side when MLS = 0, and from the MSB side when MLS = 1.

ICDR can be written to and read from only when the ICE bit is set to 1 in ICCR. The initial value of ICDR is undefined.

16.3.2 Slave Address Register (SAR)

SAR sets the slave address and selects the communication format. If the LSI is in slave mode with the I²C bus format selected, when the FS bit is set to 0 and the upper 7 bits of SAR match the upper 7 bits of the first frame received after a start condition, the LSI operates as the slave device specified by the master device. SAR can be accessed only when the ICE bit in ICCR is cleared to 0.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | SVA6 | 0 | R/W | Slave Address 6 to 0 |
| 6 | SVA5 | 0 | R/W | Set a slave address. |
| 5 | SVA4 | 0 | R/W | |
| 4 | SVA3 | 0 | R/W | |
| 3 | SVA2 | 0 | R/W | |
| 2 | SVA1 | 0 | R/W | |
| 1 | SVA0 | 0 | R/W | |
| 0 | FS | 0 | R/W | Format Select |
| | | | | Selects the communication format together with the FSX bit in SARX and the SW bit in DDCSWR. Refer to table 16.2. |
| | | | | This bit should be set to 0 when general call address recognition is performed. |
| | | | | |

16.3.3 Second Slave Address Register (SARX)

SARX sets the second slave address and selects the communication format. In slave mode, transmit/receive operations by the DTC are possible when the received address matches the second slave address. If the LSI is in slave mode with the I²C bus format selected, when the FSX bit is set to 0 and the upper 7 bits of SARX match the upper 7 bits of the first frame received after a start condition, the LSI operates as the slave device specified by the master device. SARX can be accessed only when the ICE bit in ICCR is cleared to 0.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | SVAX6 | 0 | R/W | Second Slave Address 6 to 0 |
| 6 | SVAX5 | 0 | R/W | Set the second slave address. |
| 5 | SVAX4 | 0 | R/W | |
| 4 | SVAX3 | 0 | R/W | |
| 3 | SVAX2 | 0 | R/W | |
| 2 | SVAX1 | 0 | R/W | |
| 1 | SVAX0 | 0 | R/W | |
| 0 | FSX | 1 | R/W | Format Select X |
| | | | | Selects the communication format together with the FS bit in SAR and the SW bit in DDCSWR. Refer to table 16.2. |

Table 16.2 Communication Format

| DDCSWR | SAR | SARX | |
|--------|-----|------|---|
| SW | FS | FSX | Operating Mode |
| 0 | 0 | 0 | I ² C bus format |
| | | | SAR and SARX slave addresses recognized |
| | | | General call address recognized |
| | | 1 | I ² C bus format |
| | | | SAR slave address recognized |
| | | | SARX slave address ignored |
| | | | General call address recognized |
| | 1 | 0 | I ² C bus format |
| | | | SAR slave address ignored |
| | | | SARX slave address recognized |
| | | | General call address ignored |
| | | 1 | Clocked synchronous serial format |
| | | | SAR and SARX slave addresses ignored |
| | | | General call address ignored |
| 1 | 0 | 0 | Formatless mode (start/stop conditions not detected) |
| | | 1 | Acknowledge bit used |
| | 1 | 0 | |
| | | 1 | Formatless mode* (start/stop conditions not detected) |
| | | | No acknowledge bit |
| | | | Do not set this mode when automatic switching to the I ² C bus format is performed by means of the DDCSWR setting. |

- I²C bus format: addressing format with an acknowledge bit
- Clocked synchronous serial format: non-addressing format without an acknowledge bit, for master mode only
- Formatless mode (for IIC_0 only): non-addressing format with or without an acknowledge bit, slave mode only, start/stop conditions not detected

16.3.4 I²C Bus Mode Register (ICMR)

ICMR sets the communication format and transfer rate. It can only be accessed when the ICE bit in ICCR is set to 1.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | MLS | 0 | R/W | MSB-First/LSB-First Select |
| | | | | 0: MSB-first |
| | | | | 1: LSB-first |
| | | | | Set this bit to 0 when the I ² C bus format is used. |
| 6 | WAIT | 0 | R/W | Wait Insertion Bit |
| | | | | This bit is valid only in master mode with the I ² C bus format. |
| | | | | 0: Data and the acknowledge bit are transferred consecutively with no wait inserted. |
| | | | | 1: After the fall of the clock for the final data bit (8 th clock), the IRIC flag is set to 1 in ICCR, and a wait state begins (with SCL at the low level). When the IRIC flag is cleared to 0 in ICCR, the wait ends and the acknowledge bit is transferred. |
| | | | | For details, refer to section 16.4.7, IRIC Setting Timing and SCL Control. |
| 5 | CKS2 | 0 | R/W | Transfer Clock Select 2 to 0 |
| 4 | CKS1 | 0 | R/W | These bits are used only in master mode. |
| 3 | CKS0 | 0 | R/W | These bits select the required transfer rate, together with the IICX1 (IIC_1) and IICX0 (IIC_0) bits in STCR. Refer to table 16.3. |

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| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|-----|---|--|
| 2 | BC2 | 0 | R/W | Bit Counter 2 to 0 | |
| 1 | BC1 | 0 | R/W | These bits specify the | ne number of bits to be transferred next. |
| 0 | BC0 | 0 | R/W | Bit BC2 to BC0 settings should be made during an interval between transfer frames. If bits BC2 to BC0 are set to a value other than 000, the setting should be made while the SCL line is low. | |
| | | | | | itialized to 000 when a start condition is returns to 000 at the end of a data |
| | | | | I ² C Bus Format | Clocked Synchronous Serial Mode |
| | | | | 000: 9 bits | 000: 8 bits |
| | | | | 001: 2 bits | 001: 1 bits |
| | | | | 010: 3 bits | 010: 2 bits |
| | | | | 011: 4 bits | 011: 3 bits |
| | | | | 100: 5 bits | 100: 4 bits |
| | | | | 101: 6 bits | 101: 5 bits |
| | | | | 110: 7 bits | 110: 6 bits |
| | | | | 111: 8 bits | 111: 7 bits |

Table 16.3 I²C Transfer Rate

| STCR | | ICMR | | | | | | | |
|-----------------|-------|-------|-------|-------|-----------|-----------|---------------|------------|------------|
| Bits 5 and 6 | Bit 5 | Bit 4 | Bit 3 | _ | | | Transfer Rate | e | |
| IICX | CKS2 | CKS1 | CKS0 | Clock | ø = 5 MHz | ø = 8 MHz | ø = 10 MHz | ø = 16 MHz | ø = 20 MHz |
| 0 | 0 | 0 | 0 | ø/28 | 179 kHz | 286 kHz | 357 kHz | 517 kHz* | 714 kHz* |
| 0 | 0 | 0 | 1 | ø/40 | 125 kHz | 200 kHz | 250 kHz | 400 kHz | 500 kHz* |
| 0 | 0 | 1 | 0 | ø/48 | 104 kHz | 167 kHz | 208 kHz | 333 kHz | 417 kHz* |
| 0 | 0 | 1 | 1 | ø/64 | 78.1 kHz | 125 kHz | 156 kHz | 250 kHz | 313 kHz |
| 0 | 1 | 0 | 0 | ø/80 | 62.5 kHz | 100 kHz | 125 kHz | 200 kHz | 250 kHz |
| 0 | 1 | 0 | 1 | ø/100 | 50.0 kHz | 80.0 kHz | 100 kHz | 160 kHz | 200 kHz |
| 0 | 1 | 1 | 0 | ø/112 | 44.6 kHz | 71.4 kHz | 89.3 kHz | 143 kHz | 179 kHz |
| 0 | 1 | 1 | 1 | ø/128 | 39.1 kHz | 62.5 kHz | 78.1 kHz | 125 kHz | 156 kHz |
| 1 | 0 | 0 | 0 | ø/56 | 89.3 kHz | 143 kHz | 179 kHz | 286 kHz | 357 kHz |
| 1 | 0 | 0 | 1 | ø/80 | 62.5 kHz | 100 kHz | 125 kHz | 200 kHz | 250 kHz |
| 1 | 0 | 1 | 0 | ø/96 | 52.1 kHz | 83.3 kHz | 104 kHz | 167 kHz | 208 kHz |
| 1 | 0 | 1 | 1 | ø/128 | 39.1 kHz | 62.5 kHz | 78.1 kHz | 125 kHz | 156 kHz |
| 1 | 1 | 0 | 0 | ø/160 | 31.3 kHz | 50.0 kHz | 62.5 kHz | 100 kHz | 125 kHz |
| 1 | 1 | 0 | 1 | ø/200 | 25.0 kHz | 40.0 kHz | 50.0 kHz | 80.0 kHz | 100 kHz |
| 1 | 1 | 1 | 0 | ø/224 | 22.3 kHz | 35.7 kHz | 44.6 kHz | 71.4 kHz | 89.3 kHz |
| 1 | 1 | 1 | 1 | ø/256 | 19.5 kHz | 31.3 kHz | 39.1 kHz | 62.5 kHz | 78.1 kHz |

Note:* Outside the I²C bus interface specifications (standard mode: max. 100 kHz; high-speed mode: max. 400 kHz)

16.3.5 I²C Bus Control Register (ICCR)

ICCR controls the I²C bus interface and performs interrupt flag confirmation.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ICE | 0 | R/W | I ² C Bus Interface Enable |
| | | | | 0: I ² C bus interface modules are stopped and I ² C bus interface module internal state is initialized. SAR and SARX can be accessed. |
| | | | | 1: I ² C bus interface modules can perform transfer operation, and the ports function as the SCL and SDA input/output pins. ICMR and ICDR can be accessed. |
| 6 | IEIC | 0 | R/W | I ² C Bus Interface Interrupt Enable |
| | | | | 0: Disables interrupts from the I ² C bus interface to the CPU |
| | | | | 1: Enables interrupts from the I ² C bus interface to the CPU. |
| 5 | MST | 0 | R/W | Master/Slave Select |
| 4 | TRS | 0 | R/W | Transmit/Receive Select |
| | | | | 00: Slave receive mode |
| | | | | 01: Slave transmit mode |
| | | | | 10: Master receive mode |
| | | | | 11: Master transmit mode |
| | | | | Both these bits will be cleared by hardware when they lose in a bus contention in master mode with the I ² C bus format. In slave receive mode with I ² C bus format, the R/W bit in the first frame immediately after the start condition sets these bits in receive mode or transmit mode automatically by hardware. |
| | | | | Modification of the TRS bit during transfer is deferred until transfer is completed, and the changeover is made after completion of the transfer. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 5 | MST | 0 | R/W | [MST clearing conditions] |
| 4 | TRS | 0 | | 1. When 0 is written by software |
| | | | | When lost in bus contention in I²C bus format master mode |
| | | | | [MST setting conditions] |
| | | | | When 1 is written by software (for MST clearing condition 1) |
| | | | | When 1 is written in MST after reading MST = 0 (for MST clearing condition 2) |
| | | | | [TRS clearing conditions] |
| | | | | When 0 is written by software (except for TRS setting condition 3) |
| | | | | When 0 is written in TRS after reading TRS = 1 (for TRS setting condition 3) |
| | | | | When lost in bus contention in I ² C bus format master mode |
| | | | | 4. When the SW bit in DDCSWR is changed from 1 to 0 [TRS setting conditions] |
| | | | | When 1 is written by software (except for TRS clearing conditions 3 and 4) |
| | | | | When 1 is written in TRS after reading TRS = 0 (for TRS clearing conditions 3 and 4) |
| | | | | 3. When 1 is received as the R/W bit after the first frame address matching in I ² C bus format slave mode |
| 3 | ACKE | 0 | R/W | Acknowledge Bit Decision and Selection |
| | | | | 0: The value of the acknowledge bit is ignored, and continuous transfer is performed. The value of the received acknowledge bit is not indicated by the ACKB bit in ICSR, which is always 0. |
| | | | | 1: If the received acknowledge bit is 1, continuous transfer is halted. |
| | | | | Depending on the receiving device, the acknowledge bit may be significant, in indicating completion of processing of the received data, for instance, or may be fixed at 1 and have no significance. |
| | | | | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | BBSY | 0 | R/W | Bus Busy |
| 0 | SCP | 1 | W | Start Condition/Stop Condition Prohibit |
| | | | | In master mode: |
| | | | | Writing 0 in BBSY and 0 in SCP: A stop condition is issued |
| | | | | Writing 1 in BBSY and 0 in SCP: A start condition and a restart condition are issued |
| | | | | In slave mode: |
| | | | | Writing to the BBSY flag is disabled. |
| | | | | [BBSY setting condition] |
| | | | | When the SDA level changes from high to low under the condition of SCL = high, assuming that the start condition has been issued. |
| | | | | [BBSY clearing condition] |
| | | | | When the SDA level changes from low to high under the condition of SCL = high, assuming that the stop condition has been issued. |
| | | | | To issue a start/stop condition, use the MOV instruction. |
| | | | | The I ² C bus interface must be set in master transmit mode before the issue of a start condition. Set MST to 1 and TRS to 1 before writing 1 in BBSY and 0 in SCP. |
| | | | | The BBSY flag can be read to check whether the I ² C bus (SCL, SDA) is busy or free. |
| | | | | The SCP bit is always read as 1. If 0 is written, the data is not stored. |

| Interface Interrupt Request Flag |
|---|
| |
| es that the I ² C bus interface has issued an interrupt to the CPU. |
| set at different times depending on the FS bit in the FSX bit in SARX, and the WAIT bit in ICMR. See 16.4.7, IRIC Setting Timing and SCL Control. The cons under which IRIC is set also differ depending on ting of the ACKE bit in ICCR. |
| g conditions] |
| format master mode: |
| en a start condition is detected in the bus line state er a start condition is issued (when the ICDRE flag is to 1 because of first frame transmission) en a wait is inserted between the data and mowledge bit when the WAIT bit is 1 (fall of the 8th |
| nsmit/receive clock) |
| he end of data transfer (rise of the 9th name) |
| en a slave address is received after bus arbitration ost (the first frame after the start condition) |
| is received as the acknowledge bit (when the ACKB in ICSR is set to 1) when the ACKE bit is 1 |
| en the AL flag is set to 1 after bus arbitration is lost le the ALIE bit is 1 |
| format slave mode: |
| en the slave address (SVA or SVAX) matches en the AAS or AASX flag in ICSR is set to 1) and at end of data transfer up to the subsequent ansmission start condition or stop condition ection (rise of the 9th transmit/receive clock) |
| en the general call address is detected (when 0 is eived as the R/W bit and the ADZ flag in ICSR is set) and at the end of data reception up to the esequent retransmission start condition or stop edition detection (rise of the 9th receive clock) |
| is received as the acknowledge bit (when the ACKB in ICSR is set to 1) while the ACKE bit is 1 |
| en a stop condition is detected (when the STOP or TP flag in ICSR is set to 1) while the STOPIM bit is 0 |
| |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 1 | IRIC | 0 | R/W | Clocked synchronous serial format and formatless modes: |
| | | | | At the end of data transfer (rise of the 8th transmit/receive clock with serial format selected and rise of the 9th transmit/receive clock with formatless selected) |
| | | | | When a start condition is detected with serial format selected |
| | | | | When the SW bit in DDCSWR is set to 1 |
| | | | | When the ICDRE or ICDRF flag is set to 1 in any operating mode: |
| | | | | When a start condition is detected in transmit mode (when a start condition is detected in transmit mode and the ICDRE flag is set to 1) |
| | | | | When data is transferred among the ICDR register and buffer (when data is transferred from ICDRT to ICDRS in transmit mode and the ICDRE flag is set to 1, or when data is transferred from ICDRS to ICDRR in receive mode and the ICDRF flag is set to 1) |
| | | | | [Clearing conditions] |
| | | | | When 0 is written in IRIC after reading IRIC = 1 |
| | | | | When ICDR is read from or written to by the DTC (This may not function as a clearing condition depending on the situation. For details, see the description of the DTC operation given below.) |

Note: *Only 0 can be written, to clear the flag.

When the DTC is used, IRIC is cleared automatically and transfer can be performed continuously without CPU intervention.

When, with the I²C bus format selected, IRIC is set to 1 and an interrupt is generated, other flags must be checked in order to identify the source that set IRIC to 1. Although each source has a corresponding flag, caution is needed at the end of a transfer.

When the ICDRE or ICDRF flag is set, the IRTR flag may or may not be set. The IRTR flag (the DTC start request flag) is not set at the end of a data transfer up to detection of a retransmission start condition or stop condition after a slave address (SVA) or general call address match in I²C bus format slave mode.

Even when the IRIC flag and IRTR flag are set, the ICDRE or ICDRF flag may not be set. The IRIC and IRTR flags are not cleared at the end of the specified number of transfers in continuous transfer using the DTC. The ICDRE or ICDRF flag is cleared, however, since the specified number of ICDR reads or writes have been completed.

Tables 16.4 and 16.5 show the relationship between the flags and the transfer states.

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Table 16.4 Flags and Transfer States (Master Mode)

| MST | TRS | BBSY | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | ICDRF | ICDRE | State |
|-----|-----|------|------|------|------|------|----|-----|-----|------|-------|----------|---|
| 1 | 1 | 0 | 0 | 0 | 0 | 0∤ | 0 | 0↓ | 0↓ | 0 | _ | 0 | Idle state (flag clearing required) |
| 1 | 1 | 1↑ | 0 | 0 | 1↑ | 0 | 0 | 0 | 0 | 0 | _ | 1↑ | Start condition detected |
| 1 | _ | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | _ | _ | _ | Wait state |
| 1 | 1 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | 1↑ | _ | _ | Transmission end (ACKE=1 and ACKB=1) |
| 1 | 1 | 1 | 0 | 0 | 1↑ | 0 | 0 | 0 | 0 | 0 | _ | 1↑ | Transmission end with ICDRE=0 |
| 1 | 1 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | 0 | _ | 0↓ | ICDR write with the above state |
| 1 | 1 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | 0 | _ | 1 | Transmission end with ICDRE=1 |
| 1 | 1 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | 0 | _ | 0↓ | ICDR write with the above state or after start condition detected |
| 1 | 1 | 1 | 0 | 0 | 1↑ | 0 | 0 | 0 | 0 | 0 | | 1↑ | Automatic data transfer from ICDRT to ICDRS with the above state |
| 1 | 0 | 1 | 0 | 0 | 1↑ | 0 | 0 | 0 | 0 | _ | 1↑ | _ | Reception end with ICDRF=0 |
| 1 | 0 | 1 | 0 | 0 | | 0 | 0 | 0 | 0 | | 0↓ | | ICDR read with the above state |
| 1 | 0 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | _ | 1 | _ | Reception end with ICDRF=1 |
| 1 | 0 | 1 | 0 | 0 | _ | 0 | 0 | 0 | 0 | _ | 0↓ | <u>—</u> | ICDR read with the above state |
| 1 | 0 | 1 | 0 | 0 | 1↑ | 0 | 0 | 0 | 0 | _ | 1↑ | _ | Automatic data transfer from ICDRS to ICDRR with the above state |

| MST | TRS | BBSY | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | ICDRF | ICDRE | State |
|-----|-----|------|------|------|------|------|----|-----|-----|------|-------|-------|-------------------------|
| 0↓ | 0↓ | 1 | 0 | 0 | _ | 0 | 1↑ | 0 | 0 | _ | _ | _ | Arbitration lost |
| 1 | _ | 0↓ | 0 | 0 | _ | 0 | 0 | 0 | 0 | _ | _ | 0 | Stop condition detected |

Legend

0: 0-state retained

1: 1-state retained

—: Previous state retained

0↓: Cleared to 0

1↑: Set to 1

Table 16.5 Flags and Transfer States (Slave Mode)

| MST | TRS | BBSY | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | ICDRF | ICDRE | State |
|-----|------------|------|------|------|-------------|-------------|----|-----|-----|--------------|-------|-------------|---|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | _ | 0 | Idle state (flag clearing required) |
| 0 | 0 | 1↑ | 0 | 0 | 0 | 0↓ | 0 | 0 | 0 | 0 | _ | 1↑ | Start condition detected |
| 0 | 1↑/0 *1 | 1 | 0 | 0 | 0 | 0 | _ | 1↑ | 0 | 0 | 1↑ | 1 | SAR match in first frame (SARX≠SAR) |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | _ | 1↑ | 1↑ | 0 | 1↑ | 1 | General call address match in first frame (SARX≠H'00) |
| 0 | 1↑/0 *1 | 1 | 0 | 0 | 1↑ | 1↑ | _ | 0 | 0 | 0 | 1↑ | 1 | SARS match in first frame (SAR≠SARX) |
| 0 | 1 | 1 | 0 | 0 | _ | _ | _ | _ | 0 | 1↑ | _ | _ | Transmission end (ACKE=1 and ACKB=1) |
| 0 | 1 | 1 | 0 | 0 | 1^/0 *1 | _ | _ | _ | 0 | 0 | _ | 1↑ | Transmission end with ICDRE=0 |
| 0 | 1 | 1 | 0 | 0 | _ | _ | 0↓ | 0↓ | 0 | 0 | | 0↓ | ICDR write with the above state |
| 0 | 1 | 1 | 0 | 0 | _ | _ | _ | _ | 1 | 0 | | 1 | Transmission end with ICDRE=1 |
| 0 | 1 | 1 | 0 | 0 | | | 0↓ | 0↓ | 0 | 0 | | 0↓ | ICDR write with the above state |
| 0 | 1 | 1 | 0 | 0 | 1↑/0 *² | | 0 | 0 | 0 | 0 | | 1↑ | Automatic data transfer from ICDRT to ICDRS with the above state |
| 0 | 0 | 1 | 0 | 0 | 1↑/0 *² | _ | _ | _ | _ | _ | 1↑ | _ | Reception end with ICDRF=0 |
| 0 | 0 | 1 | 0 | 0 | | | 0↓ | 0↓ | 0↓ | _ | 0↓ | | ICDR read with the above state |

| MST | TRS | BBSY | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | ICDRF | ICDRE | State |
|-----|-----|------|-------------------|------------|------------|----------|----|-----|-----|------|-------|-------|--|
| 0 | 0 | 1 | 0 | 0 | _ | _ | _ | _ | _ | _ | 1 | _ | Reception end with ICDRF=1 |
| 0 | 0 | 1 | 0 | 0 | | <u>—</u> | 0↓ | 0↓ | 0↓ | | 0↓ | | ICDR read with the above state |
| 0 | 0 | 1 | 0 | 0 | 1↑/0 *² | _ | 0 | 0 | 0 | | 1↑ | | Automatic data transfer from ICDRS to ICDRR with the above state |
| 0 | _ | 0↓ | 1 ¹ /0 | 0/1↑ *³ | _ | _ | _ | _ | _ | _ | _ | 0 | Stop condition detected |

Legend

0: 0-state retained

1: 1-state retained

—: Previous state retained

0↓: Cleared to 0

1↑: Set to 1

Notes: 1. Set to 1 when 1 is received as a R/\overline{W} bit following an address.

2. Set to 1 when the AASX bit is set to 1.

3. When ESTP=1, STOP is 0, or when STOP=1, ESTP is 0.

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16.3.6 I²C Bus Status Register (ICSR)

ICSR consists of status flags. Also see tables 16.4 and 16.5.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 7 | ESTP | 0 | R/(W)* | Error Stop Condition Detection Flag |
| | | | | This bit is valid in I ² C bus format slave mode. |
| | | | | [Setting condition] |
| | | | | When a stop condition is detected during frame transfer. |
| | | | | [Clearing conditions] |
| | | | | When 0 is written in ESTP after reading ESTP = 1 |
| | | | | When the IRIC flag in ICCR is cleared to 0 |
| 6 | STOP | 0 | R/(W)* | Normal Stop Condition Detection Flag |
| | | | | This bit is valid in I ² C bus format slave mode. |
| | | | | [Setting condition] |
| | | | | When a stop condition is detected after frame transfer completion. |
| | | | | [Clearing conditions] |
| | | | | When 0 is written in STOP after reading STOP = 1 |
| | | | | When the IRIC flag is cleared to 0 |
| 5 | IRTR | 0 | R/(W)* | I ² C Bus Interface Continuous Transfer Interrupt Request Flag |
| | | | | Indicates that the I ² C bus interface has issued an interrupt request to the CPU, and the source is completion of reception/transmission of one frame in continuous transmission/reception for which DTC activation is possible. When the IRTR flag is set to 1, the IRIC flag is also set to 1 at the same time. |
| | | | | [Setting conditions] |
| | | | | I ² C bus format slave mode: |
| | | | | When the ICDRE or ICDRF flag in ICDR is set to 1 when AASX = 1 |
| | | | | Master mode or clocked synchronous serial format mode with I ² C bus format, or formatless mode: |
| | | | | When the ICDRE or ICDRF flag is set to 1 |
| | | | | [Clearing conditions] |
| | | | | When 0 is written after reading IRTR = 1 |
| | | | | When the IRIC flag is cleared to 0 while ICE is 1 |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 4 | AASX | 0 | R/(W)* | Second Slave Address Recognition Flag |
| | | | | In I ² C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVAX6 to SVAX0 in SARX. |
| | | | | [Setting condition] |
| | | | | When the second slave address is detected in slave receive mode and FSX = 0 in SARX |
| | | | | [Clearing conditions] |
| | | | | When 0 is written in AASX after reading AASX = 1 |
| | | | | When a start condition is detected |
| | | | | In master mode |
| 3 | AL | 0 | R/(W)* | Arbitration Lost Flag |
| | | | | Indicates that arbitration was lost in master mode. |
| | | | | [Setting conditions] |
| | | | | When ALSL=0 |
| | | | | • If the internal SDA and SDA pin disagree at the rise of SCL in master transmit mode |
| | | | | If the internal SCL line is high at the fall of SCL in master transmit mode |
| | | | | When ALSL=1 |
| | | | | If the internal SDA and SDA pin disagree at the rise of SCL in master transmit mode |
| | | | | • If the SDA pin is driven low by another device before the I ² C bus interface drives the SDA pin low, after the start condition instruction was executed in master transmit mode |
| | | | | [Clearing conditions] |
| | | | | When ICDR is written to (transmit mode) or read from (receive mode) |
| | | | | • When 0 is written in AL after reading AL = 1 |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 2 | AAS | 0 | R/(W)* | Slave Address Recognition Flag |
| | | | | In I ² C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVA6 to SVA0 in SAR, or if the general call address (H'00) is detected. |
| | | | | [Setting condition] |
| | | | | When the slave address or general call address (one frame including a R/\overline{W} bit is H'00) is detected in slave receive mode and FS = 0 in SAR |
| | | | | [Clearing conditions] |
| | | | | When ICDR is written to (transmit mode) or read from |
| | | | | (receive mode) |
| | | | | When 0 is written in AAS after reading AAS = 1 |
| | | | | In master mode |
| 1 | ADZ | 0 | R/(W)* | General Call Address Recognition Flag |
| | | | | In I ² C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition is the general call address (H'00). |
| | | | | [Setting condition] |
| | | | | When the general call address (one frame including a R/ \overline{W} bit is H'00) is detected in slave receive mode and FS = 0 or FSX = 0 |
| | | | | [Clearing conditions] |
| | | | | When ICDR is written to (transmit mode) or read from (receive mode) |
| | | | | When 0 is written in ADZ after reading ADZ = 1 |
| | | | | In master mode |
| | | | | If a general call address is detected while FS=1 and FSX=0, the ADZ flag is set to 1; however, the general call address is not recognized (AAS flag is not set to 1). |
| | | | | |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|------------------|-----|---|
| 0 | ACKB | 0 | R/W | Acknowledge Bit |
| | | | | Stores acknowledge data. |
| | | | | Transmit mode: |
| | | | | [Setting condition] |
| | | | | When 1 is received as the acknowledge bit when ACKE=1 in transmit mode |
| | | | | [Clearing conditions] |
| | | | | When 0 is received as the acknowledge bit when ACKE=1 in transmit mode |
| | | | | When 0 is written to the ACKE bit |
| | | | | Receive mode: |
| | | | | 0: Returns 0 as acknowledge data after data reception |
| | | | | 1: Returns 1 as acknowledge data after data reception |
| | | | | When this bit is read, the value loaded from the bus line (returned by the receiving device) is read in transmission (when TRS = 1). In reception (when TRS = 0), the value set by internal software is read. |
| | | | | When this bit is written, acknowledge data that is returned after receiving is rewritten regardless of the TRS value. If the ICSR register bit is written using bit-manipulation instructions, the acknowledge data should be re-set since the acknowledge data setting is rewritten by the ACKB bit reading value. |
| | | oon ho writton t | | Write the ACKE bit to 0 to clear the ACKB flag to 0, before transmission is ended and a stop condition is issued in master mode, or before transmission is ended and SDA is released to issue a stop condition by a master device. |

Note:* Only 0 can be written to clear the flag.

16.3.7 DDC Switch Register (DDCSWR)

DDCSWR controls the IIC_0 automatic format switching function and IIC internal latch clearance.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|---------|---|
| 7 | SWE | 0 | R/W | DDC Mode Switch Enable |
| | | | | 0: Disables automatic switching of IIC channel 0 from formatless mode to I ² C bus format |
| | | | | 1: Enables automatic switching of IIC channel 0 from formatless mode to I ² C bus format |
| 6 | SW | 0 | R/W | DDC Mode Switch |
| | | | | 0: Uses IIC channel 0 with the I ² C bus format |
| | | | | 1: Uses IIC channel 0 in formatless mode |
| | | | | [Setting condition] |
| | | | | When 1 is written in SW after reading SW = 0 |
| | | | | [Clearing conditions] |
| | | | | When 0 is written by software |
| | | | | When a falling edge is detected on the SCL pin when SWE = 1 |
| 5 | IE | 0 | R/W | DDC Mode Switch Interrupt Enable Bit |
| | | | | 0: Disables interrupts when automatic format switching is executed |
| | | | | 1: Enables interrupts when automatic format switching is executed |
| 4 | IF | 0 | R/(W)*1 | DDC Mode Switch Interrupt Flag |
| | | | | Indicates an interrupt request to the CPU is generated when automatic format switching is executed for IIC_0. |
| | | | | [Setting condition] |
| | | | | When a falling edge is detected on the SCL pin when SWE = 1 |
| | | | | [Clearing condition] |
| | | | | When 0 is written in IF after reading IF = 1 |

| Bit Name | Initial Value | R/W | Description |
|----------|----------------------|----------------------------|---|
| CLR3 | 1 | W* ² | IIC Clear 3 to 0 |
| CLR2 | 1 | | Controls initialization of the internal state of IIC_0 and |
| CLR1 | 1 | | IIC_1. |
| CLR0 | 1 | | 00: Setting prohibited |
| | | | 0100: Setting prohibited |
| | | | 0101: IIC_0 internal latch cleared |
| | | | 0110: IIC_1 internal latch cleared |
| | | | 0111: IIC_0 and IIC_1 internal latches cleared |
| | | | 1: Invalid setting |
| | | | When a write operation is performed on these bits, a clear signal is generated for the internal latch circuit of the corresponding module, and the internal state of the IIC module is initialized. |
| | | | These bits can only be written to; they are always read as 1. Write data to this bit is not retained. |
| | | | To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR. |
| | | | When clearing is required again, all the bits must be written to in accordance with the setting. |
| | | | If the function of these bits is not used, set all of the CLR3 to CLR0 bits to 1 when writing to DDCSWR. |
| | CLR3 CLR2 CLR1 | CLR3 1 CLR2 1 CLR1 1 | CLR3 1 W* ² CLR2 1 CLR1 1 |

Notes: 1. Only 0 can be written, to clear the flag.

2. This bit is always read as 1.

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16.3.8 I²C Bus Extended Control Register (ICXR)

ICXR enables or disables the I²C bus interface interrupt generation and continuous receive operation, and indicates the status of receive/transmit operations.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | STOPIM | 0 | R/W | Stop Condition Interrupt Source Mask |
| | | | | Enables or disables the interrupt generation when the stop condition is detected in slave mode. |
| | | | | 0: Enables IRIC flag setting and interrupt generation when the stop condition is detected (STOP = 1 or ESTP = 1) in slave mode. |
| | | | | 1: Disables IRIC flag setting and interrupt generation when the stop condition is detected. |
| 6 | HNDS | 0 | R/W | Handshake Receive Operation Select |
| | | | | Enables or disables continuous receive operation in receive mode. |
| | | | | 0: Enables continuous receive operation |
| | | | | 1: Disables continuous receive operation |
| | | | | When the HNDS bit is cleared to 0, receive operation is performed continuously after data has been received successfully while ICDRF flag is 0. |
| | | | | When the HNDS bit is set to 1, SCL is fixed to the low level and the next data transfer is disabled after data has been received successfully while the ICDRF flag is 0. The bus line is released and next receive operation is enabled by reading the receive data in ICDR. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 5 | ICDRF | 0 | R | Receive Data Read Request Flag |
| | | | | Indicates the ICDR (ICDRR) status in receive mode. |
| | | | | 0: Indicates that the data has been already read from ICDR (ICDRR) or ICDR is initialized. |
| | | | | 1: Indicates that data has been received successfully and transferred from ICDRS to ICDRR, and the data is ready to be read out. |
| | | | | [Setting conditions] |
| | | | | When data is received successfully and transferred from ICDRS to ICDRR. |
| | | | | (1) When data is received successfully while ICDRF = 0 (at the rise of the 9th clock pulse). |
| | | | | (2) When ICDR is read successfully in receive mode after data was received while ICDRF = 1. |
| | | | | [Clearing conditions] |
| | | | | When ICDR (ICDRR) is read. |
| | | | | When 0 is written to the ICE bit. |
| | | | | When the IIC is internally initialized using the CLR3 to CLR0 bits in DDCSWR. |
| | | | | When ICDRF is set due to the condition (2) above, ICDRF is temporarily cleared to 0 when ICDR (ICDRR) is read; however, since data is transferred from ICDRS to ICDRR immediately, ICDRF is set to 1 again. |
| | | | | Note that ICDR cannot be read successfully in transmit mode (TRS = 1) because data is not transferred from ICDRS to ICDRR. Be sure to read data from ICDR in receive mode (TRS = 0). |

| | | Initial Value | R/W | Description |
|---|-------|---------------|-----|--|
| 4 | ICDRE | 0 | R | Transmit Data Write Request Flag |
| | | | | Indicates the ICDR (ICDRT) status in transmit mode. |
| | | | | 0: Indicates that the data has been already written to ICDR (ICDRT) or ICDR is initialized. |
| | | | | 1: Indicates that data has been transferred from ICDRT to ICDRS and is being transmitted, or the start condition has been detected or transmission has been complete, thus allowing the next data to be written to. |
| | | | | [Setting conditions] |
| | | | | When the start condition is detected from the bus line state with I²C bus format or serial format. |
| | | | | When I²C bus mode is switched to formatless (when the SW bit in DDCSWR is set to 1). |
| | | | | When data is transferred from ICDRT to ICDRS. |
| | | | | When data transmission completed while ICDRE = 0 (at the rise of the 9th clock pulse). |
| | | | | When data is written to ICDR in transmit mode after data transmission was completed while ICDRE = 1. |
| | | | | [Clearing conditions] |
| | | | | When data is written to ICDR (ICDRT). |
| | | | | When the stop condition is detected with I²C bus format or serial format. |
| | | | | When 0 is written to the ICE bit. |
| | | | | When the IIC is internally initialized using the CLR3 to CLR0 bits in DDCSWR. |
| | | | | Note that if the ACKE bit is set to 1 with I ² C bus format thus enabling acknowledge bit decision, ICDRE is not set when data transmission is completed while the acknowledge bit is 1. |
| | | | | When ICDRE is set due to the condition (2) above, ICDRE is temporarily cleared to 0 when data is written to ICDR (ICDRT); however, since data is transferred from ICDRT to ICDRS immediately, ICDRE is set to 1 again. Do not write data to ICDR when TRS = 0 because the ICDRE flag value is invalid during the time. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 3 | ALIE | 0 | R/W | Arbitration Lost Interrupt Enable |
| | | | | Enables or disables IRIC flag setting and interrupt generation when arbitration is lost. |
| | | | | 0: Disables interrupt request when arbitration is lost. |
| | | | | 1: Enables interrupt request when arbitration is lost. |
| 2 | ALSL | 0 | R/W | Arbitration Lost Condition Select |
| | | | | Selects the condition under which arbitration is lost. |
| | | | | 0: When the SDA pin state disagrees with the data that IIC bus interface outputs at the rise of SCL, or when the SCL pin is driven low by another device. |
| | | | | 1: When the SDA pin state disagrees with the data that IIC bus interface outputs at the rise of SCL, or when the SDA line is driven low by another device in idle state or after the start condition instruction was executed. |
| 1 | FNC1 | 0 | R/W | Function Bit |
| 0 | FNC0 | 0 | R/W | Cancels some restrictions on usage. For details, refer to section 16.6, Usage Notes. |
| | | | | 00: Restrictions on operation remaining in effect |
| | | | | 01: Setting prohibited |
| | | | | 10: Setting prohibited |
| | | | | 11: Restrictions on operation canceled |

16.4 Operation

The I²C bus interface has an I²C bus format and a serial format.

16.4.1 I²C Bus Data Format

The I²C bus format is an addressing format with an acknowledge bit. This is shown in figure 16.3. The first frame following a start condition always consists of 9 bits.

IIC_0 only is capable of formatless operation, as shown in figure 16.4.

The serial format is a non-addressing format with no acknowledge bit. This is shown in figure 16.5.

Figure 16.6 shows the I²C bus timing.

The symbols used in figures 16.3 to 16.6 are explained in table 16.6.

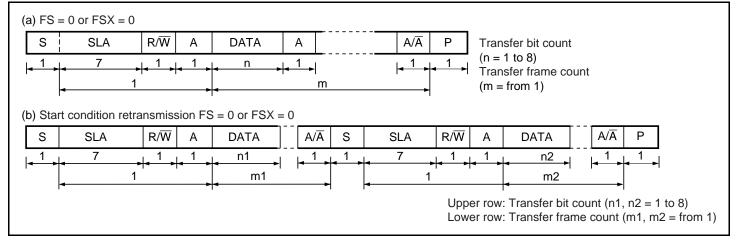


Figure 16.3 I²C Bus Data Format (I²C Bus Format)

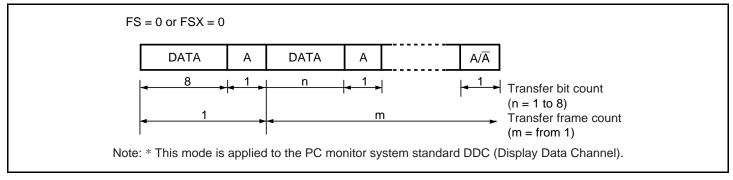


Figure 16.4 I²C Bus Data Format (Formatless) (IIC_0 Only)

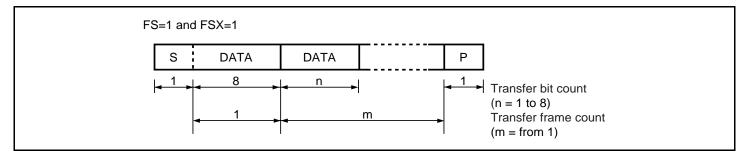


Figure 16.5 I²C Bus Data Format (Serial Format)

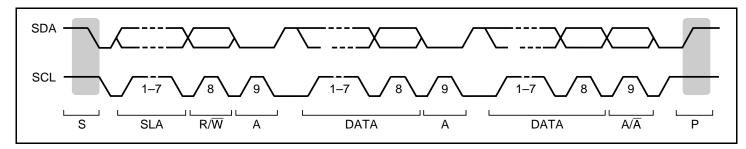


Figure 16.6 I²C Bus Timing

Table 16.6 I²C Bus Data Format Symbols

| Legend | |
|--------|---|
| S | Start condition. The master device drives SDA from high to low while SCL is high |
| SLA | Slave address. The master device selects the slave device. |
| R/W | Indicates the direction of data transfer: from the slave device to the master device when R/\overline{W} is 1, or from the master device to the slave device when R/\overline{W} is 0 |
| A | Acknowledge. The receiving device drives SDA low to acknowledge a transfer. (The slave device returns acknowledge in master transmit mode, and the master device returns acknowledge in master receive mode.) |
| DATA | Transferred data. The bit length of transferred data is set with the BC2 to BC0 bits in ICMR. The MSB first or LSB first is switched with the MLS bit in ICMR. |
| Р | Stop condition. The master device drives SDA from low to high while SCL is high |

16.4.2 Initialization

Initialize the IIC by the procedure shown in figure 16.7 before starting transmission/reception of data.

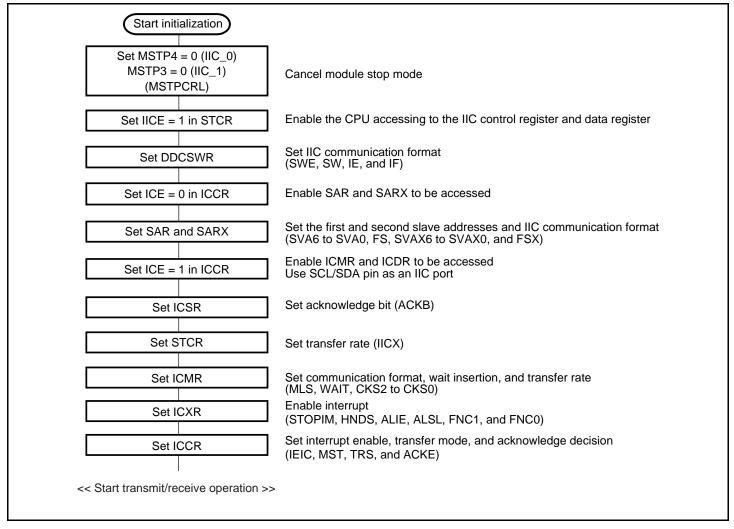


Figure 16.7 Sample Flowchart for IIC Initialization

Note: Be sure to modify the ICMR register after transmit/receive operation has been completed. If the ICMR register is modified during transmit/receive operation, bit counter BC2 to BC0 will be modified erroneously, thus causing incorrect operation.

16.4.3 Master Transmit Operation

In I²C bus format master transmit mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal.

Figure 16.8 shows the sample flowchart for the operations in master transmit mode.

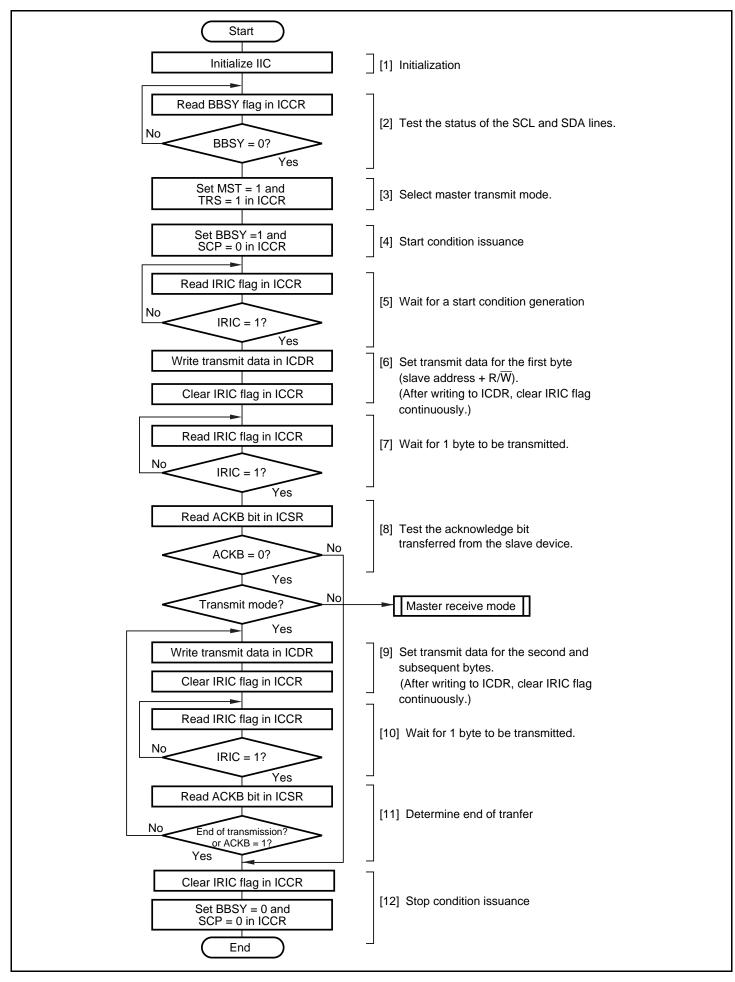


Figure 16.8 Sample Flowchart for Operations in Master Transmit Mode

The transmission procedure and operations by which data is sequentially transmitted in synchronization with ICDR (ICDRT) write operations, are described below.

- 1. Initialize the IIC as described in section 16.4.2, Initialization.
- 2. Read the BBSY flag in ICCR to confirm that the bus is free.
- 3. Set bits MST and TRS to 1 in ICCR to select master transmit mode.
- 4. Write 1 to BBSY and 0 to SCP in ICCR. This changes SDA from high to low when SCL is high, and generates the start condition.
- 5. Then the IRIC and IRTR flags are set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU.
- 6. Write the data (slave address + R/\overline{W}) to ICDR.
 - With the I²C bus format (when the FS bit in SAR or the FSX bit in SARX is 0), the first frame data following the start condition indicates the 7-bit slave address and transmit/receive direction (R/\overline{W}).
 - To determine the end of the transfer, the IRIC flag is cleared to 0. After writing to ICDR, clear IRIC continuously so no other interrupt handling routine is executed. If the time for transmission of one frame of data has passed before the IRIC clearing, the end of transmission cannot be determined. The master device sequentially sends the transmission clock and the data written to ICDR. The selected slave device (i.e. the slave device with the matching slave address) drives SDA low at the 9th transmit clock pulse and returns an acknowledge signal.
- 7. When one frame of data has been transmitted, the IRIC flag is set to 1 at the rise of the 9th transmit clock pulse. After one frame has been transmitted, SCL is automatically fixed low in synchronization with the internal clock until the next transmit data is written.
- 8. Read the ACKB bit in ICSR to confirm that ACKB is cleared to 0. When the slave device has not acknowledged (ACKB bit is 1), operate step [12] to end transmission, and retry the transmit operation.
- 9. Write the transmit data to ICDR.
 - As indicating the end of the transfer, the IRIC flag is cleared to 0. Perform the ICDR write and the IRIC flag clearing sequentially, just as in step [6]. Transmission of the next frame is performed in synchronization with the internal clock.
- 10. When one frame of data has been transmitted, the IRIC flag is set to 1 at the rise of the 9th transmit clock pulse. After one frame has been transmitted, SCL is automatically fixed low in synchronization with the internal clock until the next transmit data is written.
- 11. Read the ACKB bit in ICSR.
 - Confirm that the slave device has been acknowledged (ACKB bit is 0). When there is still data to be transmitted, go to step [9] to continue the next transmission operation. When the slave device has not acknowledged (ACKB bit is set to 1), operate step [12] to end transmission.
- 12. Clear the IRIC flag to 0.
 - Write 0 to ACKE in ICCR, to clear received ACKB contents to 0.

Write 0 to BBSY and SCP in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition.

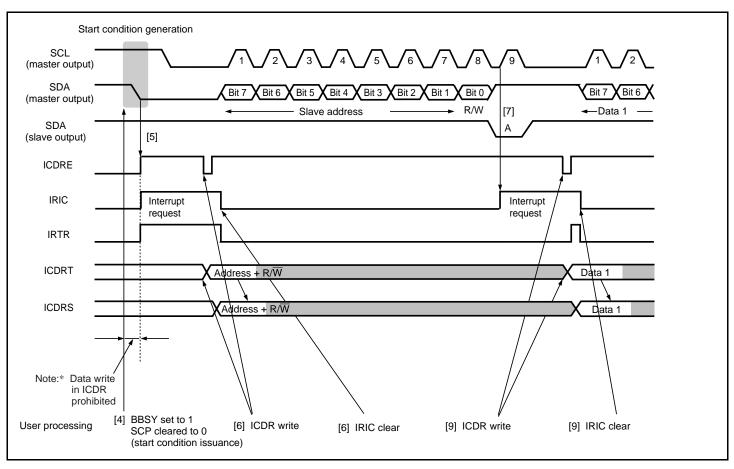


Figure 16.9 Example of Operation Timing in Master Transmit Mode (MLS = WAIT = 0)

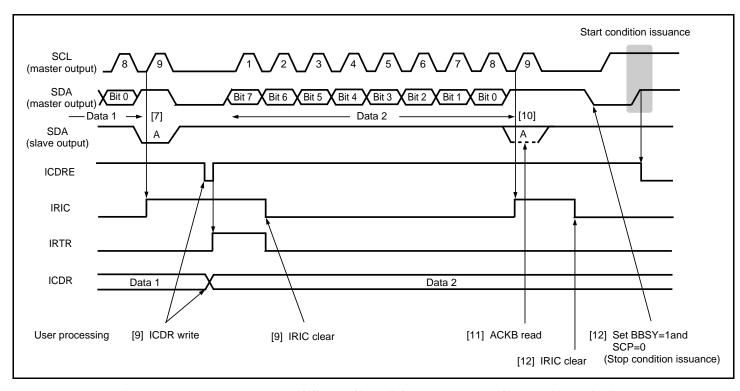


Figure 16.10 Example of Stop Condition Issuance Operation Timing in Master Transmit Mode (MLS = WAIT = 0)

16.4.4 Master Receive Operation

In I²C bus format master receive mode, the master device outputs the receive clock, receives data, and returns an acknowledge signal. The slave device transmits data.

The master device transmits data containing the slave address and R/\overline{W} (1: read) in the first frame following the start condition issuance in master transmit mode, selects the slave device, and then switches the mode for receive operation.

Receive Operation Using the HNDS Function (HNDS = 1):

Figure 16.11 shows the sample flowchart for the operations in master receive mode (HNDS = 1).

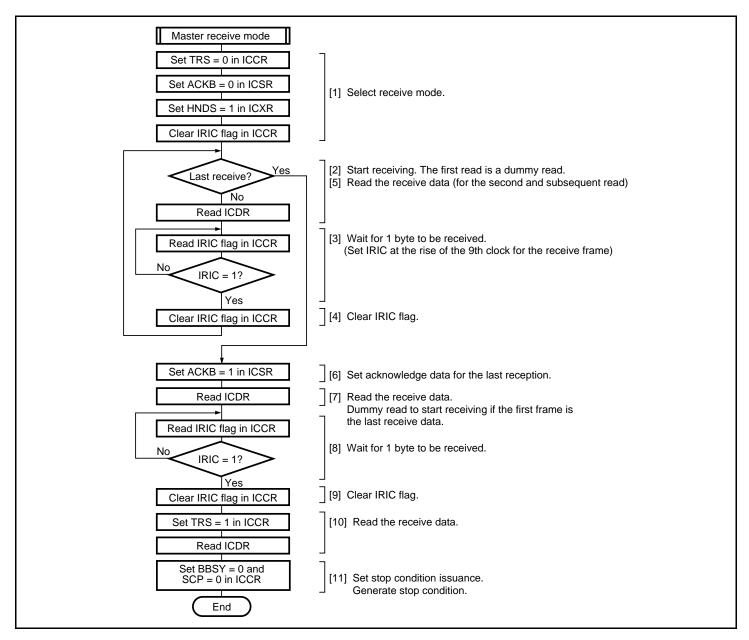


Figure 16.11 Sample Flowchart for Operations in Master Receive Mode (HNDS = 1)

The reception procedure and operations using the HNDS function, by which the data reception process is provided in 1-byte units with SCL fixed low at each data reception, are described below.

- 1. Clear the TRS bit in ICCR to 0 to switch from transmit mode to receive mode.
 - Clear the ACKB bit in ICSR to 0 (acknowledge data setting).
 - Set the HNDS bit in ICXR to 1.
 - Clear the IRIC flag to 0 to determine the end of reception.
 - Go to step [6] to halt reception operation if the first frame is the last receive data.
- 2. When ICDR is read (dummy data read), reception is started, the receive clock is output in synchronization with the internal clock, and data is received. (Data from the SDA pin is sequentially transferred to ICDRS in synchronization with the rise of the receive clock pulses.)
- 3. The master device drives SDA low to return the acknowledge data at the 9th receive clock pulse. The receive data is transferred from ICDRS to ICDRR at the rise of the 9th clock pulse, setting the ICDRF, IRIC, and IRTR flags to 1. If the IEIC bit has been set to 1, an interrupt request is sent to the CPU.
 - The master device drives SCL low from the fall of the 9th receive clock pulse to the ICDR data reading.
- 4. Clear the IRIC flag to clear the wait state.
 - Go to step [6] to halt reception operation if the next frame is the last receive data.
- 5. Read ICDR receive data. This clears the ICDRF flag to 0. The master device outputs the receive clock continuously to receive the next data.

Data can be received continuously by repeating steps [3] to [5].

- 6. Set the ACKB bit to 1 so as to return the acknowledge data for the last reception.
- 7. Read ICDR receive data. This clears the ICDRF flag to 0. The master device outputs the receive clock to receive data.
- 8. When one frame of data has been received, the ICDRF, IRIC, and IRTR flags are set to 1 at the rise of the 9th receive clock pulse.
- 9. Clear the IRIC flag to 0.
- 10. Read ICDR receive data after setting the TRS bit. This clears the ICDRF flag to 0.
- 11. Clear the BBSY bit and SCP bit to 0 in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition.

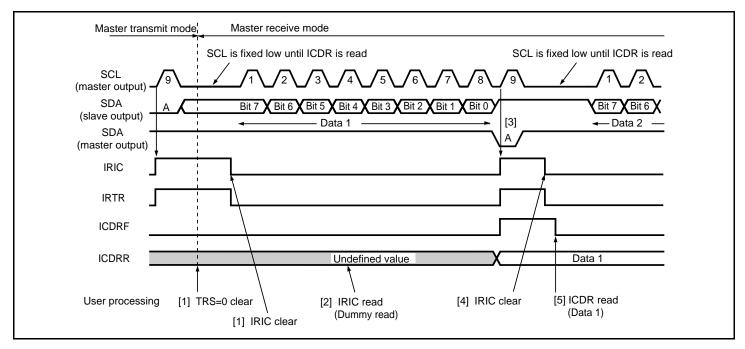


Figure 16.12 Example of Operation Timing in Master Receive Mode (MLS = WAIT = 0, HNDS = 1)

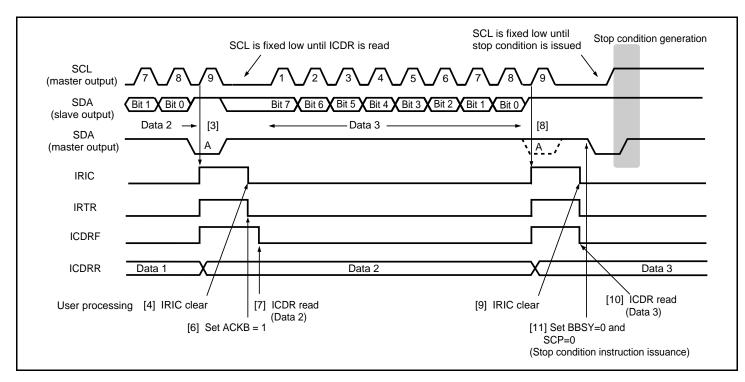


Figure 16.13 Example of Stop Condition Issuance Operation Timing in Master Receive Mode (MLS = WAIT = 0, HNDS = 1)

Receive Operation Using the Wait Function:

Figures 16.14 and 16.15 show the sample flowcharts for the operations in master receive mode (WAIT = 1).

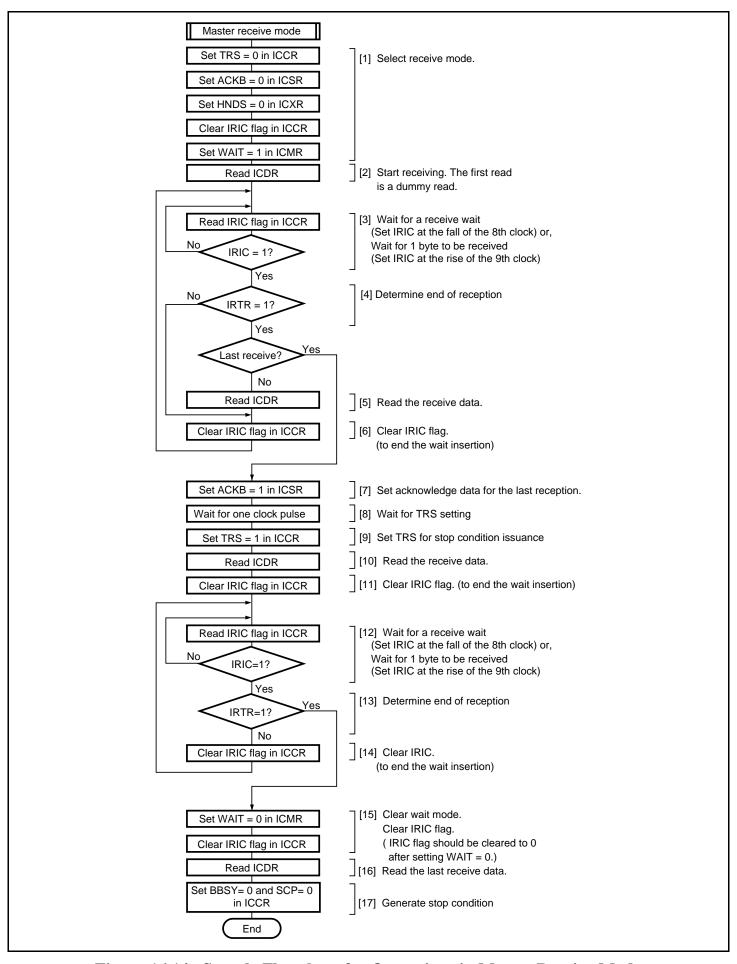


Figure 16.14 Sample Flowchart for Operations in Master Receive Mode (receiving multiple bytes) (WAIT = 1)

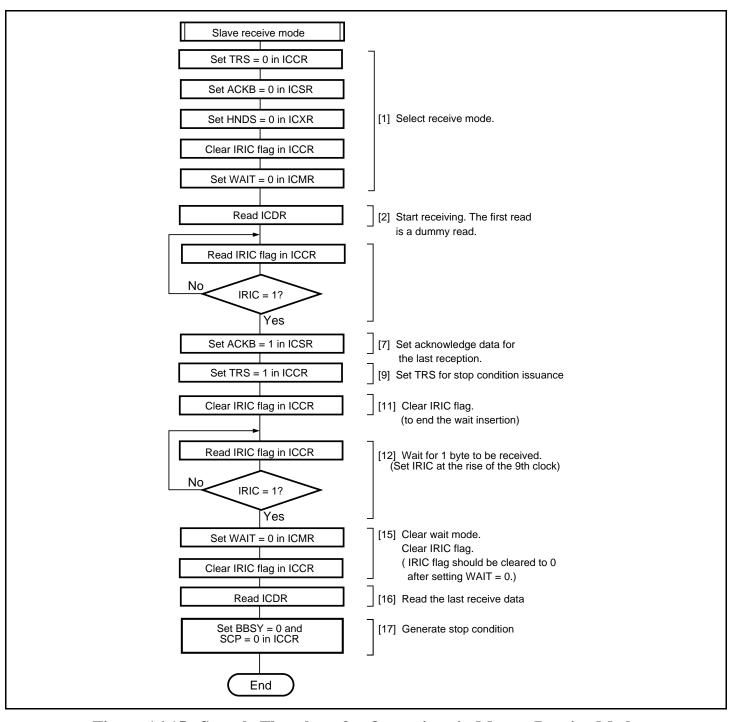


Figure 16.15 Sample Flowchart for Operations in Master Receive Mode (receiving a single byte) (WAIT = 1)

The reception procedure and operations using the wait function (WAIT bit), by which data is sequentially received in synchronization with ICDR (ICDRR) read operations, are described below.

The following describes the multiple-byte reception procedure. In single-byte reception, some steps of the following procedure are omitted. At this time, follow the procedure shown in figure 16.15.

- 1. Clear the TRS bit in ICCR to 0 to switch from transmit mode to receive mode.
 - Clear the ACKB bit in ICSR to 0 to set the acknowledge data.
 - Clear the HNDS bit in ICXR to 0 to cancel the handshake function.
 - Clear the IRIC flag to 0, and then set the WAIT bit in ICMR to 1.
- 2. When ICDR is read (dummy data is read), reception is started, the receive clock is output in synchronization with the internal clock, and data is received.
- 3. The IRIC flag is set to 1 in either of the following cases. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU.
 - At the fall of the 8th receive clock pulse for one frame
 SCL is automatically fixed low in synchronization with the internal clock until the IRIC flag clearing.
 - At the rise of the 9th receive clock pulse for one frame
 The IRTR and ICDRF flags are set to 1, indicating that one frame of data has been received. The master device outputs the receive clock continuously to receive the next data.
- 4. Read the IRTR flag in ICSR.
 - If the IRTR flag is 0, execute step [6] to clear the IRIC flag to 0 to release the wait state. If the IRTR flag is 1 and the next data is the last receive data, execute step [7] to halt reception.
- 5. If IRTR flag is 1, read ICDR receive data.
- 6. Clear the IRIC flag. When the flag is set as the first case in step [3], the master device outputs the 9th clock and drives SDA low at the 9th receive clock pulse to return an acknowledge signal.

Data can be received continuously by repeating steps [3] to [6].

- 7. Set the ACKB bit in ICSR to 1 so as to return the acknowledge data for the last reception.
- 8. After the IRIC flag is set to 1, wait for at least one clock pulse until the rise of the first clock pulse for the next receive data.
- 9. Set the TRS bit in ICCR to 1 to switch from receive mode to transmit mode. The TRS bit value becomes valid when the rising edge of the next 9th clock pulse is input.
- 10. Read the ICDR receive data.
- 11. Clear the IRIC flag to 0.
- 12. The IRIC flag is set to 1 in either of the following cases.
 - At the fall of the 8th receive clock pulse for one frame

SCL is automatically fixed low in synchronization with the internal clock until the IRIC flag is cleared.

- At the rise of the 9th receive clock pulse for one frame
 The IRTR and ICDRF flags are set to 1, indicating that one frame of data has been received. The master device outputs the receive clock continuously to receive the next data.
- 13. Read the IRTR flag in ICSR.

If the IRTR flag is 0, execute step [14] to clear the IRIC flag to 0 to release the wait state. If the IRTR flag is 1 and data reception is complete, execute step [15] to issue the stop condition.

- 14. If IRTR flag is 0, clear the IRIC flag to 0 to release the wait state.

 Execute step [12] to read the IRIC flag to detect the end of reception.
- 15. Clear the WAIT bit in CMR to cancel the wait mode.

 Then, clear the IRIC flag. Clearing of the IRIC flag should be done while WAIT = 0. (If the WAIT bit is cleared to 0 after clearing the IRIC flag and then an instruction to issue a stop condition is executed, the stop condition may not be issued correctly.)
- 16. Read the last ICDR receive data.
- 17. Clear the BBSY bit and SCP bit to 0 in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition.

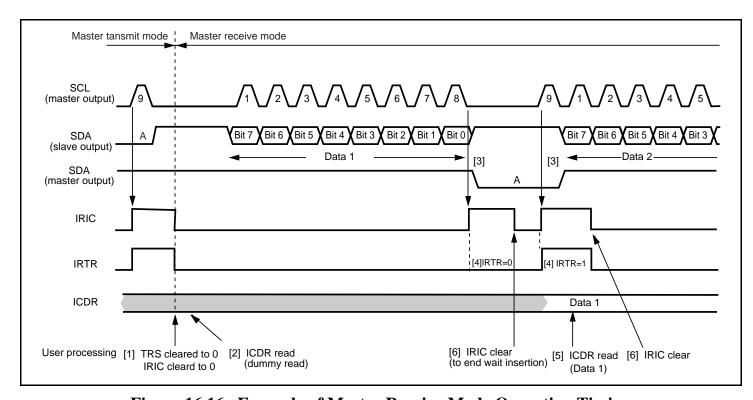


Figure 16.16 Example of Master Receive Mode Operation Timing (MLS = ACKB = 0, WAIT = 1)

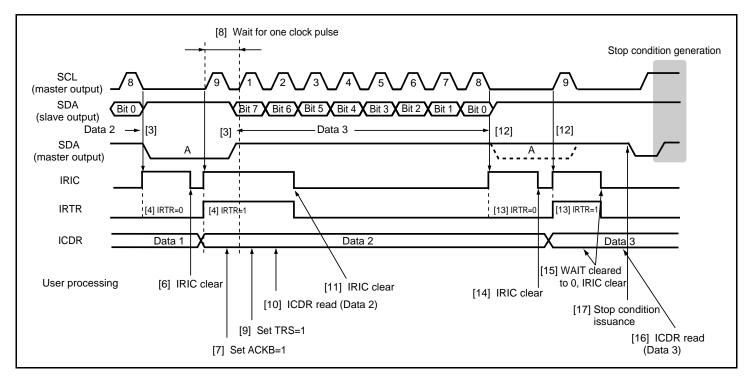


Figure 16.17 Example of Stop Condition Issuance Timing in Master Receive Mode (MLS = ACKB = 0, WAIT = 1)

16.4.5 Slave Receive Operation

In I²C bus format slave receive mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal.

The slave device operates as the device specified by the master device when the slave address in the first frame following the start condition that is issued by the master device matches its own address.

Receive Operation Using the HNDS Function (HNDS = 1):

Figure 16.18 shows the sample flowchart for the operations in slave receive mode (HNDS = 1).

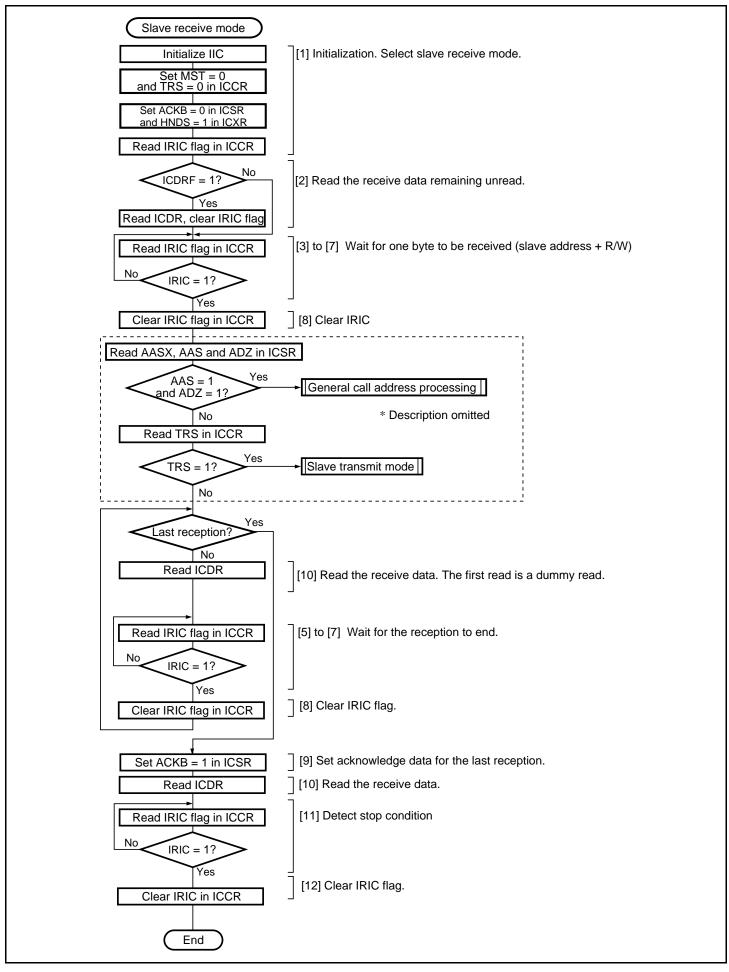


Figure 16.18 Sample Flowchart for Operations in Slave Receive Mode (HNDS = 1)

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The reception procedure and operations using the HNDS bit function, by which data reception process is provided in 1-byte unit with SCL being fixed low at every data reception, are described below.

- 1. Initialize the IIC as described in section 16.4.2, Initialization.

 Clear the MST and TRS bits to 0 to set slave receive mode, and set the HNDS bit to 1 and the ACKB bit to 0. Clear the IRIC flag in ICCR to 0 to see the end of reception.
- 2. Confirm that the ICDRF flag is 0. If the ICDRF flag is set to 1, read the ICDR and then clear the IRIC flag to 0.
- 3. When the start condition output by the master device is detected, the BBSY flag in ICCR is set to 1. The master device then outputs the 7-bit slave address and transmit/receive direction (R/W), in synchronization with the transmit clock pulses.
- 4. When the slave address matches in the first frame following the start condition, the device operates as the slave device specified by the master device. If the 8th data bit (R/\overline{W}) is 0, the TRS bit remains cleared to 0, and slave receive operation is performed. If the 8th data bit (R/\overline{W}) is 1, the TRS bit is set to 1, and slave transmit operation is performed. When the slave address does not match, receive operation is halted until the next start condition is detected.
- 5. At the 9th clock pulse of the receive frame, the slave device returns the data in the ACKB bit as an acknowledge signal.
- 6. At the rise of the 9th clock pulse, the IRIC flag is set to 1. If the IEIC bit has been set to 1, an interrupt request is sent to the CPU.
 - If the AASX bit has been set to 1, IRTR flag is also set to 1.
- 7. At the rise of the 9th clock pulse, the receive data is transferred from ICDRS to ICDRR, setting the ICDRF flag to 1. The slave device drives SCL low from the fall of the 9th receive clock pulse until data is read from ICDR.
- 8. Confirm that the STOP bit is cleared to 0, and clear the IRIC flag to 0.
- 9. If the next frame is the last receive frame, set the ACKB bit to 1.
- 10. If ICDR is read, the ICDRF flag is cleared to 0, releasing the SCL bus line. This enables the master device to transfer the next data.

Receive operations can be performed continuously by repeating steps [5] to [10].

- 11. When the stop condition is detected (SDA is changed from low to high when SCL is high), the BBSY flag is cleared to 0 and the STOP bit is set to 1. If the STOPIM bit has been cleared to 0, the IRIC flag is set to 1.
- 12. Confirm that the STOP bit is set to 1, and clear the IRIC flag to 0.

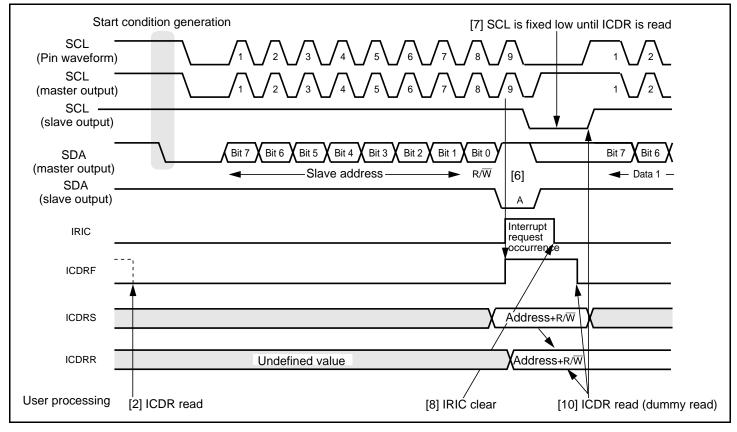


Figure 16.19 Example of Slave Receive Mode Operation Timing (1) (MLS = 0, HNDS= 1)

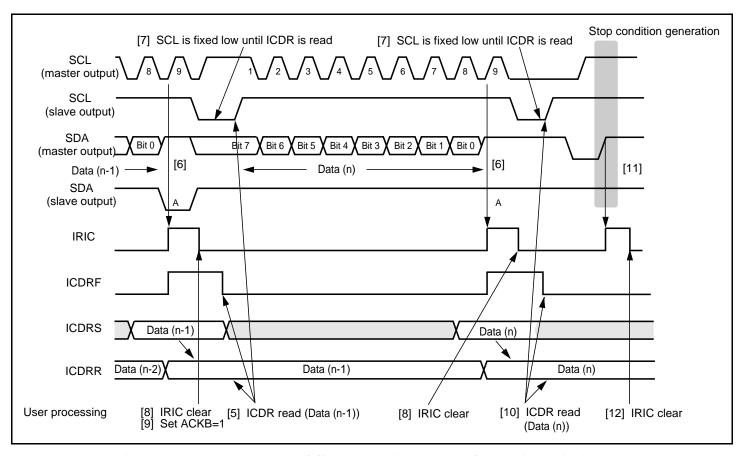


Figure 16.20 Example of Slave Receive Mode Operation Timing (2) (MLS = 0, HNDS= 1)

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Continuous Receive Operation:

Figure 16.21 shows the sample flowchart for the operations in slave receive mode (HNDS = 0).

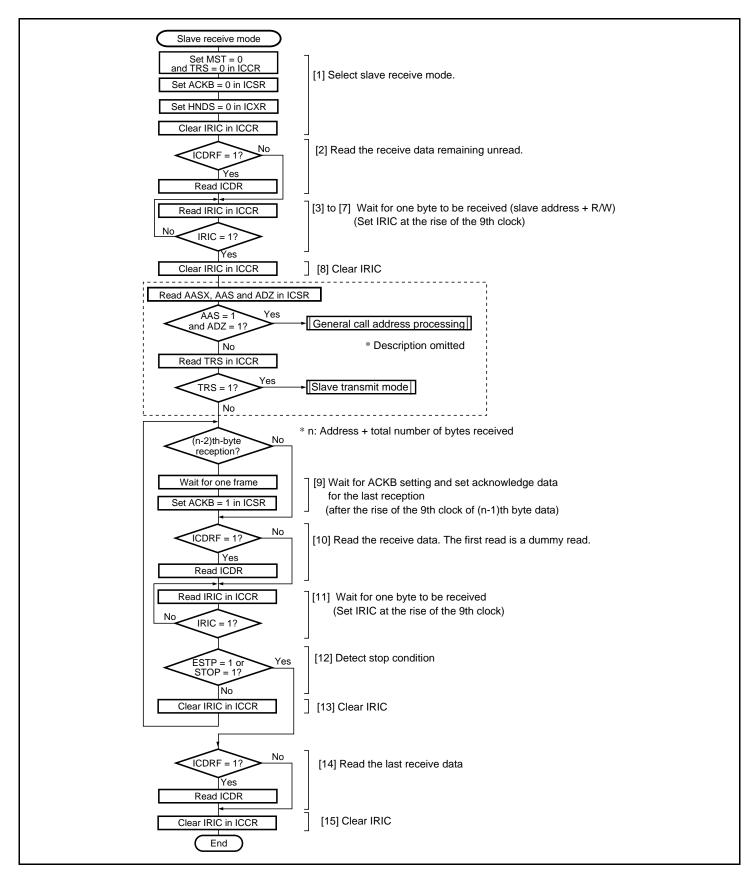


Figure 16.21 Sample Flowchart for Operations in Slave Receive Mode (HNDS = 0)

The reception procedure and operations in slave receive are described below.

- 1. Initialize the IIC as described in section 16.4.2, Initialization.

 Clear the MST and TRS bits to 0 to set slave receive mode, and set the HNDS and ACKB bits to 0. Clear the IRIC flag in ICCR to 0 to see the end of reception.
- 2. Confirm that the ICDRF flag is 0. If the ICDRF flag is set to 1, read the ICDR and then clear the IRIC flag to 0.
- 3. When the start condition output by the master device is detected, the BBSY flag in ICCR is set to 1. The master device then outputs the 7-bit slave address and transmit/receive direction (R/W) in synchronization with the transmit clock pulses.
- 4. When the slave address matches in the first frame following the start condition, the device operates as the slave device specified by the master device. If the 8th data bit (R/W) is 0, the TRS bit remains cleared to 0, and slave transmit operation is performed. When the slave address does not match, receive operation is halted until the next start condition is detected.
- 5. At the 9th clock pulse of the receive frame, the slave device returns the data in the ACKB bit as an acknowledge signal.
- 6. At the rise of the 9th clock pulse, the IRIC flag is set to 1. If the IEIC bit has been set to 1, an interrupt request is sent to the CPU.
 - If the AASX bit has been set to 1, the IRTR flag is also set to 1.
- 7. At the rise of the 9th clock pulse, the receive data is transferred from ICDRS to ICDRR, setting the ICDRF flag to 1.
- 8. Confirm that the STOP bit is cleared to 0 and clear the ICIC flag to 0.
- 9. If the next read data is the third last receive frame, wait for at least one frame time to set the ACKB bit. Set the ACKB bit after the rise of the 9th clock pulse of the second last receive frame.
- 10. Confirm that the ICDRF flag is set to 1 and read ICDR. This clears the ICDRF flag to 0.
- 11. At the rise of the 9th clock pulse or when the receive data is transferred from IRDRS to ICDRR due to ICDR read operation, the IRIC and ICDRF flags are set to 1.
- 12. When the stop condition is detected (SDA is changed from low to high when SCL is high), the BBSY flag is cleared to 0 and the STOP or ESTP flag is set to 1. If the STOPIM bit has been cleared to 0, the IRIC flag is set to 1. In this case, execute step [14] to read the last receive data.
- 13. Clear the IRIC flag to 0.

Receive operations can be performed continuously by repeating steps [9] to [13].

- 14. Confirm that the ICDRF flag is set to 1, and read ICDR.
- 15. Clear the IRIC flag.

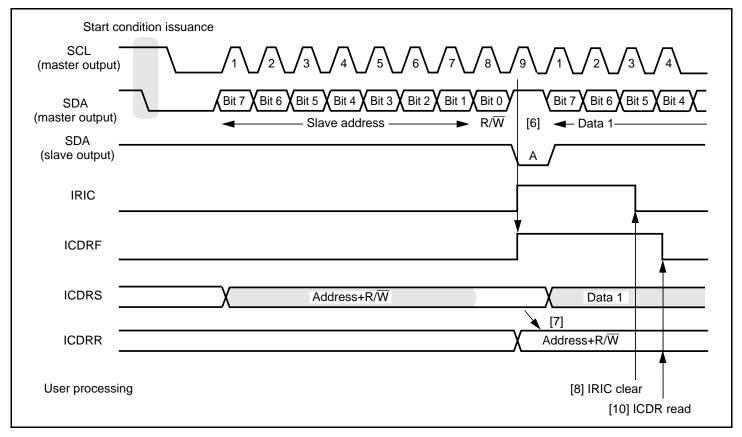


Figure 16.22 Example of Slave Receive Mode Operation Timing (1) (MLS = ACKB = 0)

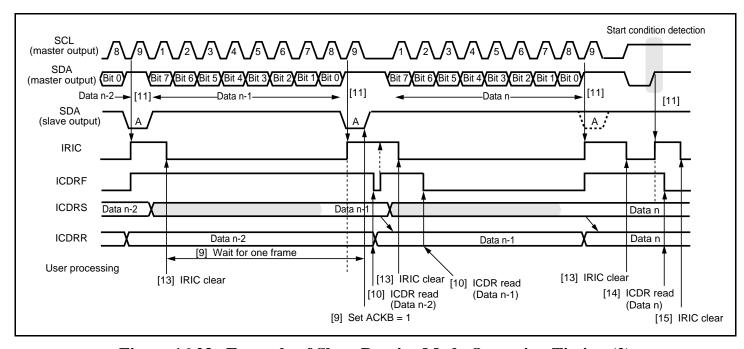


Figure 16.23 Example of Slave Receive Mode Operation Timing (2) (MLS = ACKB = 0)

16.4.6 Slave Transmit Operation

If the slave address matches to the address in the first frame (address reception frame) following the start condition detection when the 8th bit data (R/\overline{W}) is 1 (read), the TRS bit in ICCR is automatically set to 1 and the mode changes to slave transmit mode.

Figure 16.24 shows the sample flowchart for the operations in slave transmit mode.

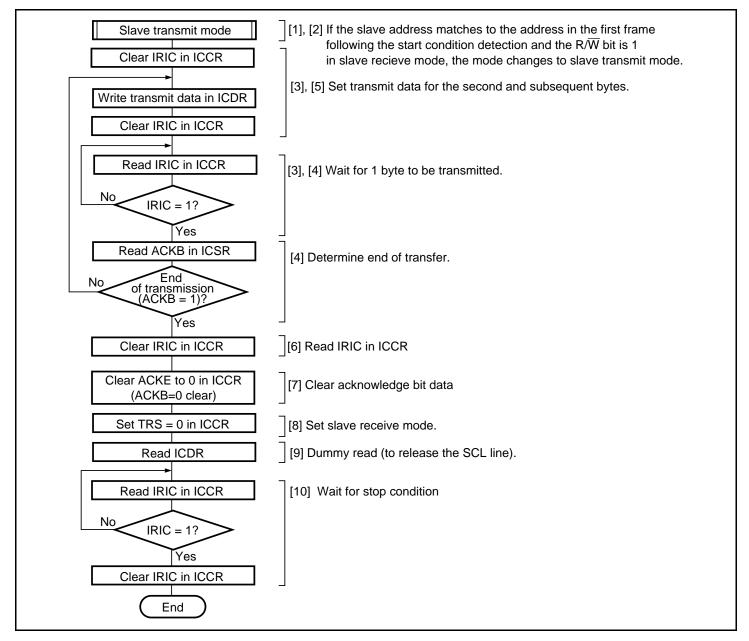


Figure 16.24 Sample Flowchart for Slave Transmit Mode

In slave transmit mode, the slave device outputs the transmit data, while the master device outputs the receive clock and returns an acknowledge signal. The transmission procedure and operations in slave transmit mode are described below.

- 1. Initialize slave receive mode and wait for slave address reception.
- 2. When the slave address matches in the first frame following detection of the start condition, the slave device drives SDA low at the 9th clock pulse and returns an acknowledge signal. If the 8th data bit (R/W) is 1, the TRS bit in ICCR is set to 1, and the mode changes to slave transmit mode automatically. The IRIC flag is set to 1 at the rise of the 9th clock. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. At the same time, the ICDRE flag is set to 1. The slave device drives SCL low from the fall of the transmit clock until ICDR data is written, to disable the master device to output the next transfer clock.
- 3. After clearing the IRIC flag to 0, write data to ICDR. At this time, the ICDRE flag is cleared to 0. The written data is transferred to ICDRS, and the ICDRE and IRIC flags are set to 1 again. The slave device sequentially sends the data written into ICDRS in accordance with the clock output by the master device.
 - The IRIC flag is cleared to 0 to detect the end of transmission. Processing from the ICDR register writing to the IRIC flag clearing should be performed continuously. Prevent any other interrupt processing from being inserted.
- 4. The master device drives SDA low at the 9th clock pulse, and returns an acknowledge signal. As this acknowledge signal is stored in the ACKB bit in ICSR, this bit can be used to determine whether the transfer operation was performed successfully. When one frame of data has been transmitted, the IRIC flag in ICCR is set to 1 at the rise of the 9th transmit clock pulse. When the ICDRE flag is 0, the data written into ICDR is transferred to ICDRS, transmission starts, and the ICDRE and IRIC flags are set to 1 again. If the ICDRE flag has been set to 1, this slave device drives SCL low from the fall of the transmit clock until data is written to ICDR.
- 5. To continue transmission, write the next data to be transmitted into ICDR. The ICDRE flag is cleared to 0. The IRIC flag is cleared to 0 to detect the end of transmission. Processing from the ICDR register writing to the IRIC flag clearing should be performed continuously. Prevent any other interrupt processing from being inserted.

Transmit operations can be performed continuously by repeating steps [4] and [5].

- 6. Clear the IRIC flag to 0.
- 7. To end transmission, clear the ACKE bit in ICCR to 0, to clear the acknowledge bit stored in the ACKB bit to 0.
- 8. Clear the TRS bit to 0 for the next address reception, to set slave receive mode.
- 9. Dummy-read ICDR to release SDA on the slave side.
- 10. When the stop condition is detected, that is, when SDA is changed from low to high when SCL is high, the BBSY flag in ICCR is cleared to 0 and the STOP flag in ICSR is set to 1. When the

STOPIM bit in ICXR is 0, the IRIC flag is set to 1. If the IRIC flag has been set, it is cleared to 0.

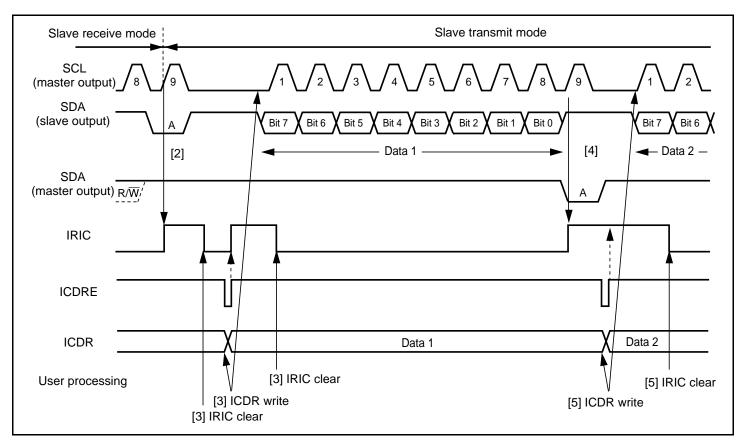


Figure 16.25 Example of Slave Transmit Mode Operation Timing (MLS = 0)

16.4.7 IRIC Setting Timing and SCL Control

The interrupt request flag (IRIC) is set at different times depending on the WAIT bit in ICMR, the FS bit in SAR, and the FSX bit in SARX. If the ICDRE or ICDRF flag is set to 1, SCL is automatically held low after one frame has been transferred in synchronization with the internal clock. Figures 16.26 to 16.28 show the IRIC set timing and SCL control.

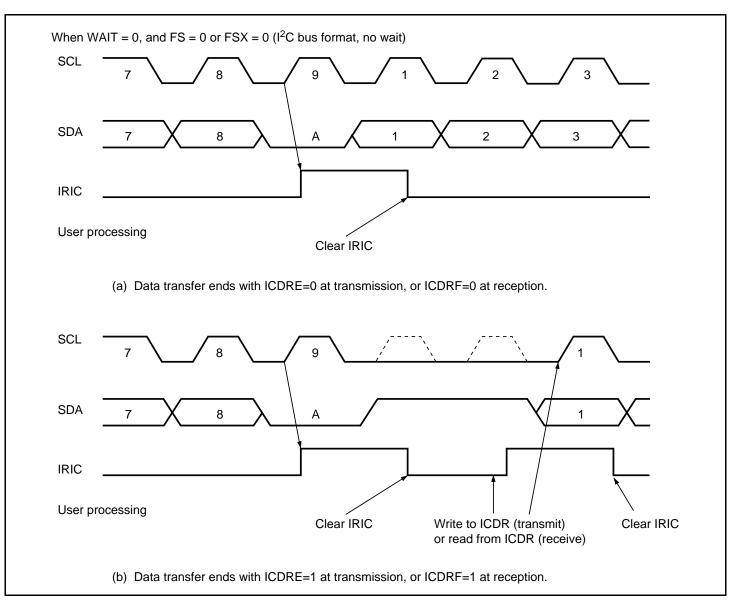


Figure 16.26 IRIC Setting Timing and SCL Control (1)

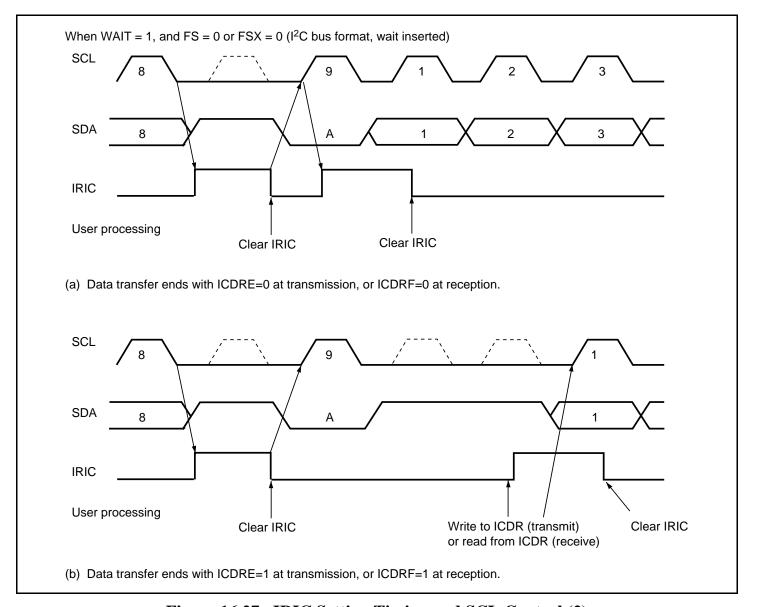


Figure 16.27 IRIC Setting Timing and SCL Control (2)

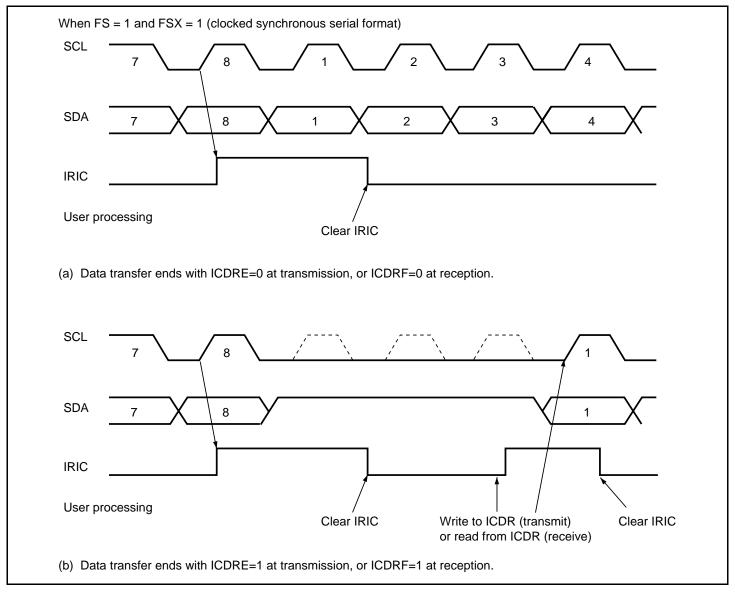


Figure 16.28 IRIC Setting Timing and SCL Control (3)

16.4.8 Automatic Switching from Formatless Mode to I²C Bus Format

Setting the SW bit to 1 in DDCSWR enables formatless mode to be selected as the IIC_0 operating mode. Switching from formatless mode to the I²C bus format (slave mode) is performed automatically when a falling edge is detected on the SCL pin.

The following four preconditions are necessary for this operation:

- A common data pin (SDA) for formatless and I²C bus format operation
- Separate clock pins for formatless operation (VSYNCI) and I²C bus format operation (SCL)
- A fixed 1 level for the SCL pin during formatless operation (the SCL pin does not output a low level)
- Settings of bits other than TRS in ICCR that allow I²C bus format operation

Automatic switching is performed from formatless mode to the I²C bus format when the SW bit in DDCSWR is automatically cleared to 0 on detection of a falling edge on the SCL pin. Switching from the I²C bus format to formatless mode is achieved by setting the SW bit in DDCSWR to 1 by software.

In formatless mode, bits (such as MSL and TRS) that control the I²C bus interface operating mode must not be modified. When switching from the I²C bus format to formatless mode, set the TRS bit to 1 or clear it to 0 according to the transfer direction (transmission or reception) in formatless mode, then set the SW bit to 1. After automatic switching from formatless mode to the I²C bus format (slave mode), the TRS bit is automatically cleared to 0 in order to wait for slave address reception.

If a falling edge is detected on the SCL pin during formatless operation, the mode of the I²C bus interface is immediately switched to I²C bus format before a stop condition is detected.

16.4.9 Operation Using DTC

This LSI provides the DTC to allow continuous data transfer. The DTC is initiated when the IRTR flag is set to 1, which is one of the two interrupt flags (IRTR and IRIC). When the ACKE bit is 0, the ICDRE, IRIC, and IRTR flags are set at the end of data transmission regardless of the acknowledge bit value. If the ACKE bit is 1, the ICDRE, IRIC, and IRTR flags are set when data transmission is completed with the acknowledge bit value of 0, and if the ACKE bit is 1, only the IRIC flag is set when data transmission is completed with the acknowledge bit value of 1.

When initiated, the DTC transfers specified number of bytes, clears the ICDRE, IRIC, and IRTR flags to 0. Therefore, no interrupt is generated during continuous data transfer; however, if data transmission is completed with the acknowledge bit value of 1 when the ACKE bit is 1, the DTC is not initiated, thus allowing an interrupt to be generated if enabled.

The acknowledge bit may indicate specific events such as completion of receive data processing for some receiving devices, and for other receiving devices, the acknowledge bit may be fixed at 1, indicating no specific events.

The I^2C bus format provides for selection of the slave device and transfer direction by means of the slave address and the R/\overline{W} bit, confirmation of reception with the acknowledge bit, indication of the last frame, and so on. Therefore, continuous data transfer using the DTC must be carried out in conjunction with CPU processing by means of interrupts.

Table 16.7 shows some examples of processing using the DTC. These examples assume that the number of transfer data bytes is known in slave mode.

Table 16.7 Examples of Operation Using DTC

| Item | Master Transmit Mode | Master Receive Mode | Slave Transmit Mode | Slave Receive Mode | |
|---|---|----------------------------------|--|------------------------------|--|
| Slave address + R/W bit transmission/ reception | Transmission by DTC (ICDR write) | Transmission by CPU (ICDR write) | Reception by CPU (ICDR read) | Reception by CPU (ICDR read) | |
| Dummy data read | _ | Processing by CPU (ICDR read) | _ | _ | |
| Actual data transmission/ reception | Transmission by DTC (ICDR write) | Reception by DTC (ICDR read) | Transmission by DTC (ICDR write) | Reception by DTC (ICDR read) | |
| Dummy data (H'FF) write | _ | _ | Processing by DTC (ICDR write) | _ | |
| Last frame processing | Not necessary | Reception by CPU (ICDR read) | Not necessary | Reception by CPU (ICDR read) | |
| Transfer request processing after last frame processing | 1st time: Clearing by CPU 2nd time: Stop condition issuance by CPU | Not necessary | Automatic clearing on detection of stop condition during transmission of dummy data (H'FF) | | |
| Setting of number of DTC transfer data frames | Transmission: Actual data count + 1 (+1 equivalent to slave address + R/W bits) | Reception: Actual data count | Transmission: Actual data count + 1 (+1 equivalent to dummy data (H'FF)) | Reception: Actual data count | |

16.4.10 Noise Canceler

The logic levels at the SCL and SDA pins are routed through noise cancelers before being latched internally. Figure 16.29 shows a block diagram of the noise canceler.

The noise canceler consists of two cascaded latches and a match detector. The SCL (or SDA) pin input signal is sampled on the system clock, but is not passed forward to the next circuit unless the outputs of both latches agree. If they do not agree, the previous value is held.

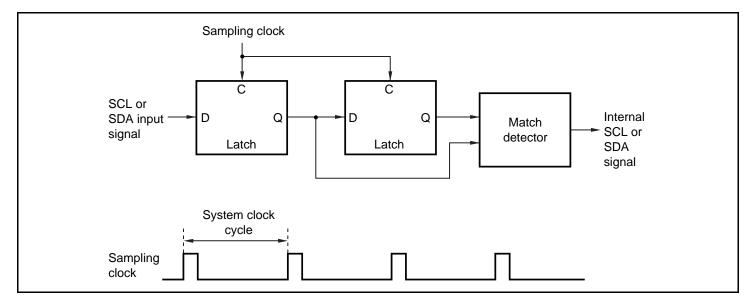


Figure 16.29 Block Diagram of Noise Canceler

16.4.11 Initialization of Internal State

The IIC has a function for forcible initialization of its internal state if a deadlock occurs during communication.

Initialization is executed in accordance with the setting of bits CLR3 to CLR0 in DDCSWR or clearing ICE bit. For details on the setting of bits CLR3 to CLR0, see section 16.3.7, DDC Switch Register (DDCSWR).

Scope of Initialization: The initialization executed by this function covers the following items:

- ICDRE and ICDRF internal flags
- Transmit/receive sequencer and internal operating clock counter
- Internal latches for retaining the output state of the SCL and SDA pins (wait, clock, data output, etc.)

The following items are not initialized:

- Actual register values (ICDR, SAR, SARX, ICMR, ICCR, ICSR, ICXR (except for the ICDRE and ICDRF flags), DDCSWR)
- Internal latches used to retain register read information for setting/clearing flags in ICMR, ICCR, ICSR, and DDCSWR
- The value of the ICMR bit counter (BC2 to BC0)
- Generated interrupt sources (interrupt sources transferred to the interrupt controller)

Notes on Initialization:

- Interrupt flags and interrupt sources are not cleared, and so flag clearing measures must be taken as necessary.
- Basically, other register flags are not cleared either, and so flag clearing measures must be taken as necessary.
- When initialization is executed by DDCSWR, the write data for bits CLR3 to CLR0 is not retained. To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR.
- Similarly, when clearing is required again, all the bits must be written to simultaneously in accordance with the setting.
- If a flag clearing setting is made during transmission/reception, the IIC module will stop transmitting/receiving at that point and the SCL and SDA pins will be released. When transmission/reception is started again, register initialization, etc., must be carried out as necessary to enable correct communication as a system.

The value of the BBSY bit cannot be modified directly by this module clear function, but since the stop condition pin waveform is generated according to the state and release timing of the SCL and SDA pins, the BBSY bit may be cleared as a result. Similarly, state switching of other bits and flags may also have an effect.

To prevent problems caused by these factors, the following procedure should be used when initializing the IIC state.

- 1. Execute initialization of the internal state according to the setting of bits CLR3 to CLR0 or ICE bit clearing.
- 2. Execute a stop condition issuance instruction (write 0 to BBSY and SCP) to clear the BBSY bit to 0, and wait for two transfer rate clock cycles.
- 3. Re-execute initialization of the internal state according to the setting of bits CLR3 to CLR0 or ICE bit clearing.
- 4. Initialize (re-set) the IIC registers.

16.5 Interrupt Sources

The IIC has interrupt sources IICI and DDCSWI. Table 16.8 shows the interrupt sources and priority. Individual interrupt sources can be enabled or disabled using the enable bits in ICCR and DDCSWR, and are sent to the interrupt controller independently.

An IICI interrupt can activate the DTC to allow data transfer.

Table 16.8 IIC Interrupt Sources

| Channel | Name | Enable Bit | Interrupt Source | Interrupt Flag | DTC Activation | Priority |
|---------|------------|---------------|--|-------------------|----------------|-----------|
| 0 | IICI0 | IEIC | I ² C bus interface interrupt request | IRIC | Possible | High • |
| | DDCS WI | IE | Format automatic switch interrupt | IF | Not possible | |
| 1 | IICI1 | IEIC | I ² C bus interface interrupt request | IRIC | Possible | Low |

16.6 Usage Notes

- 1. In master mode, if an instruction to generate a start condition is issued and then an instruction to generate a stop condition is issued before the start condition is output to the I²C bus, neither condition will be output correctly. To output the start condition followed by the stop condition, after issuing the instruction that generates the start condition, read DR in each I²C bus output pin, and check that SCL and SDA are both low. The pin states can be monitored by reading DR even if the ICE bit is set to 1. Then issue the instruction that generates the stop condition. Note that SCL may not yet have gone low when BBSY is cleared to 0.
- 2. Either of the following two conditions will start the next transfer. Pay attention to these conditions when accessing to ICDR.
 - Write to ICDR when ICE = 1 and TRS = 1 (including automatic transfer from ICDRT to ICDRS)
 - Read from ICDR when ICE = 1 and TRS = 0 (including automatic transfer from ICDRS to ICDRR)
- 3. Table 16.9 shows the timing of SCL and SDA outputs in synchronization with the internal clock. Timings on the bus are determined by the rise and fall times of signals affected by the bus load capacitance, series resistance, and parallel resistance.

Table 16.9 I²C Bus Timing (SCL and SDA Outputs)

| Item | Symbol | Output Timing | Unit | Notes |
|--|--------------------|---|------|------------|
| SCL output cycle time | t _{sclo} | 28t _{cyc} to 256t _{cyc} | ns | See figure |
| SCL output high pulse width | t _{sclho} | 0.5t _{sclo} | ns | 28.29. |
| SCL output low pulse width | t _{scllo} | 0.5t _{sclo} | ns | |
| SDA output bus free time | t _{BUFO} | $0.5t_{\scriptscriptstyle SCLO} - 1t_{\scriptscriptstyle cyc}$ | ns | |
| Start condition output hold time | t _{STAHO} | $0.5t_{\scriptscriptstyle SCLO} - 1t_{\scriptscriptstyle cyc}$ | ns | |
| Retransmission start condition output setup time | t _{staso} | 1t _{sclo} | ns | <u> </u> |
| Stop condition output setup time | t _{stoso} | $0.5t_{\text{SCLO}} + 2t_{\text{cyc}}$ | ns | |
| Data output setup time (master) | t _{SDASO} | $1t_{\text{SCLLO}} - 3t_{\text{cyc}}$ | ns | |
| Data output setup time (slave) | | $1t_{\text{SCLL}} - (6t_{\text{cyc}} \text{ or } 12t_{\text{c}})$ | *) | <u> </u> |
| Data output hold time | t _{SDAHO} | 3t _{cyc} | ns | |
| Data output setup time (slave) | | $1t_{\text{SCLL}} - (6t_{\text{cyc}} \text{ or } 12t_{\text{c}}$ | *) | _ _ |

Note:* 6t_{cvc} when IICX is 0, 12t_{cvc} when 1.

- 4. SCL and SDA inputs are sampled in synchronization with the internal clock. The AC timing therefore depends on the system clock cycle t_{cyc}, as shown in section 28, Electrical Characteristics. Note that the I²C bus interface AC timing specifications will not be met with a system clock frequency of less than 5 MHz.
- 5. The I²C bus interface specification for the SCL rise time t_{sr} is 1000 ns or less (300 ns for high-speed mode). In master mode, the I²C bus interface monitors the SCL line and synchronizes one bit at a time during communication. If t_{sr} (the time for SCL to go from low to V_{IH}) exceeds the time determined by the input clock of the I²C bus interface, the high period of SCL is extended. The SCL rise time is determined by the pull-up resistance and load capacitance of the SCL line. To insure proper operation at the set transfer rate, adjust the pull-up resistance and load capacitance so that the SCL rise time does not exceed the values given in table 16.10.

Table 16.10 Permissible SCL Rise Time (t_{sr}) Values

| | | | Time Indication [ns] | | | | | | |
|------|--------------------------------|-----------------|---|---------------|--------------|---------------|---------------|---------------|--|
| IICX | t _{cyc} Indication | | I ² C Bus Specification (Max.) | ıø = 5 MHz | ø = 8 MHz | ø = 10 MHz | ø = 16 MHz | ø = 20 MHz | |
| 0 | 7.5 t _{cyc} | Standard mode | 1000 | 1000 | 937 | 750 | 468 | 375 | |
| | | High-speed mode | 300 | 300 | 300 | 300 | 300 | 300 | |
| 1 | 17.5 t _{cyc} | Standard mode | 1000 | 100 | 1000 | 1000 | 1000 | 875 | |
| | | High-speed mode | 300 | 300 | 300 | 300 | 300 | 300 | |

6. The I²C bus interface specifications for the SCL and SDA rise and fall times are under 1000 ns and 300 ns. The I²C bus interface SCL and SDA output timing is prescribed by t_{cyc}, as shown in table 16.9. However, because of the rise and fall times, the I²C bus interface specifications may not be satisfied at the maximum transfer rate. Table 16.11 shows output timing calculations for different operating frequencies, including the worst-case influence of rise and fall times.

 t_{BUFO} fails to meet the I²C bus interface specifications at any frequency. The solution is either (a) to provide coding to secure the necessary interval (approximately 1 µs) between issuance of a stop condition and issuance of a start condition, or (b) to select devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

 $t_{\rm scllo}$ in high-speed mode and $t_{\rm staso}$ in standard mode fail to satisfy the I²C bus interface specifications for worst-case calculations of $t_{\rm sr}/t_{\rm sr}$. Possible solutions that should be investigated include (a) adjusting the rise and fall times by means of a pull-up resistor and capacitive load, (b) reducing the transfer rate to meet the specifications, or (c) selecting devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

Table 16.11 I²C Bus Timing (with Maximum Influence of t_{sr}/t_{sr})

| Time Indication | (at Maximum | Transfer | Rate) | [ne] |
|-------------------|-------------------|----------|-------|-------|
| Tille illulcation | iai iviaxiiiiuiii | Hallstei | nate | HIISI |

| Item | t _{cyc} Indication | | t _{sr} /t _{sr} Influence (Max.) | I ² C Bus Specification (Min.) | ø = 5 MHz | ø = 8 MHz | ø = 10 MHz | ø = 16 MHz | ø = 20 MHz |
|----------------------------|--|-----------------|---|---|-------------------|--------------------|--------------------|---------------|---------------|
| t _{sclho} | 0.5 t _{SCLO} (-t _{Sr}) | Standard mode | -1000 | 4000 | 4000 | 4000 | 4000 | 4000 | 4000 |
| | | High-speed mode | -300 | 600 | 950 | 950 | 950 | 950 | 950 |
| t _{scllo} | 0.5 t _{SCLO} (-t _{Sf}) | Standard mode | -250 | 4700 | 4750 | 4750 | 4750 | 4750 | 4750 |
| | | High-speed mode | -250 | 1300 | 1000*1 | 1000*1 | 1000*1 | 1000*1 | 1000*1 |
| t _{BUFO} | 0.5 t _{sclo} -1 t _{cyc} | Standard mode | -1000 | 4700 | 3800*1 | 3875*1 | 3900*1 | 3938*1 | 3950*1 |
| | $(-t_{Sr})$ | High-speed mode | -300 | 1300 | 750* ¹ | 825* ¹ | 850* ¹ | 888*1 | 900*1 |
| t _{STAHO} | $0.5 t_{SCLO} - 1 t_{cyc}$ $(-t_{Sf})$ | Standard mode | -250 | 4000 | 4550 | 4625 | 4650 | 4688 | 4700 |
| | | High-speed mode | -250 | 600 | 800 | 875 | 900 | 938 | 950 |
| t _{STASO} | 1 t _{sclo} (-t _{sr}) | Standard mode | -1000 | 4700 | 9000 | 9000 | 9000 | 9000 | 9000 |
| | | High-speed mode | -300 | 600 | 2200 | 2200 | 2200 | 2200 | 2200 |
| t _{stoso} | • | Standard mode | -1000 | 4000 | 4400 | 4250 | 4200 | 4125 | 4100 |
| | (-t _{Sr}) | High-speed mode | -300 | 600 | 1350 | 1200 | 1150 | 1075 | 1050 |
| t _{sdaso} | | Standard mode | -1000 | 250 | 3100 | 3325 | 3400 | 3513 | 3550 |
| (master) | (-t _{Sr}) | High-speed mode | -300 | 100 | 400 | 625 | 700 | 813 | 850 |
| t _{SDASO} (slave) | 1 t _{scll} * ³ -12 t _{cyc} * ² | Standard mode | -1000 | 250 | 1300 | 2200 | 2500 | 2950 | 3100 |
| | $(-t_{sr})$ | High-speed mode | -300 | 100 | -1400 *1 | -500* ¹ | -200* ¹ | 250 | 400 |
| t _{SDAHO} | 3 t _{cyc} | Standard mode | 0 | 0 | 600 | 375 | 300 | 188 | 150 |
| | | High-speed mode | 0 | 0 | 600 | 375 | 300 | 188 | 150 |

Notes: 1. Does not meet the I²C bus interface specification. Remedial action such as the following is necessary: (a) secure a start/stop condition issuance interval; (b) adjust the rise and fall times by means of a pull-up resistor and capacitive load; (c) reduce the transfer rate; (d) select slave devices whose input timing permits this output timing.

The values in the above table will vary depending on the settings of the IICX bit and bits CKS0 to CKS2. Depending on the frequency it may not be possible to achieve the maximum transfer rate; therefore, whether or not the I²C bus interface specifications are met must be determined in accordance with the actual setting conditions.

- 2. Value when the IICX bit is set to 1. When the IICX bit is cleared to 0, the value is $(t_{SCLL} 6t_{cvc})$.
- 3. Calculated using the I²C bus specification values (standard mode: 4700 ns min.; high-speed mode: 1300 ns min.).

7. Notes on ICDR read at end of master reception

To halt reception at the end of a receive operation in master receive mode, set the TRS bit to 1 and write 0 to BBSY and SCP in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition. After this, receive data can be read by means of an ICDR read, but if data remains in the buffer the ICDRS receive data will not be transferred to ICDR (ICDRR), and so it will not be possible to read the second byte of data.

If it is necessary to read the second byte of data, issue the stop condition in master receive mode (i.e. with the TRS bit cleared to 0). When reading the receive data, first confirm that the BBSY bit in ICCR is cleared to 0, the stop condition has been generated, and the bus has been released, then read ICDR with TRS cleared to 0.

Note that if the receive data (ICDR data) is read in the interval between execution of the instruction for issuance of the stop condition (writing of 0 to BBSY and SCP in ICCR) and the actual generation of the stop condition, the clock may not be output correctly in subsequent master transmission.

Clearing of the MST bit after completion of master transmission/reception, or other modifications of IIC control bits to change the transmit/receive operating mode or settings, must be carried out during interval (a) in figure 16.30 (after confirming that the BBSY bit in ICCR has been cleared to 0).

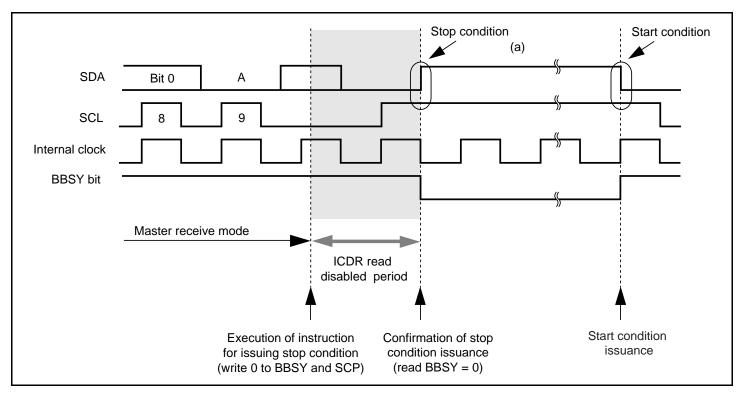


Figure 16.30 Notes on Reading Master Receive Data

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

8. Notes on start condition issuance for retransmission

Figure 16.31 shows the timing of start condition issuance for retransmission, and the timing for subsequently writing data to ICDR, together with the corresponding flowchart. Write the transmit data to ICDR after the start condition for retransmission is issued and then the start condition is actually generated.

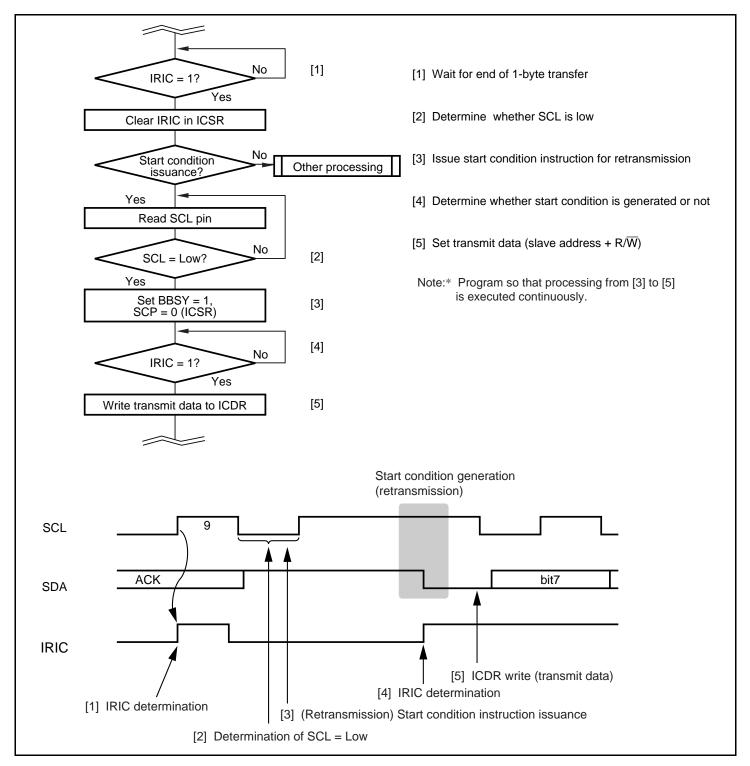


Figure 16.31 Flowchart for Start Condition Issuance Instruction for Retransmission and Timing

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

9. Note on when I²C bus interface stop condition instruction is issued

In cases where the rise time of the 9th clock of SCL exceeds the stipulated value because of a large bus load capacity or where a slave device in which a wait can be inserted by driving the SCL pin low is used, the stop condition instruction should be issued after reading SCL after the rise of the 9th clock pulse and determining that it is low.

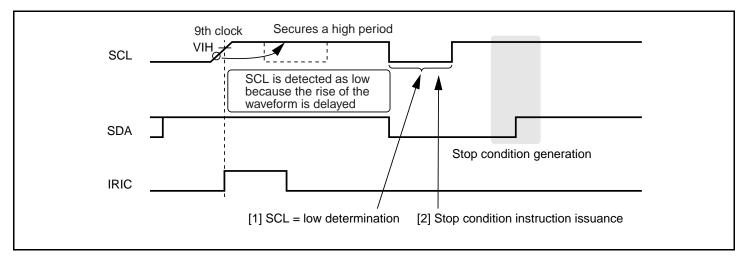


Figure 16.32 Stop Condition Issuance Timing

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

10. Note on IRIC flag clear when the wait function is used

If the rise time of SCL exceeds the stipulated value or a slave device in which a wait can be inserted by driving the SCL pin low is used when the wait function is used in I²C bust interface master mode, the IRIC flag should be cleared after determining that the SCL is low, as described below.

If the IRIC flag is cleared to 0 when WAIT = 1 while the SCL is extending the high level time, the SDA level may change before the SCL goes low, which may generate a start or stop condition erroneously.

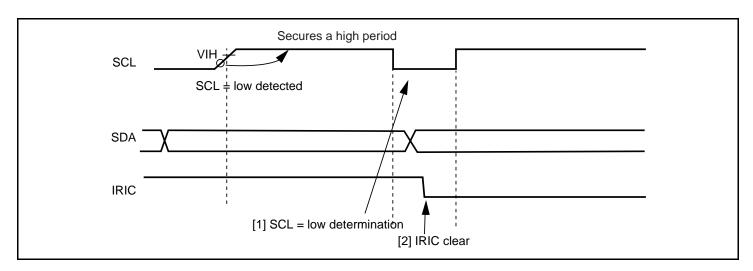


Figure 16.33 IRIC Flag Clearing Timing When WAIT = 1

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

11. Note on ICDR read and ICCR access in slave transmit mode

In I²C bus interface slave transmit mode, do not read ICDR or do not read/write from/to ICCR during the time shaded in figure 16.34. However, such read and write operations cause no problem in interrupt handling processing that is generated in synchronization with the rising edge of the 9th clock pulse because the shaded time has passed before making the transition to interrupt handling.

To handle interrupts securely, be sure to keep either of the following conditions.

- Read ICDR data that has been received so far or read/write from/to ICCR before starting the receive operation of the next slave address.
- Monitor the BC2 to BC0 bit counter in ICMR; when the count is 000 (8th or 9th clock pulse), wait for at least two transfer clock times in order to read ICDR or read/write from/to ICCR during the time other than the shaded time.

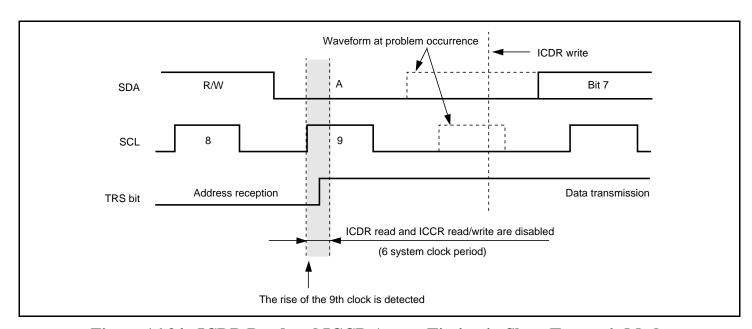


Figure 16.34 ICDR Read and ICCR Access Timing in Slave Transmit Mode

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

12. Note on TRS bit setting in slave mode

In I²C bus interface slave mode, if the TRS bit value in ICCR is set after detecting the rising edge of the 9th clock pulse or the stop condition before detecting the next rising edge on the SCL pin (the time indicated as (a) in figure 16.35), the bit value becomes valid immediately when it is set. However, if the TRS bit is set during the other time (the time indicated as (b) in figure 16.35), the bit value is suspended and remains invalid until the rising edge of the 9th clock pulse or the stop condition is detected. Therefore, when the address is received after the restart condition is input without the stop condition, the effective TRS bit value remains 1 (transmit mode) internally and thus the acknowledge bit is not transmitted after the address has been received at the 9th clock pulse.

To receive the address in slave mode, clear the TRS bit to 0 during the time indicated as (a) in figure 16.35. To release the SCL low level that is held by means of the wait function in slave mode, clear the TRS bit to and then dummy-read ICDR.

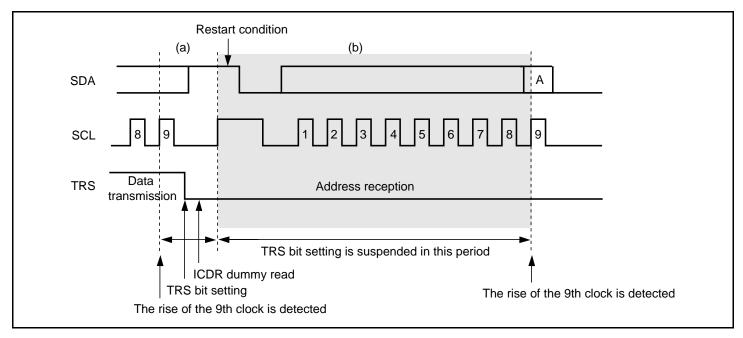


Figure 16.35 TRS Bit Set Timing in Slave Mode

Note: This restriction on usage can be canceled by setting the FNC1 and FNC0 bits to 1 in ICXR.

13. Note on ICDR read in transmit mode and ICDR write in receive mode

If ICDR is read in transmit mode (TRS = 1) or ICDR is written to in receive mode (TRS = 0), the SCL pin may not be held low in some cases after transmit/receive operation has been completed, thus inconveniently allowing clock pulses to be output on the SCL bus line before ICDR is accessed correctly. To access ICDR correctly, read ICDR after setting receive mode or write to ICDR after setting transmit mode.

14. Note on ACKE and TRS bits in slave mode

In the I²C bus interface, if 1 is received as the acknowledge bit value (ACKB = 1) in transmit mode (TRS = 1) and then the address is received in slave mode without performing appropriate processing, interrupt handling may start at the rising edge of the 9th clock pulse even when the address does not match. Similarly, if the start condition or address is transmitted from the master device in slave transmit mode (TRS = 1), the IRIC flag may be set after the ICDRE flag is set and 1 received as the acknowledge bit value (ACKB = 1), thus causing an interrupt source even when the address does not match.

To use the I²C bus interface module in slave mode, be sure to follow the procedures below.

- A. When having received 1 as the acknowledge bit value for the last transmit data at the end of a series of transmit operation, clear the ACKE bit in ICCR once to initialize the ACKB bit to 0.
- B. Set receive mode (TRS = 0) before the next start condition is input in slave mode. Complete transmit operation by the procedure shown in figure 16.24, in order to switch from slave transmit mode to slave receive mode.

16.6.1 Module Stop Mode Setting

The IIC operation can be enabled or disabled using the module stop control register. The initial setting is for the IIC operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

RENESAS

Section 17 Keyboard Buffer Controller

This LSI has three on-chip keyboard buffer controller channels. The keyboard buffer controller is provided with functions conforming to the PS/2 interface specifications.

Data transfer using the keyboard buffer controller employs a data line (KD) and a clock line (KCLK), providing economical use of connectors, board surface area, etc. Figure 17.1 shows a block diagram of the keyboard buffer controller.

17.1 Features

- Conforms to PS/2 interface specifications
- Direct bus drive (via the KCLK and KD pins)
- Interrupt sources: on completion of data reception and on detection of clock edge
- Error detection: parity error and stop bit monitoring

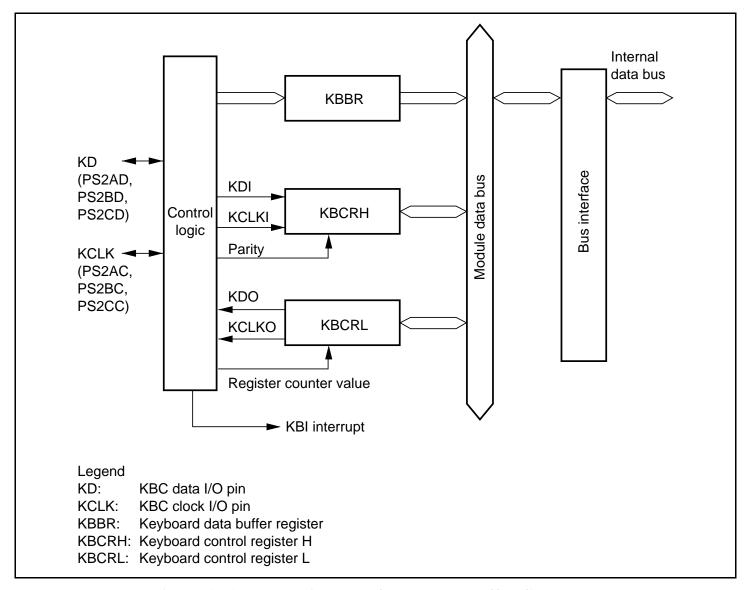


Figure 17.1 Block Diagram of Keyboard Buffer Controller

Figure 17.2 shows how the keyboard buffer controller is connected.

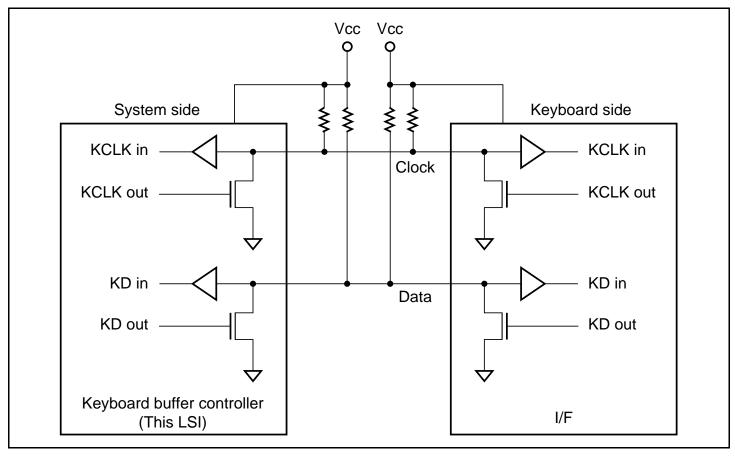


Figure 17.2 Keyboard Buffer Controller Connection

17.2 Input/Output Pins

Table 17.1 lists the input/output pins used by the keyboard buffer controller.

Table 17.1 Pin Configuration

| Channel | Name | Abbreviation* | I/O | Function |
|---------|---------------------------|---------------|-----|------------------------|
| 0 | KBC clock I/O pin (KCLK0) | PS2AC | I/O | KBC clock input/output |
| | KBC data I/O pin (KD0) | PS2AD | I/O | KBC data input/output |
| 1 | KBC clock I/O pin (KCLK1) | PS2BC | I/O | KBC clock input/output |
| | KBC data I/O pin (KD1) | PS2BD | I/O | KBC data input/output |
| 2 | KBC clock I/O pin (KCLK2) | PS2CC | I/O | KBC clock input/output |
| | KBC data I/O pin (KD2) | PS2CD | I/O | KBC data input/output |

Note:* These are the external I/O pin names. In the text, clock I/O pins are referred to as KCLK and data I/O pins as KD, omitting the channel designations.

17.3 Register Descriptions

The keyboard buffer controller has the following registers for each channel.

- Keyboard control register H (KBCRH)
- Keyboard control register L (KBCRL)
- Keyboard data buffer register (KBBR)

17.3.1 Keyboard Control Register H (KBCRH)

KBCRH indicates the operating status of the keyboard buffer controller.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KBIOE | 0 | R/W | Keyboard In/Out Enable |
| | | | | Selects whether or not the keyboard buffer controller is used. |
| | | | | The keyboard buffer controller is non-operational (KCLK and KD signal pins have port functions) |
| | | | | The keyboard buffer controller is enabled for transmission and reception (KCLK and KD signal pins are in the bus drive state) |
| 6 | KCLKI | 1 | R/W | Keyboard Clock In |
| | | | | Monitors the KCLK I/O pin. This bit cannot be modified. |
| | | | | 0: KCLK I/O pin is low |
| | | | | 1: KCLK I/O pin is high |
| 5 | KDI | 1 | R/W | Keyboard Data In: |
| | | | | Monitors the KDI I/O pin. This bit cannot be modified. |
| | | | | 0: KD I/O pin is low |
| | | | | 1: KD I/O pin is high |
| 4 | KBFSEL | 1 | R/W | Keyboard Buffer Register Full Select |
| | | | | Selects whether the KBF bit is used as the keyboard buffer register full flag or as the KCLK fall interrupt flag. When KBFSEL is cleared to 0, the KBE bit in KBCRL should be cleared to 0 to disable reception. |
| | | | | 0: KBF bit is used as KCLK fall interrupt flag |
| | | | | 1: KBF bit is used as keyboard buffer register full flag |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 3 | KBIE | 0 | R/W | Keyboard Interrupt Enable |
| | | | | Enables or disables interrupts from the keyboard buffer controller to the CPU. |
| | | | | 0: Interrupt requests are disabled |
| | | | | 1: Interrupt requests are enabled |
| 2 | KBF | 0 | R/(W)* | Keyboard Buffer Register Full |
| | | | | Indicates that data reception has been completed and the received data is in KBBR. |
| | | | | 0: [Clearing condition] |
| | | | | Read KBF when KBF =1, then write 0 in KBF |
| | | | | 1: [Setting conditions] |
| | | | | When data has been received normally and has been transferred to KBBR while KBFSEL = 1 (keyboard buffer register full flag) |
| | | | | When a KCLK falling edge is detected while KBFSEL = 0 (KCLK interrupt flag) |
| 1 | PER | 0 | R/(W)* | Parity Error |
| | | | | Indicates that an odd parity error has occurred. |
| | | | | 0: [Clearing condition] |
| | | | | Read PER when PER =1, then write 0 in PER |
| | | | | 1: [Setting condition] |
| | | | | When an odd parity error occurs |
| 0 | KBS | 0 | R | Keyboard Stop |
| | | | | Indicates the receive data stop bit. Valid only when KBF = 1. |
| | | | | 0: 0 stop bit received |
| | | | | 1: 1 stop bit received |

Note:* Only 0 can be written for clearing the flag.

17.3.2 Keyboard Control Register L (KBCRL)

KBCRL enables the receive counter count and controls the keyboard buffer controller pin output.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KBE | 0 | R/W | Keyboard Enable |
| | | | | Enables or disables loading of receive data into KBBR. |
| | | | | 0: Loading of receive data into KBBR is disabled |
| | | | | 1: Loading of receive data into KBBR is enabled |
| 6 | KCLKO | 1 | R/W | Keyboard Clock Out |
| | | | | Controls KBC clock I/O pin output. |
| | | | | 0: KBC clock I/O pin is low |
| | | | | 1: KBC clock I/O pin is high |
| 5 | KDO | 1 | R/W | Keyboard Data Out |
| | | | | Controls KBC data I/O pin output. |
| | | | | 0: KBC data I/O pin is low |
| | | | | 1: KBC data I/O pin is high |
| 4 | _ | 1 | _ | Reserved |
| | | | | This bit is always read as 1 and cannot be modified. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 3 | RXCR3 | 0 | R | Receive Counter |
| 2 | RXCR2 | 0 | R | These bits indicate the received data bit. Their value is |
| 1 | RXCR1 | 0 | R | incremented on the fall of KCLK. These bits cannot be modified. |
| 0 | RXCR0 | 0 | R | The receive counter is initialized to 0000 by a reset and when 0 is written in KBE. Its value returns to 0000 after a stop bit is received. |
| | | | | 0000: — |
| | | | | 0001: Start bit |
| | | | | 0010: KB0 |
| | | | | 0011: KB1 |
| | | | | 0100: KB2 |
| | | | | 0101: KB3 |
| | | | | 0110: KB4 |
| | | | | 0111: KB5 |
| | | | | 1000: KB6 |
| | | | | 1001: KB7 |
| | | | | 1010: Parity bit |
| | | | | 1011: — |
| | | | | 11:— |

17.3.3 Keyboard Data Buffer Register (KBBR)

KBBR stores receive data. Its value is valid only when KBF = 1.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | KB7 | 0 | R | Keyboard Data 7 to 0 |
| 6 | KB6 | 0 | R | 8-bit read only data. |
| 5 | KB5 | 0 | R | Initialized to H'00 by a reset, in standby mode, watch |
| 4 | KB4 | 0 | R | mode, subactive mode, subsleep mode, and module stop mode, and when KBIOE is cleared to 0. |
| 3 | KB3 | 0 | R | stop mode, and when NBIOL is cleared to 0. |
| 2 | KB2 | 0 | R | |
| 1 | KB1 | 0 | R | |
| 0 | KB0 | 0 | R | |

17.4 Operation

17.4.1 Receive Operation

In a receive operation, both KCLK (clock) and KD (data) are outputs on the keyboard side and inputs on this LSI chip (system) side. KD receives a start bit, 8 data bits (LSB-first), an odd parity bit, and a stop bit, in that order. The KD value is valid when KCLK is low. A sample receive processing flowchart is shown in figure 17.3, and the receive timing in figure 17.4.

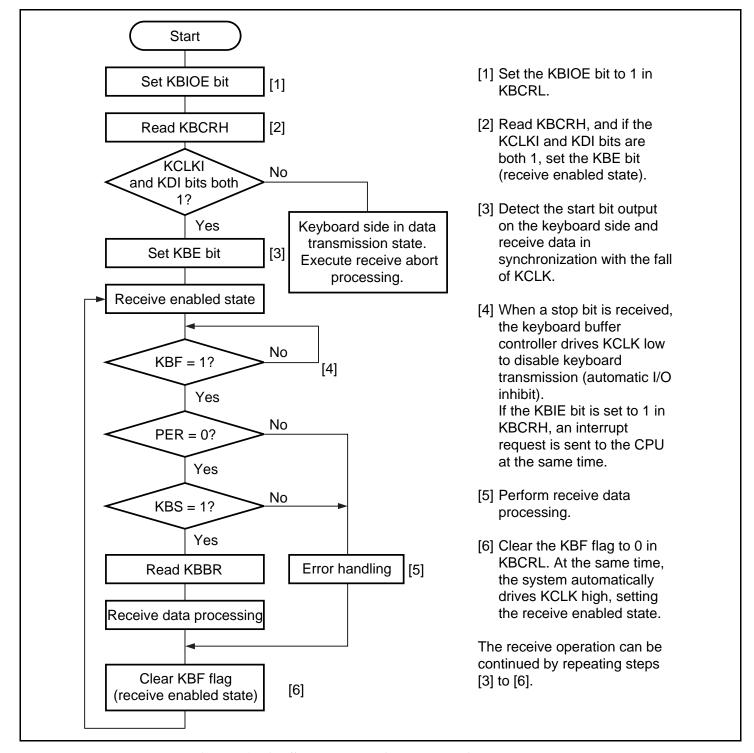


Figure 17.3 Sample Receive Processing Flowchart

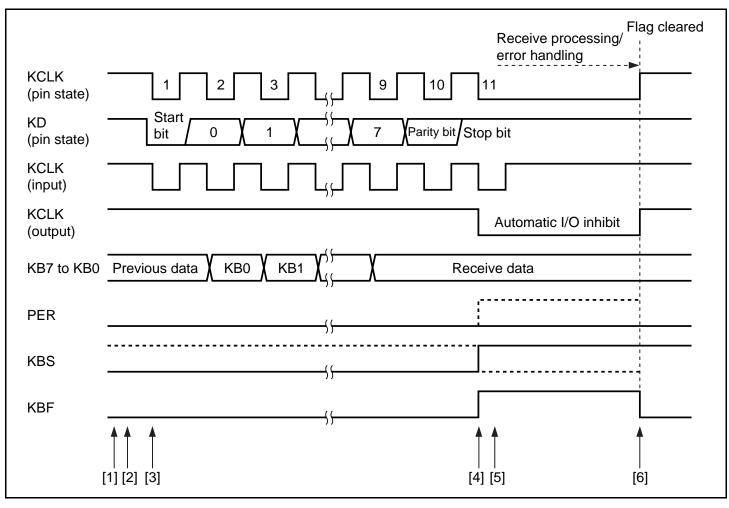


Figure 17.4 Receive Timing

17.4.2 Transmit Operation

In a transmit operation, KCLK (clock) is an output on the keyboard side, and KD (data) is an output on the chip (system) side. KD outputs a start bit, 8 data bits (LSB-first), an odd parity bit, and a stop bit, in that order. The KD value is valid when KCLK is high. A sample transmit processing flowchart is shown in figure 17.5, and the transmit timing in figure 17.6.

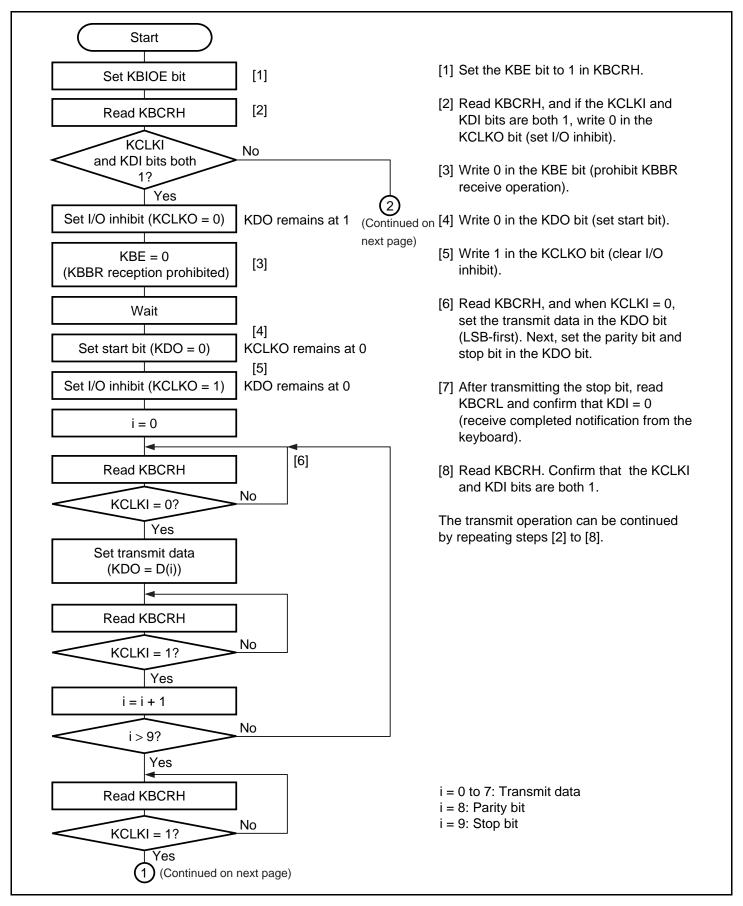


Figure 17.5 (1) Sample Transmit Processing Flowchart

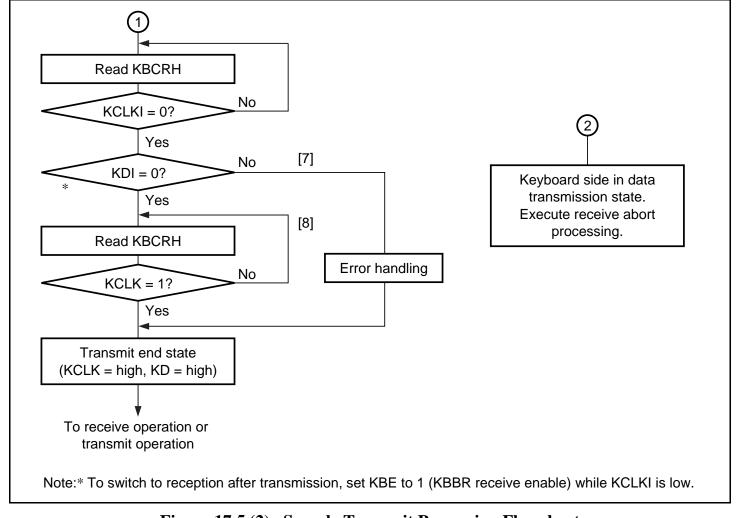


Figure 17.5 (2) Sample Transmit Processing Flowchart

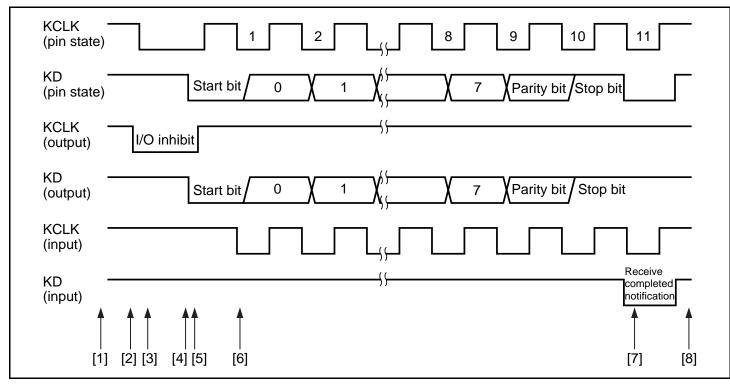


Figure 17.6 Transmit Timing

17.4.3 Receive Abort

This LSI (system side) can forcibly abort transmission from the device connected to it (keyboard side) in the event of a protocol error, etc. In this case, the system holds the clock low. During reception, the keyboard also outputs a clock for synchronization, and the clock is monitored when the keyboard output clock is high. If the clock is low at this time, the keyboard judges that there is an abort request from the system, and data transmission from the keyboard is aborted. Thus the system can abort reception by holding the clock low for a certain period. A sample receive abort processing flowchart is shown in figure 17.7, and the receive abort timing in figure 17.8.

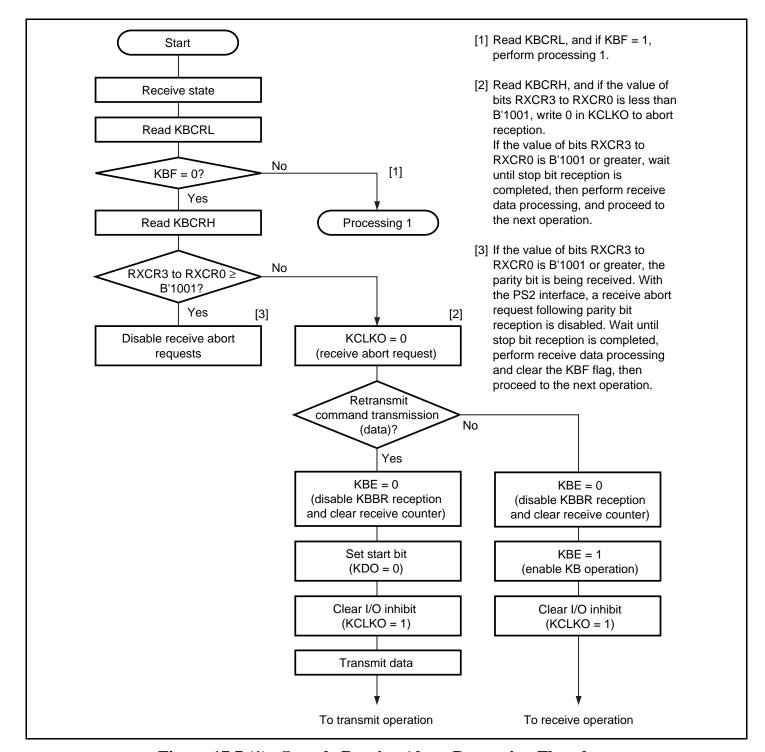


Figure 17.7 (1) Sample Receive Abort Processing Flowchart

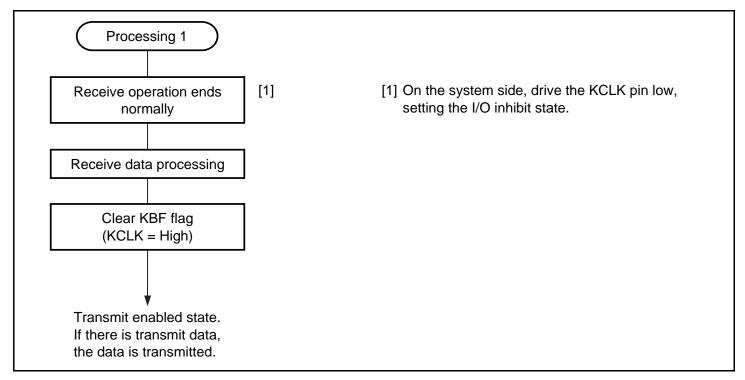


Figure 17.7 (2) Sample Receive Abort Processing Flowchart

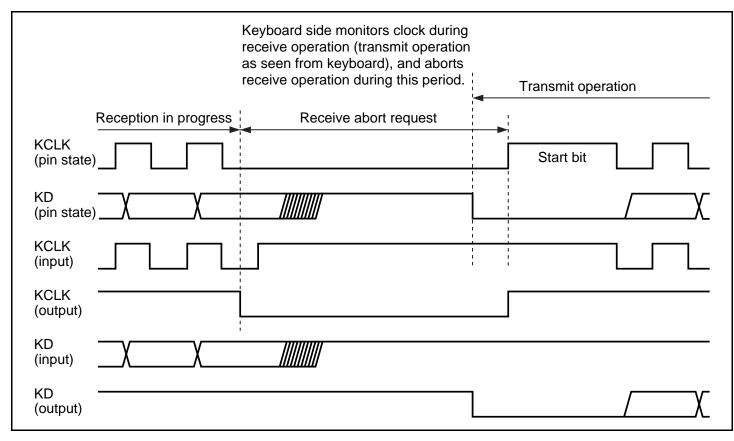


Figure 17.8 Receive Abort and Transmit Start (Transmission/Reception Switchover) Timing

17.4.4 KCLKI and KDI Read Timing

Figure 17.9 shows the KCLKI and KDI read timing.

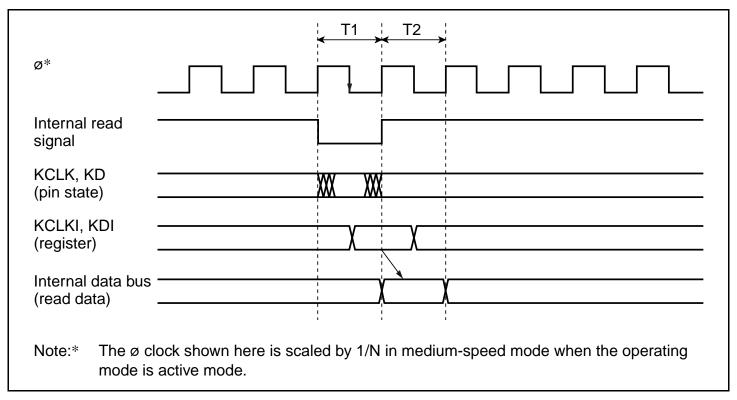


Figure 17.9 KCLKI and KDI Read Timing

17.4.5 KCLKO and KDO Write Timing

Figure 17.10 shows the KLCKO and KDO write timing and the KCLK and KD pin states.

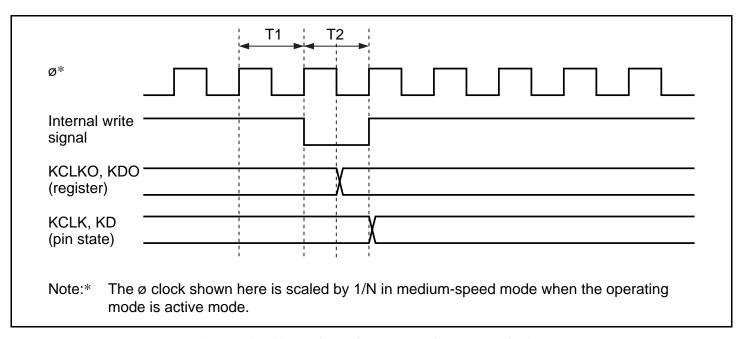


Figure 17.10 KCLKO and KDO Write Timing

17.4.6 KBF Setting Timing and KCLK Control

Figure 17.11 shows the KBF setting timing and the KCLK pin states.

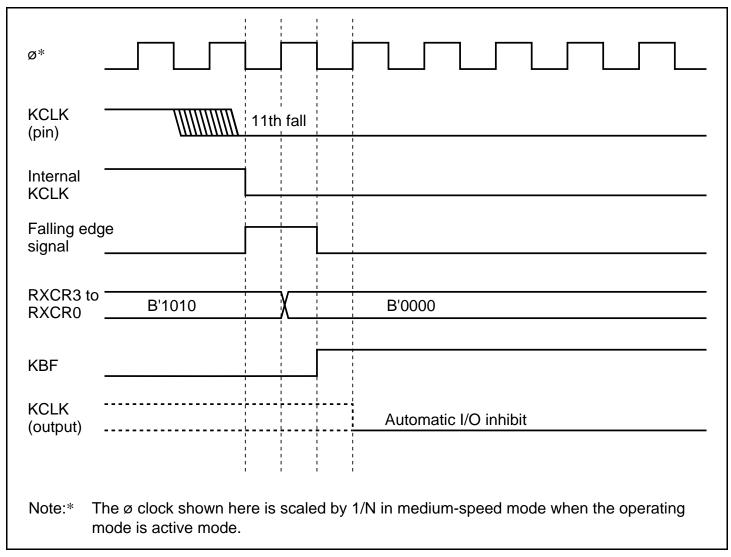


Figure 17.11 KBF Setting and KCLK Automatic I/O Inhibit Generation Timing

17.4.7 Receive Timing

Figure 17.12 shows the receive timing.

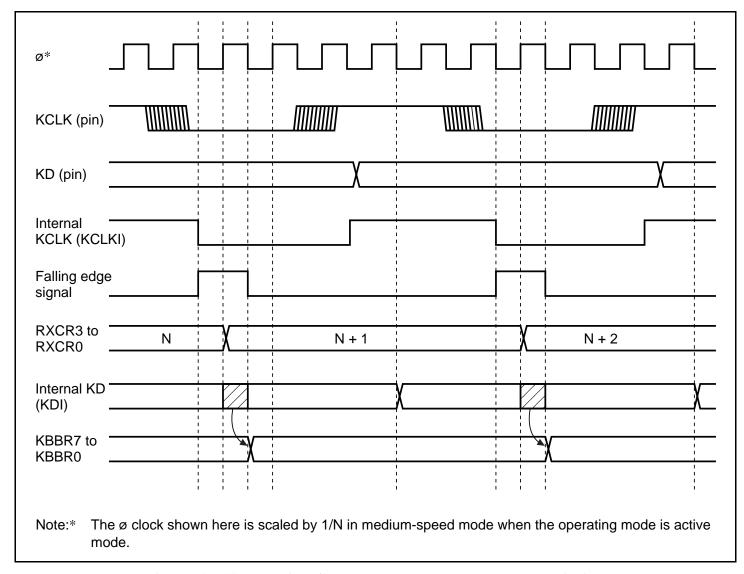


Figure 17.12 Receive Counter and KBBR Data Load Timing

17.4.8 KCLK Fall Interrupt Operation

In this device, clearing the KBFSEL bit to 0 in KBCRH enables the KBF bit in KBCRL to be used as a flag for the interrupt generated by the fall of KCLK input.

Figure 17.13 shows the setting method and an example of operation.

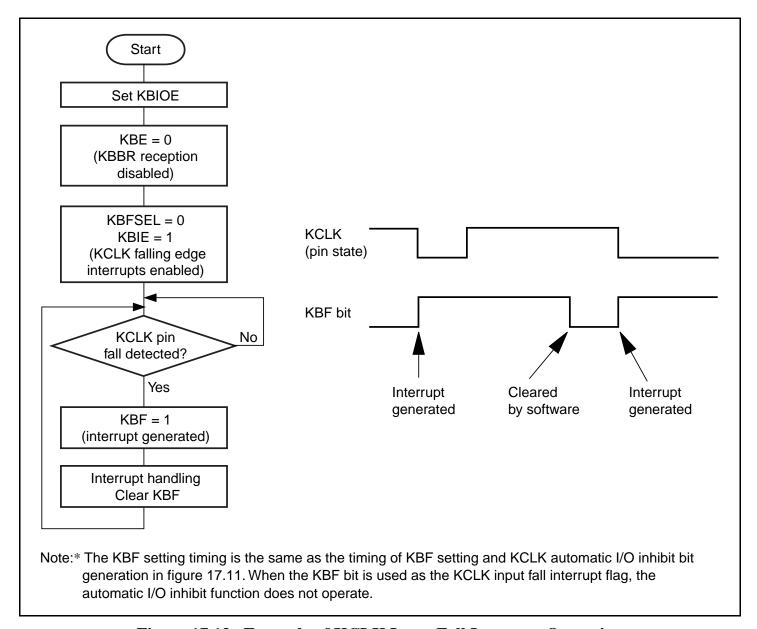


Figure 17.13 Example of KCLK Input Fall Interrupt Operation

17.5 Usage Notes

17.5.1 KBIOE Setting and KCLK Falling Edge Detection

When KBIOE is 0, the internal KCLK and internal KD settings are fixed at 1. Therefore, if the KCLK pin is low when the KBIOE bit is set to 1, the edge detection circuit operates and the KCLK falling edge is detected.

If the KBFSEL bit and KBE bit are both 0 at this time, the KBF bit is set. Figure 17.14 shows the timing of KBIOE setting and KCLK falling edge detection.

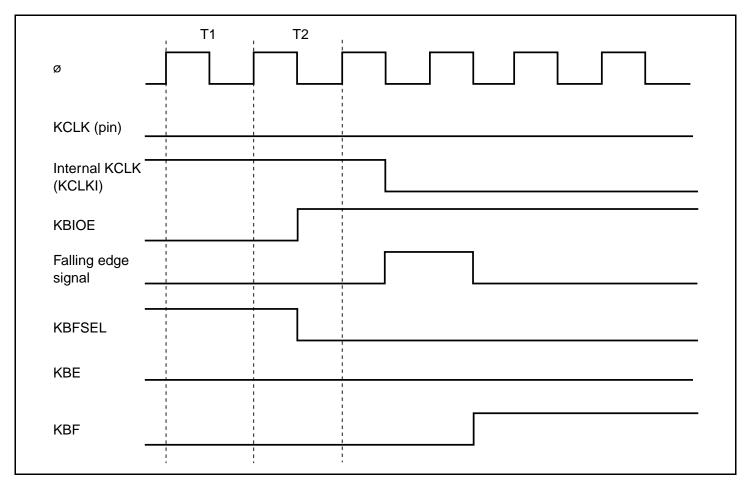


Figure 17.14 KBIOE Setting and KCLK Falling Edge Detection Timing

17.5.2 Module Stop Mode Setting

Keyboard buffer controller operation can be enabled or disabled using the module stop control register. The initial setting is for keyboard buffer controller operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

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Section 18 Host Interface X-Bus Interface (XBS)

This LSI has an on-chip host interface (HIF) that enables connection to the ISA bus (X-BUS) and has an on-chip LPC interface. In the following text, these two host interfaces (HIFs) are referred to as XBS and LPC, respectively.

The XBS provides a four-channel parallel interface between the chip's internal CPU and a host processor.

Communication is carried out via seven control signals from the host processor ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, $\overline{CS3}$, $\overline{CS4}$, $\overline{HA0}$, $\overline{HA0}$, $\overline{HA0}$, and $\overline{HA0}$, six output signals to the host processor ($\overline{GA20}$, $\overline{HRQ1}$, $\overline{HRQ11}$, $\overline{HRQ12}$, $\overline{HRQ3}$, and $\overline{HRQ4}$), and an 8-bit bidirectional command/data bus ($\overline{HDB7}$ to $\overline{HDB0}$). The $\overline{HA0}$ ($\overline{HA0}$), $\overline{HA0}$ ($\overline{HA0}$), $\overline{HA0}$ ($\overline{HA0}$), $\overline{HA0}$ ($\overline{HA0}$), $\overline{HA0}$ ($\overline{HA0}$), $\overline{HA0}$ 0 ($\overline{HA0}$ 0). The $\overline{HA0}$ 1 ($\overline{HA0}$ 1), $\overline{HA0}$ 2 ($\overline{HA0}$ 3), $\overline{HA0}$ 3 and $\overline{HA0}$ 3 ($\overline{HA0}$ 3), $\overline{HA0}$ 3 and $\overline{HA0}$ 4 signals select one of the four interface channels.

18.1 Features

- Control of the fast GATE A20 function
- Shutdown of the XBS module by the HIFSD pin
- Five host interrupt requests

Figure 18.1 shows a block diagram of the XBS.

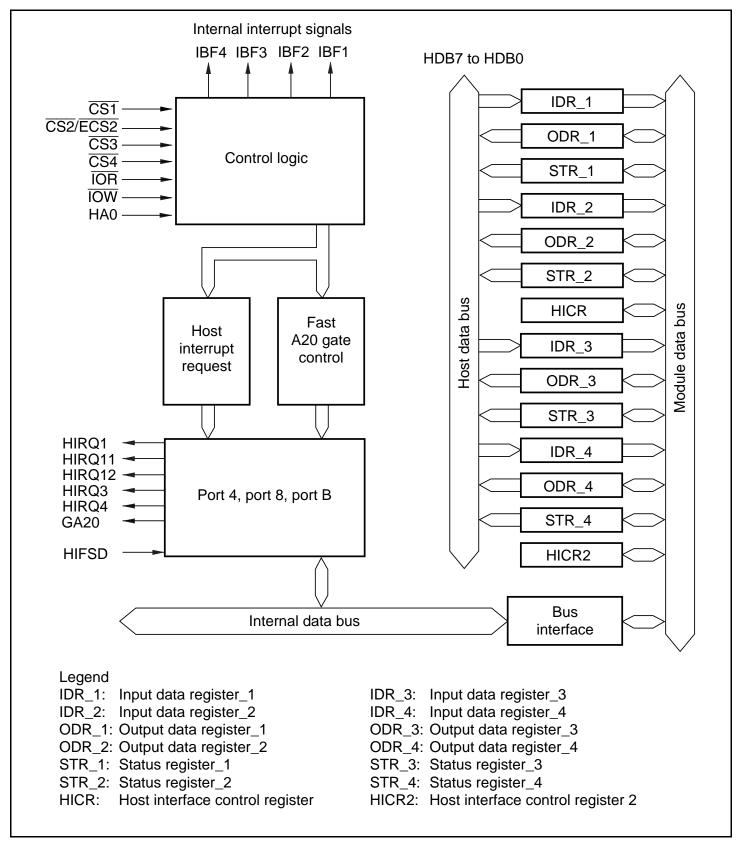


Figure 18.1 Block Diagram of XBS

18.2 Input/Output Pins

Table 18.1 lists the input and output pins of the XBS module.

Table 18.1 Pin Configuration

| Name | Abbreviation | Port | I/O | Function |
|-------------------|--------------|---------------|--------|--|
| I/O read | ĪOR | P93 | Input | Host interface read signal |
| I/O write | ĪOW | P94 | Input | Host interface write signal |
| Chip select 1 | CS1 | P95 | Input | Host interface chip select signal for IDR_1, ODR_1, STR_1 |
| Chip select 2* | CS2 | P81 | Input | Host interface chip select signal for IDR_2, |
| | ECS2 | P90 | | ODR_2, STR_2 |
| Chip select 3 | CS3 | PB2 | Input | Host interface chip select signal for IDR_3, ODR_3, STR_3 |
| Chip select 4 | CS4 | PB3 | Input | Host interface chip select signal for IDR_4, ODR_4, STR_4 |
| Command/data | HA0 | P80 | Input | Host interface address select signal |
| | | | | In host read access, this signal selects the status registers (STR_1 to STR_4) or data registers (ODR_1 to ODR_4). In host write access to the data registers (IDR_1 to IDR_4), this signal indicates whether the host is writing a command or data. |
| Data bus | HDB7 to HDB0 | P37 to P30 | I/O | Host interface data bus |
| Host interrupt 11 | HIRQ11 | P43 | Output | Interrupt output 11 to host |
| Host interrupt 1 | HIRQ1 | P44 | Output | Interrupt output 1 to host |
| Host interrupt 12 | HIRQ12 | P45 | Output | Interrupt output 12 to host |
| Host interrupt 3 | HIRQ3 | PB0 | Output | Interrupt output 3 to host |
| Host interrupt 4 | HIRQ4 | PB1 | Output | Interrupt output 4 to host |
| Gate A20 | GA20 | P81 | Output | A20 gate control signal output |
| HIF shutdown | HIFSD | P82 | Input | Host interface shutdown control signal |

Note:* Selection of $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ is by means of the CS2E bit in STCR and the FGA20E bit in HICR. XBS channel 2 and the $\overline{\text{CS2}}$ pin can be used when CS2E = 1. When CS2E = 1, $\overline{\text{CS2}}$ is used when FGA20E = 0, and $\overline{\text{ECS2}}$ is used when FGA20E = 1. In this manual, both are referred to as $\overline{\text{CS2}}$.

18.3 Register Descriptions

XBS has the following registers. XBS registers HICR, IDR_1, IDR_2, ODR_1, ODR_2, STR_1, and STR_2 can only be accessed when the HIE bit is set to 1 in SYSCR. For details on SYSCR, refer to section 3.2.2, System Control Register (SYSCR).

- System control register 2 (SYSCR2)
- Host interface control register (HICR)
- Host interface control register 2 (HICR2)
- Input data register (IDR)
- Output data register (ODR)
- Status register (STR)

18.3.1 System Control Register 2 (SYSCR2)

SYSCR2 controls the operations of port 6 and host interface.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|-------------|---------------|-----|--|
| 7 | KWUL1 | 0 | R/W | Key Wakeup Level 1 and 0 |
| 6 | KWUL0 | 0 | R/W | Sets the port 6 input level. The input level of port-6 multiplexing pins is also changed by these settings. |
| | | | | 00: Port 6 is in the standard input level |
| | | | | 01: Port 6 is in input level 1 |
| | | | | 10: Port 6 is in input level 2 |
| | | | | 11: Port 6 is in input level 3 |
| 5 | P6PUE | 0 | R/W | Port 6 Input Pull-Up MOS Extra (P6PUE) |
| | | | | Controls and selects the current specification for the port 6 input pull-up MOS. |
| | | | | 0: Standard current specification |
| | | | | 1: Current limited specification |
| 4 | | 0 | | Reserved |
| | | | | Only 0 should be written to this bit. |
| 3 | SDE | 0 | R/W | Shutdown Enable |
| | | | | 0: Host interface pin shutdown function disabled |
| | | | | 1: Host interface pin shutdown function enabled |
| | | | | When the shutdown function is enabled, host interface pin functions can be halted, and the pins placed in the high-impedance state, according to the state of the HIFSD pin. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | CS4E | 0 | R/W | CS4 Enable |
| | | | | 0: Channel 4 functions disabled |
| | | | | 1: Channel 4 functions enabled (channel 4 pin is enabled) |
| | | | | Enabling setting is valid when the HI12E bit is 1. |
| 1 | CS3E | 0 | R/W | CS3 Enable |
| | | | | 0: Channel 3 functions disabled |
| | | | | 1: Channel 3 functions enabled (channel 3 pin is enabled) |
| | | | | Enabling setting is valid when the HI12E bit is 1. |
| 0 | HI12E | 0 | R/W | Host Interface Enable Bit |
| | | | | 0: Host interface functions are disabled |
| | | | | 1: Host interface functions are enabled (settings of bits CS2E to CS4E, FGA20E, and SDE are enabled) |
| | | | | Enabling setting is valid in single-chip mode. |

18.3.2 Host Interface Control Register (HICR) Host Interface Control Register 2 (HICR2)

HICR controls host interface channel 1 and 2 interrupts and the fast A20 gate function. HICR2 controls host interface channel 3 and 4 interrupts.

HICR

| | Bit | Initial | R/W | | |
|--------|--------|---------|-------|------|--|
| Bit | Name | Value | Slave | Host | Description |
| 7 to 3 | | All 1 | | _ | Reserved |
| | | | | | These bits are always read as 1 and cannot be modified. |
| 2 | IBFIE2 | 0 | R/W | | Input Data Register Full Interrupt Enable 2 |
| | | | | | Enables or disables the IBF2 interrupt to the internal CPU. |
| | | | | | Input data register (IDR_2) reception completed interrupt request disabled |
| | | | | | 1: Input data register (IDR_2) reception completed interrupt request enabled |
| 1 | IBFIE1 | 0 | R/W | _ | Input Data Register Full Interrupt Enable 1 |
| | | | | | Enables or disables the IBF1 interrupt to the internal CPU. |
| | | | | | Input data register (IDR_1) reception completed interrupt request disabled |
| | | | | | Input data register (IDR_1) reception completed interrupt request enabled |

| | Bit | Initial | R/W | | |
|-----|--------|---------|-------|------|--|
| Bit | Name | Value | Slave | Host | Description |
| 0 | FGA20E | 0 | R/W | _ | Fast A20 Gate Function Enable |
| | | | | | When P81DDR=0: |
| | | | | | 0: XBS fast A20 gate function disabled |
| | | | | | 1: Setting prohibited |
| | | | | | When P81DDR=1: |
| | | | | | 0: XBS fast A20 gate function disabled |
| | | | | | 1: XBS fast A20 gate function enabled |
| | | | | | When the fast A20 gate is disabled, the normal A20 gate can be implemented by the firmware operation of the P81 output. |
| | | | | | When the host interface (XBS) fast A20 gate function is enabled, the DDR bit for P81 must be set to 1. Therefore, the state of the P81/GA20 pin cannot be monitored by reading the DR bit for P81. |
| | | | | | A fast A20 gate function is also provided in the LPC. The state of the P81/GA20 pin can be monitored by reading the LPC's GA20 bit. |

• HICR2

| | Bit | Initial | R/W | | |
|--------|--------|---------|-------|------|--|
| Bit | Name | Value | Slave | Host | Description |
| 7 to 3 | _ | All 1 | | _ | Reserved |
| | | | | | These bits are always read as 1, and cannot be modified. |
| 2 | IBFIE4 | 0 | R/W | | Input Data Register Full Interrupt Enable 4 |
| | | | | | Enables or disables the IBF4 interrupt to the internal CPU. |
| | | | | | Input data register (IDR_4) reception completed interrupt request disabled |
| | | | | | 1: Input data register (IDR_4) reception completed interrupt request enabled |
| 1 | IBFIE3 | 0 | R/W | | Input Data Register Full Interrupt Enable 3 |
| | | | | | Enables or disables the IBF3 interrupt to the internal CPU. |
| | | | | | Input data register (IDR_3) reception completed interrupt request disabled |
| | | | | | 1: Input data register (IDR_3) reception completed interrupt request enabled |
| 0 | _ | 0 | | _ | Reserved |
| | | | | | The initial value should not be changed. |

18.3.3 Input Data Register (IDR)

IDR is a register in which data to be input from the host processor to the slave processor (this LSI) is stored.

| | Bit | Initial | R/W | | |
|-----|------|---------|-------|------|---|
| Bit | Name | Value | Slave | Host | Description |
| 7 | IDR7 | _ | R | W | When \overline{CSn} (n = 1 to 4) is low, information on the |
| 6 | IDR6 | | R | W | host data bus is written into IDR_n at the rising edge of IOW. The HA0 state is also latched into |
| 5 | IDR5 | | R | W | the C/\overline{D} bit in STR_n to indicate whether the |
| 4 | IDR4 | | R | W | written information is a command or data. |
| 3 | IDR3 | | R | W | |
| 2 | IDR2 | | R | W | |
| 1 | IDR1 | | R | W | |
| 0 | IDR0 | | R | W | |

18.3.4 Output Data Register 1 (ODR)

ODR is a register in which data to be output from the slave processor (this LSI) to the host processor is stored.

| | Bit | Initial | R/W | | |
|-----|------|---------|-------|------|--|
| Bit | Name | Value | Slave | Host | Description |
| 7 | ODR7 | _ | R/W | R | The ODR_n contents are output on the host |
| 6 | ODR6 | | R/W | R | data bus when HA0 is low, \overline{CSn} (n = 1 to 4) is low, and \overline{IOR} is low. |
| 5 | ODR5 | _ | R/W | R | iow, and ion is iow. |
| 4 | ODR4 | | R/W | R | |
| 3 | ODR3 | | R/W | R | |
| 2 | ODR2 | | R/W | R | |
| 1 | ODR1 | | R/W | R | |
| 0 | ODR0 | | R/W | R | |

18.3.5 Status Register (STR)

STR indicates status information during host interface processing.

| | Bit InitialR/W | | /W | | |
|--------|----------------|-------|--------|------|--|
| Bit | Name | Value | Slave | Host | |
| 7 to 4 | DBU | All 0 | R/W | R | Defined by User |
| | | | | | The user can use these bits as necessary. |
| 3 | C/D | 0 | R | R | Command/Data |
| | | | | | Receives the HA0 input when the host processor writes to IDR, and indicates whether IDR contains data or a command. |
| | | | | | 0: Contents of input data register (IDR) are data |
| | | | | | 1: Contents of input data register (IDR) are a command |
| 2 | DBU | 0 | R/W | R | Defined by User |
| | | | | | The user can use these bits as necessary. |
| 1 | IBF | 0 | R | R | Input Buffer Full |
| | | | | | This bit is an internal interrupt source to the slave processor (this LSI). |
| | | | | | The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 18.5. |
| | | | | | [Clearing Condition] |
| | | | | | 0: When the slave processor reads IDR |
| | | | | | [Setting Condition] |
| | | | | | 1: When the host processor writes to IDR |
| 0 | OBF | 0 | R/(W)* | R | Output Buffer Full |
| | | | | | [Clearing Condition] |
| | | | | | 0: When the host processor reads ODR or the slave writes 0 in the OBF bit |
| | | | | | [Setting Condition] |
| | | | | | 1: When the slave processor writes to ODR |

Note:* Only 0 can be written, to clear the flag.

Table 18.2 shows the conditions for setting and clearing the STR flags.

Table 18.2 Set/Clear Timing for STR Flags

| Flag | Setting Condition | Clearing Condition |
|------|--|--|
| C/D | Rising edge of host's write signal (IOW) when HA0 is high | Rising edge of host's write signal ($\overline{\text{IOW}}$) when HA0 is low |
| IBF* | Rising edge of host's write signal (IOW) when writing to IDR1 | Falling edge of slave's internal read signal when reading IDR1 |
| OBF | Falling edge of slave's internal write signal when writing to ODR1 | Rising edge of host's read signal (IOR) when reading ODR1 |

Note:* The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 18.5.

18.4 Operation

18.4.1 Host Interface Activation

The host interface is activated by setting the HI12E bit in SYSCR2 to 1 in single-chip mode. When the host interface is activated, all related I/O ports (data port 3, control ports 8 and 9, and host interrupt request port 4) become dedicated host interface ports. Setting the CS3E bit and CS4E bit to 1 enables the number of host interface channels to be extended to four, and makes the channel 3 and 4 related I/O port (part of port B for control and host interrupt requests) a dedicated host interface port.

Table 18.3 shows HIF host interface channel selection and pin operation.

Table 18.3 Host Interface Channel Selection and Pin Operation

| HI12E | CS2E | CS3E | CS4E | Operation | |
|-------|------|------|------|---|--|
| 0 | | | | Host interface functions halted | |
| 1 | 0 | 0 | 0 | Host interface channel 1 only operating | |
| | | | | Operation of channels 2 to 4 halted | |
| | | | | Pins P43, P81, P90, and PB0 to PB3 operate as I/O ports. $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$, $\overline{\text{CS3}}$, and $\overline{\text{CS4}}$ inputs do not operate. | |
| | | | 1 | Host interface channel 1 and 4 functions operating | |
| | | | | Operation of channels 2 and 3 halted | |
| | | | | Pins P43, P81, P90, PB0, and PB2 operate as I/O ports. $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ and $\overline{\text{CS3}}$ inputs do not operate. | |
| | | 1 | 0 | Host interface channel 1 and 3 functions operating | |
| | | | | Operation of channels 2 and 4 halted | |
| | | | | Pins P43, P81, P90, PB1, and PB3 operate as I/O ports. $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ and $\overline{\text{CS4}}$ inputs do not operate. | |
| | | | 1 | Host interface channel 1, 3, and 4 functions operating | |
| | | | | Operation of channel 2 halted | |
| | | | | Pins P43, P81, and P90 operate as I/O ports. $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ input does not operate. | |
| | 1 | 0 | 0 | Host interface channel 1 and 2 functions operating | |
| | | | | Operation of channels 3 and 4 halted | |
| | | | | Pins PB0 to PB3 operate as I/O ports. $\overline{\text{CS3}}$ and $\overline{\text{CS4}}$ inputs do not operate. | |
| | | | 1 | Host interface channel 1, 2, and 4 functions operating | |
| | | | | Operation of channel 3 halted | |
| | | | | Pins PB0 and PB2 operate as I/O ports. $\overline{\text{CS3}}$ input does not operate. | |
| | | 1 | 0 | Host interface channel 1 to 3 functions operating | |
| | | | | Operation of channel 4 halted | |
| | | | | Pins PB1 and PB3 operate as I/O ports. $\overline{\text{CS4}}$ input does not operate. | |
| | | | 1 | Host interface channel 1 to 4 functions operating | |

18.4.2 Control States

Table 18.4 shows host interface operations from the HIF host, and slave (this LSI) operation.

Table 18.4 Host Interface Operations from HIF Host, and Slave Operation

| Other than CSn | CSn | ĪŌR | ĪOW | HA0 | Operation |
|----------------|-----|-----|-----|-----|--|
| 1 | 0 | 0 | 0 | 0 | Setting prohibited |
| | | | | 1 | Setting prohibited |
| | | | 1 | 0 | Data read from output data register n (ODR_n) |
| | | | | 1 | Status read from status register n (STR_n) |
| | | 1 | 0 | 0 | Data written to input data register n (IDR_n) |
| | | | | 1 | Command written to input data register n (IDR_n) |
| | | | 1 | 0 | Idle state |
| | | | | 1 | Idle state |
| | | | | | (n = 1 to 4) |

18.4.3 A20 Gate

The A20 gate signal can mask address A20 to emulate an addressing mode used by personal computers with an 8086*-family CPU. A regular-speed A20 gate signal can be output under firmware control. Fast A20 gate output is enabled by setting the FGA20E bit (bit 0) to 1 in HICR (H'FFF0).

Note: *: Intel microprocessor.

Regular A20 Gate Operation: Output of the A20 gate signal can be controlled by an H'D1 command followed by data. When the slave processor (this LSI) receives data, it normally uses an interrupt routine activated by the IBF1 interrupt to read IDR1. If the data follows an H'D1 command, software copies bit 1 of the data and outputs it at the gate A20 pin.

Fast A20 Gate Operation: When the FGA20E bit is set to 1, P81/GA20 is used for output of a fast A20 gate signal. Bit P81DDR must be set to 1 to assign this pin for output. When the DDR bit for P81 is set to 1, the state of the P81/GA20 pin cannot be monitored by reading the DR bit for P81. The state of the P81/GA20 pin can be monitored by reading the GA20 bit in the LPC's HICR2 register. The initial output from this pin will be a logic 1, which is the initial value. Afterward, the host processor can manipulate the output from this pin by sending commands and data. This function is available only when register IDR1 is accessed using CS1. The slave processor (this LSI) decodes the commands input from the host processor. When an H'D1 host command is detected, bit 1 of the data following the host command is output from the GA20 output pin. This operation does not depend on firmware or interrupts, and is faster than the regular

processing using interrupts. Table 18.5 lists the conditions that set and clear GA20 (P81). Figure 18.2 shows the GA20 output in flowchart form. Table 18.6 indicates the GA20 output signal values.

Table 18.5 GA20 (P81) Set/Clear Timing

| Pin Name | Setting Condition | Clearing Condition |
|---------------|--|--|
| GA20 (P81) | Rising edge of the host's write signal (IOW) when bit 1 of the written data is 1 and the data follows an H'D1 host command | Rising edge of the host's write signal (IOW) when bit 1 of the written data is 0 and the data follows an H'D1 host command |
| | | Also, when bit FGA20E in HICR is cleared to 0 |

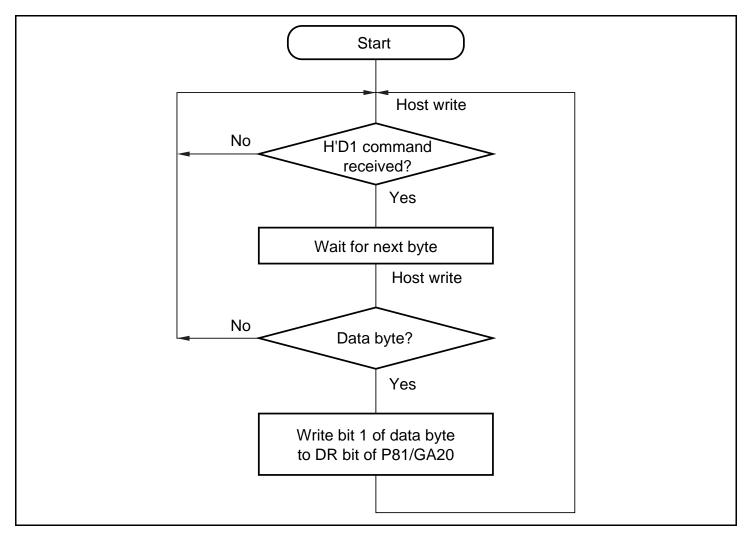


Figure 18.2 GA20 Output

Table 18.6 Fast A20 Gate Output Signal

| HA0 | Data/Command | Internal CPU Interrupt Flaç (IBF) | g GA20 (P81) | Remarks |
|-------|--|---|-----------------|------------------------|
| 1 | H'D1 command | 0 | Q | Turn-on sequence |
| 0 | 1 data*1 | 0 | 1 | |
| 1 | H'FF command | 0 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence |
| 0 | 0 data* ² | 0 | 0 | |
| 1 | H'FF command | 0 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Turn-on sequence |
| 0 | 1 data* ¹ | 0 | 1 | (abbreviated form) |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence |
| 0 | 0 data* ² | 0 | 0 | (abbreviated form) |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Cancelled sequence |
| 1 | Command other than H'D1 | 1 | Q | · |
| 1 | H'D1 command | 0 | Q | Retriggered sequence |
| 1 | H'D1 command | 0 | Q | |
| 1 | H'D1 command | 0 | Q | Consecutively executed |
| 0 | Any data | 0 | 1/0 | sequences |
| 1 | H'D1 command | 0 | Q (1/0) | |
| N 1 4 | 4. Aula itua marala ta susitia la ita 4. a a t | | | |

Notes: 1. Arbitrary data with bit 1 set to 1.

2. Arbitrary data with bit 1 cleared to 0.

18.4.4 Host Interface Pin Shutdown Function

Host interface output can be placed in the high-impedance state according to the state of the HIFSD pin. Setting the SDE bit to 1 in the SYSCR2 register when the HI12E bit is set to 1 enables the HIFSD pin. The HIF constantly monitors the HIFSD pin, and when this pin goes low, places the host interface output pins (HIRQ1, HIRQ11, HIRQ12, HIRQ3, HIRQ4, and GA20) in the high-impedance state. At the same time, the host interface input pins ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, $\overline{CS3}$, $\overline{CS4}$, \overline{IOW} , \overline{IOR} , and HA0) are disabled (fixed at the high input state internally) regardless of the pin states, and the signals of the multiplexed functions of these pins (input block) are similarly fixed internally. As a result, the host interface I/O pins (HDB7 to HDB0) also go to the high-impedance state.

This state is maintained while the HIFSD pin is low, and when the HIFSD pin returns to the high-level state, the pins are restored to their normal operation as host interface pins.

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Table 18.7 shows the scope of HIF pin shutdown.

Table 18.7 Scope of HIF Pin Shutdown

| Abbreviation | Port | Scope of Shutdown in Slave Mode | I/O | Selection Conditions |
|-----------------|---------------|---------------------------------------|--------|---------------------------------------|
| ĪOR | P93 | 0 | Input | HI12E = 1 |
| ĪOW | P94 | 0 | Input | HI12E = 1 |
| CS1 | P95 | 0 | Input | HI12E = 1 |
| CS2 | P81 | Δ | Input | HI12E = 1 and CS2E = 1 and FGA20E = 0 |
| ECS2 | P90 | Δ | Input | HI12E = 1 and CS2E = 1 and FGA20E = 1 |
| CS3 | PB2 | Δ | Input | HI12E = 1 and CS3E = 1 |
| CS4 | PB3 | Δ | Input | HI12E = 1 and CS4E = 1 |
| HA0 | P80 | 0 | Input | HI12E = 1 |
| HDB7 to HDB0 | P37 to P30 | 0 | I/O | HI12E = 1 |
| HIRQ11 | P43 | Δ | Output | HI12E = 1 and CS2E = 1 and P43DDR = 1 |
| HIRQ1 | P44 | Δ | Output | HI12E = 1 and P44DDR = 1 |
| HIRQ12 | P45 | Δ | Output | HI12E = 1 and P45DDR = 1 |
| HIRQ3 | PB0 | Δ | Output | HI12E = 1 and CS3E = 1 and PB0DDR = 1 |
| HIRQ4 | PB1 | Δ | Output | HI12E = 1 and CS4E = 1 and PB1DDR = 1 |
| GA20 | P81 | Δ | Output | HI12E = 1 and FGA20E = 1 |
| HIFSD | P82 | _ | Input | HI12E = 1 and SDE = 1 |

Legend:

O: Pins shut down by shutdown function

The IRQ2/ADTRG input signal is also fixed in the case of P90 shutdown, the TMCI1/HSYNCI signal in the case of P43 shutdown, and the TMRI/CSYNCI in the case of P45 shutdown.

Δ: Pins shut down only when the XBS function is selected by means of a register setting

—: Pin not shut down

18.5 Interrupt Sources

18.5.1 IBF1, IBF2, IBF3, and IBF4

The host interface can issue four interrupt requests to the slave processor: IBF1, IBF2, IBF3 and IBF4. They are input buffer full interrupts for input data registers IDR_1, IDR_2, IDR_3 and IDR_4 respectively. Each interrupt is enabled when the corresponding enable bit is set.

Table 18.8 Input Buffer Full Interrupts

| Interrupt | Description |
|-----------|---|
| IBF1 | Requested when IBFIE1 is set to 1 and IDR_1 is full |
| IBF2 | Requested when IBFIE2 is set to 1 and IDR_2 is full |
| IBF3 | Requested when IBFIE3 is set to 1 and IDR_3 is full |
| IBF4 | Requested when IBFIE4 is set to 1 and IDR_4 is full |

18.5.2 HIRQ11, HIRQ1, HIRQ12, HIRQ3, and HIRQ4

Bits P45DR to P43DR in the port 4 data register (P4DR) and bits PB1ODR and PB0ODR in the port B data register (PBODR) can be used as host interrupt request latches. When they are used as host interrupt request output, set each bit in the data direction register (DDR) of the pin to 1.

The corresponding bits in P4DR are cleared to 0 by the host processor's read signal (IOR). If CS1 and HA0 are low, when \overline{IOR} goes low and the host reads ODR_1, HIRQ1 and HIRQ12 are cleared to 0. If $\overline{CS2}$ and HA0 are low, when \overline{IOR} goes low and the host reads ODR_2, HIRQ11 is cleared to 0. The corresponding bit in PBODR is cleared to 0 by the host's read signal (\overline{IOR}). If $\overline{CS3}$ and HA0 are low, when \overline{IOR} goes low and the host reads ODR_3, HIRQ3 is cleared to 0. If $\overline{CS4}$ and HA0 are low, when \overline{IOR} goes low and the host reads ODR_4, HIRQ4 is cleared to 0. To generate a host interrupt request, normally on-chip firmware writes 1 in the corresponding bit. In processing the interrupt, the host's interrupt handling routine reads the output data register (ODR_1, ODR_2, ODR_3, or ODR_4) and this clears the host interrupt latch to 0.

Table 18.9 indicates how these bits are set and cleared. Figure 18.3 shows the processing in flowchart form.

Table 18.9 HIRQ Setting/Clearing Conditions

| Host Interrupt Signal | Setting Condition | Clearing Condition |
|-----------------------|---|---|
| HIRQ11 (P43) | Internal CPU reads 0 from bit P43DR, then writes 1 | Internal CPU writes 0 in bit P43DR, or host reads output data register_2 (ODR_2) |
| HIRQ1 (P44) | Internal CPU reads 0 from bit P44DR, then writes 1 | Internal CPU writes 0 in bit P44DR, or host reads output data register_1 (ODR_1) |
| HIRQ12 (P45) | Internal CPU reads 0 from bit P45DR, then writes 1 | Internal CPU writes 0 in bit P45DR, or host reads output data register_1 (ODR_1) |
| HIRQ3 (PB0) | Internal CPU reads 0 from bit PB0ODR, then writes 1 | Internal CPU writes 0 in bit PB0ODR, or host reads output data register_3 (ODR_3) |
| HIRQ4 (PB1) | Internal CPU reads 0 from bit PB1ODR, then writes 1 | Internal CPU writes 0 in bit PB1ODR, or host reads output data register_4 (ODR_4) |

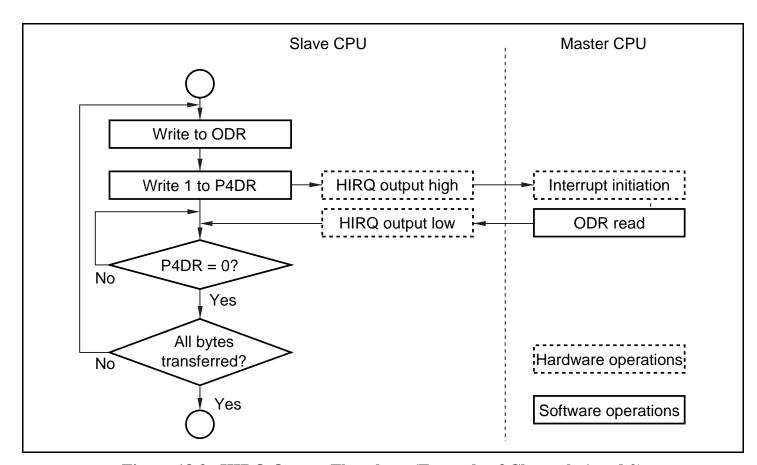


Figure 18.3 HIRQ Output Flowchart (Example of Channels 1 and 2)

HIRQ Setting/Clearing Conflict: If there is conflict between a P4DR or PBODR read/write by the CPU and P4DR (HIRQ11, HIRQ1, HIRQ12) or PBODR (HIRQ3, HIRQ4) clearing by the

host, clearing by the host is held pending during the P4DR or PBODR read/write by the CPU. P4DR or PBODR clearing is executed after completion of the read/write.

18.6 Usage Notes

18.6.1 Note on Host Interface

The host interface provides buffering of asynchronous data from the host processor and slave processor (this LSI), but an interface protocol must be followed to implement necessary functions and avoid data contention. For example, if the host and slave processors try to access the same input or output data register simultaneously, the data will be corrupted. Interrupts can be used to design a simple and effective protocol.

Also, if two or more of pins $\overline{CS1}$ to $\overline{CS4}$ are driven low simultaneously in attempting IDR or ODR access, signal contention will occur within the chip, and a through-current may result. This usage must therefore be avoided.

18.6.2 Module Stop Mode Setting

XBS operation can be enabled or disabled using the module stop control register. The initial setting is for XBS operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

Section 19 Host Interface LPC Interface (LPC)

This LSI has an on-chip LPC interface.

The LPC performs serial transfer of cycle type, address, and data, synchronized with the 33 MHz PCI clock. It uses four signal lines for address/data, and one for host interrupt requests. This LPC module supports only I/O read cycle and I/O write cycle transfers.

It is also provided with power-down functions that can control the PCI clock and shut down the host interface.

19.1 Features

- Supports LPC interface I/O read cycles and I/O write cycles
 - Uses four signal lines (LAD3 to LAD0) to transfer the cycle type, address, and data.
 - Uses three control signals: clock (LCLK), reset (<u>LRESET</u>), and frame (<u>LFRAME</u>).
- Has three register sets comprising data and status registers
 - The basic register set comprises three bytes: an input register (IDR), output register (ODR), and status register (STR).
 - Channels 1 and 2 have fixed I/O addresses of H'60/H'64 and H'62/H'66, respectively. A fast A20 gate function is also provided.
 - The I/O address can be set for channel 3. Sixteen bidirectional data register bytes can be manipulated in addition to the basic register set.
- Supports SERIRQ
 - Host interrupt requests are transferred serially on a single signal line (SERIRQ).
 - On channel 1, HIRQ1 and HIRQ12 can be generated.
 - On channels 2 and 3, SMI, HIRQ6, and HIRQ9 to HIRQ11 can be generated.
 - Operation can be switched between quiet mode and continuous mode.
 - The CLKRUN signal can be manipulated to restart the PCI clock (LCLK).
- Eleven interrupt sources
 - The LPC module can be shut down by inputting the \overline{LPCPD} signal.
 - Three pins, PME, LSMI, and LSCI, are provided for general input/output.

Figure 19.1 shows a block diagram of the LPC.

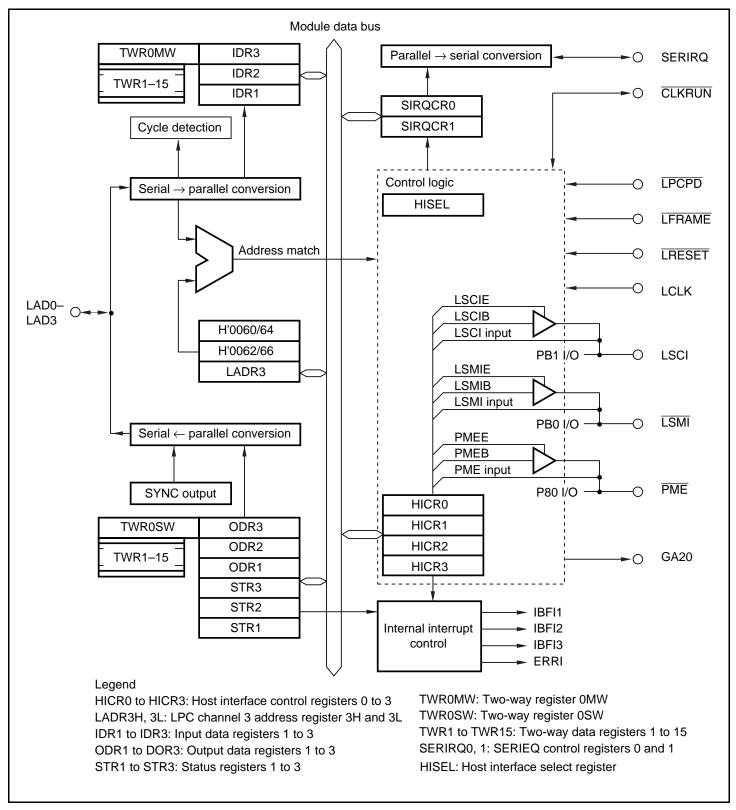


Figure 19.1 Block Diagram of LPC

19.2 Input/Output Pins

Table 19.1 lists the input and output pins of the LPC module.

Table 19.1 Pin Configuration

| Name | Abbreviation | Port | I/O | Function |
|------------------------------|--------------|------------|--|---|
| LPC address/ data 3 to 0 | LAD3 to LAD0 | P33 to P30 | Input/ output | Serial (4-signal-line) transfer cycle type/address/data signals, synchronized with LCLK |
| LPC frame | LFRAME | P34 | Input*1 | Transfer cycle start and forced termination signal |
| LPC reset | LRESET | P35 | Input*1 | LPC interface reset signal |
| LPC clock | LCLK | P36 | Input | 33 MHz PCI clock signal |
| Serialized interrupt request | SERIRQ | P37 | Input/ output* ¹ | Serialized host interrupt request signal, synchronized with LCLK (SMI, IRQ1, IRQ6, IRQ9 to IRQ12) |
| LSCI general output | LSCI | PB1 | Output* ^{1,} * ² | General output |
| LSMI general output | LSMI | PB0 | Output*1, *2 | General output |
| PME general output | PME | P80 | Output*1, *2 | General output |
| GATE A20 | GA20 | P81 | Output*1, *2 | A20 gate control signal output |
| LPC clock run | CLKRUN | P82 | Input/ output* ^{1,} * ² | LCLK restart request signal in case of serial host interrupt request |
| LPC power-down | LPCPD | P83 | Input* ¹ | LPC module shutdown signal |

Notes: 1. Pin state monitoring input is possible in addition to the LPC interface control input/output function.

2. Only 0 can be output. If 1 is output, the pin goes to the high-impedance state, so an external resistor is necessary to pull the signal up to V_{cc} .

19.3 Register Descriptions

The LPC has the following registers. The settings of XBS related bits do not affect the operation of this LSI's LPC. However, for reasons relating to the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 should not be set to 1. For details, see section 3.2.2, System Control Register (SYSCR), and section 18.3.1, System Control Register 2 (SYSCR2).

- Host interface control register 0 (HICR0)
- Host interface control register 1 (HICR1)
- Host interface control register 2 (HICR2)
- Host interface control register 3 (HICR3)
- LPC channel 3 address registers (LADR3H, LADR3L)
- Input data register 1 (IDR1)
- Output data register 1 (ODR1)
- Status register 1 (STR1)
- Input data register 2 (IDR2)
- Output data register 2 (ODR2)
- Status register 2 (STR2)
- Input data register 3 (IDR3)
- Output data register 3 (ODR3)
- Status register 3 (STR3)
- Bidirectional data registers 0 to 15 (TWR0 to TWR15)
- SERIRQ control register 0 (SIRQCR0)
- SERIRQ control register 1 (SIRQCR1)
- Host interface select register (HISEL)

19.3.1 Host Interface Control Registers 0 and 1 (HICR0, HICR1)

HICR0 and HICR1 contain control bits that enable or disable host interface functions, control bits that determine pin output and the internal state of the host interface, and status flags that monitor the internal state of the host interface.

• HICR0

| | | | R/W | | | |
|-----|----------|---------------|-------|------|--|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description | |
| 7 | LPC3E | 0 | R/W | _ | LPC Enable 3 to 1 | |
| 6 | LPC2E | 0 | R/W | _ | Enable or disable the host interface function in | |
| 5 | LPC1E | 0 | R/W | _ | single-chip mode. When the host interface is enable (one of the three bits is set to 1), processing for data transfer between the slave processor (this LSI) and the host processor is performed using pins LAD3 to LAD0, LFRAME, LRESET, LCLK, SERIRQ, CLKRUN, and LPCPD. | |
| | | | | | • LPC3E | |
| | | | | | 0: LPC channel 3 operation is disabled | |
| | | | | | No address (LADR3) matches for IDR3, ODR3, STR3, or TWR0 to TWR15 | |
| | | | | | 1: LPC channel 3 operation is enabled | |
| | | | | | • LPC2E | |
| | | | | | 0: LPC channel 2 operation is disabled | |
| | | | | | No address (H'0062, 66) matches for IDR2, ODR2, or STR2 | |
| | | | | | 1: LPC channel 2 operation is enabled | |
| | | | | | • LPC1E | |
| | | | | | 0: LPC channel 1 operation is disabled | |
| | | | | | No address (H'0060, 64) matches for IDR1, ODR1, or STR1 | |
| | | | | | 1: LPC channel 1 operation is enabled | |

| | | | R | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 4 | FGA20E | 0 | R/W | | Fast A20 Gate Function Enable |
| | | | | | Enables or disables the fast A20 gate function. When the fast A20 gate is disabled, the normal A20 gate can be implemented by firmware operation of the P81 output. |
| | | | | | When the fast A20 gate function is enabled, the DDR bit for P81 must not be set to 1. |
| | | | | | 0: Fast A20 gate function disabled |
| | | | | | Other function of pin P81 is enabled |
| | | | | | GA20 output internal state is initialized to 1 |
| | | | | | 1: Fast A20 gate function enabled |
| | | | | | GA20 pin output is open-drain (external VCC pull- up resistor required) |
| 3 | SDWNE | 0 | R/W | _ | LPC Software Shutdown Enable |
| | | | | | Controls host interface shutdown. For details of the LPC shutdown function, and the scope of initialization by an LPC reset and an LPC shutdown, see section 19.4.4, Host Interface Shutdown Function (LPCPD). |
| | | | | | 0: Normal state, LPC software shutdown setting enabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 |
| | | | | | LPC hardware reset or LPC software reset |
| | | | | | LPC hardware shutdown release (rising edge of |
| | | | | | 1: LPC hardware shutdown state setting enabled |
| | | | | | Hardware shutdown state when LPCPD signal is low |
| | | | | | [Setting condition] |

• Writing 1 after reading SDWNE = 0

R/W

| Bit | Bit Name | Initial Value | Slave | Host | _ Descripti | on |
|-----|----------|---------------|-------|------|----------------|---|
| 2 | PMEE | 0 | R/W | _ | PME outp | ut Enable |
| | | | | | bit in HICI | PME output in combination with the PMEB R1. PME pin output is open-drain, and an ull-up resistor is needed to pull the output |
| | | | | | | PME output function is used, the DDR bit ust not be set to 1. |
| | | | | | PMEE | PMEB |
| | | | | | 0 | x: PME output disabled, other function of pin is enabled |
| | | | | | 1 | 0: PME output enabled, PME pin output goes to 0 level |
| | | | | | 1 | 1: PME output enabled, PME pin output is high-impedance |
| 1 | LSMIE | 0 | R/W | | LSMI outp | out Enable |
| | | | | | bit in HICI | SMI output in combination with the LSMIB R1. LSMI pin output is open-drain, and an ull-up resistor is needed to pull the output |
| | | | | | | LSMI output function is used, the DDR bit lust not be set to 1. |
| | | | | | LSMIE | LSMIB |
| | | | | | 0 | x: LSMI output disabled, other function of pin is enabled |
| | | | | | 1 | 0: LSMI output enabled, LSMI pin output goes to 0 level |
| | | | | | 1 high-impe | 1: LSMI output enabled, LSMI pin output is dance |

| | | | R | /W | | |
|-----|----------|---------------|-------|------|------------|---|
| Bit | Bit Name | Initial Value | Slave | Host | | ion |
| 0 | LSCIE | 0 | R/W | _ | LSCI out | put Enable |
| | | | | | bit in HIC | LSCI output in combination with the LSCIB R1. LSCI pin output is open-drain, and an oull-up resistor is needed to pull the output |
| | | | | | | e LSCI output function is used, the DDR bit must not be set to 1. |
| | | | | | LSCIE | LSCIB |
| | | | | | 0 | x: LSCI output disabled, other function of pin is enabled |
| | | | | | 1 | 0: LSCI output enabled, LSCI pin output goes to 0 level |
| | | | | | 1 | 1: LSCI output enabled, LSCI pin output is |

high-impedance

Legend

X: Don't care

| | | | R | /W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | LPCBSY | 0 | R/W | _ | LPC Busy |
| | | | | | Indicates that the host interface is processing a transfer cycle. |
| | | | | | 0: Host interface is in transfer cycle wait state |
| | | | | | Bus idle, or transfer cycle not subject to processing is in progress |
| | | | | | Cycle type or address indeterminate during transfer cycle |
| | | | | | [Clearing conditions] |
| | | | | | LPC hardware reset or LPC software reset |
| | | | | | LPC hardware shutdown or LPC software shutdown |
| | | | | | Forced termination (abort) of transfer cycle subject to processing |
| | | | | | Normal termination of transfer cycle subject to processing |
| | | | | | 1: Host interface is performing transfer cycle processing |
| | | | | | [Setting condition] |

• Match of cycle type and address

| | | | R/ | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | |
| 6 | CLKREQ | 0 | R | _ | LCLK Request |
| | | | | | Indicates that the host interface's SERIRQ output is requesting a restart of LCLK. |
| | | | | | 0: No LCLK restart request |
| | | | | | [Clearing conditions] |
| | | | | | LPC hardware reset or LPC software reset |
| | | | | | LPC hardware shutdown or LPC software shutdown |
| | | | | | SERIRQ is set to continuous mode |
| | | | | | • There are no further interrupts for transfer to the host in quiet mode |
| | | | | | 1: LCLK restart request issued |
| | | | | | [Setting condition] |
| | | | | | In quiet mode, SERIRQ interrupt output becomes necessary while LCLK is stopped |
| 5 | IRQBSY | 0 | R | | SERIRQ Busy |
| | | | | | Indicates that the host interface's SERIRQ signal is engaged in transfer processing. |
| | | | | | 0: SERIRQ transfer frame wait state |
| | | | | | [Clearing conditions] |
| | | | | | LPC hardware reset or LPC software reset |
| | | | | | LPC hardware shutdown or LPC software shutdown |
| | | | | | End of SERIRQ transfer frame |
| | | | | | 1: SERIRQ transfer processing in progress |

[Setting condition]

Start of SERIRQ transfer frame

| R | Λ | ۸ | 1 |
|---|-----|---|---|
| | , , | , | • |

| Bit | Bit Name | Initial Value | Slave | Host | Description |
|-----|----------|---------------|-------|------|--|
| 4 | LRSTB | 0 | _ | _ | LPC Software Reset Bit |
| | | | | | Resets the host interface. For the scope of initialization by an LPC reset, see section 19.4.4, Host Interface Shutdown Function (LPCPD). |
| | | | | | 0: Normal state |
| | | | | | [Clearing conditions] |
| | | | | | • Writing 0 |
| | | | | | LPC hardware reset |
| | | | | | 1: LPC software reset state |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading LRSTB = 0 |
| 3 | SDWNB | 0 | R/W | | LPC Software Shutdown Bit |
| | | | | | Controls host interface shutdown. For details of the LPC shutdown function, and the scope of initialization by an LPC reset and an LPC shutdown, see section 19.4.4, Host Interface Shutdown Function (LPCPD). |
| | | | | | 0: Normal state |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 |
| | | | | | LPC hardware reset or LPC software reset |
| | | | | | LPC hardware shutdown |
| | | | | | LPC hardware shutdown release |
| | | | | | (rising edge of \overline{LPCPD} signal when SDWNE = 0) 1: LPC software shutdown state |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading SDWNB = 0 |
| 2 | PMEB | 0 | R/W | | PME Output Bit |
| | | | | | Controls PME output in combination with the PMEE bit. For details, refer to description on the PMEE bit in HICR0. |
| 1 | LSMIB | 0 | R/W | _ | LSMI Output Bit |
| | | | | | Controls LSMI output in combination with the LSMIE bit. For details, refer to description on the LSMIE bit in HICR0. |

| | | | R | /W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 0 | LSCIB | 0 | R/W | _ | LSCI output Bit |
| | | | | | Controls LSCI output in combination with the LSCIE bit. For details, refer to description on the LSCIE bit in HICR0. |

19.3.2 Host Interface Control Registers 2 and 3 (HICR2, HICR3)

R/W

Bits 6 to 0 in HICR2 control interrupts from the host interface (LPC) module to the slave processor (this LSI). Bit 7 in HICR2 and HICR3 monitor host interface pin states.

The pin states can be monitored regardless of the host interface operating state or the operating state of the functions that use pin multiplexing.

• HICR2

| | | | - 107 | ** | _ |
|-----|----------|---------------|--------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | GA20 | Undefined | R | _ | GA20 Pin Monitor |
| 6 | LRST | 0 | R/(W)* | _ | LPC Reset Interrupt Flag |
| | | | | | This bit is a flag that generates an ERRI interrupt when an LPC hardware reset occurs. |
| | | | | | 0: [Clearing conditions] |
| | | | | | Writing 0 after reading LRST = 1 |
| | | | | | 1: [Setting condition] |
| | | | | | LRESET pin falling edge detection |
| 5 | SDWN | 0 | R/(W)* | _ | LPC Shutdown Interrupt Flag |
| | | | | | This bit is a flag that generates an ERRI interrupt when an LPC hardware shutdown request is generated. |
| | | | | | 0: [Clearing conditions] |
| | | | | | Writing 0 after reading SDWN = 1 |
| | | | | | LPC hardware reset and LPC software reset |
| | | | | | 1: [Setting condition] |
| | | | | | LPCPD pin falling edge detection |

| Bit | Bit Name | Initial Value | Slave | Host | Description |
|-----|----------|---------------|--------|------|--|
| 4 | ABRT | 0 | R/(W)* | _ | LPC Abort Interrupt Flag |
| | | | | | This bit is a flag that generates an ERRI interrupt when a forced termination (abort) of an LPC transfer cycle occurs. |
| | | | | | 0: [Clearing conditions] |
| | | | | | Writing 0 after reading ABRT = 1 |
| | | | | | LPC hardware reset and LPC software reset |
| | | | | | LPC hardware shutdown and LPC software shutdown |
| | | | | | 1: [Setting condition] |
| | | | | | LFRAME pin falling edge detection during LPC |
| | | | | | transfer cycle |
| 3 | IBFIE3 | 0 | R/W | _ | IDR3 and TWR Receive Completion Interrupt Enable |
| | | | | | Enables or disables IBFI3 interrupt to the slave processor (this LSI). |
| | | | | | Input data register IDR3 and TWR receive completed interrupt requests disabled |
| | | | | | 1: [When TWRIE = 0 in LADR3] |
| | | | | | Input data register (IDR3) receive completed interrupt requests enabled |
| | | | | | [When TWRIE = 1 in LADR3] |
| | | | | | Input data register (IDR3) and TWR receive completed interrupt requests enabled |
| 2 | IBFIE2 | 0 | R/W | _ | IDR2 Receive Completion Interrupt Enable |
| | | | | | Enables or disables IBFI2 interrupt to the slave processor (this LSI). |
| | | | | | Input data register (IDR2) receive completed interrupt requests disabled |
| | | | | | Input data register (IDR2) receive completed interrupt requests enabled |
| 1 | IBFIE1 | 0 | R/W | _ | IDR1 Receive Completion Interrupt Enable |
| | | | | | Enables or disables IBFI1 interrupt to the slave processor (this LSI). |
| | | | | | Input data register (IDR1) receive completed interrupt requests disabled |
| | | | | | Input data register (IDR1) receive completed interrupt requests enabled |
| | | | | | |

| | | | R | /W | |
|-----|----------|---------------|-------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 0 | ERRIE | 0 | R/W | _ | Error Interrupt Enable |
| | | | | | Enables or disables ERRI interrupt to the slave processor (this LSI). |
| | | | | | 0: Error interrupt requests disabled |
| | | | | | 1: Error interrupt requests enabled |

Note:* Only 0 can be written to bits 6 to 4, to clear the flag.

• HICR3

R/W

| Bit | Bit Name | Initial Value | Slave | Host | Description |
|-----|----------|---------------|-------|------|--------------------|
| 7 | LFRAME | Undefined | R | _ | LFRAME Pin Monitor |
| 6 | CLKRUN | Undefined | R | _ | CLKRUN Pin Monitor |
| 5 | SERIRQ | Undefined | R | | SERIRQ Pin Monitor |
| 4 | LRESET | Undefined | R | _ | LRESET Pin Monitor |
| 3 | LPCPD | Undefined | R | | LPCPD Pin Monitor |
| 2 | PME | Undefined | R | _ | PME Pin Monitor |
| 1 | LSMI | Undefined | R | _ | LSMI Pin Monitor |
| 0 | LSCI | Undefined | R | _ | LSCI Pin Monitor |

19.3.3 LPC Channel 3 Address Register (LADR3)

LADR3 comprises two 8-bit readable/writable registers that perform LPC channel-3 host address setting and control the operation of the bidirectional data registers. The contents of the address field in LADR3 must not be changed while channel 3 is operating (while LPC3E is set to 1).

LADR3H

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | Bit 15 | 0 | R/W | Channel 3 Address Bits 15 to 8: |
| 6 | Bit 14 | 0 | R/W | When LPC3E = 1, an I/O address received in an LPC I/O |
| 5 | Bit 13 | 0 | R/W | cycle is compared with the contents of LADR3. When determining an IDR3, ODR3, or STR3 address match, bit 0 |
| 4 | Bit 12 | 0 | R/W | of LADR3 is regarded as 0, and the value of bit 2 is ignored. |
| 3 | Bit 11 | 0 | R/W | When determining a TWR0 to TWR15 address match, bit 4 |
| 2 | Bit 10 | 0 | R/W | of LADR3 is inverted, and the values of bits 3 to 0 are ignored. Register selection according to the bits ignored in |
| 1 | Bit 9 | 0 | R/W | address match determination is as shown in table 19.2. |
| 0 | Bit 8 | 0 | R/W | |

• LADR3L

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | Bit 7 | 0 | R/W | Channel 3 Address Bits 7 to 3 |
| 6 | Bit 6 | 0 | R/W | |
| 5 | Bit 5 | 0 | R/W | |
| 4 | Bit 4 | 0 | R/W | |
| 3 | Bit 3 | 0 | R/W | |
| 2 | _ | 0 | R/W | Reserved |
| | | | | This bit is readable/writable, however, only 0 should be written to this bit. |
| 1 | Bit 1 | 0 | R/W | Channel 3 Address Bit 1 |
| 0 | TWRE | 0 | R/W | Bidirectional Data Register Enable |
| | | | | Enables or disables bidirectional data register operation. |
| | | | | 0: TWR operation is disabled |
| | | | | TWR-related I/O address match determination is halted |
| | | | | 1: TWR operation is enabled |

Table 19.2 Register Selection

| | | I/O Addr | ess | | Transfer | | |
|-------|-------|----------|-------|-------|-----------|--|--|
| Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Cycle | Host Register Selection | |
| Bit 4 | Bit 3 | 0 | Bit 1 | 0 | I/O write | IDR3 write, $C/\overline{D}3 \leftarrow 0$ | |
| Bit 4 | Bit 3 | 1 | Bit 1 | 0 | I/O write | IDR3 write, $C/\overline{D}3 \leftarrow 1$ | |
| Bit 4 | Bit 3 | 0 | Bit 1 | 0 | I/O read | ODR3 read | |
| Bit 4 | Bit 3 | 1 | Bit 1 | 0 | I/O read | STR3 read | |
| Bit 4 | 0 | 0 | 0 | 0 | I/O write | TWR0MW write | |
| Bit 4 | 0 | 0 | 0 | 1 | I/O write | TWR1 to TWR15 write | |
| | | | | | | | |
| | 1 | 1 | 1 | 1 | | | |
| Bit 4 | 0 | 0 | 0 | 0 | I/O read | TWR0SW read | |
| Bit 4 | 0 | 0 | 0 | 1 | I/O read | TWR1 to TWR15 read | |
| | | | | | | | |
| | 1 | 1 | 1 | 1 | | | |

19.3.4 Input Data Registers 1 to 3 (IDR1 to IDR3)

The IDR registers are 8-bit read-only registers for the slave processor (this LSI), and 8-bit write-only registers for the host processor. The registers selected from the host according to the I/O address are shown in the following table. For information on IDR3 selection, see section 19.3.3, LPC Channel 3 Address Register (LADR3). Data transferred in an LPC I/O write cycle is written to the selected register. The state of bit 2 of the I/O address is latched into the C/\overline{D} bit in STR, to indicate whether the written information is a command or data. The initial values of IDR1 to IDR3 are undefined.

| . <u> </u> | I/O Ad | dress | | | Transfer | |
|----------------|--------|-------|-------|-------|-----------|--|
| Bits 15 to 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Cycle | Host Register Selection |
| 0000 0000 0110 | 0 | 0 | 0 | 0 | I/O write | IDR1 write, $C/\overline{D}1 \leftarrow 0$ |
| 0000 0000 0110 | 0 | 1 | 0 | 0 | I/O write | IDR1 write, $C/\overline{D}1 \leftarrow 1$ |
| 0000 0000 0110 | 0 | 0 | 1 | 0 | I/O write | IDR2 write, $C/\overline{D}2 \leftarrow 0$ |
| 0000 0000 0110 | 0 | 1 | 1 | 0 | I/O write | IDR2 write, $C/\overline{D}2 \leftarrow 1$ |

19.3.5 Output Data Registers 1 to 3 (ODR1 to ODR3)

The ODR registers are 8-bit readable/writable registers for the slave processor (this LSI), and 8-bit read-only registers for the host processor. The registers selected from the host according to the I/O address are shown in the following table. For information on ODR3 selection, see section 19.3.3, LPC Channel 3 Address Register (LADR3). In an LPC I/O read cycle, the data in the selected register is transferred to the host. The initial values of ODR1 to ODR3 are undefined.

| | I/O Ad | dress | Transfer | | | |
|----------------|--------|-------|----------|-------|----------|-------------------------|
| Bits 15 to 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Cycle | Host Register Selection |
| 0000 0000 0110 | 0 | 0 | 0 | 0 | I/O read | ODR1 read |
| 0000 0000 0110 | 0 | 0 | 1 | 0 | I/O read | ODR2 read |

19.3.6 Bidirectional Data Registers 0 to 15 (TWR0 to TWR15)

The TWR registers are sixteen 8-bit readable/writable registers to both the slave processor (this LSI) and the host processor. In TWR0, however, two registers (TWR0MW and TWR0SW) are allocated to the same address for both the host address and the slave address. TWR0MW is a write-only register for the host processor, and a read-only register for the slave processor, while TWR0SW is a write-only register for the slave processor and a read-only register for the host processor. When the host and slave processors begin a write, after the respective TWR0 registers have been written to, access right arbitration for simultaneous access is performed by checking the status flags to see if those writes were valid. For the registers selected from the host according to the I/O address, see section 19.3.3, LPC Channel 3 Address Register (LADR3).

Data transferred in an LPC I/O write cycle is written to the selected register; in an LPC I/O read cycle, the data in the selected register is transferred to the host. The initial values of TWR0 to TWR15 are undefined.

19.3.7 Status Registers 1 to 3 (STR1 to STR3)

The STR registers are 8-bit registers that indicate status information during host interface processing. Bits 3, 1, and 0 of STR1 to STR3, and bits 7 to 4 of STR3, are read-only bits for both the host processor and the slave processor (this LSI). However, only 0 can be written to bit 0 of STR1 to STR3 and bits 6 and 4 of STR3, from the slave processor (this LSI), in order to clear the flags to 0. The registers selected from the host processor according to the I/O address are shown in the following table. For information on STR3 selection, see section 19.3.3, LPC Channel 3 Address Register (LADR3). In an LPC I/O read cycle, the data in the selected register is transferred to the host processor. The initial values of STR1 to STR3 are H'00.

| | I/O Ad | dress | Transfer | | | |
|----------------|--------|-------|----------|-------|----------|--------------------------------|
| Bits 15 to 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Cycle | Host Register Selection |
| 0000 0000 0110 | 0 | 1 | 0 | 0 | I/O read | STR1 read |
| 0000 0000 0110 | 0 | 1 | 1 | 0 | I/O read | STR2 read |

| R | Λ | N |
|---|-----|---|
| | , , | |

| Bit | Bit Name | Initial Value | Slave | Host | Description |
|-----|----------|---------------|--------|------|---|
| 7 | DBU17 | 0 | R/W | R | Defined by User |
| 6 | DBU16 | 0 | R/W | R | The user can use these bits as necessary. |
| 5 | DBU15 | 0 | R/W | R | |
| 4 | DBU14 | 0 | R/W | R | |
| 3 | C/D1 | 0 | R | R | Command/Data |
| | | | | | When the host processor writes to an IDR register, bit 2 of the I/O address is written into this bit to indicate whether IDR contains data or a command. |
| | | | | | 0: Contents of data register (IDR) are data |
| | | | | | 1: Contents of data register (IDR) are a command |
| 2 | DBU12 | 0 | R/W | R | Defined by User |
| | | | | | The user can use this bit as necessary. |
| 1 | IBF1 | 0 | R | R | Input Buffer Full |
| | | | | | Set to 1 when the host processor writes to IDR. This bit is an internal interrupt source to the slave processor (this LSI). IBF is cleared to 0 when the slave processor reads IDR. |
| | | | | | The IBF1 flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 19.3. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads IDR |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to IDR using I/O write cycle |
| 0 | OBF1 | 0 | R/(W)* | R | Output Buffer Full |
| | | | | | Set to 1 when the slave processor (this LSI) writes to ODR. Cleared to 0 when the host processor reads ODR. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the host processor reads ODR using I/O read cycle, or the slave processor writes 0 to the OBF bit |
| | | | | | 1: [Setting condition] |
| | | | | | When the slave processor writes to ODR |

Note:* Only 0 can be written to clear the flag.

| | | | | ** | _ |
|-----|----------|---------------|--------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | DBU27 | 0 | R/W | R | Defined by User |
| 6 | DBU26 | 0 | R/W | R | The user can use these bits as necessary. |
| 5 | DBU25 | 0 | R/W | R | |
| 4 | DBU24 | 0 | R/W | R | |
| 3 | C/D2 | 0 | R | R | Command/Data |
| | | | | | When the host processor writes to an IDR register, bit 2 of the I/O address is written into this bit to indicate whether IDR contains data or a command. |
| | | | | | 0: Contents of data register (IDR) are data |
| | | | | | 1: Contents of data register (IDR) are a command |
| 2 | DBU22 | 0 | R/W | R | Defined by User |
| | | | | | The user can use this bit as necessary. |
| 1 | IBF2 | 0 | R | R | Input Buffer Full |
| | | | | | Set to 1 when the host processor writes to IDR. This bit is an internal interrupt source to the slave processor (this LSI). IBF is cleared to 0 when the slave processor reads IDR. |
| | | | | | The IBF1 flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 19.3. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads IDR |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to IDR using I/O write cycle |
| 0 | OBF2 | 0 | R/(W)* | R | Output Buffer Full |
| | | | | | Set to 1 when the slave processor (this LSI) writes to ODR. Cleared to 0 when the host processor reads ODR. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the host processor reads ODR using I/O read cycle, or the slave processor writes 0 to the OBF bit |
| | | | | | 1: [Setting condition] |
| | | | | | When the slave processor writes to ODR |
| | | | | | |

Note:* Only 0 can be written to clear the flag.

• STR3 (TWRE = 1 or SELSTR3 = 0)

R/W

| Bit | Bit Name | Initial Value | Slave | Host | _ Description |
|-----|----------|---------------|--------|------|---|
| 7 | IBF3B | 0 | R | R | Bidirectional Data Register Input Buffer Full |
| | | | | | Set to 1 when the host processor writes to TWR15. This is an internal interrupt source to the slave processor (this LSI). IBF3B is cleared to 0 when the slave processor reads TWR15. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads TWR15 |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to TWR15 using I/O write cycle |
| 6 | OBF3B | 0 | R/(W)* | R | Bidirectional Data Register Output Buffer Full |
| | | | | | Set to 1 when the slave processor (this LSI) writes to TWR15. OBF3B is cleared to 0 when the host processor reads TWR15. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the host processor reads TWR15 using I/O read cycle, or the slave processor writes 0 to the OBF3B bit |
| | | | | | 1: [Setting condition] |
| | | | | | When the slave processor writes to TWR15 |
| 5 | MWMF | 0 | R | R | Master Write Mode Flag |
| | | | | | Set to 1 when the host processor writes to TWR0. MWMF is cleared to 0 when the slave processor (this LSI) reads TWR15. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads TWR15 |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to TWR0 using I/O write cycle while SWMF = 0 |

R/W Bit Bit Name Initial Value Slave Host Description

| Bit | Bit Name | Initial Value | Siave | HOST | Description |
|-----|----------|---------------|--------|------|---|
| 4 | SWMF | 0 | R/(W)* | R | Slave Write Mode Flag |
| | | | | | Set to 1 when the slave processor (this LSI) writes to TWR0. In the event of simultaneous writes by the master and the slave, the master write has priority. SWMF is cleared to 0 when the host reads TWR15 |
| | | | | | 0: [Clearing condition] |
| | | | | | When the host processor reads TWR15 using I/O read cycle, or the slave processor writes 0 to the SWMF bit |
| | | | | | 1: [Setting condition] |
| | | | | | When the slave processor writes to TWR0 while MWMF = 0 |
| 3 | C/D3 | 0 | R | R | Command/Data |
| | | | | | When the host processor writes to an IDR register, bit 2 of the I/O address is written into this bit to indicate whether IDR contains data or a command. |
| | | | | | 0: Contents of data register (IDR) are data |
| | | | | | 1: Contents of data register (IDR) are a command |
| 2 | DBU32 | 0 | R/W | R | Defined by User |
| | | | | | The user can use this bit as necessary. |
| 1 | IBF3A | 0 | R | R | Input Buffer Full |
| | | | | | Set to 1 when the host processor writes to IDR. This bit is an internal interrupt source to the slave processor (this LSI). IBF is cleared to 0 when the slave processor reads IDR. |
| | | | | | The IBF1 flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 19.3. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads IDR |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to IDR using I/O write cycle |

| | | | R/ | W | |
|-----|----------|---------------|--------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 0 | OBF3A | 0 | R/(W)* | R | Output Buffer Full |
| | | | | | Set to 1 when the slave processor (this LSI) writes to ODR. OBF3A is cleared to 0 when the host processor reads ODR. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the host processor reads ODR using I/O read cycle, or the slave processor writes 0 to the OBF bit |
| | | | | | 1: [Setting condition] |
| | | | | | When the slave processor writes to ODR |

Note:* Only 0 can be written to clear the flag.

• STR3 (TWRE = 0 and SELSTR3 = 1)

| | | | R/ | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | DBU37 | 0 | R/W | R | Defined by User |
| 6 | DBU36 | 0 | R/W | R | The user can use these bits as necessary. |
| 5 | DBU35 | 0 | R/W | R | |
| 4 | DBU34 | 0 | R/W | R | |
| 3 | C/D3 | 0 | R | R | Command/Data |
| | | | | | When the host processor writes to an IDR register, bit 2 of the I/O address is written into this bit to indicate whether IDR contains data or a command. |
| | | | | | 0: Contents of data register (IDR) are data |
| | | | | | 1: Contents of data register (IDR) are a command |
| 2 | DBU32 | 0 | R/W | R | Defined by User |
| | | | | | The user can use this bit as necessary. |

| | R/W | | | W | |
|-----|----------|---------------|--------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 1 | IBF3A | 0 | R | R | Input Buffer Full |
| | | | | | Set to 1 when the host processor writes to IDR. This bit is an internal interrupt source to the slave processor (this LSI). IBF is cleared to 0 when the slave processor reads IDR. |
| | | | | | The IBF1 flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 19.3. |
| | | | | | 0: [Clearing condition] |
| | | | | | When the slave processor reads IDR |
| | | | | | 1: [Setting condition] |
| | | | | | When the host processor writes to IDR using I/O write cycle |
| 0 | OBF3A | 0 | R/(W)* | R | Output Buffer Full |
| | | | | | Set to 1 when the slave processor (this LSI) writes to ODR. OBF3A is cleared to 0 when the host processor reads ODR. |
| | | | | | 0: [Clearing condition] |

1: [Setting condition]

When the host processor reads ODR using I/O read cycle, or the slave processor writes 0 to the OBF bit

When the slave processor writes to ODR

Note:* Only 0 can be written to clear the flag.

19.3.8 SERIRQ Control Registers 0 and 1 (SIRQCR0, SIRQCR1)

The SIRQCR registers contain status bits that indicate the SERIRQ operating mode and bits that specify SERIRQ interrupt sources.

• SIRQCR0

| | | | R/ | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | Q/C | 0 | R | | Quiet/Continuous Mode Flag |
| | | | | | Indicates the mode specified by the host at the end of an SERIRQ transfer cycle (stop frame). |
| | | | | | 0: Continuous mode |
| | | | | | [Clearing conditions] |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Specification by SERIRQ transfer cycle stop frame |
| | | | | | 1: Quiet mode |
| | | | | | [Setting condition] |
| | | | | | Specification by SERIRQ transfer cycle stop frame. |
| 6 | SELREQ | 0 | R/W | _ | Start Frame Initiation Request Select |
| | | | | | Selects whether start frame initiation is requested when one or more interrupt requests are cleared, or when all interrupt requests are cleared, in quiet mode. |
| | | | | | 0: Start frame initiation is requested when all interrupt requests are cleared in quiet mode. |
| | | | | | 1: Start frame initiation is requested when one or more interrupt requests are cleared in quiet mode. |
| 5 | IEDIR | 0 | R/W | _ | Interrupt Enable Direct Mode |
| | | | | | Specifies whether LPC channel 2 and channel 3 SERIRQ interrupt source (SMI, IRQ6, IRQ9 to IRQ11) generation is conditional upon OBF, or is controlled only by the host interrupt enable bit. |
| | | | | | 0: Host interrupt is requested when host interrupt enable bit and corresponding OBF are both set to 1 |
| · | | | | | 1: Host interrupt is requested when host interrupt enable bit is set to 1 |

| | | | R | w | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | |
| 4 | SMIE3B | 0 | R/W | _ | Host SMI Interrupt Enable 3B |
| | | | | | Enables or disables a host SMI interrupt request when OBF3B is set by a TWR15 write. |
| | | | | | 0: Host SMI interrupt request by OBF3B and SMIE3B is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to SMIE3B |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF3B to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host SMI interrupt request by setting OBF3B to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host SMI interrupt is requested |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading SMIE3B = 0 |
| 3 | SMIE3A | 0 | R/W | | Host SMI Interrupt Enable 3A |
| | | | | | Enables or disables a host SMI interrupt request when OBF3A is set by an ODR3 write. |
| | | | | | 0: Host SMI interrupt request by OBF3A and SMIE3A is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to SMIE3A |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF3A to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host SMI interrupt request by setting OBF3A to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host SMI interrupt is requested |
| | | | | | [Setting condition] |

• Writing 1 after reading SMIE3A = 0

| | | | R/ | w | |
|-----|----------|---------------|-------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | |
| 2 | SMIE2 | 0 | R/W | _ | Host SMI Interrupt Enable 2 |
| | | | | | Enables or disables a host SMI interrupt request when OBF2 is set by an ODR2 write. |
| | | | | | 0: Host SMI interrupt request by OBF2 and SMIE2 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to SMIE2 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF2 to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host SMI interrupt request by setting OBF2 to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host SMI interrupt is requested |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading SMIE2 = 0 |
| 1 | IRQ12E1 | 0 | R/W | | Host IRQ12 Interrupt Enable 1 |
| | | | | | Enables or disables a host IRQ12 interrupt request when OBF1 is set by an ODR1 write. |
| | | | | | 0: Host IRQ12 interrupt request by OBF1 and IRQ12E1 is disabled |
| | | | | | [Clearing conditions] |

Writing 0 to IRQ12E1

Clearing OBF1 to 0

is enabled

[Setting condition]

LPC hardware reset, LPC software reset

Writing 1 after reading IRQ12E1 = 0

1: Host IRQ12 interrupt request by setting OBF1 to 1

| | | | R | /W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 0 | IRQ1E1 | 0 | R/W | _ | Host IRQ1 Interrupt Enable 1 |
| | | | | | Enables or disables a host IRQ1 interrupt request when OBF1 is set by an ODR1 write. |
| | | | | | 0: Host IRQ1 interrupt request by OBF1 and IRQ1E1 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ1E1 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF1 to 0 |
| | | | | | 1: Host IRQ1 interrupt request by setting OBF1 to 1 is enabled |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ1E1 = 0 |

• SIRQCR1

| | | | R | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 7 | IRQ11E3 | 0 | R/W | _ | Host IRQ11 Interrupt Enable 3 |
| | | | | | Enables or disables a host IRQ11 interrupt request when OBF3A is set by an ODR3 write. |
| | | | | | 0: Host IRQ11 interrupt request by OBF3A and IRQ11E3 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ11E3 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF3A to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ11 interrupt request by setting OBF3A to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ11 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ11E3 = 0 |

| | | | R/ | W | |
|-----|----------|---------------|-------|------|--|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 6 | IRQ10E3 | 0 | R/W | _ | Host IRQ10 Interrupt Enable 3 |
| | | | | | Enables or disables a host IRQ10 interrupt request when OBF3A is set by an ODR3 write. |
| | | | | | 0: Host IRQ10 interrupt request by OBF3A and IRQ10E3 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ10E3 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OB3FA to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ10 interrupt request by setting OBF3A to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ10 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ10E3 = 0 |
| 5 | IRQ9E3 | 0 | R/W | _ | Host IRQ9 Interrupt Enable 3 |
| | | | | | Enables or disables a host IRQ9 interrupt request when OBF3A is set by an ODR3 write. |
| | | | | | 0: Host IRQ9 interrupt request by OBF3A and IRQ9E3 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ9E3 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF3A to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ9 interrupt request by setting OBF3A to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ9 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ9E3 = 0 |

| | | | R/ | w | |
|-----|----------|---------------|-------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | |
| 4 | IRQ6E3 | 0 | R/W | | Host IRQ6 Interrupt Enable 3 |
| | | | | | Enables or disables a host IRQ6 interrupt request when OBF3A is set by an ODR3 write. |
| | | | | | 0: Host IRQ6 interrupt request by OBF3A and IRQ6E3 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ6E3 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF3A to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ6 interrupt request by setting OBF3A to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ6 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ6E3 = 0 |
| 3 | IRQ11E2 | 0 | R/W | _ | Host IRQ11 Interrupt Enable 2 |
| | | | | | Enables or disables a host IRQ11 interrupt request when OBF2 is set by an ODR2 write. |
| | | | | | 0: Host IRQ11 interrupt request by OBF2 and IRQ11E2 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ11E2 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF2 to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ11 interrupt request by setting OBF2 to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ11 interrupt is requested. |
| | | | | | [Setting condition] |

Writing 1 after reading IRQ11E2 = 0

| | | | R/ | W | |
|-----|----------|---------------|-------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | Description |
| 2 | IRQ10E2 | 0 | R/W | _ | Host IRQ10 Interrupt Enable 2 |
| | | | | | Enables or disables a host IRQ10 interrupt request when OBF2 is set by an ODR2 write. |
| | | | | | 0: Host IRQ10 interrupt request by OBF2 and IRQ10E2 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ10E2 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF2 to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ10 interrupt request by setting OBF2 to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ10 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ10E2 = 0 |
| 1 | IRQ9E2 | 0 | R/W | _ | Host IRQ9 Interrupt Enable 2 |
| | | | | | Enables or disables a host IRQ9 interrupt request when OBF2 is set by an ODR2 write. |
| | | | | | 0: Host IRQ9 interrupt request by OBF2 and IRQ9E2 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ9E2 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF2 to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ9 interrupt request by setting OBF2 to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ9 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | Writing 1 after reading IRQ9E2 = 0 |

| R/W | |
|-----|--|
|-----|--|

| Bit | Bit Name | Initial Value | Slave | Host | Description |
|-----|----------|---------------|-------|------|--|
| 0 | IRQ6E2 | 0 | R/W | _ | Host IRQ6 Interrupt Enable 2 |
| | | | | | Enables or disables a host IRQ6 interrupt request when OBF2 is set by an ODR2 write. |
| | | | | | 0: Host IRQ6 interrupt request by OBF2 and IRQ6E2 is disabled |
| | | | | | [Clearing conditions] |
| | | | | | Writing 0 to IRQ6E2 |
| | | | | | LPC hardware reset, LPC software reset |
| | | | | | Clearing OBF2 to 0 (when IEDIR = 0) |
| | | | | | 1: [When IEDIR = 0] |
| | | | | | Host IRQ6 interrupt request by setting OBF2 to 1 is enabled |
| | | | | | [When IEDIR = 1] |
| | | | | | Host IRQ6 interrupt is requested. |
| | | | | | [Setting condition] |
| | | | | | • Writing 1 after reading IRQ6E2 = 0 |

19.3.9 Host Interface Select Register (HISEL)

HISEL selects the function of bits 7 to 4 in STR3 and specifies the output of the host interrupt request signal of each frame.

| | | | R | /W | |
|-----|----------|---------------|-------|------|---|
| Bit | Bit Name | Initial Value | Slave | Host | |
| 7 | SELSTR3 | 0 | W | | STR3 Register Function Select 3 |
| | | | | | Selects the function of bits 7 to 4 in STR3 in combination with the TWRE bit in LADR3L. See description on STR3 in section 19.3.7, Status Registers 1 to 3 (STR1 to STR3), for details. |
| | | | | | 0: Bits 7 to 4 in STR3 are status bits of the host interface. |
| | | | | | 1: [When TWRE = 1] |
| | | | | | Bits 7 to 4 in STR3 are status bits of the host interface. |
| | | | | | [When TWRE = 0] |
| | | | | | Bits 7 to 4 in STR3 are user bits. |
| 6 | SELIRQ11 | 0 | W | _ | SERIRQ Output Select |
| 5 | SELIRQ10 | 0 | W | _ | Selects the pin output status of host interrupt |
| 4 | SELIRQ9 | | W | _ | requests (HIRQ11, HIRQ10, HIRQ9, HIRQ6, SMI, HIRQ12, and HIRQ1) of the LPC. |
| 3 | SELIRQ6 | 0 | W | _ | 0: [When host interrupt request is cleared] |
| 2 | SELSMI | 0 | W | _ | SERIRQ pin output is in the high-impedance |
| 1 | SELIRQ12 | 11 | W | | state. |
| 0 | SELIRQ1 | 1 | W | | [When host interrupt request is set] |
| | | | | | SERIRQ pin output is 0. |
| | | | | | 1: [When host interrupt request is cleared] |
| | | | | | SERIRQ pin output is 0. |
| | | | | | [When host interrupt request is set] |
| | | | | | SERIRQ pin output is in the high-impedance state. |

19.4 Operation

19.4.1 Host Interface Activation

The host interface is activated by setting one of bits LPC3E to LPC1E in HICR0 to 1 in single-chip mode. When the host interface is activated, the related I/O ports (ports 37 to 30, ports 83 and 82) function as dedicated host interface input/output pins. In addition, setting the FGA20E, PMEE, LSMIE, and LSCIE bits to 1 adds the related I/O ports (ports 81 and 80, ports B0 and B1) to the host interface's input/output pins.

Use the following procedure to activate the host interface after a reset release.

- 1. Read the signal line status and confirm that the LPC module can be connected. Also check that the LPC module is initialized internally.
- 2. When using channel 3, set LADR3 to determine the channel 3 I/O address and whether bidirectional data registers are to be used.
- 3. Set the enable bit (LPC3E to LPC1E) for the channel to be used.
- 4. Set the enable bits (GA20E, PMEE, LSMIE, and LSCIE) for the additional functions to be used.
- 5. Set the selection bits for other functions (SDWNE, IEDIR).
- 6. As a precaution, clear the interrupt flags (LRST, SDWN, ABRT, OBF). Read IDR or TWR15 to clear IBF.
- 7. Set interrupt enable bits (IBFIE3 to IBFIE1, ERRIE) as necessary.

19.4.2 **LPC I/O Cycles**

There are ten kinds of LPC transfer cycle: memory read, memory write, I/O read, I/O write, DMA read, DMA write, bus master memory read, bus master memory write, bus master I/O read, and bus master I/O write. Of these, the chip's LPC supports only I/O read and I/O write cycles.

An LPC transfer cycle is started when the \overline{LFRAME} signal goes low in the bus idle state. If the \overline{LFRAME} signal goes low when the bus is not idle, this means that a forced termination (abort) of the LPC transfer cycle has been requested.

In an I/O read cycle or I/O write cycle, transfer is carried out using LAD3 to LAD0 in the following order, in synchronization with LCLK. The host can be made to wait by sending back a value other than B'0000 in the slave's synchronization return cycle, but with the chip's LPC a value of B'0000 is always returned.

If the received address matches the host address in an LPC register (IDR, ODR, STR, TWR), the host interface enters the busy state; it returns to the idle state by output of a state count 12 turnaround. Register and flag changes are made at this timing, so in the event of a transfer cycle forced termination (abort) before state #12, registers and flags are not changed.

| | I/O Read Cycle | | | I/O Write Cycle | | |
|----------------|--------------------------|-----------------|-------------------|--------------------------|-----------------|-------------------|
| State Count | Contents | Drive Source | Value (3 to 0) | Contents | Drive Source | Value (3 to 0) |
| 1 | Start | Host | 0000 | Start | Host | 0000 |
| 2 | Cycle type/direction | Host | 0000 | Cycle type/direction | Host | 0010 |
| 3 | Address 1 | Host | Bits 15 to 12 | Address 1 | Host | Bits 15 to 12 |
| 4 | Address 2 | Host | Bits 11 to 8 | Address 2 | Host | Bits 11 to 8 |
| 5 | Address 3 | Host | Bits 7 to 4 | Address 3 | Host | Bits 7 to 4 |
| 6 | Address 4 | Host | Bits 3 to 0 | Address 4 | Host | Bits 3 to 0 |
| 7 | Turnaround (recovery) | Host | 1111 | Data 1 | Host | Bits 3 to 0 |
| 8 | Turnaround | None | ZZZZ | Data 2 | Host | Bits 7 to 4 |
| 9 | Synchronization | Slave | 0000 | Turnaround (recovery) | Host | 1111 |
| 10 | Data 1 | Slave | Bits 3 to 0 | Turnaround | None | ZZZZ |
| 11 | Data 2 | Slave | Bits 7 to 4 | Synchronization | Slave | 0000 |
| 12 | Turnaround (recovery) | Slave | 1111 | Turnaround (recovery) | Slave | 1111 |
| 13 | Turnaround | None | ZZZZ | Turnaround | None | ZZZZ |

The timing of the LFRAME, LCLK, and LAD signals is shown in figures 19.2 and 19.3.

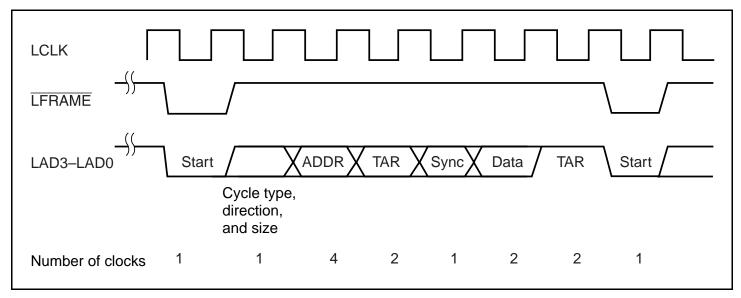


Figure 19.2 Typical LFRAME Timing

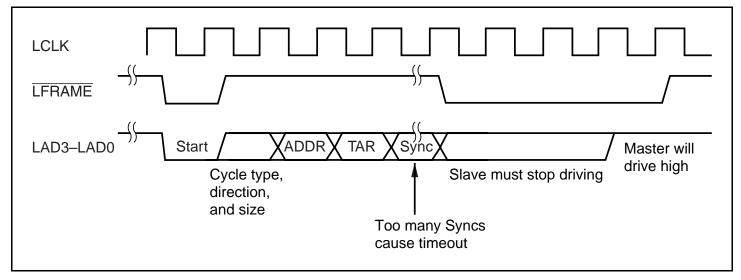


Figure 19.3 Abort Mechanism

19.4.3 A20 Gate

The A20 gate signal can mask address A20 to emulate an addressing mode used by personal computers with an 8086*-family CPU. A regular-speed A20 gate signal can be output under firmware control. The fast A20 gate function that is speeded up by hardware is enabled by setting the FGA20E bit to 1 in HICR0.

Note: An Intel microprocessor

Regular A20 Gate Operation: Output of the A20 gate signal can be controlled by an H'D1 command followed by data. When the slave processor (this LSI) receives data, it normally uses an interrupt routine activated by the IBF1 interrupt to read IDR1. At this time, firmware copies bit 1 of data following an H'D1 command and outputs it at the gate A20 pin.

Fast A20 Gate Operation: The internal state of GA20 output is initialized to 1 when FGA20E = 0. When the FGA20E bit is set to 1, P81/GA20 is used for output of a fast A20 gate signal. The state of the P81/GA20 pin can be monitored by reading the GA20 bit in HICR2.

The initial output from this pin will be a logic 1, which is the initial value. Afterward, the host processor can manipulate the output from this pin by sending commands and data. This function is only available via the IDR1 register. The host interface decodes commands input from the host. When an H'D1 host command is detected, bit 1 of the data following the host command is output from the GA20 output pin. This operation does not depend on firmware or interrupts, and is faster than the regular processing using interrupts. Table 19.3 shows the conditions that set and clear GA20 (P81). Figure 19.4 shows the GA20 output in flowchart form. Table 19.4 indicates the GA20 output signal values.

Table 19.3 GA20 (P81) Set/Clear Timing

| Pin Name | Setting Condition | Clearing Condition |
|------------|---|---|
| GA20 (P81) | When bit 1 of the data that follows an H'D1 host command is 1 | When bit 1 of the data that follows an H'D1 host command is 0 |

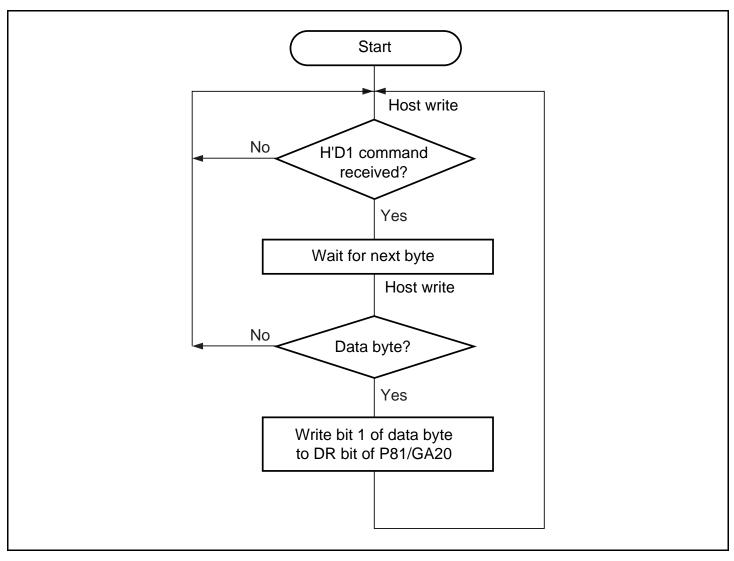


Figure 19.4 GA20 Output

Table 19.4 Fast A20 Gate Output Signals

| HA0 | Data/Command | Internal CPU Interrupt Flag (IBF) | GA20 (P81) | Remarks |
|-----|----------------------------------|---|---------------|------------------------|
| 1 | H'D1 command | 0 | Q | Turn-on sequence |
| 0 | 1 data* ¹ | 0 | 1 | |
| 1 | H'FF command | 0 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence |
| 0 | 0 data* ² | 0 | 0 | |
| 1 | H'FF command | 0 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Turn-on sequence |
| 0 | 1 data* ¹ | 0 | 1 | (abbreviated form) |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (1) | |
| 1 | H'D1 command | 0 | Q | Turn-off sequence |
| 0 | 0 data* ² | 0 | 0 | (abbreviated form) |
| 1/0 | Command other than H'FF and H'D1 | 1 | Q (0) | |
| 1 | H'D1 command | 0 | Q | Cancelled sequence |
| 1 | Command other than H'D1 | 1 | Q | |
| 1 | H'D1 command | 0 | Q | Retriggered sequence |
| 1 | H'D1 command | 0 | Q | |
| 1 | H'D1 command | 0 | Q | Consecutively executed |
| 0 | Any data | 0 | 1/0 | sequences |
| 1 | H'D1 command | 0 | Q (1/0) | |

Notes: 1. Arbitrary data with bit 1 set to 1.

2. Arbitrary data with bit 1 cleared to 0.

RENESAS

19.4.4 Host Interface Shutdown Function (LPCPD)

The host interface can be placed in the shutdown state according to the state of the \overline{LPCPD} pin. There are two kinds of host interface shutdown state: LPC hardware shutdown and LPC software shutdown. The LPC hardware shutdown state is controlled by the \overline{LPCPD} pin, while the software shutdown state is controlled by the SDWNB bit. In both states, the host interface enters the reset state by itself, and is no longer affected by external signals other than the \overline{LRESET} and \overline{LPCPD} signals.

Placing the slave processor in sleep mode or software standby mode is effective in reducing current dissipation in the shutdown state. If software standby mode is set, some means must be provided for exiting software standby mode before clearing the shutdown state with the LPCPD signal.

If the SDWNE bit has been set to 1 beforehand, the LPC hardware shutdown state is entered at the same time as the \overline{LPCPD} signal falls, and prior preparation is not possible. If the LPC software shutdown state is set by means of the SDWNB bit, on the other hand, the LPC software shutdown state cannot be cleared at the same time as the rise of the \overline{LPCPD} signal. Taking these points into consideration, the following operating procedure uses a combination of LPC software shutdown and LPC hardware shutdown.

- 1. Clear the SDWNE bit to 0.
- 2. Set the ERRIE bit to 1 and wait for an interrupt by the SDWN flag.
- 3. When an ERRI interrupt is generated by the SDWN flag, check the host interface internal status flags and perform any necessary processing.
- 4. Set the SDWNB bit to 1 to set LPC software standby mode.
- 5. Set the SDWNE bit to 1 and make a transition to LPC hardware standby mode. The SDWNB bit is cleared automatically.
- 6. Check the state of the \overline{LPCPD} signal to make sure that the \overline{LPCPD} signal has not risen during steps 3 to 5. If the signal has risen, clear SDWNE to 0 to return to the state in step 1.
- 7. Place the slave processor in sleep mode or software standby mode as necessary.
- 8. If software standby mode has been set, exit software standby mode by some means independent of the LPC.
- 9. When a rising edge is detected in the LPCPD signal, the SDWNE bit is automatically cleared to 0. If the slave processor has been placed in sleep mode, the mode is exited by means of LRESET signal input, on completion of the LPC transfer cycle, or by some other means.

Table 19.5 shows the scope of the host interface pin shutdown.

Table 19.5 Scope of Host Interface Pin Shutdown

| Abbreviation | Port | Scope of Shutdown | I/O | Notes |
|--------------|---------|----------------------|-------|---------------------------------------|
| LAD3 to LAD0 | P33-P30 | 0 | I/O | Hi-Z |
| LFRAME | P34 | 0 | Input | Hi-Z |
| LRESET | P35 | X | Input | LPC hardware reset function is active |
| LCLK | P36 | 0 | Input | Hi-Z |
| SERIRQ | P37 | 0 | I/O | Hi-Z |
| LSCI | PB1 | Δ | I/O | Hi-Z, only when LSCIE = 1 |
| LSMI | PB0 | Δ | I/O | Hi-Z, only when LSMIE = 1 |
| PME | P80 | Δ | I/O | Hi-Z, only when PMEE = 1 |
| GA20 | P81 | Δ | I/O | Hi-Z, only when FGA20E = 1 |
| CLKRUN | P82 | 0 | I/O | Hi-Z |
| LPCPD | P83 | × | Input | Needed to clear shutdown state |

Legend

- O: Pin that is shutdown by the shutdown function
- Δ: Pin that is shutdown only when the LPC function is selected by register setting
- x: Pin that is not shutdown

In the LPC shutdown state, the LPC's internal state and some register bits are initialized. The order of priority of LPC shutdown and reset states is as follows.

- 1. System reset (reset by STBY or RES pin input, or WDT0 overflow)
 - All register bits, including bits LPC3E to LPC1E, are initialized.
- 2. LPC hardware reset (reset by \overline{LRESET} pin input)
 - LRSTB, SDWNE, and SDWNB bits are cleared to 0.
- 3. LPC software reset (reset by LRSTB)
 - SDWNE and SDWNB bits are cleared to 0.
- 4. LPC hardware shutdown
 - SDWNB bit is cleared to 0.
- 5. LPC software shutdown

The scope of the initialization in each mode is shown in table 19.6.

 Table 19.6
 Scope of Initialization in Each Host Interface Mode

| Items Initialized | System Reset | LPC Reset | LPC Shutdown |
|---|----------------------|--------------------|---------------------|
| LPC transfer cycle sequencer (internal state), LPCBSY and ABRT flags | Initialized | Initialized | Initialized |
| SERIRQ transfer cycle sequencer (internal state), CLKREQ and IRQBSY flags | Initialized | Initialized | Initialized |
| Host interface flags (IBF1, IBF2, IBF3A, IBF3B, MWMF, C/\overline{D}1, C/\overline{D}2, C/\overline{D}3, OBF1, OBF2, OBF3A, OBF3B, SWMF, DBU), GA20 (internal state) | Initialized | Initialized | Retained |
| Host interrupt enable bits (IRQ1E1, IRQ12E1, SMIE2, IRQ6E2, IRQ9E2 to IRQ11E2, SMIE3B, SMIE3A, IRQ6E3, IRQ9E3 to IRQ11E3), Q/C flag, SELREQ bit | Initialized | Initialized | Retained |
| LRST flag | Initialized (0) | Can be set/cleared | Can be set/cleared |
| SDWN flag | Initialized (0) | Initialized (0) | Can be set/cleared |
| LRSTB bit | Initialized (0) | HR: 0 SR: 1 | 0 (can be set) |
| SDWNB bit | Initialized (0) | Initialized (0) | HS: 0 SS: 1 |
| SDWNE bit | Initialized (0) | Initialized (0) | HS: 1 SS: 0 or 1 |
| Host interface operation control bits (LPC3E to LPC1E, FGA20E, LADR3, IBFIE1 to IBFIE3, PMEE, PMEB, LSMIE, LSMIB, LSCIE, LSCIB, TWRE, SELSTR3, SELIRQ1, SELSMI, SELIRQ6, SELIRQ9, SELIRQ10, SELIRQ11, SELIRQ12) | Initialized | Retained | Retained |
| LRESET signal | Input (port function | Input | Input |
| LPCPD signal | - | Input | Input |
| LAD3 to LAD0, LFRAME, LCLK, SERIRQ, CLKRUN signals | - | Input | Hi-Z |
| PME, LSMI, LSCI, GA20 signals (when function is selected) | _ | Output | Hi-Z |
| PME, LSMI, LSCI, GA20 signals (when function is not selected) | _ | Port function | Port function |

Note: System reset: Reset by STBY input, RES input, or WDT overflow

LPC reset: Reset by LPC hardware reset (HR) or LPC software reset (SR)

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Figure 19.5 shows the timing of the \overline{LPCPD} and \overline{LRESET} signals.

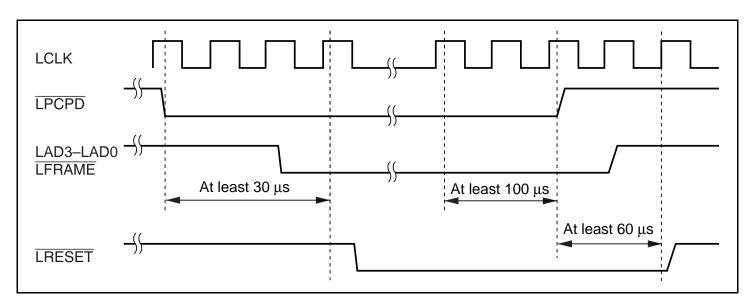


Figure 19.5 Power-Down State Termination Timing

19.4.5 Host Interface Serialized Interrupt Operation (SERIRQ)

A host interrupt request can be issued from the host interface by means of the SERIRQ pin. In a host interrupt request via the SERIRQ pin, LCLK cycles are counted from the start frame of the serialized interrupt transfer cycle generated by the host or a peripheral function, and a request signal is generated by the frame corresponding to that interrupt. The timing is shown in figure 19.6.

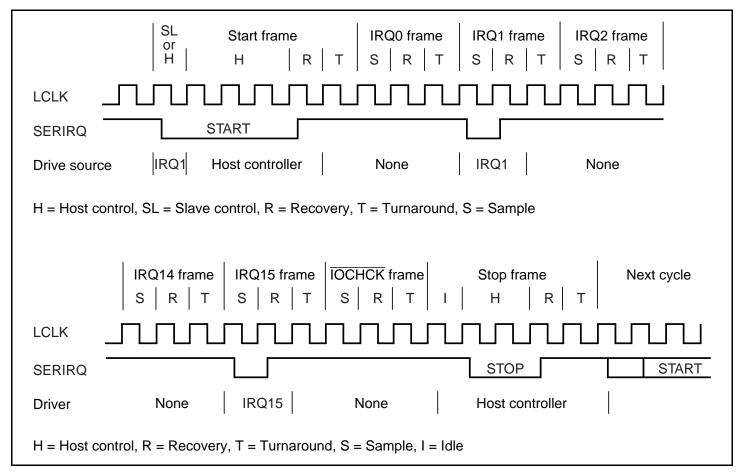


Figure 19.6 SERIRQ Timing

The serialized interrupt transfer cycle frame configuration is as follows. Two of the states comprising each frame are the recover state in which the SERIRQ signal is returned to the 1-level at the end of the frame, and the turnaround state in which the SERIRQ signal is not driven. The recover state must be driven by the host or slave processor that was driving the preceding state.

Serial Interrupt Transfer Cycle

| Frame Count | Contents | Drive Source | Number of States | Notes | |
|----------------|----------|-----------------|------------------|--|--|
| 0 | Start | Slave Host | 6 | In quiet mode only, slave drive possible in first state, then next 3 states 0-driven by host | |
| 1 | IRQ0 | Slave | 3 | | |
| 2 | IRQ1 | Slave | 3 | Drive possible in LPC channel 1 | |
| 3 | SMI | Slave | 3 | Drive possible in LPC channels 2 and 3 | |
| 4 | IRQ3 | Slave | 3 | | |
| 5 | IRQ4 | Slave | 3 | | |
| 6 | IRQ5 | Slave | 3 | | |
| 7 | IRQ6 | Slave | 3 | Drive possible in LPC channels 2 and 3 | |
| 8 | IRQ7 | Slave | 3 | | |
| 9 | IRQ8 | Slave | 3 | | |
| 10 | IRQ9 | Slave | 3 | Drive possible in LPC channels 2 and 3 | |
| 11 | IRQ10 | Slave | 3 | Drive possible in LPC channels 2 and 3 | |
| 12 | IRQ11 | Slave | 3 | Drive possible in LPC channels 2 and 3 | |
| 13 | IRQ12 | Slave | 3 | Drive possible in LPC channel 1 | |
| 14 | IRQ13 | Slave | 3 | | |
| 15 | IRQ14 | Slave | 3 | | |
| 16 | IRQ15 | Slave | 3 | | |
| 17 | IOCHCK | Slave | 3 | | |
| 18 | Stop | Host | Undefined | First, 1 or more idle states, then 2 or 3 states 0-driven by host 2 states: Quiet mode next 3 states: Continuous mode next | |

There are two modes—continuous mode and quiet mode—for serialized interrupts. The mode initiated in the next transfer cycle is selected by the stop frame of the serialized interrupt transfer cycle that ended before that cycle.

In continuous mode, the host initiates host interrupt transfer cycles at regular intervals. In quiet mode, the slave processor with interrupt sources requiring a request can also initiate an interrupt transfer cycle, in addition to the host. In quiet mode, since the host does not necessarily initiate interrupt transfer cycles, it is possible to suspend the clock (LCLK) supply and enter the power-down state. In order for a slave to transfer an interrupt request in this case, a request to restart the clock must first be issued to the host. For details see section 19.4.6, Host Interface Clock Start Request (CLKRUN).

19.4.6 Host Interface Clock Start Request (CLKRUN)

A request to restart the clock (LCLK) can be sent to the host processor by means of the CLKRUN pin. With LPC data transfer and SERIRQ in continuous mode, a clock restart is never requested since the transfer cycles are initiated by the host. With SERIRQ in quiet mode, when a host interrupt request is generated the CLKRUN signal is driven and a clock (LCLK) restart request is sent to the host. The timing for this operation is shown in figure 19.7.

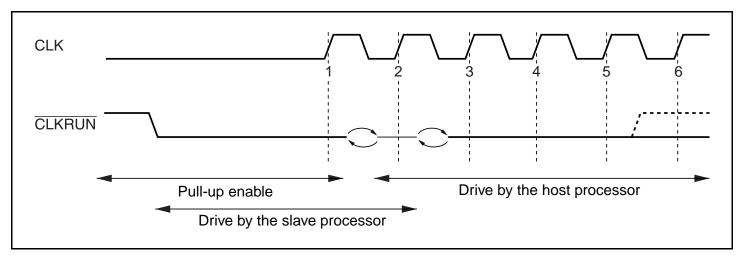


Figure 19.7 Clock Start Request Timing

Cases other than SERIRQ in quiet mode when clock restart is required must be handled with a different protocol, using the PME signal, etc.

19.5 Interrupt Sources

19.5.1 IBFI1, IBFI2, IBFI3, and ERRI

The host interface has four interrupt requests for the slave processor (this LSI): IBF1, IBF2, IBF3, and ERRI. IBFI1, IBFI2, and IBFI3 are IDR receive complete interrupts for IDR1, IDR2, and IDR3 and TWR, respectively. The ERRI interrupt indicates the occurrence of a special state such as an LPC reset, LPC shutdown, or transfer cycle abort. An interrupt request is enabled by setting the corresponding enable bit.

Table 19.7 Receive Complete Interrupts and Error Interrupt

| Interrupt | Description |
|-----------|--|
| IBFI1 | When IBFIE1 is set to 1 and IDR1 reception is completed |
| IBFI2 | When IBFIE2 is set to 1 and IDR2 reception is completed |
| IBFI3 | When IBFIE3 is set to 1 and IDR3 reception is completed, or when TWRE and IBFIE3 are set to 1 and reception is completed up to TWR15 |
| ERRI | When ERRIE is set to 1 and one of LRST, SDWN and ABRT is set to 1 |

19.5.2 SMI, HIRQ1, HIRQ6, HIRQ9, HIRQ10, HIRQ11, and HIRQ12

The host interface can request seven kinds of host interrupt by means of SERIRQ. HIRQ1 and HIRQ12 are used on LPC channel 1 only, while SMI, HIRQ6, HIRQ9, HIRQ10, and HIRQ11 can be requested from LPC channel 2 or 3.

There are two ways of clearing a host interrupt request.

When the IEDIR bit is cleared to 0 in SIRQCR0, host interrupt sources and LPC channels are all linked to the host interrupt request enable bits. When the OBF flag is cleared to 0 by a read of ODR or TWR15 by the host in the corresponding LPC channel, the corresponding host interrupt enable bit is automatically cleared to 0, and the host interrupt request is cleared.

When the IEDIR bit is set to 1 in SIRQCR0, LPC channel 2 and 3 interrupt requests are dependent only upon the host interrupt enable bits. The host interrupt enable bit is not cleared when OBF for channel 2 or 3 is cleared. Therefore, SMIE2, SMIE3A and SMIE3B, IRQ6E2 and IRQ6E3, IRQ9E2 and IRQ9E3, IRQ10E2 and IRQ10E3, and IRQ11E2 and IRQ11E3 lose their respective functional differences. In order to clear a host interrupt request, it is necessary to clear the host interrupt enable bit.

Table 19.8 summarizes the methods of setting and clearing these bits, and figure 19.8 shows the processing flowchart.

Table 19.8 HIRQ Setting and Clearing Conditions

| Host Interrupt | Setting Condition | Clearing Condition | | | |
|---------------------------------------|--|--|--|--|--|
| HIRQ1 (independent from IEDIR) | Internal CPU writes to ODR1, then reads 0 from bit IRQ1E1 and writes 1 | Internal CPU writes 0 to bit IRQ1E1, or host reads ODR1 | | | |
| HIRQ12 (independent from IEDIR) | Internal CPU writes to ODR1, then reads 0 from bit IRQ12E1 and writes 1 | Internal CPU writes 0 to bit IRQ12E1, or host reads ODR1 | | | |
| SMI | Internal CPU | Internal CPU | | | |
| (IEDIR = 0) | writes to ODR2, then reads 0 from bit SMIE2 and writes 1 | writes 0 to bit SMIE2, or host reads ODR2 | | | |
| | writes to ODR3, then reads 0 from bit SMIE3A and writes 1 | writes 0 to bit SMIE3A, or host reads ODR3 | | | |
| | writes to TWR15, then reads 0 from bit SMIE3B and writes 1 | writes 0 to bit SMIE3B, or host reads TWR15 | | | |
| SMI | Internal CPU | Internal CPU | | | |
| (IEDIR = 1) | • reads 0 from bit SMIE2, then writes 1 | writes 0 to bit SMIE2 | | | |
| | • reads 0 from bit SMIE3A, then writes | writes 0 to bit SMIE3A | | | |
| | 1 | writes 0 to bit SMIE3B | | | |
| | reads 0 from bit SMIE3B, then writes1 | | | | |
| HIRQi | Internal CPU | Internal CPU | | | |
| (i = 6, 9, 10, 11) (IEDIR = 0) | writes to ODR2, then reads 0 from bit IRQiE2 and writes 1 | writes 0 to bit IRQiE2, or host reads ODR2 | | | |
| | writes to ODR3, then reads 0 from bit IRQiE3 and writes 1 | CPU writes 0 to bit IRQiE3, or host reads ODR3 | | | |
| HIRQi | Internal CPU | Internal CPU | | | |
| (i = 6, 9, 10, 11) (IEDIR = 1) | • reads 0 from bit IRQiE2, then writes 1 | writes 0 to bit IRQiE2 | | | |
| (ILDIX = 1) | • reads 0 from bit IRQiE3, then writes 1 | writes 0 to bit IRQiE3 | | | |

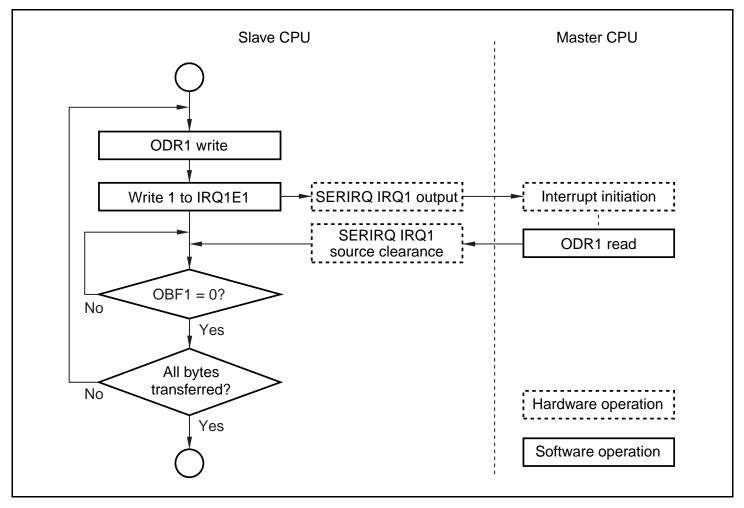


Figure 19.8 HIRQ Flowchart (Example of Channel 1)

19.6 Usage Notes

19.6.1 Module Stop Mode Setting

LPC operation can be enabled or disabled using the module stop control register. The initial setting is for LPC operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

19.6.2 Notes on Using Host Interface

The host interface provides buffering of asynchronous data from the host processor and slave processor (this LSI), but an interface protocol that uses the flags in STR must be followed to avoid data contention. For example, if the host and slave processor both try to access IDR or ODR at the same time, the data will be corrupted. To prevent simultaneous accesses, IBF and OBF must be used to allow access only to data for which writing has finished.

Unlike the IDR and ODR registers, the transfer direction is not fixed for the bidirectional data registers (TWR). MWMF and SWMF are provided in STR to handle this situation. After writing

to TWR0, MWMF and SWMF must be used to confirm that the write authority for TWR1 to TWR15 has been obtained.

Table 19.9 shows host address examples for LADR3 and registers, IDR3, ODR3, STR3, TWR0MW, TWR0SW, and TWR1 to TWR15 when LADR3 = H'A24F and LADR3 = H'3FD0.

Table 19.9 Host Address Example

| Register | Host Address when LADR3 = | H'A24F Host Address when LADR3 = H'3FD0 |
|----------|---------------------------|---|
| IDR3 | H'A24A and H'A24E | H'3FD0 and H'3FD4 |
| ODR3 | H'A24A | H'3FD0 |
| STR3 | H'A24E | H'3FD4 |
| TWR0MW | H'A250 | H'3FC0 |
| TWR0SW | H'A250 | H'3FC0 |
| TWR1 | H'A251 | H'3FC1 |
| TWR2 | H'A252 | H'3FC2 |
| TWR3 | H'A253 | H'3FC3 |
| TWR4 | H'A254 | H'3FC4 |
| TWR5 | H'A255 | H'3FC5 |
| TWR6 | H'A256 | H'3FC6 |
| TWR7 | H'A257 | H'3FC7 |
| TWR8 | H'A258 | H'3FC8 |
| TWR9 | H'A259 | H'3FC9 |
| TWR10 | H'A25A | H'3FCA |
| TWR11 | H'A25B | H'3FCB |
| TWR12 | H'A25C | H'3FCC |
| TWR13 | H'A25D | H'3FCD |
| TWR14 | H'A25E | H'3FCE |
| TWR15 | H'A25F | H'3FCF |
| | | |

Section 20 D/A Converter

20.1 Features

• 8-bit resolution

• Two output channels

• Conversion time: Max. 10 μs (when load capacitance is 20 pF)

• Output voltage: 0 V to AVref

• D/A output retaining function in software standby mode

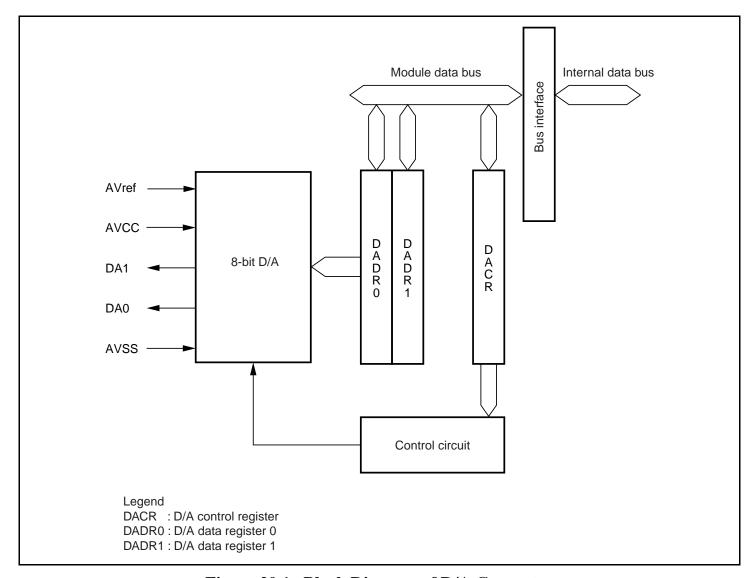


Figure 20.1 Block Diagram of D/A Converter

20.2 Input/Output Pins

Table 20.1 summarizes the input/output pins used by the D/A converter.

Table 20.1 Pin Configuration

| Pin Name | Symbol | I/O | Function |
|----------------------------|--------|--------|---|
| Analog power supply pin | AVCC | Input | Analog block power supply |
| Analog ground pin | AVSS | Input | Analog block ground and reference voltage |
| Analog output pin 0 | DA0 | Output | Channel 0 analog output |
| Analog output pin 1 | DA1 | Output | Channel 1 analog output |
| Reference power supply pin | AVref | Input | Analog block reference voltage |

20.3 Register Descriptions

The D/A converter has the following registers.

- D/A data register 0 (DADR0)
- D/A data register 1 (DADR1)
- D/A control register (DACR)

20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1)

DADR0 and DADR1 are 8-bit readable/writable registers that store data for D/A conversion. When analog output is permitted, D/A data register contents are converted and output to analog output pins. DADR0 and DADR1 are initialized to H'00.

20.3.2 D/A Control Register (DACR)

DACR controls D/A converter operation.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|-----|---|
| 7 | DAOE1 | 0 | R/W | D/A Output Enable 1 |
| | | | | Controls D/A conversion and analog output. |
| | | | | 0: Analog output DA1 is disabled |
| | | | | 1: D/A conversion for channel 1 and analog output DA1 are enabled |
| 6 | DAOE0 | 0 | R/W | D/A Output Enable 0 |
| | | | | Controls D/A conversion and analog output. |
| | | | | 0: Analog output DA0 is disabled |
| | | | | 1: D/A conversion for channel 0 and analog output DA0 are enabled |
| 5 | DAE | 0 | R/W | D/A Enable |
| | | | | Controls D/A conversion in conjunction with the DAOE0 and DAOE1 bits. When the DAE bit is cleared to 0, D/A conversion for channels 0 and 1 is controlled individually. When the DAE bit is set to 1, D/A conversion for channels 0 and 1 are controlled as one. Conversion result output is controlled by the DAOE0 and DAOE1 bits. For details, see table 20.2 below. |
| 4 | _ | All 1 | R | Reserved |
| to 0 | | | | These bits are always read as 1 and cannot be modified. |

Table 20.2 D/A Channel Enable

| Bit 7 | Bit 6 | Bit 5 | |
|-------|-------|-------|---|
| DAOE1 | DAOE0 | DAE | Description |
| 0 | 0 | _ | Disables D/A conversion |
| | 1 | 0 | Enables D/A conversion for channel 0 |
| | | | Disables D/A conversion for channel 1 |
| | | 1 | Enables D/A conversion for channels 0 and 1 |
| 1 | 0 | 0 | Disables D/A conversion for channel 0 |
| | | | Enables D/A conversion for channel 1 |
| | | 1 | Enables D/A conversion for channels 0 and 1 |
| | 1 | _ | Enables D/A conversion for channels 0 and 1 |

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20.4 Operation

The D/A converter incorporates two channels of the D/A circuits and can be converted individually.

When the DAOE bit in DACR is set to 1, D/A conversion is enabled and conversion results are output.

An example of D/A conversion of channel 0 is shown below. The operation timing is shown in figure 20.2.

- 1. Write conversion data to DADR0.
- 2. When the DAOE0 bit in DACR is set to 1, D/A conversion starts. After the interval of t_{DCONV}, conversion results are output from the analog output pin DA0. The conversion results are output continuously until DADR0 is modified or the DAOE0 bit is cleared to 0. The output value is calculated by the following formula:

DADR contents/256 × AVref

- 3. Conversion starts immediately after DADR0 is modified. After the interval of t_{DCONV}, conversion results are output.
- 4. When the DAOE0 bit is cleared to 0, analog output is disabled.

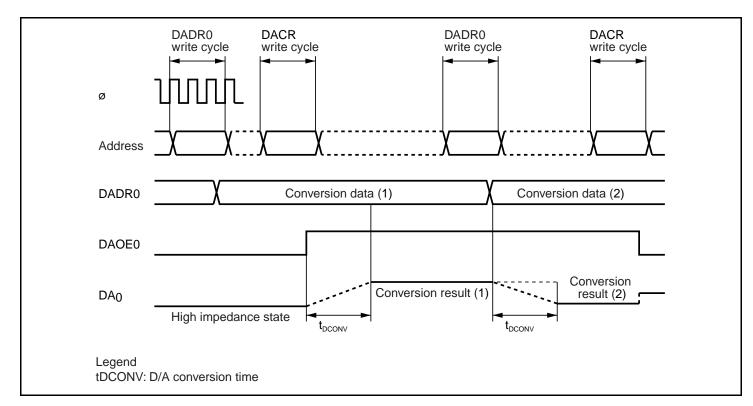


Figure 20.2 D/A Converter Operation Example

20.5 Usage Note

When this LSI enters software standby mode with D/A conversion enabled, the D/A output is retained, and the analog power supply current is equal to as during D/A conversion. If the analog power supply current needs to be reduced in software standby mode, clear the DAOE1, DAOE0, and DAE bits all to 0 to disable D/A output.

20.5.1 Module Stop Mode Setting

D/A converter operation can be enabled or disabled using the module stop control register. The initial setting is for D/A converter operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

Section 21 A/D Converter

This LSI includes a successive-approximation-type 10-bit A/D converter that allows up to eight analog input channels and up to 16 digital input to be selected. A/D conversion for digital input is effective as a comparator in multiple input testing.

21.1 Features

- 10-bit resolution
- Input channels: eight analog input channels and 16 digital input channels
- Analog conversion voltage range can be specified using the reference power supply voltage pin (AVref) as an analog reference voltage.
- Conversion time: 13.4 µs per channel (at 10-MHz operation)
- Two kinds of operating modes
 - Single mode: Single-channel A/D conversion
 - Scan mode: Continuous A/D conversion on 1 to 4 channels
- Four data registers
 - Conversion results are held in a 16-bit data register for each channel
- Sample and hold function
- Three kinds of conversion start
 - Software, 8-bit timer (TMR) conversion start trigger, or external trigger signal.
- Interrupt request
 - A/D conversion end interrupt (ADI) request can be generated

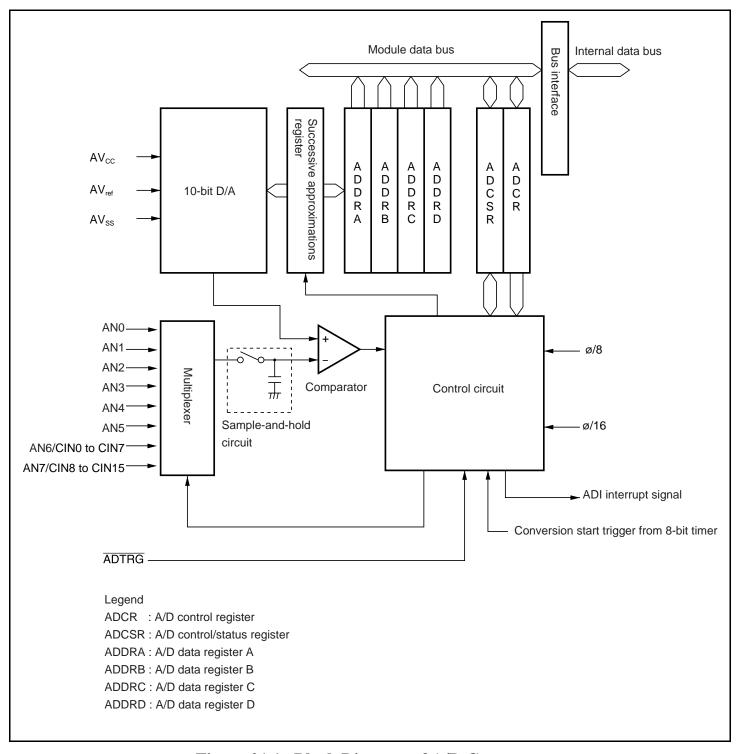


Figure 21.1 Block Diagram of A/D Converter

21.2 Input/Output Pins

Table 21.1 summarizes the pins used by the A/D converter. The 8 analog input pins are divided into two groups consisting of four channels. Analog input pins 0 to 3 (AN0 to AN3) comprising group 0 and analog input pins 4 to 7 (AN4 to AN7) comprising group 1. Expanded A/D conversion input pins (CIN0 to CIN15) can be selected with the AN6 and AN7 pins. The AVcc and AVss pins are the power supply pins for the analog block in the A/D converter.

Table 21.1 Pin Configuration

| Pin Name | Symbol | I/O | Function | | | |
|--------------------------------|------------------|-------|--|--|--|--|
| Analog power supply pin | AV _{cc} | Input | Analog block power supply and reference voltage | | | |
| Analog ground pin | AV _{ss} | Input | Analog block ground and reference voltage | | | |
| Reference power supply pin | AVref | Input | Reference voltage for A/D conversion | | | |
| Analog input pin 0 | AN0 | Input | Group 0 analog input pins | | | |
| Analog input pin 1 | AN1 | Input | | | | |
| Analog input pin 2 | AN2 | Input | | | | |
| Analog input pin 3 | AN3 | Input | | | | |
| Analog input pin 4 | AN4 | Input | Group 1 analog input pins | | | |
| Analog input pin 5 | AN5 | Input | | | | |
| Analog input pin 6 | AN6 | Input | | | | |
| Analog input pin 7 | AN7 | Input | | | | |
| A/D external trigger input pin | ADTRG | Input | External trigger input pin for starting A/D conversion | | | |
| Expanded A/D conversion input | CIN0 to CIN15 | Input | Expanded A/D conversion input (digital input) channels 0 to 15 | | | |
| pins 0 to 15 | | | Can be used as digital input pins | | | |

21.3 Register Descriptions

The A/D converter has the following registers.

- A/D data register A (ADDRA)
- A/D data register B (ADDRB)
- A/D data register C (ADDRC)
- A/D data register D (ADDRD)
- A/D control/status register (ADCSR)
- A/D control register (ADCR)
- Keyboard comparator control register (KBCOMP)

21.3.1 A/D Data Registers A to D (ADDRA to ADDRD)

There are four 16-bit read-only ADDR registers, ADDRA to ADDRD, used to store the results of A/D conversion. The ADDR registers, which store a conversion result for each channel, are shown in table 21.2.

The converted 10-bit data is stored to bits 15 to 6. The lower 6-bit data is always read as 0.

The data bus between the CPU and the A/D converter is 8-bit width. The upper byte can be read directly from the CPU, but the lower byte should be read via a temporary register. The temporary register contents are transferred from the ADDR when the upper byte data is read. When reading the ADDR, read the upper byte before lower byte or in word units.

Table 21.2 Analog Input Channels and Corresponding ADDR Registers

| Ana | alog Input Channel | _ A/D Data Register to Store A/D Conversion | | | | |
|-----------------|-----------------------|---|--|--|--|--|
| Group 0 Group 1 | | Results | | | | |
| AN0 | AN4 | ADDRA | | | | |
| An1 | AN5 | ADDRB | | | | |
| AN2 | AN6, or CIN0 to CIN7 | ADDRC | | | | |
| AN3 | AN7, or CIN8 to CIN15 | ADDRD | | | | |

21.3.2 A/D Control/Status Register (ADCSR)

ADCSR controls A/D conversion operations.

| Bit | Bit Name | Initial Value | R/W | Description | | |
|-----|----------|---------------|--------|---|--|--|
| 7 | ADF | 0 | R/(W)* | A/D End Flag | | |
| | | | | A status flag that indicates the end of A/D conversion. | | |
| | | | | [Setting conditions] | | |
| | | | | When A/D conversion ends in single mode | | |
| | | | | When A/D conversion ends on all channels specified in scan mode | | |
| | | | | [Clearing conditions] | | |
| | | | | When 0 is written after reading ADF = 1 | | |
| | | | | When DTC starts by an ADI interrupt and ADDR is read | | |
| 6 | ADIE | 0 | R/W | A/D Interrupt Enable | | |
| | | | | Enables ADI interrupt by ADF when this bit is set to 1 | | |
| 5 | ADST | 0 | R/W | A/D Start | | |
| | | | | Setting this bit to 1 starts A/D conversion. Clearing this bit to 0 stops A/D conversion. In single mode, this bit is cleared to 0 automatically when conversion on the specified channel ends. In scan mode, conversion continues sequentially on the specified channels until this bit is cleared to 0 by software, a reset, or a transition to standby mode or module stop mode. | | |
| 4 | SCAN | 0 | R/W | Scan Mode | | |
| | | | | Selects the A/D conversion operating mode. The setting of this bit must be made when conversion is halted (ADST = 0). | | |
| | | | | 0: Single mode | | |
| | | | | 1: Scan mode | | |
| 3 | CKS | 0 | R/W | Clock Select | | |
| | | | | Sets A/D conversion time. The input channel setting must be made when conversion is halted (ADST = 0). | | |
| | | | | 0: Conversion time is 266 states (max) | | |
| | | | | 1: Conversion time is 134 states (max) | | |
| | | | | Switch conversion time while ADST is 0. | | |

| Bit | Bit Name | Initial Value | R/W | Description | | | | |
|-----|----------|---------------|-----------------|---|--|--|--|--|
| 2 | CH2 | 0 | R/W | Channel Select 2 to 0 | | | | |
| 1 | CH1 | 0 | R/W | Select analog input channels. The input channel | | | | |
| 0 | CH0 | 0 | R/W | setting must be made when (ADST = 0). | conversion is halted | | | |
| | | | When SCAN = 0: | When SCAN = 1: | | | | |
| | | 000: AN0 | 000: AN0 | | | | | |
| | | | 001: AN1 | 001: AN0 and AN1 | | | | |
| | | 010: AN2 | 010: AN0 to AN2 | | | | | |
| | | 011: AN3 | 011: AN0 to AN3 | | | | | |
| | | | | 100: AN4 | 100: AN4 | | | |
| | | | | 101: AN5 | 101: AN4 and AN5 | | | |
| | | | | 110: AN6, or CIN0 to CIN7 | 110: AN4 to AN6 or CIN0 to CIN7 | | | |
| | | | | 111: AN7, or CIN8 to CIN15 | 111: AN4 to AN6 or CIN0 to CIN7, or AN7 or CIN8 to CIN15 | | | |

Note:* Only 0 can be written for clearing the flag.

21.3.3 A/D Control Register (ADCR)

ADCR enables A/D conversion started by an external trigger signal.

| Bit | Bit Name | Initial Value | R/W | Description | | | |
|------|----------|---------------|-----|---|--|--|--|
| 7 | TRGS1 | 0 | R/W | Timer Trigger Select 1 and 0 | | | |
| 6 | TRGS0 | 0 | R/W | Enable the start of A/D conversion by a trigger signal. Only set bits TRGS1 and TRGS0 when conversion is halted (ADST = 0). 00: A/D conversion start by external trigger is disabled | | | |
| | | | | | | | |
| | | | | 01: A/D conversion start by external trigger is disable | | | |
| | | | | A/D conversion start by conversion trigger from TMR is enabled | | | |
| | | | | 11: A/D conversion start by ADTRG pin is enabled | | | |
| 5 to | _ | All 1 | R | Reserved | | | |
| 0 | | | | These bits are always read as 1 and cannot be modified. | | | |

21.3.4 Keyboard Comparator Control Register (KBCOMP)

KBCOMP selects the CIN input channel for which A/D conversion is performed and enables or disables the comparator scan function of CIN7 to CIN0.

| Bit | Bit Name | Initial Value | R/W | Description | | | | |
|-----|----------|--------------------------|-----|---|-----------|--|--|--|
| 7 | IrE | 0 | R/W | These bits are related to the SCI. For details, refer to section 15.3.10, Keyboard Comparator Control Register (KBCOMP). | | | | |
| 6 | IrCKS2 | 0 | R/W | | | | | |
| 5 | IrCKS1 | 0 | R/W | | | | | |
| 4 | IrCKS0 | 0 | R/W | _ | | | | |
| 3 | KBADE | 0 | R/W | Keyboard A/D Enable (AN6, A | AN7) | | | |
| | | | | Selects whether channels 6 and 7 of the A/D converter are used as analog pins or digital pins, in combination with the KBCH2 to KBCH0 bits. For details, refer to description for bits 2 to 0. Analog pins of the A/D converter are set to digital pins (CIN0 to CIN7 and CIN8 to CIN15). | | | | |
| 2 | KBCH2 | 0 | R/W | Keyboard A/D Channel Select 2 to 0 | | | | |
| 1 | KBCH1 | 0 | R/W | These bits select a channel of digital input pins for A/D conversion, in combination with the KBADE bit. The input channel setting must be made while conversion is halted. | | | | |
| 0 | KBCH0 | 0 | R/W | | | | | |
| | | | | Channel 6 | Channel 7 | | | |
| | | | | 0xxx: Selects AN6 | AN7 | | | |
| | | | | 1000: Selects CIN0 | CIN8 | | | |
| | | | | 1001: Selects CIN1 | CIN9 | | | |
| | | | | 1010: Selects CIN2 | CIN10 | | | |
| | | | | 1011: Selects CIN3 | CIN11 | | | |
| | | | | 1100: Selects CIN4 | CIN12 | | | |
| | | | | 1101: Selects CIN5 | CIN13 | | | |
| | | | | 1110: Selects CIN6 | CIN14 | | | |
| | | 1111: Selects CIN7 CIN15 | | | | | | |

Legend

x: Don't care

21.4 Operation

The A/D converter operates by successive approximation with 10-bit resolution. It has two operating modes: single mode and scan mode. When changing the operating mode or analog input channel, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. The ADST bit can be set at the same time as the operating mode or analog input channel is changed.

21.4.1 Single Mode

In single mode, A/D conversion is to be performed only once on the specified single channel. Operations are as follows.

- 1. A/D conversion on the specified channel is started when the ADST bit in ADCSR is set to 1, by software or an external trigger input.
- 2. When A/D conversion is completed, the result is transferred to the A/D data register corresponding to the channel.
- 3. On completion of A/D conversion, the ADF bit in ADCSR is set to 1. If the ADIE bit is set to 1 at this time, an ADI interrupt request is generated.
- 4. The ADST bit remains set to 1 during A/D conversion. When conversion ends, the ADST bit is automatically cleared to 0, and the A/D converter enters wait state.

21.4.2 Scan Mode

Scan mode is useful for monitoring analog inputs in a group of one or more channels. When the ADST bit is set to 1 by software, or by timer or external trigger input, A/D conversion starts on the first channel in the group (AN0 when CH2 = 0; AN4 when CH2 = 1).

When two or more channels are selected, after conversion of the first channel ends, conversion of the second channel (AN1 or AN5) starts immediately. A/D conversion continues cyclically on the selected channels until the ADST bit is cleared to 0. The conversion results are transferred for storage into the ADDR registers corresponding to the channels.

Typical operations when three channels (AN0 to AN2) are selected in scan mode are described below.

- 1. Scan mode is selected (SCAN = 1), scan group 0 is selected (CH2 = 0), analog input channels AN0 to AN2 are selected (CH1 = 1, CH0 = 0), and A/D conversion is started (ADST = 1).
- 2. When A/D conversion of the first channel (AN0) is completed, the result is transferred to ADDRA. Next, conversion of the second channel (AN1) starts automatically.
- 3. Conversion proceeds in the same way through the third channel (AN2).
- 4. When conversion of all the selected channels (AN0 to AN2) is completed, the ADF flag is set to 1 and conversion of the first channel (AN0) starts again. If the ADIE bit is set to 1 at this time, an ADI interrupt is requested after A/D conversion ends.
- 5. Steps 2 to 4 are repeated as long as the ADST bit remains set to 1. When the ADST bit is cleared to 0, A/D conversion stops. After that, if the ADST bit is set to 1, A/D conversion starts again from the first channel (AN0).

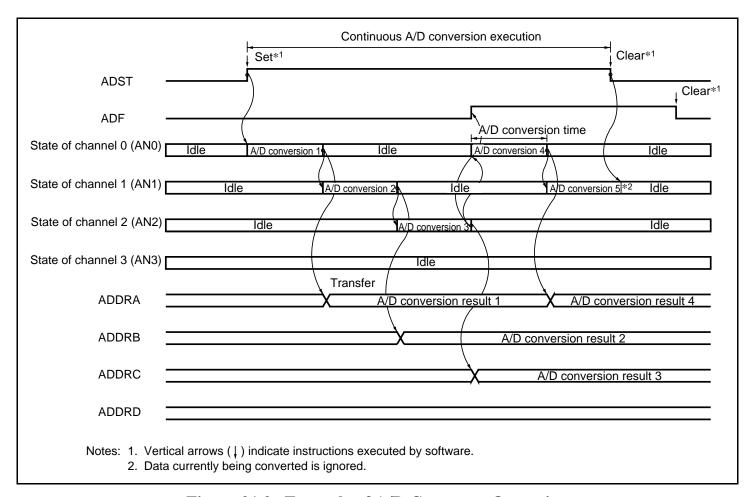


Figure 21.2 Example of A/D Converter Operation (Scan Mode, Channels AN0 to AN2 Selected)

21.4.3 Input Sampling and A/D Conversion Time

The A/D converter has a built-in sample-and-hold circuit. The A/D converter samples the analog input when the A/D conversion start delay time (t_D) passes after the ADST bit in ADCSR is set to 1, then starts A/D conversion. Figure 21.3 shows the A/D conversion timing. Table 21.3 indicates the A/D conversion time.

As indicated in figure 21.3, the A/D conversion time (t_{CONV}) includes t_D and the input sampling time (t_{SPL}). The length of t_D varies depending on the timing of the write access to ADCSR. The total conversion time therefore varies within the ranges indicated in table 21.3.

In scan mode, the values given in table 21.3 apply to the first conversion time. In the second and subsequent conversions, the conversion time is 256 state (fixed) when CKS = 0 and 128 states (fixed) when CKS = 1.

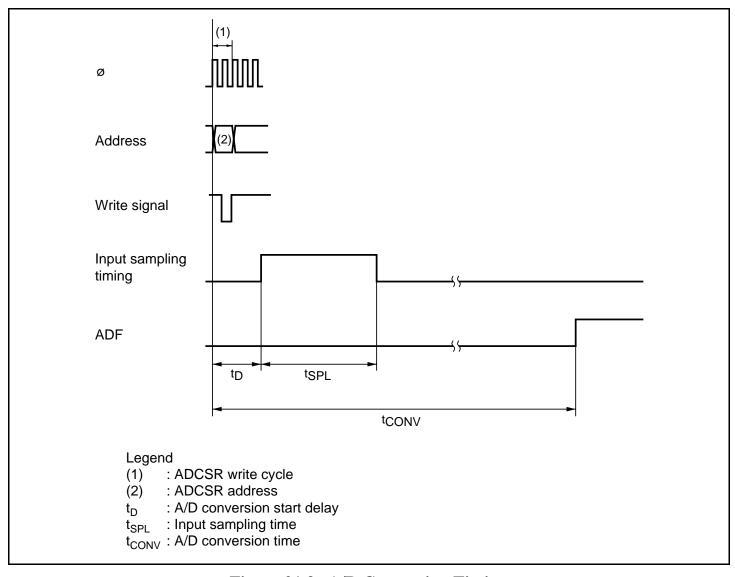


Figure 21.3 A/D Conversion Timing

Table 21.3 A/D Conversion Time (Single Mode)

| | | | CKS = 0 | | CKS = 1 | | 1 |
|---------------------------------|-------------------|-----|---------|-----|---------|-----|-----|
| Item | Symbol | min | typ | max | min | typ | max |
| A/D conversion start delay time | t _D | 10 | _ | 17 | 6 | _ | 9 |
| Input sampling time | t _{SPL} | _ | 63 | _ | _ | 31 | _ |
| A/D conversion time | t _{conv} | 259 | _ | 266 | 131 | _ | 134 |

Note:* Values in the table indicate the number of states.

21.4.4 External Trigger Input Timing

A/D conversion can be externally triggered. When the TRGS1 and TRGS0 bits are set to B'11 in ADCR, external trigger input is enabled at the ADTRG pin. A falling edge at the ADTRG pin sets the ADST bit to 1 in ADCSR, starting A/D conversion. Other operations, in both single and scan modes, are the same as when the ADST bit has been set to 1 by software. Figure 21.4 shows the timing.

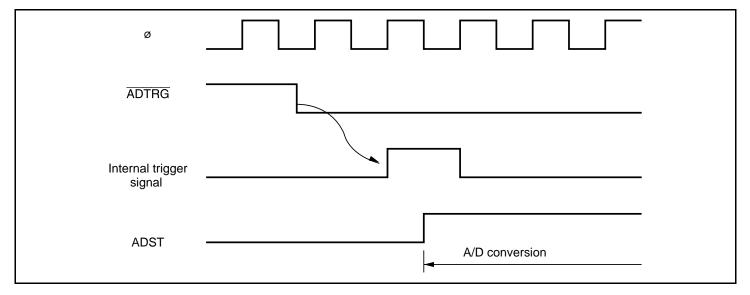


Figure 21.4 External Trigger Input Timing

21.5 Interrupt Sources

The A/D converter generates an A/D conversion end interrupt (ADI) at the end of A/D conversion. Setting the ADIE bit to 1 enables ADI interrupt requests while the ADF bit in ADCSR is set to 1 after A/D conversion is completed.

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21.6 A/D Conversion Accuracy Definitions

This LSI's A/D conversion accuracy definitions are given below.

Resolution

The number of A/D converter digital output codes

Quantization error

The deviation inherent in the A/D converter, given by 1/2 LSB (see figure 21.5).

Offset error

The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from the minimum voltage value B'0000000000 (H'000) to B'0000000001 (H'001) (see figure 21.6).

Full-scale error

The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from B'1111111110 (H'3FE) to B'1111111111 (H'3FF) (see figure 21.6).

Nonlinearity error

The error with respect to the ideal A/D conversion characteristics between the zero voltage and the full-scale voltage. Does not include the offset error, full-scale error, or quantization error (see figure 21.6).

Absolute accuracy

The deviation between the digital value and the analog input value. Includes the offset error, full-scale error, quantization error, and nonlinearity error.

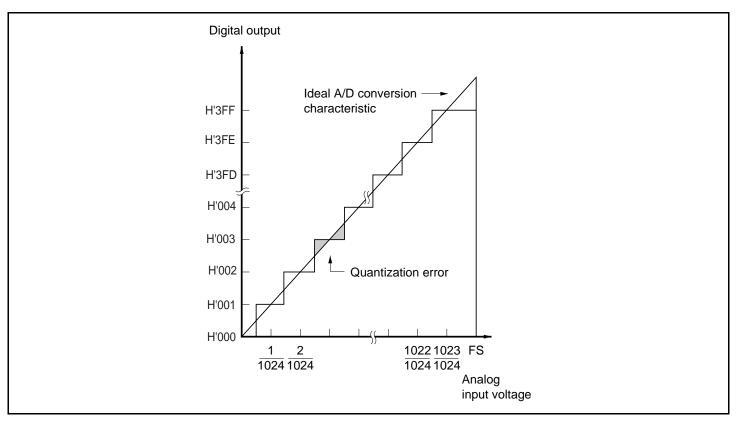


Figure 21.5 A/D Conversion Accuracy Definitions

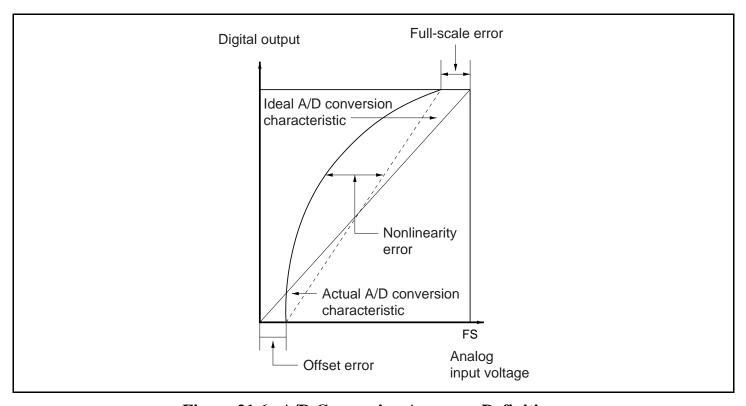


Figure 21.6 A/D Conversion Accuracy Definitions

21.7 Usage Notes

21.7.1 Permissible Signal Source Impedance

This LSI's analog input (3-V version) is designed so that the conversion accuracy is guaranteed for an input signal for which the signal source impedance is $5 \text{ k}\Omega$ or less. This specification is provided to enable the A/D converter's sample-and-hold circuit input capacitance to be charged within the sampling time; if the sensor output impedance exceeds $5 \text{ k}\Omega$, charging may be insufficient and it may not be possible to guarantee the A/D conversion accuracy. However, if a large capacitance is provided externally in single mode, the input load will essentially comprise only the internal input resistance of $10 \text{ k}\Omega$, and the signal source impedance is ignored. However, since a low-pass filter effect is obtained in this case, it may not be possible to follow an analog signal with a large differential coefficient (e.g., voltage fluctuation ratio of $5 \text{ mV/}\mu\text{s}$ or greater) (see figure 21.7). When converting a high-speed analog signal or converting in scan mode, a low-impedance buffer should be inserted. For details on the 5-V version, refer to section 28, Electrical Characteristics.

21.7.2 Influences on Absolute Accuracy

Adding capacitance results in coupling with ground, and therefore noise in ground may adversely affect the absolute accuracy. Be sure to make the connection to an electrically stable ground such as AVss.

Care is also required to insure that filter circuits do not communicate with digital signals on the mounting board, so acting as antennas.

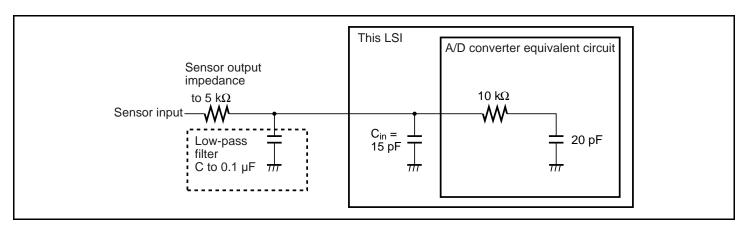


Figure 21.7 Example of Analog Input Circuit

21.7.3 Setting Range of Analog Power Supply and Other Pins

If conditions shown below are not met, the reliability of this LSI may be adversely affected.

- Analog input voltage range
 The voltage applied to analog input pin ANn during A/D conversion should be in the range AVss ≤ ANn ≤ AVref (n = 0 to 7).
- Digital input voltage range
 The voltage applied to digital input pin CINn should be in the range AVss ≤ CINn ≤ AVref and Vss ≤ CINn ≤ Vcc (n = 0 to 15).
- Relation between AVcc, AVss and Vcc, Vss
 For the relationship between AVcc, AVss and Vcc, Vss, set AVss = Vss. If the A/D converter is not used, the AVcc and AVss pins must on no account be left open.
- AVref pin reference voltage specification range
 The reference voltage of the AVref pin should be in the range AVref ≤ AVcc.

21.7.4 Notes on Board Design

In board design, digital circuitry and analog circuitry should be as mutually isolated as possible, and layout in which digital circuit signal lines and analog circuit signal lines cross or are in close proximity should be avoided as far as possible. Failure to do so may result in incorrect operation of the analog circuitry due to inductance, adversely affecting A/D conversion values. Also, digital circuitry must be isolated from the analog input signals (AN0 to AN7), analog reference voltage (AV_{ref}) , and analog power supply (AV_{cc}) by the analog ground (AV_{ss}) . Also, the analog ground (AV_{ss}) should be connected at one point to a stable digital ground (V_{ss}) on the board.

21.7.5 Notes on Noise Countermeasures

A protection circuit connected to prevent damage due to an abnormal voltage such as an excessive surge at the analog input pins (AN0 to AN7) and analog reference voltage (AV $_{\rm ref}$) should be connected between AVcc and AVss as shown in figure 21.8. Also, the bypass capacitors connected to AVcc and AV $_{\rm ref}$, and the filter capacitor connected to AN2 to AN7, must be connected to AV $_{\rm ss}$.

If a filter capacitor is connected, the input currents at the analog input pins (AN0 to AN7) are averaged, and so an error may arise. Also, when A/D conversion is performed frequently, as in scan mode, if the current charged and discharged by the capacitance of the sample-and-hold circuit in the A/D converter exceeds the current input via the input impedance (R_{in}), an error will arise in the analog input pin voltage. Careful consideration is therefore required when deciding the circuit constants.

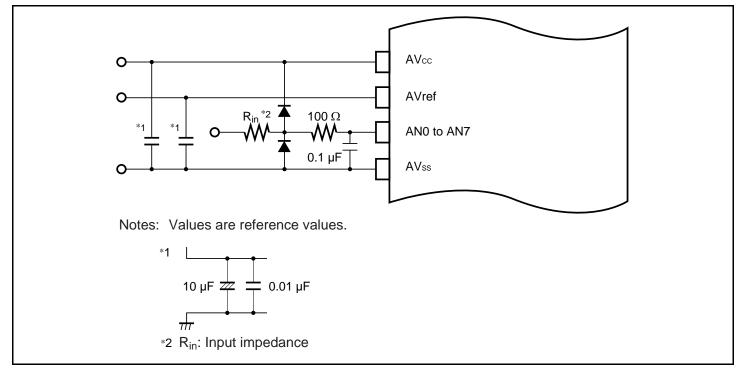


Figure 21.8 Example of Analog Input Protection Circuit

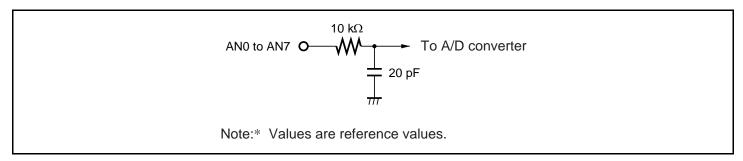


Figure 21.9 Equivalent Circuit of Analog Input Pin

21.7.6 Module Stop Mode Setting

A/D converter operation can be enabled or disabled using the module stop control register. The initial setting is for A/D converter operation to be halted. Register access is enabled by canceling module stop mode. For details, refer to section 26, Power-Down Modes.

Section 22 RAM

This LSI has an on-chip high-speed static RAM. The RAM is connected to the CPU by a 16-bit data bus, enabling one-state access by the CPU to both byte data and word data.

The on-chip RAM can be enabled or disabled by means of the RAME bit in the system control register (SYSCR). For details on SYSCR, refer to section 3.2.2, System Control Register (SYSCR).

| Product Classif | ication | RAM Capacitance | RAM Address |
|----------------------|-----------|-----------------|------------------------------|
| Flash memory version | H8S/2161B | 4 kbytes | H'E080-H'EFFF, H'FF00-H'FF7F |
| | H8S/2160B | 4 kbytes | H'E080–H'EFFF, H'FF00–H'FF7F |
| | H8S/2141B | 4 kbytes | H'E080–H'EFFF, H'FF00–H'FF7F |
| | H8S/2140B | 4 kbytes | H'E080–H'EFFF, H'FF00–H'FF7F |
| | H8S/2145B | 8 kbytes | H'D080-H'EFFF, H'FF00-H'FF7F |
| | H8S/2148B | 4 kbytes | H'E080-H'EFFF, H'FF00-H'FF7F |
| Masked ROM version | H8S/2161B | 4 kbytes | H'E080-H'EFFF, H'FF00-H'FF7F |
| | H8S/2160B | 4 kbytes | H'E080-H'EFFF, H'FF00-H'FF7F |

Section 23 ROM

This LSI has an on-chip ROM (flash memory or masked ROM). The features of the flash memory are summarized below.

A block diagram of the flash memory is shown in figure 23.1.

23.1 Features

Size

| Product Classification | RAM Capacitance | RAM Address |
|-------------------------------|-----------------|--|
| H8S/2161B | 128 kbytes | H'000000-H'01FFFF (mode 2) H'0000-H'DFFF (mode 3) |
| H8S/2160B | 64 kbytes | H'000000-H'00FFFF (mode 2) H'0000-H'DFFF (mode 3) |
| H8S/2141B | 128 kbytes | H'000000-H'01FFFF (mode 2) H'0000-H'DFFF (mode 3) |
| H8S/2140B | 64 kbytes | H'000000-H'00FFFF (mode 2) H'0000-H'DFFF (mode 3) |
| H8S/2145B | 256 kbytes | H'000000-H'03FFFF (mode 2) H'0000-H'DFFF (mode 3) |
| H8S/2148B | 128 kbytes | H'000000-H'01FFFF (mode 2) H'0000-H'DFFF (mode 3) |

• Programming/erase methods

The flash memory is programmed 128 bytes at a time. Erase is performed in single-block units. The flash memory is configured as follows:

- 64-kbyte version: 8 kbytes \times 2 blocks, 16 kbytes \times 1 block, 28 kbytes \times 1 block, and 1 kbyte \times 4 blocks
- 128-kbyte version: 32 kbytes \times 2 blocks, 8 kbytes \times 2 blocks, 16 kbytes \times 1 block, 28 kbytes \times 1 block, and 1 kbyte \times 4 blocks
- 256-kbyte version: 64 kbytes \times 3 blocks, 32 kbytes \times 1 block, and 4 kbytes \times 8 blocks.

To erase the entire flash memory, each block must be erased in turn.

• Programming/erase time

It takes 10 ms (typ.) to program the flash memory 128 bytes at a time; 80 μs (typ.) per 1 byte. Erasing one block takes 100 ms (typ.).

• Reprogramming capability

The flash memory can be reprogrammed up to 100 times.

• Two flash memory on-board programming modes



- Boot mode
- User program mode

On-board programming/erasing can be done in boot mode in which the boot program built into the chip is started for erase or programming of the entire flash memory. In user program mode, individual blocks can be erased or programmed.

Automatic bit rate adjustment

With data transfer in boot mode, this LSI's bit rate can be automatically adjusted to match the transfer bit rate of the host.

• Programming/erasing protection

Sets protection against flash memory programming/erasing via hardware, software, or error protection.

Programmer mode

In addition to on-board programming mode, programmer mode is supported to program or erase the flash memory using a PROM programmer.

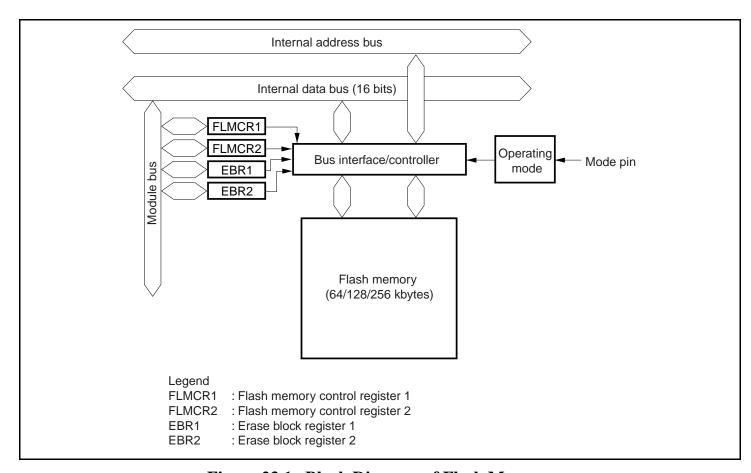


Figure 23.1 Block Diagram of Flash Memory

23.2 Mode Transitions

When the mode pins are set in the reset state and a reset-start is executed, this LSI enters an operating mode as shown in figure 23.2. In user mode, flash memory can be read but not programmed or erased. The boot, user program, and programmer modes are provided as modes to write and erase the flash memory.

The differences between boot mode and user program mode are shown in table 23.1. Figure 23.3 shows the boot mode and figure 23.4 shows the user program mode.

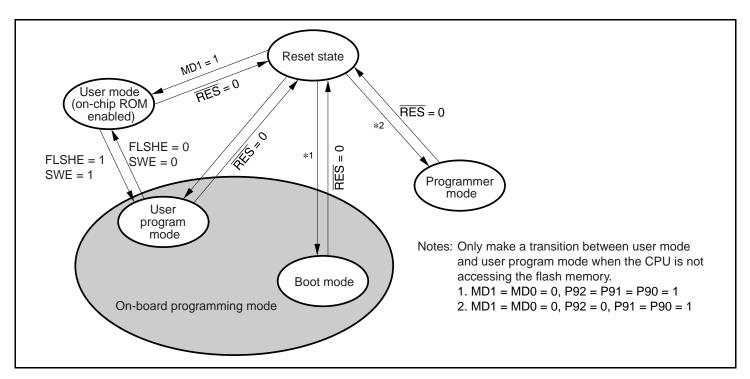


Figure 23.2 Flash Memory State Transitions

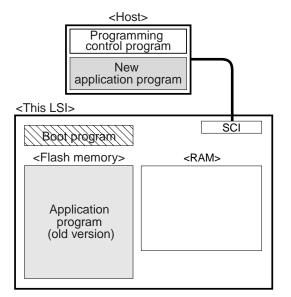
Table 23.1 Differences between Boot Mode and User Program Mode

| | Boot Mode | User Program Mode |
|------------------------------|------------------------|------------------------|
| Total erase | Yes | Yes |
| Block erase | No | Yes |
| Programming control program* | Program/program-verify | Program/program-verify |
| | | Erase/erase-verify |

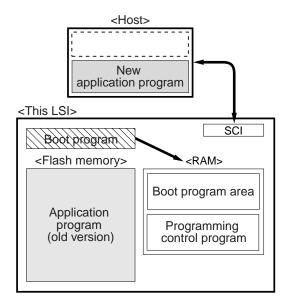
RENESAS

Note:* Should be provided by the user, in accordance with the recommended algorithm.

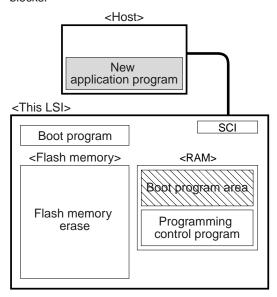
Initial state
 The flash memory is erased at shipment.
 The following describes how to write over an old-version application program or data in the flash memory. The user should prepare the programming control program and new application program beforehand in the host.



 SCI communication check When boot mode is entered, the boot program in this LSI (originally incorporated in the chip) is started and SCI communication is checked. Then the boot program required for flash memory erasing is automatically transferred to the RAM boot program area.



Flash memory initialization
 The erase program in the boot program area (in RAM) is executed, and the flash memory is initialized (to H'FF). In boot mode, total flash memory erasure is performed, without regard to blocks.



4. Writing new application program The programming control program transferred from the host to RAM via SCI communication is executed, and the new application program in the host is written into the flash memory.

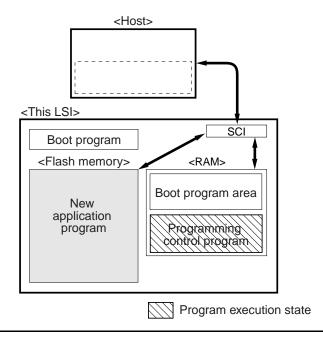
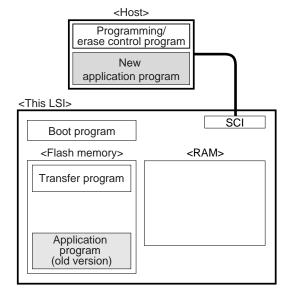
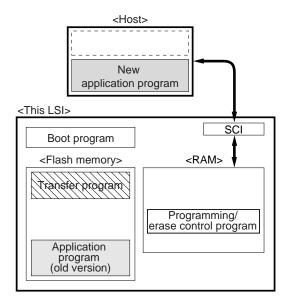


Figure 23.3 Boot Mode

- 1. Initial state
 - (1) The program that will transfer the programming/erase control program from flash memory to on-chip RAM should be written into the flash memory by the user beforehand.
 - (2) The programming/erase control program should be prepared in the host or in the flash memory.
- Programming/erase control program transfer
 The transfer program in the flash memory is executed and the programming/erase control program is transferred to RAM.

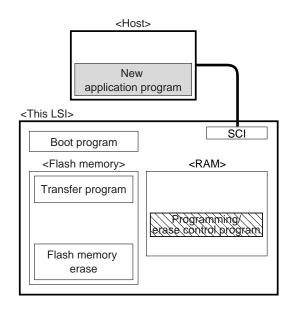




3. Flash memory initialization

The programming/erase program in RAM is executed, and the flash memory is initialized (to H'FF). Erasing can be performed in block units, but not in byte units. 4. Writing new application program

Next, the new application program in the host is written into the erased flash memory blocks. Do not write to unerased blocks.



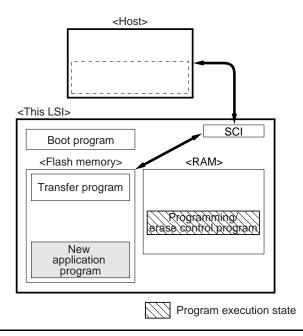


Figure 23.4 User Program Mode (Example)

23.3 Block Configuration

23.3.1 Block Configuration of 64-Kbyte Flash Memory

Figure 23.5 shows the block configuration of 64-kbyte flash memory. The thick lines indicate erasing units, the narrow lines indicate programming units, and the values are addresses. The flash memory is divided into 8 kbytes (2 blocks), 16 kbytes (1 block), 28 kbytes (1 block), and 1 kbyte (4 blocks). Erasing is performed in these divided units. Programming is performed in 128-byte units starting from an address whose lower bits are H'00 or H'80.

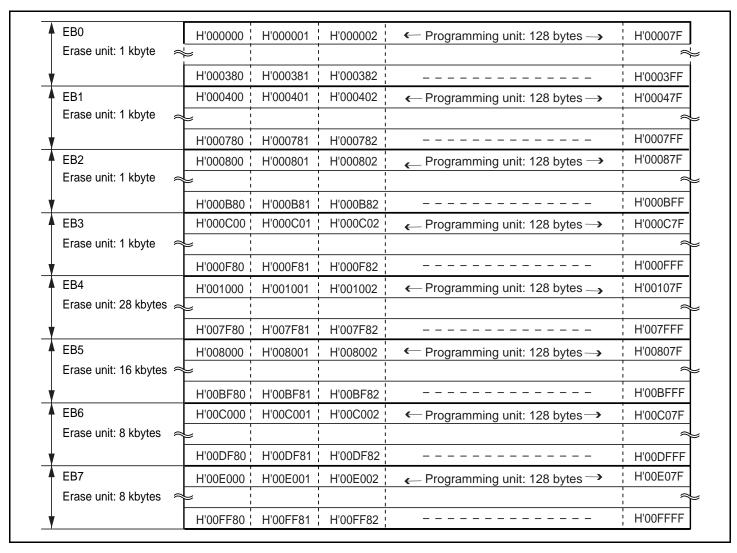


Figure 23.5 64-Kbyte Flash Memory Block Configuration

23.3.2 Block Configuration of 128-Kbyte Flash Memory

Figure 23.6 shows the block configuration of 128-kbyte flash memory. The thick lines indicate erasing units, the narrow lines indicate programming units, and the values are addresses. The flash memory is divided into 32 kbytes (2 blocks), 8 kbytes (2 blocks), 16 kbytes (1 block), 28 kbytes (1 block), and 1 kbyte (4 blocks). Erasing is performed in these divided units. Programming is performed in 128-byte units starting from an address whose lower bits are H'00 or H'80.

| EB0 | H'000000 | H'000001 | H'000002 | ← Programming unit: 128 bytes → | H'000071 |
|-------------------------|----------|----------|---------------------------------------|---------------------------------|----------|
| Erase unit: 1 kbyte | * | | · · · · · · · · · · · · · · · · · · · | <u> </u> | 1 |
| | H'000380 | H'000381 | H'000382 | | H'0003F |
| EB1 | H'000400 | H'000401 | H'000402 | ← Programming unit: 128 bytes → | H'00407I |
| Erase unit: 1 kbyte | * | | | | ; ; |
| | H'000780 | H'000781 | H'000782 | | H'0007F |
| EB2 | H'000800 | H'000801 | H'000802 | ← Programming unit: 128 bytes → | H'00087 |
| Erase unit: 1 kbyte | * | | | | 1 |
| | H'000B80 | H'000B81 | H'000B82 | | H'000BF |
| EB3 | H'000C00 | H'000C01 | H'000C02 | ← Programming unit: 128 bytes → | H'000C7 |
| Erase unit: 1 kbyte | * | | | | 1 |
| | H'000F80 | H'000F81 | H'000F82 | | H'000FF |
| EB4 | H'001000 | H'001001 | H'001002 | ← Programming unit: 128 bytes → | H'00107 |
| Erase unit: 28 kbytes | * | | | | ! |
| | H'007F80 | H'007F81 | H'007F82 | | H'007FF |
| EB5 | H'008000 | H'008001 | H'008002 | ← Programming unit: 128 bytes → | H'00807 |
| Erase unit: 16 kbytes | * | | | | |
| | H'00BF80 | H'00BF81 | H'00BF82 | | H'00BFF |
| EB6 | H'00C000 | H'00C001 | H'00C002 | ← Programming unit: 128 bytes → | H'00C07 |
| Erase unit: 8 kbytes | ₹ | | , | | 1 |
| | H'00DF80 | H'00DF81 | H'00DF82 | | H'00DFF |
| EB7 | H'00E000 | H'00E001 | H'00E002 | ← Programming unit: 128 bytes → | H'00E07 |
| Erase unit: 8 kbytes | * | | · | | <u>i</u> |
| | H'00FF80 | H'00FF81 | H'00FF82 | | H'00FFF |
| EB8 | H'010000 | H'010001 | H'010002 | ← Programming unit: 128 bytes → | H'01007I |
| Erase unit: 32 kbytes = | * | | , | | <u> </u> |
| | H'017F80 | H'017F81 | H'017F82 | | H'017FF |
| EB9 | H'018000 | H'018001 | H'018002 | Programming unit: 128 bytes — | H'01807 |
| Erase unit: 32 kbytes | * | | , | | i 1 |
| | H'01FF80 | H'01FF81 | H'01FF82 | | H'01FFF |

Figure 23.6 128-Kbyte Flash Memory Block Configuration

23.3.3 Block Configuration of 256-Kbyte Flash Memory

Figure 23.7 shows the block configuration of 256-kbyte flash memory. The thick lines indicate erasing units, the narrow lines indicate programming units, and the values are addresses. The flash memory is divided into 64 kbytes (3 blocks), 32 kbytes (1 block), and 4 kbytes (8 blocks). Erasing is performed in these divided units. Programming is performed in 128-byte units starting from an address whose lower bits are H'00 or H'80.

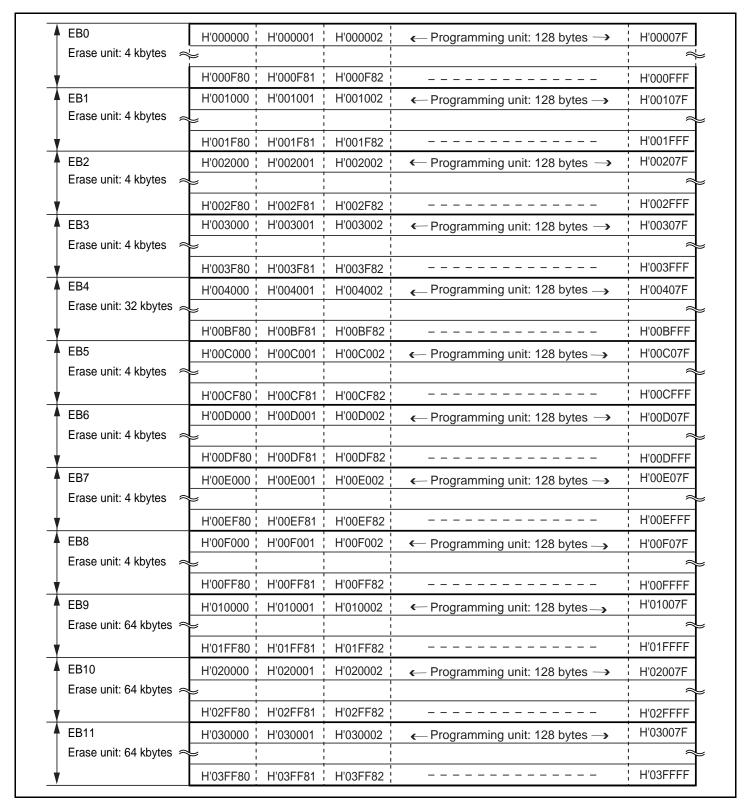


Figure 23.7 256-Kbyte Flash Memory Block Configuration

23.4 Input/Output Pins

The flash memory is controlled by means of the pins shown in table 23.2.

Table 23.2 Pin Configuration

| Pin Name | I/O | Function |
|----------|--------|--------------------------------|
| RES | Input | Reset |
| MD1 | Input | Sets this LSI's operating mode |
| MD0 | Input | Sets this LSI's operating mode |
| P92 | Input | Sets this LSI's operating mode |
| P91 | Input | Sets this LSI's operating mode |
| P90 | Input | Sets this LSI's operating mode |
| TxD1 | Output | Serial transmit data output |
| RxD1 | Input | Serial receive data input |

23.5 Register Descriptions

The flash memory has the following registers. To access FLMCR1, FLMCR2, EBR1, or EBR2, the FLSHE bit in the serial/timer control register (STCR) should be set to 1. For details on the serial/timer control register, refer to section 3.2.3, Serial/Timer Control Register (STCR).

- Flash memory control register 1 (FLMCR1)
- Flash memory control register 2 (FLMCR2)
- Erase block register 1 (EBR1)
- Erase block register 2 (EBR2)

23.5.1 Flash Memory Control Register 1 (FLMCR1)

FLMCR1, used together with FLMCR2, makes the flash memory transit to program mode, program-verify mode, erase mode, or erase-verify mode. For details on register setting, refer to section 23.8, Flash Memory Programming/Erasing.

FLMCR1 is initialized to H'80 by a reset, or in hardware standby mode, software standby mode, sub-active mode, sub-sleep mode, or watch mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | FWE | 1 | R | Flash Write Enable |
| | | | | Controls programming/erasing of on-chip flash memory. This bit is always read as 0, and cannot be modified. |
| 6 | SWE | 0 | R/W | Software Write Enable |
| | | | | When this bit is set to 1, flash memory programming/erasing is enabled. When this bit is cleared to 0, the EV, PV, E, and P bits in this register, the ESU and PSU bits in FLMCR2, and all EBR1 and EBR2 bits cannot be set to 1. Do not clear these bits and SWE to 0 simultaneously. |
| 5 | _ | 0 | R | Reserved |
| 4 | _ | 0 | R | These bits are always read as 0 and cannot be modified. |
| 3 | EV | 0 | R/W | Erase-Verify |
| | | | | When this bit is set to 1 while SWE = 1, the flash memory transits to erase-verify mode. When it is cleared to 0, erase-verify mode is cancelled. |
| 2 | PV | 0 | R/W | Program-Verify |
| | | | | When this bit is set to 1 while SWE = 1, the flash memory transits to program-verify mode. When it is cleared to 0, program-verify mode is cancelled. |
| 1 | Е | 0 | R/W | Erase |
| | | | | When this bit is set to 1 while SWE = 1 and ESU = 1, the flash memory transits to erase mode. When it is cleared to 0, erase mode is cancelled. |
| 0 | Р | 0 | R/W | Program |
| | | | | When this bit is set to 1 while SWE = 1 and PSU = 1, the flash memory transits to program mode. When it is cleared to 0, program mode is cancelled. |

23.5.2 Flash Memory Control Register 2 (FLMCR2)

FLMCR2 monitors the state of flash memory programming/erasing protection (error protection) and sets up the flash memory to transit to programming/erasing mode. FLMCR2 is initialized to H'00 by a reset or in hardware standby mode. The ESU and PSU bits are cleared to 0 in software standby mode, sub-active mode, sub-sleep mode, or watch mode, or when the SWE bit in FLMCR1 is cleared to 0.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-------|--|
| 7 | FLER | 0 | R | Flash memory error |
| | | | | Indicates that an error has occurred during flash memory programming/erasing. When this bit is set to 1, flash memory goes to the error-protection state. |
| | | | | For details, see section 23.9.3, Error Protection. |
| 6 to | _ | All 0 | R/(W) | Reserved |
| 2 | | | | The initial values should not be modified. |
| 1 | ESU | 0 | R/W | Erase Setup |
| | | | | When this bit is set to 1 while SWE = 1, the flash memory transits to the erase setup state. When it is cleared to 0, the erase setup state is cancelled. Set this bit to 1 before setting the E bit in FLMCR1 to 1. |
| 0 | PSU | 0 | R/W | Program Setup |
| | | | | When this bit is set to 1 while SWE = 1, the flash memory transits to the program setup state. When it is cleared to 0, the program setup state is cancelled. Set this bit to 1 before setting the P bit in FLMCR1 to 1. |

23.5.3 Erase Block Registers 1 and 2 (EBR1, EBR2)

EBR1 and EBR2 are used to specify the flash memory erase block. EBR1 and EBR2 are initialized to H'00 by a reset, or in hardware standby mode, software standby mode, sub-active mode, sub-sleep mode, or watch mode, or when the SWE bit in FLMCR1 is cleared to 0. Set only one bit to 1 at a time, otherwise all bits in EBR1 and EBR2 are automatically cleared to 0.

• EBR1 (64-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-------|--|
| 7 to 0 | _ | All 0 | R/(W) | Reserved |
| | | | | The initial values should not be modified. |

• EBR2 (64-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 7 | EB7 | 0 | R/W* | When this bit is set to 1, 8 kbytes of EB7 (H'00E000 to H'00FFFF) are to be erased. |
| 6 | EB6 | 0 | R/W | When this bit is set to 1, 8 kbytes of EB6 (H'00C000 to H'00DFFF) are to be erased. |
| 5 | EB5 | 0 | R/W | When this bit is set to 1, 16 kbytes of EB5 (H'008000 to H'00BFFF) are to be erased. |
| 4 | EB4 | 0 | R/W | When this bit is set to 1, 28 kbytes of EB4 (H'001000 to H'007FFF) are to be erased. |
| 3 | EB3 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB3 (H'000C00 to H'000FFF) is to be erased. |
| 2 | EB2 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB2 (H'000800 to H'000BFF) is to be erased. |
| 1 | EB1 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB1 (H'000400 to H'0007FF) is to be erased. |
| 0 | EB0 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB0 (H'000000 to H'0003FF) is to be erased. |

Note:* In normal mode, this bit is always read as 0 and cannot be modified.

• EBR1 (128-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-------|--|
| 7 to 2 | _ | All 0 | R/(W) | Reserved |
| | | | | The initial values should not be modified. |
| 1 | EB9 | 0 | R/W* | When this bit is set to 1, 32 kbytes of EB9 (H'018000 to H'01FFFF) are to be erased. |
| 0 | EB8 | 0 | R/W* | When this bit is set to 1, 32 kbytes of EB8 (H'010000 to H'017FFF) are to be erased. |

• EBR2 (128-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 7 | EB7 | 0 | R/W* | When this bit is set to 1, 8 kbytes of EB7 (H'00E000 to H'00FFFF) are to be erased. |
| 6 | EB6 | 0 | R/W | When this bit is set to 1, 8 kbytes of EB6 (H'00C000 to H'00DFFF) are to be erased. |
| 5 | EB5 | 0 | R/W | When this bit is set to 1, 16 kbytes of EB5 (H'008000 to H'00BFFF) are to be erased. |
| 4 | EB4 | 0 | R/W | When this bit is set to 1, 28 kbytes of EB4 (H'001000 to H'007FFF) are to be erased. |
| 3 | EB3 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB3 (H'000C00 to H'000FFF) is to be erased. |
| 2 | EB2 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB2 (H'000800 to H'000BFF) is to be erased. |
| 1 | EB1 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB1 (H'000400 to H'0007FF) is to be erased. |
| 0 | EB0 | 0 | R/W | When this bit is set to 1, 1 kbyte of EB0 (H'000000 to H'0003FF) is to be erased. |

Note:* In normal mode, this bit is always read as 0 and cannot be modified.

• EBR1 (256-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-------|---|
| 7 to 4 | _ | All 0 | R/(W) | Reserved |
| | | | | The initial values should not be modified. |
| 3 | EB11 | 0 | R/W* | When this bit is set to 1, 64 kbytes of EB11 (H'030000 to H'03FFFF) are to be erased. |
| 2 | EB10 | 0 | R/W* | When this bit is set to 1, 64 kbytes of EB10 (H'020000 to H'02FFFF) are to be erased. |
| 1 | EB9 | 0 | R/W* | When this bit is set to 1, 64 kbytes of EB9 (H'010000 to H'01FFFF) are to be erased. |
| 0 | EB8 | 0 | R/W* | When this bit is set to 1, 4 kbytes of EB8 (H'00F000 to H'00FFFF) are to be erased. |
| | • | • | | |

• EBR2 (256-kbyte version)

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 7 | EB7 | 0 | R/W* | When this bit is set to 1, 4 kbytes of EB7 (H'00E000 to H'00EFFF) are to be erased. |
| 6 | EB6 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB6 (H'00D000 to H'00DFFF) are to be erased. |
| 5 | EB5 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB5 (H'00C000 to H'00CFFF) are to be erased. |
| 4 | EB4 | 0 | R/W | When this bit is set to 1, 32 kbytes of EB4 (H'004000 to H'00BFFF) are to be erased. |
| 3 | EB3 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB3 (H'003000 to H'003FFF) is to be erased. |
| 2 | EB2 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB2 (H'002000 to H'002FFF) is to be erased. |
| 1 | EB1 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB1 (H'001000 to H'001FFF) is to be erased. |
| 0 | EB0 | 0 | R/W | When this bit is set to 1, 4 kbytes of EB0 (H'000000 to H'000FFF) is to be erased. |

Note:* In normal mode, this bit is always read as 0 and cannot be modified.

23.6 Operating Modes

The flash memory is connected to the CPU via a 16-bit data bus, enabling byte data and word data to be accessed in a single state. Even addresses are connected to the upper 8 bits and odd addresses are connected to the lower 8 bits. Note that word data must start from an even address.

On-chip ROM is enabled or disabled by the mode select pins (MD1 and MD0) and the EXPE bit in MDCR, as summarized in table 23.3.

In normal mode (mode 3), up to 56 kbytes of ROM can be used.

Table 23.3 Operating Modes and ROM

| Operating Modes | | | Mode Pins | | MDCR | | |
|--------------------------|--|--|------------------|-----|------|-----------------------------------|--|
| MCU Operating Mode | CPU Operating Mode | Mode | MD1 | MD0 | EXPE | On-Chip ROM | |
| Mode 1 | Normal Expanded mode with on-chip ROM disabled | | 0 | 1 | 1 | Disabled | |
| Mode 2 | Advanced | Single-chip mode | 1 | 0 | 0 | Enabled (64/128/256 kbytes) | |
| | Advanced | Expanded mode with on-chip ROM enabled | 1 | 0 | 1 | | |
| Mode 3 | Normal | Single-chip mode | 1 | 1 | 0 | Enabled | |
| | Normal | Expanded mode with on-chip ROM enabled | 1 | 1 | 1 | (56 kbytes) | |

23.7 On-Board Programming Modes

An on-board programming mode is used to perform on-chip flash memory programming, erasing, and verification. This LSI has two on-board programming modes: boot mode and user program mode. Table 23.4 shows pin settings for boot mode. In user program mode, operation by software is enabled by setting control bits. For details on flash memory mode transitions, see figure 23.2.

Table 23.4 On-Board Programming Mode Settings

| Mode Setting | | MD1 | MD0 | P92 | P91 | P90 |
|--------------|------------------------|-----|-----|-----|-----|-----|
| Boot mode | | 0 | 0 | 1* | 1* | 1* |
| User program | Mode 2 (advanced mode) | 1 | 0 | | | |
| mode | Mode 3 (normal mode) | 1 | 1 | | | |

Note:* Can be used as an I/O port after the boot mode activation.

23.7.1 Boot Mode

Table 23.5 shows the boot mode operations between reset end and branching to the programming control program.

- 1. When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. Prepare a programming control program in accordance with the description in section 23.8, Flash Memory Programming/Erasing. In boot mode, if any data exists in the flash memory (except in the case that all data are 1), all blocks in the flash memory are erased. Use boot mode at initial writing in the on-board state, or forced recovery when user program mode cannot be executed because the program to be initiated in user program mode was mistakenly erased.
- 2. The SCI_1 should be set to asynchronous mode, and the transfer format as follows: 8-bit data, 1 stop bit, and no parity.
- 3. When the boot program is initiated, this LSI measures the low-level period of asynchronous SCI communication data (H'00) transmitted continuously from the host. This LSI then calculates the bit rate of transmission from the host, and adjusts the SCI_1 bit rate to match that of the host. The reset should end with the RxD1 pin high. The RxD1 and TxD1 pins should be pulled up on the board if necessary. After the reset ends, it takes approximately 100 states before this LSI is ready to measure the low-level period.
- 4. After matching the bit rates, this LSI transmits one H'00 byte to the host to indicate the end of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to this LSI. If reception could not be performed normally, initiate boot mode again by a reset. Depending on the host's transfer bit rate and system clock frequency of this LSI, there will be a discrepancy between the bit rates of the host and this LSI. To operate the SCI properly, set the host's transfer bit rate and system clock frequency of this LSI within the ranges listed in table 23.6.
- 5. In boot mode, a part of the on-chip RAM area is used by the boot program. Addresses H'FFE080 to H'FFE87F*¹ is the area to which the programming control program is transferred from the host. Note, however, that ID codes are assigned to addresses H'FFE080 to H'FFE087*². The boot program area cannot be used until the execution state in boot mode switches to the programming control program. Figure 23.8 shows the on-chip RAM area in boot mode.
- 6. Before branching to the programming control program (H'FFE088*³ in the RAM area), this LSI terminates transfer operations by the SCI_1 (by clearing the RE and TE bits in SCR to 0), but the adjusted bit rate value remains set in BRR. Therefore, the programming control program can still use it for transfer of write data or verify data with the host. The TxD1 pin is in high-level output state. The contents of the CPU general registers are undefined immediately after branching to the programming control program. These registers must be initialized at the beginning of the programming control program, since the stack pointer (SP), in particular, is used implicitly in subroutine calls, etc.

- 7. Boot mode can be cleared by a reset. Cancel the reset*⁴ after driving the reset pin low, waiting at least 20 states, and then setting the mode pins. Boot mode is also cleared when a WDT overflow occurs.
- 8. Do not change the mode pin input levels in boot mode. If mode pin input levels are changed from low to high during reset, operating modes are switched and the state of ports that are also used for address output and bus control output signals (AS, RD, and HWR) are changed*5. Therefore, set these pins carefully not to be output signals during reset or not to conflict with LSI external signals.
- 9. All interrupts are disabled during programming or erasing of the flash memory.
- Notes: 1. Address area for the H8S/2140B, H8S/2141B, H8S/2148B, H8S/2160B, and H8S/2161B. On the H8S/2145B, the address area is from H'FFD080 to H'FFD87F.
 - 2. Address area for the H8S/2140B, H8S/2141B, H8S/2148B, H8S/2160B, and H8S/2161B. On the H8S/2145B, the address area is from H'FFD080 to H'FFD087.
 - 3. RAM address for the H8S/2140B, H8S/2141B, H8S/2148B, H8S/2160B, and H8S/2161B. On the H8S/2145B, the address is H'FFD088.
 - 4. After reset is cancelled, mode pin input settings must satisfy the mode programming setup time ($t_{MDS} = 4$ states).
 - 5. The ports that also have address output functions output low as address output when the mode pins are set to mode 1 during a reset. In modes other than mode 1, it enters the high impedance state. Bus control output signals output high when the mode pins are set to mode 1 during a reset. In modes other than mode 1, it enters the high impedance state.

Table 23.5 Boot Mode Operation

| ٦ | Host Operation | Communications Contents | LSI Operation |
|---|--|--|---|
| ltem | Processing Contents | | Processing Contents |
| Boot mode start | | | Branches to boot program at reset-start. Boot program start |
| Bit rate adjustment | Continuously transmits data H'00 at specified bit rate. Transmits data H'55 when data H'00 is received error-free. Receives data H'AA. | H'00, H'00 · · · H'00 H'00 H'55 H'AA | Measures low-level period of receive data H'00. Calculates bit rate and sets it in BRR of SCI_1. Transmits data H'00 to host as adjustment end indication. After receiving data H'55, transmits data H'AA to host. |
| Transfer of programming control program | Transmits number of bytes (N) of programming control program to be transferred as 2-byte data (low-order byte following high-order byte). Transmits 1-byte of programming control program (repeated for N times). | High-order byte and low-order byte Echoback H'XX Echoback | Echobacks the 2-byte data received to host. Echobacks received data to host and also transfers it to RAM (repeated for N times). |
| Flash memory erase | Boot program erase error Receives data H'AA. ◀ | H'FF H'AA | Checks flash memory data, erases all flash memory blocks in case of written data existing, and transmits data H'AA to host. (If erase could not be done, transmits data H'FF to host and aborts operation.) |
| | | | Branches to programming control program transferred to on-chip RAM and starts execution. |

Table 23.6 System Clock Frequencies for which Automatic Adjustment of LSI Bit Rate is Possible

| Host Bit Rate | System Clock Frequency Range of LSI (3-V Version) | System Clock Frequency Range of LSI (5-V Version) |
|---------------|---|---|
| 19200 bps | 8 to 10 MHz | 8 to 20 MHz |
| 9600 bps | 4 to 10 MHz | 4 to 20 MHz |
| 4800 bps | 2 to 10 MHz | 2 to 18 MHz |

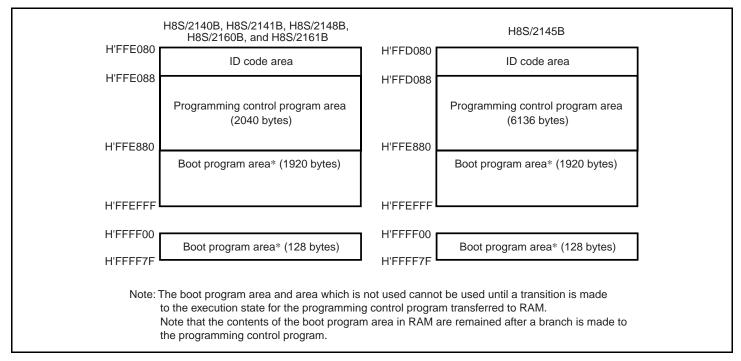


Figure 23.8 On-Chip RAM Area in Boot Mode

In boot mode, this LSI checks the contents of the 8-byte ID code area as shown below to confirm that the programming control program corresponds with this LSI. To originally write a programming control program to be used in boot mode, the above 8-byte ID code must be added at the beginning of the program.

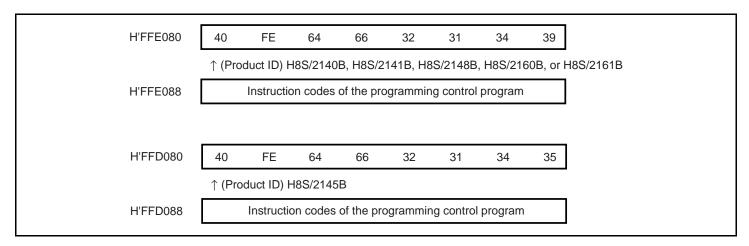


Figure 23.9 ID Code Area

23.7.2 User Program Mode

On-board programming/erasing of an individual flash memory block can also be performed in user program mode by branching to a user program/erase control program. The user must set branching conditions and provide on-board means of supplying programming data. The flash memory must contain the user program/erase control program or a program which provides the user program/erase control program from external memory. Because the flash memory itself cannot be read during programming/erasing, transfer the user program/erase control program to on-chip RAM, as like in boot mode. Figure 23.10 shows a sample procedure for programming/erasing in user program mode. Prepare a user program/erase control program in accordance with the description in section 23.8, Flash Memory Programming/Erasing.

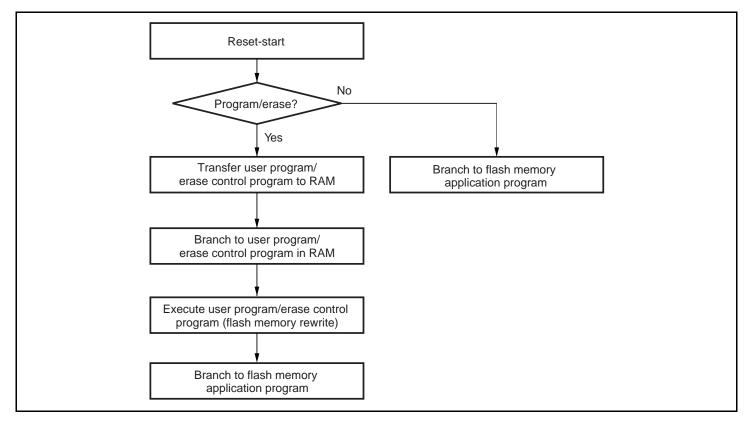


Figure 23.10 Programming/Erasing Flowchart Example in User Program Mode

23.8 Flash Memory Programming/Erasing

A software method, using the CPU, is employed to program and erase flash memory in the onboard programming modes. Depending on the FLMCR1 and FLMCR2 settings, the flash memory operates in one of the following four modes: program mode, program-verify mode, erase mode, and erase-verify mode. The programming control program in boot mode and the user program/erase control program in user program mode use these operating modes in combination to perform programming/erasing. Flash memory programming and erasing should be performed in accordance with the descriptions in section 23.8.1, Program/Program-Verify and section 23.8.2, Erase/Erase-Verify, respectively.

23.8.1 Program/Program-Verify

When writing data or programs to the flash memory, the program/program-verify flowchart shown in figure 23.11 should be followed. Performing programming operations according to this flowchart will enable data or programs to be written to the flash memory without subjecting this LSI to voltage stress or sacrificing program data reliability.

- 1. Programming must be done to an empty address. Do not reprogram an address to which programming has already been performed.
- 2. Programming should be carried out 128 bytes at a time. A 128-byte data transfer must be performed even if writing fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
- 3. Prepare the following data storage areas in RAM: a 128-byte programming data area, a 128-byte reprogramming data area, and a 128-byte additional-programming data area. Perform reprogramming data computation and additional programming data computation according to figure 23.11.
- 4. Consecutively transfer 128 bytes of data in byte units from the reprogramming data area or additional-programming data area to the flash memory. The program address and 128-byte data are latched in the flash memory. The lower 8 bits of the start address in the flash memory destination area must be H'00 or H'80.
- 5. The time during which the P bit is set to 1 is the programming time. Figure 23.11 shows the allowable programming times.
- 6. The watchdog timer (WDT) is set to prevent overprogramming due to program runaway, etc. The overflow cycle should be longer than $(y + z2 + \alpha + \beta) \mu s$.
- 7. For a dummy write to a verify address, write 1-byte data H'FF to an address whose lower 2 bits are B'00. Verify data can be read in words from the address to which a dummy write was performed.
- 8. The maximum number of repetitions of the program/program-verify sequence to the same bit is (N).

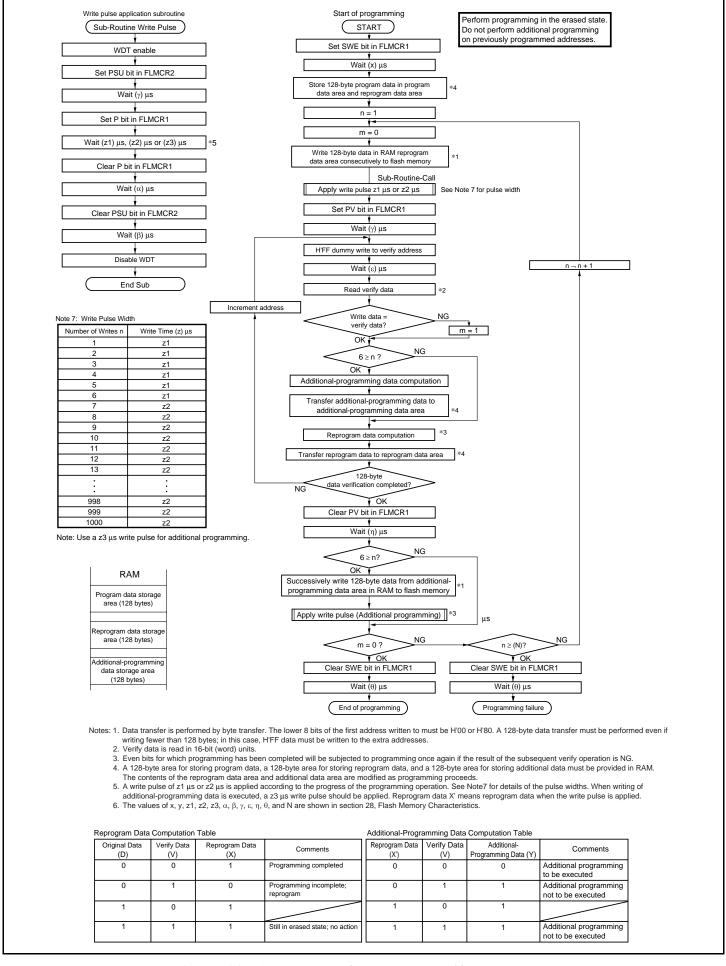


Figure 23.11 Program/Program-Verify Flowchart

23.8.2 Erase/Erase-Verify

When erasing flash memory, the erase/erase-verify flowchart shown in figure 23.12 should be followed.

- 1. Prewriting (setting erase block data to all 0) is not necessary.
- 2. Erasing is performed in block units. Make only a single-block specification in erase block registers 1 and 2 (EBR1 and EBR2). To erase multiple blocks, each block must be erased in turn.
- 3. The time during which the E bit is set to 1 is the flash memory erase time.
- 4. The watchdog timer (WDT) is set to prevent overprogramming due to program runaway, etc. An overflow cycle of approximately $(y + z + \alpha + \beta)$ ms is allowed.
- 5. For a dummy write to a verify address, write 1-byte data H'FF to an address whose lower two bits are B'00. Verify data can be read in longwords from the address to which a dummy write was performed.
- 6. If the read data is unerased, set erase mode again, and repeat the erase/erase-verify sequence as before. The maximum number of repetitions of the erase/erase-verify sequence is N.

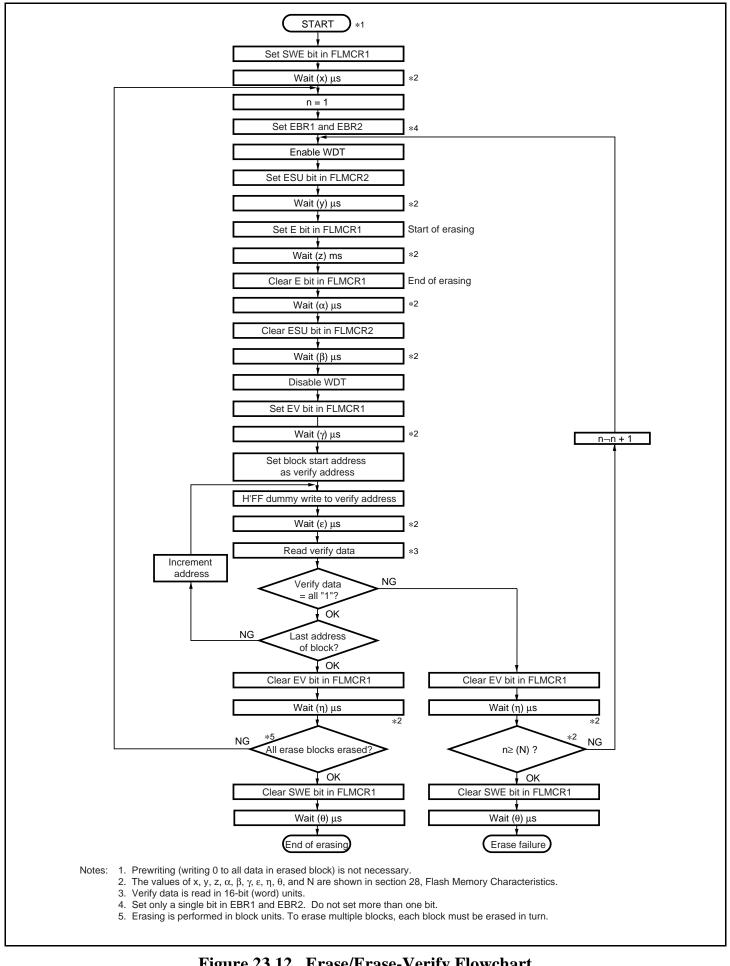


Figure 23.12 Erase/Erase-Verify Flowchart

23.9 Program/Erase Protection

There are three kinds of flash memory program/erase protection: hardware protection, software protection, and error protection.

23.9.1 Hardware Protection

Hardware protection is a state in which programming/erasing of flash memory is forcibly disabled or aborted by a reset (including WDT overflow reset), or a transition to hardware standby mode, software standby mode, sub-active mode, sub-sleep mode or watch mode. Flash memory control registers 1 and 2 (FLMCR1 and FLMCR2) and erase block registers 1 and 2 (EBR1 and EBR2) are initialized. In a reset via the \overline{RES} pin, the reset state is not entered unless the \overline{RES} pin is held low until oscillation stabilizes after powering on. In the case of a reset during operation, hold the \overline{RES} pin low for the \overline{RES} pulse width specified in the AC Characteristics section.

23.9.2 Software Protection

Software protection can be implemented against programming/erasing of all flash memory blocks by clearing the SWE bit in FLMCR1 to 0. When software protection is in effect, setting the P or E bit in FLMCR1 does not cause a transition to program mode or erase mode. By setting the erase block registers 1 and 2 (EBR1 and EBR2), erase protection can be set for individual blocks. When EBR1 and EBR2 are set to H'00, erase protection is set for all blocks.

23.9.3 Error Protection

In error protection, an error is detected when the CPU's runaway occurs during flash memory programming/erasing, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

When the following errors are detected during programming/erasing of flash memory, the FLER bit in FLMCR2 is set to 1, and the error protection state is entered.

- When the flash memory of is read during programming/erasing (including vector read and instruction fetch)
- Immediately after exception handling (excluding a reset) during programming/erasing
- When a SLEEP instruction is executed (transits to software standby mode, sleep mode, sub-active mode, sub-sleep mode, or watch mode) during programming/erasing
- When the bus ownership is released during programming/erasing

The FLMCR1, FLMCR2, EBR1, and EBR2 settings are retained, but program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be entered by setting the P or E bit to 1. However, because the PV and EV bit settings are retained, a

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transition to verify mode can be made. The error protection state can be cancelled by a reset or in hardware standby mode.

23.10 Interrupts during Flash Memory Programming/Erasing

In order to give the highest priority to programming/erasing operations, disable all interrupts including NMI input during flash memory programming/erasing (the P or E bit in FIMCR1 is set to 1) or boot program execution*¹.

- 1. If an interrupt is generated during programming/erasing, operation in accordance with the program/erase algorithm is not guaranteed.
- 2. CPU runaway may occur because normal vector reading cannot be performed in interrupt exception handling during programming/erasing*².
- 3. If an interrupt occurs during boot program execution, the normal boot mode sequence cannot be executed.
- Notes: 1. Interrupt requests must be disabled inside and outside the CPU until the programming control program has completed programming.
 - 2. The vector may not be read correctly for the following two reasons:

 If flash memory is read while being programmed or erased (while the P or E bit in FLMCR1 is set to 1), correct read data will not be obtained (undefined values will be returned).
 - If the interrupt entry in the vector table has not been programmed yet, interrupt exception handling will not be executed correctly.

23.11 Programmer Mode

In programmer mode, the on-chip flash memory can be programmed/erased by a PROM programmer via a socket adapter, just like for a discrete flash memory. Use a PROM programmer that supports the Hitachi 64/128/256-kbyte flash memory on-chip MCU device*. Figure 23.13 shows a memory map in programmer mode.

Note: For 3-V and 5-V version products, set the programming voltage of the PROM programmer to 3.3V.

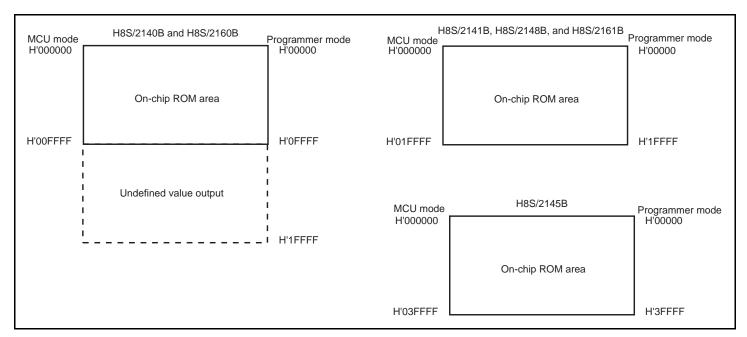


Figure 23.13 Memory Map in Programmer Mode

23.12 Usage Notes

The following lists notes on the use of on-board programming modes and programmer mode.

- Perform programming/erasing with the specified voltage and timing.
 If a voltage higher than the rated voltage is applied, the product may be fatally damaged. For 3-V and 5-V version products, use a PROM programmer that supports the Hitachi 64/128/256-kbyte flash memory on-chip MCU device at 3.3 V. Do not set the programmer to HN28F101 or the programming voltage to 5.0 V.
- 2. Notes on power on/off
 - At powering on or off the Vcc power supply, fix the RES pin to low and set the flash memory to hardware protection state. This power on/off timing must also be satisfied at a power-off and power-on caused by a power failure and other factors.
- 3. Perform flash memory programming/erasing in accordance with the recommended algorithm

- In the recommended algorithm, flash memory programming/erasing can be performed without subjecting this LSI to voltage stress or sacrificing program data reliability. When setting the P or E bit in FLMCR1 to 1, set the watchdog timer against program runaway.
- 4. Do not set/clear the SWE bit during program execution in the flash memory.
 Do not set/clear the SWE bit during program execution in the flash memory. An interval of at least 100 μs is necessary between program execution or data reading in flash memory and SWE bit clearing. When the SWE bit is set to 1, flash memory data can be modified, however,

flash memory data can be read only in program-verify or erase-verify mode. Do not access the flash memory for a purpose other than verification during programming/erasing. Do not clear the SWE bit during programming, erasing, or verifying.

- 5. Do not use interrupts during flash memory programming/erasing
 In order to give the highest priority to programming/erasing operation, disable all interrupts including NMI input when the flash memory is programmed or erased.
- 6. Do not perform additional programming. Programming must be performed in the erased state. Program the area with 128-byte programming-unit blocks in on-board programming or programmer mode only once. Perform programming in the state where the programming-unit block is fully erased.
- 7. Ensure that the PROM programmer is correctly attached before programming. If the socket, socket adapter, or product index does not match the specifications, too much current flows and the product may be damaged.
- 8. Do not touch the socket adapter or LSI while programming.

 Touching either of these can cause contact faults and write errors.

Section 24 Masked ROM

This series incorporates a 64-kbyte or 128-kbyte masked ROM. The on-chip ROM is connected to the CPU and data transfer controller (DTC) via the 16-bit data bus. The CPU and DTC can access the on-chip ROM with 8- or 16-bit width. Data in the on-chip ROM can always be accessed in one state.

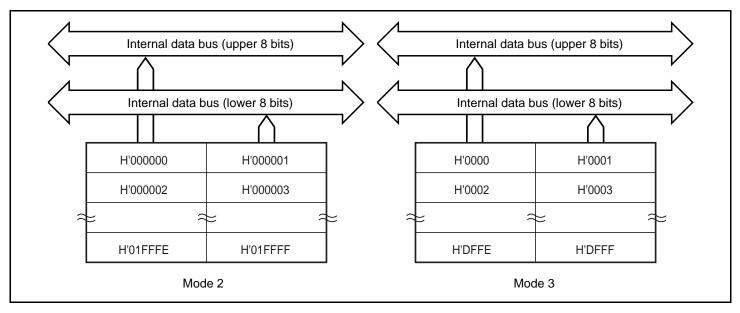


Figure 24.1 Block Diagram of 128-Kbyte Masked ROM (HD6432161BV)

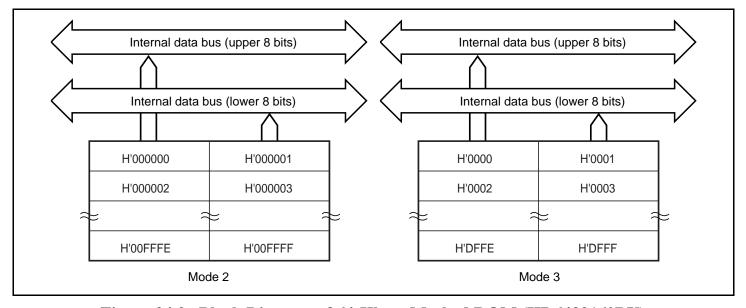


Figure 24.2 Block Diagram of 64-Kbyte Masked ROM (HD6432160BV)

The on-chip ROM is enabled or disabled according to the operating mode. The operating mode is selected by the mode select pins MD1 and MD0 as indicated in table 3.1. Select mode 2 or 3 to enable the on-chip ROM; whereas mode 1 to disable the on-chip ROM. The on-chip ROM is allocated in area 0.

Section 25 Clock Pulse Generator

This LSI incorporates a clock pulse generator, which generates the system clock (\emptyset), bus master clock, and internal clock.

The clock pulse generator consists of an oscillator, duty correction circuit, clock select circuit, medium-speed clock divider, bus master clock select circuit, subclock input circuit, and waveform forming circuit. Figure 25.1 shows a block diagram of the clock pulse generator.

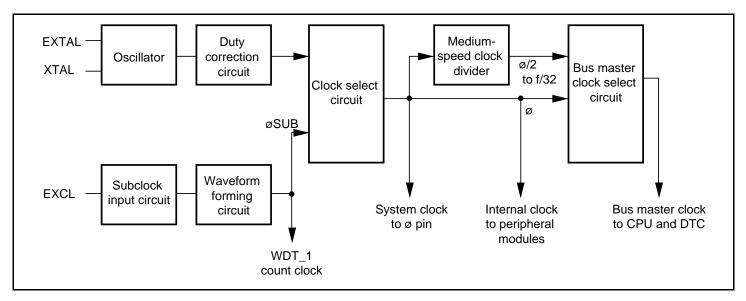


Figure 25.1 Block Diagram of Clock Pulse Generator

The bus master clock is selected as either high-speed mode or medium-speed mode by software according to the settings of the SCK2 to SCK0 bits in the standby control register. For details on the standby control register, refer to section 26.1.1, Standby Control Register (SBYCR).

The subclock input is controlled by software according to the EXCLE bit setting in the low power control register. For details on the low power control register, refer to section 26.1.2, Low Power Control Register (LPWRCR).

25.1 Oscillator

Clock pulses can be supplied either by connecting a crystal resonator, or by providing external clock input.

25.1.1 Connecting Crystal Resonator

Figure 25.2 shows a typical method of connecting a crystal resonator. An appropriate damping resistance R_d , given in table 25.1, should be used. An AT-cut parallel-resonance crystal resonator should be used.

Figure 25.3 shows the equivalent circuit of a crystal resonator. A resonator having the characteristics given in table 25.2 should be used.

A crystal resonator with frequency identical to that of the system clock (ø) should be used.

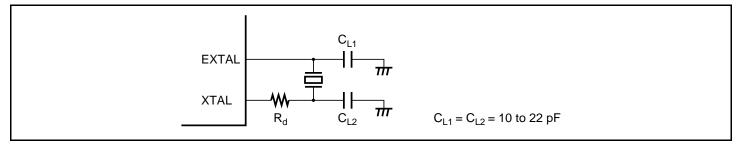


Figure 25.2 Typical Connection to Crystal Resonator

Table 25.1 Damping Resistance Values

| Frequency (MHz) | 2 | 4 | 8 | 10 | 12 | 16 | 20 |
|-----------------|-----|-----|-----|----|----|----|----|
| $R_{d}(\Omega)$ | 1 k | 500 | 200 | 0 | 0 | 0 | 0 |

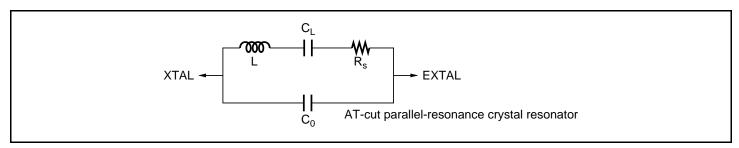


Figure 25.3 Equivalent Circuit of Crystal Resonator

 Table 25.2
 Crystal Resonator Parameters

| Frequency (MHz) | 2 | 4 | 8 | 10 | 12 | 16 | 20 | |
|---------------------------|-----|-----|----|----|----|----|----|--|
| R_s (max) (Ω) | 500 | 120 | 80 | 70 | 60 | 50 | 40 | |
| C ₀ (max) (pF) | | | | 7 | | | | |

25.1.2 External Clock Input Method

Figure 25.4 shows a typical method of connecting an external clock signal. To leave the XTAL pin open, incidental capacitance should be 10 pF or less.

To input an inverted clock to the XTAL pin, the external clock should be set to high in standby mode, subactive mode, subsleep mode, and watch mode. External clock input conditions are shown in table 25.3. The frequency of the external clock should be the same as that of the system clock (\emptyset) .

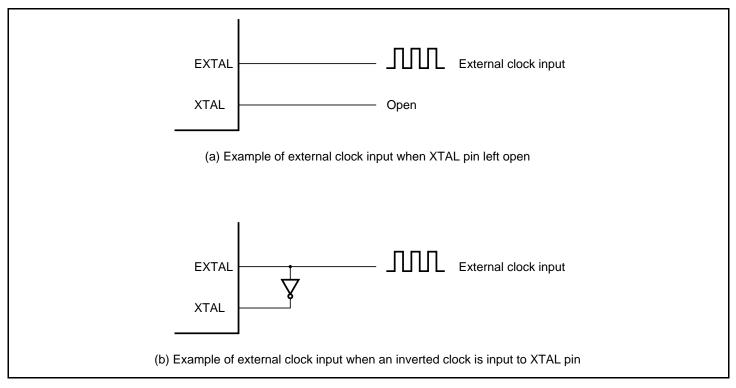


Figure 25.4 Example of External Clock Input

RENESAS

Table 25.3 External Clock Input Conditions

| | | to 3. | | ± 10 | % | _ | | |
|---|--|-------|-----|------|-----|------------------|-------------|--------|
| Item | Symbol | Min | Max | Min | Max | Unit | Test Condit | ions |
| External clock input pulse width low level | t _{EXL} | 40 | _ | 20 | _ | ns | Figure 25.5 | |
| External clock input pulse width high level | $\mathbf{t}_{\scriptscriptstyle{EXH}}$ | 40 | — | 20 | — | ns | | |
| External clock rising time | \mathbf{t}_{EXr} | _ | 10 | _ | 5 | ns | | |
| External clock falling time | \mathbf{t}_{EXf} | | 10 | _ | 5 | ns | | |
| Clock pulse width low | t _{CL} | 0.4 | 0.6 | 0.4 | 0.6 | t _{cyc} | ø≥5 MHz | Figure |
| level | | 80 | _ | 80 | _ | ns | ø < 5 MHz | 28.6 |
| Clock pulse width high | t_{\scriptscriptstyleCH} | 0.4 | 0.6 | 0.4 | 0.6 | t _{cyc} | ø≥5 MHz | |
| level | | 80 | | 80 | _ | ns | ø < 5 MHz | |

V = 5.0 V

V = 2.7

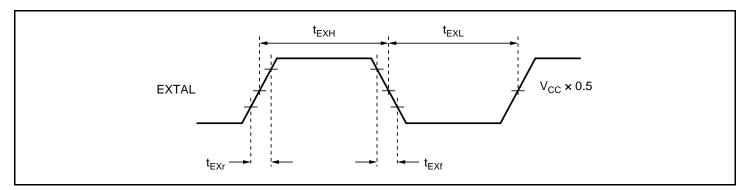


Figure 25.5 External Clock Input Timing

The oscillator and duty correction circuit have a function to adjust the waveform of the external clock input that is input to the EXTAL pin. When a specified clock signal is input to the EXTAL pin, internal clock signal output is determined after the external clock output stabilization delay time (t_{DEXT}) has passed. As the clock signal output is not determined during the t_{DEXT} cycle, a reset signal should be set to low to hold it in reset state. Table 25.4 shows the external clock output stabilization delay time. Figure 25.6 shows the timing of the external clock output stabilization delay time.

Table 25.4 External Clock Output Stabilization Delay Time

Condition: $V_{cc} = 2.7 \text{ V to } 5.5 \text{ V}, AV_{cc} = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = AV_{ss} = 0 \text{ V}$

| Item | Symbol | Min. | Max. | Unit | Remarks |
|--|---------------------|------|------|------|-------------|
| External clock output stabilization delay time | t _{DEXT} * | 500 | _ | μs | Figure 25.6 |

Note:* t_{DEXT} includes a \overline{RES} pulse width (t_{RESW}) .

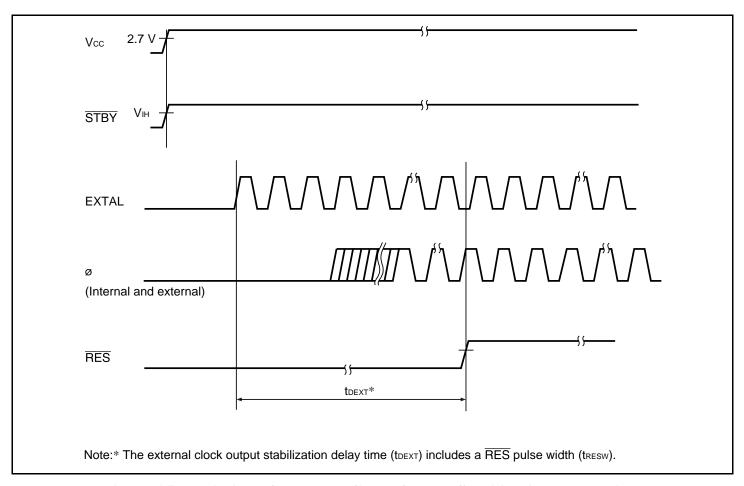


Figure 25.6 Timing of External Clock Output Stabilization Delay Time

25.2 Duty Correction Circuit

The duty correction circuit is valid when the oscillating frequency is 5 MHz or more. It corrects the duty of a clock that is output from the oscillator, and generates the system clock (ø).

25.3 Medium-Speed Clock Divider

The medium-speed clock divider divides the system clock (ϕ), and generates $\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, and $\phi/32$ clocks.

25.4 Bus Master Clock Select Circuit

The bus master clock select circuit selects a clock to supply the bus master with either the system clock (\emptyset) or medium-speed clock (\emptyset /2, \emptyset /4, \emptyset /8, \emptyset /16, or \emptyset /32) by the SCK2 to SCK0 bits in SBYCR.

25.5 Subclock Input Circuit

The subclock input circuit controls subclock input from the EXCL pin. To use the subclock, a 32.768-kHz external clock should be input from the EXCL pin. At this time, the P96DDR bit in P9DDR should be cleared to 0, and the EXCLE bit in LPWRCR should be set to 1.

Subclock input conditions are shown in table 25.5. When the subclock is not used, subclock input should not be enabled.

Table 25.5 Subclock Input Conditions

| | | V | cc = 2.7 to | 5.5 V | | Measurement |
|---------------------------------------|--------------------|-----|-------------|-------|------|-------------|
| Item | Symbol | Min | Тур | Max | Unit | Condition |
| Subclock input pulse width low level | t _{excll} | _ | 15.26 | _ | μs | Figure 25.7 |
| Subclock input pulse width high level | t _{EXCLH} | _ | 15.26 | _ | μs | _ |
| Subclock input rising time | t _{EXCLr} | _ | _ | 10 | ns | _ |
| Subclock input falling time | t _{EXCLf} | _ | _ | 10 | ns | _ |

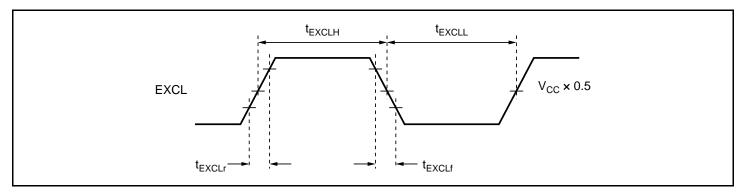


Figure 25.7 Subclock Input Timing

25.6 Subclock Waveform Forming Circuit

To remove noise from the subclock input at the EXCL pin, the subclock is sampled by a divided ø clock. The sampling frequency is set by the NESEL bit in LPWRCR.

The subclock is not sampled in subactive mode, subsleep mode, or watch mode.

25.7 Clock Select Circuit

The clock select circuit selects the system clock that is used in this LSI.

A clock generated by an oscillator to which the EXTAL and XTAL pins are input is selected as a system clock when returning from high-speed mode, medium-speed mode, sleep mode, reset state, or standby mode.

A subclock input from the EXCL pin is selected as a system clock in subactive mode, subsleep mode, or watch mode. At this time, modules such as the CPU, TMR_0, TMR_1, WDT_0, WDT_1, ports, and interrupt controller and their functions operate depending on the øSUB. The count clock and sampling clock for each timer are divided øSUB clocks.

25.8 Processing for X1 and X2 Pins

The X1 and X2 pins should be open as shown in figure 25.8.

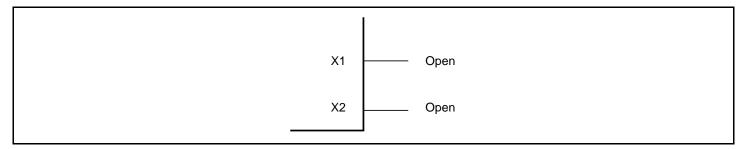


Figure 25.8 Processing for X1 and X2 Pins

25.9 Usage Notes

25.9.1 Note on Resonator

Since all kinds of characteristics of the resonator are closely related to the board design by the user, use the example of resonator connection in this document for only reference; be sure to use an resonator that has been sufficiently evaluated by the user. Consult with the resonator manufacturer about the resonator circuit ratings which vary depending on the stray capacitances of the resonator and installation circuit. Make sure the voltage applied to the oscillator pins does not exceed the maximum rating.

25.9.2 Notes on Board Design

When using a crystal resonator, the crystal resonator and its load capacitors should be placed as close as possible to the XTAL and EXTAL pins.

Other signal lines should be routed away from the oscillator circuit to prevent inductive interference with the correct oscillation as shown in figure 25.9.

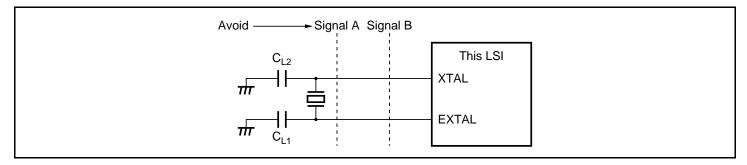


Figure 25.9 Note on Board Design of Oscillator Circuit Section

Section 26 Power-Down Modes

For operating modes after the reset state is cancelled, this LSI has not only the normal program execution state but also seven power-down modes in which power dissipation is significantly reduced. In addition, there is also module stop mode in which reduced power dissipation can be achieved by individually stopping on-chip peripheral modules.

• Medium-speed mode

System clock frequency for the CPU operation can be selected as $\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, or $\phi/32$.

• Subactive mode

The CPU operates based on the subclock and on-chip peripheral modules other than TMR_0, TMR_1, WDT_0, and WDT_1 stop operating.

• Sleep mode

The CPU stops but on-chip peripheral modules continue operating.

Subsleep mode

The CPU and on-chip peripheral modules other than TMR_0, TMR_1, WDT_0, and WDT_1 stop operating.

Watch mode

The CPU and on-chip peripheral modules other than WDT_1 stop operating.

• Software standby mode

Clock oscillation stops, and the CPU and on-chip peripheral modules stop operating.

• Hardware standby mode

Clock oscillation stops, and the CPU and on-chip peripheral modules enter reset state.

Module stop mode

Independently of above operating modes, on-chip peripheral modules that are not used can be stopped individually.

26.1 Register Descriptions

Power-down modes are controlled by the following registers. To access SBYCR, LPWRCR, MSTPCRH, and MSTPCRL, the FLSHE bit in the serial timer control register (STCR) must be cleared to 0. For details on STCR, see section 3.2.3, Serial Timer Control Register (STCR).

- Standby control register (SBYCR)
- Low power control register (LPWRCR)
- Module stop control register H (MSTPCRH)
- Module stop control register L (MSTPCRL)

26.1.1 Standby Control Register (SBYCR)

SBYCR controls power-down modes.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|--|--|---|
| 7 | SSBY | 0 | R/W | Software Standby |
| | | | | Specifies the operating mode to be entered after executing the SLEEP instruction. |
| | | | | When the SLEEP instruction is executed in high-speed mode or medium-speed mode: |
| | | | | 0: Shifts to sleep mode |
| | | | | 1: Shifts to software standby mode, subactive mode, or watch mode |
| | | | | When the SLEEP instruction is executed in subactive mode: |
| | | | | 0: Shifts to subsleep mode |
| | | | | 1: Shifts to watch mode or high-speed mode |
| | | | | Note that the SSBY bit is not changed even if a mode transition occurs by an interrupt. |
| 6 | STS2 | 0 | R/W | Standby Timer Select 2 to 0 |
| 5 | STS1 | 0 | R/W | Selects the wait time for clock stabilization from clock |
| 4 | STS0 | TS0 0 R/W oscillation start when canceling softw watch mode, or subactive mode. Sele (oscillation stabilization time) or more operating frequency. Table 26.1 show | oscillation start when canceling software standby mode, watch mode, or subactive mode. Select a wait time of 8 ms (oscillation stabilization time) or more, depending on the operating frequency. Table 26.1 shows the relationship between the STS2 to STS0 values and wait time. | |
| | | | | With an external clock, there are no specific wait requirements. Normally the minimum value is recommended. |
| 3 | | 0 | R | Reserved |
| | | | | This bit is always read as 0, and cannot be modified. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | SCK2 | 0 | R/W | System Clock Select 2 to 0 |
| 1 | SCK1 | 0 | R/W | Selects a clock for the bus master in high-speed mode or |
| 0 | SCK0 | 0 | R/W | medium-speed mode. |
| | | | | When making a transition to subactive mode or watch mode, SCK2 to SCK0 must be cleared to 0. |
| | | | | 000: High-speed mode |
| | | | | 001: Medium-speed clock: ø/2 |
| | | | | 010: Medium-speed clock: ø/4 |
| | | | | 011: Medium-speed clock: ø/8 |
| | | | | 100: Medium-speed clock: ø/16 |
| | | | | 101: Medium-speed clock: ø/32 |
| | | | | 11X: — |

Legend

X: Don't care

Table 26.1 Operating Frequency and Wait Time

| STS2 | STS1 | STS0 | Wait Time | 20 MHz | 10 MHz | 8 MHz | 6 MHz | 4 MHz | 2 MHz | Unit |
|------|------|------|---------------|--------|--------|-------|-------|-------|-------|------|
| 0 | 0 | 0 | 8192 states | 0.4 | 8.0 | 1.0 | 1.3 | 20. | 4.1 | ms |
| 0 | 0 | 1 | 16384 states | 8.0 | 1.6 | 2.0 | 2.7 | 4.1 | 8.2 | |
| 0 | 1 | 0 | 32768 states | 2.0 | 3.3 | 4.1 | 5.5 | 8.2 | 16.4 | _ |
| 0 | 1 | 1 | 65536 states | 4.1 | 6.6 | 8.2 | 10.9 | 16.4 | 32.8 | _ |
| 1 | 0 | 0 | 131072 states | 8.2 | 13.1 | 16.4 | 21.8 | 32.8 | 65.5 | _ |
| 1 | 0 | 1 | 262144 states | 16.4 | 26.2 | 32.8 | 43.6 | 65.6 | 131.2 | _ |
| 1 | 1 | 0 | Reserved | | | | | | | _ |
| 1 | 1 | 1 | 16 states* | 0.8 | 1.6 | 2.0 | 2.7 | 4.0 | 8.0 | μs |

Shaded cells indicate the recommended specification.

Note:* This setting cannot be made in the flash-memory version of this LSI.

26.1.2 Low-Power Control Register (LPWRCR)

LPWRCR controls power-down modes.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | DTON | 0 | R/W | Direct Transfer On Flag |
| | | | | Specifies the operating mode to be entered after executing the SLEEP instruction. |
| | | | | When the SLEEP instruction is executed in high-speed mode or medium-speed mode: |
| | | | | 0: Shifts to sleep mode, software standby mode, or watch mode |
| | | | | 1: Shifts directly to subactive mode, or shifts to sleep mode or software standby mode |
| | | | | When the SLEEP instruction is executed in subactive mode: |
| | | | | 0: Shifts to subsleep mode or watch mode |
| | | | | 1: Shifts directly to high-speed mode, or shifts to subsleep mode |
| 6 | LSON | 0 | R/W | Low-Speed On Flag |
| | | | | Specifies the operating mode to be entered after executing the SLEEP instruction. This bit also controls whether to shift to high-speed mode or subactive mode when watch mode is cancelled. |
| | | | | When the SLEEP instruction is executed in high-speed mode or medium-speed mode: |
| | | | | 0: Shifts to sleep mode, software standby mode, or watch mode |
| | | | | 1: Shifts to watch mode or subactive mode |
| | | | | When the SLEEP instruction is executed in subactive mode: |
| | | | | 0: Shifts directly to watch mode or high-speed mode |
| | | | | 1: Shifts to subsleep mode or watch mode |
| | | | | When watch mode is cancelled: |
| | | | | 0: Shifts to high-speed mode |
| | | | | 1: Shifts to subactive mode |

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 5 | NESEL | 0 | R/W | Noise Elimination Sampling Frequency Select |
| | | | | Selects the frequency by which the subclock (ØSUB) input from the EXCL pin is sampled using the clock (Ø) generated by the system clock pulse generator. Clear this bit to 0 when Ø is 5 MHz or more. |
| | | | | 0: Sampling using ø/32 clock |
| | | | | 1: Sampling using ø/4 clock |
| 4 | EXCLE | 0 | R/W | Subclock Input Enable |
| | | | | Enables/disables subclock input from the EXCL pin. |
| | | | | 0: Disables subclock input from the EXCL pin |
| | | | | 1: Enables subclock input from the EXCL pin |
| 3 | | 0 | R/W | Reserved |
| | | | | An undefined value is read from this bit. This bit should not be set to 1. |
| 2 to 0 | | All 0 | R | Reserved |
| | | | | These bits are always read as 0 and cannot be modified. |

26.1.3 Module Stop Control Registers H and L (MSTPCRH, MSTPCRL)

MSTPCRH and MSTPCRL specify on-chip peripheral modules to shift to module stop mode in module units. Each module can enter module stop mode by setting the corresponding bit to 1.

MSTPCRH

| Bit | Bit Name | Initial Value | R/W | Corresponding Module |
|-----|----------|---------------|-----|--|
| 7 | MSTP15 | 0* | R/W | |
| 6 | MSTP14 | 0 | R/W | Data transfer controller (DTC) |
| 5 | MSTP13 | 1 | R/W | 16-bit free-running timer (FRT) |
| 4 | MSTP12 | 1 | R/W | 8-bit timers (TMR_0, TMR_1) |
| 3 | MSTP11 | 1 | R/W | 8-bit PWM timer (PWM), 14-bit PWM timer (PWMX) |
| 2 | MSTP10 | 1 | R/W | D/A converter |
| 1 | MSTP9 | 1 | R/W | A/D converter |
| 0 | MSTP8 | 1 | R/W | 8-bit timers (TMR_X, TMR_Y), timer connection |

Note:* Do not set this bit to 1.

MSTPCRL

| Bit | Bit Name | Initial Value | R/W | Corresponding Module |
|-----|----------|---------------|-----|--|
| 7 | MSTP7 | 1 | R/W | Serial communication interface_0 (SCI_0) |
| 6 | MSTP6 | 1 | R/W | Serial communication interface_1 (SCI_1) |
| 5 | MSTP5 | 1 | R/W | Serial communication interface_2 (SCI_2) |
| 4 | MSTP4 | 1 | R/W | I ² C bus interface_0 (IIC_0) |
| 3 | MSTP3 | 1 | R/W | I ² C bus interface_1 (IIC_1) |
| 2 | MSTP2 | 1 | R/W | Host interface (XBS), keyboard buffer controller, keyboard matrix interrupt mask register (KMIMR), keyboard matrix interrupt mask register A (KMIMRA), port 6 pull-up MOS control register (KMPCR) |
| 1 | MSTP1 | 1* | R/W | _ |
| 0 | MSTP0 | 1 | R/W | Host interface (LPC), wake-up event interrupt mask register B (WUEMRB) |

Note:* This bit can be read from or written to, however, operation is not affected.

26.2 Mode Transitions and LSI States

Figure 26.1 shows the enabled mode transition diagram. The mode transition from program execution state to program halt state is performed by the SLEEP instruction. The mode transition from program halt state to program execution state is performed by an interrupt. The \overline{STBY} input causes a mode transition from any state to hardware standby mode. The \overline{RES} input causes a mode transition from a state other than hardware standby mode to the reset state. Table 26.2 shows the LSI internal states in each operating mode.

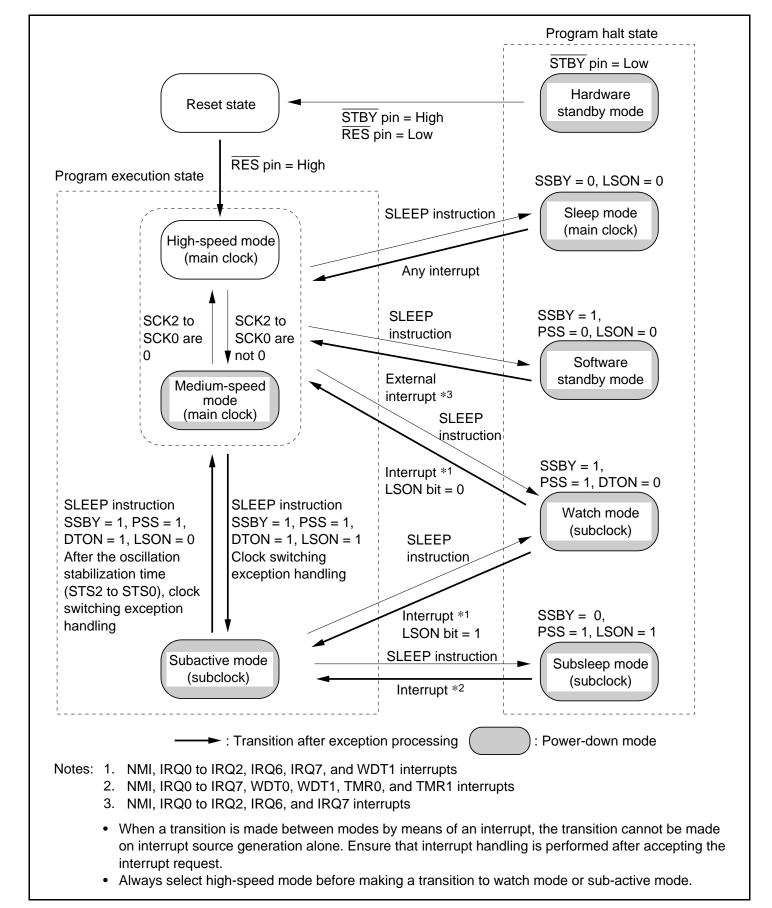


Figure 26.1 Mode Transition Diagram

Table 26.2 LSI Internal States in Each Mode

| Function | | High- Speed | Medium- Speed | Sleep | Module Stop | Watch | Sub- Active | Sub- Sleep | Software Standby | Hardward Standby |
|-------------------------|-----------------------|------------------|-------------------------------|------------------|---------------------------------------|----------------------|----------------------|----------------------|----------------------|---------------------|
| System clo generator | ck pulse | Function- ing | Function- ing | Function- ing | Function- ing | Halted | Halted | Halted | Halted | Halted |
| Subclock p generator | ulse | Function- ing | Function- ing | Function- ing | Function- ing | Function- ing | Function- ing | Function- ing | Halted | Halted |
| CPU | Instruction execution | Function- ing | Medium- speed | Halted | Function- ing | Halted | Subclock operation | Halted | Halted | Halted |
| | Registers | = | operation | Retained | _ | Retained | - | Retained | Retained | Undefined |
| External | NMI | Function- | Function- | Function- | Function- | Function- | Function- | Function- | Function- | Halted |
| interrupts | IRQ0 to IRQ7 | ing - | ing | ing | ing | ing | ing | ing | ing | |
| | KIN0 to KIN15 | _ | | | | | | | | |
| WUE0 WUE7 | WUE0 to WUE7 | _ | | | | | | | | |
| Peripheral modules | DTC | Function- ing | Medium- speed operation | Function- ing | Function- ing/Halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (retained) | Halted (reset) |
| | WDT_1 | _ | Function-ing | _ | Function- ing | Subclock operation | Subclock operation | | _ | |
| | WDT_0 | = | | | | Halted | - | | | |
| | TMR_0, TMR_1 | _ | | | Function- ing/Halted | (retained) | | | | |
| | FRT | _ | | | (retained) | | Halted | Halted | _ | |
| | TMR_X, TMR_Y | _ | | | | | (retained) | (retained) | | |
| | Timer connection | _ | | | | | | | | |
| | IIC_0 | _ | | | | | | | | |
| | IIC_1 | _ | | | | | | | | |
| | LPC | _ | | | | | | | | |
| | SCI_0 | _ | | | Function- | Halted | Halted | Halted | Halted | = |
| | SCI_1 | _ | | | ing/Halted (reset) | (reset) | (reset) | (reset) | (reset) | |
| | SCI_2 | _ | | | (10001) | | | | | |

| Function | | High- Speed | Medium- Speed | Sleep | Module Stop | Watch | Sub- Active | Sub- Sleep | Software Standby | Hardware Standby |
|------------|--|----------------|------------------|------------------------|--------------------|----------|------------------|-------------------|---------------------|---------------------|
| Peripheral | PWM | Function- | Function- | Function- | Function- | Halted | Halted | Halted (reset) | Halted (reset) | Halted (reset) |
| modules | PWMX | ing ing | ing | ing | ing/Halted (reset) | (reset) | (reset) | | | |
| | XBS, Keyboard buffer controller | _ | | | (1111) | | | | | |
| | D/A | _ | | | | | | | | |
| | A/D | _ | | | | | | | | |
| | RAM | _ | | Function- ing (DTC) | Function- ing | Retained | Function- ing | Retained | Retained | Retained |
| | I/O | _ | | Function- ing | Function- ing | Retained | Function- ing | Function- ing | Retained | High impedance |

Note:* "Halted (retained)" means that internal register values are retained. The internal state is "operation suspended."

"Halted (reset)" means that internal register values and internal states are initialized. In module stop mode, only modules for which a stop setting has been made are halted (reset or retained).

26.3 Medium-Speed Mode

The CPU makes a transition to medium-speed mode as soon as the current bus cycle ends according to the setting of the SCK2 to SCK0 bits in SBYCR. In medium-speed mode, the CPU operates on the operating clock ($\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, or $\phi/32$). On-chip peripheral modules other than the bus masters always operate on the system clock (ϕ).

In medium-speed mode, a bus access is executed in the specified number of states with respect to the bus master operating clock. For example, if $\emptyset/4$ is selected as the operating clock, on-chip memory is accessed in 4 states, and internal I/O registers in 8 states.

By clearing all of bits SCK2 to SCK0 to 0, a transition is made to high-speed mode at the end of the current bus cycle.

If a SLEEP instruction is executed when the SSBY bit in SBYCR is cleared to 0, and the LSON bit in LPWRCR is cleared to 0, a transition is made to sleep mode. When sleep mode is cleared by an interrupt, medium-speed mode is restored. When the SLEEP instruction is executed with the SSBY bit set to 1, the LSON bit cleared to 0, and the PSS bit in TCSR (WDT_1) cleared to 0, operation shifts to software standby mode. When software standby mode is cleared by an external interrupt, medium-speed mode is restored.

When the RES pin is set low and medium-speed mode is cancelled, operation shifts to the reset state. The same applies in the case of a reset caused by overflow of the watchdog timer.

When the \overline{STBY} pin is driven low, medium-speed mode is cancelled and a transition is made to hardware standby mode.

Figure 26.2 shows an example of medium-speed mode timing.

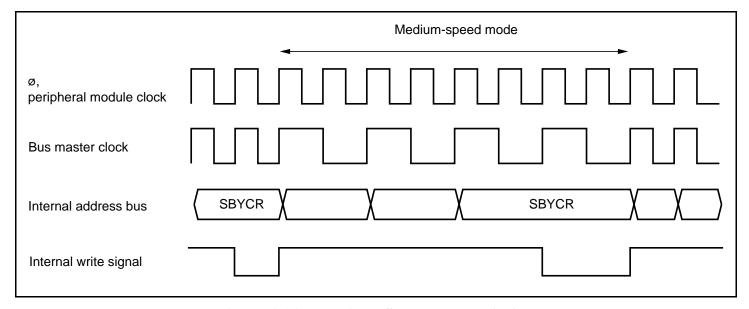


Figure 26.2 Medium-Speed Mode Timing

26.4 Sleep Mode

The CPU makes a transition to sleep mode if the SLEEP instruction is executed when the SSBY bit in SBYCR is cleared to 0 and the LSON bit in LPWRCR is cleared to 0. In sleep mode, CPU operation stops but the peripheral modules do not stop. The contents of the CPU's internal registers are retained.

Sleep mode is exited by any interrupt, the \overline{RES} pin, or the \overline{STBY} pin.

When an interrupt occurs, sleep mode is exited and interrupt exception handling starts. Sleep mode is not exited if the interrupt is disabled, or interrupts other than NMI are masked by the CPU.

Setting the RES pin level low cancels sleep mode and selects the reset state. After the oscillation stabilization time has passed, driving the \overline{RES} pin high causes the CPU to start reset exception handling.

When the STBY pin level is driven low, sleep mode is cancelled and a transition is made to hardware standby mode.

26.5 Software Standby Mode

The CPU makes a transition to software standby mode when the SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1, the LSON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT_1) is cleared to 0.

In software standby mode, the CPU, on-chip peripheral modules, and clock pulse generator all stop. However, the contents of the CPU's internal registers, on-chip RAM data, I/O ports, and the states of on-chip peripheral modules other than the SCI, PWM, and PWMX, are retained as long as the prescribed voltage is supplied.

Software standby mode is cleared by an external interrupt (NMI, IRQ0 to IRQ2, IRQ6, or IRQ7), the RES pin input, or STBY pin input.

When an external interrupt request signal is input, system clock oscillation starts, and after the elapse of the time set in bits STS2 to STS0 in SBYCR, software standby mode is cleared, and interrupt exception handling is started. When clearing software standby mode with an IRQ0 to IRQ2, IRQ6, or IRQ7 interrupt, set the corresponding enable bit to 1 and ensure that no interrupt with a higher priority than interrupts IRQ0 to IRQ2, IRQ6, and IRQ7 is generated. Software standby mode cannot be cleared if an interrupt enable bit corresponding to an IRQ0 to IRQ2, IRQ6, or IRQ7 interrupt is cleared to 0 or if the interrupt has been masked on the CPU side.

When the RES pin is driven low, system clock oscillation is started. At the same time as system clock oscillation starts, the system clock is supplied to the entire LSI. Note that the \overline{RES} pin must be held low until clock oscillation stabilizes. When the \overline{RES} pin goes high after clock oscillation stabilizes, the CPU begins reset exception handling.

When the STBY pin is driven low, software standby mode is cancelled and a transition is made to hardware standby mode.

Figure 26.3 shows an example in which a transition is made to software standby mode at the falling edge of the NMI pin, and software standby mode is cleared at the rising edge of the NMI pin.

In this example, an NMI interrupt is accepted with the NMIEG bit in SYSCR cleared to 0 (falling edge specification), then the NMIEG bit is set to 1 (rising edge specification), the SSBY bit is set to 1, and a SLEEP instruction is executed, causing a transition to software standby mode.

Software standby mode is then cleared at the rising edge of the NMI pin.

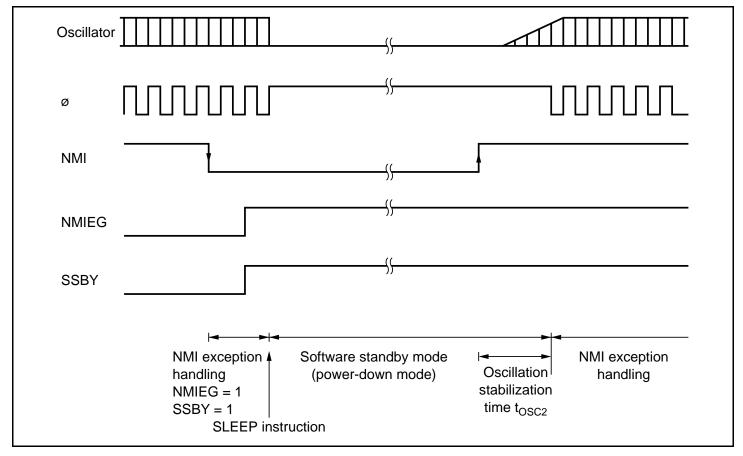


Figure 26.3 Application Example in Software Standby Mode

26.6 Hardware Standby Mode

The CPU makes a transition to hardware standby mode from any mode when the STBY pin is driven low.

In hardware standby mode, all functions enter the reset state. As long as the prescribed voltage is supplied, on-chip RAM data is retained. The I/O ports are set to the high-impedance state.

In order to retain on-chip RAM data, the RAME bit in SYSCR should be cleared to 0 before driving the STBY pin low. Do not change the state of the mode pins (MD1 and MD0) while this LSI is in hardware standby mode.

Hardware standby mode is cleared by the \overline{STBY} pin input or the \overline{RES} pin input.

When the \overline{STBY} pin is driven high while the \overline{RES} pin is low, clock oscillation is started. Ensure that the \overline{RES} pin is held low until system clock oscillation stabilizes. When the \overline{RES} pin is subsequently driven high after the clock oscillation stabilization time has passed, reset exception handling starts.

Figure 26.4 shows an example of hardware standby mode timing.

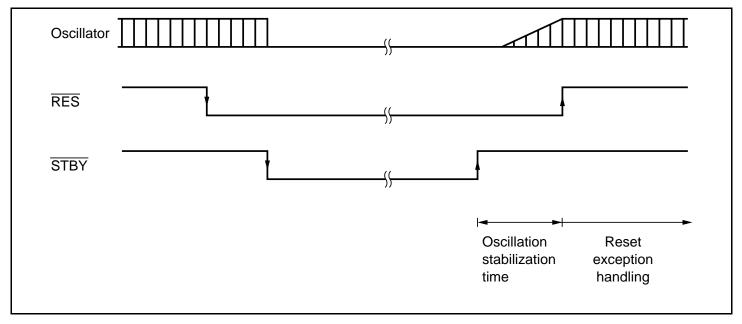


Figure 26.4 Hardware Standby Mode Timing

26.7 Watch Mode

The CPU makes a transition to watch mode when the SLEEP instruction is executed in high-speed mode or subactive mode with the SSBY bit in SBYCR set to 1, the DTON bit in LPWRCR cleared to 0, and the PSS bit in TCSR (WDT_1) set to 1.

In watch mode, the CPU is stopped and peripheral modules other than WDT_1 are also stopped. The contents of the CPU's internal registers, several on-chip peripheral module registers, and on-chip RAM data are retained and the I/O ports retain their values before transition as long as the prescribed voltage is supplied.

Watch mode is exited by an interrupt (WOVI1, NMI, IRQ0 to IRQ2, IRQ6, or IRQ7), RES pin input, or STBY pin input.

When an interrupt occurs, watch mode is exited and a transition is made to high-speed mode or medium-speed mode when the LSON bit in LPWRCR cleared to 0 or to subactive mode when the LSON bit is set to 1. When a transition is made to high-speed mode, a stable clock is supplied to the entire LSI and interrupt exception handling starts after the time set in the STS2 to STS0 bits in SBYCR has elapsed. In the case of an IRQ0 to IRQ2, IRQ6, or IRQ7 interrupt, watch mode is not exited if the corresponding enable bit has been cleared to 0. In the case of interrupts from the on-chip peripheral modules, watch mode is not exited if the interrupt enable register has been set to disable the reception of that interrupt, or the interrupt is masked by the CPU.

When the RES pin is driven low, system clock oscillation starts. Simultaneously with the start of system clock oscillation, the system clock is supplied to the entire LSI. Note that the \overline{RES} pin must

be held low until clock oscillation is stabilized. If the \overline{RES} pin is driven high after the clock oscillation stabilization time has passed, the CPU begins reset exception handling.

If the STBY pin is driven low, the LSI enters hardware standby mode.

26.8 Subsleep Mode

The CPU makes a transition to subsleep mode when the SLEEP instruction is executed in subactive mode with the SSBY bit in SBYCR cleared to 0, the LSON bit in LPWRCR set to 1, and the PSS bit in TCSR (WDT_1) set to 1.

In subsleep mode, the CPU is stopped. Peripheral modules other than TMR_0, TMR_1, WDT_0, and WDT_1 are also stopped. The contents of the CPU's internal registers, several on-chip peripheral module registers, and on-chip RAM data are retained and the I/O ports retain their values before transition as long as the prescribed voltage is supplied.

Subsleep mode is exited by an interrupt (interrupts by on-chip peripheral modules, NMI, IRQ0 to IRQ7), the \overline{RES} pin input, or the \overline{STBY} pin input.

When an interrupt occurs, subsleep mode is exited and interrupt exception handling starts.

In the case of an IRQ0 to IRQ7 interrupt, subsleep mode is not exited if the corresponding enable bit has been cleared to 0. In the case of interrupts from the on-chip peripheral modules, subsleep mode is not exited if the interrupt enable register has been set to disable the reception of that interrupt, or the interrupt is masked by the CPU.

When the \overline{RES} pin is driven low, system clock oscillation starts. Simultaneously with the start of system clock oscillation, the system clock is supplied to the entire LSI. Note that the \overline{RES} pin must be held low until clock oscillation is stabilized. If the \overline{RES} pin is driven high after the clock oscillation stabilization time has passed, the CPU begins reset exception handling.

If the STBY pin is driven low, the LSI enters hardware standby mode.

26.9 Subactive Mode

The CPU makes a transition to subactive mode when the SLEEP instruction is executed in high-speed mode with the SSBY bit in SBYCR set to 1, the DTON bit and LSON bit in LPWRCR set to 1, and the PSS bit in TCSR (WDT_1) set to 1. When an interrupt occurs in watch mode, and if the LSON bit in LPWRCR is 1, a direct transition is made to subactive mode. Similarly, if an interrupt occurs in subsleep mode, a transition is made to subactive mode.

In subactive mode, the CPU operates at a low speed based on the subclock and sequentially executes programs. Peripheral modules other than TMR_0, TMR_1, WDT_0, and WDT_1 are also stopped.

When operating the CPU in subactive mode, the SCK2 to SCK0 bits in SBYCR must be cleared to 0.

Subactive mode is exited by the SLEEP instruction, RES pin input, or STBY pin input.

When the SLEEP instruction is executed with the SSBY bit in SBYCR set to 1, the DTON bit in LPWRCR cleared to 0, and the PSS bit in TCSR (WDT_1) set to 1, the CPU exits subactive mode and a transition is made to watch mode. When the SLEEP instruction is executed with the SSBY bit in SBYCR cleared to 0, the LSON bit in LPWRCR set to 1, and the PSS bit in TCSR (WDT_1) set to 1, a transition is made to subsleep mode. When the SLEEP instruction is executed with the SSBY bit in SBYCR set to 1, the DTON bit and LSON bit in LPWRCR set to 10, and the PSS bit in TCSR (WDT_1) set to 1, a direct transition is made to high-speed mode.

For details of direct transitions, see section 26.11, Direct Transitions.

When the \overline{RES} pin is driven low, system clock oscillation starts. Simultaneously with the start of system clock oscillation, the system clock is supplied to the entire LSI. Note that the \overline{RES} pin must be held low until the clock oscillation is stabilized. If the \overline{RES} pin is driven high after the clock oscillation stabilization time has passed, the CPU begins reset exception handling.

If the \overline{STBY} pin is driven low, the LSI enters hardware standby mode.

26.10 Module Stop Mode

Module stop mode can be individually set for each on-chip peripheral module.

When the corresponding MSTP bit in MSTPCR is set to 1, module operation stops at the end of the bus cycle and a transition is made to module stop mode. In turn, when the corresponding MSTP bit is cleared to 0, module stop mode is cancelled and the module operation resumes at the end of the bus cycle. In module stop mode, the internal states of modules other than the SCI, D/A converter, A/D converter, PWM, and PWMX are retained.

After the reset state is cancelled, all modules other than DTC are in module stop mode.

While an on-chip peripheral module is in module stop mode, read/write access to its registers is disabled.

26.11 Direct Transitions

The CPU executes programs in three modes: high-speed, medium-speed, and subactive. When a direct transition is made from high-speed mode to subactive mode, there is no interruption of program execution. A direct transition is enabled by setting the DTON bit in LPWRCR to 1 and then executing the SLEEP instruction. After a transition, direct transition exception handling starts.

The CPU makes a transition to subactive mode when the SLEEP instruction is executed in high-speed mode with the SSBY bit in SBYCR set to 1, the LSON bit and DTON bit in LPWRCR set to 11, and the PSS bit in TSCR (WDT_1) set to 1.

To make a direct transition to high-speed mode after the time set in the STS2 to STS0 bits in SBYCR has elapsed, execute the SLEEP instruction in subactive mode with the SSBY bit in SBYCR set to 1, the LSON bit and DTON bit in LPWRCR set to 01, and the PSS bit in TSCR (WDT_1) set to 1.

26.12 Usage Notes

26.12.1 I/O Port Status

The status of the I/O ports is retained in software standby mode. Therefore, when a high level is output, the current consumption is not reduced by the amount of current to support the high level output.

26.12.2 Current Consumption when Waiting for Oscillation Stabilization

The current consumption increases during oscillation stabilization.

26.12.3 DTC Module Stop Mode

If the DTC module stop mode specification and DTC bus request occur simultaneously, the bus is released to the DTC and the MSTP bit cannot be set to 1. After completing the DTC bus cycle, set the MSTP bit to 1 again.

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Section 27 List of Registers

The register list gives information on the on-chip I/O register addresses, how the register bits are configured, and the register states in each operating mode. The information is given as shown below.

- 1. Register Addresses (address order)
- Registers are listed from the lower allocation addresses.
- The MSB-side address is indicated for 16-bit addresses.
- Registers are classified by functional modules.
- The access size is indicated.
- 2. Register Bits
- Bit configurations of the registers are described in the same order as the Register Addresses (address order) above.
- Reserved bits are indicated by in the bit name column.
- The bit number in the bit-name column indicates that the whole register is allocated as a counter or for holding data.
- 16-bit registers are indicated from the bit on the MSB side.
- 3. Register States in Each Operating Mode
- Register states are described in the same order as the Register Addresses (address order) above.
- The register states described here are for the basic operating modes. If there is a specific reset for an on-chip peripheral module, refer to the section on that on-chip peripheral module.
- 4. Register Select Conditions
- Register states are described in the same order as the Register Addresses (address order) above.
- For details on the register select conditions, refer to section 3.2.2, System Control Register (SYSCR), 3.2.3, Serial Timer Control Register (STCR), 26.1.3, Module Stop Control Registers H, L (MSTPCRH, MSTPCRL), and the register descriptions for each module.

27.1 Register Addresses (Address Order)

The data bus width indicates the numbers of bits by which the register is accessed.

The number of access states indicates the number of states based on the specified reference clock.

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|------------------------------------|--------------|-------------------|---------|--------|----------------------|----------------------------------|
| Port G open drain control register | PGNOCR*1 | 8 | H'FE16 | PORT | 8 | 3 |
| Port E open drain control register | PENOCR*1 | 8 | H'FE18 | PORT | 8 | 3 |
| Port F open drain control register | PFNOCR*1 | 8 | H'FE19 | PORT | 8 | 3 |
| Port C open drain control register | PCNOCR*1 | 8 | H'FE1C | PORT | 8 | 3 |
| Port D open drain control register | PDNOCR*1 | 8 | H'FE1D | PORT | 8 | 3 |
| Bidirectional data register 0MW | TWR0MW | 8 | H'FE20 | LPC | 8 | 3 |
| Bidirectional data register 0SW | TWR0SW | 8 | H'FE20 | LPC | 8 | 3 |
| Bidirectional data register 1 | TWR1 | 8 | H'FE21 | LPC | 8 | 3 |
| Bidirectional data register 2 | TWR2 | 8 | H'FE22 | LPC | 8 | 3 |
| Bidirectional data register 3 | TWR3 | 8 | H'FE23 | LPC | 8 | 3 |
| Bidirectional data register 4 | TWR4 | 8 | H'FE24 | LPC | 8 | 3 |
| Bidirectional data register 5 | TWR5 | 8 | H'FE25 | LPC | 8 | 3 |
| Bidirectional data register 6 | TWR6 | 8 | H'FE26 | LPC | 8 | 3 |
| Bidirectional data register 7 | TWR7 | 8 | H'FE27 | LPC | 8 | 3 |
| Bidirectional data register 8 | TWR8 | 8 | H'FE28 | LPC | 8 | 3 |
| Bidirectional data register 9 | TWR9 | 8 | H'FE29 | LPC | 8 | 3 |
| Bidirectional data register 10 | TWR10 | 8 | H'FE2A | LPC | 8 | 3 |
| Bidirectional data register 11 | TWR11 | 8 | H'FE2B | LPC | 8 | 3 |
| Bidirectional data register 12 | TWR12 | 8 | H'FE2C | LPC | 8 | 3 |
| Bidirectional data register 13 | TWR13 | 8 | H'FE2D | LPC | 8 | 3 |
| Bidirectional data register 14 | TWR14 | 8 | H'FE2E | LPC | 8 | 3 |
| Bidirectional data register 15 | TWR15 | 8 | H'FE2F | LPC | 8 | 3 |
| Input data register 3 | IDR3 | 8 | H'FE30 | LPC | 8 | 3 |
| Output data register 3 | ODR3 | 8 | H'FE31 | LPC | 8 | 3 |
| Status register 3 | STR3 | 8 | H'FE32 | LPC | 8 | 3 |
| LPC channel address register H | LADR3H | 8 | H'FE34 | LPC | 8 | 3 |
| LPC channel address register L | LADR3L | 8 | H'FE35 | LPC | 8 | 3 |
| SERIRQ control register 0 | SIRQCR0 | 8 | H'FE36 | LPC | 8 | 3 |
| SERIRQ control register 1 | SIRQCR1 | 8 | H'FE37 | LPC | 8 | 3 |
| Input data register 1 | IDR1 | 8 | H'FE38 | LPC | 8 | 3 |
| Output data register 1 | ODR1 | 8 | H'FE39 | LPC | 8 | 3 |
| Status register 1 | STR1 | 8 | H'FE3A | LPC | 8 | 3 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|--|---------------------|-------------------|-------------------|--------|----------------------|----------------------------------|
| Input data register 2 | IDR2 | 8 | H'FE3C | LPC | 8 | 3 |
| Output data register 2 | ODR2 | 8 | H'FE3D | LPC | 8 | 3 |
| Status register 2 | STR2 | 8 | H'FE3E | LPC | 8 | 3 |
| Host interface select register | HISEL | 8 | H'FE3F | LPC | 8 | 3 |
| Host interface control register 0 | HICR0 | 8 | H'FE40 | LPC | 8 | 3 |
| Host interface control register 1 | HICR1 | 8 | H'FE41 | LPC | 8 | 3 |
| Host interface control register 2 | HICR2 | 8 | H'FE42 | LPC | 8 | 3 |
| Host interface control register 3 | HICR3 | 8 | H'FE43 | LPC | 8 | 3 |
| Wakeup event interrupt mask register B | WUEMRB*2 | 8 | H'FE44 | INT | 8 | 3 |
| Port G output data register | PGODR*1 | 8 | H'FE46 | PORT | 8 | 3 |
| Port G input data register | PGPIN*1 | 8 | H'FE47 (read) | PORT | 8 | 3 |
| Port G data direction register | PGDDR* ¹ | 8 | H'FE47 (write) | PORT | 8 | 3 |
| Port E output data register | PEODR*1 | 8 | H'FE48 | PORT | 8 | 3 |
| Port F output data register | PFODR*1 | 8 | H'FE49 | PORT | 8 | 3 |
| Port E input data register | PEPIN*1 | 8 | H'FE4A (read) | PORT | 8 | 3 |
| Port E data direction register | PEDDR* ¹ | 8 | H'FE4A (write) | PORT | 8 | 3 |
| Port F input data register | PFPIN*1 | 8 | H'FE4B (read) | PORT | 8 | 3 |
| Port F data direction register | PFDDR*1 | 8 | H'FE4B (write) | PORT | 8 | 3 |
| Port C output data register | PCODR*1 | 8 | H'FE4C | PORT | 8 | 3 |
| Port D output data register | PDODR*1 | 8 | H'FE4D | PORT | 8 | 3 |
| Port C input data register | PCPIN*1 | 8 | H'FE4E (read) | PORT | 8 | 3 |
| Port C data direction register | PCDDR*1 | 8 | H'FE4E (write) | PORT | 8 | 3 |
| Port D input data register | PDPIN*1 | 8 | H'FE4F (read) | PORT | 8 | 3 |
| Port D data direction register | PDDDR* ¹ | 8 | H'FE4F (write) | PORT | 8 | 3 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Bus Width | Number of Access States |
|--|--------------|----------------|---------|--|--------------|----------------------------------|
| Host interface control register 2 | HICR2 | 8 | H'FE80 | XBS | 8 | 2 |
| Input data register_3 | IDR_3 | 8 | H'FE81 | XBS | 8 | 2 |
| Output data register_3 | ODR_3 | 8 | H'FE82 | XBS | 8 | 2 |
| Status register_3 | STR_3 | 8 | H'FE83 | XBS | 8 | 2 |
| Input data register_4 | IDR_4 | 8 | H'FE84 | XBS | 8 | 2 |
| Output data register_4 | ODR_4 | 8 | H'FE85 | XBS | 8 | 2 |
| Status register_4 | STR_4 | 8 | H'FE86 | XBS | 8 | 2 |
| I ² C bus extended control register_0 | ICXR_0 | 8 | H'FED4 | IIC_0 | 8 | 2 |
| I ² C bus extended control register_1 | ICXR_1 | 8 | H'FED5 | IIC_1 | 8 | 2 |
| Keyboard control register H_0 | KBCRH_0 | 8 | H'FED8 | Keyboard buffer controller_ 0 | 8 | 2 |
| Keyboard control register L_0 | KBCRL_0 | 8 | H'FED9 | Keyboard buffer controller_ 0 | 8 | 2 |
| Keyboard data buffer register_0 | KBBR_0 | 8 | H'FEDA | Keyboard buffer controller_ 0 | 8 | 2 |
| Keyboard control register H_1 | KBCRH_1 | 8 | H'FEDC | Keyboard buffer controller_ 1 | 8 | 2 |
| Keyboard control register L_1 | KBCRL_1 | 8 | H'FEDD | Keyboard buffer controller_ 1 | 8 | 2 |
| Keyboard data buffer register_1 | KBBR_1 | 8 | H'FEDE | Keyboard buffer controller_ 1 | 8 | 2 |
| Keyboard control register H_2 | KBCRH_2 | 8 | H'FEE0 | Keyboard buffer controller_ 2 | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|--------------------------------------|--------------|----------------|---------|--|----------------------|----------------------------------|
| Keyboard control register L_2 | KBCRL_2 | 8 | H'FEE1 | Keyboard buffer controller_ 2 | 8 | 2 |
| Keyboard data buffer register_2 | KBBR_2 | 8 | H'FEE2 | Keyboard buffer controller_ 2 | 8 | 2 |
| Keyboard comparator control register | KBCOMP | 8 | H'FEE4 | IrDA/ Extended A/D | 8 | 2 |
| DDC switch register | DDCSWR | 8 | H'FEE6 | IIC_0 | 8 | 2 |
| Interrupt control register A | ICRA | 8 | H'FEE8 | INT | 8 | 2 |
| Interrupt control register B | ICRB | 8 | H'FEE9 | INT | 8 | 2 |
| Interrupt control register C | ICRC | 8 | H'FEEA | INT | 8 | 2 |
| IRQ status register | ISR | 8 | H'FEEB | INT | 8 | 2 |
| IRQ sense control register H | ISCRH | 8 | H'FEEC | INT | 8 | 2 |
| IRQ sense control register L | ISCRL | 8 | H'FEED | INT | 8 | 2 |
| DTC enable register A | DTCERA | 8 | H'FEEE | DTC | 8 | 2 |
| DTC enable register B | DTCERB | 8 | H'FEEF | DTC | 8 | 2 |
| DTC enable register C | DTCERC | 8 | H'FEF0 | DTC | 8 | 2 |
| DTC enable register D | DTCERD | 8 | H'FEF1 | DTC | 8 | 2 |
| DTC enable register E | DTCERE | 8 | H'FEF2 | DTC | 8 | 2 |
| DTC vector register | DTVECR | 8 | H'FEF3 | DTC | 8 | 2 |
| Address break control register | ABRKCR | 8 | H'FEF4 | INT | 8 | 2 |
| Break address register A | BARA | 8 | H'FEF5 | INT | 8 | 2 |
| Break address register B | BARB | 8 | H'FEF6 | INT | 8 | 2 |
| Break address register C | BARC | 8 | H'FEF7 | INT | 8 | 2 |
| Flash memory control register 1 | FLMCR1 | 8 | H'FF80 | FLASH | 8 | 2 |
| Flash memory control register 2 | FLMCR2 | 8 | H'FF81 | FLASH | 8 | 2 |
| Peripheral clock select register | PCSR | 8 | H'FF82 | PWM | 8 | 2 |
| Erase block register 1 | EBR1 | 8 | H'FF82 | FLASH | 8 | 2 |
| System control register 2 | SYSCR2 | 8 | H'FF83 | SYSTEM | 8 | 2 |
| Erase block register 2 | EBR2 | 8 | H'FF83 | FLASH | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|---|--------------|-------------------|---------|--------|----------------------|----------------------------------|
| Standby control register | SBYCR | 8 | H'FF84 | SYSTEM | 8 | 2 |
| Low power control register | LPWRCR | 8 | H'FF85 | SYSTEM | 8 | 2 |
| Module stop control register H | MSTPCRH | 8 | H'FF86 | SYSTEM | 8 | 2 |
| Module stop control register L | MSTPCRL | 8 | H'FF87 | SYSTEM | 8 | 2 |
| Serial mode register_1 | SMR_1 | 8 | H'FF88 | SCI_1 | 8 | 2 |
| I ² C bus control register_1 | ICCR_1 | 8 | H'FF88 | IIC_1 | 8 | 2 |
| Bit rate register_1 | BRR_1 | 8 | H'FF89 | SCI_1 | 8 | 2 |
| I ² C bus status register_1 | ICSR_1 | 8 | H'FF89 | IIC_1 | 8 | 2 |
| Serial control register_1 | SCR_1 | 8 | H'FF8A | SCI_1 | 8 | 2 |
| Transmit data register_1 | TDR_1 | 8 | H'FF8B | SCI_1 | 8 | 2 |
| Serial status register_1 | SSR_1 | 8 | H'FF8C | SCI_1 | 8 | 2 |
| Receive data register_1 | RDR_1 | 8 | H'FF8D | SCI_1 | 8 | 2 |
| Smart card mode register_1 | SCMR_1 | 8 | H'FF8E | SCI_1 | 8 | 2 |
| I ² C bus data register_1 | ICDR_1 | 8 | H'FF8E | IIC_1 | 8 | 2 |
| Second slave address register_1 | SARX_1 | 8 | H'FF8E | IIC_1 | 8 | 2 |
| I ² C bus mode register_1 | ICMR_1 | 8 | H'FF8F | IIC_1 | 8 | 2 |
| Slave address register_1 | SAR_1 | 8 | H'FF8F | IIC_1 | 8 | 2 |
| Timer interrupt enable register | TIER | 8 | H'FF90 | FRT | 8 | 2 |
| Timer control/status register | TCSR | 8 | H'FF91 | FRT | 8 | 2 |
| Free running counter H | FRCH | 8 | H'FF92 | FRT | 8 | 2 |
| Free running counter L | FRCL | 8 | H'FF93 | FRT | 8 | 2 |
| Output control register AH | OCRAH | 8 | H'FF94 | FRT | 8 | 2 |
| Output control register BH | OCRBH | 8 | H'FF94 | FRT | 8 | 2 |
| Output control register AL | OCRAL | 8 | H'FF95 | FRT | 8 | 2 |
| Output control register BL | OCRBL | 8 | H'FF95 | FRT | 8 | 2 |
| Timer control register | TCR | 8 | H'FF96 | FRT | 8 | 2 |
| Timer output compare control register | TOCR | 8 | H'FF97 | FRT | 8 | 2 |
| Input capture register AH | ICRAH | 8 | H'FF98 | FRT | 8 | 2 |
| Output control register ARH | OCRARH | 8 | H'FF98 | FRT | 8 | 2 |
| Input capture register AL | ICRAL | 8 | H'FF99 | FRT | 8 | 2 |
| Output control register ARL | OCRARL | 8 | H'FF99 | FRT | 8 | 2 |
| Input capture register BH | ICRBH | 8 | H'FF9A | FRT | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|-------------------------------------|--------------|-------------------|-------------------|--------|----------------------|----------------------------------|
| Output control register AFH | OCRAFH | 8 | H'FF9A | FRT | 8 | 2 |
| Input capture register BL | ICRBL | 8 | H'FF9B | FRT | 8 | 2 |
| Output control register AFL | OCRAFL | 8 | H'FF9B | FRT | 8 | 2 |
| Input capture register CH | ICRCH | 8 | H'FF9C | FRT | 8 | 2 |
| Output compare register DMH | OCRDMH | 8 | H'FF9C | FRT | 8 | 2 |
| Input capture register CL | ICRCL | 8 | H'FF9D | FRT | 8 | 2 |
| Output compare register DML | OCRDML | 8 | H'FF9D | FRT | 8 | 2 |
| Input capture register DH | ICRDH | 8 | H'FF9E | FRT | 8 | 2 |
| Input capture register DL | ICRDL | 8 | H'FF9F | FRT | 8 | 2 |
| Serial mode register_2 | SMR_2 | 8 | H'FFA0 | SCI_2 | 8 | 2 |
| PWM (D/A) control register | DACR | 8 | H'FFA0 | PWMX | 8 | 2 |
| PWM (D/A) data register AH | DADRAH | 8 | H'FFA0 | PWMX | 8 | 2 |
| PWM (D/A) data register AL | DADRAL | 8 | H'FFA1 | PWMX | 8 | 2 |
| Bit rate register_2 | BRR_2 | 8 | H'FFA1 | SCI_2 | 8 | 2 |
| Serial control register_2 | SCR_2 | 8 | H'FFA2 | SCI_2 | 8 | 2 |
| Transmit data register_2 | TDR_2 | 8 | H'FFA3 | SCI_2 | 8 | 2 |
| Serial status register_2 | SSR_2 | 8 | H'FFA4 | SCI_2 | 8 | 2 |
| Receive data register_2 | RDR_2 | 8 | H'FFA5 | SCI_2 | 8 | 2 |
| Smart card mode register_2 | SCMR_2 | 8 | H'FFA6 | SCI_2 | 8 | 2 |
| PWM (D/A) counter H | DACNTH | 8 | H'FFA6 | PWMX | 8 | 2 |
| PWM (D/A) data register BH | DADRBH | 8 | H'FFA6 | PWMX | 8 | 2 |
| PWM (D/A) counter L | DACNTL | 8 | H'FFA7 | PWMX | 8 | 2 |
| PWM (D/A) data register BL | DADRBL | 8 | H'FFA7 | PWMX | 8 | 2 |
| Timer control/status register_0 | TCSR_0 | 8 | H'FFA8 | WDT | 8 | 2 |
| Timer counter_0 | TCNT_0 | 8 | H'FFA8 (write) | WDT_0 | 8 | 2 |
| Timer counter_0 | TCNT_0 | 8 | H'FFA9 (read) | WDT_0 | 8 | 2 |
| Port A output data register | PAODR | 8 | H'FFAA | PORT | 8 | 2 |
| Port A input data register | PAPIN | 8 | H'FFAB | PORT | 8 | 2 |
| Port A data direction register | PADDR | 8 | H'FFAB | PORT | 8 | 2 |
| Port 1 pull-up MOS control register | P1PCR | 8 | H'FFAC | PORT | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|-------------------------------------|--------------|-------------------|-------------------|--------|----------------------|----------------------------------|
| Port 2 pull-up MOS control register | P2PCR | 8 | H'FFAD | PORT | 8 | 2 |
| Port 3 pull-up MOS control register | P3PCR | 8 | H'FFAE | PORT | 8 | 2 |
| Port 1 data direction register | P1DDR | 8 | H'FFB0 | PORT | 8 | 2 |
| Port 2 data direction register | P2DDR | 8 | H'FFB1 | PORT | 8 | 2 |
| Port 1 data register | P1DR | 8 | H'FFB2 | PORT | 8 | 2 |
| Port 2 data register | P2DR | 8 | H'FFB3 | PORT | 8 | 2 |
| Port 3 data direction register | P3DDR | 8 | H'FFB4 | PORT | 8 | 2 |
| Port 4 data direction register | P4DDR | 8 | H'FFB5 | PORT | 8 | 2 |
| Port 3 data register | P3DR | 8 | H'FFB6 | PORT | 8 | 2 |
| Port 4 data register | P4DR | 8 | H'FFB7 | PORT | 8 | 2 |
| Port 5 data direction register | P5DDR | 8 | H'FFB8 | PORT | 8 | 2 |
| Port 6 data direction register | P6DDR | 8 | H'FFB9 | PORT | 8 | 2 |
| Port 5 data register | P5DR | 8 | H'FFBA | PORT | 8 | 2 |
| Port 6 data register | P6DR | 8 | H'FFBB | PORT | 8 | 2 |
| Port B output data register | PBODR | 8 | H'FFBC | PORT | 8 | 2 |
| Port B input data register | PBPIN | 8 | H'FFBD (read) | PORT | 8 | 2 |
| Port 8 data direction register | P8DDR | 8 | H'FFBD (write) | PORT | 8 | 2 |
| Port 7 input data register | P7PIN | 8 | H'FFBE (read) | PORT | 8 | 2 |
| Port B data direction register | PBDDR | 8 | H'FFBE (write) | PORT | 8 | 2 |
| Port 8 data register | P8DR | 8 | H'FFBF | PORT | 8 | 2 |
| Port 9 data direction register | P9DDR | 8 | H'FFC0 | PORT | 8 | 2 |
| Port 9 data register | P9DR | 8 | H'FFC1 | PORT | 8 | 2 |
| Interrupt enable register | IER | 8 | H'FFC2 | INT | 8 | 2 |
| Serial timer control register | STCR | 8 | H'FFC3 | SYSTEM | 8 | 2 |
| System control register | SYSCR | 8 | H'FFC4 | SYSTEM | 8 | 2 |
| Mode control register | MDCR | 8 | H'FFC5 | SYSTEM | 8 | 2 |
| Bus control register | BCR | 8 | H'FFC6 | BSC | 8 | 2 |
| Wait state control register | WSCR | 8 | H'FFC7 | BSC | 8 | 2 |
| Timer control register_0 | TCR_0 | 8 | H'FFC8 | TMR_0 | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|---|--------------------|-------------------|---------|------------------|----------------------|----------------------------------|
| Timer control register_1 | TCR_1 | 8 | H'FFC9 | TMR_1 | 8 | 2 |
| Timer control/status register_0 | TCSR_0 | 8 | H'FFCA | TMR_0 | 8 | 2 |
| Timer control/status register_1 | TCSR_1 | 8 | H'FFCB | TMR_1 | 16 | 2 |
| Time constant register A_0 | TCORA_0 | 8 | H'FFCC | TMR_0 | 16 | 2 |
| Time constant register A_1 | TCORA_1 | 8 | H'FFCD | TMR_1 | 16 | 2 |
| Time constant register B_0 | TCORB_0 | 8 | H'FFCE | TMR_0 | 16 | 2 |
| Time constant register B_1 | TCORB_1 | 8 | H'FFCF | TMR_1 | 16 | 2 |
| Timer counter_0 | TCNT_0 | 8 | H'FFD0 | TMR_0 | 16 | 2 |
| Timer counter_1 | TCNT_1 | 8 | H'FFD1 | TMR_1 | 16 | 2 |
| PWM output enable register B | PWOERB | 8 | H'FFD2 | PWM | 8 | 2 |
| PWM output enable register A | PWOERA | 8 | H'FFD3 | PWM | 8 | 2 |
| PWM data polarity register B | PWDPRB | 8 | H'FFD4 | PWM | 8 | 2 |
| PWM data polarity register A | PWDPRA | 8 | H'FFD5 | PWM | 8 | 2 |
| PWM register select | PWSL | 8 | H'FFD6 | PWM | 8 | 2 |
| PWM data registers 0 to 15 | PWDR0 to PWDR15 | 8 | H'FFD7 | PWM | 8 | 2 |
| Serial mode register_0 | SMR_0 | 8 | H'FFD8 | SCI_0 | 8 | 2 |
| I ² C bus control register_0 | ICCR_0 | 8 | H'FFD8 | IIC_0 | 8 | 2 |
| Bit rate register_0 | BRR_0 | 8 | H'FFD9 | SCI_0 | 8 | 2 |
| I ² C bus status register_0 | ICSR_0 | 8 | H'FFD9 | IIC_0 | 8 | 2 |
| Serial control register_0 | SCR_0 | 8 | H'FFDA | SCI_0 | 8 | 2 |
| Transmit data register_0 | TDR_0 | 8 | H'FFDB | SCI_0 | 8 | 2 |
| Serial status register_0 | SSR_0 | 8 | H'FFDC | SCI_0 | 8 | 2 |
| Receive data register_0 | RDR_0 | 8 | H'FFDD | SCI_0 | 8 | 2 |
| Smart card mode register_0 | SCMR_0 | 8 | H'FFDE | SCI_0 | 8 | 2 |
| I ² C bus data register_0 | ICDR_0 | 8 | H'FFDE | IIC_0 | 8 | 2 |
| Second slave address register_0 | SARX_0 | 8 | H'FFDE | IIC_0 | 8 | 2 |
| I ² C bus mode register_0 | ICMR_0 | 8 | H'FFDF | IIC_0 | 8 | 2 |
| Slave address register_0 | SAR_0 | 8 | H'FFDF | IIC_0 | 8 | 2 |
| A/D data register AH | ADDRAH | 8 | H'FFE0 | A/D converter | 8 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|--------------------------------------|--------------|----------------|-------------------|------------------|----------------------|----------------------------------|
| A/D data register AL | ADDRAL | 8 | H'FFE1 | A/D converter | 8 | 2 |
| A/D data register BH | ADDRBH | 8 | H'FFE2 | A/D converter | 8 | 2 |
| A/D data register BL | ADDRBL | 8 | H'FFE3 | A/D converter | 8 | 2 |
| A/D data register CH | ADDRCH | 8 | H'FFE4 | A/D converter | 8 | 2 |
| A/D data register CL | ADDRCL | 8 | H'FFE5 | A/D converter | 8 | 2 |
| A/D data register DH | ADDRDH | 8 | H'FFE6 | A/D converter | 8 | 2 |
| A/D data register DL | ADDRDL | 8 | H'FFE7 | A/D converter | 8 | 2 |
| A/D control/status register | ADCSR | 8 | H'FFE8 | A/D converter | 8 | 2 |
| A/D control register | ADCR | 8 | H'FFE9 | A/D converter | 8 | 2 |
| Timer control/status register_1 | TCSR_1 | 8 | H'FFEA | WDT_1 | 8 | 2 |
| Timer counter_1 | TCNT_1 | 8 | H'FFEA (write) | WDT_1 | 8 | 2 |
| Timer counter_1 | TCNT_1 | 8 | H'FFEB (read) | WDT_1 | 8 | 2 |
| Host interface control register | HICR | 8 | H'FFF0 | XBS | 8 | 2 |
| Timer control register_X | TCR_X | 8 | H'FFF0 | TMR_X | 16 | 2 |
| Timer control register_Y | TCR_Y | 8 | H'FFF0 | TMR_Y | 16 | 2 |
| Keyboard matrix interrupt register 6 | KMIMR | 8 | H'FFF1 | INT | 8 | 2 |
| Timer control/status register_X | TCSR_X | 8 | H'FFF1 | TMR_X | 16 | 2 |
| Timer control/status register_Y | TCSR_Y | 8 | H'FFF1 | TMR_Y | 16 | 2 |
| Pull-up MOS control register | KMPCR | 8 | H'FFF2 | PORT | 8 | 2 |
| Input capture register R | TICRR | 8 | H'FFF2 | TMR_X | 16 | 2 |
| Time constant register A_Y | TCORA_Y | 8 | H'FFF2 | TMR_Y | 16 | 2 |
| Keyboard matrix interrupt register A | KMIMRA | 8 | H'FFF3 | INT | 8 | 2 |
| Input capture register F | TICRF | 8 | H'FFF3 | TMR_X | 16 | 2 |
| Time constant register B_Y | TCORB_Y | 8 | H'FFF3 | TMR_Y | 16 | 2 |

| Register Name | Abbreviation | Number of Bits | Address | Module | Data Bus Width | Number of Access States |
|-----------------------------|--------------|----------------|---------|------------------|----------------------|----------------------------------|
| Input data register_1 | IDR_1 | 8 | H'FFF4 | XBS | 8 | 2 |
| Timer counter_X | TCNT_X | 8 | H'FFF4 | TMR_X | 16 | 2 |
| Timer counter_Y | TCNT_Y | 8 | H'FFF4 | TMR_Y | 16 | 2 |
| Output data register_1 | ODR_1 | 8 | H'FFF5 | XBS | 8 | 2 |
| Timer constant register C | TCORC | 8 | H'FFF5 | TMR_X | 16 | 2 |
| Timer input select register | TISR | 8 | H'FFF5 | TMR_Y | 16 | 2 |
| Status register_1 | STR_1 | 8 | H'FFF6 | XBS | 8 | 2 |
| Timer constant register A_X | TCORA_X | 8 | H'FFF6 | TMR_X | 16 | 2 |
| Timer constant register B_X | TCORB_X | 8 | H'FFF7 | TMR_X | 16 | 2 |
| D/A data register 0 | DADR0 | 8 | H'FFF8 | D/A converter | 8 | 2 |
| D/A data register 1 | DADR1 | 8 | H'FFF9 | D/A converter | 8 | 2 |
| D/A control register | DACR | 8 | H'FFFA | D/A converter | 8 | 2 |
| Input data register_2 | IDR_2 | 8 | H'FFFC | XBS | 8 | 2 |
| Timer connection register I | TCONRI | 8 | H'FFFC | Timer connection | 8 | 2 |
| Output data register_2 | ODR_2 | 8 | H'FFFD | XBS | 8 | 2 |
| Timer connection register O | TCONRO | 8 | H'FFFD | Timer connection | 8 | 2 |
| Status register_2 | STR_2 | 8 | H'FFFE | XBS | 8 | 2 |
| Timer connection register S | TCONRS | 8 | H'FFFE | Timer connection | 8 | 2 |
| Edge sense register | SEDGR | 8 | H'FFFF | Timer connection | 8 | 2 |

Notes: 1. Can be used on the H8S/2160B and H8S/2161B.

2. Not supported by the H8S/2148B.

27.2 Register Bits

Register addresses and bit names of the on-chip peripheral modules are described below.

16-bit registers are shown as 2 lines.

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|---------|---------|---------|---------|---------|---------|---------|---------|--------|
| PGNOCR*1 | PG7NOCR | PG6NOCR | PG5NOCR | PG4NOCR | PG3NOCR | PG2NOCR | PG1NOCR | PG0NOCR | PORT |
| PENOCR*1 | PE7NOCR | PE6NOCR | PE5NOCR | PE4NOCR | PE3NOCR | PE2NOCR | PE1NOCR | PE0NOCR | - |
| PFNOCR*1 | PF7NOCR | PF6NOCR | PF5NOCR | PF4NOCR | PF3NOCR | PF2NOCR | PF1NOCR | PF0NOCR | - |
| PCNOCR*1 | PC7NOCR | PC6NOCR | PC5NOCR | PC4NOCR | PC3NOCR | PC2NOCR | PC1NOCR | PC0NOCR | - |
| PDNOCR*1 | PD7NOCR | PD6NOCR | PD5NOCR | PD4NOCR | PD3NOCR | PD2NOCR | PD1NOCR | PD0NOCR | - |
| TWR0MW | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | LPC |
| TWR0SW | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR3 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR4 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR5 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR6 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR7 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR9 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR10 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR11 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR12 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR13 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR14 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| TWR15 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| IDR3 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| ODR3 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| STR3*2 | IBF3B | OBF3B | MWMF | SWMF | C/D3 | DBU32 | IBF3A | OBF3A | _ |
| STR3*3 | DBU37 | DBU36 | DBU35 | DBU34 | C/D3 | DBU32 | IBF3A | OBF3A | _ |
| LADR3H | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | _ |
| LADR3L | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | _ | Bit 1 | TWRE | = |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|---------|----------|----------|---------|---------|---------|----------|---------|--------|
| SIRQCR0 | Q/C | SELREQ | IEDIR | SMIE3B | SMIE3A | SMIE2 | IRQ12E1 | IRQ1E1 | LPC |
| SIRQCR1 | IRQ11E3 | IRQ10E3 | IRQ9E3 | IRQ6E3 | IRQ11E2 | IRQ10E2 | IRQ9E2 | IRQ6E2 | • |
| IDR1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | • |
| ODR1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | • |
| STR1 | DBU17 | DBU16 | DBU15 | DBU14 | C/D1 | DBU12 | IBF1 | OBF1 | • |
| IDR2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | • |
| ODR2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | • |
| STR2 | DBU27 | DBU26 | DBU25 | DBU24 | C/D2 | DBU22 | IBF2 | OBF2 | • |
| HISEL | SELSTR3 | SELIRQ11 | SELIRQ10 | SELIRQ9 | SELIRQ6 | SELSMI | SELIRQ12 | SELIRQ1 | • |
| HICR0 | LPC3E | LPC2E | LPC1E | FGA20E | SDWNE | PMEE | LSMIE | LSCIE | • |
| HICR1 | LPCBSY | CLKREQ | IRQBSY | LRSTB | SDWNB | PMEB | LSMIB | LSCIB | • |
| HICR2 | GA20 | LRST | SDWN | ABRT | IBFIE3 | IBFIE2 | IBFIE1 | ERRIE | • |
| HICR3 | LFRAME | CLKRUN | SERIRQ | LRESET | LPCPD | PME | LSMI | LSCI | • |
| WUEMRB*5 | WUEMR7 | WUEMR6 | WUEMR5 | WUEMR4 | WUEMR3 | WUEMR2 | WUEMR1 | WUEMR0 | INT |
| PGODR*1 | PG70DR | PG60DR | PG5ODR | PG40DR | PG3ODR | PG2ODR | PG10DR | PG00DR | PORT |
| PGPIN*1 | PG7PIN | PG6PIN | PG5PIN | PG4PIN | PG3PIN | PG2PIN | PG1PIN | PG0PIN | • |
| PGDDR*1 | PG7DDR | PG6DDR | PG5DDR | PG4DDR | PG3DDR | PG2DDR | PG1DDR | PG0DDR | • |
| PEODR*1 | PE7ODR | PE6ODR | PE5ODR | PE4ODR | PE3ODR | PE2ODR | PE10DR | PE0ODR | • |
| PFODR*1 | PF70DR | PF6ODR | PF5ODR | PF4ODR | PF3ODR | PF2ODR | PF10DR | PF0ODR | • |
| PEPIN*1 | PE7PIN | PE6PIN | PE5PIN | PE4PIN | PE3PIN | PE2PIN | PE1PIN | PE0PIN | • |
| PEDDR*1 | PE7DDR | PE6DDR | PE5DDR | PE4DDR | PE3DDR | PE2DDR | PE1DDR | PE0DDR | • |
| PFPIN*1 | PF7PIN | PF6PIN | PF5PIN | PF4PIN | PF3PIN | PF2PIN | PF1PIN | PF0PIN | • |
| PFDDR*1 | PF7DDR | PF6DDR | PF5DDR | PF4DDR | PF3DDR | PF2DDR | PF1DDR | PF0DDR | • |
| PCODR*1 | PC70DR | PC6ODR | PC5ODR | PC40DR | PC3ODR | PC2ODR | PC10DR | PC00DR | • |
| PDODR*1 | PD70DR | PD60DR | PD5ODR | PD40DR | PD3ODR | PD2ODR | PD10DR | PD00DR | • |
| PCPIN*1 | PC7PIN | PC6PIN | PC5PIN | PC4PIN | PC3PIN | PC2PIN | PC1PIN | PC0PIN | |
| PCDDR*1 | PC7DDR | PC6DDR | PC5DDR | PC4DDR | PC3DDR | PC2DDR | PC1DDR | PC0DDR | • |
| PDPIN*1 | PD7PIN | PD6PIN | PD5PIN | PD4PIN | PD3PIN | PD2PIN | PD1PIN | PD0PIN | |
| PDDDR*1 | PD7DDR | PD6DDR | PD5DDR | PD4DDR | PD3DDR | PD2DDR | PD1DDR | PD0DDR | • |
| HICR2 | _ | _ | _ | _ | _ | IBFIE4 | IBFIE3 | _ | XBS |
| IDR_3 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | • |
| ODR_3 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | |
| STR_3 | DBU | DBU | DBU | DBU | C/D | DBU | IBF | OBF | • |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|---------|---------|---------|---------|---------|---------|---------|---------|--------------------------|
| IDR_4 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | XBS |
| ODR_4 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | - |
| STR_4 | DBU | DBU | DBU | DBU | C/D | DBU | IBF | OBF | - |
| ICXR_0 | STOPIM | HNDS | ICDRF | ICDRE | ALIE | ALSL | FNC1 | FNC0 | IIC_0 |
| ICXR_1 | STOPIM | HNDS | ICDRF | ICDRE | ALIE | ALSL | FNC1 | FNC0 | IIC_1 |
| KBCRH_0 | KBIOE | KCLKI | KDI | KBFSEL | KBIE | KBF | PER | KBS | Keyboard |
| KBCRL_0 | KBE | KCLKO | KDO | _ | RXCR3 | RXCR2 | RXCR1 | RXCR0 | buffer controller |
| KBBR_0 | KB7 | KB6 | KB5 | KB4 | KB3 | KB2 | KB1 | KB0 | _0 |
| KBCRH_1 | KBIOE | KCLKI | KDI | KBFSEL | KBIE | KBF | PER | KBS | Keyboard |
| KBCRL_1 | KBE | KCLKO | KDO | | RXCR3 | RXCR2 | RXCR1 | RXCR0 | buffer controller |
| KBBR_1 | KB7 | KB6 | KB5 | KB4 | KB3 | KB2 | KB1 | KB0 | _1 |
| KBCRH_2 | KBIOE | KCLKI | KDI | KBFSEL | KBIE | KBF | PER | KBS | Keyboard |
| KBCRL_2 | KBE | KCLKO | KDO | _ | RXCR3 | RXCR2 | RXCR1 | RXCR0 | buffer controller |
| KBBR_2 | KB7 | KB6 | KB5 | KB4 | KB3 | KB2 | KB1 | KB0 | _2 |
| KBCOMP | IrE | IrCKS2 | IrCKS1 | IrCKS0 | KBADE | KBCH2 | KBCH1 | KBCH0 | IrDA/ expanded A/D |
| DDCSWR | SWE | SW | IE | IF | CLR3 | CLR2 | CLR1 | CLR0 | IIC_0 |
| ICRA | ICRA7 | ICRA6 | ICRA5 | ICRA4 | ICRA3 | ICRA2 | ICRA1 | ICRA0 | INT |
| ICRB | ICRB7 | ICRB6 | ICRB5 | ICRB4 | ICRB3 | ICRB2 | ICRB1 | ICRB0 | |
| ICRC | ICRC7 | ICRC6 | ICRC5 | ICRC4 | ICRC3 | ICRC2 | ICRC1 | ICRC0 | |
| ISR | IRQ7F | IRQ6F | IRQ5F | IRQ4F | IRQ3F | IRQ2F | IRQ1F | IRQ0F | |
| ISCRH | IRQ7SCB | IRQ7SCA | IRQ6SCB | IRQ6SCA | IRQ5SCB | IRQ5SCA | IRQ4SCB | IRQ4SCA | |
| ISCRL | IRQ3SCB | IRQ3SCA | IRQ2SCB | IRQ2SCA | IRQ1SCB | IRQ1SCA | IRQ0SCB | IRQ0SCA | |
| DTCERA | DTCEA7 | DTCEA6 | DTCEA5 | DTCEA4 | DTCEA3 | DTCEA2 | DTCEA1 | DTCEA0 | DTC |
| DTCERB | DTCEB7 | DTCEB6 | DTCEB5 | DTCEB4 | DTCEB3 | DTCEB2 | DTCEB1 | DTCEB0 | _ |
| DTCERC | DTCEC7 | DTCEC6 | DTCEC5 | DTCEC4 | DTCEC3 | DTCEC2 | DTCEC1 | DTCEC0 | _ |
| DTCERD | DTCED7 | DTCED6 | DTCED5 | DTCED4 | DTCED3 | DTCED2 | DTCED1 | DTCED0 | _ |
| DTCERE | DTCEE7 | DTCEE6 | DTCEE5 | DTCEE4 | DTCEE3 | DTCEE2 | DTCEE1 | DTCEE0 | _ |
| DTVECR | SWDTE | DTVEC6 | DTVEC5 | DTVEC4 | DTVEC3 | DTVEC2 | DTVEC1 | DTVEC0 | |
| ABRKCR | CMF | _ | _ | _ | _ | _ | _ | BIE | INT |
| BARA | A23 | A22 | A21 | A20 | A19 | A18 | A17 | A16 | _ |
| BARB | A15 | A14 | A13 | A12 | A11 | A10 | A9 | A8 | |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|--------|--------|--------|--------|--------|--------|-------|-------|--------------|
| BARC | A7 | A6 | A5 | A4 | A3 | A2 | A1 | _ | INT |
| FLMCR1 | FWE | SWE | _ | _ | EV | PV | Е | Р | FLASH |
| FLMCR2 | FLER | _ | _ | _ | _ | _ | ESU | PSU | _ |
| PCSR | _ | _ | _ | _ | _ | PWCKB | PWCKA | _ | PWM |
| EBR1*4 | _ | _ | _ | _ | EB11 | EB10 | EB9 | EB8 | FLASH |
| SYSCR2 | KWUL1 | KWUL0 | P6PUE | _ | SDE | CS4E | CS3E | HI12E | SYSTEM |
| EBR2 | EB7 | EB6 | EB5 | EB4 | EB3 | EB2 | EB1 | EB0 | FLASH |
| SBYCR | SSBY | STS2 | STS1 | STS0 | _ | SCK2 | SCK1 | SCK0 | SYSTEM |
| LPWRCR | DTON | LSON | NESEL | EXCLE | _ | _ | _ | _ | _ |
| MSTPCRH | MSTP15 | MSTP14 | MSTP13 | MSTP12 | MSTP11 | MSTP10 | MSTP9 | MSTP8 | _ |
| MSTPCRL | MSTP7 | MSTP6 | MSTP5 | MSTP4 | MSTP3 | MSTP2 | MSTP1 | MSTP0 | _ |
| SMR_1 | C/A | CHR | PE | O/E | STOP | MP | CKS1 | CKS0 | SCI_1 |
| ICCR_1 | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP | IIC_1 |
| BRR_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | SCI_1 |
| ICSR_1 | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | IIC_1 |
| SCR_1 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | SCI_1 |
| TDR_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| SSR_1 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | _ |
| RDR_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| SCMR_1 | _ | _ | _ | _ | SDIR | SINV | _ | SMIF | _ |
| ICDR_1 | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 | IIC_1 |
| SARX_1 | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX | _ |
| ICMR_1 | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 | _ |
| SAR_1 | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS | _ |
| TIER | ICIAE | ICIBE | ICICE | ICIDE | OCIAE | OCIBE | OVIE | _ | FRT |
| TCSR | ICFA | ICFB | ICFC | ICFD | OCFA | OCFB | OVF | CCLRA | _ |
| FRCH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | _ |
| FRCL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| OCRAH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | _ |
| OCRBH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | _ |
| OCRAL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| OCRBL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| TCR | IEDGA | IEDGB | IEDGC | IEDGD | BUFEA | BUFEB | CKS1 | CKS0 | _ |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|--------|--------|--------|--------|---------|--------|--------|--------|--------|
| TOCR | ICRDMS | OCRAMS | ICRS | OCRS | OEA | OEB | OLVLA | OLVLB | FRT |
| ICRAH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | _ |
| OCRARH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | - |
| ICRAL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| OCRARL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| ICRBH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | - |
| OCRAFH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | =' |
| ICRBL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | =' |
| OCRAFL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| ICRCH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | =' |
| OCRDMH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | - |
| ICRCL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| OCRDML | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| ICRDH | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | - |
| ICRDL | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| SMR_2 | C/Ā | CHR | PE | O/Ē | STOP | MP | CKS1 | CKS0 | SCI_2 |
| DACR | TEST | PWME | _ | _ | OEB | OEA | os | CKS | PWMX |
| DADRAH | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | - |
| DADRAL | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | _ | - |
| BRR_2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | SCI_2 |
| SCR_2 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | - |
| TDR_2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| SSR_2 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | - |
| RDR_2 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | - |
| SCMR_2 | _ | _ | _ | _ | SDIR | SINV | _ | SMIF | - |
| DACNTH | UC7 | UC6 | UC5 | UC4 | UC3 | UC2 | UC1 | UC0 | PWMX |
| DADRBH | DA13 | DA12 | DA11 | DA10 | DA9 | DA8 | DA7 | DA6 | _ |
| DACNTL | UC8 | UC9 | UC10 | UC11 | UC12 | UC13 | _ | REGS | _ |
| DADRBL | DA5 | DA4 | DA3 | DA2 | DA1 | DA0 | CFS | REGS | _ |
| TCSR_0 | OVF | WT/ĪT | TME | _ | RST/NMI | CKS2 | CKS1 | CKS0 | WDT_0 |
| TCNT_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| PAODR | PA7ODR | PA6ODR | PA5ODR | PA4ODR | PA3ODR | PA2ODR | PA10DR | PA0ODR | PORT |
| PAPIN | PA7PIN | PA6PIN | PA5PIN | PA4PIN | PA3PIN | PA2PIN | PA1PIN | PA0PIN | = |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|--------|--------|--------|--------|--------|--------|--------|--------|--------------|
| PADDR | PA7DDR | PA6DDR | PA5DDR | PA4DDR | PA3DDR | PA2DDR | PA1DDR | PA0DDR | PORT |
| P1PCR | P17PCR | P16PCR | P15PCR | P14PCR | P13PCR | P12PCR | P11PCR | P10PCR | _ |
| P2PCR | P27PCR | P26PCR | P25PCR | P24PCR | P23PCR | P22PCR | P21PCR | P20PCR | _ |
| P3PCR | P37PCR | P36PCR | P35PCR | P34PCR | P33PCR | P32PCR | P31PCR | P30PCR | _ |
| P1DDR | P17DDR | P16DDR | P15DDR | P14DDR | P13DDR | P12DDR | P11DDR | P10DDR | _ |
| P2DDR | P27DDR | P26DDR | P25DDR | P24DDR | P23DDR | P22DDR | P21DDR | P20DDR | _ |
| P1DR | P17DR | P16DR | P15DR | P14DR | P13DR | P12DR | P11DR | P10DR | _ |
| P2DR | P27DR | P26DR | P25DR | P24DR | P23DR | P22DR | P21DR | P20DR | _ |
| P3DDR | P37DDR | P36DDR | P35DDR | P34DDR | P33DDR | P32DDR | P31DDR | P30DDR | _ |
| P4DDR | P47DDR | P46DDR | P45DDR | P44DDR | P43DDR | P42DDR | P41DDR | P40DDR | _ |
| P3DR | P37DR | P36DR | P35DR | P34DR | P33DR | P32DR | P31DR | P30DR | = |
| P4DR | P47DR | P46DR | P45DR | P44DR | P43DR | P42DR | P41DR | P40DR | _ |
| P5DDR | _ | _ | _ | _ | _ | P52DDR | P51DDR | P50DDR | _ |
| P6DDR | P67DDR | P66DDR | P65DDR | P64DDR | P63DDR | P62DDR | P61DDR | P60DDR | _ |
| P5DR | _ | _ | _ | _ | _ | P52DR | P51DR | P50DR | _ |
| P6DR | P67DR | P66DR | P65DR | P64DR | P63DR | P62DR | P61DR | P60DR | _ |
| PBODR | PB7ODR | PB6ODR | PB5ODR | PB4ODR | PB3ODR | PB2ODR | PB1ODR | PB0ODR | _ |
| PBPIN | PB7PIN | PB6PIN | PB5PIN | PB4PIN | PB3PIN | PB2PIN | PB1PIN | PB0PIN | _ |
| P8DDR | _ | P86DDR | P85DDR | P84DDR | P83DDR | P82DDR | P81DDR | P80DDR | _ |
| P7PIN | P77PIN | P76PIN | P75PIN | P74PIN | P73PIN | P72PIN | P71PIN | P70PIN | _ |
| PBDDR | PB7DDR | PB6DDR | PB5DDR | PB4DDR | PB3DDR | PB2DDR | PB1DDR | PB0DDR | _ |
| P8DR | _ | P86DR | P85DR | P84DR | P83DR | P82DR | P81DR | P80DR | _ |
| P9DDR | P97DDR | P96DDR | P95DDR | P94DDR | P93DDR | P92DDR | P91DDR | P90DDR | _ |
| P9DR | P97DR | P96DR | P95DR | P94DR | P93DR | P92DR | P91DR | P90DR | _ |
| IER | IRQ7E | IRQ6E | IRQ5E | IRQ4E | IRQ3E | IRQ2E | IRQ1E | IRQ0E | INT |
| STCR | IICS | IICX1 | IICX0 | IICE | FLSHE | _ | ICKS1 | ICKS0 | SYSTEM |
| SYSCR | CS2E | IOSE | INTM1 | INTM0 | XRST | NMIEG | HIE | RAME | - |
| MDCR | EXPE | _ | _ | _ | _ | _ | MDS1 | MDS0 | - |
| BCR | | ICIS0 | BRSTRM | BRSTS1 | BRSTS0 | _ | IOS1 | IOS0 | BSC |
| WSCR | _ | _ | ABW | AST | WMS1 | WMS0 | WC1 | WC0 | _ |
| TCR_0 | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMR_0, |
| TCR_1 | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMR_1 |
| TCSR_0 | CMFB | CMFA | OVF | ADTE | OS3 | OS2 | OS1 | OS0 | _ |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|-------|-------|-------|--------------|-------|-------|-------|-------|---------------|
| TCSR_1 | CMFB | CMFA | OVF | _ | OS3 | OS2 | OS1 | OS0 | TMR_0, |
| TCORA_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_1 |
| TCORA_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| TCORB_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| TCORB_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| TCNT_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| TCNT_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| PWOERB | OE15 | OE14 | OE13 | OE12 | OE11 | OE10 | OE9 | OE8 | PWM |
| PWOERA | OE7 | OE6 | OE5 | OE4 | OE3 | OE2 | OE1 | OE0 | |
| PWDPRB | OS15 | OS14 | OS13 | OS12 | OS11 | OS10 | OS9 | OS8 | |
| PWDPRA | OS7 | OS6 | OS5 | OS4 | OS3 | OS2 | OS1 | OS0 | |
| PWSL | PWCKE | PWCKS | _ | _ | RS3 | RS2 | RS1 | RS0 | <u> </u> |
| PWDR0-15 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| SMR_0 | C/A | CHR | PE | O/E | STOP | MP | CKS1 | CKS0 | SCI_0 |
| ICCR_0 | ICE | IEIC | MST | TRS | ACKE | BBSY | IRIC | SCP | IIC_0 |
| BRR_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | SCI_0 |
| ICSR_0 | ESTP | STOP | IRTR | AASX | AL | AAS | ADZ | ACKB | IIC_0 |
| SCR_0 | TIE | RIE | TE | RE | MPIE | TEIE | CKE1 | CKE0 | SCI_0 |
| TDR_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| SSR_0 | TDRE | RDRF | ORER | FER | PER | TEND | MPB | MPBT | |
| RDR_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| SCMR_0 | _ | _ | _ | _ | SDIR | SINV | _ | SMIF | <u> </u> |
| ICDR_0 | ICDR7 | ICDR6 | ICDR5 | ICDR4 | ICDR3 | ICDR2 | ICDR1 | ICDR0 | IIC_0 |
| SARX_0 | SVAX6 | SVAX5 | SVAX4 | SVAX3 | SVAX2 | SVAX1 | SVAX0 | FSX | |
| ICMR_0 | MLS | WAIT | CKS2 | CKS1 | CKS0 | BC2 | BC1 | BC0 | |
| SAR_0 | SVA6 | SVA5 | SVA4 | SVA3 | SVA2 | SVA1 | SVA0 | FS | , |
| ADDRAH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | A/D |
| ADDRAL | AD1 | AD0 | _ | _ | _ | _ | _ | _ | converter |
| ADDRBH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | <u> </u> |
| ADDRBL | AD1 | AD0 | _ | _ | _ | _ | _ | _ | <u> </u> |
| ADDRCH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | <u> </u> |
| ADDRCL | AD1 | AD0 | _ | _ | _ | _ | _ | _ | <u> </u> |
| ADDRDH | AD9 | AD8 | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | <u> </u> |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
|--------------------------|---------|---------|---------|---------|---------|---------|--------|--------|------------------|
| ADDRDL | AD1 | AD0 | _ | _ | _ | _ | _ | _ | A/D |
| ADCSR | ADF | ADIE | ADST | SCAN | CKS | CH2 | CH1 | CH0 | converter |
| ADCR | TRGS1 | TRGS0 | _ | _ | _ | _ | _ | _ | _ |
| TCSR_1 | OVF | WT/ĪT | TME | PSS | RST/NMI | CKS2 | CKS1 | CKS0 | WDT_1 |
| TCNT_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| HICR | _ | _ | _ | _ | _ | IBFIE2 | IBFIE1 | FGA20E | XBS |
| TCR_X | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMR_X |
| TCR_Y | CMIEB | CMIEA | OVIE | CCLR1 | CCLR0 | CKS2 | CKS1 | CKS0 | TMR_Y |
| KMIMR | KMIMR7 | KMIMR6 | KMIMR5 | KMIMR4 | KMIMR3 | KMIMR2 | KMIMR1 | KMIMR0 | INT |
| TCSR_X | CMFB | CMFA | OVF | ICF | OS3 | OS2 | OS1 | OS0 | TMR_X |
| TCSR_Y | CMFB | CMFA | OVF | ICIE | OS3 | OS2 | OS1 | OS0 | TMR_Y |
| KMPCR | KMIMR7 | KMIMR6 | KMIMR5 | KMIMR4 | KMIMR3 | KMIMR2 | KMIMR1 | KMIMR0 | PORT |
| TICRR | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_X |
| TCORA_Y | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_Y |
| KMIMRA | KMIMR15 | KMIMR14 | KMIMR13 | KMIMR12 | KMIMR11 | KMIMR10 | KMIMR9 | KMIMR8 | INT |
| TICRF | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_X |
| TCORB_Y | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_Y |
| IDR_1 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | XBS |
| TCNT_X | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_X |
| TCNT_Y | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_Y |
| ODR_1 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | XBS |
| TCORC | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_X |
| TISR | _ | _ | _ | _ | _ | _ | _ | IS | TMR_Y |
| STR_1 | DBU17 | DBU16 | DBU15 | DBU14 | C/D1 | DBU12 | IBF1 | OBF1 | XBS |
| TCORA_X | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | TMR_X |
| TCORB_X | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | _ |
| DADR_0 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | D/A |
| DADR_1 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | converter |
| DACR | DAOE1 | DAOE0 | DAE | _ | _ | _ | _ | _ | _ |
| IDR_2 | IDR7 | IDR6 | IDR5 | IDR4 | IDR3 | IDR2 | IDR1 | IDR0 | XBS |
| TCONRI | SIMOD1 | SIMOD0 | SCONE | ICST | HFINV | VFINV | HIINV | VIINV | Timer connection |
| ODR_2 | ODR7 | ODR6 | ODR5 | ODR4 | ODR3 | ODR2 | ODR1 | ODR0 | XBS |



| Register | | | | | | | | | |
|--------------|--------|--------|--------|--------|--------|--------|--------|--------|------------------|
| Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module |
| TCONRO | HOE | VOE | CLOE | CBOE | HOINV | VOINV | CLOINV | CBOINV | Timer connection |
| STR_2 | DBU27 | DBU26 | DBU25 | DBU24 | C/D2 | DBU22 | IBF2 | OBF2 | XBS |
| TCONRS | TMRX/Y | ISGENE | HOMOD1 | HOMOD0 | VOMOD1 | VOMOD0 | CLMOD1 | CLMOD0 | Timer |
| SEDGR | VEDG | HEDG | CEDG | HFEDG | VFEDG | PREQF | IHI | IVI | connection |

Notes: 1. Can be used on the H8S/2160B and H8S/2161B.

- 2. When TWRE = 1 or SELSTR3 = 0 in LADR3L
- 3. When TWRE = 0 and SELSTR3 = 1 in LADR3L
- 4. All bits are reserved in the 64-kbyte flash memory version.

 The EB11 and EB10 bits are reserved in the 128-kbyte flash memory version.
- 5. Not supported by the H8S/2148B.

27.3 Register States in Each Operating Mode

| Register | | High-Speed/ | | | | | | | | |
|-------------------|-------------|------------------|-------|-------|----------------|--------------|----------------|---------------------|---------------------|----------|
| Abbrevia- tion | Reset | Medium- Speed | Watch | Sleep | Sub- Active | Sub-Sleep | Module Stop | Software Standby | Hardware Standby | Module |
| PGNOCR*1 | Initialized | | _ | _ | _ | | _ | | Initialized | PORT |
| | Initialized | | | | | | _ | _ | Initialized | - |
| PENOCR*1 | | | _ | _ | _ | _ | _ | _ | | - |
| PFNOCR*1 | Initialized | _ | | | _ | _ | _ | - | Initialized | = |
| PCNOCR*1 | Initialized | _ | | _ | _ | _ | _ | _ | Initialized | - |
| PDNOCR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| TWR0MW | _ | _ | _ | _ | _ | _ | _ | _ | _ | LPC - |
| TWR0SW | _ | _ | _ | _ | _ | _ | <u> </u> | _ | _ | = |
| TWR1 | <u> </u> | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR2 | _ | _ | _ | _ | _ | | _ | _ | _ | _ |
| TWR3 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| TWR4 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| TWR5 | _ | _ | _ | _ | _ | _ | _ | | | _ |
| TWR6 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR7 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR8 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR9 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR10 | _ | _ | _ | _ | _ | _ | _ | _ | _ | = |
| TWR11 | | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR12 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR13 | _ | _ | _ | _ | _ | | _ | _ | _ | - |
| TWR14 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| TWR15 | _ | _ | _ | _ | _ | | _ | | | - |
| IDR3 | _ | _ | _ | | _ | | _ | _ | _ | - |
| ODR3 | _ | _ | _ | _ | _ | | _ | | | - |
| STR3 | Initialized | _ | _ | | | _ | _ | _ | Initialized | - |
| LADR3H | Initialized | _ | _ | | _ | | _ | _ | Initialized | - |
| LADR3L | Initialized | | _ | | | | | | Initialized | = |
| | | | | | | | | | Initialized | _ |
| SIRQCR0 | Initialized | | _ | _ | _ | <u>-</u> | | _ | | - |
| SIRQCR1 | Initialized | | _ | _ | _ | | _ | | Initialized | - |
| IDR1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | - |
| ODR1 | <u> </u> | _ | | | | | <u> </u> | | _ | |

| Register | | High-Spee | d/ | | | | | 0.4 | | |
|-------------------|-------------|------------------|-------|-------|----------------|-----------|----------------|---------------------|---------------------|--------|
| Abbrevia- tion | Reset | Medium- Speed | Watch | Sleep | Sub- Active | Sub-Sleep | Module Stop | Software Standby | Hardware Standby | Module |
| STR1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | LPC |
| IDR2 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| ODR2 | _ | _ | _ | _ | _ | _ | _ | _ | _ | = |
| STR2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | = |
| HISEL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| HICR0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| HICR1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | = |
| HICR2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| HICR3 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| WUEMRB*2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | INT |
| PGODR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | PORT |
| PGPIN*1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PGDDR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PEODR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PFODR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PEPIN*1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PEDDR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PFPIN*1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PFDDR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PCODR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PDODR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PCPIN*1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PCDDR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PDPIN*1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PDDDR*1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| HICR2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | XBS |
| IDR_3 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| ODR_3 | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| STR_3 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| IDR_4 | _ | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ODR_4 | _ | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| STR_4 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |

| tion Reset Speed Watch Sleep Active Sub-Sleep Stop Standby Module ICXR_0 Initialized — — — — — — — Initialized IC_0 — | Register Abbrevia- | | High-Speed/ Medium- | | | Sub- | | Module | Software | Hardware | |
|--|-----------------------|-------------|------------------------|-------------|-------|--------------|-------------|--------------|-------------|-------------|-------|
| ICXR.1 | | | | watch | Sieep | Active | Sub-Sieep | Stop | Standby | | |
| Mathematical Math | ICXR_0 | Initialized | | | _ | _ | _ | _ | _ | Initialized | IIC_0 |
| March | ICXR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IIC_1 |
| KBCRL | KBCRH_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| March | KBCRL_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| March | KBBR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| KBBR_1 | KBCRH_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| KBBR_1 Initialized <t< td=""><td>KBCRL_1</td><td>Initialized</td><td>_</td><td>Initialized</td><td>_</td><td>Initialized</td><td>Initialized</td><td>Initialized</td><td>Initialized</td><td>Initialized</td><td></td></t<> | KBCRL_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| KBCRL_2 | KBBR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| KBBR_2 | KBCRH_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| KBBR_2 Initialized Initialized Initialized Initialized Initialized Initialized Initialized Initialized Initialized IrDA/A/D DCSWR Initialized — — — — — — Initialized IIC_0 ICRA Initialized — — — — — Initialized IINT ICRB Initialized — — — — — Initialized ICRC Initialized — — — — Initialized ISR Initialized — — — — Initialized ISCRL Initialized — — — — Initialized DTCERA Initialized — — — — — Initialized DTCERB Initialized — — — — — Initialized DTCERC Initialized — — — — | KBCRL_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| A/D Converter A/D Converter | KBBR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| DDCSWR | KBCOMP | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IrDA/ |
| DDCSWR | | | | | | | | | | | |
| ICRA | DDCSWR | Initialized | _ | _ | | _ | | _ | _ | Initialized | |
| ICRB | | | _ | _ | | _ | _ | _ | _ | | |
| ISR Initialized — — — — — Initialized ISCRH Initialized — — — — — Initialized ISCRL Initialized — — — — — Initialized DTCERA Initialized — — — — — Initialized DTCERB Initialized — — — — — Initialized DTCERC Initialized — — — — — Initialized DTCERD Initialized — — — — — Initialized DTVECR Initialized — — — — — Initialized DTVECR Initialized — — — — — Initialized ABRKCR Initialized — — — — — Initialized BARD Initialized — <t< td=""><td>ICRB</td><td>Initialized</td><td>_</td><td>_</td><td></td><td>_</td><td>_</td><td>_</td><td></td><td>Initialized</td><td>_</td></t<> | ICRB | Initialized | _ | _ | | _ | _ | _ | | Initialized | _ |
| ISCRH | ICRC | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| ISCRL Initialized Initialized DTCERA Initialized Initialized DTCERB Initialized Initialized DTCERB Initialized Initialized DTCERC Initialized Initialized Initialized DTCERD Initialized Initialized I | ISR | Initialized | _ | _ | | _ | _ | _ | _ | Initialized | _ |
| DTCERA Initialized — — — — — Initialized DTC DTCERB Initialized — — — — — Initialized DTCERC Initialized — — — — — Initialized DTCERE Initialized — — — — Initialized DTVECR Initialized — — — — Initialized ABRKCR Initialized — — — — Initialized INT BARB Initialized — — — — Initialized Initialized FLMCR1 Initialized — Initialized Initialized Initialized Initialized Initialized FLASH | ISCRH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| DTCERB Initialized — — — — — Initialized DTCERC Initialized — — — — — Initialized DTCERD Initialized — — — — — Initialized DTVECR Initialized — — — — — Initialized ABRKCR Initialized — — — — — Initialized INT BARB Initialized — — — — — Initialized BARC Initialized — — — — — Initialized Initialized Initialized FLASH | ISCRL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| DTCERC Initialized — — — — — Initialized DTCERD Initialized — — — — — Initialized DTCERE Initialized — — — — — Initialized DTVECR Initialized — — — — Initialized ABRKCR Initialized — — — — Initialized INT BARA Initialized — — — — — Initialized BARC Initialized — — — — — Initialized | DTCERA | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | DTC |
| DTCERD Initialized — — — — — Initialized DTCERE Initialized — — — — — Initialized DTVECR Initialized — — — — — Initialized ABRKCR Initialized — — — — — Initialized Initialized BARA Initialized — — — — — Initialized BARC Initialized — — — — — Initialized — Initialized FLASH | DTCERB | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| DTCERE Initialized — — — — — Initialized DTVECR Initialized — — — — — Initialized ABRKCR Initialized — — — — — Initialized INT BARA Initialized — — — — — Initialized BARB Initialized — — — — Initialized BARC Initialized — — — — Initialized Initialized Initialized FLASH | DTCERC | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| DTVECR Initialized — — — — — Initialized ABRKCR Initialized — — — — — Initialized INIT BARA Initialized — — — — — Initialized BARB Initialized — — — — — Initialized BARC Initialized — — — — — Initialized Initialized Initialized FLASH | DTCERD | Initialized | _ | | _ | _ | _ | _ | _ | Initialized | _ |
| ABRKCR Initialized — — — — — Initialized INT BARA Initialized — — — — — Initialized BARB Initialized — — — — — Initialized BARC Initialized — — — — Initialized Initialized Initialized FLASH | DTCERE | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| BARA Initialized — — — — — Initialized BARB Initialized — — — — — Initialized BARC Initialized — — — — — Initialized FLMCR1 Initialized — Initialized — Initialized — Initialized FLASH | DTVECR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| BARB Initialized — — — — — Initialized BARC Initialized — — — — — Initialized FLMCR1 Initialized — Initialized — Initialized — Initialized FLASH | ABRKCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | INT |
| BARC Initialized — — — — — — — Initialized FLMCR1 Initialized — Initialized — Initialized — Initialized — Initialized FLASH | BARA | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| FLMCR1 Initialized — Initialized — Initialized — Initialized — Initialized — Initialized FLASH | BARB | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| | BARC | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| FLMCR2 Initialized — Initialized — Initialized — Initialized Initialized Initialized | FLMCR1 | Initialized | _ | Initialized | _ | Initialized | Initialized | _ | Initialized | Initialized | FLASH |
| | FLMCR2 | Initialized | _ | Initialized | _ | Initialized | Initialized | _ | Initialized | Initialized | _ |



| Register Abbrevia- | | High-Speed/ Medium- | | | Sub- | | Module | Software | Hardware | |
|-----------------------|-------------|------------------------|-------------|----------|-------------|-------------|-------------|-------------|-------------|--------------|
| tion | Reset | Speed | Watch | Sleep | Active | Sub-Sleep | Stop | Standby | Standby | Module |
| PCSR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | PWM |
| EBR1 | Initialized | _ | Initialized | _ | Initialized | Initialized | _ | Initialized | Initialized | FLASH |
| SYSCR2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | SYSTEM |
| EBR2 | Initialized | _ | Initialized | _ | Initialized | Initialized | _ | Initialized | Initialized | FLASH |
| SBYCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | SYSTEM |
| LPWRCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| MSTPCRH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| MSTPCRL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| SMR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_1 |
| ICCR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IIC_1 |
| BRR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_1 |
| ICSR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IIC_1 |
| SCR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_1 |
| TDR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| SSR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| RDR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| SCMR_1 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| ICDR_1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | IIC_1 |
| SARX_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICMR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| SAR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| TIER | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | FRT |
| TCSR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| FRCH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| FRCL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| OCRAH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| OCRBH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| OCRAL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| OCRBL | Initialized | _ | _ | | _ | _ | _ | _ | Initialized | _ |
| TCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| TOCR | Initialized | | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRAH | Initialized | _ | _ | | _ | _ | _ | _ | Initialized | - |
| OCRARH | Initialized | | | | | | | | Initialized | _ |
| OUNAKH | minanzeu | | | <u> </u> | | | | _ | mmanzeu | |

| Register | | High-Speed/ | | | | | | | | |
|-------------------|-------------|------------------|-------------|-------|----------------|-------------|----------------|---------------------|---------------------|--------|
| Abbrevia- tion | Reset | Medium- Speed | Watch | Sleep | Sub- Active | Sub-Sleep | Module Stop | Software Standby | Hardware Standby | Module |
| ICRAL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | FRT |
| OCRARL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRBH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| OCRAFH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRBL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| OCRAFL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRCH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| OCRDMH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRCL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| OCRDML | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRDH | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICRDL | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| SMR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_2 |
| DACR | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | PWMX |
| DADRAH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| DADRAL | Initialized | - | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| BRR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_2 |
| SCR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| TDR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| SSR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| RDR_2 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| SCMR_2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| DACNTH | Initialized | - | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | PWMX |
| DADRBH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| DACNTL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| DADRBL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| TCSR_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | WDT_0 |
| TCNT_0 | Initialized | _ | | _ | _ | _ | | | Initialized | |
| PAODR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | PORT |
| PAPIN | _ | _ | _ | _ | _ | _ | _ | _ | _ | _ |
| PADDR | Initialized | _ | | _ | _ | _ | | | Initialized | _ |
| P1PCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| P2PCR | Initialized | _ | _ | _ | _ | _ | _ | | Initialized | |

| Abbreviation Reservation Reservation P3PCR Initia | et Spe | ed Wat | ch Sle | | Sub- | | Module | Software | Hardware | |
|---|---------|--------------|--------|---|--------|-----------|--------|----------|-------------|--------|
| - | | | | | Active | Sub-Sleep | Stop | Standby | Standby | Module |
| P1DDR Initia | lized — | | _ | _ | _ | _ | _ | _ | Initialized | PORT |
| | 1200 | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P2DDR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P1DR Initia | lized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P2DR Initia | ized — | _ | _ | = | _ | _ | _ | _ | Initialized | |
| P3DDR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P4DDR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P3DR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P4DR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P5DDR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P6DDR Initia | ized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| P5DR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| P6DR Initia | lized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| PBODR Initia | lized — | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| PBPIN — | _ | _ | _ | _ | _ | _ | _ | _ | _ | |
| P8DDR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| P7PIN — | _ | _ | _ | - | _ | _ | _ | _ | _ | |
| PBDDR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| P8DR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| P9DDR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| P9DR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| IER Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | INT |
| STCR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | SYSTEM |
| SYSCR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| MDCR Initia | lized — | _ | _ | - | _ | _ | _ | _ | Initialized | |
| BCR Initia | lized — | _ | _ | | _ | _ | _ | _ | Initialized | BSC |
| WSCR Initia | lized — | | | | | | | | Initialized | |
| TCR_0 Initia | lized — | | | | | | _ | | Initialized | TMR_0, |
| TCR_1 Initia | lized — | _ | _ | | _ | _ | _ | _ | Initialized | TMR_1 |
| TCSR_0 Initia | lized — | | | | | | | | Initialized | |
| TCSR_1 Initia | lized — | | | | | | _ | | Initialized | |
| TCORA_0 Initia | lized — | | | | | _ | _ | _ | Initialized | |
| TCORA_1 Initia | lized — | | | | | | | | Initialized | |

| Register Abbrevia- | Passt | High-Speed/ Medium- | Watak | Class | Sub- | Cult Class | Module | Software | Hardware | Madula |
|-----------------------|-------------|------------------------|-------------|-------|-------------|-------------|-------------|-------------|-------------|-----------------|
| tion | Reset | Speed | Watch | Sleep | Active | Sub-Sleep | Stop | Standby | Standby | Module |
| TCORB_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_0, TMR_1 |
| TCORB_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| TCNT_0 | Initialized | _ | _ | | _ | _ | _ | _ | Initialized | _ |
| TCNT_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | |
| PWOERB | Initialized | | | _ | | | _ | _ | Initialized | PWM - |
| PWOERA | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PWDPRB | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | = |
| PWDPRA | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| PWSL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| PWDR0 to PWDR15 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | |
| SMR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_0 |
| ICCR_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IIC_0 |
| BRR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_0 |
| ICSR_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | IIC_0 |
| SCR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | SCI_0 |
| TDR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | - |
| SSR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| RDR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | - |
| SCMR_0 | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| ICDR_0 | _ | _ | _ | _ | _ | _ | _ | _ | _ | IIC_0 |
| SARX_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| ICMR_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| SAR_0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | - |
| ADDRAH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | A/D |
| ADDRAL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | converter |
| ADDRBH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | = |
| ADDRBL | Initialized | <u> </u> | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | - |
| ADDRCH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| ADDRCL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | - |
| ADDRDH | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| ADDRDL | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |
| ADCSR | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | _ |

| Register Abbrevia- | | High-Speed/ Medium- | | | Sub- | | Module | Software | Hardware | |
|-----------------------|-------------|------------------------|-------------|-------|-------------|-------------|-------------|-------------|-------------|------------------|
| tion | Reset | Speed | Watch | Sleep | Active | Sub-Sleep | Stop | Standby | Standby | Module |
| ADCR | Initialized | _ | Initialized | _ | Initialized | Initialized | Initialized | Initialized | Initialized | A/D converter |
| TCSR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | WDT_1 |
| TCNT_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| HICR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | XBS |
| TCR_X | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCR_Y | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| KMIMR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | INT |
| TCSR_X | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCSR_Y | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| KMPCR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | PORT |
| TICRR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCORA_Y | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| KMIMRA | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | INT |
| TICRF | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCORB_Y | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| IDR_1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | XBS |
| TCNT_X | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCNT_Y | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| ODR_1 | _ | _ | _ | _ | _ | _ | _ | _ | _ | XBS |
| TCORC | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TISR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_Y |
| STR_1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | XBS |
| TCORA_X | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | TMR_X |
| TCORB_X | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | = |
| DADR0 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | D/A |
| DADR1 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | converter |
| DACR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | _ |
| IDR_2 | _ | _ | _ | _ | _ | _ | _ | _ | _ | XBS |
| TCONRI | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | Timer connection |
| ODR_2 | _ | _ | _ | _ | | _ | _ | _ | _ | XBS |

| Register | | High-Speed/ | | | | | | | | |
|-----------|-------------|-------------|-------|-------|--------|-----------|--------|----------|-------------|------------------|
| Abbrevia- | | Medium- | | | Sub- | | Module | Software | Hardware | |
| tion | Reset | Speed | Watch | Sleep | Active | Sub-Sleep | Stop | Standby | Standby | Module |
| TCONRO | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | Timer connection |
| STR_2 | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | XBS |
| TCONRS | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | Timer |
| SEDGR | Initialized | _ | _ | _ | _ | _ | _ | _ | Initialized | connection |

Notes: 1. Can be used on the H8S/2160B and H8S/2161B.

2. Not supported by the H8S/2148B.

RENESAS

27.4 Register Select Conditions

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name |
|---------------|---------------|---|--|-------------|
| H'FE16 | PGNOCR | _ | No condition | PORT |
| H'FE18 | PENOCR | _ | | |
| H'FE19 | PFNOCR | _ | | |
| H'FE1C | PCNOCR | _ | | |
| H'FE1D | PDNOCR | _ | | |
| H'FE20 | TWR0MW | MSTP = 0, | MSTP = 0, | LPC |
| | TWR0SW | - (HI12E = 0)* | (HI12E = 0)* | |
| H'FE21 | TWR1 | _ | | |
| H'FE22 | TWR2 | _ | | |
| H'FE23 | TWR3 | _ | | |
| H'FE24 | TWR4 | _ | | |
| H'FE25 | TWR5 | _ | | |
| H'FE26 | TWR6 | _ | | |
| H'FE27 | TWR7 | _ | | |
| H'FE28 | TWR8 | _ | | |
| H'FE29 | TWR9 | _ | | |
| H'FE2A | TWR10 | _ | | |
| H'FE2B | TWR11 | _ | | |
| H'FE2C | TWR12 | _ | | |
| H'FE2D | TWR13 | _ | | |
| H'FE2E | TWR14 | _ | | |
| H'FE2F | TWR15 | _ | | |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name |
|---------------|---------------|---|--|-------------|
| H'FE30 | IDR3 | MSTP = 0, | MSTP = 0, | LPC |
| H'FE31 | ODR3 | - (HI12E = 0)* | (HI12E = 0)* | |
| H'FE32 | STR3 | _ | | |
| H'FE34 | LADR3H | _ | | |
| H'FE35 | LADR3L | _ | | |
| H'FE36 | SIRQCR0 | _ | | |
| H'FE37 | SIRQCR1 | _ | | |
| H'FE38 | IDR1 | _ | | |
| H'FE39 | ODR1 | _ | | |
| H'FE3A | STR1 | _ | | |
| H'FE3C | IDR2 | _ | | |
| H'FE3D | ODR2 | _ | | |
| H'FE3E | STR2 | _ | | |
| H'FE3F | HISEL | _ | | |
| H'FE40 | HICR0 | _ | | |
| H'FE41 | HICR1 | _ | | |
| H'FE42 | HICR2 | _ | | |
| H'FE43 | HICR3 | _ | | |
| H'FE44 | WUEMRB | No condition | _ | INT |
| H'FE46 | PGODR | _ | No condition | PORT |
| H'FE47 | PGPIN (read) | _ | | |
| | PGDDR (write) | _ | | |
| H'FE48 | PEODR | _ | | |
| H'FE49 | PFODR | _ | | |
| H'FE4A | PEPIN (read) | _ | | |
| | PEDDR (write) | _ | | |
| H'FE4B | PFPIN (read) | | | |
| | PFDDR (write) | _ | | |
| H'FE4C | PCODR | _ | | |
| H'FE4D | PDODR | | | |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name |
|---------------|---------------|---|--|----------------------|
| H'FE4E | PCPIN (read) | _ | No condition | PORT |
| | PCDDR (write) | _ | | |
| H'FE4F | PDPIN (read) | _ | | |
| | PDDDR (write) | _ | | |
| H'FE80 | HICR2 | MSTP2 = 0 | MSTP2 = 0 | XBS |
| H'FE81 | IDR_3 | _ | | |
| H'FE82 | ODR_3 | _ | | |
| H'FE83 | STR_3 | _ | | |
| H'FE84 | IDR_4 | _ | | |
| H'FE85 | ODR_4 | _ | | |
| H'FE86 | STR_4 | _ | | |
| H'FED4 | ICXR_0 | No condition | No condition | IIC_0 |
| H'FED5 | ICXR_1 | _ | | IIC_1 |
| H'FED8 | KBCRH_0 | MSTP2 = 0 | MSTP2 = 0 | Keyboard buffer |
| H'FED9 | KBCRL_0 | _ | | controller |
| H'FEDA | KBBR_0 | _ | | |
| H'FEDC | KBCRH_1 | _ | | |
| H'FEDD | KBCRL_1 | _ | | |
| H'FEDE | KBBR_1 | _ | | |
| H'FEE0 | KBCRH_2 | _ | | |
| H'FEE1 | KBCRL_2 | _ | | |
| H'FEE2 | KBBR_2 | _ | | |
| H'FEE4 | KBCOMP | No condition | No condition | IrDA/expanded A/D |
| H'FEE6 | DDCSWR | MSTP4 = 0 | MSTP4 = 0 | IIC_0 |
| H'FEE8 | ICRA | No condition | No condition | INT |
| H'FEE9 | ICRB | _ | | |
| H'FEEA | ICRC | _ | | |
| H'FEEB | ISR | _ | | |
| H'FEEC | ISCRH | _ | | |
| H'FEED | ISCRL | | | |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name |
|---------------|---------------|---|--|-------------|
| H'FEEE | DTCERA | No condition | No condition | DTC |
| H'FEEF | DTCERB | _ | | |
| H'FEF0 | DTCERC | _ | | |
| H'FEF1 | DTCERD | _ | | |
| H'FEF2 | DTCERE | _ | | |
| H'FEF3 | DTVECR | _ | | |
| H'FEF4 | ABRKCR | No condition | No condition | INT |
| H'FEF5 | BARA | _ | | |
| H'FEF6 | BARB | _ | | |
| H'FEF7 | BARC | _ | | |
| H'FF80 | FLMCR1 | FLSHE = 1 in | FLSHE = 1 in | FLASH |
| H'FF81 | FLMCR2 | STCR | STCR | |
| H'FF82 | PCSR | FLSHE = 0 in STCR | FLSHE = 0 in STCR | PWM |
| | EBR1 | FLSHE = 1 in STCR | FLSHE = 1 in STCR | FLASH |
| H'FF83 | SYSCR2 | FLSHE = 0 in STCR | FLSHE = 0 in STCR | SYSTEM |
| | EBR2 | FLSHE = 1 in STCR | FLSHE = 1 in STCR | FLASH |
| H'FF84 | SBYCR | FLSHE = 0 in | FLSHE = 0 in | SYSTEM |
| H'FF85 | LPWRCR | STCR | STCR | |
| H'FF86 | MSTPCRH | _ | | |
| H'FF87 | MSTPCRL | _ | | |
| H'FF88 | SMR_1 | MSTP6 = 0, IICE = 0 in STCR | MSTP6 = 0,IICE = 0 in STCR | SCI_1 |
| | ICCR_1 | MSTP3 = 0, IICE = 1 in STCR | MSTP3 = 0, IICE = 1 in STCR | IIC_1 |
| H'FF89 | BRR_1 | MSTP6 = 0, IICE = 0 in STCR | MSTP6 = 0, IICE = 0 in STCR | SCI_1 |
| | ICSR_1 | MSTP3 = 0, IICE = 1 in STCR | · — | |

| Lower Address | Register Name | H8S/2148B Register Select Condition | | H8S/2160B, H8S2161B Register Select Condition | | Module Name |
|---------------|---------------|---|---------------------|--|---------------------|--------------|
| H'FF8A | SCR_1 | MSTP6 | = 0 | MSTP6 | = 0 | SCI_1 |
| H'FF8B | TDR_1 | _ | | | | |
| H'FF8C | SSR_1 | _ | | | | |
| H'FF8D | RDR_1 | _ | | | | |
| H'FF8E | SCMR_1 | MSTP6 = 0 in S | = 0, IICE TCR | MSTP6 : = 0 in S | = 0, IICE FCR | - |
| | ICDR_1 | MSTP3 = 0, IICE = | ICE = 1 in ICCR1 | MSTP3 = 0, IICE = | ICE = 1 in ICCR1 | IIC_1 |
| | SARX_1 | 1 in STCR | ICE = 0 in ICCR1 | 1 in STCR | ICE = 0 in ICCR1 | - |
| H'FF8F | ICMR_1 | _ | ICE = 1 in ICCR1 | _ | ICE = 1 in ICCR1 | - |
| | SAR_1 | _ | ICE = 0 in ICCR1 | _ | ICE = 0 in ICCR1 | - |
| H'FF90 | TIER | MSTP13 | 3 = 0 | MSTP13 | B = 0 | FRT |
| H'FF91 | TCSR | | | | | |
| H'FF92 | FRCH | | | | | |
| H'FF93 | FRCL | _ | | | | |
| H'FF94 | OCRAH | MSTP13 = 0 | OCRS = 0 in TOCR | MSTP13 = 0 | OCRS = 0 in TOCR | FRT |
| | OCRBH | _ | OCRS = 1 in TOCR | - | OCRS = 1 in TOCR | - |
| H'FF95 | OCRAL | _ | OCRS = 0 in TOCR | _ | OCRS = 0 in TOCR | - |
| | OCRBL | _ | OCRS = 1 in TOCR | - | OCRS = 1 in TOCR | - |
| H'FF96 | TCR | _ | | _ | | - |
| H'FF97 | TOCR | _ | | | | |
| H'FF98 | ICRAH | _ | ICRS = 0 in TOCR | - | ICRS = 0 in TOCR | - |
| | OCRARH | | ICRS = 1 in TOCR | - | ICRS = 1 in TOCR | - |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Register Name Condition | | | 0B, IB Select on | Module Name | |
|---------------|----------------------|--|---------------------|----------------------|---------------------------|-------------|--|
| H'FF99 | ICRAL | MSTP13 = | ICRS = 0 | MSTP13 = | ICRS = 0 | FRT | |
| | | _ 0 | in TOCR | - - | in TOCR | - | |
| | OCRARL | | ICRS = 1 in TOCR | | ICRS = 1 in TOCR | | |
| H'FF9A | ICRBH | _ | ICRS = 0 | _ | ICRS = 0 | | |
| | | | in TOCR | | in TOCR | | |
| | OCRAFH | _ | ICRS = 1 | _ | ICRS = 1 | | |
| | | | in TOCR | _ | in TOCR | | |
| H'FF9B | ICRBL | | ICRS = 0 | | ICRS = 0 | | |
| | | _ | in TOCR | = | in TOCR | <u>.</u> | |
| | OCRAFL | | ICRS = 1 | | ICRS = 1 | | |
| | | <u> </u> | in TOCR | _ | in TOCR | - | |
| H'FF9C | ICRCH | | ICRS = 0 | | ICRS = 0 | | |
| | 00000441 | _ | in TOCR | _ | in TOCR | | |
| | OCRDMH | | ICRS = 1 in TOCR | | ICRS = 1 in TOCR | | |
| H'FF9D | ICRCL | _ | | _ | | | |
| ПГГЭО | ICROL | | ICRS = 0 in TOCR | | ICRS = 0 in TOCR | | |
| | OCRDML | _ | ICRS = 1 | _ | ICRS = 1 | | |
| | OOKDINE | | in TOCR | | in TOCR | | |
| H'FF9E | ICRDH | _ | | _ | | - | |
| H'FF9F | ICRDL | _ | | | | | |
| H'FFA0 | SMR_2 | MSTP5 : = 0 in S7 | | MSTP5 = = 0 in ST | | SCI_2 | |
| | DADRAH | MSTP11 = | REGS = 0 | MSTP11 = | REGS = 0 | PWMX | |
| | | 0, IICE = 1 | in DACNT/ | 0, IICE = 1 | in DACNT/ | | |
| | | in STCR — | DADRB | in STCR | DADRB | - | |
| | DACR | | REGS = 1 | | REGS = 1 | | |
| | | | in DACNT/ DADRB | | in DACNT/ DADRB | | |
| H'FFA1 | BRR_2 | MSTP5 : = 0 in ST | = 0, IICE | MSTP5 = 0 in ST | = 0, IICE | SCI_2 | |
| | DADRAL | MSTP11 = | REGS = 0 | MSTP11 = | REGS = 0 | PWMX | |
| | 2. (2. () (<u>L</u> | 0, IICE = 1 | in DACNT/ | 0, IICE = 1 | in DACNT/ | | |
| | | in STCR | DADRB | in STCR | DADRB | | |

| Lower Address | Register Name | H8S/214 H8S/214 H8S/214 H8S/214 Registe Conditio | I1B, I5B, I8B r Select | H8S/216 H8S216 Registe Conditio | 1B r Select | Module Name |
|---------------|----------------|---|---------------------------------|--|--------------------------------|-------------|
| H'FFA2 | SCR_2 | MSTP5 | = 0 | MSTP5 | = 0 | SCI_2 |
| H'FFA3 | TDR_2 | _ | | | | |
| H'FFA4 | SSR_2 | _ | | | | |
| H'FFA5 | RDR_2 | _ | | | | |
| H'FFA6 | SCMR_2 | MSTP5 = 0 in S | = 0, IICE TCR | MSTP5 = 0 in S | = 0, IICE FCR | SCI_2 |
| | DADRBH | MSTP11 = 0, IICE = 1 in STCR | REGS = 0 in DACNT/ DADRB | MSTP11 = 0, IICE = 1 in STCR | REGS = 0 in DACNT/ DADRB | PWMX |
| | DACNTH | | REGS = 1 in DACNT/ DADRB | _ | REGS = 1 in DACNT/ DADRB | - |
| H'FFA7 | DADRBL | _ | REGS = 0 in DACNT/ DADRB | - | REGS = 0 in DACNT/ DADRB | - |
| | DACNTL | | REGS = 1 in DACNT/ DADRB | _ | REGS = 1 in DACNT/ DADRB | - |
| H'FFA8 | TCSR_0 | No cond | ition | No cond | ition | WDT_0 |
| | TCNT_0 (write) | _ | | | | |
| H'FFA9 | TCNT_0 (read) | _ | | | | |
| H'FFAA | PAODR | No cond | ition | No cond | ition | PORT |
| H'FFAB | PAPIN (read) | | | | | |
| | PADDR (write) | | | | | |
| H'FFAC | P1PCR | _ | | | | |
| H'FFAD | P2PCR | _ | | | | |
| H'FFAE | P3PCR | _ | | | | |
| H'FFB0 | P1DDR | _ | | | | |
| H'FFB1 | P2DDR | _ | | | | |
| H'FFB2 | P1DR | | | | | |
| H'FFB3 | P2DR | _ | | | | |
| H'FFB4 | P3DDR | _ | | | | |
| H'FFB5 | P4DDR | | | | | |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name | | |
|---------------|---------------|---|--|--------------|--|--|
| H'FFB6 | P3DR | No condition | No condition | PORT | | |
| H'FFB7 | P4DR | _ | | | | |
| H'FFB8 | P5DDR | _ | | | | |
| H'FFB9 | P6DDR | _ | | | | |
| H'FFBA | P5DR | _ | | | | |
| H'FFBB | P6DR | _ | | | | |
| H'FFBC | PBODR | _ | | | | |
| H'FFBD | P8DDR (write) | _ | | | | |
| | PBPIN (read) | _ | | | | |
| H'FFBE | P7PIN (read) | _ | | | | |
| | PBDDR (write) | _ | | | | |
| H'FFBF | P8DR | _ | | | | |
| H'FFC0 | P9DDR | _ | | | | |
| H'FFC1 | P9DR | _ | | | | |
| H'FFC2 | IER | No condition | No condition | INT | | |
| H'FFC3 | STCR | No condition | No condition | SYSTEM | | |
| H'FFC4 | SYSCR | _ | | | | |
| H'FFC5 | MDCR | _ | | | | |
| H'FFC6 | BCR | No condition | No condition | BSC | | |
| H'FFC7 | WSCR | _ | | | | |
| H'FFC8 | TCR_0 | MSTP12 = 0 | MSTP12 = 0 | TMR_0, TMR_1 | | |
| H'FFC9 | TCR_1 | _ | | | | |
| H'FFCA | TCSR_0 | | | | | |
| H'FFCB | TCSR_1 | _ | | | | |
| H'FFCC | TCORA_0 | _ | | | | |
| H'FFCD | TCORA_1 | _ | | | | |
| H'FFCE | TCORB_0 | _ | | | | |
| H'FFCF | TCORB_1 | _ | | | | |
| H'FFD0 | TCNT_0 | _ | | | | |
| H'FFD1 | TCNT_1 | | | | | |

| Lower Address | Register Name | H8S/214 H8S/214 H8S/214 H8S/214 Registe Condition | I1B, I5B, I8B r Select | H8S/216 H8S216 Registe Conditio | 1B r Select | Module Name |
|---------------|--------------------|--|---------------------------------|--|---------------------|-------------|
| H'FFD2 | PWOERB | No cond | ition | No cond | ition | PWM |
| H'FFD3 | PWOERA | _ | | | | |
| H'FFD4 | PWDPRB | _ | | | | |
| H'FFD5 | PWDPRA | _ | | | | |
| H'FFD6 | PWSL | MSTP11 | l = 0 | MSTP11 | = 0 | PWM |
| H'FFD7 | PWDR0 to PWDR15 | _ | | | | |
| H'FFD8 | SMR_0 | MSTP7 : = 0 in S7 | = 0, IICE FCR | MSTP7 : = 0 in S | = 0, IICE FCR | SCI_0 |
| | ICCR_0 | MSTP4 = 0, IICE = 1 in STCR | | MSTP4 = 0, IICE = 1 in STCR | | IIC_0 |
| H'FFD9 | BRR_0 | MSTP7 = 0, IICE = 0 in STCR | | MSTP7 = 0, IICE = 0 in STCR | | SCI_0 |
| | ICSR_0 | MSTP4 = 0, IICE = 1 in STCR | | MSTP4 = 0, IICE = 1 in STCR | | IIC_0 |
| H'FFDA | SCR_0 | MSTP7 | = 0 | MSTP7 | = 0 | SCI_0 |
| H'FFDB | TDR_0 | _ | | | | |
| H'FFDC | SSR_0 | _ | | | | |
| H'FFDD | RDR_0 | _ | | | | |
| H'FFDE | SCMR_0 | MSTP7 : = 0 in S7 | = 0, IICE TCR | MSTP7 := 0 in S | = 0, IICE FCR | |
| | ICDR_0 | MSTP4 = 0, IICE = 1 | ICE = 1 in ICCR0 | MSTP4 = 0, IICE = 1 | ICE = 1 in ICCR0 | IIC_0 |
| | SARX_0 | in STCR | ICE = 0 in | in STCR | ICE = 0 in | - |
| H'FFDF | ICMR_0 | MSTP4 = 0, IICE = 1 | ICE = 1 in | MSTP4 = 0, IICE = 1 | ICE = 1 in | - |
| | SAR_0 | in STCR ICE = 0 in ICCR0 | | in STCR | ICE = 0 in | |

| Lower Address | Register Name | H8S/214 H8S/214 H8S/214 H8S/214 Registe Condition | I1B, I5B, I8B r Select | H8S/216 H8S216 Registe Conditio | 1B r Select | Module Name |
|---------------|----------------|--|---------------------------------|--|----------------------------|-------------|
| H'FFE0 | ADDRAH | MSTP9 | = 0 | MSTP9 | = 0 | A/D |
| H'FFE1 | ADDRAL | _ | | | | |
| H'FFE2 | ADDRBH | _ | | | | |
| H'FFE3 | ADDRBL | _ | | | | |
| H'FFE4 | ADDRCH | _ | | | | |
| H'FFE5 | ADDRCL | _ | | | | |
| H'FFE6 | ADDRDH | _ | | | | |
| H'FFE7 | ADDRDL | _ | | | | |
| H'FFE8 | ADCSR | _ | | | | |
| H'FFE9 | ADCR | _ | | | | |
| H'FFEA | TCSR_1 | No cond | ition | No cond | ition | WDT_1 |
| | TCNT_1 (write) | _ | | | | |
| H'FFEB | TCNT_1 (read) | _ | | | | |
| H'FFF0 | HICR | MSTP2 = 1 in S | • | MSTP2 = 0, HIE = 1 in SYSCR | | XBS |
| | TCR_X | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X |
| | TCR_Y | _ | TMRX/Y = 1 in TCONRS | - | TMRX/Y = 1 in TCONRS | TMR_Y |
| H'FFF1 | KMIMR | MSTP2 = 0, HIE = 1 in SYSCR | | MSTP2 = 1 in S | • | INT |
| | TCSR_X | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X |
| | TCSR_Y | _ | TMRX/Y = 1 in TCONRS | - | TMRX/Y = 1 in TCONRS | TMR_Y |

| Lower Address | Register Name | Condition | 41B, 45B, 48B r Select on | Condition | 1B r Select on | Module Name | |
|---------------|-----------------|--------------------------------|---------------------------------------|-----------------------------|----------------------|-------------|--|
| H'FFF2 | KMPCR | MSTP2 = 1 in S | = 0, HIE YSCR | MSTP2 = 1 in S' | | PORT | |
| | TICRR | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X | |
| | TCORA_Y | _ | TMRX/Y = 1 in TCONRS | _ | TMRX/Y = 1 in TCONRS | TMR_Y | |
| H'FFF3 | KMIMRA | MSTP2 = 1 in S | = 0, HIE YSCR | MSTP2 = 1 in S | • | INT | |
| | TICRF | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X | |
| | TCORB_Y | _ | TMRX/Y = 1 in TCONRS | _ | TMRX/Y = 1 in TCONRS | TMR_Y | |
| H'FFF4 | IDR_1 | MSTP2 = 0, HIE = 1 in SYSCR | | MSTP2 = 1 in S | • | XBS | |
| | TCNT_X | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X | |
| | TCNT_Y | _ | TMRX/Y = 1 in TCONRS | _ | TMRX/Y = 1 in TCONRS | TMR_Y | |
| H'FFF5 | ODR_1 | MSTP2 = 1 in S | | MSTP2 = 1 in S | • | XBS | |
| | TCORC | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | MSTP8 = 0, HIE = 0 in SYSCR | TMRX/Y = 0 in TCONRS | TMR_X | |
| | TISR | _ | TMRX/Y = 1 in TCONRS | _ | TMRX/Y = 1 in TCONRS | TMR_Y | |
| H'FFF6 | STR_1 | MSTP2 = 1 in S | = 0, HIE YSCR | MSTP2 = 1 in S | • | XBS | |
| H'FFF7 | TCORA_X TCORB_X | MSTP8 = 0, HIE = 0 | TMRX/Y = 0 in | MSTP8 = 0, HIE = 0 | TMRX/Y = 0 in | TMR_X | |

| Lower Address | Register Name | H8S/2140B, H8S/2141B, H8S/2145B, H8S/2148B Register Select Condition | H8S/2160B, H8S2161B Register Select Condition | Module Name |
|---------------|---------------|---|--|------------------|
| H'FFF8 | DADR0 | MSTP10 = 0 | MSTP10 = 0 | D/A |
| H'FFF9 | DADR1 | _ | | |
| H'FFFA | DACR | _ | | |
| H'FFFC | IDR_2 | MSTP2 = 0, HIE = 1 in SYSCR | MSTP2 = 0, HIE = 1 in SYSCR | XBS |
| | TCONRI | MSTP8 = 0, HIE = 0 in SYSCR | MSTP8 = 0, HIE = 0 in SYSCR | Timer connection |
| H'FFFD | ODR_2 | MSTP2 = 0, HIE = 1 in SYSCR | MSTP2 = 0, HIE = 1 in SYSCR | XBS |
| | TCONRO | MSTP8 = 0, HIE = 0 in SYSCR | MSTP8 = 0, HIE = 0 in SYSCR | Timer connection |
| H'FFFE | STR_2 | MSTP2 = 0, HIE = 1 in SYSCR | MSTP2 = 0, HIE = 1 in SYSCR | XBS |
| | TCONRS | MSTP8 = 0, HIE | MSTP8 = 0, HIE | Timer connection |
| H'FFFF | SEDGR | = 0 in SYSCR | = 0 in SYSCR | |

Note: * Although setting the XBS corresponding bits does not affected to the LPC operation, the HI12E bit in SYSCR2 must not be set to 1 to use the LPC according to the limitation depending on the program development tool (emulator) configuration.

Section 28 Electrical Characteristics

28.1 Electrical Characteristics of H8S/2140B, H8S/2141B, H8S/2160B, and H8S/2161B

28.1.1 Absolute Maximum Ratings

Table 28.1 lists the absolute maximum ratings.

Table 28.1 Absolute Maximum Ratings

| Symbol | Value | Unit |
|---------------------|---|--|
| V_{cc} , V_{cL} | -0.3 to +4.3 | V |
| V _{cc} B | -0.3 to +7.0 | V |
| S, V _{in} | -0.3 to V_{cc} +0.3 | V |
| V_{in} | -0.3 to V_{cc} +0.3 | V |
| V _{in} | -0.3 to $V_{cc}B + 0.3$ | V |
| V _{in} | -0.3 V to lower of voltages V_{cc} + 0.3 and AV_{cc} + 0.3 | V |
| V _{in} | -0.3 V to lower of voltages $V_{cc}B$ + 0.3 and AV_{cc} + 0.3 | V |
| V _{in} | -0.3 to +7.0 | V |
| V_{in} | -0.3 to AV _{cc} + 0.3 | V |
| AV_{ref} | -0.3 to AV _{cc} + 0.3 | V |
| AV_cc | -0.3 to +4.3 | V |
| V_{AN} | -0.3 to AV $_{\rm cc}$ +0.3 | V |
| T _{opr} | –20 to +75 | °C |
| T _{opr} | –20 to +75 | °C |
| T _{stg} | -55 to +125 | °C |
| | V _{cc} , V _{cL} V _{cc} B S, V _{in} V _{in} V _{in} V _{in} V _{in} V _{in} V _{in} V _{in} V _{in} T _{opr} | $\begin{array}{cccccccccccccccccccccccccccccccccccc$ |

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded. Ensure so that the impressed voltage does not exceed 4.3 V for pins for which the maximum rating is determined by the voltage on the V_{cc} , AV_{cc} , and V_{cL} pins, or 7.0 V for pins for which the maximum rating is determined by $V_{cc}B$.

The V_{cc} and V_{cl} pins must be connected to the Vcc power supply.

28.1.2 DC Characteristics

Table 28.2 lists the DC characteristics. Permitted output current values and bus drive characteristics are shown in tables 28.3 and 28.4, respectively.

Table 28.2 DC Characteristics (1)

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V*}^9, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, AV_{cc}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{ref}^{*1} = 2.7 \text{ V to } AV_{cc}, V_{ss} = AV_{ss}^{*1} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------|--|-------|---|--|-----|---|-------------|--------------------|
| Schmitt trigger input | P67 to P60* ² , * ⁶ , | (1)*8 | V _T - | $V_{cc} \times 0.2$ $V_{cc}B \times 0.2$ | _ | _ | V | |
| voltage | $\overline{\text{KIN15}}$ to $\overline{\text{KIN8}}^{*7}$, $\overline{\text{IRQ2}}$ to $\overline{\text{IRQ0}}^{*3}$, | | V_T^{+} | _ | _ | $V_{cc} \times 0.7$ $V_{cc}B \times 0.7$ | | |
| | ĪRQ5 to ĪRQ3 | _ | $V_T^+ - V_T^-$ | $V_{cc} \times 0.05$ $V_{cc} B \times 0.05$ | _ | _ | | |
| Schmitt | P67 to P60 | | $V_{\scriptscriptstyle T}^{\;-}$ | $V_{cc} \times 0.2$ | _ | _ | V | |
| trigger input voltage (in | (KWUL = 00) | | $V_{T}^{^+}$ | _ | _ | $V_{cc} \times 0.7$ | _ | |
| level | | | $V_{\scriptscriptstyle T}^{\scriptscriptstyle +} - V_{\scriptscriptstyle T}^{\scriptscriptstyle -}$ | $V_{cc} \times 0.05$ | _ | _ | _ | |
| switching)*6 | P67 to P60 (KWUL = 01) | _ | V _T - | $V_{cc} \times 0.3$ | _ | _ | - - - | |
| | | | V _T ⁺ | _ | _ | $V_{cc} \times 0.7$ | | |
| | | | $V_T^+ - V_T^-$ | $V_{cc} \times 0.05$ | _ | _ | | |
| | P67 to P60 (KWUL = 10) | | V_{T}^{-} | $V_{cc} \times 0.4$ | _ | _ | | |
| | | | V_T^+ | _ | _ | $V_{cc} \times 0.8$ | | |
| | | | $V_{\scriptscriptstyle T}^{\scriptscriptstyle +} - V_{\scriptscriptstyle T}^{\scriptscriptstyle -}$ | $V_{cc} \times 0.03$ | _ | _ | _ | |
| | P67 to P60 | | V_{T}^{-} | $V_{cc} \times 0.45$ | _ | _ | _ | |
| | (KWUL = 11) | | $V_{T}^{^+}$ | _ | _ | $V_{cc} \times 0.9$ | _ | |
| | | | $V_{\scriptscriptstyle T}^{\scriptscriptstyle +} - V_{\scriptscriptstyle T}^{\scriptscriptstyle -}$ | 0.05 | _ | _ | _ | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | (2) | V _{IH} | $V_{cc} \times 0.9$ | | V _{cc} +0.3 | V | _ |
| | EXTAL | _ | | $V_{cc} \times 0.7$ | | V _{cc} +0.3 | = | |
| | PA7 to PA0* ⁷ | | | $V_{cc}B \times 0.7$ | | $V_{cc}B + 0.3$ | _ | |

| | Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------|---|-----|-----------------|-----------------------------------|-----|------------------------|------|--|
| Input high | Port 7 | (2) | V _{IH} | $V_{cc} \times 0.7$ | _ | AV _{cc} + 0.3 | V | |
| voltage | P97, P86, P52, P42(Port G is added in the H8S/2160B and H8S/2161B.) | | | $V_{cc} \times 0.7$ | _ | 5.5 | - | |
| | Input pins except (and (2) above (Ports C to F are added in the H8S/2160B and H8S/2161B.) | 1) | | $V_{cc} \times 0.7$ | _ | V _{cc} + 0.3 | - | |
| Input low voltage | RES, STBY, MD1, MD0 | (3) | V _{IL} | -0.3 | _ | $V_{cc} \times 0.1$ | V | |
| | PA7 to PA0 | | | -0.3 | _ | $V_{cc}B \times 0.2$ | _ | $V_{cc}B = 2.7 \text{ V}$ to 4.0 V |
| | | | | | | 0.8 | - | $V_{cc}B = 4.0 \text{ V}$ to 5.5 V |
| | NMI, EXTAL, input pins except (and (3) above (Ports C to G are added in the H8S/2160B and H8S/2161B.) | 1) | | -0.3 | _ | $V_{cc} \times 0.2$ | - | V _{cc} = 2.7 V to 3.6 V |
| Output high voltage | All output pins (except P97, | | V _{OH} | $V_{cc} - 0.5$ $V_{cc}B - 0.5$ | _ | _ | V | I _{OH} = -200 μA |
| | P86, P52, and P42) * ⁴ , * ⁵ , * ⁸ (Ports C to F are added in the H8S/2160B and H8S/2161B.) | | | $V_{cc} - 1.0$ $V_{cc}B - 1.0$ | _ | _ | V | $I_{OH} = -1 \text{ mA},$ $(V_{CC} = 2.7 \text{ V})$ to 3.6 V, $V_{CC}B = 2.7 \text{ V}$ to 4.5 V) |
| | P97, P86, P52, an P42* ⁴ (Port G is added in H8S/2160B and H8S/2161B.) | | | 0.5 | _ | | V | I _{OH} = -200 μA |

| | ltem | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--------------------|--|-----------------|-------------|-----|-----|------|--------------------------|
| Output low voltage | All output pins (except RESO)*5 (Ports C to G are added in the H8S/2160B and H8S/2161B.) | V _{OL} | _ | _ | 0.4 | V | I _{OL} = 1.6 mA |
| | Ports 1 to 3 | _ | | _ | 1.0 | V | I _{OL} = 5 mA |
| | RESO | _ | _ | _ | 0.4 | V | I _{oL} = 1.6 mA |

Notes: 1. <u>Do not leave the AVcc, AVref, and AVss pins open even if the A/D converter and D/A converter are not used.</u>

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV_{cc} and AV_{ref} pins by connection to the power supply (V_{cc}) , or some other method. Ensure that $AV_{ref} \le AV_{cc}$.

- 2. P67 to P60 include peripheral module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.
- 4. P52/SCK0/SCL0, P97/SDA0, P86/SCK1/SCL1, P42/SCK2/SDA1, and port G are NMOS push-pull outputs.

When the SCL0, SDA0, SCL1, or SDA1 (ICE = 1) pin is used as an output, it is NMOS open-drain output. Therefore, an external pull-up resistor must be connected in order to output high level.

P52/SCK0, P97, P86/SCK1, P42/SCK2 (ICE = 0), and port G high levels are driven by NMOS.

An external pull-up resistor is necessary to provide high-level output from SCK0, SCK1, and SCK2.

- 5. When IICS = 0, ICE = 0, and KBIOE = 0. Low-level output when the bus drive function is selected is determined separately.
- 6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 7. The upper limit of the port A applied voltage is $V_{cc}B + 0.3 V$ when CIN input is not selected, and the lower of $V_{cc}B + 0.3 V$ and $AV_{cc} + 0.3 V$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 8. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} .
- 9. For flash memory programming/erasure, the applicable range is $V_{\rm cc}$ = 3.0 V to 3.6 V.

Table 28.2 DC Characteristics (2)

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V*}^5, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, AV_{cc}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{ref}^{*1} = 2.7 \text{ V to } AV_{cc}, V_{ss} = AV_{ss}^{*1} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | ltem | | Symbol | ol Min Typ | | Max | Unit | Test Conditions |
|---|--|------------------------|------------------|------------|----|------|------|---|
| Input | RES | | I _{in} | _ | _ | 10.0 | μA | $V_{in} = 0.5 \text{ to}$ |
| leakage current | STBY, NMI, MD1, MD0 | | | _ | | 1.0 | | V _{cc} – 0.5 V |
| | Port 7 | | | _ | _ | 1.0 | | $V_{in} = 0.5 \text{ to}$ $AV_{cc} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6, 8, 9, and B (Ports C to are added in the H8S/2160B and H8S/2161B.) | A* ⁴ , G | I _{TSI} | _ | _ | 1.0 | μА | $V_{in} = 0.5 \text{ to}$ $V_{cc} - 0.5 \text{ V},$ $V_{in} = 0.5 \text{ to}$ $V_{cc}B - 0.5 \text{ V}$ |
| Input | Ports 1 to 3 | - | -I _P | 5 | _ | 150 | μΑ | $V_{in} = 0 V$, |
| pull-up MOS current | Ports 6 (P6PUE = and B (Ports C to F are added in the H8S/2160B and H8S/2161B.) | (0) | 0) | | _ | 300 | | $V_{cc} = 2.7 \text{ V to}$ 3.6 V $V_{cc}B = 2.7 \text{ V}$ to 5.5 V |
| | Ports A* ⁴ Port 6 (P6PUE = 1) | | | 30 | _ | 600 | | |
| | | | | 3 | | 100 | | |
| Input | RES | (4) | C _{in} | _ | | 80 | pF | $V_{in} = 0 \text{ V},$ $T_{in} = 1 \text{ MHz},$ $T_{in} = 25^{\circ}\text{C}$ |
| capacitance | NMI | | | _ | _ | 50 | pF | |
| | P52, P97, P42, P86, PA7 to PA2 | | | _ | _ | 20 | pF | - I _a - 20 0 |
| | Input pins except above (Ports C to G are added in the H8S/2160B and H8S/2161B.) | (4) | | _ | | 15 | pF | _ |
| Current | Normal operation | I | СС | _ | 30 | 40 | mA | f = 10 MHz |
| dissipation*2 | Sleep mode | | | _ | 20 | 32 | mA | f = 10 MHz |
| | Standby mode*3 | | | _ | 1 | 5.0 | μΑ | T _a ≤ 50°C |
| · | | | | _ | _ | 20.0 | | 50°C < T _a |

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|----------------------------|-------------------|-----|------|-----|------|---------------------------------------|
| Analog power supply current | During A/D, D/A conversion | Al _{cc} | _ | 1.2 | 2.0 | mA | |
| | Idle | _ | _ | 0.01 | 5.0 | μΑ | $AV_{cc} = 2.0 \text{ V}$ to 3.6 V |
| Reference power supply current | During A/D conversion | Al _{ref} | _ | 0.5 | 1.0 | mA | |
| | During A/D, D/A conversion | _ | _ | 2.0 | 5.0 | | |
| | Idle | _ | _ | 0.01 | 5.0 | μA | $AV_{ref} = 2.0 V$ to AV_{CC} |
| Analog power | er supply voltage*1 | AV_cc | 2.7 | _ | 3.6 | V | Operating |
| | | | 2.0 | | 3.6 | | Idle/not used |
| RAM standby voltage | | V_{RAM} | 2.0 | _ | | V | |

Notes: 1. Do not leave the AV_{cc}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV_{cc} and AV_{ref} pins by connection to the power supply (V_{cc}) , or some other method. Ensure that $AV_{ref} \leq AV_{cc}$.

- 2. Current dissipation values are for V_{IH} min = $V_{CC} 0.2$ V, $V_{CC}B 0.2$ V, and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 3. The values are for V_{RAM} \leq V_{CC} < 2.7 V, V_{IH} min = V_{CC}- 0.2 V, V_{CC}B 0.2 V, and V_{II} max = 0.2 V.
- 4. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} .
- 5. For flash memory programming/erasure, the applicable range is V_{cc} = 3.0 V to 3.6 V.

Table 28.2 DC Characteristics (3) When LPC Function is Used

Conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $AV_{cc}^* = 2.7 \text{ V}$ to 3.6 V, $AV_{ref}^* = 2.7 \text{ V}$ to AV_{cc} , $V_{ss} = AV_{ss}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75 ^{\circ}\text{C}$

| | Item | Symbol | Min | Max | Unit | Test Conditions |
|---------------------|---|-----------------|---------------------|---------------------|------|----------------------------|
| Input high voltage | P37 to P30, P83 to P80, PB1, PB0 | V_{IH} | $V_{cc} \times 0.5$ | _ | V | |
| Input low voltage | P37 to P30, P83 to P80, PB1, PB0 | V _{IL} | _ | $V_{cc} \times 0.3$ | V | |
| Output high voltage | P37, P33 to P30, P82 to P80, PB1, PB0 | V _{OH} | $V_{cc} \times 0.9$ | _ | V | $I_{OH} = -0.5 \text{ mA}$ |
| Output low voltage | P37, P33 to P30, P82 to P80, PB1, PB0 | V _{OL} | _ | $V_{cc} \times 0.1$ | V | I _{OL} = 1.5 mA |

Note:* Do not leave the AV_{cc}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV $_{cc}$ and AV $_{ref}$ pins by connection to the power supply (V $_{cc}$), or some other method. Ensure that AV $_{ref} \leq$ AV $_{cc}$.

Table 28.3 Permissible Output Currents

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C}$

| Item | | Symbol | Min | Тур | Max | Unit |
|---|--|-------------------------|-----|-----|-----|-------------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0, PS2AC to PS2CC, PS2AD to PS2CD, PA7 to PA4 (bus drive function selected) | I _{OL} | _ | _ | 10 | mA |
| | Ports 1, 2, 3 | _ | | _ | 2 | |
| | RESO | _ | _ | _ | 1 | |
| | Other output pins | _ | _ | _ | 1 | _ |
| Permissible output | Total of ports 1, 2, and 3 | \sum I _{OL} | _ | _ | 40 | mA |
| low current (total) | Total of all output pins, including the above | | _ | _ | 60 | |
| Permissible output high current (per pin) | All output pins | -I _{OH} | _ | _ | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | _ | _ | 30 | mA |

Notes: 1. To protect chip reliability, do not exceed the output current values in table 28.3.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 28.1 and 28.2.

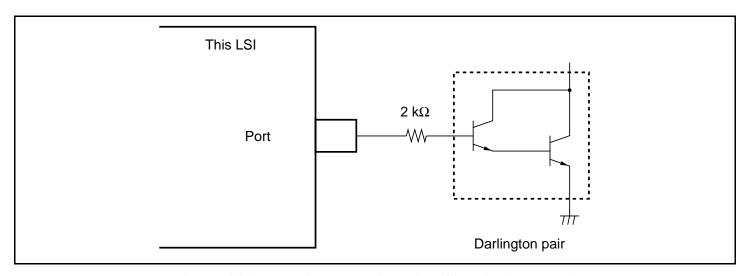


Figure 28.1 Darlington Pair Drive Circuit (Example)

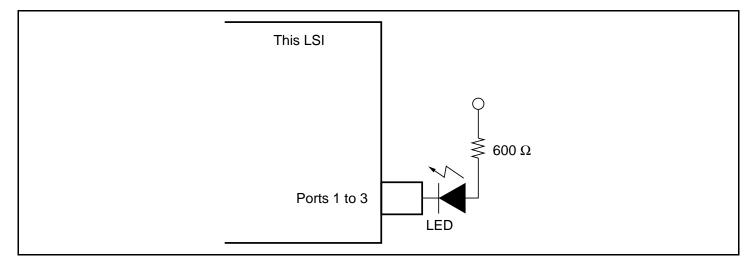


Figure 28.2 LED Drive Circuit (Example)

Table 28.4 Bus Drive Characteristics

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{ss} = 0 \text{ V}, \text{ Ta} = -20 \text{ to } +75^{\circ}\text{C}$

Applicable Pins: SCL1, SCL0, SDA1, SDA0 (bus drive function selected)

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|------------------|----------------------|-----|---------------------|------|--|
| Schmitt trigger | V _T - | $V_{cc} \times 0.3$ | _ | _ | V | $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ |
| input voltage | V_{T}^{+} | _ | _ | $V_{cc} \times 0.7$ | _ | V_{cc} = 2.7 V to 3.6 V |
| | $V_T^+ - V_T^-$ | $V_{cc} \times 0.05$ | | _ | _ | V_{cc} = 2.7 V to 3.6 V |
| Input high voltage | V _{IH} | $V_{cc} \times 0.7$ | | 5.5 | V | $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ |
| Input low voltage | V _{IL} | -0.5 | | $V_{cc} \times 0.3$ | _ | V_{cc} = 2.7 V to 3.6 V |
| Output low voltage | V _{oL} | _ | _ | 0.5 | V | I _{OL} = 8 mA |
| | | _ | | 0.4 | _ | $I_{OL} = 3 \text{ mA}$ |
| Input capacitance | C _{in} | _ | _ | 20 | pF | $V_{in} = 0 \text{ V, f} = 1 \text{ MHz,}$ $T_{a} = 25^{\circ}\text{C}$ |
| Three-state leakage current (off state) | | _ | _ | 1.0 | μΑ | $V_{in} = 0.5 \text{ to } V_{cc} - 0.5 \text{ V}$ |
| SCL, SDA output fall time | t _{Of} | 20 + 0.1Cb | _ | 250 | ns | $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}$ |

RENESAS

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, Ta = -20 \text{ to } +75^{\circ}\text{C}$

Applicable Pins: PS2AC, PS2AD, PS2BC, PS2BD, PS2CC, PS2CD, PA7 to PA4 (bus drive

function selected)

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--------------------|----------|-----|-----|-----|------|--|
| Output low voltage | V_{oL} | _ | _ | 8.0 | V | $I_{oL} = 16 \text{ mA},$ $V_{cc}B = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | | _ | _ | 0.5 | | $I_{OL} = 8 \text{ mA}$ |
| | | _ | | 0.4 | | I _{oL} = 3 mA |

28.1.3 AC Characteristics

Figure 28.3 shows the test conditions for the AC characteristics.

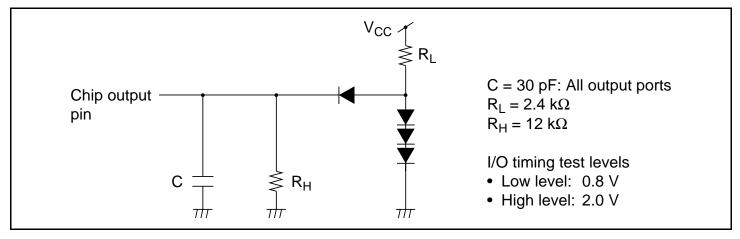


Figure 28.3 Output Load Circuit

Clock Timing: Table 28.5 shows the clock timing. The clock timing specified here covers clock (ø) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details on external clock input (EXTAL pin and EXCL pin) timing, see section 25, Clock Pulse Generator.

Table 28.5 Clock Timing

Condition: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Condition | | | | |
|---|-------------------|-----------|--------|------|-------------|--|
| | | 1 | I0 MHz | | | |
| Item | Symbol | Min | Max | Unit | Reference | |
| Clock cycle time | t _{cyc} | 100 | 500 | ns | Figure 28.6 | |
| Clock high pulse width | t _{CH} | 30 | _ | ns | Figure 28.6 | |
| Clock low pulse width | t _{CL} | 30 | _ | ns | _ | |
| Clock rise time | t _{Cr} | _ | 20 | ns | _ | |
| Clock fall time | t _{Cf} | _ | 20 | ns | | |
| Oscillation settling time at reset (crystal) | t _{osc1} | 20 | _ | ms | Figure 28.7 | |
| Oscillation settling time in software standby (crystal) | t _{osc2} | 8 | _ | ms | Figure 28.8 | |
| External clock output stabilization delay time | t _{DEXT} | 500 | _ | μs | _ | |

Control Signal Timing: Table 28.6 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768 \text{ kHz}$) are NMI and IRQ0, 1, 2, 6, and 7.

Table 28.6 Control Signal Timing

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 32.768 \text{ kHz}$, 2 MHz to

maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| | | Condition | | | | |
|--|-------------------|-----------|--------|------------------|--------------|--|
| | | 1 | I0 MHz | | Test | |
| Item | Symbol | Min | Max | Unit | Conditions | |
| RES setup time | t _{ress} | 300 | _ | ns | Figure 28.9 | |
| RES pulse width | t _{RESW} | 20 | _ | t _{cyc} | _ | |
| NMI setup time (NMI) | t _{NMIS} | 250 | _ | ns | Figure 28.10 | |
| NMI hold time (NMI) | t _{NMIH} | 10 | _ | ns | _ | |
| NMI pulse width (exiting software standby mode) | t _{NMIW} | 200 | _ | ns | _ | |
| IRQ setup time (IRQ7 to IRQ0) | t _{IRQS} | 250 | _ | ns | _ | |
| IRQ hold time(IRQ7 to IRQ0) | t _{IRQH} | 10 | _ | ns | _ | |
| IRQ pulse width (IRQ7, IRQ6, IRQ2 to IRQ0) (exiting software standby mode) | t _{IRQW} | 200 | _ | ns | | |

Bus Timing: Table 28.7 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768 \text{ kHz}$).

Table 28.7 Bus Timing (1) (Normal Mode)

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Con | dition | | |
|-------------------------|-------------------|----------------------------------|---|-----------|---------------|
| | | 10 MHz | | _ | Test |
| Item | Symbol | Min | Max | _ Unit | Conditions |
| Address delay time | t _{AD} | _ | 40 | ns | Figures 28.11 |
| Address setup time | t _{AS} | $0.5 \times t_{\text{cyc}} - 30$ | | ns | to 28.15 |
| Address hold time | t _{AH} | $0.5 \times t_{\text{cyc}} - 20$ | _ | ns | _ |
| CS delay time (IOS) | t _{CSD} | _ | 40 | ns | _ |
| AS delay time | t _{ASD} | _ | 60 | ns | _ |
| RD delay time 1 | t _{RSD1} | _ | 60 | ns | _ |
| RD delay time 2 | t _{RSD2} | _ | 60 | ns | _ |
| Read data setup time | t _{RDS} | 35 | _ | ns | _ |
| Read data hold time | t _{RDH} | 0 | _ | ns | _ |
| Read data access time 1 | t _{ACC1} | _ | $1.0 \times t_{\text{cyc}} - 60$ | ns | _ |
| Read data access time 2 | t _{ACC2} | _ | $1.5 \times t_{\text{cyc}} - 50$ | ns | _ |
| Read data access time 3 | t _{ACC3} | | $2.0 	imes t_{\scriptscriptstyle cyc} - 60$ | ns | _ |
| Read data access time 4 | t _{ACC4} | _ | $2.5 \times t_{\text{cyc}} - 50$ | ns | _ |
| Read data access time 5 | t _{ACC5} | | $3.0 	imes t_{\scriptscriptstyle 	ext{cyc}} - 60$ | ns | _ |
| HWR, LWR delay time 1 | t _{wrd1} | | 60 | ns | _ |
| HWR, LWR delay time 2 | t _{wrd2} | | 60 | ns | _ |
| HWR, LWR pulse width 1 | t _{wsw1} | $1.0 \times t_{\text{cyc}} - 40$ | | ns | _ |
| HWR, LWR pulse width 2 | t _{wsw2} | $1.5 \times t_{\text{cyc}} - 40$ | | ns | _ |
| Write data delay time | t _{wdd} | _ | 60 | ns | _ |
| Write data setup time | t _{wds} | 0 | | ns | _ |
| Write data hold time | t _{wdh} | 20 | _ | ns | _ |
| WAIT setup time | t _{wts} | 60 | _ | ns | _ |
| WAIT hold time | t _{wth} | 10 | _ | ns | _ |

Table 28.7 Bus Timing (2) (Advanced Mode)

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Condition | | | |
|-------------------------|---------------------------------|----------------------------------|---|------|-----------------------|
| | | 10 MHz | | _ | Test |
| Item | Symbol | Min | Max | Unit | Conditions |
| Address delay time | t _{AD} | _ | 60 | ns | Figures 28.11 |
| Address setup time | t _{AS} | $0.5 \times t_{\text{cyc}} - 30$ | | ns | ⁻ to 28.15 |
| Address hold time | t _{AH} | $0.5 \times t_{\text{cyc}} - 20$ | _ | ns | _ |
| CS delay time (IOS) | t _{CSD} | _ | 60 | ns | _ |
| AS delay time | t _{ASD} | _ | 60 | ns | _ |
| RD delay time 1 | t _{RSD1} | _ | 60 | ns | _ |
| RD delay time 2 | t _{RSD2} | _ | 60 | ns | |
| Read data setup time | $\mathbf{t}_{\mathtt{RDS}}$ | 35 | _ | ns | _ |
| Read data hold time | $t_{_{RDH}}$ | 0 | _ | ns | |
| Read data access time 1 | t _{ACC1} | _ | $1.0 	imes t_{\scriptscriptstyle 	ext{cyc}} - 80$ | ns | |
| Read data access time 2 | t _{ACC2} | _ | $1.5 \times t_{\text{cyc}} - 50$ | ns | _ |
| Read data access time 3 | t _{ACC3} | _ | $2.0 	imes t_{\scriptscriptstyle 	ext{cyc}} - 80$ | ns | |
| Read data access time 4 | t _{ACC4} | _ | $2.5 \times t_{\text{cyc}} - 50$ | ns | |
| Read data access time 5 | t _{ACC5} | _ | $3.0 	imes t_{\scriptscriptstyle 	ext{cyc}} - 80$ | ns | |
| HWR, LWR delay time 1 | $\mathbf{t}_{_{\mathrm{WRD1}}}$ | _ | 60 | ns | |
| HWR, LWR delay time 2 | $\mathbf{t}_{_{\mathrm{WRD2}}}$ | _ | 60 | ns | _ |
| HWR, LWR pulse width 1 | t _{wsw1} | $1.0 \times t_{\text{cyc}} - 40$ | _ | ns | _ |
| HWR, LWR pulse width 2 | $\mathbf{t}_{_{\mathrm{WSW2}}}$ | $1.5 \times t_{\text{cyc}} - 40$ | _ | ns | _ |
| Write data delay time | t _{wdd} | _ | 60 | ns | _ |
| Write data setup time | t _{wds} | 0 | _ | ns | _ |
| Write data hold time | t _{wdh} | 20 | _ | ns | _ |
| WAIT setup time | t _{wts} | 60 | _ | ns | _ |
| WAIT hold time | t _{wth} | 10 | | ns | _ |

Timing of On-Chip Peripheral Modules: Tables 28.8 to 28.11 show the on-chip peripheral module timing. The only on-chip peripheral modules that can operate in subclock operation ($\emptyset = 32.768 \text{ kHz}$) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 28.8 Timing of On-Chip Peripheral Modules (1)

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 32.768 \text{ kHz*},$ 2 MHz to maximum operating frequency, $T_a = -20 \text{ to } +75 ^{\circ}\text{C}$

| | | | | C | ondition | | | |
|--------------|-------------------------|-----------------|--------------------|-----|-------------|-------------------|------------------------|--|
| | | | | | 10 MHz | | | |
| Item | | | Symbol | Min | Max | Unit | Test Conditions | |
| I/O ports | Output data | delay time | t _{PWD} | _ | 100 | ns | Figure 28.16 | |
| | Input data se | tup time | t _{PRS} | 50 | _ | | | |
| | Input data ho | ld time | t _{PRH} | 50 | _ | | | |
| FRT | Timer output delay time | | t _{FTOD} | | 100 | ns | Figure 28.17 | |
| | Timer input s | etup time | t _{FTIS} | 50 | _ | | | |
| | Timer clock in | nput setup time | t _{FTCS} | 50 | — | | Figure 28.18 | |
| | Timer clock | Single edge | t _{FTCWH} | 1.5 | _ | t _{cyc} | _ | |
| | pulse width | Both edges | t _{FTCWL} | 2.5 | | | | |
| TMR | Timer output delay time | | t _{TMOD} | _ | 100 | ns | Figure 28.19 | |
| | Timer reset in | nput setup time | t _{TMRS} | 50 | _ | | Figure 28.21 | |
| | Timer clock in | nput setup time | t _{TMCS} | 50 | _ | | Figure 28.20 | |
| | Timer clock | Single edge | t _{mcwh} | 1.5 | _ | t _{cyc} | _ | |
| | pulse width | Both edges | t _{TMCWL} | 2.5 | _ | | | |
| PWM, PWMX | Pulse output | delay time | t _{PWOD} | _ | 100 | ns | Figure 28.22 | |
| SCI | Input clock | Asynchronous | t _{Scyc} | 4 | _ | t _{cyc} | Figure 28.23 | |
| | cycle | Synchronous | _ | 6 | _ | | | |
| | Input clock p | ulse width | t _{sckw} | 0.4 | 0.6 | t _{Scyc} | _ | |
| | Input clock ris | se time | t _{SCKr} | _ | 1.5 | t _{cyc} | _ | |
| | Input clock fa | ıll time | t _{SCKf} | _ | 1.5 | | | |

| | | | Condition 10 MHz | | | | |
|------------------|--|--------------------|------------------|-----|------------------|------------------------|--|
| | | | | | | | |
| Item | | Symbol | Min | Max | Unit | Test Conditions | |
| SCI | Transmit data delay time (synchronous) | t _{TXD} | _ | 100 | ns | Figure 28.24 | |
| | Receive data setup time (synchronous) | t _{RXS} | 100 | _ | ns | _ | |
| | Receive data hold time (synchronous) | t _{RXH} | 100 | _ | ns | _ | |
| A/D converter | Trigger input setup time | t _{TRGS} | 50 | _ | ns | Figure 28.25 | |
| WDT | RESO output delay time | t _{RESD} | | 200 | ns | Figure 28.26 | |
| | RESO output pulse width | t _{RESOW} | 132 | _ | t _{cyc} | _ | |

Note:* Only peripheral modules that can be used in subclock operation

Table 28.8 Timing of On-Chip Peripheral Modules (2)

Condition: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | | | Condition | | | |
|-------|-------------------|------------------------|---------------------|-------------|----------|------|------------------------|
| | | | | 10 MHz | | | |
| | Item | า | Symbol | Min | Max | Unit | Test Conditions |
| | CS/HA0 setup time | | t _{HAR} | 10 | _ | ns | Figure 28.27 |
| cycle | CS/HA0 ho | ld time | t _{HRA} | 10 | _ | ns | _ |
| | IOR pulse v | vidth | \mathbf{t}_{HRPW} | 220 | _ | ns | |
| | HDB delay time | | \mathbf{t}_{HRD} | _ | 200 | ns | |
| | HDB hold time | | t_{HRF} | 0 | 40 | ns | |
| | HIRQ delay time | | \mathbf{t}_{HIRQ} | | 200 | ns | _ |
| | CS/HA0 setup time | | \mathbf{t}_{HAW} | 10 | _ | ns | _ |
| cycle | CS/HA0 ho | ld time | \mathbf{t}_{HWA} | 10 | _ | ns | _ |
| | IOW pulse | width | \mathbf{t}_{HWPW} | 100 | _ | ns | |
| | HDB setup time | Fast A20 gate not used | t _{HDW} | 50 | _ | ns | _ |
| | | Fast A20 gate used | | 85 | _ | ns | _ |
| | HDB hold time | | t _{HWD} | 25 | <u> </u> | ns | _ |
| | GA20 delay | time | t _{HGA} | _ | 180 | ns | |

Table 28.9 Keyboard Buffer Controller Timing

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Ratings | | | Ratings | | | | Test | |
|--------------------------------|-------------------|------------|-----|-----|---------|------------|--------|--|------|--|
| Item | Symbol | Min | Тур | Max | Unit | Conditions | Notes | | | |
| KCLK, KD output fall time | t _{KBF} | 20 + 0.1Cb | _ | 250 | ns | | Figure | | | |
| KCLK, KD input data hold time | t _{KBIH} | 150 | _ | _ | ns | _ | 28.28 | | | |
| KCLK, KD input data setup time | t _{KBIS} | 150 | _ | _ | ns | _ | | | | |
| KCLK, KD output delay time | t _{KBOD} | _ | _ | 450 | ns | | | | | |
| KCLK, KD capacitive load | C _b | _ | _ | 400 | pF | | | | | |

Table 28.10 I²C Bus Timing

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 5 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Ratings | | | Test | | |
|---|-------------------|---------|-----|------|------------------|-------------|--------|
| Item | Symbol | Min | Тур | Max | Unit | Conditions | Notes |
| SCL input cycle time | t _{scl} | 12 | | _ | t _{cyc} | | Figure |
| SCL input high pulse width | t _{sclh} | 3 | _ | _ | t _{cyc} | | 28.29 |
| SCL input low pulse width | t _{scll} | 5 | _ | _ | t _{cyc} | | |
| SCL, SDA input rise time | t _{Sr} | _ | _ | 7.5* | t _{cyc} | | |
| SCL, SDA input fall time | t _{sf} | _ | _ | 300 | ns | | |
| SCL, SDA input spike pulse elimination time | t _{sp} | _ | _ | 1 | t _{cyc} | _ | |
| SDA input bus free time | t _{BUF} | 5 | | | t _{cyc} | | |
| Start condition input hold time | t _{STAH} | 3 | | | t _{cyc} | | |
| Retransmission start condition input setup time | t _{stas} | 3 | _ | _ | t _{cyc} | | |
| Stop condition input setup time | t _{stos} | 3 | | | t _{cyc} | | |
| Data input setup time | t _{SDAS} | 0.5 | | | t _{cyc} | | |
| Data input hold time | t _{SDAH} | 0 | | | ns | | |
| SCL, SDA capacitive load | C _b | | _ | 400 | рF | | |

Note:* 17.5 t_{cyc} can be set according to the clock selected for use by the I²C module. For details, see section 16.6, Usage Notes.

Table 28.11 LPC Module Timing

Conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|------|-------------------------------------|-------------------|-----|-----|-----|------|------------------------|
| LPC | Input clock cycle | t _{Lcyc} | 30 | _ | | ns | Figure 28.30 |
| | Input clock pulse width (H) | t _{LCKH} | 11 | _ | _ | _ | |
| | Input clock pulse width (L) | t _{LCKL} | 11 | _ | _ | _ | |
| | Transmit signal delay time | t _{TXD} | 2 | _ | 11 | _ | |
| | Transmit signal floating delay time | t _{OFF} | | | 28 | _ | |
| | Receive signal setup time | t _{RXS} | 7 | _ | | _ | |
| | Receive signal hold time | t _{RXH} | 0 | _ | _ | | |

28.1.4 A/D Conversion Characteristics

Tables 28.12 and 28.13 list the A/D conversion characteristics.

Table 28.12 A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion)

Conditions: $V_{cc} = 2.7 \text{ V}$ to 3.6 V, $AV_{cc} = 2.7 \text{ V}$ to 3.6 V, $AV_{ref} = 2.7 \text{ V}$ to AV_{cc} ,

 $V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = AV_{ss} = 0 \text{ V},$

 $\emptyset = 2$ MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| Item | Min | Тур | Max | Unit |
|-------------------------------------|-----|-----|------|------|
| Resolution | 10 | | | bits |
| Conversion time | _ | _ | 13.4 | μs |
| Analog input capacitance | _ | _ | 20 | pF |
| Permissible signal-source impedance | _ | _ | 5 | kΩ |
| Nonlinearity error | _ | _ | ±7.0 | LSB |
| Offset error | _ | _ | ±7.5 | LSB |
| Full-scale error | _ | _ | ±7.5 | LSB |
| Quantization error | _ | _ | ±0.5 | LSB |
| Absolute accuracy | _ | _ | ±8.0 | LSB |

Table 28.13 A/D Conversion Characteristics (CIN15 to CIN0 Input: 134/266-State Conversion)

Conditions: $V_{CC} = 3.0 \text{ V}$ to 3.6 V, $AV_{CC} = 3.0 \text{ V}$ to 3.6 V, $AV_{ref} = 3.0 \text{ V}$ to AV_{CC} , $V_{CC}B = 3.0 \text{ V}$ to 5.5 V, $V_{SS} = AV_{SS} = 0 \text{ V}$,

 $\emptyset = 2$ MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| Item | Min | Тур | Max | Unit |
|-------------------------------------|-----|-----|-------|----------|
| Resolution | 10 | | | bits |
| Conversion time | _ | _ | 13.4 | μs |
| Analog input capacitance | _ | _ | 20 | pF |
| Permissible signal-source impedance | _ | _ | 5 | kΩ |
| Nonlinearity error | _ | _ | ±11.0 | LSB |
| Offset error | _ | _ | ±11.5 | LSB |
| Full-scale error | _ | _ | ±11.5 | LSB |
| Quantization error | _ | _ | ±0.5 | LSB |
| Absolute accuracy | _ | _ | ±12.0 | LSB |
| | | | | |

28.1.5 D/A Conversion Characteristics

Table 28.14 lists the D/A conversion characteristics.

Table 28.14 D/A Conversion Characteristics

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, \text{ AV}_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, \text{ AV}_{ref} = 2.7 \text{ V to } \text{AV}_{cc}, V_{cc} = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = \text{AV}_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz to maximum operating frequency}, T_a = -20 \text{ to } +75 ^{\circ}\text{C}$

| | | | 10 MHz | | | |
|-------------------|-----------------------------|-----|-------------|------|----------|--|
| | Item | Min | Тур | Max | Unit | |
| Resolution | | 8 | | | bits | |
| Conversion time | With 20 pF load capacitance | | _ | 10 | μs | |
| Absolute accuracy | With 2 MΩ load resistance | | ±2.0 | ±3.0 | LSB | |
| | With 4 MΩ load resistance | _ | | ±2.0 | | |

28.1.6 Flash Memory Characteristics

Table 28.15 shows the flash memory characteristics.

Table 28.15 Flash Memory Characteristics

Conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{ss} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| Item | | Symbol | Min | Тур | Max | Unit | Test Condition |
|---|--|------------------|-----|-----|------|----------------|-------------------|
| Programming time* ¹ , * ² ,* ⁴ | | t _P | | 10 | 200 | ms/ 128 byt | es |
| Erase time*1, | * ³ ,* ⁶ | t _E | _ | 100 | 1200 | ms/ block | |
| Reprogrammi | ng count | N _{wec} | _ | | 100 | times | |
| Programming | Wait time after SWE-bit setting* ¹ | х | 1 | _ | _ | μs | |
| | Wait time after PSU-bit setting*1 | У | 50 | _ | _ | μs | |
| | Wait time after P-bit setting* ¹ , * ⁴ | z1 | 28 | 30 | 32 | μs | 1 ≤ n ≤ 6 |
| | P-bit setting*', ** | z2 | 198 | 200 | 202 | μs | 7 ≤ n ≤ 1000 |
| | | z3 | 8 | 10 | 12 | μs | Additional write |
| | Wait time after P-bit clear*1 | α | 5 | _ | _ | μs | |
| | Wait time after PSU-bit clear*1 | β | 5 | _ | _ | μs | |
| | Wait time after PV-bit setting*1 | γ | 4 | _ | _ | μs | |
| | Wait time after dummy write*1 | ε | 2 | _ | _ | μs | |
| | Wait time after PV-bit clear*1 | η | 2 | _ | _ | μs | |
| | Wait time after SWE-bit clear*1 | θ | 100 | _ | _ | μs | |
| | Maximum programming count* ¹ , * ⁴ ,* ⁵ | N | _ | _ | 1000 | times | |

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-------|--|--------|-----|-----|-----|-------|--------------------|
| Erase | Wait time after SWE-bit setting* ¹ | Х | 1 | _ | | μs | |
| | Wait time after ESU-bit setting*1 | у | 100 | _ | _ | μs | |
| | Wait time after E-bit setting* ¹ , * ⁶ | Z | 10 | _ | 100 | ms | |
| | Wait time after E-bit clear*1 | α | 10 | _ | _ | μs | |
| | Wait time after ESU-bit clear*1 | β | 10 | _ | _ | μs | |
| | Wait time after EV-bit setting*1 | γ | 20 | _ | _ | μs | |
| | Wait time after dummy write*1 | ε | 2 | _ | | μs | |
| | Wait time after EV-bit clear*1 | η | 4 | _ | | μs | |
| | Wait time after SWE-bit clear*1 | θ | 100 | _ | _ | μs | |
| | Maximum erase count*1, *6, *7 | N | | _ | 120 | times | |

Notes: 1. Set the times according to the program/erase algorithms.

- 2. Programming time per 128 bytes (Shows the total period for which the P-bit in FLMCR1 is set. It does not include the programming verification time.)
- 3. Block erase time (Shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
- 4. Maximum programming time (t_p (max))
 - t_p (max) = (wait time after P-bit setting (z1) + (z3)) × 6
 - + wait time after P-bit setting $(z2) \times ((N) 6)$
- 5. The maximun number of writes (N) should be set according to the actual set value of z1, z2 and z3 to allow programming within the maximum programming time (t_P (max)). The wait time after P-bit setting (z1, z2, and z3) should be alternated according to the number of writes (n) as follows:

$$1 \le n \le 6$$
 $z1 = 30\mu s$, $z3 = 10\mu s$
 $7 \le n \le 1000$ $z2 = 200\mu s$

- 6. Maximum erase time $(t_E (max))$
 - $t_{_E}$ (max) = Wait time after E-bit setting (z) × maximum erase count (N)
- 7. The maximum number of erases (N) should be set according to the actual set value of z to allow erasing within the maximum erase time (t_E (max)).

28.1.7 Usage Note

The method of connecting an external capacitor is shown in figure 28.4. Connect the system power supply to the VCL pin together with the VCC pins.

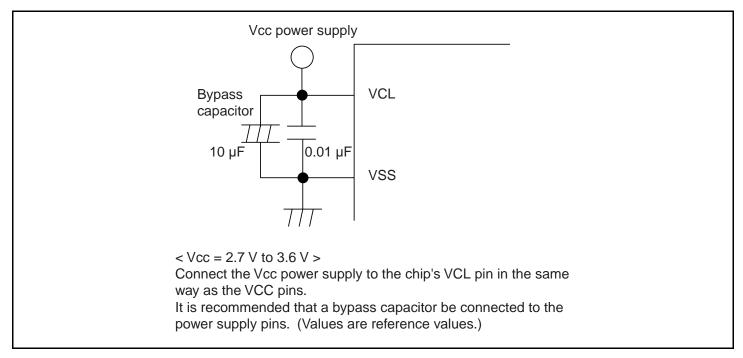


Figure 28.4 Connection of VCL Capacitor

28.2 Electrical Characteristics of H8S/2145B and H8S/2148B

28.2.1 Absolute Maximum Ratings

Table 28.16 lists the absolute maximum ratings.

Table 28.16 Absolute Maximum Ratings

| Item | Symbol Value | | | | | |
|--|-------------------|---|----|--|--|--|
| Power supply voltage*1 | V_{cc} | -0.3 to +7.0 | V | | | |
| I/O buffer power supply voltage (power supply for port A) | V _{cc} B | -0.3 to +7.0 | V | | | |
| Power supply voltage (3-V version product)*1 | V _{cc} | -0.3 to +4.3 | V | | | |
| Power supply voltage (VCL pin)*2 | V _{CL} | -0.3 to +4.3 | V | | | |
| Input voltage (except ports 6, 7, and A, P97, P86, P52, P42) | V_{in} | -0.3 to V_{cc} +0.3 | V | | | |
| Input voltage (CIN input not selected for port 6) | V _{in} | -0.3 to V _{cc} +0.3 | V | | | |
| Input voltage (CIN input not selected for port A) | V_{in} | -0.3 to V _{cc} B +0.3 | V | | | |
| Input voltage (CIN input selected for port 6) | V_{in} | -0.3 V to lower of voltages V_{cc} + 0.3 and AV_{cc} + 0.3 | V | | | |
| Input voltage (CIN input selected for port A) | V_{in} | -0.3 V to lower of voltages $V_{cc}B + 0.3$ and $AV_{cc} + 0.3$ | V | | | |
| Input voltage (P97, P86, P52, P42) | V _{in} | -0.3 to +7.0 | V | | | |
| Input voltage (port 7) | V_{in} | $-0.3 \text{ to AV}_{cc} + 0.3$ | V | | | |
| Reference supply voltage | AV_{ref} | $-0.3 \text{ to AV}_{cc} + 0.3$ | V | | | |
| Analog power supply voltage | AV_cc | -0.3 to +7.0 | V | | | |
| Analog power supply voltage (3-V version product) | AV _{cc} | -0.3 to +4.3 | V | | | |
| Analog input voltage | V _{AN} | -0.3 to AV _{cc} +0.3 | V | | | |
| Operating temperature | T _{opr} | Normal specification product: -20 to +75 | °C | | | |
| | | Wide range temperature specification product: –40 to +85 | _ | | | |
| Operating temperature (flash memory programming/erasing) | T _{opr} | Normal specification product: -20 to +75 | °C | | | |
| | | Wide range temperature specification product: –40 to +85 | _ | | | |
| Storage temperature | T_{stg} | -55 to +125 | °C | | | |

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

Ensure that for 5-V/4-V version products, the input pin voltage does not exceed 7.0 V, and for 3-V version products, all the input voltage except for port A does not exceed 4.3 V.

Notes: 1. Voltage applied to the VCC1 pin. Since both the VCC1 pin and VCL pin are connected to the VCC power supply on low-power voltage (3-V) products, VCL ratings should not be exceeded.

2. Power supply voltage pin used for operation within the chip. Do not apply power supply voltage to the VCL pin on 5-V/4-V products. Be sure to insert an external capacitor between the VCL pin and GND to regulate the internal voltage.

28.2.2 DC Characteristics

Table 28.17 lists the DC characteristics. Permitted output current values and bus drive characteristics are shown in tables 28.18 and 28.19, respectively.

Table 28.17 DC Characteristics (1)

Conditions: $V_{cc} = 5.0 \text{ V} \pm 10 \text{ %}, V_{cc}B = 5.0 \text{ V} \pm 10 \text{ %}, AV_{cc}^{*1} = 5.0 \text{ V} \pm 10 \text{ %}, AV_{ref}^{*1} = 4.5 \text{ V} \text{ to } AV_{cc}, V_{ss} = AV_{ss}^{*1} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C} \text{ (normal specification product)}, T_a = -40 \text{ to } +85^{\circ}\text{C} \text{ (wide range temperature specification product)}$

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--|--|-----------------------------|----------------------|-----|---|--------------|--------------------|
| Schmitt trigger input voltage | P67 to P60 (KWUL $= 00)^{*2}$, * ⁶ , $\overline{\text{KIN15}}$ to $\overline{\text{KIN8}}^{*7}$, * ⁸ | (1) V _T | 1.0 | _ | _ | V | |
| | IRQ2 to IRQ0*3, IRQ5 to IRQ3 | V _T ⁺ | _ | | $\begin{array}{c} V_{cc} \times 0.7 \\ V_{cc} B \times 0.7 \end{array}$ | - | |
| | | $V_T^+ - V_T^-$ | 0.4 | _ | _ | | |
| Schmitt trigger input voltage (in level switching)* ⁶ | P67 to P60 | V _T - | $V_{cc} \times 0.3$ | _ | _ | V | |
| | (KWUL = 01) | V_{T}^{+} | _ | _ | $V_{cc} \times 0.7$ | _ | |
| | | $V_{T}^{+} - V_{T}^{-}$ | $V_{cc} \times 0.05$ | _ | _ | _ | |
| | P67 to P60 (KWUL = 10) | V _T - | $V_{cc} \times 0.4$ | _ | _ | _ | |
| | | V_{T}^{+} | _ | _ | $V_{cc} \times 0.8$ | _ | |
| | | $V_T^+ - V_T^-$ | $V_{cc} \times 0.03$ | _ | _ | _ | |
| | P67 to P60 | V _T - | $V_{cc} \times 0.45$ | _ | _ | _ | |
| | (KWUL = 11) | V_{T}^{+} | _ | _ | $V_{cc} \times 0.9$ | _ | |
| | | $V_T^+ - V_T^-$ | 0.05 | | _ | _ | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | (2) V _{IH} | $V_{cc} - 0.7$ | | V _{cc} + 0.3 | V | |
| | EXTAL | | $V_{cc} \times 0.7$ | _ | V _{cc} + 0.3 | = | |
| | PA7 to PA0* ⁷ | | $V_{cc}B \times 0.7$ | _ | $V_{cc}B + 0.3$ | _ | |
| | Port 7 | | 2.0 | _ | $AV_{cc} + 0.3$ | = | |
| | P97, P86, P52, P42 | | $V_{cc} \times 0.7$ | _ | 5.5 | - | |
| | Input pins except (1) and (2) above | | 2.0 | | V _{cc} + 0.3 | _ | |

| | | | | | | | Test |
|---------------------|---|-------------------------|-----------------------------------|-----|-----|------|---------------------------|
| Item | | Symbol | Min | Тур | Max | Unit | Conditions |
| Input low voltage | RES, STBY, (3 MD1, MD0 |) V _{IL} | -0.3 | _ | 0.5 | V | |
| | PA7 to PA0 | | -0.3 | | 1.0 | | |
| | NMI, EXTAL, input pins except (1) and (3) above |) | -0.3 | | 0.8 | | |
| Output high voltage | All output pins (except P97, P86, P | V _{он} 252, | $V_{cc} - 0.5$ $V_{cc}B - 0.5$ | _ | _ | V | $I_{OH} = -200 \ \mu A$ |
| | and P42)* ⁵ , * ⁸ | | 3.5 | | | V | $I_{OH} = -1 \text{ mA},$ |
| | P97, P86, P52, and P42*4 | | 2.0 | _ | _ | V | $I_{OH} = -200 \ \mu A$ |
| Output low voltage | All output pins (except RESO)*5 | V _{oL} | _ | _ | 0.4 | V | I _{OL} = 1.6 mA |
| | Ports 1 to 3 | | | | 1.0 | V | I _{OL} = 10 mA |
| | RESO | | | _ | 0.4 | V | I _{OL} = 2.6 mA |

Notes: 1. <u>Do not leave the AV_{CC1} AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A</u> converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV $_{\rm cc}$ and AV $_{\rm ref}$ pins by connection to the power supply (V $_{\rm cc}$), or some other method. Ensure that AV $_{\rm ref}$ \leq AV $_{\rm cc}$.

- 2. P67 to P60 include peripheral module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.
- 4. P52/SCK0/SCL0, P97/SDA0, P86/SCK1/SCL1, P42/SCK2/SDA1, and port G are NMOS push-pull outputs.

When the SCL0, SDA0, SCL1, or SDA1 (ICE = 1) pin is used as an output, it is NMOS open-drain output. Therefore, an external pull-up resistor must be connected in order to output high level.

P52/SCK0, P97, P86/SCK1, P42/SCK2 (ICE = 0), and port G high levels are driven by NMOS.

When the SCK0, SCK1, or SCK2 pin is used as an output, an external pull-up resistor must be connected in order to output high level.

- 5. When IICS = 0, ICE = 0, and KBIOE = 0. Low-level output when the bus drive function is selected is determined separately.
- 6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 7. The upper limit of the port A applied voltage is $V_{cc}B + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{cc}B + 0.3 \text{ V}$ and $AV_{cc} + 0.3 \text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 8. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} in output mode.

Table 28.17 DC Characteristics (2)

Conditions: $V_{cc} = 5.0 \text{ V} \pm 10 \text{ %}, V_{cc} B = 5.0 \text{ V} \pm 10 \text{ %}, AV_{cc}^{*1} = 5.0 \text{ V} \pm 10 \text{ %}, AV_{ref}^{*1} = 4.5 \text{ V} \text{ to } AV_{cc}, V_{ss} = AV_{ss}^{*1} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C} \text{ (normal specification of the content$

product), $T_a = -40$ to +85°C (wide range temperature specification product)

| | ltem | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|---|------------------|-----|------|------|------|--|
| Input | RES | I _{in} | | _ | 10.0 | μA | $V_{in} = 0.5 \text{ to}$ |
| leakage current | STBY, NMI, MD1, MD0 | | _ | _ | 1.0 | | $V_{cc} - 0.5 V$ |
| | Port 7 | | _ | _ | 1.0 | | $\overline{V_{in} = 0.5 \text{ to}}$ $AV_{cc} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6 Ports 8, 9, A* ⁴ , B | I _{TSI} | _ | _ | 1.0 | μΑ | $V_{in} = 0.5 \text{ to}$ $V_{cc} - 0.5 \text{ V},$ $V_{in} = 0.5 \text{ to}$ $V_{cc}B - 0.5 \text{ V}$ |
| Input pull-up | Ports 1 to 3 | -I _P | 30 | | 300 | μΑ | $V_{in} = 0 V$ |
| MOS current | Ports A* ⁴ , B, 6 (P6PUE = 0) | | 60 | _ | 600 | μΑ | _ |
| | Port 6 (P6PUE = 1) | | 15 | _ | 200 | μΑ | _ |
| Input | RES (4) | C _{in} | | | 80 | pF | $V_{in} = 0 V$, |
| capacitance | NMI | | _ | _ | 50 | | f = 1 MHz, $T_a = 25$ °C |
| | P52, P97, P42, P86, PA7 to PA2 | | _ | _ | 20 | | 1 _a – 20 0 |
| | Input pins except (4) above | | _ | _ | 15 | | |
| Current | Normal operation | I _{cc} | | 55 | 70 | mA | f = 20 MHz |
| dissipation*2 | Sleep mode | | _ | 36 | 55 | mA | f = 20 MHz |
| | Standby mode*3 | | _ | 1.0 | 5.0 | μΑ | T _a ≤ 50°C |
| | | | _ | _ | 20.0 | | 50°C < T _a |
| Analog power | During A/D, D/A conversion | Al _{cc} | _ | 1.2 | 2.0 | mA | _ |
| supply current | Idle | | _ | 0.01 | 5.0 | μΑ | $AV_{cc} = 2.0 \text{ V}$ to 5.5 V |

| | ltem | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------|----------------------------|------------------|-----|------|-----|------|------------------------------------|
| Reference | During A/D conversion | Al_{ref} | _ | 0.5 | 1.0 | mA | |
| power supply | During A/D, D/A conversion | _ | _ | 2.0 | 5.0 | | |
| current | Idle | _ | _ | 0.01 | 5.0 | μA | $AV_{ref} = 2.0 V$ to AV_{CC} |
| Analog power | er supply voltage*1 | AV _{cc} | 4.5 | | 5.5 | V | Operating |
| | | | 2.0 | _ | 5.5 | | Idle/not used |
| RAM standb | y voltage | V_{RAM} | 2.0 | _ | _ | V | |

Notes: 1. Do not leave the AV_{CC}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV_{cc} and AV_{ref} pins by connection to the power supply (V_{cc}) , or some other method. Ensure that $AV_{ref} \le AV_{cc}$.

- 2. Current dissipation values are for $V_{\rm IH}$ min = $V_{\rm CC}$ 0.2 V, $V_{\rm CC}$ B 0.2 V, and $V_{\rm IL}$ max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 3. The values are for V_{RAM} \leq V_{CC} < 4.5 V, V_{IH} min = V_{CC}- 0.2 V, V_{CC}B 0.2 V, and V_{II} max = 0.2 V.
- 4. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} .

Table 28.17 DC Characteristics (3)

Conditions: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc}B = 4.0 \text{ V to } 5.5 \text{ V}, AV_{cc}^{*1} = 4.0 \text{ V to } 5.5 \text{ V}, AV_$

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------|---|---|-------------------------|-----|---|------|---|
| Schmitt | P67 to P60 (KWUL (| 1) V _T | 1.0 | _ | _ | V | V _{cc} = 4.5 V |
| trigger input voltage | = $00)^{*^{2}}$, * ⁶ , $\overline{\text{KIN15}}$ to $\overline{\text{KIN8}}^{*^{7}}$, * ⁸ , | V _T ⁺ | _ | _ | $\begin{array}{c} V_{cc} \times 0.7 \\ V_{cc} B \times 0.7 \end{array}$ | V | $^{-}$ to 5.5 V, $V_{cc}B = 4.5 V$ to 5.5 V |
| | ĪRQ2 to ĪRQ0*3, | $V_T^+ - V_T^-$ | 0.4 | _ | _ | _ | 10 0.0 V |
| | IRQ5 to IRQ3 | V_{T}^{-} | 0.8 | _ | _ | V | $V_{cc} = 4.0 \text{ V}$ to 4.5 V, $V_{cc}B = 4.0 \text{ V}$ to 4.5 V |
| | | V _T ⁺ | _ | | $\begin{array}{c} V_{cc} \times 0.7 \\ V_{cc} B \times 0.7 \end{array}$ | _ | |
| | _ | $V_T^+ - V_T^-$ | 0.3 | _ | _ | | 10 1.0 V |
| Schmitt | P67 to P60 | $V_{\scriptscriptstyle T}^{-}$ | $V_{cc} \times 0.3$ | _ | _ | V | $V_{cc} = 4.0 \text{ V}$ |
| trigger input voltage (in | (KWUL = 01) | $V_{T}^{}^{T}}$ | _ | _ | $V_{cc} \times 0.7$ | | to 5.5 V |
| level | | $V_{\scriptscriptstyle T}^{\scriptscriptstyle +} - V_{\scriptscriptstyle T}^{\scriptscriptstyle -}$ | $V_{cc} \times 0.05$ | _ | _ | | |
| switching)*6 | P67 to P60 (KWUL = 10) | V_{T}^{-} | $V_{cc} \times 0.4$ | _ | _ | | |
| | | $V_{T}^{}^{T}}$ | _ | _ | $V_{cc} \times 0.8$ | | |
| | | $V_T^+ - V_T^-$ | $V_{cc} \times 0.03$ | _ | _ | _ | |
| | P67 to P60 | V_{T}^{-} | $V_{cc} \times 0.45$ | _ | | _ | |
| | (KWUL = 11) | $V_{T}^{}^{+}}$ | _ | _ | $V_{cc} \times 0.9$ | _ | |
| | | $V_T^+ - V_T^-$ | 0.05 | _ | _ | | |
| Input high voltage | RES, STBY, (2 NMI, MD1, MD0 | 2) V _{IH} | $V_{cc} - 0.7$ | | V _{cc} +0.3 | V | |
| | EXTAL | | $V_{\rm cc} \times 0.7$ | _ | V _{cc} + 0.3 | _ | |
| | PA7 to PA0* ⁷ | | $V_{cc}B \times 0.7$ | _ | $V_{cc}B + 0.3$ | | |
| | Port 7 | | 2.0 | _ | AV _{cc} + 0.3 | | |
| | P97, P86, P52, P42 | | $V_{cc} \times 0.7$ | _ | 5.5 | _ | |
| | Input pins except (1) and (2) above | | 2.0 | | V _{cc} +0.3 | _ | |

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------|---|-----------------|-----------------------------------|-----|-----|------|--|
| Input low | RES, STBY, (3) | V _{IL} | -0.3 | | 0.5 | V | |
| voltage | MD1, MD0 | | -0.3 | | 1.0 | | $V_{cc}B = 4.5 \text{ V}$ to 5.5 V |
| | PA7 to PA0 | | -0.3 | | 0.8 | | $V_{cc}B = 4.0 \text{ V}$ to 4.5 V |
| | NMI, EXTAL, input pins except (1) and (3) above | _ | -0.3 | | 0.8 | | |
| Output high voltage | All output pins (except P97, P86, P52 | V _{OH} | $V_{cc} - 0.5$ $V_{cc}B - 0.5$ | | _ | V | $I_{OH} = -200 \mu A$ |
| | and P42)* ⁴ ,* ⁵ , * ⁸ | | 3.5 | | _ | V | $I_{OH} = -1 \text{ mA},$ |
| | | | | | | | $V_{cc} = 4.5 \text{ V to}$ 5.5 V, $V_{cc}B =$ 4.5 V to 5.5 V |
| | | | 3.0 | _ | _ | V | $I_{OH} = -1 \text{ mA},$ $V_{CC} = 4.0 \text{ V to}$ $4.5 \text{ V}, V_{CC}B =$ $4.0 \text{ V to } 4.5 \text{ V}$ |
| | P97, P86, P52, and P42*4 | _ | 1.5 | _ | _ | V | $I_{OH} = -200 \mu A$ |
| Output low voltage | All output pins (except RESO)*5 | V _{OL} | _ | _ | 0.4 | V | I _{OL} = 1.6 mA |
| | Ports 1 to 3 | <u> </u> | _ | | 1.0 | V | I _{OL} = 10 mA |
| | RESO | _ | | _ | 0.4 | V | I _{OL} = 2.6 mA |

Notes: 1. Do not leave the AV_{cc}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV $_{\rm cc}$ and AV $_{\rm ref}$ pins by connection to the power supply (V $_{\rm cc}$), or some other method. Ensure that AV $_{\rm ref}$ \leq AV $_{\rm cc}$.

- 2. P67 to P60 include peripheral module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.
- 4. P52/SCK0/SCL0, P97/SDA0, P86/SCK1/SCL1, P42/SCK2/SDA1, and port G are NMOS push-pull outputs.

When the SCL0, SDA0, SCL1, or SDA1 (ICE = 1) pin is used as an output, it is NMOS open-drain output. Therefore, an external pull-up resistor must be connected in order to output high level.

P52/SCK0, P97, P86/SCK1, P42/SCK2 (ICE = 0), and port G high levels are driven by NMOS.

- When the SCK0, SCK1, or SCK2 pin is used as an output, an external pull-up resistor must be connected in order to output high level.
- 5. When IICS = 0, ICE = 0, and KBIOE = 0. Low-level output when the bus drive function is selected is determined separately.
- 6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 7. The upper limit of the port A applied voltage is $V_{cc}B + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{cc}B + 0.3 \text{ V}$ and $AV_{cc} + 0.3 \text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 8. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} .

Table 28.17 DC Characteristics (4)

Conditions: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc}B = 4.0 \text{ V to } 5.5 \text{ V}, AV_{cc}^{*1} = 4.0 \text{ V to } 5.5 \text{ V}, AV_$

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|---|-------------------|-----|-----|------|------|--|
| Input | RES | I _{in} | _ | _ | 10.0 | μΑ | $V_{in} = 0.5 \text{ to}$ |
| leakage current | STBY, NMI, MD1, MD0 | | _ | | 1.0 | | V _{cc} –0.5 V |
| | Port 7 | | _ | _ | 1.0 | | $\overline{V_{in} = 0.5 \text{ to}}$ $AV_{cc} - 0.5 \text{ V}$ |
| Three-state leakage current (off state) | Ports 1 to 6 Ports 8, 9, A* ⁴ , B | I _{TSI} | _ | _ | 1.0 | μΑ | $V_{in} = 0.5 \text{ to}$ $V_{cc} - 0.5 \text{ V},$ $V_{in} = 0.5 \text{ to}$ $V_{cc}B - 0.5 \text{ V}$ |
| Input pull-up | Ports 1 to 3 | -I _P | 30 | _ | 300 | μΑ | $V_{in} = 0 V$, |
| MOS current | Ports A* ⁴ , B, 6 (P6PUE = 0) | | 60 | | 600 | | $V_{cc} = 4.5 \text{ V to}$ 5.5 V, $V_{cc}B =$ 4.5 V to 5.5 |
| | Port 6 (P6PUE = 1) | | 15 | _ | 200 | | V 10 0.5 |
| | Ports 1 to 3 | | 20 | _ | 200 | μΑ | $V_{in} = 0 V$, |
| | Ports A* ⁴ , B, 6 (P6PUE = 0) | | 40 | _ | 500 | | $V_{cc} = 4.0 \text{ V to}$ $4.5 \text{ V}, V_{cc}B =$ 4.0 V to 4.5 |
| | Port 6 (P6PUE = 1) | | 10 | | 150 | | V 10 4.5 |
| Input | RES (4 |) C _{in} | | _ | 80 | pF | $V_{in} = 0 V$, |
| capacitance | NMI | | _ | _ | 50 | | f = 1 MHz, $T_a = 25$ °C |
| | P52, P97, P42, P86, PA7 to PA2 | | _ | _ | 20 | | 1 _a – 20 0 |
| | Input pins except (4 above |) | _ | _ | 15 | | |
| Current | Normal operation | I _{cc} | _ | 45 | 58 | mA | f = 16 MHz |
| dissipation*2 | Sleep mode | | _ | 30 | 46 | mA | f = 16 MHz |
| | Standby mode*3 | | _ | 1.0 | 5.0 | μΑ | T _a ≤ 50°C |
| | | | | _ | 20.0 | _ | 50°C < T _a |

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|----------------------------|----------------------------|-------------------|-----|------|-----|------|---------------------------------------|
| Analog power | During A/D, D/A conversion | Al _{cc} | _ | 1.2 | 2.0 | mA | |
| supply current | Idle | _ | _ | 0.01 | 5.0 | μΑ | $AV_{cc} = 2.0 \text{ V}$ to 5.5 V |
| Reference | During A/D conversion | Al _{ref} | _ | 0.5 | 1.0 | mA | |
| power supply current | During A/D, D/A conversion | _ | _ | 2.0 | 5.0 | | |
| Garrent | Idle | _ | | 0.01 | 5.0 | μΑ | $AV_{ref} = 2.0 V$ to AV_{CC} |
| Analog power | er supply voltage*1 | AV _{cc} | 4.0 | _ | 5.5 | V | Operating |
| | | | 2.0 | | 5.5 | | Idle/not used |
| RAM standb | y voltage | V_{RAM} | 2.0 | _ | _ | V | |

Notes: 1. Do not leave the AV_{cc}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

> Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AV_{cc} and AV_{ref} pins by connection to the power supply (V_{cc}), or some other method. Ensure that $AV_{ref} \leq AV_{CC}$.

- 2. Current dissipation values are for V_{IH} min = V_{CC} 0.2 V, V_{CC} B 0.2 V, and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 3. Current dissipation values are for V_{IH} min = $V_{CC} 0.2$ V, $V_{CC}B 0.2$ V, and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 4. The port A characteristics depend on VCCB, and the other pins characteristics depend on VCC.

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Table 28.17 DC Characteristics (5)

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V*}^9$, $V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{cc}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}$, $AV_{ref} = 2.7 \text{ V to } 3.6 \text{ V}$, $V_{ss} = AV_{ss}^{*1} = 0 \text{ V}$, $V_{a} = -20 \text{ to } +75 ^{\circ}\text{C}$

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------|--|-----------------------------|--|-----|---|------|--------------------|
| Schmitt trigger input | | (1) V _T | $V_{cc} \times 0.2$ $V_{cc} B \times 0.2$ | _ | _ | V | |
| voltage | KIN15 to $\overline{\text{KIN8}}^{*7}, *^{8},$ $\overline{\text{IRQ2}} \text{ to } \overline{\text{IRQ0}}^{*3},$ $\overline{\text{IRQ5}} \text{ to } \overline{\text{IRQ3}}$ | V _T ⁺ | _ | _ | $V_{cc} \times 0.7$ $V_{cc}B \times 0.7$ | _ | |
| Schmitt | P67 to P60 | V _T - | $V_{cc} \times 0.3$ | _ | _ | V | |
| trigger input voltage (in | (KWUL = 01) | $V_{T}^{}^{T}}$ | _ | | $V_{cc} \times 0.7$ | _ | |
| level | | $V_T^+ - V_T^-$ | $V_{cc} \times 0.05$ | _ | _ | _ | |
| switching)*6 | P67 to P60 | V _T - | $V_{cc} \times 0.4$ | | _ | _ | |
| | (KWUL = 10) | $V_{T}^{^+}$ | - | | $V_{cc} \times 0.8$ | _ | |
| | | $V_T^+ - V_T^-$ | $V_{cc} \times 0.03$ | | _ | _ | |
| | P67 to P60 | V_{T}^{-} | $V_{cc} \times 0.45$ | _ | _ | _ | |
| | (KWUL = 11) | $V_{T}^{}^{T}}$ | _ | _ | $V_{cc} \times 0.9$ | _ | |
| | | $V_T^+ - V_T^-$ | 0.05 | | _ | | |
| Input high voltage | RES, STBY, NMI, MD1, MD0 | (2) V _{IH} | $V_{cc} \times 0.9$ | | V _{cc} + 0.3 | V | |
| | EXTAL | | $V_{cc} \times 0.7$ | _ | V _{cc} + 0.3 | _ | |
| | PA7 to PA0* ⁷ | | $V_{cc}B \times 0.7$ | _ | $V_{cc}B + 0.3$ | _ | |
| | Port 7 | | $V_{cc} \times 0.7$ | _ | AV _{cc} + 0.3 | _ | |
| | P97, P86, P52, P42 | | $V_{cc} \times 0.7$ | _ | 5.5 | _ | |
| | Input pins except (1) and (2) above | | $V_{cc} \times 0.7$ | _ | V _{cc} +0.3 | | |

| | | | | | | | Test |
|---------------------|--|------------------------|--|-----|-------------------------|------|---|
| | Item | Symbol | Min | Тур | Max | Unit | Conditions |
| Input low voltage | RES, STBY, (3) MD1, MD0 | V _{IL} | -0.3 | | $V_{cc} \times 0.1$ | V | |
| | PA7 to PA0 | | -0.3 | | V _{cc} B × 0.2 | _ | V _{cc} B = 2.7 V to 4.0 V |
| | | | | | 0.8 | _ | $V_{cc}B = 4.0 \text{ V}$ to 5.5 V |
| | NMI, EXTAL, input pins except (1) and (3) above | | -0.3 | _ | $V_{cc} \times 0.2$ | _ | $V_{cc} = 2.7 \text{ V to}$ 3.6 V |
| Output high voltage | All output pins (except P97, P86, P8 | V _{он} 52, | $V_{cc} - 0.5$ $V_{cc}B - 0.5$ | | _ | V | $I_{OH} = -200 \mu A$ |
| | and P42)* ⁴ , * ⁵ , * ⁸ | | V _{cc} – 1.0 V _{cc} B – 1.0 | _ | _ | V | $I_{OH} = -1 \text{ mA},$ $V_{CC} = 2.7 \text{ V to}$ $3.6 \text{ V}, V_{CC}B =$ $2.7 \text{ V to } 4.0$ $V,$ |
| | P97, P86, P52, and P42*4 | _ | 0.5 | _ | _ | V | $I_{OH} = -200 \ \mu A$ |
| Output low voltage | All output pins (except RESO)*5 | V _{oL} | | _ | 0.4 | V | I _{OL} = 1.6 mA |
| | Ports 1 to 3 | _ | _ | | 1.0 | V | I _{OL} = 5 mA |
| | RESO | | _ | | 0.4 | V | I _{OL} = 1.6 mA |

Notes: 1. <u>Do not leave the AV_{CC}, AV_{ref}, and AV_{SS} pins open even if the A/D converter and D/A</u> converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV_{cc} and AV_{ref} pins by connection to the power supply (V_{cc}) , or some other method. Ensure that $AV_{ref} \le AV_{cc}$.

- 2. P67 to P60 include peripheral module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.
- 4. P52/SCK0/SCL0, P97/SDA0, P86/SCK1/SCL1, P42/SCK2/SDA1, and port G are NMOS push-pull outputs.

When the SCL0, SDA0, SCL1, or SDA1 (ICE = 1) pin is used as an output, it is NMOS open-drain output. Therefore, an external pull-up resistor must be connected in order to output high level.

P52/SCK0, P97, P86/SCK1, P42/SCK2 (ICE = 0), and port G high levels are driven by NMOS.

When the SCK0, SCK1, or SCK 2 pin is used as an output, an external pull-up resistor must be connected in order to output high level.

5. When IICS = 0, ICE = 0, and KBIOE = 0. Low-level output when the bus drive function is selected is determined separately.

- 6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 7. The upper limit of the port A applied voltage is $V_{cc}B + 0.3 \text{ V}$ when CIN input is not selected, and the lower of $V_{cc}B + 0.3 \text{ V}$ and $AV_{cc} + 0.3 \text{ V}$ when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 8. The port A characteristics depend on $V_{cc}B$, and the other pins characteristics depend on V_{cc} .
- 9. For flash memory programming/erasure, the applicable range is $V_{cc} = 3.0 \text{ V}$ to 3.6 V.

Table 28.17 DC Characteristics (6)

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V*}^5, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, AV_{cc}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{ref}^{*1} = 2.7 \text{ V to } 3.6 \text{ V}, V_{ss} = AV_{ss}^{*1} = 0 \text{ V}, T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | ltem | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|---|------------------|-----|------|------|------|--|
| Input | RES | _{in} | | | 10.0 | μA | $V_{in} = 0.5 \text{ to}$ |
| leakage current | STBY, NMI, MD1, MD0 | | _ | _ | 1.0 | | $V_{cc} - 0.5 V$ |
| | Port 7 | | _ | | 1.0 | | $V_{in} = 0.5 \text{ to}$ AV _{CC} - 0.5 V |
| Three-state leakage current (off state) | Ports 1 to 6 Ports 8, 9, A* ⁴ , B | I _{TSI} | _ | _ | 1.0 | μА | $V_{in} = 0.5 \text{ to}$ $V_{cc} - 0.5 \text{ V},$ $V_{in} = 0.5 \text{ to}$ $V_{cc}B - 0.5 \text{ V}$ |
| Input pull-up | Ports 1 to 3 | -I _P | 5 | _ | 150 | μA | $V_{in} = 0 V$, |
| MOS current | Ports A* ⁴ , B, 6 (P6PUE = 0) | | 30 | | 300 | | $V_{cc} = 2.7 \text{ V to}$ 3.6 V, $V_{cc}B =$ 2.7 V to 3.6 |
| | Port 6 (P6PUE = 1) | | 3 | _ | 100 | | V 10 3.0 |
| Input | RES (4) | C _{in} | _ | _ | 80 | pF | $V_{in} = 0 V$, |
| capacitance | NMI | | | _ | 50 | | f = 1 MHz, $T_a = 25$ °C |
| | P52, P97, P42, P86, PA7 to PA2 | | _ | _ | 20 | | 1 _a – 23 O |
| | Input pins except (4) above | | _ | | 15 | | |
| Current | Normal operation | I _{cc} | _ | 30 | 40 | mA | f = 10 MHz |
| dissipation*2 | Sleep mode | | _ | 20 | 32 | mA | f = 10 MHz |
| | Standby mode*3 | | | 1.0 | 5.0 | μA | T _a ≤ 50°C |
| | | | _ | _ | 20.0 | | 50°C < T _a |
| Analog power | During A/D, D/A conversion | Al _{cc} | _ | 1.2 | 2.0 | mA | |
| supply current | Idle | | _ | 0.01 | 5.0 | μΑ | $AV_{cc} = 2.0 \text{ V}$ to 3.6 V |

| | Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------|----------------------------|------------------|-----|------|-----|------|--|
| Reference | During A/D conversion | Al_{ref} | _ | 0.5 | 1.0 | mA | |
| power supply | During A/D, D/A conversion | _ | _ | 2.0 | 5.0 | | |
| current | Idle | _ | _ | 0.01 | 5.0 | μΑ | $AV_{ref} = 2.0 \text{ V}$ to AV_{CC} |
| Analog power | er supply voltage*1 | AV _{cc} | 2.7 | _ | 3.6 | V | Operating |
| | | | 2.0 | _ | 3.6 | | Idle/not used |
| RAM standb | y voltage | V_{RAM} | 2.0 | _ | _ | V | |

Notes: 1. Do not leave the AV_{cc}, AV_{ref}, and AV_{ss} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV $_{cc}$ and AV $_{ref}$ pins by connection to the power supply (V $_{cc}$), or some other method. Ensure that AV $_{ref} \leq$ AV $_{cc}$.

- 2. Current dissipation values are for V_{IH} min = $V_{\text{CC}} 0.2$ V, $V_{\text{CC}}B 0.2$ V, and V_{IL} max = 0.2 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 3. The values are for V_{RAM} \leq V_{CC} < 2.7 V, V_{IH} min = V_{CC}- 0.2 V, V_{CC}B 0.2 V, and V_{IL} max = 0.2 V.
- 4. The port A characteristics depend on VCCB, and the other pins characteristics depend on VCC.
- 5. For flash memory programming/erasure, the applicable range is V_{cc} = 3.0 V to 3.6 V.

Table 28.17 DC Characteristics (7) (3-V Version of H8S/2145BV)
When LPC Function is Used

Conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $AV_{cc}^* = 2.7 \text{ V}$ to 3.6 V, $AV_{ref}^* = 2.7 \text{ V}$ to AV_{cc}^* , $V_{ss} = AV_{ss}^{*1} = 0 \text{ V}$, $V_{a} = -20 \text{ to } +75 \text{ C}$

| | Item | Symbol | Min | Max | Unit | Test Conditions |
|----------------------|---|-----------------|---------------------|---------------------|------|----------------------------|
| Input high voltage | P37 to P30, P83 to P80, PB1, PB0 | V _{IH} | $V_{cc} \times 0.5$ | _ | V | |
| Input low voltage | P37 to P30, P83 to P80, PB1, PB0 | V_{IL} | _ | $V_{cc} \times 0.3$ | V | |
| Output high voltage | P37, P33 to P30, P82 to P80, PB1, PB0 | V _{OH} | $V_{cc} \times 0.9$ | _ | V | $I_{OH} = -0.5 \text{ mA}$ |
| Output low voltage | P37, P33 to P30, P82 to P80, PB1, PB0 | V _{oL} | | $V_{cc} \times 0.1$ | V | I _{OL} = 1.5 mA |

Note:* Do not leave the AV_{CC}, AV_{ref}, and AV_{SS} pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 3.6 V to AV $_{\rm cc}$ and AV $_{\rm ref}$ pins by connection to the power supply (V $_{\rm cc}$), or some other method. Ensure that AV $_{\rm ref}$ \leq AV $_{\rm cc}$.

Table 28.18 Permissible Output Currents

Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc}B = 4.0 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$,

 $T_a = -20$ to +75 °C (normal specification product), $T_a = -40$ to +85 °C (wide range

temperature specification product)

| | Item | Symbol | Min | Тур | Max | Unit |
|---|--|------------------------|-----|-----|-----|--------------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0, PS2AC to PS2CC, PS2AD to PS2CD, PA7 to PA4 (bus drive function selected) | I _{OL} | _ | _ | 20 | mA |
| | Ports 1, 2, 3 | | _ | _ | 10 | |
| | RESO | _ | _ | _ | 3 | _ |
| | Other output pins | _ | _ | | 2 | |
| Permissible output | Total of ports 1, 2, and 3 | \sum I _{OL} | _ | | 80 | mA |
| low current (total) | Total of all output pins, including the above | _ | _ | _ | 120 | _ |
| Permissible output high current (per pin) | All output pins | -I _{OH} | _ | _ | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\sum -I_{OH}$ | | _ | 40 | mA |

Conditions: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V},$ $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | Item | Symbol | Min | Тур | Max | Unit |
|---|--|------------------------|-----|-----|-----|------|
| Permissible output low current (per pin) | SCL1, SCL0, SDA1, SDA0, PS2AC to PS2CC, PS2AD to PS2CD, PA7 to PA4 (bus drive function selected) | I _{OL} | _ | _ | 10 | mA |
| | Ports 1, 2, 3 | _ | | _ | 2 | _ |
| | RESO | _ | _ | _ | 1 | _ |
| | Other output pins | _ | _ | _ | 1 | |
| Permissible output | Total of ports 1, 2, and 3 | \sum I _{OL} | _ | | 40 | mA |
| low current (total) | Total of all output pins, including the above | | _ | _ | 60 | mA |
| Permissible output high current (per pin) | All output pins | -I _{OH} | _ | _ | 2 | mA |
| Permissible output high current (total) | Total of all output pins | $\Sigma - I_{OH}$ | | | 30 | mA |

Notes: 1. To protect chip reliability, do not exceed the output current values in table 28.18.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 28.1 and 28.2.

Table 28.19 Bus Drive Characteristics

Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc} = 2.7 \text{ V}$ to 3.6 V (3-V version product), $V_{ss} = 0 \text{ V}$

Applicable Pins: SCL1, SCL0, SDA1, SDA0 (bus drive function selected)

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---|----------------------|----------------------|-----|---------------------|------|--|
| Schmitt trigger | V _T - | $V_{cc} \times 0.3$ | _ | _ | V | |
| input voltage | V_{T}^{+} | _ | _ | $V_{cc} \times 0.7$ | _ | |
| | $V_T^+ - V_T^-$ | $V_{cc} \times 0.05$ | _ | _ | | |
| Input high voltage | V _{IH} | $V_{cc} \times 0.7$ | | 5.5 | V | |
| Input low voltage | V _{IL} | -0.5 | | $V_{cc} \times 0.3$ | | |
| Output low voltage | V _{OL} | _ | | 0.8 | V | $I_{OL} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V to 5.5 V}$ |
| | | _ | _ | 0.5 | _ | $I_{OL} = 8 \text{ mA}$ |
| | | _ | | 0.4 | _ | $I_{OL} = 3 \text{ mA}$ |
| Input capacitance | C _{in} | _ | | 20 | pF | $V_{in} = 0 \text{ V, f} = 1 \text{ MHz,}$ $T_{a} = 25^{\circ}\text{C}$ |
| Three-state leakage current (off state) | ; I _{TSI} | _ | | 1.0 | μA | $V_{in} = 0.5 \text{ to } V_{cc} - 0.5 \text{ V}$ |
| SCL, SDA output fall time | t _{Of} | 20 + 0.1Cb | | 250 | ns | |

Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc} = 2.7 \text{ V}$ to 3.6 V (3-V version product),

 $V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}$

Applicable Pins: PS2AC, PS2AD, PS2BC, PS2BD, PS2CC, PS2CD, PA7 to PA4 (bus drive

function selected)

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--------------------|----------|-----|-----|-----|------|--|
| Output low voltage | V_{oL} | _ | _ | 8.0 | V | $I_{oL} = 16 \text{ mA},$ $V_{cc}B = 4.5 \text{ V to } 5.5 \text{ V}$ |
| | | | _ | 0.5 | | $I_{OL} = 8 \text{ mA}$ |
| | | | _ | 0.4 | | $I_{OL} = 3 \text{ mA}$ |

28.2.3 AC Characteristics

The following shows the clock timing, control signal timing, bus timing, and on-chip peripheral function timing. For the AC characteristics test conditions, see figure 28.3.

Clock Timing: Table 28.20 shows the clock timing. The clock timing specified here covers clock (ø) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 25, Clock Pulse Generator.

Table 28.20 Clock Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{CC}B = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum

operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -20 \text{ to } +75^{\circ}\text{C}$

-40 to +85°C (wide range temperature specification product)

Condition B: $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}, V_{CC} = 4.0 \text{ V to } 5.5 \text{ V}, V_{SS} = 0 \text{ V}, \emptyset = 2 \text{ MHz to } 1.0 \text{ V}$

maximum operating frequency, $T_a = -20$ to +75°C (normal specification

product), $T_a = -40$ to +85°C (wide range temperature specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$

maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| | | Cond | lition A | Cond | dition B | Cond | ition C | | |
|---|-------------------|------|----------|------|----------|------|---------|------|-------------|
| | | 10 | MHz | 16 | MHz | 20 | MHz | | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| Clock cycle time | t _{cyc} | 100 | 500 | 62.5 | 500 | 50 | 500 | ns | Figure 28.6 |
| Clock high pulse width | t _{ch} | 30 | _ | 20 | _ | 17 | _ | ns | Figure 28.6 |
| Clock low pulse width | t _{CL} | 30 | _ | 20 | _ | 17 | _ | ns | |
| Clock rise time | t _{Cr} | _ | 20 | _ | 10 | _ | 8 | ns | |
| Clock fall time | t _{Cf} | _ | 20 | | 10 | _ | 8 | ns | |
| Oscillation settling time at reset (crystal) | t _{osc1} | 20 | _ | 10 | _ | 10 | _ | ms | Figure 28.7 |
| Oscillation settling time in software standby (crystal) | t _{osc2} | 8 | _ | 8 | _ | 8 | _ | ms | Figure 28.8 |
| External clock output stabilization delay time | t _{DEXT} | 500 | | 500 | | 500 | | μs | |

Control Signal Timing: Table 28.21 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768 \text{ kHz}$) are NMI and IRQ0, 1, 2, 6, and 7.

Table 28.21 Control Signal Timing

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{CC}B = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $\emptyset = 32.768 \text{ kHz}$,

2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C (normal specification product), $T_a = -40$ to $+85^{\circ}$ C (wide range temperature

specification product)

Condition B: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc} B = 4.0 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 32.768 \text{ kHz},$

2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C (normal specification product), $T_a = -40$ to $+85^{\circ}$ C (wide range temperature

specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 32.768 \text{ kHz},$

2 MHz to maximum operating frequency, $T_a = -20$ to +75°C

| | | Condition A Condition B | | | | | lition C | | |
|--|-------------------|-------------------------|-----|-----|-----|-----|----------|------------------|-------------|
| | | 10 | MHz | 16 | MHz | 20 | MHz | _ | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| RES setup time | t _{ress} | 300 | | 200 | _ | 200 | | ns | Figure 28.9 |
| RES pulse width | t _{RESW} | 20 | _ | 20 | _ | 20 | _ | t _{cyc} | - |
| NMI setup time (NMI) | t _{NMIS} | 250 | _ | 150 | _ | 150 | _ | ns | Figure |
| NMI hold time (NMI) | t _{nmih} | 10 | _ | 10 | _ | 10 | _ | ns | 28.10 |
| NMI pulse width (NMI) (exiting software standby mode) | t _{nmiw} | 200 | _ | 200 | _ | 200 | _ | ns | - |
| IRQ setup time (IRQ7 to IRQ0) | t _{IRQS} | 250 | _ | 150 | _ | 150 | _ | ns | - |
| IRQ hold time (IRQ7 to IRQ0) | t _{IRQH} | 10 | _ | 10 | | 10 | _ | ns | - |
| IRQ pulse width (IRQ7, IRQ6, IRQ2 to IRQ0) (exiting software standby mode) | t _{IRQW} | 200 | _ | 200 | _ | 200 | _ | ns | - |

Bus Timing: Table 28.22 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768 \text{ kHz}$).

Table 28.22 Bus Timing (1) (Normal Mode)

 $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{cc}B = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum Condition A:

operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -20 \text{ to } +75^{\circ}\text{C}$

-40 to +85°C (wide range temperature specification product)

Condition B: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc}B = 4.0 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to

maximum operating frequency, $T_a = -20$ to +75°C (normal specification

product), $T_a = -40$ to +85°C (wide range temperature specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc}B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$

maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Conditi | on A | Condit | ion B | Conditi | on C | | |
|-------------------------|-----------------------------|-----------------------------|-----------------------------------|-----------------------------------|-----------------------------------|-----------------------------|-----------------------------------|------|-------------------|
| | | 10 N | ИHz | 16 I | ИНz | 20 N | 1Hz | _ | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| Address delay time | t _{AD} | _ | 40 | _ | 30 | _ | 20 | ns | Figures |
| Address setup time | t _{AS} | 0.5 × tcyc – 30 | _ | 0.5 × t _{cyc} − 20 | _ | 0.5 × t _{cvc} – 15 | _ | ns | 28.11 to 28.15 |
| Address hold time | t _{AH} | 0.5 × t _{cvc} – 20 | | 0.5 × t _{cyc} − 15 | _ | 0.5 × t _{cvc} – 10 | | ns | |
| CS delay time (IOS) | t _{CSD} | | 40 | _ | 30 | | 20 | ns | • |
| AS delay time | t _{ASD} | _ | 60 | _ | 45 | _ | 30 | ns | |
| RD delay time 1 | t _{RSD1} | _ | 60 | _ | 45 | _ | 30 | ns | |
| RD delay time 2 | t _{RSD2} | | 60 | _ | 45 | | 30 | ns | |
| Read data setup time | $\mathbf{t}_{\mathtt{RDS}}$ | 35 | | 20 | _ | 15 | | ns | |
| Read data hold time | t _{RDH} | 0 | _ | 0 | _ | 0 | _ | ns | |
| Read data access | t _{ACC1} | _ | 1.0× | _ | 1.0 × | _ | 1.0 × | ns | |
| time 1 | | | t _{cyc} – 60 | | t _{cyc} – 40 | | t _{cyc} – 30 | | |
| Read data access time 2 | t _{ACC2} | _ | 1.5 × t _{cyc} − 50 | _ | 1.5 × t _{cyc} – 35 | _ | 1.5 × t _{cyc} – 25 | ns | |

| | | Condition A | | Cond | ition B | Conditi | on C | | |
|-------------------------|-------------------|-----------------------------|--------------------------------|-----------------------------------|-----------------------------------|-----------------------------|-----------------------------------|------|-----------------------|
| | | 10 | MHz | 16 | MHz | 20 N | lHz | • | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| Read data access time 3 | t _{ACC3} | _ | 2.0 × t _{cyc} - 60 | _ | 2.0 × t _{cyc} – 40 | _ | 2.0 × t _{cyc} – 30 | ns | Figures 28.9 to 28.13 |
| Read data access time 4 | t _{ACC4} | _ | 2.5 × t _{cyc} – 50 | _ | 2.5 × t _{cyc} − 35 | _ | 2.5 × t _{cyc} − 25 | ns | |
| Read data access time 5 | t _{ACC5} | _ | 3.0 × t _{cyc} – 60 | _ | 3.0 × t _{cyc} – 40 | _ | 3.0 × t _{cyc} − 30 | ns | |
| HWR, LWR delay time 1 | t _{wrd1} | _ | 60 | | 45 | _ | 30 | ns | |
| HWR, LWR delay time 2 | t _{WRD2} | _ | 60 | _ | 45 | _ | 30 | ns | |
| HWR, LWR pulse width 1 | t _{wsw1} | 1.0 × t _{ovo} – 40 | _ | 1.0 × t _{cyc} – 30 | _ | 1.0 × t _{cvc} – 20 | _ | ns | |
| HWR, LWR pulse width 2 | t _{wsw2} | 1.5 × t _{cvc} – 40 | _ | 1.5 × t _{cyc} − 30 | _ | 1.5 × t _{cvc} – 20 | _ | ns | |
| Write data delay time | t _{wdd} | _ | 60 | | 45 | _ | 30 | ns | |
| Write data setup time | t _{wds} | 0 | _ | 0 | _ | 0 | | ns | |
| Write data hold time | t _{wdh} | 20 | _ | 15 | _ | 10 | _ | ns | |
| WAIT setup time | t _{wts} | 60 | _ | 45 | _ | 30 | _ | ns | |
| WAIT hold time | t _{WTH} | 10 | _ | 5 | _ | 5 | _ | ns | |

Table 28.22 Bus Timing (2) (Advanced Mode)

Condition A: $V_{cc} = 5.0 \text{ V} \pm 10 \text{ %}, V_{cc} B = 5.0 \text{ V} \pm 10 \text{ %}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$ maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -40 \text{ to } +85^{\circ}\text{C}$ (wide range temperature specification product)

Condition B: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc}B = 4.0 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$ maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -40 \text{ to } +85^{\circ}\text{C}$ (wide range temperature specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$ maximum operating frequency, $T_a = -20 \text{ to } +75 ^{\circ}\text{C}$

| | | Condition A C | | Cond | ition B | B Condition C | | | |
|-------------------------|-------------------|-----------------------------|-----------------------------|-----------------------------------|-----------------------------------|-----------------------------|-----------------------------------|------|-------------------|
| | | 10 | MHz | 16 | MHz | 20 N | 1Hz | | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| Address delay time | t _{AD} | _ | 60 | _ | 45 | _ | 30 | ns | Figures |
| Address setup time | t _{AS} | 0.5 × t _{cvc} - 50 | _ | 0.5 × t _{cyc} − 35 | _ | 0.5 × t _{cvc} – 25 | _ | ns | 28.11 to 28.15 |
| Address hold time | t _{AH} | 0.5 × t _{cvc} - 20 | _ | 0.5 × t _{cyc} − 15 | _ | 0.5 × t _{cvc} – 10 | | ns | |
| CS delay time (IOS) | t _{CSD} | | 60 | _ | 45 | _ | 30 | ns | • |
| AS delay time | t _{ASD} | _ | 60 | _ | 45 | _ | 30 | ns | |
| RD delay time 1 | t _{RSD1} | _ | 60 | _ | 45 | _ | 30 | ns | |
| RD delay time 2 | t _{RSD2} | _ | 60 | _ | 45 | _ | 30 | ns | |
| Read data setup time | t _{RDS} | 35 | _ | 20 | _ | 15 | | ns | |
| Read data hold time | t _{RDH} | 0 | _ | 0 | _ | 0 | _ | ns | |
| Read data access time 1 | t _{ACC1} | _ | 1.0 × t _{cyc} – 80 | _ | 1.0 × t _{cyc} – 55 | _ | 1.0 × t _{cyc} − 40 | ns | |
| Read data access time 2 | t _{ACC2} | _ | 1.5 × t _{cyc} – 50 | _ | 2.5 × t _{cyc} – 35 | _ | 2.5 × t _{cyc} − 25 | ns | |
| Read data access time 3 | t _{ACC3} | _ | 2.0 × t _{cyc} – 80 | _ | 3.0 × t _{cyc} − 55 | _ | 3.0 × t _{cyc} – 40 | ns | |

| | | Condition A | | Conditi | on B | Conditi | on C | | |
|-------------------------|-------------------|-----------------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|-----------------------------------|------|------------------------------|
| | | 10 N | 1Hz | 16 N | ИНZ | 20 N | lHz | | Test |
| Item | Symbol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| Read data access time 4 | t _{ACC4} | _ | 2.5 × t _{cyc} – 50 | _ | 2.5 × t _{cyc} − 35 | _ | 2.5 × t _{cyc} − 25 | ns | Figures 28.11 to 28.15 |
| Read data access time 5 | t _{ACC5} | _ | 3.0 × t _{cyc} − 80 | _ | 3.0 × t _{cyc} − 55 | _ | 3.0 × t _{cyc} − 40 | ns | |
| HWR, LWR delay time 1 | t _{wrd1} | _ | 60 | _ | 45 | _ | 30 | ns | |
| HWR, LWR delay time 2 | t _{WRD2} | _ | 60 | _ | 45 | _ | 30 | ns | |
| HWR, LWR pulse width 1 | t _{wsw1} | 1.0 × t _{cvc} - 40 | - | 1.0 × t _{cvc} - 30 | | 1.0 × t _{cvc} – 20 | | ns | |
| HWR, LWR pulse width 2 | t _{wsw2} | 1.5 × t _{cvc} – 40 | _ | 1.5 × t _{cvc} – 30 | | 1.5 × t _{cvc} – 20 | _ | ns | |
| Write data delay time | t _{wdd} | _ | 60 | _ | 45 | | 30 | ns | |
| Write data setup time | t _{wds} | 0 | _ | 0 | _ | 0 | _ | ns | |
| Write data hold time | t _{wdh} | 20 | _ | 15 | _ | 10 | _ | ns | |
| WAIT setup time | t _{wts} | 60 | | 45 | | 30 | | ns | |
| WAIT hold time | t _{wth} | 10 | _ | 5 | _ | 5 | _ | ns | |

Timing of On-Chip Peripheral Modules: Tables 28.23 to 28.26 show the on-chip peripheral module timing. The only on-chip peripheral modules that can operate in subclock operation (\emptyset = 32.768 kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 28.23 Timing of On-Chip Peripheral Modules (1)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10 \text{ %}, V_{CC} B = 5.0 \text{ V} \pm 10 \text{ %}, V_{SS} = 0 \text{ V},$

 $\emptyset = 32.768 \text{ kHz}^*$, 2 MHz to maximum operating frequency,

 $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -40 \text{ to } +85^{\circ}\text{C}$ (wide

range temperature specification product)

Condition B: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc} B = 4.0 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V},$

 $\emptyset = 32.768 \text{ kHz*}, 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -40 \text{ to } +85^{\circ}\text{C}$ (wide

range temperature specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 32.768 \text{ kHz*},$

2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| | | | | | dition A | | dition B | | dition C | _ | |
|-------|------------------------------|-------------|--|-----|-------------|-----|-------------|-----|-------------|------------------|-----------------|
| | | | Sym- | 10 | MHz | 16 | MHz | 20 | MHz | | Test |
| Item | | | | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| I/O | Output data delay time | | $\mathbf{t}_{\scriptscriptstyle{PWD}}$ | _ | 100 | | 50 | _ | 50 | ns | Figure |
| ports | Input data se | tup time | t _{PRS} | 50 | _ | 30 | _ | 30 | _ | - | 28.16 |
| | Input data hold time | | t _{PRH} | 50 | _ | 30 | _ | 30 | _ | _ | |
| FRT | Timer output delay time | | $t_{\scriptscriptstyle{FTOD}}$ | _ | 100 | _ | 50 | _ | 50 | ns | Figure |
| | Timer input setup time | | t _{FTIS} | 50 | | 30 | _ | 30 | _ | - | 28.17 |
| | Timer clock in time | nput setup | t _{FTCS} | 50 | _ | 30 | | 30 | _ | - | Figure 28.18 |
| | Timer clock | Single edge | t _{FTCWH} | 1.5 | _ | 1.5 | _ | 1.5 | _ | t _{cyc} | |
| | pulse width | Both edges | t _{FTCWL} | 2.5 | _ | 2.5 | _ | 2.5 | _ | - | |
| TMR | Timer output delay time | | t _{tmod} | _ | 100 | _ | 50 | _ | 50 | ns | Figure 28.19 |
| | Timer reset input setup time | | t _{TMRS} | 50 | _ | 30 | _ | 30 | _ | | Figure 28.21 |
| | Timer clock input setup time | | t _{TMCS} | 50 | _ | 30 | _ | 30 | _ | - | Figure 28.20 |

| | | | A B | | <u>C</u> | | | | | | |
|------------------|--|--|---------------------------------|-----|----------|-----|-----|-----|-----|--------------------|-----------------|
| | | | Sym- | 10 | MHz | 16 | MHz | 20 | MHz | | Test |
| | Iten | า | bol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| TMR | Timer clock | Single edge | \mathbf{t}_{TMCWH} | 1.5 | | 1.5 | | 1.5 | | t _{cyc} | Figure |
| | pulse width | Both edges | t _{TMCWL} | 2.5 | _ | 2.5 | _ | 2.5 | _ | _ | 28.20 |
| PWM, PWMX | Pulse outpu | it delay time | t _{PWOD} | _ | 100 | _ | 50 | _ | 50 | ns | Figure 28.22 |
| SCI | • | Asynchronous | t _{Scyc} | 4 | _ | 4 | _ | 4 | _ | t _{cyc} | Figure |
| | cycle | Synchronous | | 6 | _ | 6 | _ | 6 | _ | | 28.23 |
| | Input clock pulse width | | t _{sckw} | 0.4 | 0.6 | 0.4 | 0.6 | 0.4 | 0.6 | t _{cscyc} | |
| | Input clock | rise time | t _{SCKr} | _ | 1.5 | _ | 1.5 | _ | 1.5 | t _{cyc} | |
| | Input clock | fall time | $\mathbf{t}_{_{\mathrm{SCKf}}}$ | _ | 1.5 | _ | 1.5 | _ | 1.5 | _ | |
| | Transmit da (clocked sy | ita delay time nchronous) | \mathbf{t}_{TXD} | _ | 100 | _ | 50 | _ | 50 | ns | Figure 28.24 |
| | | ceive data setup time ocked synchronous) | | 100 | _ | 50 | _ | 50 | _ | | |
| | Receive data hold time (clocked synchronous) | | t _{RXH} | 100 | _ | 50 | _ | 50 | _ | | |
| A/D converter | Trigger input setup time | | t _{TRGS} | 50 | _ | 30 | _ | 30 | _ | ns | Figure 28.25 |
| WDT | RESO outp | ut delay time | t _{RESD} | _ | 200 | | 120 | | 100 | ns | Figure |
| | RESO output pulse width | | t _{RESOW} | 132 | _ | 132 | _ | 132 | | t _{cyc} | 28.26 |

Condition Condition

Note:* Only peripheral modules that can be used in subclock operation

Table 28.23 Timing of On-Chip Peripheral Modules (2)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10 \text{ %}, V_{CC} B = 5.0 \text{ V} \pm 10 \text{ %}, V_{SS} = 0 \text{ V},$

2 MHz to maximum operating frequency,

 $T_a = -20$ to +75 °C (normal specification product), $T_a = -40$ to +85 °C (wide

range temperature specification product)

Condition B: $V_{cc} = 4.0 \text{ V to } 5.5 \text{ V}, V_{cc} B = 4.0 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V},$

2 MHz to maximum operating frequency,

 $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal specification product), $T_a = -40 \text{ to } +85^{\circ}\text{C}$ (wide

range temperature specification product)

Condition C: $V_{cc} = 2.7 \text{ V to } 3.6 \text{ V}, V_{cc} B = 2.7 \text{ V to } 5.5 \text{ V}, V_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to}$

maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

| | | | | Condition Condit | | Condition Condition B C | | | | | |
|-----------|---------------|-----------------------|--------------------|------------------|-----|---------------------------|-----|-----|-----|------|------------|
| | | | Sym- | 10 | MHz | 16 | MHz | 20 | MHz | _ | Test |
| Item | | | bol | Min | Max | Min | Max | Min | Max | Unit | Conditions |
| HIF read | CS/HAC | setup time | \mathbf{t}_{HAR} | 10 | _ | 10 | _ | 10 | | ns | Figure |
| cycle | CS/HAC |) hold time | t _{HRA} | 10 | _ | 10 | _ | 10 | _ | _ | 28.27 |
| | IOR pul | se width | t_{HRPW} | 220 | _ | 120 | _ | 120 | _ | _ | |
| | HDB de | elay time | t _{HRD} | _ | 200 | _ | 100 | _ | 100 | _ | |
| | HDB ho | old time | t _{HRF} | 0 | 40 | 0 | 25 | 0 | 25 | _ | |
| | HIRQ d | elay time | t _{HIRQ} | _ | 200 | _ | 120 | | 120 | _ | |
| HIF write | CS/HAC | setup time | t _{HAW} | 10 | _ | 10 | _ | 10 | _ | _ | |
| cycle | CS/HAC |) hold time | t _{HWA} | 10 | | 10 | | 10 | | _ | |
| | IOW pu | lse width | t _{HWPW} | 100 | _ | 60 | _ | 60 | _ | _ | |
| | HDB | Fast A20 | t _{HDW} | 50 | | 30 | | 30 | | _ | |
| | setup time | gate not used | | | | | | | | | |
| | | Fast A20 gate used | _ | 85 | _ | 55 | _ | 45 | _ | _ | |
| | HDB ho | old time | t _{HWD} | 25 | _ | 15 | _ | 15 | | _ | |
| | GA20 d | elay time | t _{HGA} | | 180 | | 90 | | 90 | _ | |

Table 28.24 Keyboard Buffer Controller Timing

Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc} = 2.7 \text{ V}$ to 3.6 V (3-V product), $V_{cc}B = 2.7 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | | Ra | tings | | | Test | |
|--------------------------------|-------------------|------------|-------|-----|------|------------|--------|
| Item | Symbol | Min | Тур | Max | Unit | Conditions | Notes |
| KCLK, KD output fall time | t _{KBF} | 20 + 0.1Cb | _ | 250 | ns | | Figure |
| KCLK, KD input data hold time | t _{KBIH} | 150 | _ | _ | ns | | 28.28 |
| KCLK, KD input data setup time | t _{KBIS} | 150 | _ | _ | ns | | _ |
| KCLK, KD output delay time | t _{KBOD} | _ | _ | 450 | ns | | _ |
| KCLK, KD capacitive load | C _b | _ | | 400 | pF | | _ |

Table 28.25 I²C Bus Timing

Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{cc} = 2.7 \text{ V}$ to 3.6 V (3-V product), $V_{ss} = 0 \text{ V}$, $\emptyset = 5 \text{ MHz}$ to maximum operating frequency,

| | | Ratings | | | | Test | |
|---|----------------------------|---------|-----|---------|-----------------------------|------------|--------------------|
| Item | Symbol | Min | Тур | Typ Max | | Conditions | Notes |
| SCL input cycle time | t _{scl} | 12 | _ | _ | $t_{\scriptscriptstylecyc}$ | | Figure |
| SCL input high pulse width | t _{sclh} | 3 | _ | _ | t _{cyc} | | ⁻ 28.29 |
| SCL input low pulse width | t _{SCLL} | 5 | _ | _ | t _{cyc} | | |
| SCL, SDA input rise time | t _{sr} | _ | _ | 7.5* | t _{cyc} | | _ |
| SCL, SDA input fall time | t_{\scriptscriptstyleSf} | _ | _ | 300 | ns | | _ |
| SCL, SDA input spike pulse elimination time | t _{sp} | _ | | 1 | t _{cyc} | | _ |
| SDA input bus free time | t _{BUF} | 5 | | | t _{cyc} | | |
| Start condition input hold time | t _{STAH} | 3 | | _ | t _{cyc} | | _ |
| Retransmission start condition input setup time | t _{STAS} | 3 | _ | _ | t _{cyc} | | _ |
| Stop condition input setup time | t _{stos} | 3 | | | t _{cyc} | | |
| Data input setup time | t _{SDAS} | 0.5 | | | t _{cyc} | | _ |
| Data input hold time | t _{SDAH} | 0 | | | ns | | |
| SCL, SDA capacitive load | C _b | | _ | 400 | рF | | |

Note:* 17.5t_{cyc} can be set according to the clock selected for use by the I²C module. For details, see section 16.6, Usage Notes.

Table 28.26 LPC Module Timing (For H8S/2145B Only)

Conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency, $T_a = -20 \text{ to } +75 ^{\circ}\text{C}$

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|------|-------------------------------------|-------------------|-----|-----|-----|------|------------------------|
| LPC | Input clock cycle | t _{Lcyc} | 30 | | _ | ns | Figure 28.30 |
| | Input clock pulse width (H) | t _{LCKH} | 11 | _ | | | |
| | Input clock pulse width (L) | t _{LCKL} | 11 | | | | |
| | Transmit signal delay time | t _{TXD} | 2 | | 11 | | |
| | Transmit signal floating delay time | t _{OFF} | | | 28 | _ | |
| | Receive signal setup time | t _{RXS} | 7 | | | | |
| | Receive signal hold time | t _{RXH} | 0 | _ | | | |

28.2.4 A/D Conversion Characteristics

Tables 28.27 and 28.28 list the A/D conversion characteristics.

Table 28.27 A/D Conversion Characteristics (AN7 to AN0 Input: 134/266-State Conversion)

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{ref} = 4.5 \text{ V}$ to AV_{CC} ,

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20$ to +75°C (normal specification product), $T_a = -40$ to +85°C (wide

range temperature specification product)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{ref} = 4.0 \text{ V}$ to AV_{CC}

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20$ to +75°C (normal specification product), $T_a = -40$ to +85°C (wide

range temperature specification product)

Condition C: $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{ref} = 2.7 \text{ V to } AV_{CC}$

 $V_{ss} = AV_{ss} = 0 V_{ss} = 2 MHz$ to maximum operating frequency,

 $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | С | onditio | n C | (| Conditio | n B | (| Conditio | n A | |
|---|-----|---------|------|-----|----------|----------------------------------|-----|----------|----------------------------------|--------------|
| | | 10 MH | lz | | 16 MH | lz | | 20 MF | lz | _ |
| Item | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Resolution | 10 | | | 10 | | | 10 | | | bits |
| Conversion time*3 | _ | | 13.4 | | | 8.4 | _ | _ | 6.7 | μs |
| Analog input capacitance | _ | | 20 | | _ | 20 | | _ | 20 | pF |
| Permissible signal- source impedance | | _ | 5 | _ | | 10* ¹ 5* ² | _ | | 10* ¹ 5* ² | kΩ |
| Nonlinearity error | _ | _ | ±7.0 | | _ | ±3.0 | _ | _ | ±3.0 | LSB |
| Offset error | _ | _ | ±7.5 | | _ | ±3.5 | _ | _ | ±3.5 | LSB |
| Full-scale error | _ | _ | ±7.5 | _ | _ | ±3.5 | _ | _ | ±3.5 | LSB |
| Quantization error | | | ±0.5 | | | ±0.5 | | | ±0.5 | LSB |
| Absolute accuracy | _ | | ±8.0 | _ | _ | ±4.0 | _ | | ±4.0 | LSB |

Notes: 1. When conversion time \geq 11.17 µs (CKS = 0, or $\emptyset \leq$ 12 MHz at CKS = 1)

- 2. When conversion time < 11.17 μ s (\emptyset > 12 MHz at CKS = 1)
- 3. At the maximum operating frequency in single mode.

Table 28.28 A/D Conversion Characteristics (CIN15 to CIN0 Input: 134/266-State Conversion)

Condition A: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $AV_{cc} = 5.0 \text{ V} \pm 10\%$, $AV_{ref} = 4.5 \text{ V}$ to AV_{cc} , $V_{ss} = AV_{ss} = 0 \text{ V}$, $\emptyset = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20$ to $+75^{\circ}C$ (normal specification product), $T_a = -40$ to $+85^{\circ}C$ (wide

range temperature specification product)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{ref} = 4.0 \text{ V}$ to AV_{CC} ,

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_{\rm a} = -20$ to $+75\,^{\circ}{\rm C}$ (normal specification product), $T_{\rm a} = -40$ to $+85\,^{\circ}{\rm C}$ (wide

range temperature specification product)

Condition C: $V_{cc} = 3.0 \text{ V to } 3.6 \text{ V*}^4, \text{AV}_{cc} = 3.0 \text{ V to } 3.6 \text{ V*}^4, \text{AV}_{ref} = 3.0 \text{ V to AV}_{cc}^{*4},$

 $V_{cc}B = 3.0 \text{ V to } 5.5 \text{ V*}^4, V_{ss} = AV_{ss} = 0 \text{ V}, \emptyset = 2 \text{ MHz to maximum}$

operating frequency, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | C | onditio | n C | | Conditio | n B | (| Conditio | n A | |
|---|-----|---------|-------|-----|----------|----------------------------------|-----|----------|----------------------------------|--------------|
| | | 10 MH | lz | | 16 MH | Z | | 20 MH | lz | _ |
| Item | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Resolution | 10 | | | 10 | | | 10 | | | bits |
| Conversion time*3 | | | 13.4 | _ | | 8.4 | _ | _ | 6.7 | μs |
| Analog input capacitance | _ | | 20 | _ | _ | 20 | _ | _ | 20 | pF |
| Permissible signal- source impedance | _ | _ | 5 | | _ | 10* ¹ 5* ² | _ | | 10* ¹ 5* ² | kΩ |
| Nonlinearity error | _ | _ | ±11.0 | _ | _ | ±5.0 | _ | _ | ±5.0 | LSB |
| Offset error | _ | _ | ±11.5 | _ | _ | ±5.5 | _ | _ | ±5.5 | LSB |
| Full-scale error | _ | _ | ±11.5 | _ | _ | ±5.5 | _ | _ | ±5.5 | LSB |
| Quantization error | _ | _ | ±0.5 | _ | _ | ±0.5 | _ | _ | ±0.5 | LSB |
| Absolute accuracy | | _ | ±12.0 | _ | _ | ±6.0 | _ | _ | ±6.0 | LSB |

Notes: 1. When conversion time \geq 11.17 µs (CKS = 0, or $\emptyset \leq$ 12 MHz at CKS = 1)

- 2. When conversion time < 11.17 μ s (\emptyset > 12 MHz at CKS = 1)
- 3. At the maximum operating frequency in single mode.
- 4. When using CIN, ensure that V_{cc} = 3.0 V to 3.6 V, AV_{cc} = 3.0 V to 3.6 V, AV_{ref} = 3.0 V to 3.6 V, $V_{cc}B$ = 3.0 V to 5.5 V.

28.2.5 D/A Conversion Characteristics

Table 28.29 lists the D/A conversion characteristics.

Table 28.29 D/A Conversion Characteristics

Condition A: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{ref} = 4.5 \text{ V}$ to AV_{CC} ,

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20$ to +75°C (normal specification product), $T_a = -40$ to +85°C (wide

range temperature specification product)

Condition B: $V_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{CC} = 4.0 \text{ V}$ to 5.5 V, $AV_{ref} = 4.0 \text{ V}$ to AV_{CC} ,

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20$ to +75 °C (normal specification product), $T_a = -40$ to +85 °C (wide

range temperature specification product)

Condition C: $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}, AV_{ref} = 2.7 \text{ V to } AV_{CC}$

 $V_{ss} = AV_{ss} = 0 \text{ V}, \phi = 2 \text{ MHz}$ to maximum operating frequency,

 $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| | Condition | | | ion C | C | Conditio | n B | Condition A | | | |
|-------------------|----------------------------------|-----|--------|-------|-----|----------|------|-------------|--------|------|------|
| | | | 10 MHz | | | 16 MHz | | | 20 MHz | | |
| Item | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Resolution | | 8 | | | 8 | | | 8 | | | bits |
| Conversion time | With 20 pF load capacitance | | | 10 | _ | _ | 10 | _ | _ | 10 | μs |
| Absolute accuracy | With 2 $M\Omega$ load resistance | _ | ±2.0 | ±3.0 | | ±1.0 | ±1.5 | _ | ±1.0 | ±1.5 | LSB |
| | With 4 MΩ load resistance | | _ | ±2.0 | _ | _ | ±1.0 | _ | _ | ±1.0 | _ |

28.2.6 Flash Memory Characteristics

Table 28.30 shows the flash memory characteristics.

Table 28.30 Flash Memory Characteristics (Operation Range at Programming/Erasing)

5-V version conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V, $V_{ss} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^{\circ}\text{C}$ (normal

specification product), $T_a = -40$ to $+85^{\circ}$ C (wide range temperature

specification product),

3-V version conditions: $V_{cc} = 3.0 \text{ V}$ to 3.6 V, $V_{ss} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^{\circ}\text{C}$

| Item | Item | | Min | Тур | Max | Unit | Test Condition |
|--|--|----------------|-----|-----|------|----------------|---------------------|
| Programming | time* ¹ ,* ² ,* ⁴ | t _P | _ | 10 | 200 | ms/ 128 byt | es |
| Erase time* ¹ ,* ³ ,* ⁶ | | t _E | _ | 100 | 1200 | ms/ block | |
| Reprogrammi | Reprogramming count | | _ | | 100 | times | |
| Programming | Wait time after SWE-bit setting*1 | Х | 1 | _ | _ | μs | |
| | Wait time after PSU-bit setting*1 | У | 50 | _ | _ | μs | |
| | Wait time after P-bit setting* ¹ , * ⁴ | z1 | 28 | 30 | 32 | μs | 1 ≤ n ≤ 6 |
| | | z2 | 198 | 200 | 202 | μs | 7 ≤ n ≤ 1000 |
| | | z3 | 8 | 10 | 12 | μs | Additional write |
| | Wait time after P-bit clear*1 | α | 5 | _ | _ | μs | |
| | Wait time after PSU-bit clear*1 | β | 5 | — | _ | μs | |
| | Wait time after PV-bit setting*1 | γ | 4 | — | _ | μs | |
| | Wait time after dummy write*1 | ε | 2 | — | | μs | |
| | Wait time after PV-bit clear*1 | η | 2 | — | | μs | |
| | Wait time after SWE-bit clear*1 | θ | 100 | — | | μs | |
| | Maximum programming count* ¹ , * ⁴ ,* ⁵ | N | _ | _ | 1000 | times | |

| Item | | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-------|--|--------|-----|-----|-----|-------|--------------------|
| Erase | Wait time after SWE-bit setting*1 | х | 1 | _ | _ | μs | _ |
| | Wait time after ESU-bit setting*1 | У | 100 | | _ | μs | |
| | Wait time after E-bit setting* ¹ , * ⁶ | Z | 10 | — | 100 | ms | |
| | Wait time after E-bit clear*1 | α | 10 | — | | μs | |
| | Wait time after ESU-bit clear*1 | β | 10 | | _ | μs | |
| | Wait time after EV-bit setting*1 | γ | 20 | _ | _ | μs | |
| | Wait time after dummy write*1 | ε | 2 | — | | μs | |
| | Wait time after EV-bit clear*1 | η | 4 | _ | _ | μs | |
| | Wait time after SWE-bit clear*1 | θ | 100 | _ | _ | μs | |
| | Maximum erase count*1, *6, *7 | N | _ | _ | 120 | times | |

Notes: 1. Set the times according to the program/erase algorithms.

- 2. Programming time per 128 bytes (Shows the total period for which the P-bit in FLMCR1 is set. It does not include the programming verification time.)
- 3. Block erase time (Shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
- 4. Maximum programming time (t_p (max))
 - t_P (max) = (wait time after P-bit setting (z1) + (z3)) × 6 + wait time after P-bit setting (z2) × ((N) – 6)
- 5. The maximun number of writes (N) should be set according to the actual set value of z1, z2 and z3 to allow programming within the maximum programming time (t_p (max)). The wait time after P-bit setting (z1, z2, and z3) should be alternated according to the number of writes (n) as follows:

$$1 \le n \le 6$$
 $z1 = 30 \ \mu s$, $z3 = 10 \ \mu s$
 $7 \le n \le 1000$ $z2 = 200 \ \mu s$

- 6. Maximum erase time $(t_{_{\rm F}} (max))$
 - t_{E} (max) = Wait time after E-bit setting (z) × maximum erase count (N)
- 7. The maximum number of erases (N) should be set according to the actual set value of z to allow erasing within the maximum erase time (t_{ϵ} (max)).

28.2.7 Usage Notes

1. Both of the F-ZTAT version and masked-ROM version products satisfy the electrical characteristics described in this manual, however, due to the differences in the manufacturing process, on-chip ROMs, or layout patterns, the actual electrical characteristics, operation margin, and noise margin may be changed.

When the F-ZTAT version was used for system evaluation, and switching from the F-ZTAT version to the mask-ROM version is made, the equivalent evaluation should be performed for the mask-ROM version.

2. Internal step-down products

The H8S/2148 B-masked product (HD64F2148B) includes an internal step-down circuit to step down the microprocessor internal power supply voltage to the appropriate level.

One or two (in parallel) internal voltage regulating capacitors (0.47 μ F) should be inserted between the internal step-down pin (VCL pin) and VSS pin. The method of connecting the external capacitor(s) is shown in figure 27-31.

For the 5-V and 4-V version products whose power supply (VCC) voltage exceeds 3.6 V, do not connect the VCC power supply to the VCL pin of the internal step-down product. (Connect the VCC power supply to the VCC1 pin, as usual.)

For the 3-V version product whose power supply (VCC) voltage is 3.6 V or less, connect the system power supply to the VCL pin together with the VCC1 pins.

When switching from the F-ZTAT version product without the internal step-down function to the F-ZTAT B-masked product with the internal step-down function, note that the VCL pin is allocated to the same location as the VCC2 pin of the product without the internal step-down function. Therefore, the difference in the circuits between before and after the switchover should be considered when designing the PC board patterns.

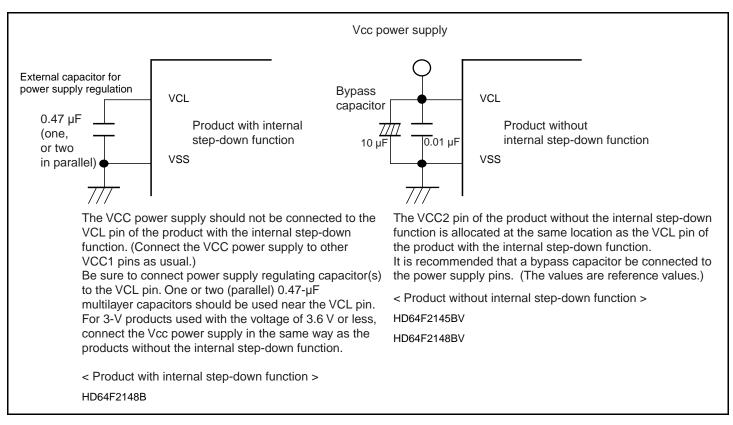


Figure 28.5 Connection of VCL Capacitor

28.3 Timing Chart

28.3.1 Clock Timing

The clock timings are shown below.

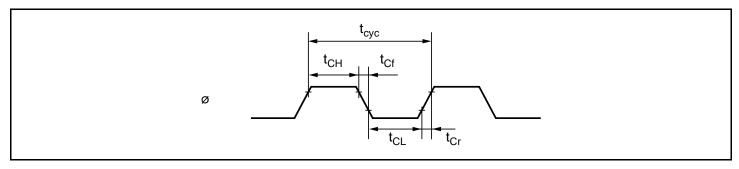


Figure 28.6 System Clock Timing

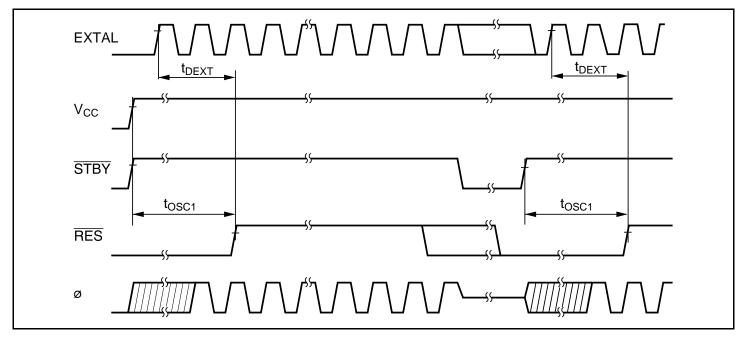


Figure 28.7 Oscillation Settling Timing

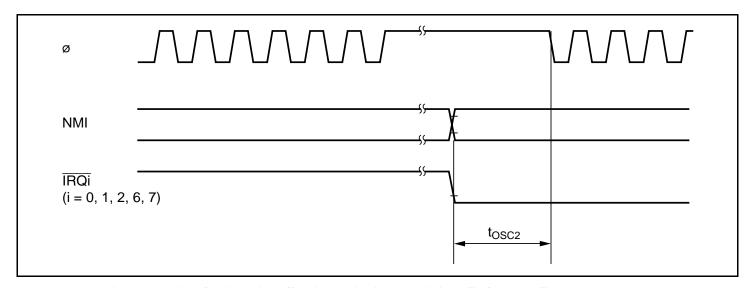


Figure 28.8 Oscillation Setting Timing (Exiting Software Standby Mode)

28.3.2 Control Signal Timing

The control signal timings are shown below.

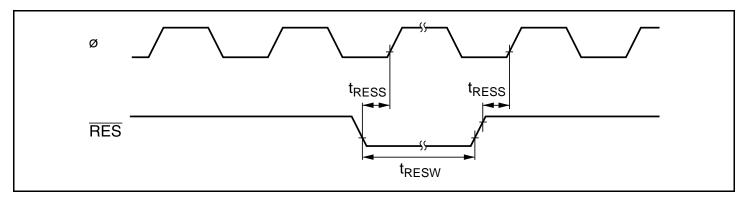


Figure 28.9 Reset Input Timing

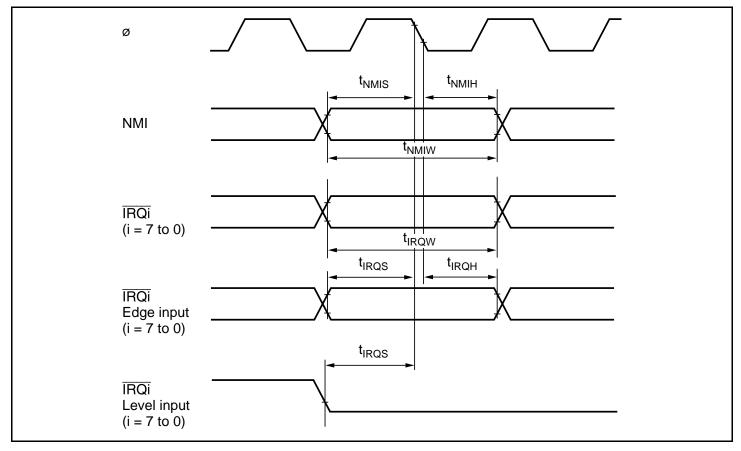


Figure 28.10 Interrupt Input Timing

28.3.3 Bus Timing

The bus timings are shown below.

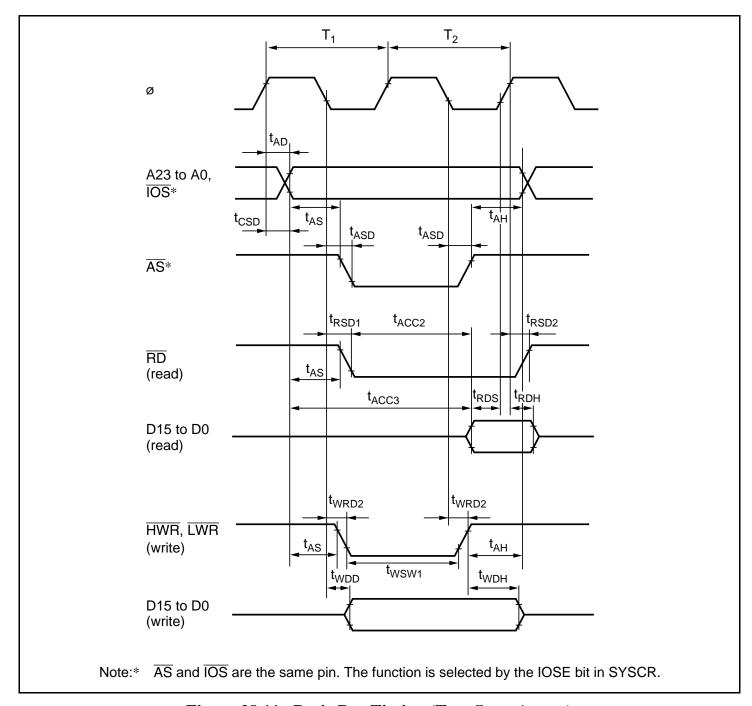


Figure 28.11 Basic Bus Timing (Two-State Access)

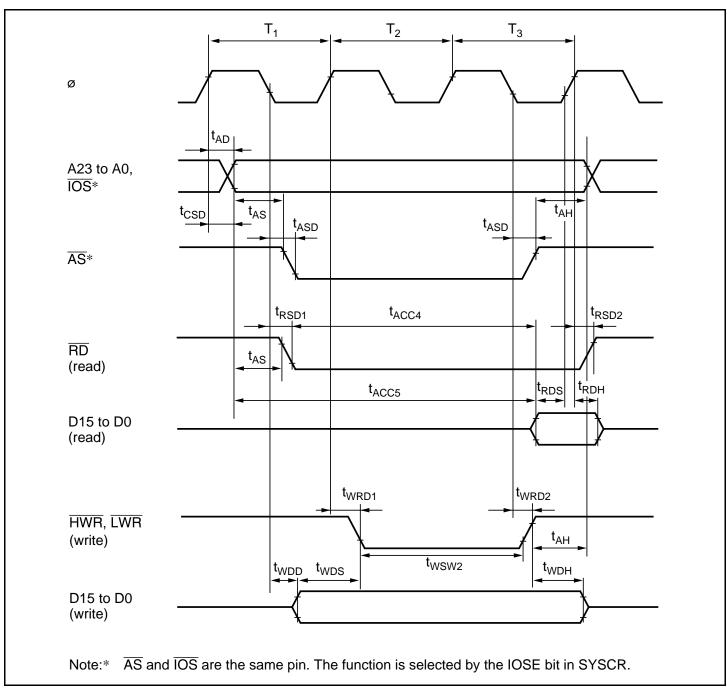


Figure 28.12 Basic Bus Timing (Three-State Access)

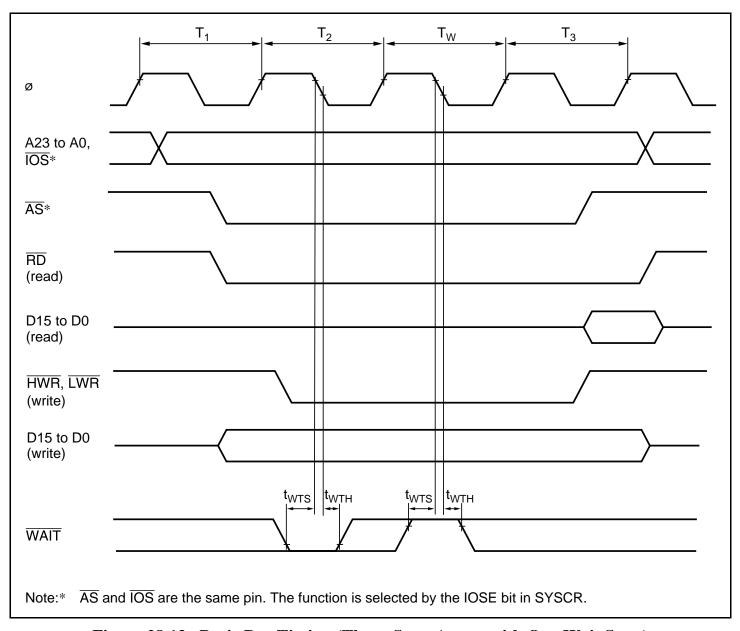


Figure 28.13 Basic Bus Timing (Three-State Access with One Wait State)

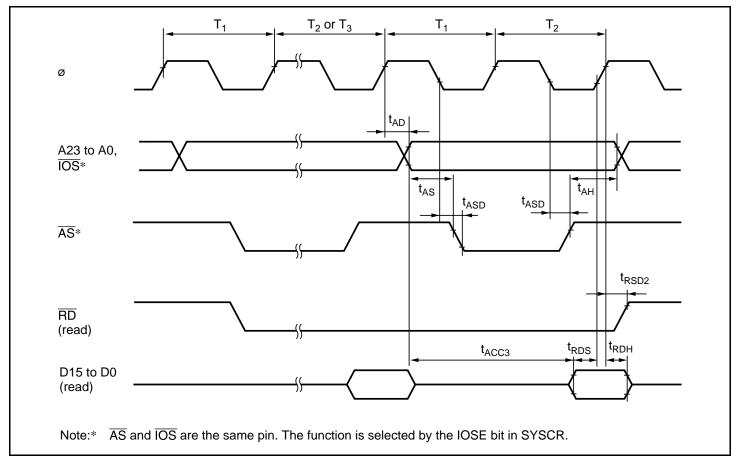


Figure 28.14 Burst ROM Access Timing (Two-State Access)

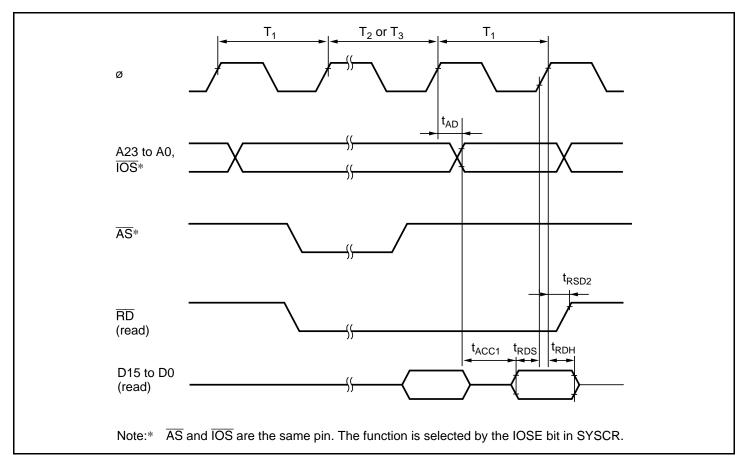


Figure 28.15 Burst ROM Access Timing (One-State Access)

28.3.4 On-Chip Peripheral Module Timing

The on-chip peripheral module timings are shown below.

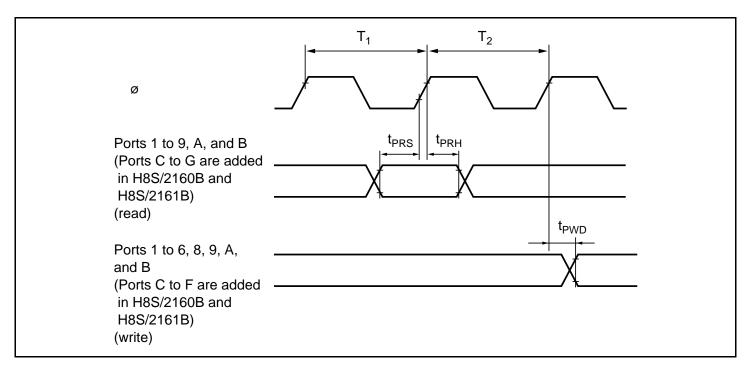


Figure 28.16 I/O Port Input/Output Timing

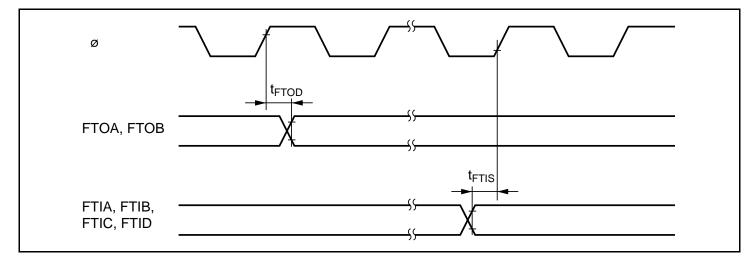


Figure 28.17 FRT Input/Output Timing

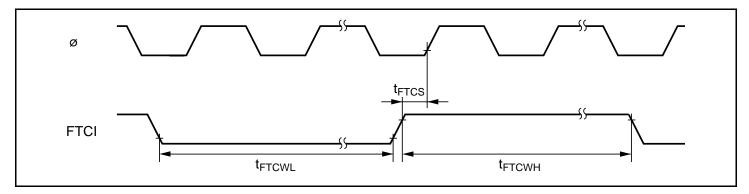


Figure 28.18 FRT Clock Input Timing

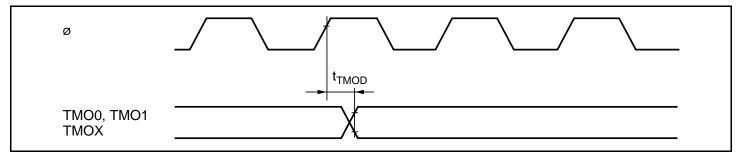


Figure 28.19 8-Bit Timer Output Timing

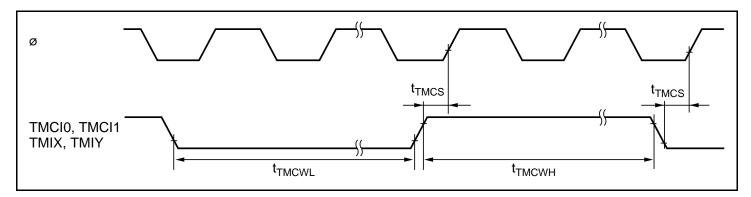


Figure 28.20 8-Bit Timer Clock Input Timing

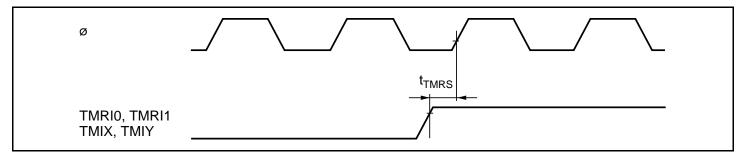


Figure 28.21 8-Bit Timer Reset Input Timing

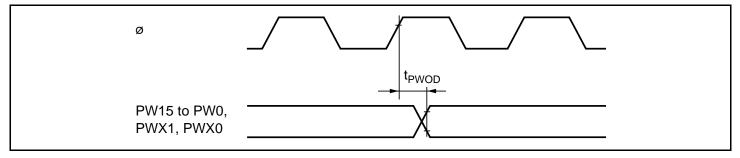


Figure 28.22 PWM, PWMX Output Timing

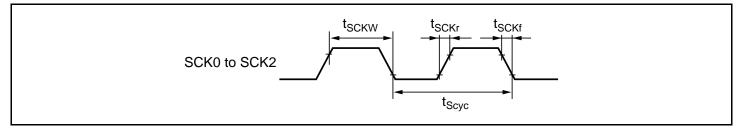


Figure 28.23 SCK Clock Input Timing

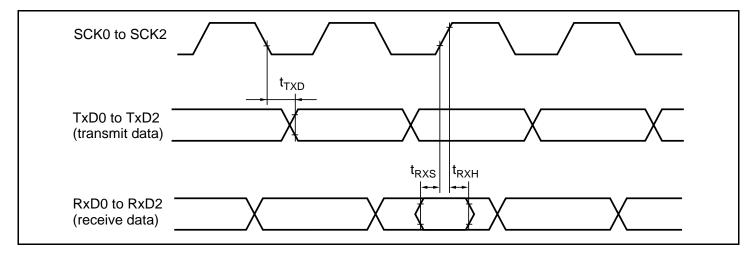


Figure 28.24 SCI Input/Output Timing (Synchronous Mode)

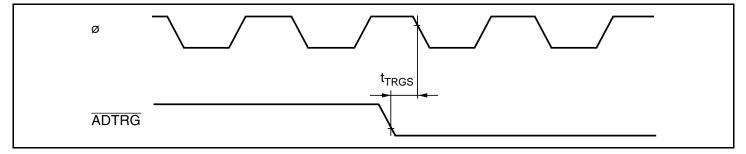


Figure 28.25 A/D Converter External Trigger Input Timing

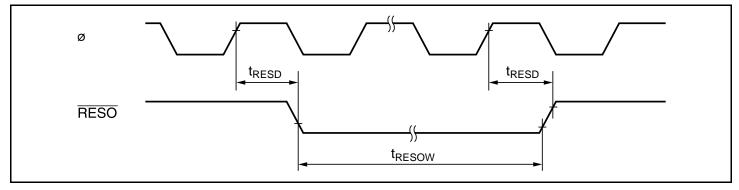


Figure 28.26 WDT Output Timing (RESO)

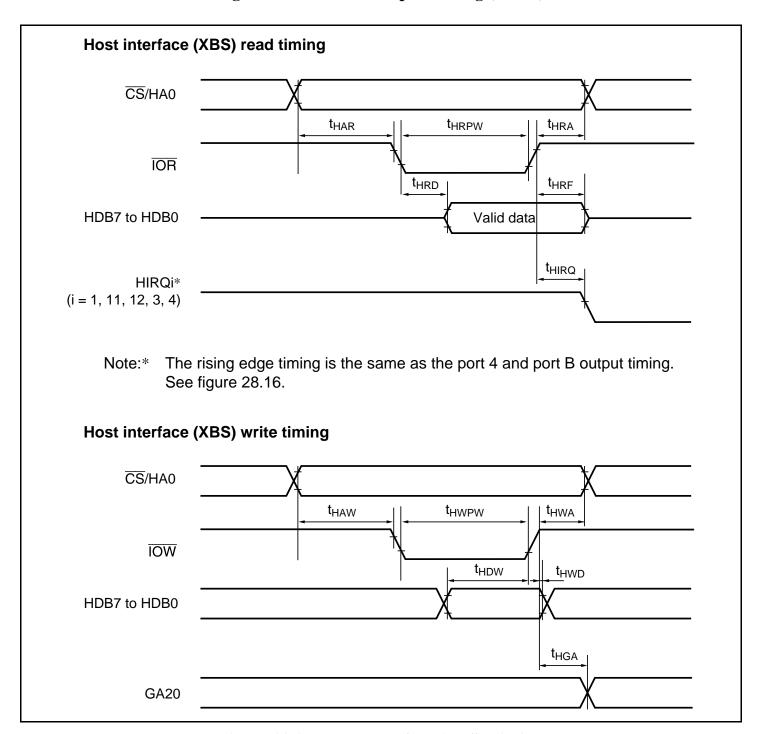


Figure 28.27 Host Interface (XBS) Timing

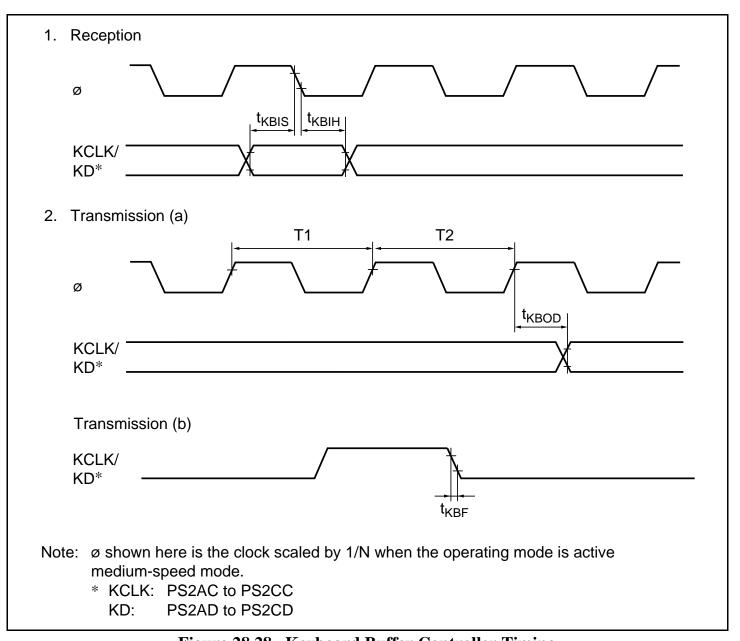


Figure 28.28 Keyboard Buffer Controller Timing

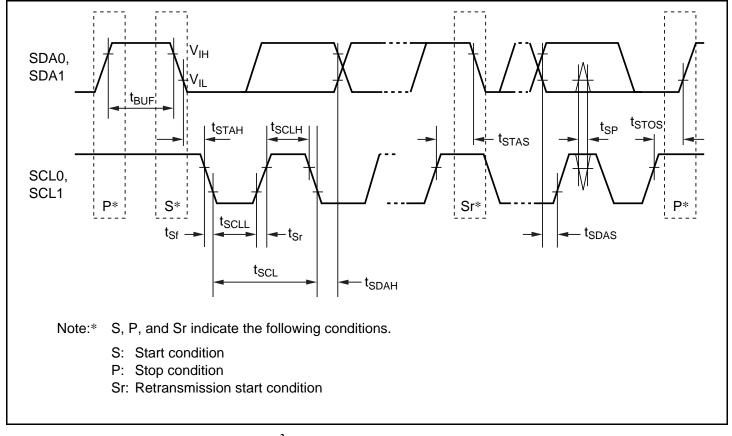


Figure 28.29 I²C Bus Interface Input/Output Timing

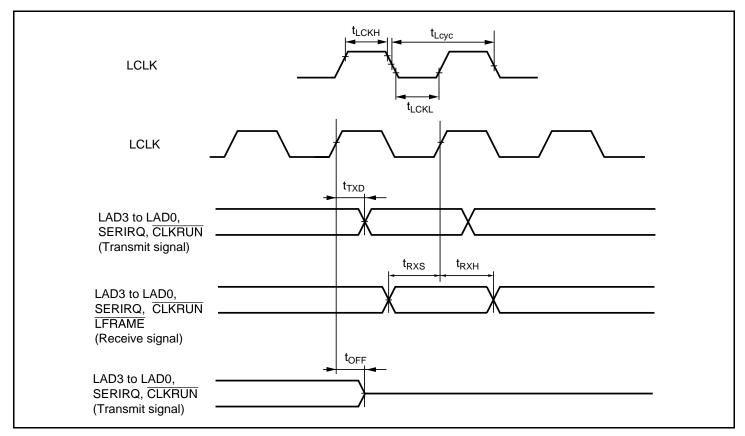


Figure 28.30 Host Interface (LPC) Timing

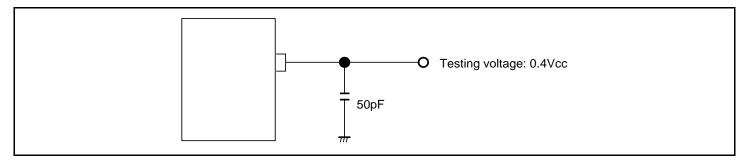


Figure 28.31 Tester Measurement Condition

Appendix A I/O Port States in Each Processing State

Table A.1 I/O Port States in Each Processing State

| Port Name Pin Name | MCU Operating Mode | Reset | Hardware Standby Mode | Software Standby Mode | Watch Mode | Sleep Mode | Sub- sleep Mode | Subactive Mode | Program Execution State |
|-----------------------|--------------------------|-------|-----------------------------|-----------------------------|---------------|---------------|-----------------------|----------------------------------|----------------------------------|
| Port 1 | 1 | L | Т | kept* | kept* | kept* | kept* | A7 to A0 | A7 to A0 |
| A7 to A0 | 2, 3 (EXPE = 1) | Т | | | | | | Address output/ input port | Address output/ input port |
| | 2, 3 (EXPE = 0) | | | | | | | I/O port | I/O port |
| Port 2 | 1 | L | Т | kept* | kept* | kept* | kept* | A15 to A8 | A15 to A8 |
| A15 to A8 | 2, 3 (EXPE = 1) | Т | | | | | | Address output/ input port | Address output/ input port |
| | 2, 3 (EXPE = 0) | | | | | | | I/O port | I/O port |
| Port 3 | 1 | Т | Т | Т | Т | Т | Т | D15 to D8 | D15 to D8 |
| D15 to D8 | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | kept | kept | kept | kept | I/O port | I/O port |
| Port 4 | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 5 | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 6 | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 7 | 1 | Т | Т | Т | Т | Т | Т | Input port | Input port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 8 | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 97 | 1 | Т | Т | T/kept | T/kept | T/kept | T/kept | WAIT/ | WAIT/ |
| WAIT | 2, 3 (EXPE = 1) | | | | | | | I/O port | I/O port |
| | 2, 3 (EXPE = 0) | | | kept | kept | kept | kept | I/O port | I/O port |

| Port Name Pin Name | MCU Operating Mode | Reset | Hardware Standby Mode | Software Standby Mode | Watch Mode | Sleep Mode | Sub- sleep Mode | Subactive Mode | Program Execution State |
|----------------------------|---|-------|-----------------------------|-----------------------------|---------------|------------------------------|-----------------------|-------------------------|--|
| Port 96 Ø EXCL | 1 | Clock | Т | [DDR = 1] H [DDR = 0] T | EXCL input | [DDR = 1] clock output | EXCL input | EXCL input | Clock output/ EXCL input/ input port |
| | $\frac{2, 3 \text{ (EXPE = 1)}}{2, 3 \text{ (EXPE = 0)}}$ | Т | | | | [DDR = 0] T | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Ports 95 to 93 AS, HWR, RD | | H | Т | Н | Н | Н | Н | AS, HWR, RD | AS, HWR, RD |
| AS, HWN, ND | 2, 3 (EXPE = 1) | T | | | | | | טט | ΠD |
| | 2, 3 (EXPE = 0) | | | kept | kept | kept | kept | I/O port | I/O port |
| Ports 92 to 91 | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |
| Port 90 | 1 | Т | Т | H/kept | H/kept | H/kept | H/kept | LWR/ | LWR/ |
| LWR | 2, 3 (EXPE = 1) | | | | | | | I/O port | I/O port |
| | 2, 3 (EXPE = 0) | | | kept | kept | kept | kept | I/O port | I/O port |
| Port A | 1 | Т | Т | kept* | kept* | kept* | kept* | I/O port | I/O port |
| A23 to A16 | 2, 3 (EXPE = 1) | | | | | | | A23 to A16/ I/O port | A23 to A16/ I/O port |
| | 2, 3 (EXPE = 0) | | | | | | | I/O port | I/O port |
| Port B | 1 | Т | Т | T/kept | T/kept | T/kept | T/kept | D7 to D0/ | D7 to D0/ |
| D7 to D0 | 2, 3 (EXPE = 1) | | | | | | | I/O port | I/O port |
| | 2, 3 (EXPE = 0) | | | kept | kept | kept | kept | I/O port | I/O port |
| Ports C to G | 1 | Т | Т | kept | kept | kept | kept | I/O port | I/O port |
| (H8S/2160B, H8S/2161B) | 2, 3 (EXPE = 1) | | | | | | | | |
| | 2, 3 (EXPE = 0) | | | | | | | | |

Legend

H: High

L: Low

T: High-impedance state

kept: Input ports are in the high-impedance state (when DDR = 0 and PCR = 1, input pull-up MOSs remain on).

Output ports maintain their previous state.

Depending on the pins, the on-chip peripheral modules may be initialized and the I/O port function determined by DDR and DR used.

DDR: Data direction register

Note: * In the case of address output, the last address accessed is retained.

Appendix B Product Codes

| Product Typ | Product Type | | Mark Code | Package (Hitachi Package Code) |
|-------------|---|--------------|----------------|-----------------------------------|
| H8S/2161B | Flash memory version (3-V version) | HD64F2161BV | F2161BVTE10 | 144-pin TQFP (TFP-144) |
| | Masked ROM version (3-V version) | HD6432161BV | 2161BV(***)TE | |
| | (3-V version with on-chip I ² C) | HD6432161BVW | 2161BVW(***)TE | <u>—</u> |
| H8S/2160B | Flash memory version (3-V version) | HD64F2160BV | F2160BVTE10 | <u> </u> |
| | Masked ROM version (3-V version) | HD6432160BV | 2160BV(***)TE | |
| | (3-V version with on-chip I ² C) | HD6432160BVW | 2160BVW(***)TE | |
| H8S/2141B | Flash memory version (3-V | HD64F2141BV | F2141BVFA10 | 100-pin QFP (FP-100B) |
| | version) | | F2141BVTE10 | 100-pin TQFP (TFP-100B) |
| H8S/2140B | Flash memory version (3-V | HD64F2140BV | F2140BVFA10 | 100-pin QFP (FP-100B) |
| | version) | | F2140BVTE10 | 100-pin TQFP (TFP-100B) |
| H8S/2145B | Flash memory version (3-V | HD64F2145BV | F2145BVFA10 | 100-pin QFP (FP-100B) |
| | version) | | F2145BVTE10 | 100-pin TQFP (TFP-100B) |
| H8S/2148B | Flash memory version (3-V | HD64F2148BV | F2148BVFA10 | 100-pin QFP (FP-100B) |
| versior | version) | | F2148BVTE10 | 100-pin TQFP (TFP-100B) |
| | Flash memory version (5-V | HD64F2148B | F2148BFA20 | 100-pin QFP (FP-100B) |
| | version) | | F2148BTE20 | 100-pin TQFP (TFP-100B) |

Legend

(***): ROM code

Note:* Some products above are in the developing or planning stage. Please contact Hitachi agency to conform the present state of each product.

Appendix C Package Dimensions

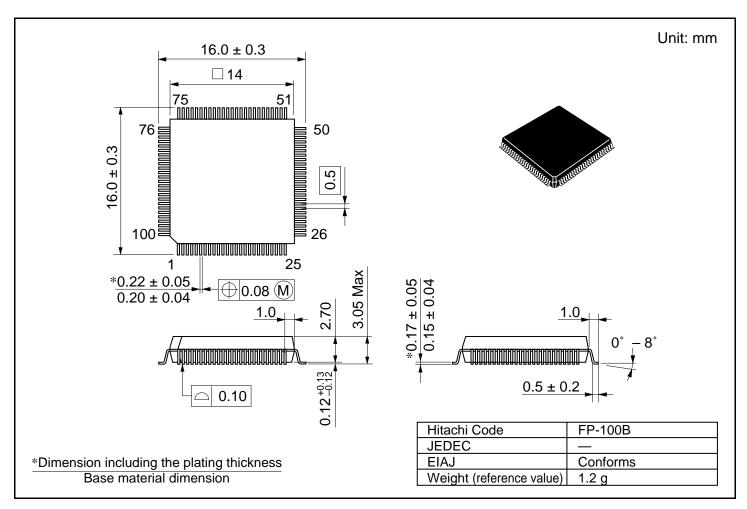


Figure C.1 Package Dimensions (FP-100B)

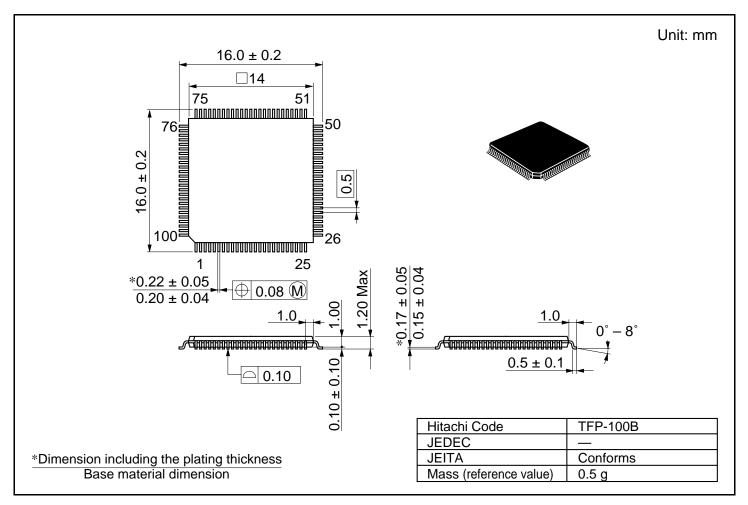


Figure C.2 Package Dimensions (TFP-100B)

RENESAS

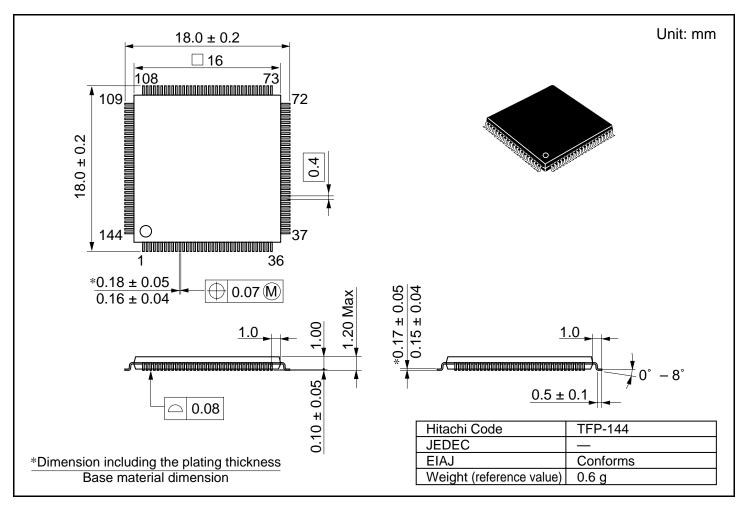


Figure C.3 Package Dimensions (TFP-144)

Main Revisions and Additions in this Edition

| Item | Page | Revisions (See Manual for Details) | | | | | | | |
|---|-------|---|---------------|----------------------|--------------|---------------|---------|--|--|
| Cover | Cover | The type nar | | | | | | | |
| Section 1 Overview | 2 | (Error) | | | (Correction) | | | | |
| 1.1 Overview | | Model | ROM | Remarks | Model | ROM | Remarks | | |
| On-chip memory | | HD64F2161BV* | 128 kbytes | Under development | HD64F2161BV* | 128 kbytes | | | |
| | | HD64F2160BV* | 64 kbytes | Under development | HD64F2160BV* | 64 kbytes | | | |
| | | HD64F2141BV* | 128 kbytes | Under development | HD64F2141BV* | 128 kbytes | | | |
| | | HD64F2140BV* | 64 kbytes | Under development | HD64F2140BV* | 64 kbytes | | | |
| | | HD64F2148BV* | 128 kbytes | Under development | HD64F2148BV* | 128 kbytes | | | |
| | | HD64F2148B | 128 kbytes | Under development | HD64F2148B | 128 kbytes | | | |
| | | Note: *3-V version | product | | | | | | |
| 1.2 Block Diagram Figure 1.1 Internal Block Diagram of H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B | 3 | (Error) → PB7/D7/WUE7 → PB6/D6/WUE6 → PB5/D5/WUE5 → PB4/D4/WUE4 → PB3/D3/WUE3/CS4 → PB2/D2/WUE2/CS3 → PB1/D1/WUE1/HIRQ4/LSCI* → PB0/D0/WUE0/HIRQ3/LSMI* Note: Not supported by the H8S/2148B and H8S/2145B (5-V version). (Correction) | | | | | | | |
| | | → PB7/D7/WUE7* → PB6/D6/WUE6* → PB5/D5/WUE5* → PB4/D4/WUE4* → PB3/D3/WUE3*/CS4 → PB2/D2/WUE2*/CS3 → PB1/D1/WUE1*/HIRQ4/LSCI* → PB0/D0/WUE0*/HIRQ3/LSMI* Note: The LPC function and the WUE pin function are not supported by the H8S/2148B. | | | | | | | |

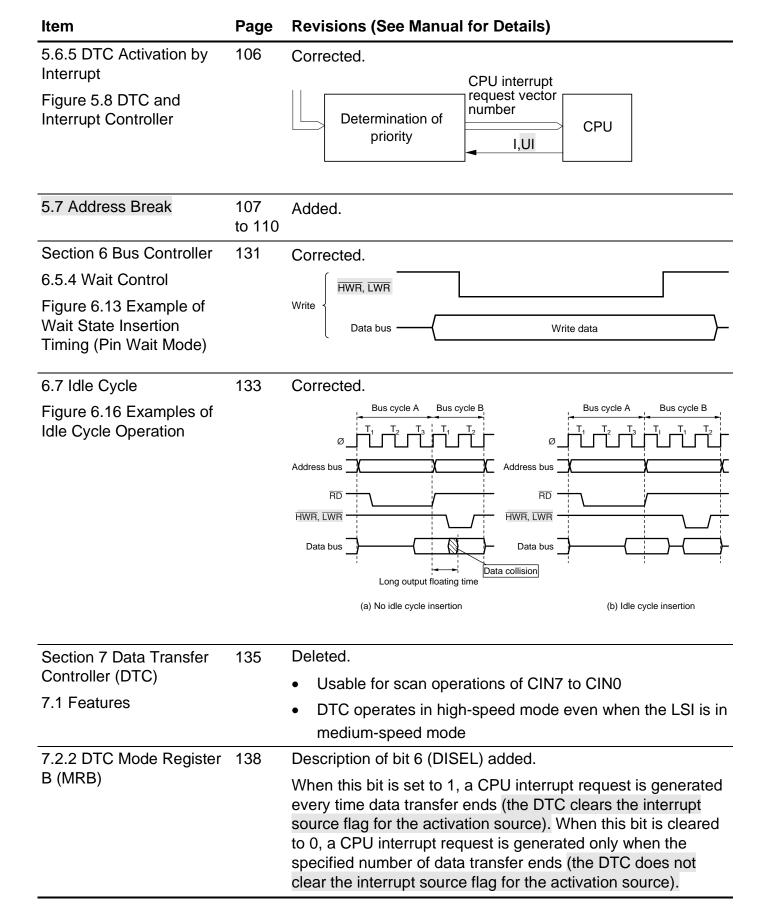
| ltem | Page | Revisio | ns (See Manual fo | or Details) | | | |
|--|---------|--------------------|--|----------------------------|--|--|--|
| 1.3 Pin Arrangement and | 5 | (Error) | | | | | |
| Functions | | | | | PB5/ <u>D5/WUE5</u> , 69 | | |
| 1.3.1 Pin Arrangement | | | / WUE4 , 80 PB3/D3 / WUE1 , 91 PB0/D0 | | 2/D2/WUE2, 90 | | |
| Figure 1.3 Pin Arrangement of | | Note:* | Not supported by | | | | |
| H8S/2140B, H8S/2141B, | | (Correct | | (100/21402 | • | | |
| H8S/2145B, and H8S/2148B | | 57 PB7/ 69 PB4/ | | 3/D3/ WUE3 *, 8 | 88 PB5/D5/ <u>WUE5</u> *, 81 PB2/D2/ <u>WUE2</u> *, | | |
| | | Note:* | The LPC function supported by the | • | oin function are not | | |
| 1.3.2 Pin Functions in | 9 to 11 | | | | | | |
| Each Operating Mode | | | | Pin Name | | | |
| Table 1.1 Pin Functions of H8S/2140B, H8S/2141B, | | Pin No. | Expanded Modes | | Single-Chip Modes | | |
| H8S/2145B, and | | FP-100B | Mode 1 | Mode 2, Mode 3 | Mode 2, Mode 3 | | |
| H8S/2148B in Each | | TFP-100B | | (EXPE = 1) | (EXPE = 0) | | |
| Operating Mode | | 57 | PB7/D7/WUE7* | PB7/D7/WUE7* | PB7/WUE7* | | |
| | | 58 | PB6/D6/WUE6* | PB6/D6/WUE6* | PB6/WUE6* | | |
| | | 68 | PB5/D5/WUE5* | PB5/D5/WUE5* | PB5/WUE5* | | |
| | | 69 | PB4/D4/WUE4* | PB4/D4/WUE4* | PB4/WUE4* | | |
| | | 80 | PB3/D3/WUE3* | PB3/D3/WUE3* | PB3/WUE3*/CS4 | | |
| | | 81 | PB2/D2/WUE2* | PB2/D2/WUE2* | PB2/WUE2*/CS3 | | |
| | | 90 | PB1/D1/WUE1* | PB1/D1/WUE1* | PB1/HIRQ4/WUE1*/LSCI* | | |
| | | 91 | PB0/D0/WUE0* | PB0/D0/WUE0* | PB0/HIRQ3/ WUE0*/LSMI* | | |
| | | Note: | The (B) in Pin No. mea | | | | |
| | | | *The LPC function and the H8S/2148B. | I the WUE pin functi | on are not supported by | | |

| Item | Page | Revi | sions (| See Manual for D | etails) | | | |
|--|--------|---|---------|---|--------------|---------|--|--|
| Table 1.2 Pin Functions of | 17 | Adde | ed. | | | | | |
| H8S/2160B and H8S/2161B in Each Operating Mode | | Note | | e (B) in Pin No. me Pin No. means the re. | | | ` / | |
| 1.3.3 Pin Functions | 18 | Name and Function of XTAL, EXTAL in Clock amended. | | | | | | |
| Table 1.3 Pin Functions | | (Erro | r) | | | | | |
| | | See section 24, Clock Pulse Generator, for typical connection diagrams. | | | | | | |
| | | (Correction) | | | | | | |
| | | See section 25, Clock Pulse Generator, for typical connectidiagrams. | | | | | | |
| | 22 | Name and Function of SERIRQ in Host interface (LPG amended. | | | | | | |
| | | (Error) | | | | | | |
| | | Input/output pin for LPC serialized host interrupts (HIRQ1, HIRQ6, HIRQ9 to HIRQ12). | | | | | | |
| | | (Correction) | | | | | | |
| | | Input/output pin for LPC serialized host interrupts (HIRQ1, SMI, HIRQ6, HIRQ9 to HIRQ12). | | | | | | |
| | 24, 25 | | | | | | | |
| | | Туре | Symbol | Name and Function | Туре | Symbol | Name and Function | |
| | | I/O ports | P47-P40 | Eight input/output pins. | I/O ports | P47-P40 | Eight input/output pins. (The output type of P42 is NMOS push-pull.) | |
| | | | P52-P50 | Three input/output pins. | | P52-P50 | Three input/output pins. (The output type of P52 is NMOS push-pull.) | |
| | | | P86-P80 | Seven input/output pins. | | P86-P80 | Seven input/output pins. (The output type of P86 is NMOS push-pull.) | |
| | | | P97-P90 | Eight input/output pins. | | P97-P90 | Eight input/output pins. (The output type of P97 is NMOS push-pull.) | |
| | | | PG7-PG0 | Eight input/output pins. | | PG7-PG0 | Eight input/output pins. (The output type of PPG7-PG0 in the H8S/2160B and the H8S/2161B is NMOS push-pull.) | |

| Item | Page | Revisio | ns (See Manual for Details) | | | |
|--|------|--|---|--|--|--|
| Section 3 MCU Operating | 66 | Descript | ion of bit 1 amended. | | | |
| Modes | | (Error) k | eyboard buffer controller | | | |
| 3.2.2 System Control Register (SYSCR) | | (Correct | ion) keyboard matrix interrupt | | | |
| Section 4 Exception Handling | 84 | Correcte | ed. Address | | | |
| 4.7 Usage Note | | | | | | |
| Figure 4.3 Operation when SP Value is Odd | | SP→ | CCR SP→ R1L H'FFEFFA H'FFEFFB PC PC H'FFEFFC H'FFEFFD H'FFEFFF H'FFEFFFF H'FFEFFFF H'FFEFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFF | | | |
| | | [| TRAPA instruction executed MOV.B R1L, @-ER7 executed | | | |
| | | SP so | et to H'FFEFFF Data saved above SP Contents of CCR lost | | | |
| | | | | | | |
| Section 5 Interrupt Controller | 86 | (Error) | (Correction) | | | |
| 5.1 Features | | KMIMR WUEMR KIN input | | | | |
| Figure 5.1 Block Diagram of Interrupt Controller | | WUE input | KIM and WUE input KIN and WUE input | | | |
| 5.3.1 Interrupt Control Registers A to C (ICRA to | 88 | , | The ICR registers set interrupt control levels for interrupts other than NMI. | | | |
| ICRC) | | (Correction) The ICR registers set interrupt control levels finterrupts other than NMI and address breaks | | | | |
| 5.3.6 IRQ Status Register | 92 | Bits 7 to | | | | |
| (ISR) | | R/W | Description | | | |
| | | R/(W)*2 | When interrupt exception handling is executed when low-level detection is set and \overline{IRQn} input is high $(n = 7 \text{ to } 0)^{*1}$ | | | |
| | | When IRQn interrupt exception handling is executed when falling edge, rising-edge, or both-edge detection is set*1 | | | | |
| | | Notes: | 1. When a product, in which a DTC is incorporated, is used, the corresponding flag bit is not automatically cleared even when exception handing is executed. For details, refer to section 5.8.4, Setting on a Product Incorporating DTC. | | | |
| | | | 2. Only 0 can be written, for flag clearing. | | | |

 $Downloaded \ from \ \underline{Elcodis.com} \ \ electronic \ components \ distributor$

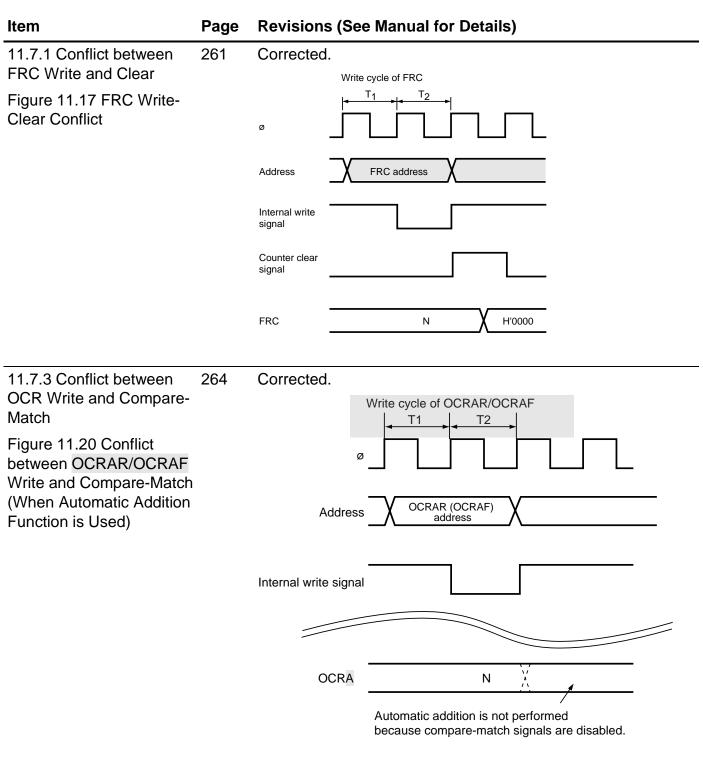
| Item | Page | Revisions (See Manual for Details) | | | | | | | |
|--|-------------|------------------------------------|---------------------------------------|--|-------------------------------|------------------|----------------------------|--|--|
| 5.3.7 Keyboard Matrix | 92 | (Error) Th | (Error) The KMIMR and WUEMR registers | | | | | | |
| Interrupt Mask Registers (KMIMRA, KMIMR) | (Correction | on) Th | ne KMIMRA, KM | IMR, and V | VUEMF | RB registers | | | |
| Wake-Up Event Interrupt | 93 | Added. | | | | | | | |
| Mask Register | | • WUE | MRB* | | | | | | |
| (WUEMRB) | | Note:* | Not s | upported by the I | H8S/2148E | 3. | | | |
| 5.4 Interrupt Sources | 95 | Description | on ad | ded to IRQ7 to IF | RQ0 Interru | upts. | | | |
| 5.4.1 External Interrupts | | Interr settin | • | ontrol levels can | be specifie | d by the | e ICR | | |
| Table 5.3 Interrupt | 98 | (Error) | | | | | | | |
| Sources, Vector Addresses, and Interrupt | | Origin of | | | Vastan | | Vector Address // | | |
| Priorities | | Interrupt Source | Name | | Vector Number | Normal Mode | Advanced // Mode | | |
| | | _ | Reserve | ed for system use | 100 | H'00C8 | H'000190 | | |
| | | | | | 101 102 | H'00CA | H'000194 \\ H'000198 \\ | | |
| | | | | | 103 | H'00CE | H'00019C | | |
| | | LPC* | | ransfer error) DR1 reception completio | 112 n) 113 | H'00D0 H'00DA | H'0001B0 H'0001B4 | | |
| | | | , | DR2 reception completion of the DR3 reception completion completion completion completion reception completion are set that the DR3 reception completion is a set of the DR3 reception completion are set of the DR3 reception completion are set of the DR3 reception completion are set of the DR3 reception completion are set of the DR3 reception completion are set of the DR3 reception completion completion completion completion completion are set of the DR3 reception comple | , | H'00DC H'00DE | H'0001B8 H'0001BC | | |
| | | (Correction) | | | | | | | |
| | | Origin of | | | | Vector Address | | | |
| | | Interrupt Source | Interrupt | | Vector Number | Normal Mode | Advanced Mode | | |
| | | _ | Reserve | ed for system use | 100 | H'00C8 | H'000190 | | |
| | | | | | to 107 | to H'00D6 | to H'0001AC | | |
| | | LPC* | ransfer error) | 108 | H'00D8 | H'0001B0 | | | |
| | | | IBF2 (ID | OR1 reception completion OR2 reception completion | n) 110 | H'00DA H'00DC | H'0001B4 H'0001B8 | | |
| | | | IBF3 (IL | OR3 reception completio | n) 111 | H'00DE | H'0001BC // | | |
| 5.6.1 Interrupt Control Mode 0 | 99 | In interru | • | ntrol mode 0, inte | rrupt reque | ests oth | er than NMI | | |
| 5.6.4 Interrupt Response | 105 | Corrected | d. | | | | | | |
| Times | | | | Object o | f Access | | | | |
| Table 5.6 Number of States in Interrupt | | External Device | | | | | | | |
| Handling Routine | | | it Bus | | 16-Bit Bus | | | | |
| Execution Status | | 2-State Ac | cess | 3-State Access | 2-State Access 3-State Access | | | | |
| | | 4 | | 6 + 2m | 2 | 3 | + m | | |
| | | - | | | | | | | |



| Table 7.1 Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs IIC_1 94 DTCED3 | Item | Page | Revisions (See Manual for Details) | | | | |
|---|------------------------|------|------------------------------------|--------------------------|----------------|-----------------------|--|
| Vector Table Table 7.1 Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs IIC_1 | • | 143 | Corre | cted. | | | |
| Corresponding DTCEs | Vector Table | | Activa | ation Source Origin | | DTC Vector Address | |
| Addresses, and Corresponding DTCES ### LPC** ### 109 | • | | IIC_1 | | 94 | DTCED3 | |
| 110 DTCEE1 | · · | | LPC* | 2 | 108 | DTCEE3 | |
| T.8.1 Module Stop Mode Setting | Corresponding DTCEs | | | | 109 | DTCEE2 | |
| T.8.1 Module Stop Mode Setting | | | | | 110 | DTCEE1 | |
| Cerror For details, refer to section 25, Power-Down Modes. (Correction) For details, refer to section 26, Power-Down Modes. | | | | | 111 | DTCEE0 | |
| Cerror For details, refer to section 25, Power-Down Modes. (Correction) For details, refer to section 26, Power-Down Modes. | | | | | | | |
| Correction For details, refer to section 26, Power-Down Modes. | 7.8.1 Module Stop Mode | 154 | Descr | ription amended. | | | |
| Section 8 I/O Ports | Setting | | (Error | r) For details, refer to | o section 25, | Power-Down Modes. | |
| Table 8.1 Port Functions of H8S/2140B, H8S/2141B, H8S/2145B, and H8S/2148B Port Mode 1 (EXPE = 1) (EXPE = 0) | | | (Corre | , | efer to sectio | on 26, Power-Down | |
| 158 | Section 8 I/O Ports | • | I/O St | atus of Port 6, Port | A, and Port I | 3 | |
| Node 2, Mode 3 Node 2, Mode 3 | | 159 | Descr | iption of On-chip in | out pull-up M | OSs added. | |
| Port 9 P97/WAIT/SDA0 P97/SDA0 P96/ø/EXCL P96/ø/EXCL AS/IOS P95/CS1 HWR P94/IOW RD P93/IOR P92/IRQO P92/IRQO P91/IRQI P91/IRQI P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/WUE6* PB6/D6/WUE6* PB6/WUE6* PB5/D5/WUE5* PB5/WUE5* PB4/D4/WUE4* PB4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS6 | H8S/2141B, H8S/2145B, | | | | Mode 2, Mode 3 | | |
| P96/ø/EXCL AS/IOS P95/CS1 HWR P94/IOW RD P92/IRQ0 P92/IRQ0 P91/IRQ1 P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS6 | | | Port | Mode 1 | (EXPE = 1) | (EXPE = 0) | |
| AS/IOS P95/CST HWR P94/IOW RD P93/IOR P92/IRQ0 P92/IRQ0 P91/IRQ1 P91/IRQ1 P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB7/WUE7* PB6/D6/WUE6* PB6/WUE6* PB5/D5/WUE5* PB5/WUE5* PB4/D4/WUE4* PB4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS6 | | | Port 9 | P97/WAIT/SDA0 | | P97/SDA0 | |
| HWR RD P93/IOR P92/IRQ0 P91/IRQ1 P91/IRQ1 P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB1/WUE1*/HIRQ4/LS6 | | | | P96/ø/EXCL | | P96/ø/EXCL | |
| P92/ĪRQ0 P92/ĪRQ0 P91/ĪRQ1 P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1*/HIRQ4/LS6 | | | | AS/IOS | | P95/CS1 | |
| P92/ĪRQ0 P91/ĪRQ1 P91/ĪRQ1 P90/LWR/ĪRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB1/D1/WUE1* PP1/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/IRQ1 P91/WUE7* PB6/WUE6* PB6/WUE6* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* PB4/WUE4* | | | | HWR | | P94/IOW | |
| P91/IRQ1 P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB1/D1/WUE1* PP1/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 P90/IRQ1 PB7/WUE7* PB7/WUE7* PB6/WUE6* PB6/WUE5* PB5/WUE5* PB4/WUE4* PB4/WUE4* PB1/WUE1*/HIRQ4/LS6 | | | | RD | | P93/IOR | |
| P90/LWR/IRQ2/ADTRG P90/IRQ2/ADTRG/ECS Port B PB7/D7/WUE7* PB6/D6/WUE6* PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB1/WUE1*/HIRQ4/LS6 | | | | P92/IRQ0 | | P92/IRQ0 | |
| Port B PB7/D7/WUE7* PB6/WUE6* PB6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB1/D1/WUE1*/HIRQ4/LS6 | | | | P91/IRQ1 | | P91/IRQ1 | |
| PB6/D6/WUE6* PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB2/D2/WUE2* PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS6 | | | | P90/LWR/IRQ2/ADTRO | <u> </u> | P90/IRQ2/ADTRG/ECS2 | |
| PB5/D5/WUE5* PB4/D4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS6 | | | Port B | PB7/D7/WUE7* | | PB7/WUE7* | |
| PB4/D4/WUE4* PB4/WUE4* PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS0 | | | | PB6/D6/WUE6* | | PB6/WUE6* | |
| PB3/D3/WUE3* PB3/WUE3*/CS4 PB2/D2/WUE2* PB2/WUE2*/CS3 PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS0 | | | | PB5/D5/WUE5* | | PB5/WUE5* | |
| PB2/D2/\overline{\text{WUE2}}* PB2/\overline{\text{WUE2}}*/\overline{\text{CS3}} PB1/\overline{\text{D1}}/\overline{\text{WUE1}}*/HIRQ4/LS0 | | | | PB4/D4/WUE4* | | PB4/WUE4* | |
| PB1/D1/WUE1* PB1/WUE1*/HIRQ4/LS0 | | | | PB3/D3/WUE3* | | PB3/WUE3*/CS4 | |
| | | | | PB2/D2/WUE2* | | PB2/WUE2*/CS3 | |
| PB0/D0/WUE0* PB0/WUE0*/HIRQ3/LSI | | | | PB1/D1/WUE1* | | PB1/WUE1*/HIRQ4/LSCI* | |
| | | | | PB0/D0/WUE0* | | PB0/WUE0*/HIRQ3/LSMI* | |
| Note:* Not supported by the H8S/2148B. | | | Note:* | Not supported by the | H8S/2148B. | | |

| Item | Page | Revisions (See Manual | for Details) | | | |
|---|---------------|--|--|--|--|--|
| 8.4.4 Pin Functions | 168 | Note: Not supported b | y the H8S/2148B. | | | |
| 8.9.3 Pin Functions | 184 to 186 | | | | | |
| 8.12.4 Pin Functions | 200 to 202 | | | | | |
| 8.6.1 Port 5 Data Direction | 174 | Descriptions of bits 2 to 0 | added. | | | |
| Register (P5DDR) | | | pins are output ports when P5DDR at ports when cleared to 0. | | | |
| 8.11 Port A | 191 | (Error) Port A pin function modes. | ns are the same in all operating | | | |
| | | (Correction) Port A pin functions change according to the operating mode. | | | | |
| 8.11.1 Port A Data Direction Register (PADDR) | 192 | Description added. | | | | |
| 8.11.3 Port A Input Data | 193 | Description amended. | | | | |
| Register (PAPIN) | | Reading PAPIN always returns the pin states. PAPIN has same address as PADDR. If a write is performed, the posettings will change. | | | | |
| 8.13 Additional Overview | 203 | (Error) | | | | |
| for H8S/2160B and H8S/2161B | | Ports C, D, E, and F have a built-in MOS input pull-up function. On ports C, D, E, F, and G, whether the MOS input pull-up is on or off is controlled by the corresponding DDR and DR. | | | | |
| | | (Correction) | | | | |
| | | Ports C, D, E, and F have an on-chip input pull-up MOS function. On ports C, D, E, and F, whether the input pull-up MOS is on or off is controlled by the corresponding DDR and ODR. | | | | |
| 8.15.5 Pin Functions | 213 | (Error) | (Correction) | | | |
| | | V _{ss} -side ch. driver | N-ch. driver | | | |
| | | V _{ss} -side N-ch. driver | P-ch. driver | | | |
| | | | | | | |

| Item | Page | Revisions (See Manual for Details) | | | |
|---|---------------|---|--|--|--|
| 8.16.4 Port G Nch-OD | 216 | Bit description amended. | | | |
| Control Register (PGNOCR) | | 1: Vss-side N-channel open drain | | | |
| Section 9 8-Bit PWM | 222 | Description added. | | | |
| Timer (PWM) | | PWDR0 to PWDR15 are initialized to H'00. | | | |
| 9.3.2 PWM Data Registers (PWDR0 to PWDR15) | | | | | |
| 9.5 Usage Note | 226 | Added. | | | |
| 9.5.1 Module Stop Mode Setting | | | | | |
| Section 10 14-Bit PWM | 228 | Description added. | | | |
| Timer (PWMX) | | Since DACNT consists of 16-bit data, DACNT transfers data | | | |
| 10.3.1 PWM (D/A) Counters H and L (DACNTH, DACNTL) | | to the CPU via the temporary register (TEMP). | | | |
| 10.3.2 PWM (D/A) Data | 230 | Description added. | | | |
| Registers A and B (DADRA, DADRB) | | Since DADR consists of 16-bit data, DADR transfers data to the CPU via the temporary register (TEMP). | | | |
| 10.5 Operation | 237 to 239 | Description of additional pulse added. | | | |
| 10.6 Usage Note | 240 | Added. | | | |
| 10.6.1 Module Stop Mode Setting | | | | | |
| Section 11 16-Bit Free- | 242 | Legend | | | |
| Running Timer (FRT) | | OCRDM: Output compare register DM (16-bit) | | | |
| 11.1 Features | | | | | |
| Figure 11.1 Block Diagram of 16-Bit Free- Running Timer | | | | | |
| 11.3.7 Timer | 249 | Description of bit 1 amended. | | | |
| Control/Status Register (TCSR) | | (Error) Overflow Flag | | | |
| | | (Correction) Timer Overflow | | | |



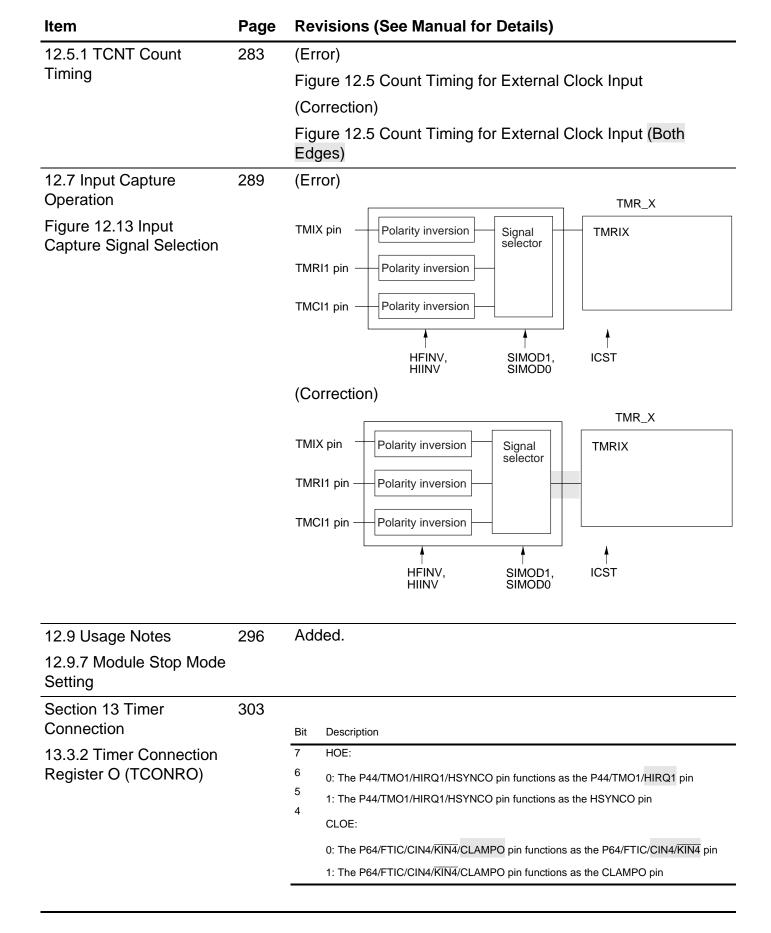
11.7.5 Module Stop Mode 266 Setting

Added.

| Item | Page | Revisions (See Manual for Details) |
|---|------|---|
| Section 12 8-Bit Timer (TMR) 12.1 Features | 267 | Timer output controlled by two compare-match signals The timer output signal in each channel is controlled by two independent compare-match signals, enabling the timer to be used for various applications, such as the generation of pulse output or PWM output with an arbitrary duty cycle. (Correction) Timer output controlled by two compare-match signals The timer output signal in each channel is controlled by two independent compare-match signals, enabling the timer to be used for various applications, such as the generation of pulse output or PWM output with an arbitrary duty cycle. (The TMR_Y does not have a |
| | | timer output pin.) (Error) Cascading of two channels Cascading of TMR_0 and TMR_1 (Correction) Cascading of TMR_0 and TMR_1 (TMR_Y and TMR_X cannot be cascaded.) |
| | 268 | (Error) Figure 12.1 Block Diagram of 8-Bit Timers (TMR_0, TMR_1, TMR_X, and TMR_Y) (Correction) Figure 12.1 Block Diagram of 8-Bit Timers (TMR_0 and TMR_1) |
| Figure 12.2 Block Diagram of 8-Bit Timers (TMR_Y and TMR_X) | 269 | Added. |

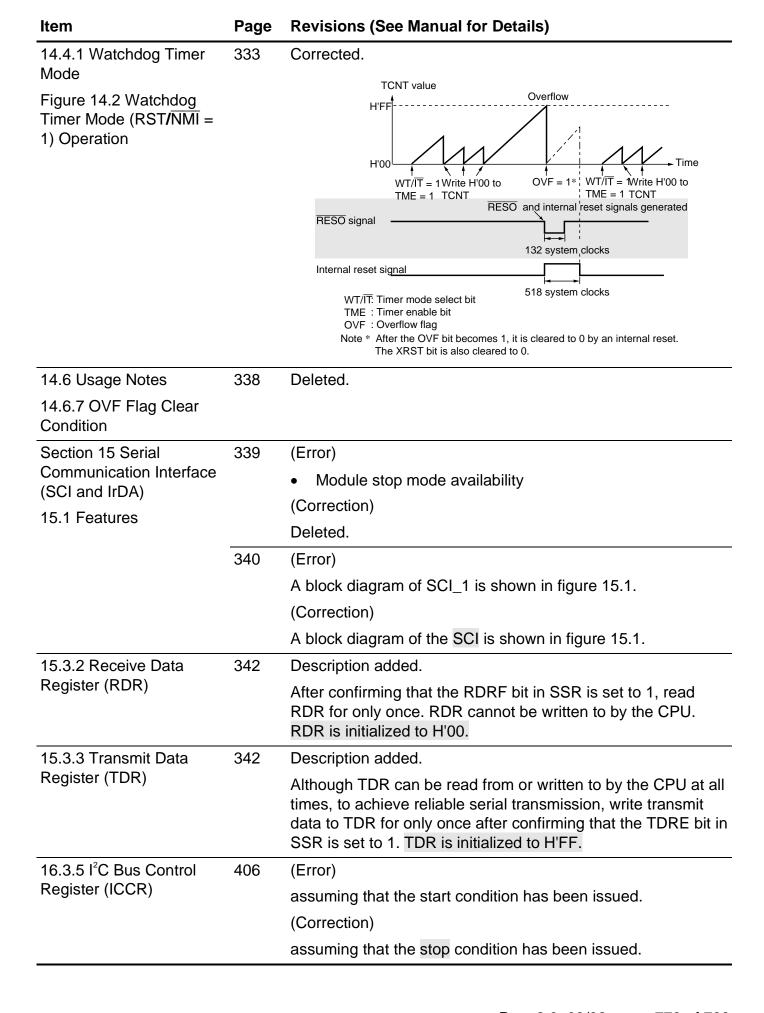
| Item | Page | Revisions (See Manual for Details) | | | | | | | |
|-------------------------|------|------------------------------------|-------------------------|-------------------------------|--------|---|--|--|--|
| 12.2 Input/Output Pins | 270 | (Error) | | | | | | | |
| Table 12.1 Pin | | Channel | Name | Symbol | I/O | Function | | | |
| Configuration | | TMR_0 | Timer output | TMO0 | Output | Output controlled by compare-match | | | |
| | | | Timer clock/reset input | TMI0/ExTMI0 | Input | External clock input (TMCI0)/external reset input (TMRI0) for the counter | | | |
| | | TMR_1 | Timer output | TMO1 | Output | Output controlled by compare-match | | | |
| | | | Timer clock/reset input | TMI1/ExTMI1 | Input | External clock input (TMCI1)/external reset input (TMRI1) for the counter | | | |
| | | TMR_Y | Timer clock/reset input | TMIY/ExTMIY | Input | External clock input (TMCIY)/external reset input (TMRIY) for the counter | | | |
| | | TMR_X | Timer output | TMOX | Output | Output controlled by compare-match | | | |
| | | | Timer clock/reset input | TMIX/ExTMIX | Input | External clock input (TMCIX)/external reset input (TMRIX) for the counter | | | |
| | | (Correction) | | | | | | | |
| | | Channel | Name | Symbol | I/O | Function | | | |
| | | TMR_0 | Timer output | TMO0 | Output | Output controlled by compare-match | | | |
| | | | Timer clock input | TMCI0 | Input | External clock input for the counter | | | |
| | | | Timer reset input | TMRI0 | Input | External reset input for the counter | | | |
| | | TMR_1 | Timer output | TMO1 | Output | Output controlled by compare-match | | | |
| | | | Timer clock input | TMCI1 | Input | External clock input for the counter | | | |
| | | | Timer reset input | TMRI1 | Input | External reset input for the counter | | | |
| | | TMR_Y | Timer clock/reset input | VSYNCI/TMIY (TMCIY/TMRIY) | Input | External clock input/external reset input for the counter | | | |
| | | TMR_X | Timer output | TMOX | Output | Output controlled by compare-match | | | |
| | | | Timer clock/reset input | HFBACKI/TMIX (TMCIX/TMRIX) | Input | External clock input/external reset input for the counter | | | |
| 12.3.5 Timer | 278 | TCSR_Y | | | | | | | |
| Control/Status Register | 2.0 | Bit 4 | ,OI_ I | | | | | | |
| (TCSR) | | The initial value is amended to 0. | | | | | | | |

| Item | Page | Revision | ons (| See Manual for Details) | | | |
|---------------------------|------|---|-------|--|--|--|--|
| 12.3.5 Timer | 279 | • TCS | SR_Y | , | | | |
| Control/Status Register | | (Error) | | | | | |
| (TCSR) | | Bits 3 a | nd 2 | | | | |
| | | change | d by | pecify how the TMOY pin output level is to be compare-match B of TCORB_Y and TCNT_Y. | | | |
| | | Bits 1 a | | | | | |
| | | | | pecify how the TMOY pin output level is to be compare-match A of TCORA_Y and TCNT_Y. | | | |
| | | Note:* | Onl | y 0 can be written, for flag clearing. | | | |
| | | (Correc | tion) | | | | |
| | | Bits 3 a | ınd 2 | | | | |
| | | | | pecify how the TMOY pin *2 output level is to be compare-match B of TCORB_Y and TCNT_Y. | | | |
| | | Bits 1 a | ınd 0 | | | | |
| | | These bits specify how the TMOY pin*2 output level is to be changed by compare-match A of TCORA_Y and TCNT_Y. | | | | | |
| | | Notes: | 1. (| Only 0 can be written, for flag clearing. | | | |
| | | | | This product does not have a TMOY external put pin. | | | |
| 12.3.9 Timer Input Select | 282 | (Error) | | | | | |
| Register (TISR) | | Bit Bit | Name | Description | | | |
| | | 0 IS | | Input Select | | | |
| | | | | Selects an internal synchronization signal (IVG signal) or timer clock/reset input pin (TMIY or ExTMIY) as the signal source of external clock/reset input for the TMRY counter. | | | |
| | | | | 0: IVG signal is selected | | | |
| | | | | 1: TMIY or ExTMIY (TMCIY/TMRIY) is selected | | | |
| | | (Correc | tion) | | | | |
| | | Bit Bit | Name | Description | | | |
| | | 0 IS | | Input Select | | | |
| | | | | Selects an internal synchronization signal (IVG signal) or timer clock/reset input pin VSYNCI/TMIY (TMCIY/TMRIY) as the signal source of external clock/reset input for the TMR_Y counter. | | | |
| | | | | 0: IVG signal is selected | | | |
| | | | | 1: VSYNCI/TMIY (TMCIY/TMRIY) is selected | | | |
| | | | | | | | |

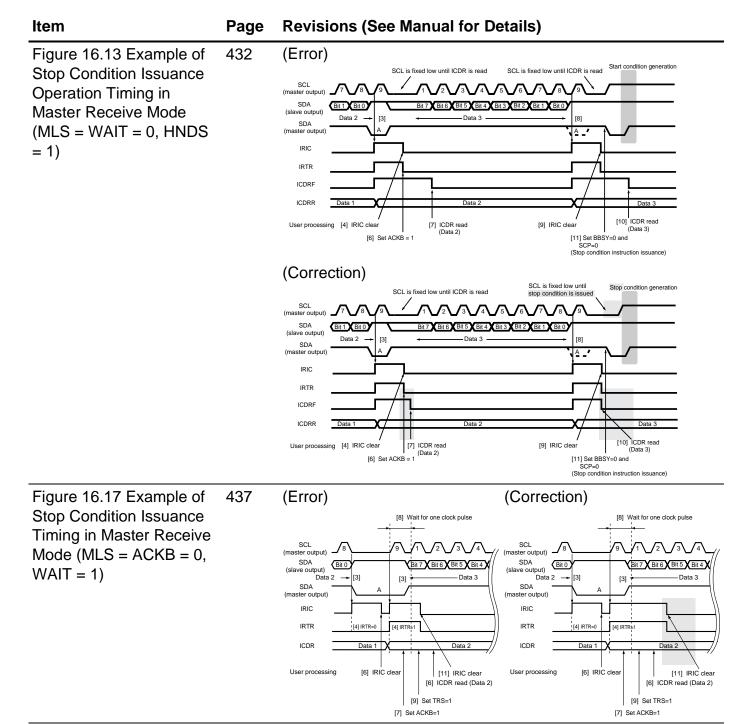


| Item | Page | Revis | sions (See Manual f | for Deta | ails) | |
|---|------|--|--|-----------|---|--|
| 13.3.4 Edge Sense | 308 | (Error | ·) | (Corre | ection) | |
| Register (SEDGR) | | Bit | Bit Name | Bit | Bit Name | |
| | | 2 | PREDG | 2 | PREQF | |
| | | | | | | |
| 13.5 Usage Note | 323 | Adde | d. | | | |
| 13.5.1 Module Stop Mode Setting | | | | | | |
| Section 14 Watchdog | 329 | CKS2 | to CKS0, Clock Se | lect 2 to | 0 | |
| Timer (WDT) | | (Error | ·) | | | |
| 14.3.2 Timer Control/Status Register (TCSR) | | | ts the clock source tency for $\emptyset = 25 \text{ MHz}$ | • | out to. The overflow osed in parentheses. | |
| • TCSR_0 | | (Corre | ection) | | | |
| 1 100K_0 | | Selects the clock source to be input to. The overflow frequency for $\emptyset = 10$ MHz is enclosed in parentheses. | | | | |
| | | (Error | ·) | | | |
| | | 000: ø/2 (frequency: 20.4 μs) 001: ø/64 (frequency: 655.3 μs) | | | | |
| | | | | | | |
| | | 010: ø/128 (frequency: 1.3 ms) | | | | |
| | | 011: ø/512 (frequency: 5.2 ms) | | | | |
| | | 100: ø/2048 (frequency: 20.9 ms) | | | | |
| | | 101: ៨ | ø/8192 (frequency: 8 | 33.8 ms) | | |
| | | 110: ៨ | ø/32768 (frequency: | 335.5 n | ns) | |
| | | 111: g | ø/131072 (frequency | /: 1.34 s | 3) | |
| | | ` | ection) | | | |
| | | | ø/2 (frequency: 51.2 | • / | | |
| | | | ø/64 (frequency: 1.6 | | | |
| | | | ø/128 (frequency: 3.: | | | |
| | | | ø/512 (frequency: 13 | | | |
| | | | 9/2048 (frequency: 5 | | | |
| | | | 9/8192 (frequency: 2 | | • | |
| | | | 7/32768 (frequency: | | | |
| | | 111.9 | ø/131072 (frequency | 7. 3.30 S | ·) | |

| Item | Page | Revisions (See Manual for Details) |
|-------------------------|------|--|
| 14.3.2 Timer | 331 | CKS2 to CKS0, Clock Select 2 to 0 |
| Control/Status Register | | (Error) |
| (TCSR) • TCSR_1 | | Selects the clock source to be input to TCNT. The overflow cycle for \emptyset = 25 MHz and \emptyset SUB = 32.768 MHz is enclosed in parentheses. |
| | | (Correction) |
| | | Selects the clock source to be input to TCNT. The overflow cycle for $\emptyset = 10$ MHz and \emptyset SUB = 32.768 kHz is enclosed in parentheses. |
| | | When PSS = 0: |
| | | (Error) |
| | | 000: ø/2 (frequency: 20.4 μs) |
| | | 001: ø/64 (frequency: 655.3 μs) |
| | | 010: ø/128 (frequency: 1.3 ms) |
| | | 011: ø/512 (frequency: 5.2 ms) |
| | | 100: ø/2048 (frequency: 20.9 ms) |
| | | 101: ø/8192 (frequency: 83.8 ms) |
| | | 110: ø/32768 (frequency: 335.5 ms) |
| | | 111: ø/131072 (frequency: 1.34 s) |
| | | (Correction) |
| | | 000: ø/2 (frequency: 51.2 μs) |
| | | 001: ø/64 (frequency: 1.64 ms) |
| | | 010: ø/128 (frequency: 3.28 ms) |
| | | 011: ø/512 (frequency: 13.1 ms) |
| | | 100: ø/2048 (frequency: 52.4 ms) |
| | | 101: ø/8192 (frequency: 209.7 ms) |
| | | 110: ø/32768 (frequency: 0.84 s) |
| | | 111: ø/131072 (frequency: 3.36 s) |



| Item | Page | Revisions (See Manual for Details) |
|---|------|---|
| 16.3.8 I ² C Bus Extended | 422 | [Clearing Conditions] |
| Control Register (ICXR) | | (Error) |
| | | ICDRF is set to 1 again. |
| | | (Correction) |
| | | ICDRE is set to 1 again. |
| Section 16 I ² C Bus Interface (IIC) (Optional) | 429 | (Error) (Correction) |
| 16.4.3 Master Transmit Operation | | Note: * Data write timing in ICDR Normal |
| Figure 16.9 Example of Operation Timing in Master Transmit Mode (MLS = WAIT = 0) | | User processing [4] BBSY set to 1 SCP cleared to 0 (start condition issuance) Note: Data write in ICDR prohibited User processing [4] BBSY set to 1 SCP cleared to 0 (start condition issuance) |
| 16.4.4 Master Receive | 430 | (Error) |
| Operation | | The master device transmits data containing the slave address and R/\overline{W} (0: read) in the first frame following the start condition issuance in master transmit mode, selects the slave device, and then switches the mode for receive operation. |
| | | (Correction) |
| | | The master device transmits data containing the slave address and R/\overline{W} (1: read) in the first frame following the start condition issuance in master transmit mode, selects the slave device, and then switches the mode for receive operation. |



1. Description amended.

| Item | Page | Revisio | ns (See Ma | nual for D | etails) | | |
|--|------------|--|--|---|---|---|---|
| 16.4.9 Operation Using | 451 | (Error) | | | (Correction | ٦) | |
| DTC Table 16.7 Examples of Operation Using DTC | | Item | Master Transmit Mode | Slave Transmit Mode | Item | Master Transmit Mode | Slave Transmit Mode |
| | | Transfer request processing after last frame processing | 1st time: Clearing by CPU 2nd time: End condition issuance by CPU | Automatic clearing on detection of end condition during transmission of dummy data (H'FF) | Transfer request processing after last frame processing | 1st time: Clearing by CPU 2nd time: Stop condition issuance by CPU | Automatic clearing on detection of stop condition during transmission of dummy data (H'FF) |
| 16.6 Usage Notes | 457 | (Error) | | | (Correction | n) | |
| Table 16.11 I ² C Bus | | Item | t _{cyc} Indica | ition | Item | t _{cyc} Indic | ation |
| Timing (with Maximum Influence of tsr/tsf) | | t _{sdaso} (slave) | $t_{\scriptscriptstyle SDASO}({\sf slave})$ 1 $t_{\scriptscriptstyle SCLL}{}^{*3}$ -3 $t_{\scriptscriptstyle cyc}{}^{*2}(-t_{\scriptscriptstyle Sr})$ $t_{\scriptscriptstyle SDASO}({\sf slave})$ 1 $t_{\scriptscriptstyle SCLL}{}^{*3}$ - | | | $-12 t_{cyc}^{*2}(-t_{Sr})$ | |
| | | Notes: | | lue when the II0 the value is (t _{sct} | CX bit is set to 1. $\frac{1}{100}$ – $\frac{1}{100}$ – $\frac{1}{100}$ | When the IICX | bit is cleared to |
| | | | | - | he I ² C bus specifi n-speed mode: 13 | | standard mode: |
| 16.6.1 Module Stop Mode Setting | 463 | Added. | | | | | |
| Section 17 Keyboard Buffer Controller | 467 | • | ion deleted. | | . h o o 4h o 4 o 11 | | into un fou |
| 17.3 Register Descriptions | | each charefer to s | board buffer annel. For d section 26.1 CRH, MSTP | etails on the .3, Module | ne module s | top contro | ol register, |
| 17.5 Usage Notes | 481 | Added. | | | | | |
| 17.5.2 Module Stop Mode Setting | | | | | | | |
| Section 18 Host Interface | 483 | (Error) | | | | | |
| X-Bus Interface (XBS) 18.1 Features | | | ule stop mo | de setting | | | |
| 10.11 Galules | | (Correct | , | | | | |
| 40.0 Haara Natas | 504 | Deleted. | | | | | |
| 18.6 Usage Notes | 501 | Added. | | | | | |
| 18.6.2 Module Stop Mode Setting | | | | | | | |

| Section 19 Host Interface LPC Interface (LPC) 517, 518, 523 19.3 Register Descriptions 506 Description added. The LPC has the following registers. The settings of XBS related bits do not affect the operation of this LSI's LPC. However, for reasons relating to the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 should not be set to 1. For details, see section 3.2.2, System Control Register (SYSCR), and section 18.3.1, System Control Register 2 (SYSCR2). 19.3.4 Input Data Registers (IDR1 to IDR3) 19.3.5 Output Data Registers (ODR1 to ODR3) 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1 to STR3) 19.6.1 Module Stop Mode Setting Section 20 D/A Converter 554 Description added. DADR0 and DADR1 are initialized to H'00. 10.5.1 Module Stop Mode Setting Section 21 A/D Converter 559 (Error) Module stop mode can be set (Correction) Deleted. | Item | Page | Revisions (See Manual for Details) |
|--|----------------------------|------|---|
| 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Descriptions 506 19.3 Register Stype St | Section 19 Host Interface | 503, | (Error) Two-way register |
| The LPC has the following registers. The settings of XBS related bits do not affect the operation of this LSI's LPC. However, for reasons relating to the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 should not be set to 1. For details, see section 3.2.2, System Control Register (SYSCR), and section 18.3.1, System Control Register 2 (SYSCR2). 19.3.4 Input Data Registers (IDR1 to IDR3) 519 Description added. The initial values of IDR1 to IDR3 are undefined. 19.3.5 Output Data Registers (ODR1 to ODR3) 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1 to STR3) 19.3.7 Status Registers (STR1 to STR3) 19.3.6 I Module Stop Mode S51 Added. Setting Section 20 D/A Converter S54 Description added. DADR0 and DADR1 are initialized to H'00. 19.5.1 Module Stop Mode S57 Added. Setting Section 21 A/D Converter S59 Ection 21 A/D Converter S59 (Error) • Module stop mode can be set (Correction) | LPC Interface (LPC) | 518, | (Correction) Bidirectional data register |
| related bits do not affect the operation of this LSI's LPC. However, for reasons relating to the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 should not be set to 1. For details, see section 3.2.2, System Control Register (SYSCR), and section 18.3.1, System Control Register (SYSCR), and section 18.3.1, System Control Register 2 (SYSCR2). 19.3.4 Input Data Registers (IDR1 to IDR3) 19.3.5 Output Data Registers (ODR1 to ODR3) 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1) 19.3.7 Status Registers (STR3) 19.3.6 Indodule Stop Mode Setting Section 20 D/A Converter 20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode Setting Section 21 A/D Converter 559 21.1 Features Pescription added and the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 bused to 1. For details, see section 2. Set on 2. For details, see section 3.2.2, System Control Register (SYSCR), and section 18.3.1, System Control Register (SYSCR), and section 18.3.1, System Control Register 9. Description added. The initial values of IDR1 to IDR3 are undefined. Description added. The initial values of ODR1 to ODR3 are undefined. Description added. The initial values of TWR0 to TWR15 are undefined. Description added. The initial values of STR1 to STR3 are H'00. Added. Setting Section 20 D/A Converter 554 Description added. DADR0 and DADR1 are initialized to H'00. Added. Setting Section 21 A/D Converter 559 (Error) Module stop mode can be set (Correction) | 19.3 Register Descriptions | 506 | Description added. |
| Registers (IDR1 to IDR3) The initial values of IDR1 to IDR3 are undefined. 19.3.5 Output Data Registers (ODR1 to ODR3) 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1 to STR3) 19.6.1 Module Stop Mode Setting Section 20 D/A Converter S54 O and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode Setting Section 21 A/D Converter S59 Section 21 A/D Converter S59 Converted Setting The initial values of IDR1 to IDR3 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of STR1 to STR3 are H'00. Description added The initial values of STR1 to STR3 are H'00. Added. Setting DADR0 and DADR1 are initialized to H'00. Added. Setting Section 21 A/D Converter S59 (Error) Module stop mode can be set (Correction) | | | related bits do not affect the operation of this LSI's LPC. However, for reasons relating to the configuration of the program development tool (emulator), when the LPC is used, bit HI12E in SYSCR2 should not be set to 1. For details, see section 3.2.2, System Control Register (SYSCR), and section |
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| Registers (ODR1 to ODR3) The initial values of ODR1 to ODR3 are undefined. 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1 to STR3) 19.6.1 Module Stop Mode Setting Section 20 D/A Converter 554 20.3.1 D/A Data Registers Oand 1 (DADR0, DADR1) 20.5.1 Module Stop Mode S57 Setting Section 21 A/D Converter 559 Cerror) Module Stop Mode S59 Added. The initial values of TWR0 to TWR15 are undefined. The initial values of STR1 to STR3 are H'00. Description added The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. Description added The initial values of TWR0 to TWR15 are undefined. The initial values of ODR1 to ODR3 are undefined. The initial values of ODR1 to ODR3 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of ODR1 to ODR3 are undefined. The initial values of ODR1 to ODR3 are undefined. The initial values of ODR1 to OTWR15 are undefined. The initial values of ODR1 to OTWR15 are undefined. The initial values of ODR1 to OTWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. The initial values of TWR0 to TWR15 are undefined. | Registers (IDR1 to IDR3) | | The initial values of IDR1 to IDR3 are undefined. |
| ODR3) 19.3.6 Bidirectional Data Registers (TWR0 to TWR15) 19.3.7 Status Registers (STR1 to STR3) 19.6.1 Module Stop Mode Stoting Section 20 D/A Converter 554 20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode | • | 519 | Description added. |
| Registers (TWR0 to TWR15) The initial values of TWR0 to TWR15 are undefined. 19.3.7 Status Registers 520 Description added The initial values of STR1 to STR3 are H'00. 19.6.1 Module Stop Mode 551 Added. Setting Section 20 D/A Converter 554 Description added. 20.3.1 D/A Data Registers DADR0 and DADR1 are initialized to H'00. 20.5.1 Module Stop Mode 557 Added. Setting Section 21 A/D Converter 559 (Error) 21.1 Features The initial values of TWR0 to TWR15 are undefined. Description added The initial values of STR1 to STR3 are H'00. Added. Setting Converter 554 Description added. DADR0 and DADR1 are initialized to H'00. | · · | | The initial values of ODR1 to ODR3 are undefined. |
| TWR15) 19.3.7 Status Registers 520 Description added (STR1 to STR3) 19.6.1 Module Stop Mode 551 Added. Setting Section 20 D/A Converter 554 Description added. 20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode 557 Setting Section 21 A/D Converter 559 (Error) 21.1 Features • Module stop mode can be set (Correction) | | 520 | Description added. |
| (STR1 to STR3) The initial values of STR1 to STR3 are H'00. 19.6.1 Module Stop Mode 551 Setting Section 20 D/A Converter 554 Description added. 20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode 557 Setting Section 21 A/D Converter 559 (Error) 21.1 Features The initial values of STR1 to STR3 are H'00. Added. Setting Converter 554 Description added. DADR0 and DADR1 are initialized to H'00. (Error) Module Stop Mode 557 Setting Module Stop Mode can be set (Correction) | ` | | The initial values of TWR0 to TWR15 are undefined. |
| 19.6.1 Module Stop Mode 551 Added. Setting Section 20 D/A Converter 554 Description added. 20.3.1 D/A Data Registers DADR0 and DADR1 are initialized to H'00. 20.5.1 Module Stop Mode 557 Added. Setting Section 21 A/D Converter 559 (Error) 21.1 Features • Module stop mode can be set (Correction) | • | 520 | Description added |
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| 20.3.1 D/A Data Registers 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode 557 Setting Section 21 A/D Converter 559 21.1 Features • Module stop mode can be set (Correction) | · | 551 | Added. |
| 0 and 1 (DADR0, DADR1) 20.5.1 Module Stop Mode 557 Added. Setting Section 21 A/D Converter 559 (Error) 21.1 Features • Module stop mode can be set (Correction) | Section 20 D/A Converter | 554 | Description added. |
| Section 21 A/D Converter 559 (Error) 21.1 Features • Module stop mode can be set (Correction) | • | | DADR0 and DADR1 are initialized to H'00. |
| 21.1 Features • Module stop mode can be set (Correction) | _ | 557 | Added. |
| (Correction) | Section 21 A/D Converter | 559 | (Error) |
| · | 21.1 Features | | Module stop mode can be set |
| Deleted. | | | (Correction) |
| | | | Deleted. |

| Item | Page | Revisions (See Manual for Details) |
|---|------|---|
| 21.3.2 A/D Control/Status | 563 | Description of bit 5 added. |
| Register (ADCSR) | | Setting this bit to 1 starts A/D conversion. Clearing this bit to 0 stops A/D conversion. In single mode, this bit is cleared to 0 automatically when conversion on the specified channel ends. |
| | 563 | Bit 4 |
| | | (Error) |
| | | Selects the A/D conversion operating mode. The setting of this bit must be made while conversion is halted. |
| | | (Correction) |
| | | Selects the A/D conversion operating mode. The setting of this bit must be made when conversion is halted (ADST = 0). |
| | | Bit 3 |
| | | (Error) |
| | | Sets A/D conversion time. |
| | | (Correction) |
| | | Sets A/D conversion time. The input channel setting must be made when conversion is halted (ADST = 0). |
| | 564 | Bits 2 to 0 |
| | | (Error) |
| | | Select analog input channels. The input channel setting must be made while conversion is halted. |
| | | (Correction) |
| | | Select analog input channels. The input channel setting must be made when conversion is halted (ADST = 0). |
| 21.4.3 Input Sampling and A/D Conversion Time | 568 | (Error) (Correction) |
| Figure 21.3 A/D | | [(1) |
| Conversion Timing | | |
| | | Write signal Write signal |
| 21.7.6 Module Stop Mode | 574 | Added. |
| Setting | | |
| Section 22 RAM | 575 | List added. |
| Section 23 ROM | 577 | List of ROM capacitance added. |
| 23.1 Features | | |
| • Size | | |

| Figure 23.13 Memory Map | 604 | Note amended. Note:* For 3-V and 5-V version products, set the programming voltage of the PROM programmer to 3.3V. Corrected. |
|-------------------------|-----|---|
| | 604 | programming voltage of the PROM programmer to 3.3V. |
| | 604 | Corrected. |
| in Programmer Mode | | MCU mode H'000000 On-chip ROM area H'00FFFF Undefined value output H'1FFFF |
| 23.12 Usage Notes | 604 | (Error) If a voltage higher than the rated voltage is applied, the product may be fatally damaged. For a 3-V version product, use a PROM programmer that supports the Hitachi 64/128/256-kbyte flash memory on-chip MCU device at 3.3 V. Do not set the programmer to HN28F101 or the programming voltage to 5.0 V. For a 5-V version product, use a PROM programmer that supports the Hitachi 128-kbyte flash memory on-chip MCU device at 5.0 V. Do not set the programmer to HN28F101 or the programming voltage to 3.3 V. (Correction) |
| Section 24 Masked ROM | 607 | If a voltage higher than the rated voltage is applied, the product may be fatally damaged. For 3-V and 5-V version products, use a PROM programmer that supports the Hitachi 64/128/256-kbyte flash memory on-chip MCU device at 3.3 V. Do not set the programmer to HN28F101 or the programming voltage to 5.0 V. Added. |

| Page | Revisions (See Manual for De | etails) |
|---------------------|---|---|
| 651 | (Error) | (Correction) |
| | Register Bit 7 Bit 6 Abbreviation | Register Bit 7 Bit 6 Abbreviation |
| | BCR ICIS1 ICIS0 WSCR RAMS RAM0 | BCR _ ICIS0 WSCR |
| 654 | (Error) | (Correction) |
| | Register Bit 2 Abbreviation | Register Bit 2 Abbreviation |
| | | SEDGR |
| 655, 658, 660 | (Error) | (Correction) |
| 664 to 675 | Added. | |
| 677 | (Error) | (Correction) |
| | Item | Item |
| | Input voltage | Input voltage |
| | (Port C to G are added in the H8S/2160B and H8S/2161B.) | (Port C to F are added in the H8S/2160B and H8S/2161B.) |
| | Input voltage (P97, P86, P52, P42) | Input voltage(P97, P86, P52, P42) |
| | | (Port G is added in the H8S/2160B and H8S/2161B.) |
| | 651 654 655, 658, 660 664 to 675 | Register |

| Item | Page | Revisions (See I | Manual fo | r Details) | | | |
|---|------|------------------------|---|---|---|--|--|
| 28.1.2 DC Characteristics | 679, | (Error) | (Correct | (Correction) | | | |
| Table 28.2 DC | 680 | Item | | Item | Item | | |
| Characteristics (1) | | Input high P97, P86, P | 52, P42 | Input high | P97, P86, P52 | , P42 | |
| | | voltage | voltage | | | ed in the d H8S/2161B.) | |
| | | Output high P97,P86, P | 52, and P42 * ⁴ | Output high | P97,P86, P52, | and P42 *⁴ | |
| | | voltage | | voltage | (Port G is adde H8S/2160B an | | |
| | | Notes: 4. | and port G are SDA0, SCL1, NMOS open-d must be conne P52/SCK0, P9 levels are drive | LO, P97/SDAO, P86 NMOS push-pull of SDA1 (ICE = 1) Irain output. Therefected in order to output. P86/SCK1, P42 en by NMOS. When the put, an external put out high level. | outputs. When the pin is used as a core an external put high level. SCK2 (ICE = 0) in the SCK0, SC | ne SCL0, n output, it is pull-up resistor n, and port G high K1 or SCK2 pin is | |
| 28.1.2 DC Characteristics Table 28.2 DC Characteristics (3) When LPC Function is Used | 683 | Table name adde | ed. | | | | |
| 28.1.2 DC Characteristics | 685 | (Error) | | (Correct | ion) | | |
| Table 28.4 Bus Drive | | Item | Max | Item | N | lax | |
| Characteristics | | Input high voltage | V _{cc} + 0.5 | Input high | voltage 5 | .5 | |
| Tables 28.7 and 28.22 | 689, | (Error) | | (Correction |) | | |
| Bus Timing (1) (Normal | 722 | Item | Symbol | Item | | Symbol | |
| Mode) | | HWR delay time 1 | t _{wrd1} | HWR, LWR | delay time 1 | t _{wrd1} | |
| | | HWR delay time 2 | $\mathbf{t}_{_{\mathrm{WRD2}}}$ | HWR, LWR | delay time 2 | t _{wrd2} | |
| | | HWR pulse width 1 | t _{wsw1} | HWR, LWR | pulse width | 1 t _{wsw1} | |
| | | HWR pulse width 2 | t _{wsw2} | HWR, LWR | pulse width | 2 t _{wsw2} | |

| Item | Page | Revisio | ns (See | Manual for D | etails) | |
|--|---------------------|-----------|-----------|---|--|---|
| 28.2.2 DC Characteristics Table 28.17 DC Characteristics (1) | 702 | Notes: | 4. | P86/SCK1/S port G are N the SCL0, Sl pin is used a drain output. | CL0, P97/SDA0, CL1, P42/SCK2/SMOS push-pull ou DA0, SCL1, or SD an output, it is Notherefore, an extended in executed in executed. | tputs. When A1 (ICE = 1) IMOS open-ernal pull-up |
| | | | | (ICE = 0), ar by NMOS. W pin is used a | P97, P86/SCK1, Pad port G high leven the SCK0, So an output, an ext be connected in exercise. | els are driven CK1, or SCK2 tternal pull-up |
| | | | 8. | - | haracteristics depe r pins characterist mode. | |
| Table 28.17 DC Characteristics (3) Table 28.17 DC Characteristics (5) | 706, 707, 711 | Notes: | 4. | P86/SCK1/S port G are N the SCL0, SI pin is used a drain output. resistor musi output high I P52/SCK0, F (ICE = 0), ar by NMOS. W pin is used a | P97, P86/SCK1, Pad port G high leven Then the SCK0, So s an output, an ext t be connected in o | tputs. When A1 (ICE = 1) IMOS open- ernal pull-up order to 42/SCK2 els are driven CK1, or SCK2 tternal pull-up |
| 28.2.2 DC Characteristics Table 28.17 DC Characteristics (7) (3-V Version of H8S/2145BV) When LPC Function is Used | 715 | Table n | ame adde | ed. | | |
| 28.2.2 DC Characteristics | 718 | (Error) | | | (Correction) | |
| Table 28.19 Bus Drive | | Item | | Max | Item | Max |
| Characteristics | | Input hig | h voltage | V _{cc} + 0.5 | Input high voltage | 5.5 |

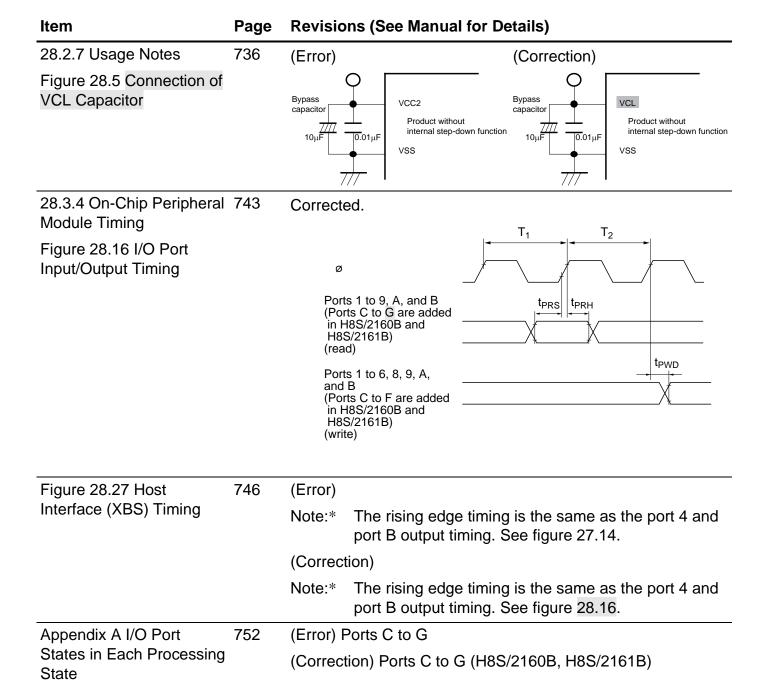
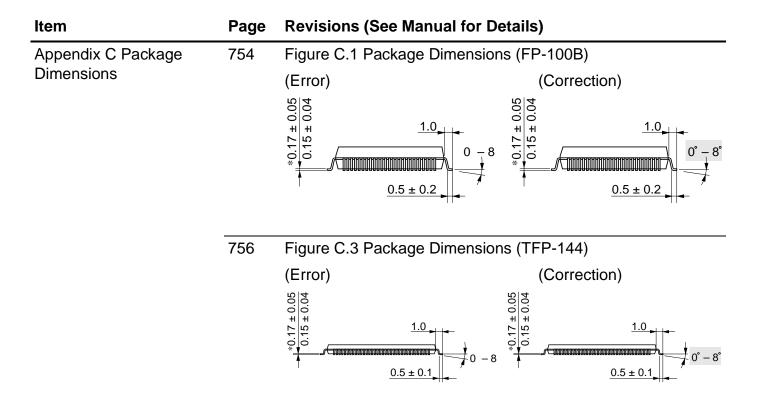


Table A.1 I/O Port States in Each Processing State



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